Dell PowerEdge R760

Installation and Service Manual

Regulatory Model: E82S
Regulatory Type: E82S001
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DELL Technologies

Notes, cautions, and warnings

NOTE: A NOTE indicates important information that helps you make better use of your product.

CAUTION: A CAUTION indicates either potential damage to hardware or loss of data and tells you how to avoid the problem.

WARNING: A WARNING indicates a potential for property damage, personal injury, or death.

Contents

1

About this document

This document provides an overview about the system, information about installing and replacing components, diagnostic tools, and guidelines to be followed while installing certain components.

2

System overview

The PowerEdge R760 system is a 2U server that supports:

- Two 4th Gen Intel® Xeon® Scalable or Intel® Xeon® Max Processors with up to 56 cores
- Two 5th Gen Intel® Xeon® Scalable Processors with up to 64 cores
- Optional Direct Liquid Cooling
- 32 DIMM slots
- Two redundant AC or DC power supply units
- Up to 12 x 3.5-inch SAS, SATA or 24 x 2.5-inch, 16 x 2.5-inch, 8 x 2.5-inch, or 2 x 2.5-inch (rear), 4 x 2.5-inch(rear), 4 x EDSFF E3.S (rear) SAS, SATA, or NVMe (HDD/SSD) drives, or 16 x EDSFF E3.S NVMe (SSD) drives.

NOTE: For more information about how to hot swap NVMe PCIe SSD U.2 device, see the *Dell Express Flash NVMe PCIe SSD User's Guide* at Dell Support **> Browse all products** > **Infrastructure** > **Data Center Infrastructure** > **Storage Adapters & Controllers** > **Dell PowerEdge Express Flash NVMe PCIe SSD** > **Select This Product** > **Documentation** > **Manuals and Documents**.

NOTE: All instances of SAS, SATA, and NVMe drives are referred to as drives in this document, unless specified otherwise.

CAUTION: Do not install GPUs, network cards, or other PCIe devices on your system that are not validated and tested by Dell. Damage caused by unauthorized and invalidated hardware installation will null and void the system warranty.

Topics:

Front view of the system

Figure 1. Front view of 24 x 2.5-inch drive system

Figure 2. Front view of 16 x 2.5-inch drive system

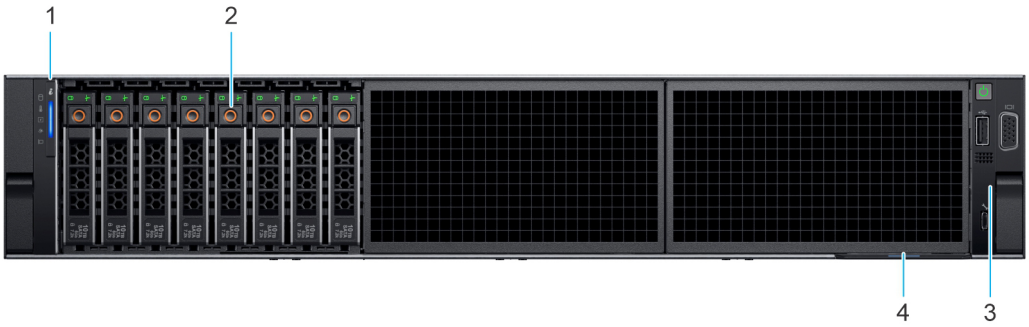


Figure 3. Front view of 8 x 2.5-inch drive system

Figure 4. Front view of 12 x 3.5-inch drive system

Figure 5. Front view of 16 x EDSFF E3.S drive system

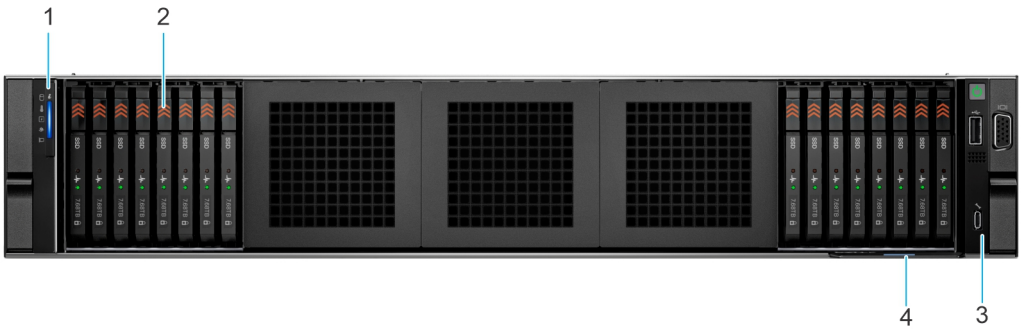


Figure 6. Front view of 16 x EDSFF E3.S drive system

Table 1. Features available on the front of the system

Item	Ports, panels, and slots	Icon	Description
1	Left control panel	N/A	Contains the system health, system ID, and the status LED indicator.
2	Drive	N/A	Enables you to install drives that are supported on your system. **NOTE:** For drive slot numbers, see the System information labels section.
3	Right control panel	N/A	Contains the power button, VGA port, USB port, iDRAC Direct (Micro-AB USB) port, and the iDRAC Direct status LED.
4	Express Service Tag	N/A	The Express Service Tag is a slide-out label panel that contains system information such as Service Tag, NIC, MAC address, and so on. If you have opted for the secure default access to iDRAC, the Information tag will also contain the iDRAC secure default password.

NOTE: For more information about ports, panels, and slots, see the Technical specification section.

Left control panel view

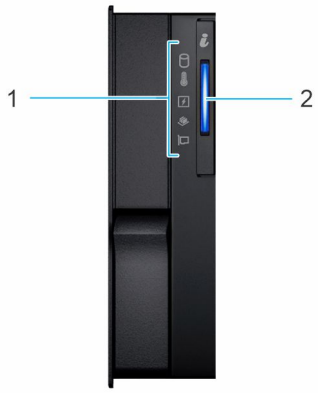


Figure 7. Left control panel

Table 2. Left control panel

Item	Indicator, button, or connector	Icon	Description
1	Status LED indicators	NA	Indicates the status of the system. For more information, see the Status LED indicators section.
2	System health and system ID	𝒊	Indicates the system health. For more information, see the System health and system ID indicator codes section.

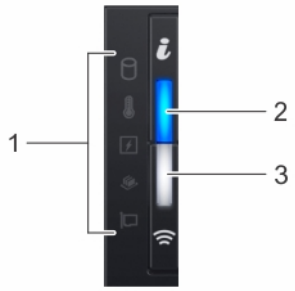


Figure 8. Left control panel with optional iDRAC Quick Sync 2 indicator

Table 3. Left control panel with optional iDRAC Quick Sync 2 indicator

Item	Indicator, button, or connector	Icon	Description
1	Status LED indicators	N/A	Indicates the status of the system. For more information, see the Status LED indicators section.
2	System health and system ID indicator	𝒊	Indicates the system health. For more information, see the System health and system ID indicator codes section.
3	iDRAC Quick Sync 2 wireless indicator (optional)	ᯤ	Indicates if the iDRAC Quick Sync 2 wireless option is activated. The Quick Sync 2 feature allows management of the system using mobile devices. This feature aggregates hardware/firmware inventory and various system level diagnostic/error information that can be used in troubleshooting the system. You can access system inventory, Dell Lifecycle Controller logs or system logs, system health status, and also configure iDRAC, BIOS, and networking parameters. You can also launch the virtual Keyboard, Video, and Mouse (KVM) viewer and virtual Kernel-based Virtual Machine (KVM), on a supported mobile device. For more information, see the Integrated Dell Remote Access Controller User's Guide at PowerEdge manuals.

NOTE: For more information about the indicator codes, see the System diagnostics and indicator codes section.

Right control panel view

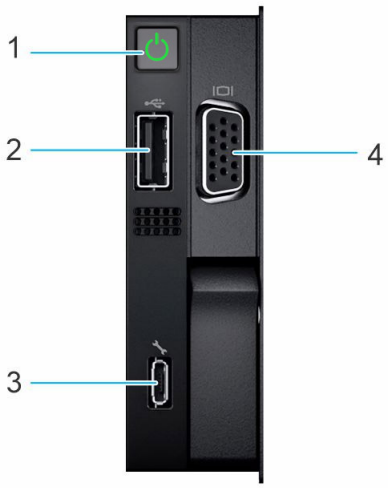


Figure 9. Right control panel

Table 4. Right control panel

Item	Indicator or button	Icon	Description
1	Power button		Indicates if the system is powered on or off. Press the power button to manually power on or off the system. **NOTE:** Press the power button to gracefully shut down an ACPI-compliant operating system.
2	USB 2.0 port		The USB port is 4-pin, 2.0-compliant. This port enables you to connect USB devices to the system.
3	iDRAC Direct (Micro-AB USB) port		The iDRAC Direct (Micro-AB USB) port enables you to access the iDRAC direct Micro-AB USB features. For more information, see the *Integrated Dell Remote Access Controller User's Guide* at PowerEdge Manuals. **NOTE:** You can configure iDRAC Direct by using a USB to micro USB (type AB) cable, which you can connect to your laptop or tablet. Cable length should not exceed 3 feet (0.91 meters). Performance could be affected by cable quality.
4	VGA port		Enables you to connect a display device to the system.

NOTE: For more information about ports, panels, and slots, see the Technical specification section.

Rear view of the system

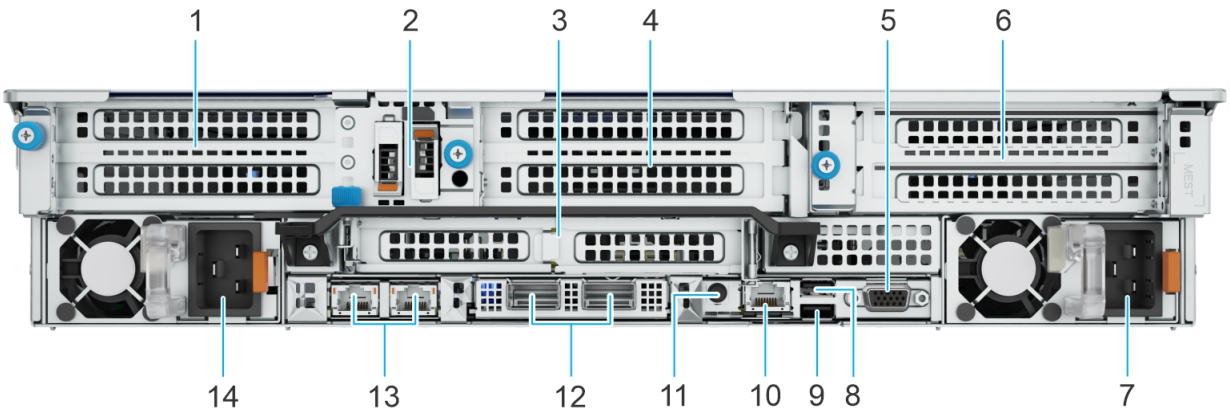


Figure 10. Rear view of the system

Table 5. Rear view of the system

Item	Ports, panels, or slots	Icon	Description
1	PCIe expansion card riser 1 (slot 1 and slot 2)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
2	BOSS module	N/A	BOSS module for internal system boot.
3	PCIe expansion card riser 2 (slot 3 and slot 6)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
4	PCIe expansion card riser 3 (slot 4 and slot 5)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
5	VGA port		Enables you to connect a display device to the system.

Table 5. Rear view of the system (continued)

Item	Ports, panels, or slots	Icon	Description
6	PCIe expansion card riser 4 (slot 7 and slot 8)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
7	Power supply unit (PSU2)	⚡2	PSU2 is the secondary PSU of the system.
8	USB 2.0 port	⇄	The USB port is 4-pin, 2.0-compliant. This port enables you to connect USB devices to the system.
9	USB 3.0 port	SS⇄	The USB port is 9-pin and 3.0-compliant. This port enables you to connect USB devices to the system.
10	Dedicated iDRAC9 Ethernet port	iDRAC	Enables you to remotely access iDRAC. For more information, see the Integrated *Dell Remote Access Controller User's Guide* at PowerEdge Manuals.
11	System Identification (ID) button	ⓘ	The System Identification (ID) button is available on the front and back of the system. Press the button to identify a system in a rack by turning on the system ID button. You can also use the system ID button to reset iDRAC and to access BIOS using the step through mode. When pressed, the system ID LED in the back panel blinks until either the front or rear button is pressed again. Press the button to toggle between on or off mode. **NOTE:** If the server stops responding during POST, press and hold the **System ID** button for more than five seconds to enter the BIOS progress mode. **NOTE:** To reset the iDRAC (if not disabled on the iDRAC setup page by pressing F2 during system boot), press and hold the **System ID** button for more than 15 seconds.
12	OCP NIC card (optional)	N/A	The OCP NIC card supports OCP 3.0. The NIC ports are integrated on the OCP card which is connected to the system board.
13	NIC ports (optional)	⧉	The NIC ports that are integrated on the LOM card provide network connectivity which is connected to the system board or Management Interface Card (MIC) to support Dell Data Processing Unit (DPU) card to be installed in the riser. **NOTE:** The system allows either LOM card or MIC card to be installed in the system.
14	Power supply unit (PSU1)	⚡1	PSU1 is the primary PSU of the system.

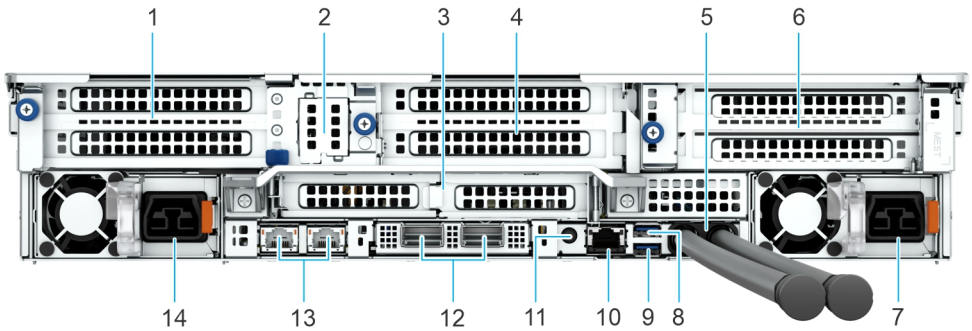


Figure 11. Rear view of the system with optional liquid cooling

Table 6. Rear view of the system with optional liquid cooling

Item	Ports, panels, or slots	Icon	Description
1	PCIe expansion card riser 1 (slot 1 and slot 2)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
2	BOSS blank	N/A	Insert BOSS blank when BOSS module is not used.
3	PCIe expansion card riser 2 (slot 3 and slot 6)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
4	PCIe expansion card riser 3 (slot 5)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
5	Coolant tubes	N/A	Cold coolant flows into the system from one tube and hot coolant leaves the system from another tube.
6	PCIe expansion card riser 4 (slot 7)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
7	Power supply unit (PSU2)	2	PSU2 is the secondary PSU of the system.
8	USB 2.0 port		The USB port is 4-pin, 2.0-compliant. This port enables you to connect USB devices to the system.
9	USB 3.0 port		The USB port is 9-pin and 3.0-compliant. This port enables you to connect USB devices to the system.
10	Dedicated iDRAC9 Ethernet port	iDRAC	Enables you to remotely access iDRAC. For more information, see the Integrated *Dell Remote Access Controller User's Guide* at PowerEdge Manuals.
11	System Identification (ID) button		The System Identification (ID) button is available on the front and back of the system. Press the button to identify a system in a rack by turning on the system ID button. You can also use the system ID button to reset iDRAC and to access BIOS using the step through mode. When pressed, the system ID LED in the back panel blinks until either the front or rear button is pressed again. Press the button to toggle between on or off mode. **NOTE:** If the server stops responding during POST, press and hold the **System ID** button for more than five seconds to enter the BIOS progress mode. **NOTE:** To reset the iDRAC (if not disabled on the iDRAC setup page by pressing F2 during system boot), press and hold the **System ID** button for more than 15 seconds.
12	OCP NIC card (optional)	N/A	The OCP NIC card supports OCP 3.0. The NIC ports are integrated on the OCP card which is connected to the system board.
13	NIC ports (optional)		The NIC ports that are integrated on the LOM card provide network connectivity which is connected to the system board or MIC to support Dell DPU card to be installed in the riser. **NOTE:** The system allows either LOM card or MIC card to be installed in the system.
14	Power supply unit (PSU1)	1	PSU1 is the primary PSU of the system.

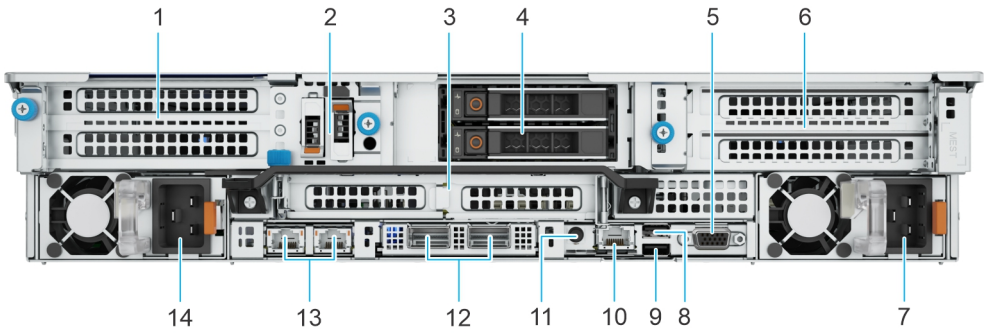


Figure 12. Rear view of the system with 2 x 2.5-inch rear drive module

Table 7. Rear view of the system with 2 x 2.5-inch rear drive module

Item	Ports, panels, or slots	Icon	Description
1	PCIe expansion card riser 1 (slot 1 and slot 2)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
2	BOSS module	N/A	BOSS module for internal system boot.
3	PCIe expansion card riser 2 (slot 3 and slot 6)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
4	Rear drive module	N/A	Enables you to install rear drives that are supported on your system. **NOTE:** For drive slot numbers, see the Rear drive module section.
5	VGA port		Enables you to connect a display device to the system.
6	PCIe expansion card riser 4 (slot 7 and slot 8)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
7	Power supply unit (PSU2)	2	PSU2 is the secondary PSU of the system.
8	USB 2.0 port		The USB port is 4-pin, 2.0-compliant. This port enables you to connect USB devices to the system.
9	USB 3.0 port		The USB port is 9-pin and 3.0-compliant. This port enables you to connect USB devices to the system.
10	Dedicated iDRAC9 Ethernet port	iDRAC	Enables you to remotely access iDRAC. For more information, see the Integrated *Dell Remote Access Controller User's Guide* at PowerEdge Manuals.
11	System Identification (ID) button		The System Identification (ID) button is available on the front and back of the system. Press the button to identify a system in a rack by turning on the system ID button. You can also use the system ID button to reset iDRAC and to access BIOS using the step through mode. When pressed, the system ID LED in the back panel blinks until either the front or rear button is pressed again. Press the button to toggle between on or off mode. **NOTE:** If the server stops responding during POST, press and hold the **System ID** button for more than five seconds to enter the BIOS progress mode. **NOTE:** To reset the iDRAC (if not disabled on the iDRAC setup page by pressing F2 during system boot), press and hold the **System ID** button for more than 15 seconds.

Table 7. Rear view of the system with 2 x 2.5-inch rear drive module (continued)

Item	Ports, panels, or slots	Icon	Description
12	OCP NIC card (optional)	N/A	The OCP NIC card supports OCP 3.0. The NIC ports are integrated on the OCP card which is connected to the system board.
13	NIC ports (optional)		The NIC ports that are integrated on the LOM card provide network connectivity which is connected to the system board or MIC to support Dell DPU card to be installed in the riser. **NOTE:** The system allows either LOM card or MIC card to be installed in the system.
14	Power supply unit (PSU1)	1	PSU1 is the primary PSU of the system.

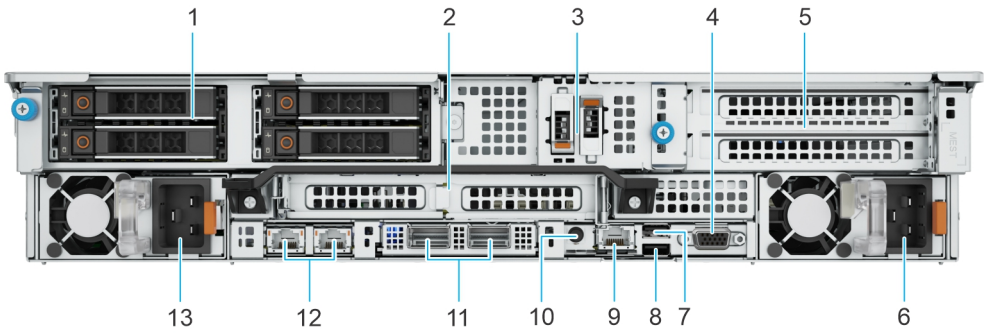


Figure 13. Rear view of the system with 4 x 2.5-inch rear drive module

Table 8. Rear view of the system with 4 x 2.5-inch rear drive module

Item	Ports, panels, or slots	Icon	Description
1	Rear drive module	N/A	Enables you to install rear drives that are supported on your system. **NOTE:** For drive slot numbers, see the Rear drive module section.
2	PCIe expansion card riser 2 (slot 3 and slot 6)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
3	BOSS module	N/A	BOSS module for internal system boot.
4	VGA port		Enables you to connect a display device to the system.
5	PCIe expansion card riser 4 (slot 7 and slot 8)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
6	Power supply unit (PSU2)	2	PSU2 is the secondary PSU of the system.
7	USB 2.0 port		The USB port is 4-pin, 2.0-compliant. This port enables you to connect USB devices to the system.
8	USB 3.0 port		The USB port is 9-pin and 3.0-compliant. This port enables you to connect USB devices to the system.
9	Dedicated iDRAC9 Ethernet port	iDRAC	Enables you to remotely access iDRAC. For more information, see the Integrated *Dell Remote Access Controller User's Guide* at PowerEdge Manuals.
10	System Identification (ID) button		The System Identification (ID) button is available on the front and back of the system. Press the button to identify a system in a rack by turning on the system ID button. You can also use the system ID button to reset iDRAC and to access BIOS using the step through mode. When pressed, the system ID LED in the back panel blinks until

Table 8. Rear view of the system with 4 x 2.5-inch rear drive module (continued)

Item	Ports, panels, or slots	Icon	Description
			either the front or rear button is pressed again. Press the button to toggle between on or off mode. **NOTE:** If the server stops responding during POST, press and hold the **System ID** button for more than five seconds to enter the BIOS progress mode. **NOTE:** To reset the iDRAC (if not disabled on the iDRAC setup page by pressing F2 during system boot), press and hold the **System ID** button for more than 15 seconds.
11	OCP NIC card (optional)	N/A	The OCP NIC card supports OCP 3.0. The NIC ports are integrated on the OCP card which is connected to the system board.
12	NIC ports (optional)		The NIC ports that are integrated on the LOM card provide network connectivity which is connected to the system board or MIC to support Dell DPU card to be installed in the riser. **NOTE:** The system allows either LOM card or MIC card to be installed in the system.
13	Power supply unit (PSU1)	1	PSU1 is the primary PSU of the system.

NOTE: For more information about ports, panels, and slots, see the Technical specification section.

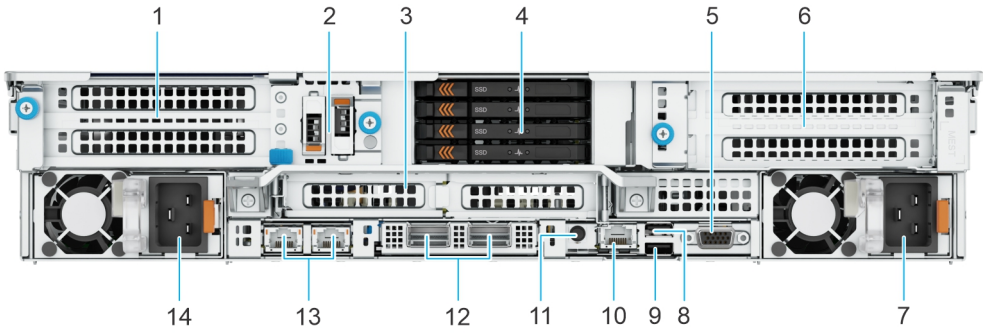


Figure 14. Rear view of the system with 4 x EDSFF E3.S rear drive module

Table 9. Rear view of the system with 4 x EDSFF E3.S rear drive module

Item	Ports, panels, or slots	Icon	Description
1	PCIe expansion card riser 1 (slot 1 and slot 2)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
2	BOSS module	N/A	BOSS module for internal system boot.
3	PCIe expansion card riser 2 (slot 3 and slot 6)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.
4	Rear drive module	N/A	Enables you to install rear drives that are supported on your system. **NOTE:** For drive slot numbers, see the Rear drive module section.
5	VGA port		Enables you to connect a display device to the system.
6	PCIe expansion card riser 4 (slot 7 and slot 8)	N/A	The expansion card riser enables you to connect PCI Express expansion cards. For more information , see the Expansion card installation guidelines section.

Table 9. Rear view of the system with 4 x EDSFF E3.S rear drive module (continued)

Item	Ports, panels, or slots	Icon	Description
7	Power supply unit (PSU2)	2	PSU2 is the secondary PSU of the system.
8	USB 2.0 port		The USB port is 4-pin, 2.0-compliant. This port enables you to connect USB devices to the system.
9	USB 3.0 port		The USB port is 9-pin and 3.0-compliant. This port enables you to connect USB devices to the system.
10	Dedicated iDRAC9 Ethernet port	iDRAC	Enables you to remotely access iDRAC. For more information, see the Integrated *Dell Remote Access Controller User's Guide* at PowerEdge Manuals.
11	System Identification (ID) button		The System Identification (ID) button is available on the front and back of the system. Press the button to identify a system in a rack by turning on the system ID button. You can also use the system ID button to reset iDRAC and to access BIOS using the step through mode. When pressed, the system ID LED in the back panel blinks until either the front or rear button is pressed again. Press the button to toggle between on or off mode. **NOTE:** If the server stops responding during POST, press and hold the **System ID** button for more than five seconds to enter the BIOS progress mode. **NOTE:** To reset the iDRAC (if not disabled on the iDRAC setup page by pressing F2 during system boot), press and hold the **System ID** button for more than 15 seconds.
12	OCP NIC card (optional)	N/A	The OCP NIC card supports OCP 3.0. The NIC ports are integrated on the OCP card which is connected to the system board.
13	NIC ports (optional)		The NIC ports that are integrated on the LOM card provide network connectivity which is connected to the system board or MIC to support Dell DPU card to be installed in the riser. **NOTE:** The system allows either LOM card or MIC card to be installed in the system.
14	Power supply unit (PSU1)	1	PSU1 is the primary PSU of the system.

Inside the system

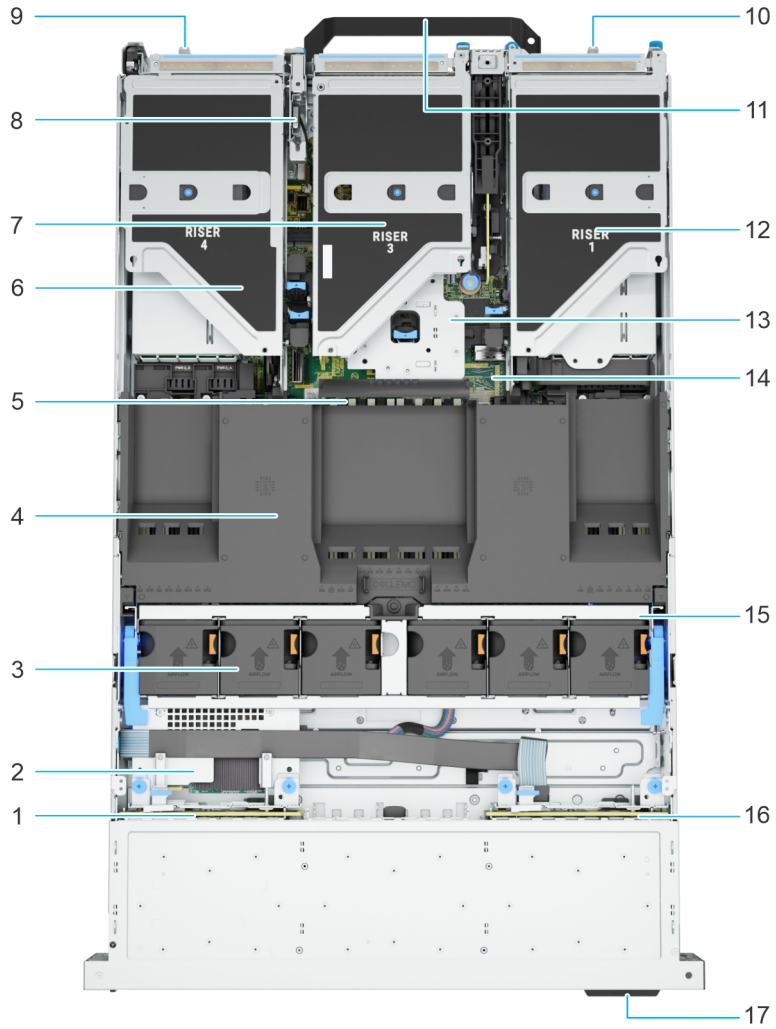


Figure 15. Inside the system

1. Backplane
2. Rear mounting front PERC module
3. Cooling fans
4. Air shroud
5. Memory DIMM sockets
6. Expansion riser 4
7. Expansion riser 3
8. Intrusion switch module
9. Power supply unit (PSU2)
10. Power supply unit (PSU1)
11. Rear handle
12. Expansion riser 1
13. Expansion riser 2
14. System board
15. Cooling fan cage assembly
16. Backplane
17. Express Service Tag

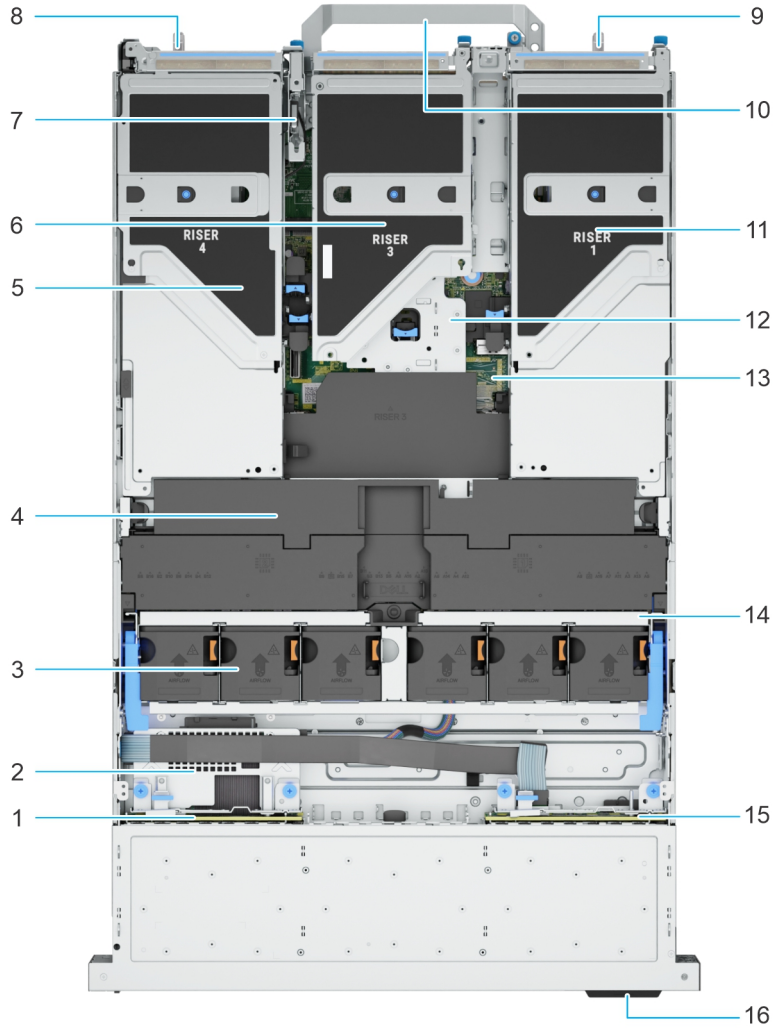


Figure 16. Inside the system with full length risers and GPU shroud

1. Backplane
2. Rear mounting front PERC module
3. Cooling fans
4. GPU air shroud
5. Expansion riser 4
6. Expansion riser 3
7. Intrusion switch module
8. Power supply unit (PSU2)
9. Power supply unit (PSU1)
10. Rear handle
11. Expansion riser 1
12. Expansion riser 2
13. System board
14. Cooling fan cage assembly
15. Backplane
16. Express Service Tag

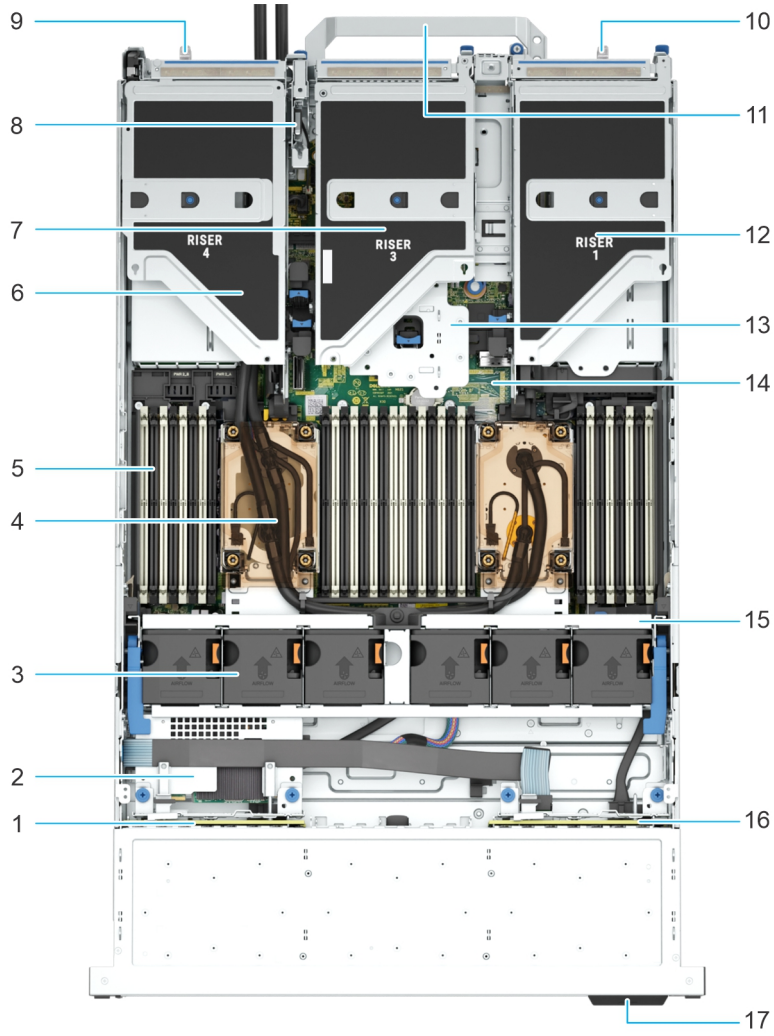


Figure 17. Inside the system with processor liquid cooling module

1. Backplane
2. Rear mounting front PERC module
3. Cooling fans
4. Processor liquid cooling modules
5. Memory DIMM sockets
6. Expansion riser 4
7. Expansion riser 3
8. Intrusion switch module
9. Power supply unit (PSU2)
10. Power supply unit (PSU1)
11. Rear handle
12. Expansion riser 1
13. Expansion riser 2
14. System board
15. Cooling fan cage assembly
16. Backplane
17. Express Service Tag

NOTE: Air shroud is hidden in the above image to show the processor liquid cooling configuration.

Locating the Express Service Code and Service Tag

The unique Express Service Code and Service Tag are used to identify the system.

The Express Service Tag is located on the front of the system that includes system information such as the Service Tag, Express Service Code, Manufacture date, NIC, MAC address, QR code, and so on. If you have opted for the secure default access to iDRAC, the Information tag also contains the iDRAC secure default password. If you have opted for iDRAC Quick Sync 2, the Information tag also contains the OpenManage Mobile (OMM) label, where administrators can configure, monitor, and troubleshoot the PowerEdge servers.

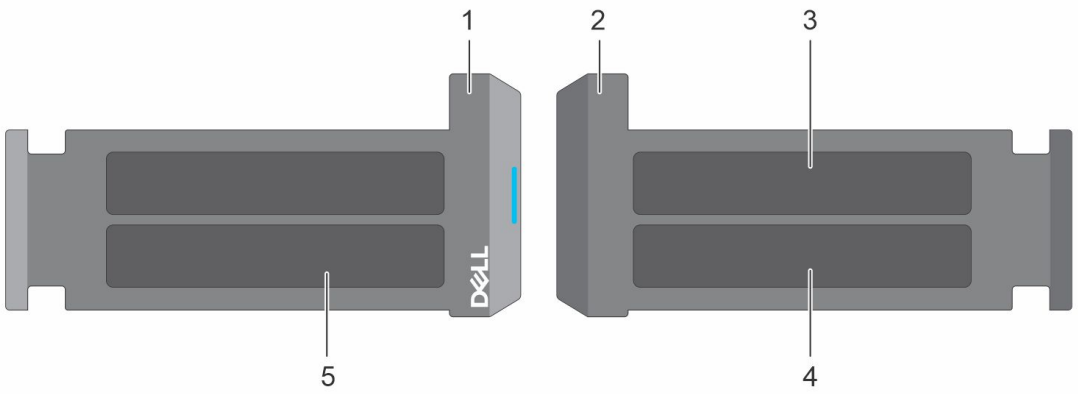


Figure 18. Locating the Express Service Code and Service tag

1. Express Service Tag (front view)
2. Express Service Tag (rear view)
3. OpenManage Mobile (OMM) label
4. iDRAC MAC address and iDRAC secure password label
5. Service Tag, Express Service Code, QR code

The Mini Enterprise Service Tag (MEST) label is on the rear of the system that includes the Service Tag (ST), and Express Service Code (Exp Svc Code). The Exp Svc Code is used by Dell to route support calls to the appropriate personnel.

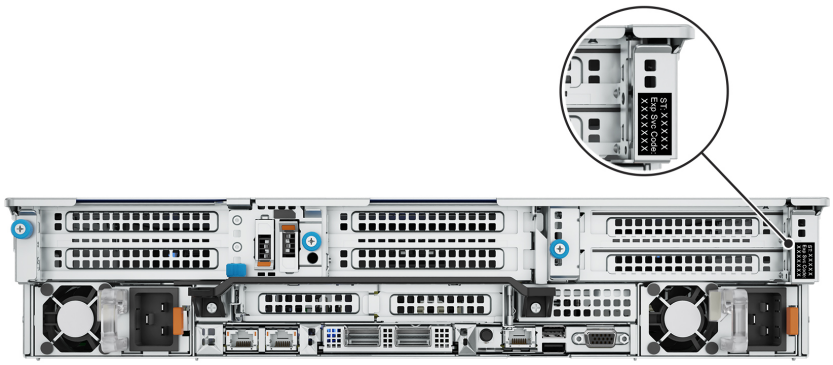


Figure 19. Locating the Mini Express Service Tag

System information labels

The system information label is on the back side of the system cover.

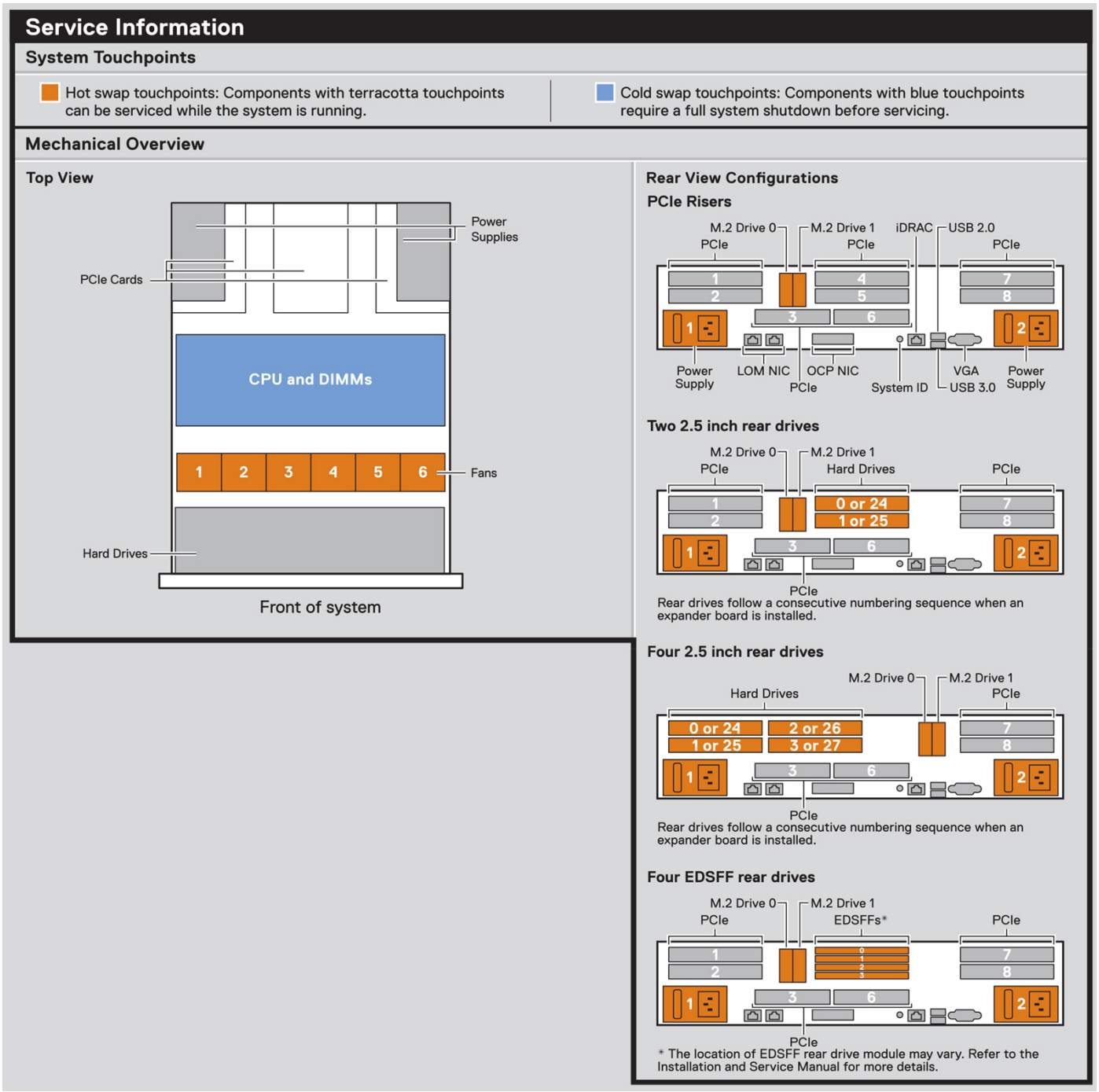


Figure 20. Service information

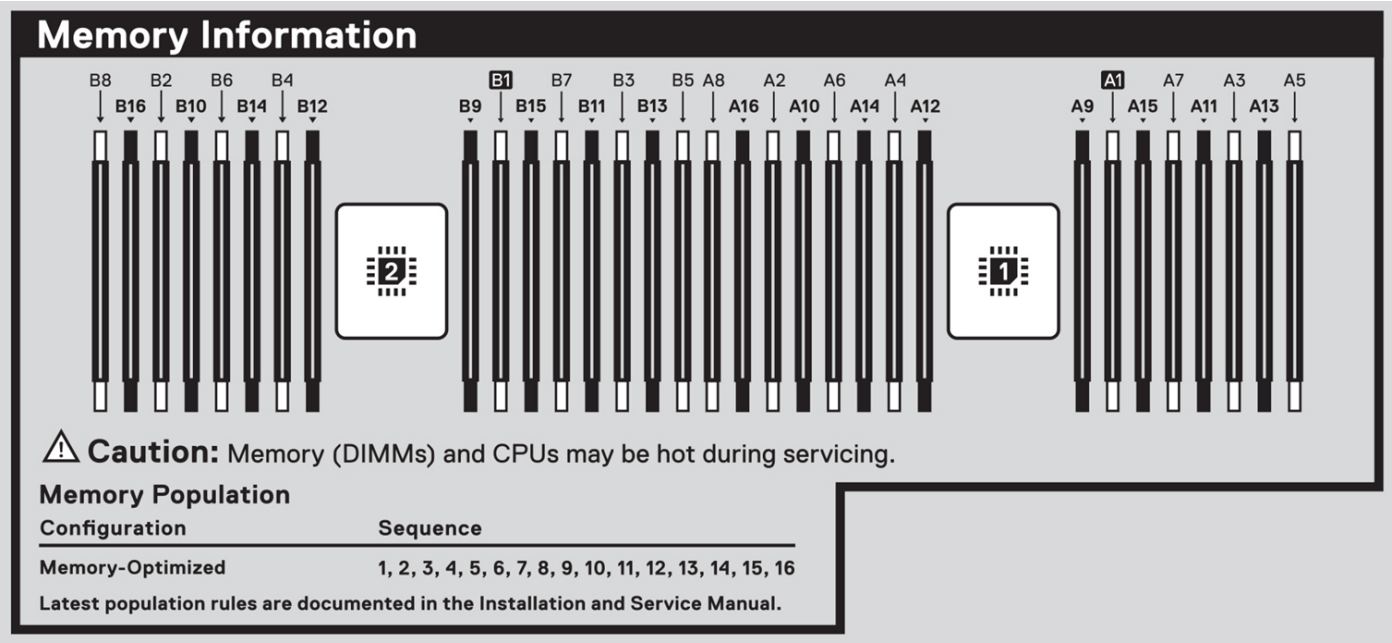


Figure 21. Memory information

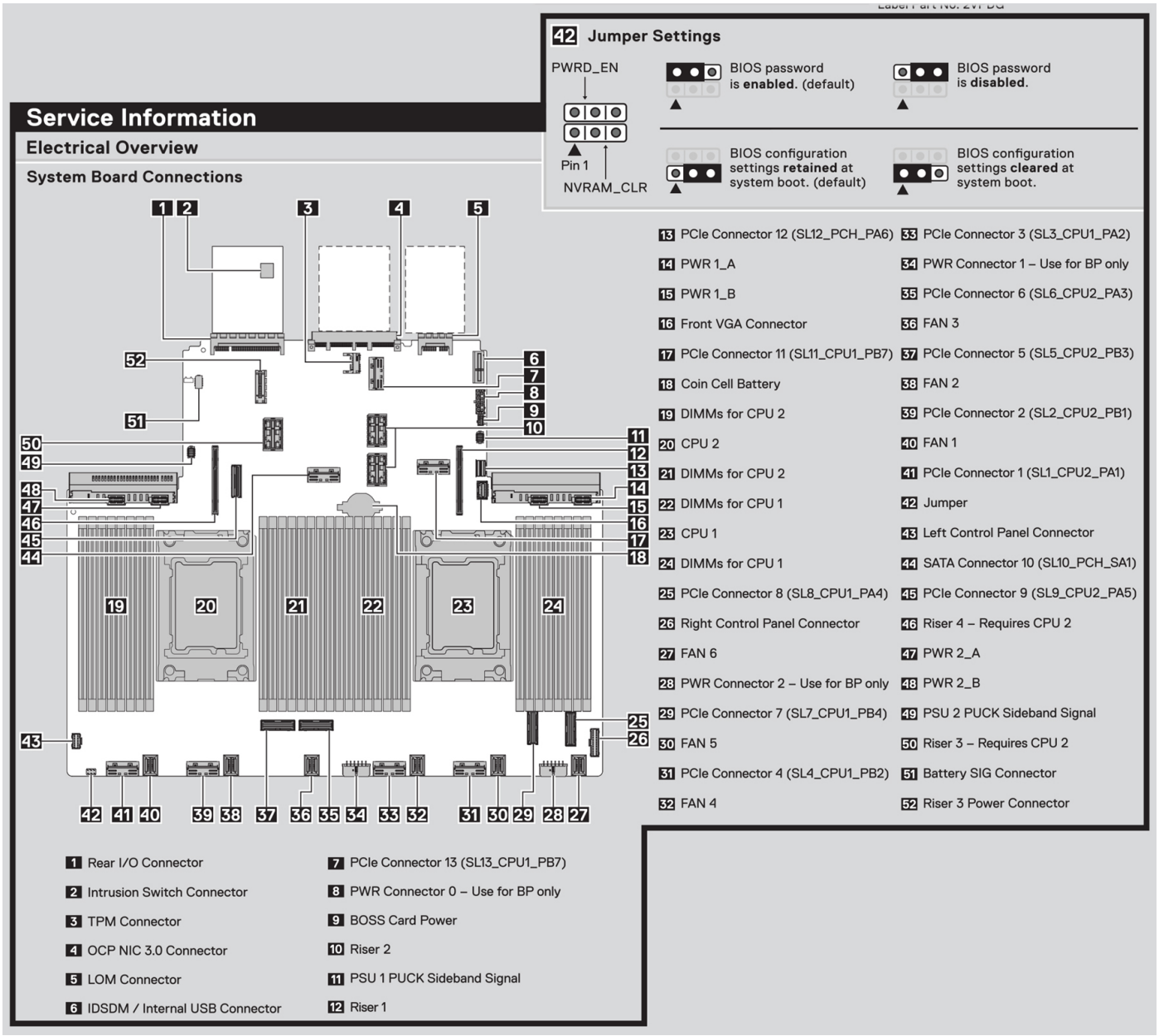


Figure 22. Electrical overview

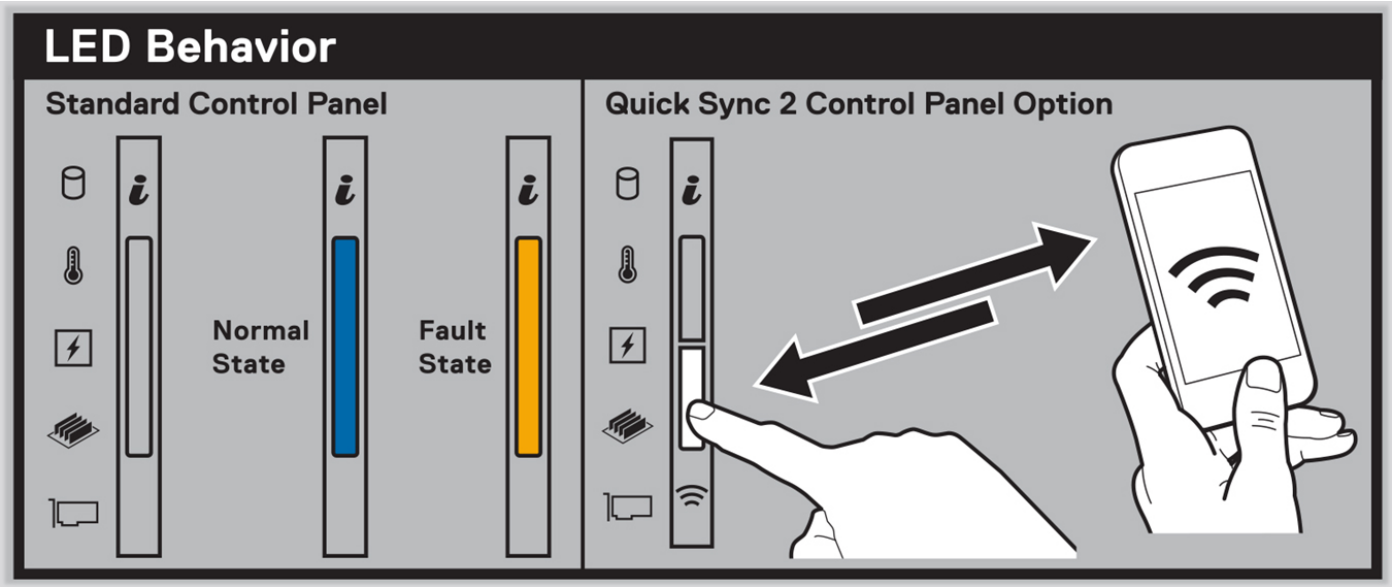


Figure 23. LED behavior

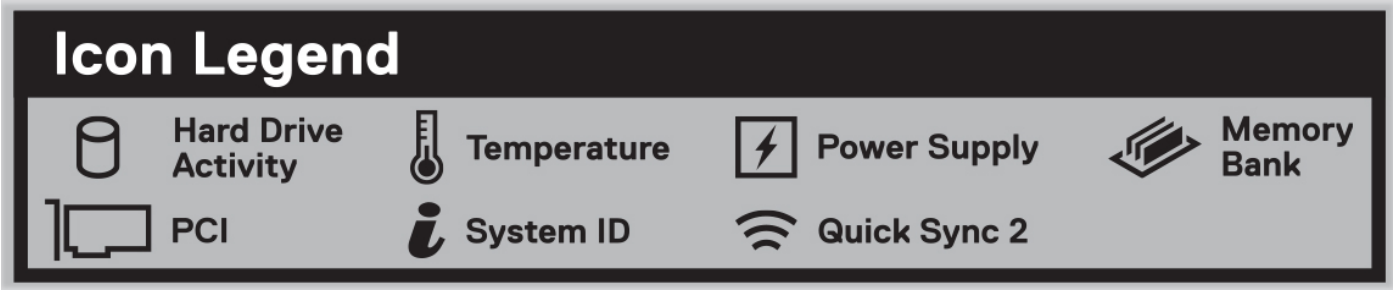


Figure 24. Icon legend

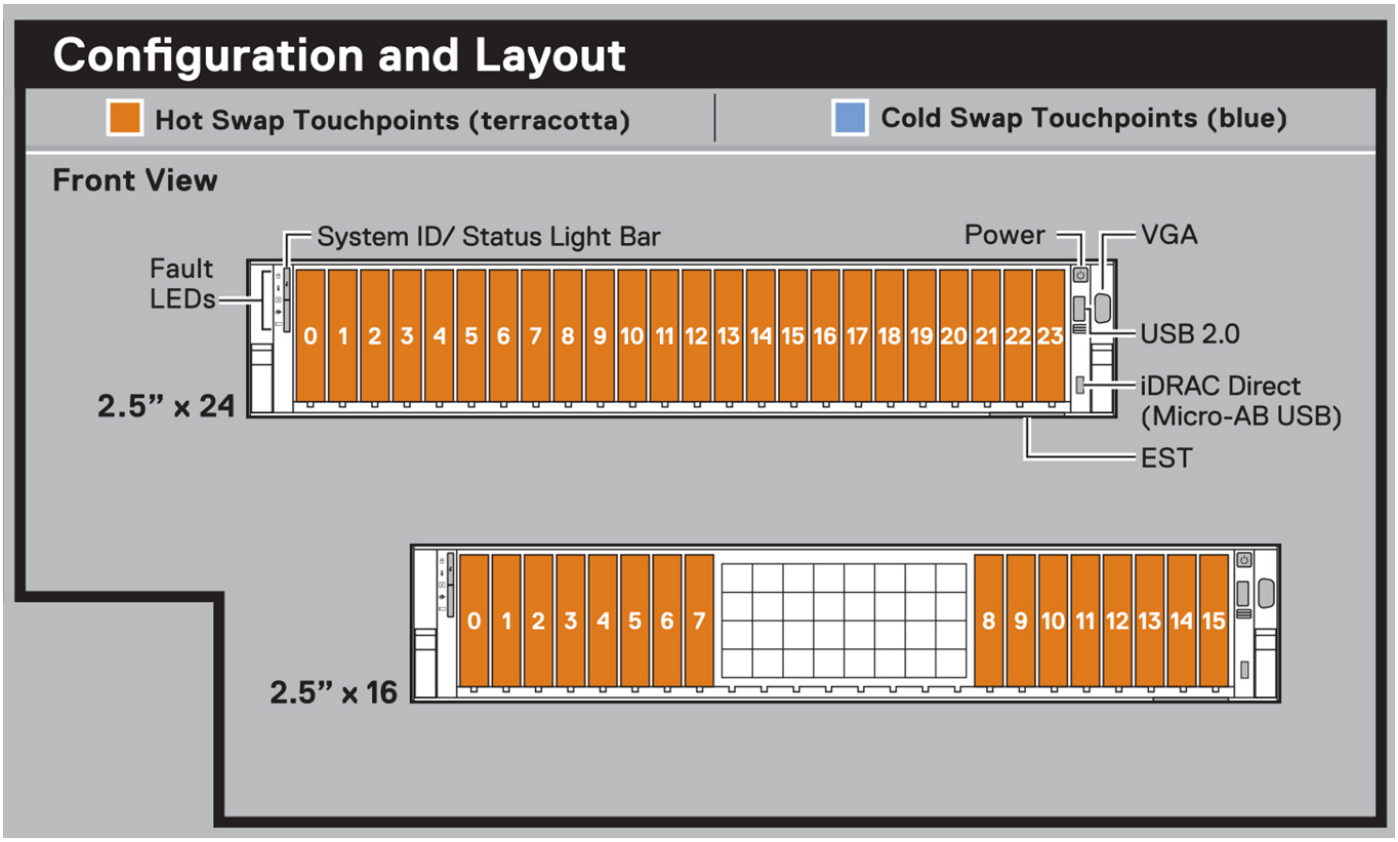


Figure 25. Configuration and layout for 2.5-inch drive system

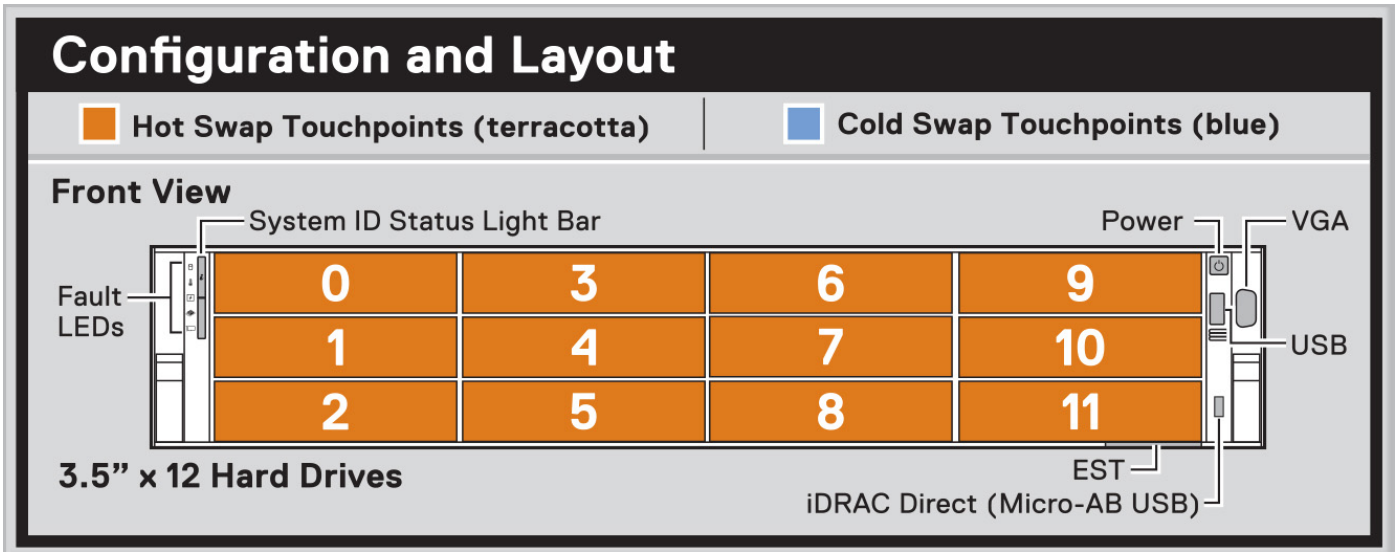


Figure 26. Configuration and layout for 3.5-inch drive system

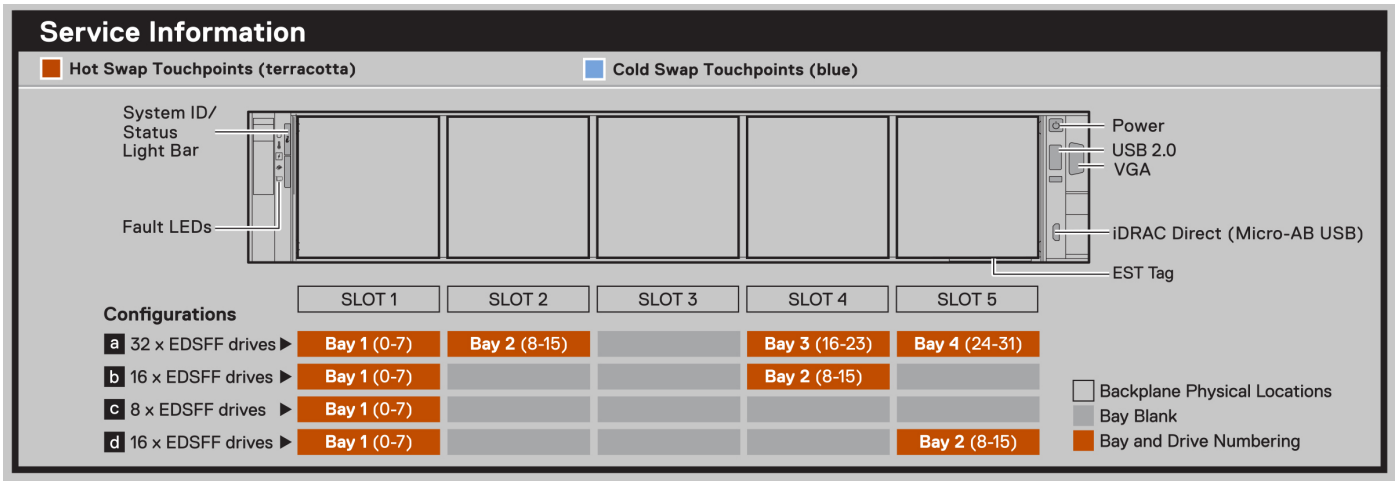


Figure 27. Configuration and layout for EDSFF E3.S drive system

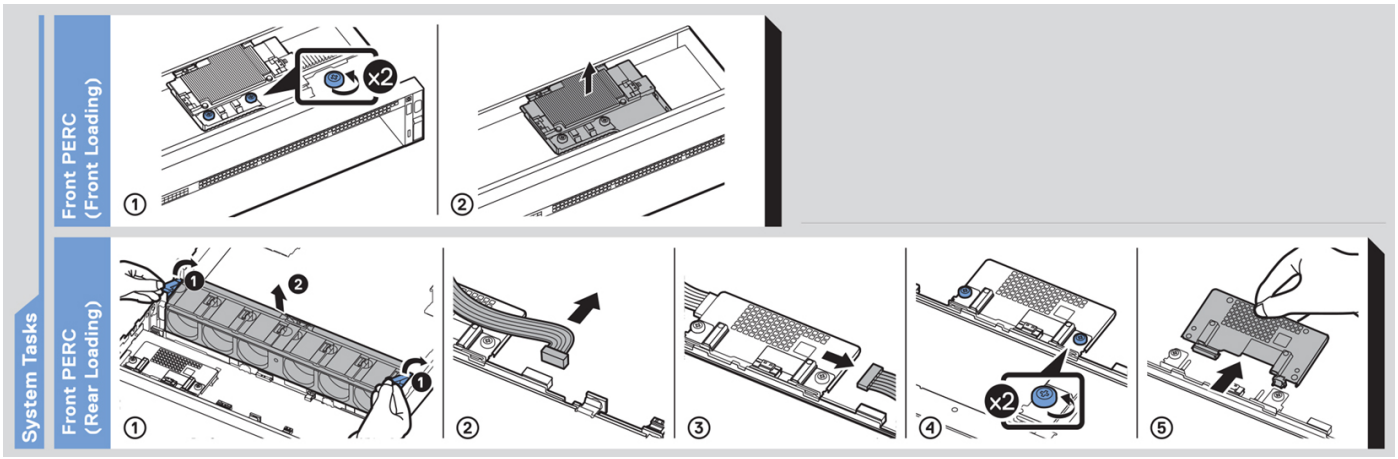


Figure 28. System tasks

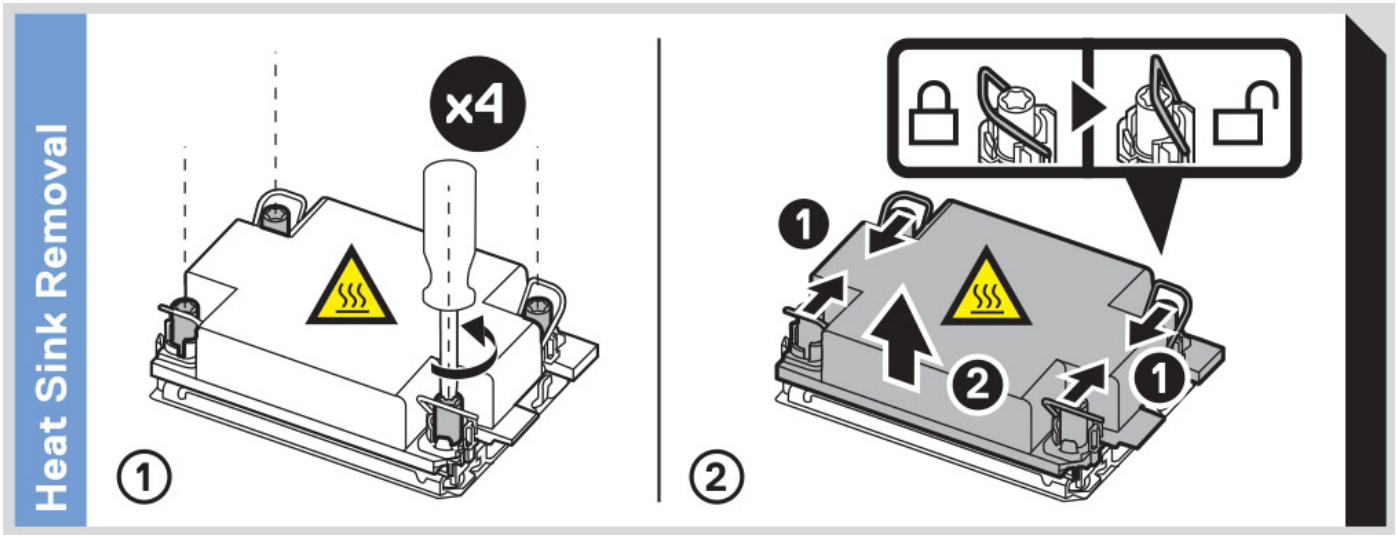


Figure 29. Heat sink

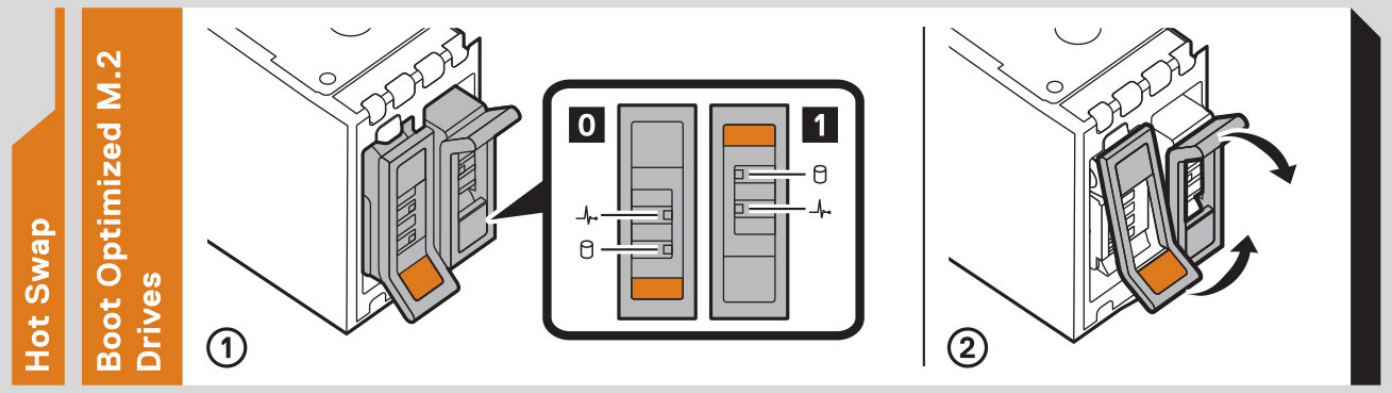


Figure 30. BOSS-N1

Figure 31. EDSFF E3.S drive

Figure 32. Caution

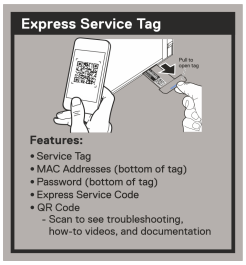


Figure 33. Express service tag

Rail sizing and rack compatibility matrix

For specific information about the rail solutions compatible with your system, see the Dell Enterprise Systems Rail Sizing and Rack Compatibility Matrix.

The document provides the information that is listed below:

- Specific details about rail types and their functionalities.
- Rail adjustability range for various types of rack mounting flanges.
- Rail depth with and without cable management accessories.

- Types of racks that are supported for various types of rack mounting flanges.

3

Technical specifications

The technical and environmental specifications of your system are outlined in this section.

Topics:

Chassis dimensions

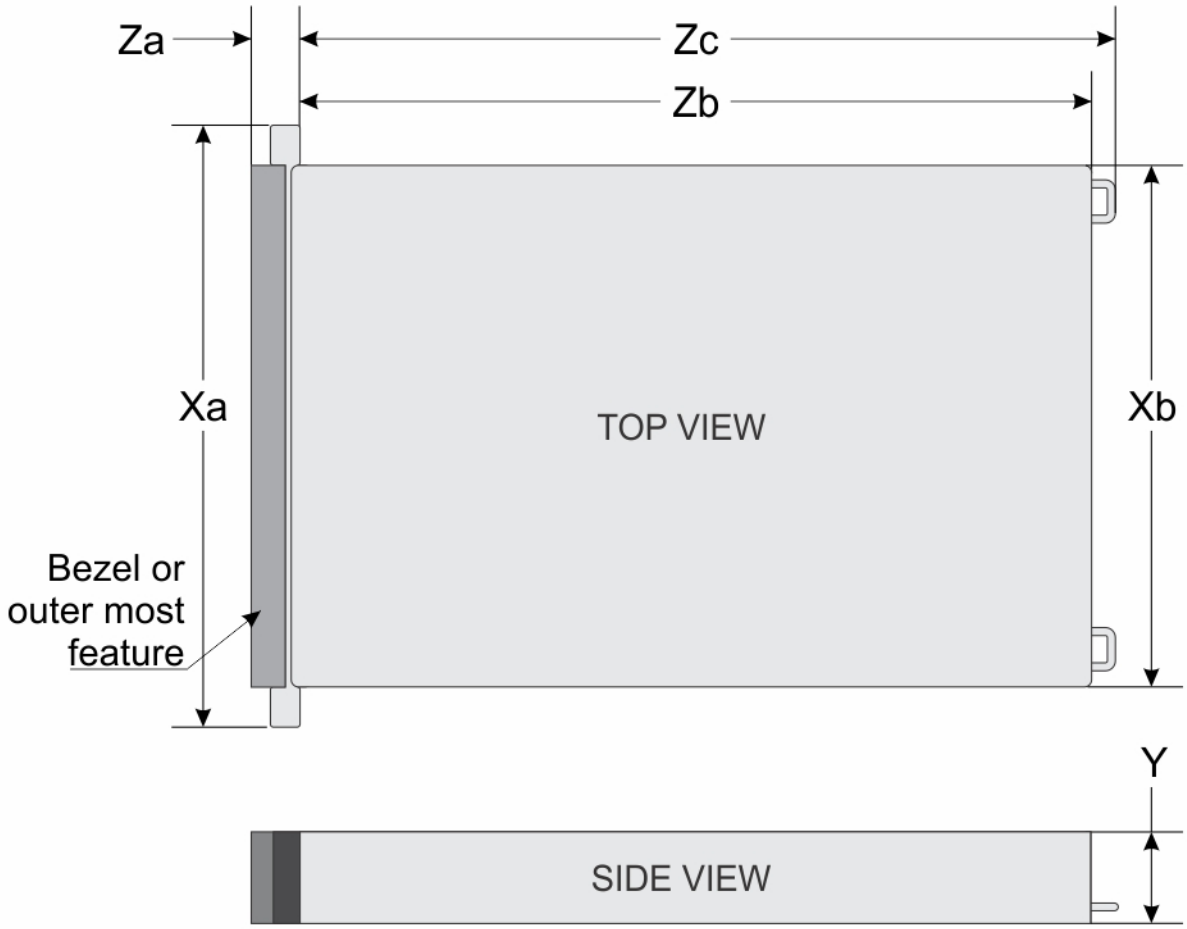


Figure 34. Chassis dimensions

Table 10. PowerEdge R760 chassis dimensions

Xa	Xb	Y	Za	Zb	Zc
482.0 mm (18.97 inches)	434.0 mm (17.08 inches)	86.8 mm (3.41 inches)	35.84 mm (1.41 inches) With bezel 22.0 mm (0.86 inches) Without bezel	700.7 mm (27.58 inches) Ear to rear wall	736.29 mm (28.98 inches) Ear to PSU handle

NOTE: Zb is the nominal rear wall external surface where the system board I/O connectors reside.

System weight

Table 11. PowerEdge R760 system weight

System configuration	Maximum weight (with all drives/SSDs)
A server with fully populated drives	36.1 kg (79.58 lbs)
A server without drives and PSU installed	25.1 kg (55.33 lbs)

Processor specifications

Table 12. PowerEdge R760 processor specifications

Supported processor	Number of processors supported
4th Gen Intel® Xeon® Scalable or Intel® Xeon® Max Processors or 5th Gen Intel® Xeon® Scalable Processors	Up to two

Table 13. Minimum Firmware version requirement for 4th Gen Intel® Xeon® Scalable Processors

Processors	iDRAC	BIOS	CPLD
8462Y+	6.10.39.00	1.2.1	1.0.5
6458Q			
6448Y			
6444Y			
6442Y			
6438Y+			
6438N			
6438M			
6434			
6428N			
6426Y			
6421N			
5420+			
5418Y			
5418N			
5416S			
5415+			
5412U			
5411N			
4416+			
4410Y			
3408U			
9480	6.10.80.00	1.3.2	1.0.5
9470			
9460			
9462			

Table 14. Minimum Firmware version requirement for 5th Gen Intel® Xeon® Scalable Processors

Processors	iDRAC	BIOS	CPLD
5th Gen Intel® Xeon® Scalable Processors	7.10.05.00	2.0.0	N/A

PSU specifications

The PowerEdge R760 system supports up to two AC or DC power supply units (PSUs).

Table 15. PSU specifications

PSU	Class	Heat dissipation (maximum) (BTU/hr)	Frequency (Hz)	AC Voltage			DC Voltage			Current (A)
				200—240 V	100—120 V	277 V	240 V	- (48—60) V	336 V	
700 W mixed mode HLAC	Titanium	2625	50/60	700 W	N/A	N/A	N/A	N/A	N/A	4.1
	N/A	2625	N/A	N/A	N/A	N/A	700 W	N/A	N/A	3.4
800 W mixed mode	Platinum	3000	50/60	800 W	800 W	N/A	N/A	N/A	N/A	9.2—4.7
	N/A	3000	N/A	N/A	N/A	N/A	800 W	N/A	N/A	3.8
1100 W mixed mode	Titanium	4100	50/60	1100 W	1050 W	N/A	N/A	N/A	N/A	12—6.3
	N/A	4100	N/A	N/A	N/A	N/A	1100 W	N/A	N/A	5.2
1400 W mixed mode	Platinum	5250	50/60	1400 W	1050 W	N/A	N/A	N/A	N/A	12—8
	N/A	5250	N/A	N/A	N/A	N/A	1400 W	N/A	N/A	6.6
1400 W mixed mode 277 Vac and HVDC	Titanium	5250	50/60	N/A	N/A	1400 W	N/A	N/A	N/A	5.8
		5250	N/A	N/A	N/A	N/A	N/A	N/A	1400 W	5.17
1800 W mixed mode HLAC	Titanium	6750	50/60	1800	N/A	N/A	N/A	N/A	N/A	10
	N/A	6750	N/A	N/A	N/A	N/A	1800 W	N/A	N/A	8.2
2400 W mixed mode	Platinum	9000	50/60	2400 W	1400 W	N/A	N/A	N/A	N/A	16—13.5
	N/A	9000	N/A	N/A	N/A	N/A	2400 W	N/A	N/A	11.2
2800 W mixed mode HLAC	Titanium	10500	50/60	2800 W	N/A	N/A	N/A	N/A	N/A	15.6
	N/A	10500	N/A	N/A	N/A	N/A	2800 W	N/A	N/A	13.6
1100 W -48 V DC	N/A	4265	N/A	N/A	N/A	N/A	N/A	1100 W	N/A	27
3200 W mixed mode 277 Vac and HVDC	Titanium	12000	50/60	N/A	N/A	3200 W	N/A	N/A	N/A	13
		12000	N/A	N/A	N/A	N/A	N/A	N/A	3200 W	11.5

NOTE: Heat dissipation is calculated using the PSU wattage rating.

NOTE: When selecting or upgrading the system configuration, to ensure optimum power utilization, verify the system power consumption with the Enterprise Infrastructure Planning Tool available at calc.

NOTE: If a system with AC 2400 W PSUs operates at low line 100-120 Vac, then the power rating per PSU is degraded to 1400 W.

NOTE: If a system with AC 1400 W or 1100 W PSUs operates at low line 100-120 Vac, then the power rating per PSU is degraded to 1050 W.

NOTE:

- HLAC stands for High-Line AC, with a range of 200 - 240 V AC.
- HVDC stands for High-Voltage DC, with 336 V DC.

Figure 35. PSU power cables

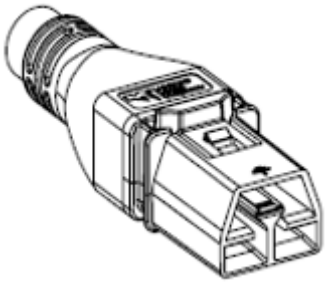


Figure 36. 277VAC/HVDC power cable

Table 16. PSU power cables

Form factor	Output	Power cable
Redundant 60 mm	700 W mixed mode HLAC	C13
	800 W mixed mode	C13
	1100 W mixed mode	C13
	1400 W mixed mode	C13
	1400 W mixed mode 277 Vac and HVDC	277VAC/HVDC
	1800 W mixed mode HLAC	C15
Redundant 86 mm	2400 W mixed mode	C19
	2800 W mixed mode HLAC	C21
	3200 W mixed mode 277 Vac and HVDC	277VAC/HVDC

NOTE: C19 power cable combined with C20 to C21 jumper power cable can be used to adapt 2800 W PSU.

NOTE: C13 power cable combined with C14 to C15 jumper power cable can be used to adapt 1800 W PSU.

Supported operating systems

The PowerEdge R760 system supports the following operating systems:

- Canonical Ubuntu Server LTS
- Microsoft Windows Server with Hyper-V
- Red Hat Enterprise Linux
- SUSE Linux Enterprise Server
- VMware ESXi

For more information, go to Operating System Manuals.

Cooling fan specifications

Cooling options

The PowerEdge R760 requires various cooling components that are based on processor TDP, storage modules, rear drives, and GPU to maintain optimum thermal performance.

The PowerEdge R760 offers two types of cooling options:

- Air cooling
- Direct Liquid Cooling (DLC) (optional)

Cooling fan specifications

The PowerEdge R760 system system supports up to six standard (STD), High performance Silver (HPR Silver) grade , or High performance Gold (HPR Gold) grade cooling fans.

Table 17. Cooling fan specifications

Fan type	Abbreviation	Label color	Label image
Standard (STD) fans	STD	No label	
High performance Silver (HPR Silver) fans	HPR Silver	Silver	
High performance Gold (HPR Gold) fans	HPR Gold	Gold	

NOTE: See the Thermal restriction matrix for required fan support with air cooled and DLC configurations.

System battery specifications

The PowerEdge R760 system uses one CR 2032 3.0 V lithium coin cell battery.

Expansion card riser specifications

The PowerEdge R760 system supports up to eight PCI express (PCIe) slots (six full lengths and two low profiles) on the system board.

Table 18. Expansion card slots supported on the system board

PCIe slot	With Regular shroud	With GPGPU shroud	R1B	R1P	R1Q	R1R	R2A	R3A	R3B	R4B	R4P	R4Q	R4R
Slot 1	Full height - Half length	Full height - Full length	x8	-	x8 (Gen5)	x16	-	-	-	-	-	-	-
Slot 2	Full height - Half length	Full height - Full length	x8	x16 (Gen 5) (Double width GPU)	x8 (Gen5)	x16 (Gen 5)	-	-	-	-	-	-	-
Slot 3	Low profile - Half length	Low profile - Half length	-	-	-	-	x16	-	-	-	-	-	-
Slot 4	Full height - Half length	Full height - Half length	-	-	-	-	-	-	x8	-	-	-	-
Slot 5	Full height - Half length	Full height - Full length	-	-	-	-	-	x16	x8	-	-	-	-
Slot 6	Low profile - Half length	Low profile - Half length	-	-	-	-	x16	-	-	-	-	-	-
Slot 7	Full height - Half length	Full height - Full length	-	-	-	-	-	-	-	x8	x16 (Gen5) (Double width GPU)	x8 (Gen5)	-
Slot 7 SNAPI	Full height- Half length	Full height - Full length	-	-	-	-	-	-	-	-	-	-	x8+x8 (Gen5)
Slot 8	Full height -	Full height -	-	-	-	-	-	-	-	x8	-	x8 (Gen5)	x8 (Gen5)

Table 18. Expansion card slots supported on the system board (continued)

PCIe slot	With Regular shroud	With GPGPU shroud	R1B	R1P	R1Q	R1R	R2A	R3A	R3B	R4B	R4P	R4Q	R4R
	Half length	Half length											

Memory specifications

The PowerEdge R760 system supports the following memory specifications for optimized operation.

Table 19. Memory specifications for 4th Gen Intel® Xeon® Scalable or Intel® Xeon® Max Processors

DIMM type	DIMM rank	DIMM capacity	Single processor		Dual processors	
			Minimum system capacity	Maximum system capacity	Minimum system capacity	Maximum system capacity
DDR5 RDIMM	Single rank	16 GB	16 GB	256 GB	32 GB	512 GB
	Dual rank	32 GB	32 GB	512 GB	64 GB	1 TB
	Dual rank	64 GB	64 GB	1 TB	128 GB	2 TB
	Quad rank	128 GB	128 GB	2 TB	256 GB	4 TB
	Octa rank	256 GB	256 GB	4 TB	512 GB	8 TB

Table 20. Memory module sockets

Memory module sockets	Rated DIMM speed
32 (288-pin)	4800 MT/s

NOTE: The processor may reduce the performance of the rated DIMM speed.

Table 21. Memory specifications for 5th Gen Intel® Xeon® Scalable Processors

DIMM type	DIMM rank	DIMM capacity	Single processor		Dual processors	
			Minimum system capacity	Maximum system capacity	Minimum system capacity	Maximum system capacity
DDR5 RDIMM	Single rank	16 GB	16 GB	256 GB	32 GB	512 GB
	Dual rank	32 GB	32 GB	512 GB	64 GB	1 TB
	Dual rank	64 GB	64 GB	1 TB	128 GB	2 TB
	Dual rank	96 GB	96 GB	1.5 TB	192 GB	3 TB
	Quad rank	128 GB	128 GB	2 TB	256 GB	4 TB
	Octa rank	256 GB	256 GB	4 TB	512 GB	8 TB

NOTE: DDR4 memories are not supported in the R760.

Table 22. Memory module sockets

Memory module sockets	Rated DIMM speed
32 (288-pin)	5600 MT/s

NOTE: The processor may reduce the performance of the rated DIMM speed.

NOTE: Memory DIMM slots are not hot pluggable.

Storage controller specifications

The PowerEdge R760 system supports the following controller cards:

Table 23. Storage controller cards

Supported storage controller cards
Internal controllers • PERC H965i • PERC H755 • PERC H755N • PERC H355
External controllers • PERC H965e
Internal Boot • Boot Optimized Storage Subsystem (BOSS-N1): HWRAID 2 x M.2 NVMe SSD • USB
Software RAID • S160
SAS Host Bus Adapters (HBA) non-RAID • HBA355e • HBA355i • HBA465i

Drives

The PowerEdge R760 system supports:

- 12 x 3.5-inch hot-swappable SAS or SATA drives
- 8 x 2.5-inch hot-swappable SAS, SATA, or NVMe drives
- 16 x 2.5-inch hot-swappable SAS, SATA, or NVMe drives
- 24 x 2.5-inch hot-swappable SAS or SATA, or NVMe drives
- 16 x EDSFF E3.S hot-swappable NVMe drives
- 2 x 2.5-inch rear hot-swappable SAS, SATA, or NVMe drives
- 4 x 2.5-inch rear hot-swappable SAS, SATA, or NVMe drives
- 4 x EDSFF E3.S rear hot-swappable NVMe drives

NOTE: For more information about how to hot swap NVMe PCIe SSD U.2 device, see the *Dell Express Flash NVMe PCIe SSD User's Guide* at Dell Support **> Browse all products** > **Infrastructure** > **Data Center Infrastructure** > **Storage Adapters & Controllers** > **Dell PowerEdge Express Flash NVMe PCIe SSD** > **Select This Product** > **Documentation** > **Manuals and Documents**.

Ports and connectors specifications

USB ports specifications

Table 24. PowerEdge R760 USB specifications

Front		Rear		Internal (optional)	
USB port type	**No. of ports**	**USB port type**	**No. of ports**	**USB port type**	**No. of ports**
USB 2.0-compliant port	One	USB 2.0-compliant port	One	Internal USB 3.0-compliant port	One
iDRAC Direct port (Micro-AB USB 2.0-compliant port)	One	USB 3.0-compliant port	One		

NOTE: The micro USB 2.0 compliant port can only be used as an iDRAC Direct or a management port.

NIC port specifications

The PowerEdge R760 system supports up to two Network Interface Controller (NIC) ports embedded on the LAN on Motherboard (LOM) card and up to four ports integrated on the Open Compute Project (OCP) NIC card.

Table 25. NIC port specification for the system

Feature	Specifications
LOM card (optional)	1 GbE x 2
OCP NIC card (OCP NIC 3.0) (optional)	1GbE x 4, 10 GbE x 2, 10 GbE x 4, 25 GbE x 2, 25 GbE x 4, 100GbE x 2
Management Interface Card (MIC) to support Dell Data Processing Unit (DPU) card (optional)	25 GbE x 2, 100 GbE x 2 or 200 GbE x 2

NOTE: The system allows either LOM card or an OCP NIC card or both to be installed in the system.

NOTE: On the MS system board, the supported OCP NIC PCIe width is x8; when x16 PCIe width is installed, it is downgraded to x8.

NOTE: A 100 GbE OCP NIC card of PCIe width x16 can be used by connecting the OCP NIC cable from SL11_CPU1_PB7 to SL13_CPU1_PB7 on the MAX system board.

NOTE: For storage configurations that already use the SL11_CPU1_PB7 or SL13_CPU1_PB7 connector on the Max system board, there is a restriction on supporting OCP NIC cable.

NOTE: The system allows either LOM card or MIC card to be installed in the system.

Serial connector specifications

The PowerEdge R760 system supports one serial port on the system board, which is Data Terminal Equipment (DTE), 16550-compliant.

The serial connector is installed as default on the system board.

VGA ports specifications

The PowerEdge R760 system supports DB-15 VGA port on front panel and on rear I/O board (optional for Direct Liquid Cooling configuration).

Video specifications

The PowerEdge R760 system supports integrated Matrox G200 graphics controller with 16 MB of video frame buffer.

Table 26. Supported video resolution options

Resolution	Refresh rate (Hz)	Color depth (bits)
1024 x 768	60	8, 16, 32
1280 x 800	60	8, 16, 32
1280 x 1024	60	8, 16, 32
1360 x 768	60	8, 16, 32
1440 x 900	60	8, 16, 32
1600 x 900	60	8, 16, 32
1600 x 1200	60	8, 16, 32
1680 x 1050	60	8, 16, 32
1920 x 1080	60	8, 16, 32
1920 x 1200	60	8, 16, 32

Environmental specifications

NOTE: For additional information about environmental certifications, refer to the *Product Environmental Datasheet* located with the *Documentation* on Dell Support.

Table 27. Continuous Operation Specifications for ASHRAE A2

Temperature	Specifications
Allowable continuous operations	
Temperature range for altitudes <= 900 m (<= 2953 ft)	10–35°C (50–95°F) with no direct sunlight on the equipment
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 80% RH with 21°C (69.8°F) maximum dew point
Operational altitude de-rating	Maximum temperature is reduced by 1°C/300 m (1.8°F/984 Ft) above 900 m (2953 Ft)

Table 28. Continuous Operation Specifications for ASHRAE A3

Temperature	Specifications	
Allowable continuous operations		
Temperature range for altitudes <= 900 m (<= 2953 ft)	5–40°C (41–104°F) with no direct sunlight on the equipment	
	Excursion Limited Operation	5-35°C (41-95°F) Continuous Operation
		35-40°C (95-104°F) 10% Annual Runtime

Table 28. Continuous Operation Specifications for ASHRAE A3 (continued)

Temperature	Specifications
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 85% RH with 24°C (75.2°F) maximum dew point
Operational altitude de-rating	Maximum temperature is reduced by 1°C/175 m (1.8°F/574 Ft) above 900 m (2953 Ft)

Table 29. Continuous Operation Specifications for ASHRAE A4

Temperature	Specifications	
Allowable continuous operations		
Temperature range for altitudes <= 900 m (<= 2953 ft)	5–45°C (41–113°F) with no direct sunlight on the equipment	
	Excursion Limited Operation	5-35°C (41-95°F) Continuous Operation
		35-40°C (95-104°F) 10% Annual Runtime
		40-45°C (104-113°F) 1% Annual Runtime
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 90% RH with 24°C (75.2°F) maximum dew point	
Operational altitude de-rating	Maximum temperature is reduced by 1°C/125 m (1.8°F/410 Ft) above 900 m (2953 Ft)	

Table 30. Common Environmental Specifications for ASHRAE A2, A3 and A4

Temperature	Specifications
Allowable continuous operations	
Maximum temperature gradient (applies to both operation and non-operation)	20°C in an hour* (36°F in an hour) and 5°C in 15 minutes (9°F in 15 minutes), 5°C in an hour* (9°F in an hour) for tape hardware **NOTE:** * - Per ASHRAE thermal guidelines for tape hardware, these are not instantaneous rates of temperature change.
Non-operational temperature limits	-40 to 65°C (-40 to 149°F)
Non-operational humidity limits	5% to 95% RH with 27°C (80.6°F) maximum dew point
Maximum non-operational altitude	12,000 meters (39,370 feet)
Maximum operational altitude	3,050 meters (10,006 feet)

Table 31. Maximum vibration specifications

Maximum vibration	Specifications
Operating	0.21 G_{rms} at 5 Hz to 500 Hz for 10 minutes (all operation orientations)
Storage	1.88 G_{rms} at 10 Hz to 500 Hz for 15 minutes (all six sides tested)

Table 32. Maximum shock pulse specifications

Maximum shock pulse	Specifications
Operating	Six consecutively executed shock pulses in the positive and negative x, y, and z axis of 6 G for up to 11 ms
Storage	Six consecutively executed shock pulses in the positive and negative x, y, and z axis (one pulse on each side of the system) of 71 G for up to 2 ms

Particulate and gaseous contamination specifications

The following table defines the limitations that help avoid any equipment damage or failure from particulates and gaseous contamination. If the levels of particulates or gaseous pollution exceed the specified limitations and result in equipment damage or failure, you may need to rectify the environmental conditions. Remediation of environmental conditions is the responsibility of the customer.

Table 33. Particulate contamination specifications

Particulate contamination	Specifications
Air filtration	Data center air filtration as defined by ISO Class 8 per ISO 14644-1 with a 95% upper confidence limit **NOTE:** This condition applies to data center environments only. Air filtration requirements do not apply to IT equipment designed to be used outside a data center, in environments such as an office or factory floor. **NOTE:** Air entering the data center must have MERV11 or MERV13 filtration.
Conductive dust	Air must be free of conductive dust, zinc whiskers, or other conductive particles **NOTE:** This condition applies to data center and non-data center environments.
Corrosive dust	• Air must be free of corrosive dust • Residual dust present in the air must have a deliquescent point less than 60% relative humidity **NOTE:** This condition applies to data center and non-data center environments.
Walk-Up Edge Data Center or Cabinet (sealed, closed loop environment)	Filtration is not required for cabinets that are anticipated to be opened 6 times or less per year. Class 8 per ISO 1466-1 filtration as defined above is required otherwise **NOTE:** In environments commonly above ISA-71 Class G1 or that may have known challenges, special filters may be required.

Table 34. Gaseous contamination specifications

Gaseous contamination	Specifications
Copper coupon corrosion rate	<300 Å/month per Class G1 as defined by ANSI/ISA71.04-2013
Silver coupon corrosion rate	<200 Å/month as defined by ANSI/ISA71.04-2013

Particulate and gaseous contamination specifications

The following table defines the limitations that help avoid any equipment damage or failure from particulates and gaseous contamination. If the levels of particulates or gaseous pollution exceed the specified limitations and result in equipment damage or failure, you must rectify the environmental conditions. Remediation of environmental conditions is the responsibility of the customer.

Table 35. Particulate contamination specifications

Particulate contamination	Specifications
Air filtration: Conventional Data Center only	Data center air filtration as defined by ISO Class 8 per ISO 14644-1 with a 95% upper confidence limit **NOTE:** Filtering room air with a MERV8 filter, as specified in ANSI/ASHRAE Standard 127, is a recommended method for achieving the necessary environmental conditions.

Table 35. Particulate contamination specifications (continued)

Particulate contamination	Specifications
	NOTE: Air entering the data center must have MERV11 or MERV13 filtration. **NOTE:** This condition applies to data center environments only. Air filtration requirements do not apply to IT equipment designed to be used outside a data center, in environments such as an office or factory floor.
Walk-Up Edge Data Center or Cabinet (sealed, closed loop environment)	Filtration is not required for cabinets that are anticipated to be opened six times or less per year. Class 8 per ISO 1466-1 filtration as defined above is required otherwise. **NOTE:** In environments commonly above ISA-71 Class G1 or that may have known challenges, special filters may be required.
Conductive dust: data center and non-data center environments	Air must be free of conductive dust, zinc whiskers, or other conductive particles. **NOTE:** Conductive dust, which can interfere with equipment operation, can originate from various sources, including manufacturing processes and zinc whiskers that may develop on the plating of raised floor tiles. **NOTE:** This condition applies to data center and non-data center environments.
Corrosive dust: data center and non-data center environments	• Air must be free of corrosive dust. • Residual dust present in the air must have a deliquescent point less than 60% relative humidity. **NOTE:** This condition applies to data center and non-data center environments.

Table 36. Gaseous contamination specifications

Gaseous contamination	Specifications	Notes
Copper coupon corrosion rate	ISA-71 Class G1: <300 Å/month	Per ANSI/ISA71.04
Silver coupon corrosion rate	ISA-71 Class G1: <200 Å/month	Per ANSI/ISA71.04

Thermal restriction matrix

Table 37. Processor and heat sink matrix

Heat sink	Processor TDP
STD HSK	≤ 165 W (supports only 2.5-inch drives and non-GPU configuration)
2U HPR HSK	125 W–250 W (supports 3.5-inch drives and non-GPU configuration)
	165 W–350 W (supports 2.5-inch drives and non-GPU configuration)
L-type HSK	Supports all GPU/FPGA configurations

NOTE: All GPU/FGPA cards require 1U L-type HSK and GPU shroud.

Table 38. Label reference

Label	Description
STD	Standard
HPR (Silver)	High performance Silver (HPR Silver) fan
HPR (Gold)	High performance Gold (HPR Gold) fan
HSK	Heat sink
LP	Low profile
FH	Full height
DLC	Direct Liquid Cooling

NOTE: The ambient temperature of the configuration is determined by the critical component in that configuration. For example, if the processor's supported ambient temperature is 35°C (95°F), the DIMM is 35°C (95°F), and the GPU is 30°C (86°F), the combined configuration can only support 30°C (86°F).

Thermal restriction matrix for 4th Gen Intel® Xeon® Scalable or Intel® Xeon® Max Processors

Table 39. Thermal restriction matrix for air cooled configuration

Configuration				No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS		16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	12 x 3.5-inch		Ambient temperature
Rear storage				No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	
CPU TDP/cTDP		Cores	T-Case max center (°C)	Fan								HPR GOLD fan 70%^		
3408U	125 W[1]	8	79	STD	STD	STD	STD	STD	HPR SLVR	STD	HPR GOLD	HPR SLVR	HPR GOLD	35°C (95°F)
5415+	150 W[1]	8	78	STD	STD	STD	STD	STD	HPR SLVR	STD	HPR GOLD	HPR SLVR	HPR GOLD	35°C (95°F)
4410Y		12	78											
5416S		16	78											
5418N	165 W[1]	24	84	STD	STD	STD	STD	STD	HPR SLVR	STD	HPR GOLD	HPR SLVR	HPR GOLD	35°C (95°F)
5411N		24	84											
4416+		20	82											
6426Y	185 W[1]	16	72	STD	STD	STD	STD	STD	HPR SLVR	HPR SLVR	HPR GOLD	HPR GOLD	HPR GOLD	35°C (95°F)
5418Y		24	80											

Table 39. Thermal restriction matrix for air cooled configuration (continued)

Configuration				No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS		16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	12 x 3.5-inch		Ambient temperature
Rear storage				No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	
CPU TDP/cTDP		Cores	T-Case max center (°C)	Fan								HPR GOLD fan 70%^		
5412U		24	80											
6428N		32	85											
6421N		32	85											
6434	205 W[1]	8	96	STD	STD	STD	STD	STD	HPR SLVR	HPR SLVR	HPR GOLD	HPR GOLD	HPR GOLD	35°C (95°F)
5420+		28	84											
6438Y+		32	76											
6438M		32	84											
6438N		32	84											
6442Y	225 W[1]	24	79	STD	STD	STD	STD	STD	HPR SLVR	HPR SLVR	HPR GOLD	HPR GOLD*	HPR GOLD*	35°C (95°F)
6448Y		32	79											
6444Y	270 W[2]	32	75	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR GOLD	Required DLC	Required DLC	35°C (95°F)
8462Y+	300 W[2]	32	81	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR fan	HPR SLVR	HPR GOLD	Required DLC	Required DLC	35°C (95°F)
6458Q	350 W[2]	32	64	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	35°C (95°F)
6414U	250 W[2]	32	76	STD fan	STD fan	STD fan	STD fan	STD fan	HPR SLVR fan	HPR SLVR	HPR GOLD	HPR GOLD*	HPR GOLD*	35°C (95°F)
6454S	270 W[2]	32	71	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR fan	HPR SLVR	HPR GOLD	Required DLC	Required DLC	35°C (95°F)
6430		32	71											

Table 39. Thermal restriction matrix for air cooled configuration (continued)

Configuration				No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS		16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	12 x 3.5-inch		Ambient temperature
Rear storage				No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	
CPU TDP/cTDP		Cores	T-Case max center (°C)	Fan								HPR GOLD fan 70%^		
8471N	300 W[2]	52	76	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR GOLD	Required DLC	Required DLC	35°C (95°F)
8470N		52	76											
8460Y+		40	75											
8452Y		36	75											
8480+	350 W[2]	56	79	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR GOLD*	Required DLC	Required DLC	35°C (95°F)
8470		52	79											
8468		48	79											
8470Q	350 W[2]	52	57	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	35°C (95°F)
9480	350 W[2]	56	64	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	35°C (95°F)
9470		52	64											
9460	350 W[2]	40	77	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR GOLD*	Required DLC	Required DLC	35°C (95°F)
9462		32	77											

NOTE: The platform supports Maximum (MAX) and Mainstream (MS) system boards.

- [1] supports MS system board (CPU TDP < 250 W)
- [2] supports MAX system board (CPU TDP => 250 W)

NOTE: ^The fan speed in the 3.5-inch chassis is limited to 70% due to the drive dynamic profile.

NOTE: *Supported ambient temperature is 30°C (86°F).

Table 40. Thermal restriction matrix for memory with air cooled configuration (non-GPU)

Configuration		No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS		16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	12 x 3.5-inch	
Rear storage		No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan
DIMM Configuration	2DPC/ Power	STD fan (CPU TDP <= 250 W)					HPR SLVR fan (CPU TDP up to 350 W)	STD fan (CPU TDP <= 165 W)	HPR GOLD fan (CPU TDP up to 350 W)	HPR SLVR fan 70% (CPU TDP up to 165 W)^	
256 GB RDIMM	12.7 W	30°C (86°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)	35°C (95°F)	Required DLC	35°C (95°F)	Required DLC	Required DLC
128 GB RDIMM	8.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	35°C (95°F)	30°C (86°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)
64 GB RDIMM	6.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)
32 GB RDIMM	4.1 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
16 GB RDIMM	3 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
DIMM Configuration	2DPC/ Power	HPR SLVR fan (CPU TDP up to 350 W)							HPR GOLD fan (CPU TDP up to 350 W)	HPR GOLD fan 70% (CPU TDP up to 250 W)	
256 GB RDIMM	12.7 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	Required DLC	Required DLC
128 GB RDIMM	8.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)
64 GB RDIMM	6.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)
32 GB RDIMM	4.1 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)

Table 40. Thermal restriction matrix for memory with air cooled configuration (non-GPU) (continued)

Configuration		No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS		16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	12 x 3.5-inch	
Rear storage		No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan
DIMM Configuration	2DPC/ Power	STD fan (CPU TDP <= 250 W)					HPR SLVR fan (CPU TDP up to 350 W)	STD fan (CPU TDP <= 165 W)	HPR GOLD fan (CPU TDP up to 350 W)	HPR SLVR fan 70% (CPU TDP up to 165 W)^	
16 GB RDIMM	3 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)

NOTE: In 12 x 3.5-inch with rear module configuration, for CPU TDP greater than 270 W and specific Low Temperature-case CPUs are not supported.

NOTE: ^The fan speed in the 3.5-inch chassis is limited to 70% due to the drive dynamic profile.

Table 41. Thermal restriction matrix for rear NVMe drives with air cooled configuration (non-GPU)

Configuration			24 x 2.5-inch SAS		12 x 3.5-inch	
Rear storage			2 x 2.5-inch with rear fan	4 x 2.5-inch with rear fan	2 x 2.5-inch with rear fan	4 x 2.5-inch with rear fan
Drive type	Drives capacity	Power	HPR SLVR fan		HPR GOLD fan 70%	
Kioxia CD7	15.36 TB	19 W	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)
Samsung PM9A3	7.68 TB	14 W	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)
Samsung PM1733	15.36 TB	22 W	30°C (86°F)	30°C (86°F)	N/A	N/A
Samsung PM1733a	15.36 TB	19.7 W	35°C (95°F)	30°C (86°F)	30°C (86°F)	N/A
Samsung PM1735a	12.8 TB	19.8 W	35°C (95°F)	30°C (86°F)	30°C (86°F)	N/A
Redtail	7.68 TB	24.5 W	30°C (86°F)	30°C (86°F)	N/A	N/A
Hynix PE8010	7.68/3.84/1.92 TB	17 W	35°C (95°F)	30°C (86°F)	30°C (86°F)	N/A
Intel P5520	15.36 TB	20 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
Kioxia CM7	30.72 TB	25 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
Kioxia CD8	15.36 TB	19 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
PE8110	7.68 TB	20 W	30°C (86°F)	N/A	N/A	N/A
PE8110	3.84/1.92 TB	20 W	35°C (95°F)	30°C (86°F)	30°C (86°F)	N/A
PS1010	15.36 TB	20 W	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)

Table 41. Thermal restriction matrix for rear NVMe drives with air cooled configuration (non-GPU) (continued)

Configuration			24 x 2.5-inch SAS		12 x 3.5-inch	
Rear storage			2 x 2.5-inch with rear fan	4 x 2.5-inch with rear fan	2 x 2.5-inch with rear fan	4 x 2.5-inch with rear fan
Drive type	Drives capacity	Power	HPR SLVR fan		HPR GOLD fan 70%	
PS1030	12.8 TB	20 W	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)

Table 42. Thermal restriction matrix for GPU configurations

Configuration				No back plane	8 x 2.5-inch NVMe	8 x 2.5-inch NVMe + 8 x 2.5-inch SAS	16 x 2.5-inch SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS	16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe
Rear storage				No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives
CPU TDP/cTDP		Cores	T-Case max center (°C)	HPR GOLD fan with 1U HPR L-Type HSK							
3408U	125 W [1]	8	79	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
5415+	150 W [1]	8	78	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
4410Y		12	78								
5416S		16	78								
5418N	165 W [1]	24	84	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
5411N		24	84								
4416+		20	82								
6426Y	185 W [1]	16	72	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
5418Y		24	80								
5412U		24	80								
6428N		32	85								
6421N		32	85								
6434	205 W [1]	8	96	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (86°F)	30°C (86°F)
5420+		28	84								
6438Y+		32	76								
6438M		32	84								
6438N		32	84								
6442Y	225 W [1]	24	79	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
6448Y		32	79								
6444Y	270 W [2]	32	75	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)

Table 42. Thermal restriction matrix for GPU configurations (continued)

Configuration				No back plane	8 x 2.5-inch NVMe	8 x 2.5-inch NVMe + 8 x 2.5-inch SAS	16 x 2.5-inch SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS	16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe
Rear storage				No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives
CPU TDP/cTDP		Cores	T-Case max center (°C)	HPR GOLD fan with 1U HPR L-Type HSK							
8462Y+	300 W [2]	32	81	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)
6458Q	350 W [2]	32	64	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC
6414U	250 W [2]	32	76	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
6454S	270 W [2]	32	71	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)
6430		32	71								
8471N	300 W [2]	52	76	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)
8470N		52	76								
8460Y+		40	75								
8452Y		36	75								
8480+	350 W [2]	56	79	30°C (86°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)	Required DLC	Required DLC	Required DLC
8470		52	79								
8468		48	79								
8470Q	350 W [2]	52	57	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC
9480	350 W [2]	56	64	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC	Required DLC
9470		52	64								
9460	350 W [2]	40	77	30°C (86°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)	Required DLC	Required DLC	Required DLC
9462		32	77								

NOTE: The platform supports Maximum (MAX) and Mainstream (MS) system boards.

- [1] supports MS system board (CPU TDP < 250 W)
- [2] supports MAX system board (CPU TDP => 250 W)

NOTE: ^The fan speed in the 3.5-inch chassis is limited to 70% due to the drive dynamic profile.

NOTE: *Supported ambient temperature is 30°C (86°F).

NOTE: GPU configuration supports only High performance Gold (HPR Gold) fan.

Table 43. Thermal restriction matrix for memory with air cooled configuration (GPU)

Configuration		No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS *	16 x 2.5-inch or 16 x EDSFF E3.S NVMe **	24 x 2.5-inch SAS*	16 x 2.5-inch SAS + 8 x 2.5-inch NVMe***	24 x 2.5-inch NVMe***
DIMM Configuration	2DPC/ Power	HPR GOLD fan with 1U HPR L-Type HSK						
256 GB RDIMM	12.7 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	Required DLC	Required DLC	Required DLC
128 GB RDIMM	8.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
64 GB RDIMM	6.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
32 GB RDIMM	4.1 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
16 GB RDIMM	3 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)

NOTE: *In 16 x 2.5-inch SAS and 8 x 2.5-inch NVMe configurations, for CPU TDP 350 W supported ambient temperature is 30°C (86°F).

NOTE: **In 16 x 2.5-inch NVMe configuration, for CPU TDP greater than 300 W supported ambient temperature is 30°C (86°F).

NOTE: ***In 24 x 2.5-inch SAS/NVMe configuration and 16 x 2.5-inch SAS + 8 x 2.5-inch NVMe, for CPU TDP 270 W - 300 W and specific Low Temperature-case CPUs supported ambient temperature is 30°C (86°F).

Table 44. Optimized Ecological upgrade thermal restriction matrix for air cooled configuration

Configuration			No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS		16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	12 x 3.5-inch			Ambient temperature
Rear storage			No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	No rear drives	No rear drives	No rear drives	2.5-inch rear drives with rear fan	EDSFF E3.S rear drives with rear fan	
CPU TDP/cTDP		Cores	T-Case max center (°C)	Fan/HSK							HPR GOLD fan 70%^			
5415+	150 W	8	78	STD /2U HPR	STD /2U HPR	STD /2U HPR	STD / 2U HPR	STD /2U HPR	HPR SLVR / 2U HPR	STD / 2U HPR	HPR GOL	HPR SLVR	HPR GOLD /	HPR SLVR / 2U HPR	35° C
4410Y		12	78											

Table 44. Optimized Ecological upgrade thermal restriction matrix for air cooled configuration (continued)

Configuration				No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS		16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	12 x 3.5-inch			Ambient temperature
Rear storage				No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	No rear drives	No rear drives	No rear drives	2.5-inch rear drives with rear fan	EDSFF E3.S rear drives with rear fan	
CPU TDP/cTDP		Cores	T-Case max center (°C)	Fan/HSK								HPR GOLD fan 70%^			
5416S		16	78								D / STD	/2U HPR	2U HPR		(95° F)
5418N/ 5411N	165 W	24	84	STD /2U HPR	STD /2U HPR	STD /2U HPR	STD / 2U HPR	STD /2U HPR	HPR SLVR / 2U HPR	STD / 2U HPR	HPR GOLD / STD	HPR SLVR /2U HPR	HPR GOLD / 2U HPR	HPR SLVR / 2U HPR	35° C (95° F)
4416+		20	82												

NOTE: ^The fan speed in the 3.5-inch chassis is limited to 70% due to the drive dynamic profile.

Thermal restriction matrix for 5th Gen Intel® Xeon® Scalable Processors

Table 45. Thermal restriction matrix for air cooled configuration

Configuration				No back plane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS		16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	12 x 3.5-inch^		Ambient temperature
Rear storage				No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	
CPU TDP/cTDP		Cores	T-Case max center (°C)	Fan										
4509Y	125 W[1]	8	84	STD	STD	STD	STD	STD	HPR SLVR	STD	HPR GOLD	HPR SLVR	HPR GOLD	35°C (95°F)
4510	150 W[1]	12	84	STD	STD	STD	STD	STD	HPR SLVR	STD	HPR GOLD	HPR SLVR	HPR GOLD	35°C (95°F)
4514Y		16	79											
5512U	185 W[1]	28	89	STD	STD	STD	STD	STD	HPR SLVR	HPR SLVR	HPR GOLD	HPR GOLD	HPR GOLD	35°C (95°F)
6534	195 W[1]	8	64	STD	STD	STD	STD	STD	HPR SLVR	HPR SLVR	HPR GOLD	HPR GOLD	HPR GOLD	35°C (95°F)
6526Y		16	82											
6542Y	250 W[1]	24	83	STD	STD	STD	STD	STD	HPR SLVR	HPR SLVR	HPR GOLD	HPR GOLD*	HPR GOLD*	35°C (95°F)
6548Y+		32	83											
6548N		32	83											
8562Y+	300 W [2]	32	81	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR GOLD	Required DLC	Required DLC	35°C (95°F)
8558U	300 W [2]	48	78	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR GOLD	Required DLC	Required DLC	35°C (95°F)
8568Y+	350 W [2]	48	81	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR fan	HPR SLVR fan	HPR GOLD*	Required DLC	Required DLC	35°C (95°F)
8580		60	81											
8592+		64	81											

NOTE: The platform supports Maximum (MAX) and Mainstream (MS) system boards.

- [1] supports MS system board (CPU TDP < 250 W)
- [2] supports MAX system board (CPU TDP ≥ 250 W)

NOTE: *Supported ambient temperature is 30°C (86°F).

NOTE: ^The fan speed in the 3.5-inch chassis is limited to 70% due to the drive dynamic profile.

Table 46. Thermal restriction matrix for memory with air cooled configuration (non-GPU)

Configuration		No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS		16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	12 x 3.5-inch	
Rear storage		No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan
DIMM Configuration	2DPC/ Power	STD fan (CPU TDP <= 250 W)					HPR SLVR fan (CPU TDP up to 350 W)	STD fan (CPU TDP <= 165 W)	HPR GOLD fan (CPU TDP up to 350 W)	HPR SLVR fan 70% (CPU TDP up to 165 W)^	
256 GB RDIMM	12.7 W	30°C (86°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)	35°C (95°F)	Required DLC	35°C (95°F)	Required DLC	Required DLC
128 GB RDIMM	8.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	35°C (95°F)	30°C (86°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)
96 GB RDIMM	8.3 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	35°C (95°F)	30°C (86°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)
64 GB RDIMM	6.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)
32 GB RDIMM	4.1 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
16 GB RDIMM	3 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
DIMM Configuration	2DPC/ Power	HPR SLVR fan (CPU TDP up to 350 W)							HPR GOLD fan (CPU TDP up to 350 W)	HPR GOLD fan 70% (CPU TDP up to 250 W)^	
256 GB RDIMM	12.7 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	Required DLC	Required DLC
128 GB RDIMM	8.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)

Table 46. Thermal restriction matrix for memory with air cooled configuration (non-GPU) (continued)

Configuration		No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS		16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	12 x 3.5-inch	
Rear storage		No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan
DIMM Configuration	2DPC/ Power	STD fan (CPU TDP <= 250 W)					HPR SLVR fan (CPU TDP up to 350 W)	STD fan (CPU TDP <= 165 W)	HPR GOLD fan (CPU TDP up to 350 W)	HPR SLVR fan 70% (CPU TDP up to 165 W)^	
96 GB RDIMM	8.3 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)
64 GB RDIMM	6.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)
32 GB RDIMM	4.1 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
16 GB RDIMM	3 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)

NOTE: ^The fan speed in the 3.5-inch chassis is limited to 70% due to the drive dynamic profile.

Table 47. Supported ambient temperature for processors with GPU

Configuration				No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS	16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe
Rear storage				No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives
CPU TDP/cTDP		Cores	T-Case max center (°C)	Support HPR GOLD fan with 1U HPR L-Type HSK						
4509Y	125 W[1]	8	84	35°C	35°C	35°C	35°C	35°C	35°C	35°C
4510	150 W[1]	12	84	35°C	35°C	35°C	35°C	35°C	35°C	35°C
4514Y		16	79							
5512U	185 W[1]	28	89	35°C	35°C	35°C	35°C	35°C	35°C	35°C
6534	195 W[1]	8	64	35°C	35°C	35°C	35°C	35°C	35°C	35°C

Table 47. Supported ambient temperature for processors with GPU (continued)

Configuration				No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS	16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe
Rear storage				No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives
CPU TDP/cTDP		Cores	T-Case max center (°C)	Support HPR GOLD fan with 1U HPR L-Type HSK						
6526Y		16	82							
6542Y	250 W[1]	24	83	35°C	35°C	35°C	35°C	35°C	35°C	35°C
6548Y+		32	83							
6548N		32	83							
8562Y+	300 W [2]	32	81	35°C	35°C	35°C	35°C	30°C	30°C	30°C
8558U	300 W [2]	48	78	35°C	35°C	35°C	35°C	30°C	30°C	30°C
8568Y+	350 W [2]	48	81	30°C	30°C	30°C	30°C	Required DLC	Required DLC	Required DLC
8580		60	81							
8592+		64	81							

NOTE: The platform supports Maximum (MAX) and Mainstream (MS) system boards.

- [1] supports MS system board (CPU TDP < 250 W)
- [2] supports MAX system board (CPU TDP ≥ 250 W)

NOTE: *Supported ambient temperature is 30°C (86°F).

Table 48. Thermal restriction matrix for memory with air cooled configuration (GPU)

Configuration		No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch NVMe	24 x 2.5-inch SAS	16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe
DIMM Configuration	2DPC/ Power	HPR GOLD fan with 1U HPR L-Type HSK						
256 GB RDIMM	12.7 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	Required DLC	Required DLC	Required DLC
128 GB RDIMM	8.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
96 GB RDIMM	8.3 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
64 GB RDIMM	6.9 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
32 GB RDIMM	4.1 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
16 GB RDIMM	3 W	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)

NOTE: *256 GB RDIMM with 5th Gen Intel® Xeon® Scalable Processors will be supported in the future release.

Common thermal restrictions for both 4th and 5th Gen Intel processors

Table 49. GPU types support thermal restriction for both air cooling and liquid cooling configuration

Configuration	No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and split NVMe-SAS	16 x 2.5-inch NVMe or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS	16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe
Rear storage	**No rear drives**	**No rear drives**	**No rear drives**	**No rear drives**	**No rear drives**	**No rear drives**	**No rear drives**
GPU	**HPR GOLD fan with 1U HPR L-Type HSK**						
A40 (Max 2)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)
Intel PVC (Max 2)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	30°C (86°F)	30°C (86°F)	30°C (86°F)
A100 80 GB (Max 2)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
A16 (Max 2)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
A30 (Max 2)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
A2 (Max 6)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
H100 (Max 2)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
A800 (Max 2)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
L4 (Max 6)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
L40 (Max 2)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
Intel ASM (Max 6)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)
L40S (Max 2)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)	35°C (95°F)

Table 50. Thermal restriction for memory with liquid cooled configuration(non-GPU)

Configuration		No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS		16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	12 x 3.5-inch^		Ambient temperature
Rear storage		No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	No rear drives	No rear drives	No rear drives	2.5-inch or EDSFF E3.S rear drives with rear fan	
DIMM Configuration	Power	Fan										
256 GB RDIMM	12.7 W	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR SLVR	HPR GOLD	HPR GOLD fan	35°C (95°F)
128 GB RDIMM	8.9 W	STD	STD	STD	STD	STD	STD	STD	STD	HPR GOLD	HPR GOLD	35°C (95°F)
96 GB RDIMM	8.3 W	STD	STD	STD	STD	STD	STD	STD	STD	HPR GOLD	HPR GOLD	35°C (95°F)
64 GB RDIMM	6.9 W	STD	STD	STD	STD	STD	STD	STD	STD	HPR GOLD	HPR GOLD	35°C (95°F)
32 GB RDIMM	4.1 W	STD	STD	STD	STD	STD	STD	STD	STD	HPR GOLD	HPR GOLD	35°C (95°F)
16 GB RDIMM	3 W	STD	STD	STD	STD	STD	STD	STD	STD	HPR GOLD	HPR GOLD	35°C (95°F)

NOTE: ^The fan speed in the 3.5-inch chassis is limited to 70% due to the drive dynamic profile.

Table 51. Thermal restriction for memory with liquid cooled configuration(GPU)

Configuration		No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS	16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	Ambient temperature
Rear storage		No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	
DIMM Configuration	Power	Fan							
256 GB RDIMM	12.7 W	HPR GOLD fan							35°C (95°F)
128 GB RDIMM	8.9 W								
96 GB RDIMM	8.3 W								
64 GB RDIMM	6.9 W								

Table 51. Thermal restriction for memory with liquid cooled configuration(GPU) (continued)

Configuration		No backplane	8 x 2.5-inch NVMe	16 x 2.5-inch SAS and Split NVMe-SAS	16 x 2.5-inch or 16 x EDSFF E3.S NVMe	24 x 2.5-inch SAS	16 x 2.5-inch SAS + 8 x 2.5-inch NVMe	24 x 2.5-inch NVMe	Ambient temperature
Rear storage		No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	No rear drives	
DIMM Configuration	Power	Fan							
32 GB RDIMM	4.1 W								
16 GB RDIMM	3 W								

NOTE: *256 GB RDIMM with 5th Gen Intel® Xeon® Scalable Processors will be supported in the future release.

Thermal air restrictions

Table 52. Air cooling configurations thermal restriction for AHSRAE A3 and A4

ASHRAE	A3/40°C (104°F)	A4/45°C (113°F)
PSU	Two PSUs are required in redundant mode. If there is PSU failure, system performance may be reduced.	
PCIe card	Non-Dell qualified peripheral cards and peripheral cards greater than 25 W are not supported.	
GPU/FPGA	Not supported	
DIMM	128 GB, or greater capacity DIMMs are not supported.	
PCIe SSD	Not supported	
Front storage	Not supported in 12 x 3.5-inch SAS configuration.	
Rear storage	Not supported	
Fan	HPR SLVR fans are required.	
Processor	≤ 165 W	≤ 125 W
OCP	Supported with 85°C (185°F) active optic cable.	Supported with 85°C (185°F) active optic cable and cards tier ≤4.
BOSS	BOSS-N1 is supported.	BOS-N1 is not supported.

Table 53. Liquid cooling configurations thermal restriction for AHSRAE A3 and A4

ASHRAE	A3/40°C (104°F)	A4/45°C (113°F)
PSU	Two PSUs are required in redundant mode. If there is PSU failure, system performance may be reduced.	
PCIe card	Non-Dell qualified peripheral cards and peripheral cards greater than 25 W are not supported.	
GPU/FPGA	Not supported	
DIMM	128 GB, or greater capacity DIMMs are not supported.	
PCIe SSD	Not supported	
Front storage	Not supported in 12 x 3.5-inch SAS configuration.	
Rear storage	Not supported	
Fan	HPR SLVR fans are required in 2.5-inch configurations systems.	

Table 53. Liquid cooling configurations thermal restriction for AHSRAE A3 and A4 (continued)

ASHRAE	A3/40°C (104°F)	A4/45°C (113°F)
OCP	Supported with 85°C (185°F) active optic cable.	Supported with 85°C (185°F) active optic cable and cards tier ≤4.
BOSS	BOSS-N1 is supported.	BOSS-N1 is not supported.

4

Initial system setup and configuration

This section describes the tasks for initial setup and configuration of the Dell system. The section also provides general steps to set up the system and the reference guides for detailed information.

Topics:

Setting up the system

Perform the following steps to set up the system:

Steps

1. Unpack the system.
2. Install the system into the rack. For more information, see the rail installation and cable management accessory guides relevant to your rail and cable management solution at PowerEdge manuals.
3. Connect the peripherals to the system and the system to the electrical outlet.
4. Power on the system.

   For more information about setting up the system, see the *Getting Started Guide* that is shipped with your system.

   NOTE: For information about managing the basic settings and features of the system, see the Pre-operating system management applications chapter.

iDRAC configuration

The Integrated Dell Remote Access Controller (iDRAC) is designed to make you more productive as a system administrator and improve the overall availability of Dell servers. iDRAC alerts you to system issues, helps you to perform remote management, and reduces the need for physical access to the system.

Options to set up iDRAC IP address

To enable communication between your system and iDRAC, you must first configure the network settings based on your network infrastructure. The network settings option is set to **DHCP**, by default.

NOTE: For static IP configuration, you must request for the settings at the time of purchase.

You can set up the iDRAC IP address using one of the interfaces in the table below. For information about setting up iDRAC IP address, see the documentation links provided in the table below.

Table 54. Interfaces to set up iDRAC IP address

Interface	Documentation links
iDRAC Settings utility	Integrated Dell Remote Access Controller User's Guide at iDRAC Manuals or for system-specific Integrated Dell Remote Access Controller User's Guide, go to PowerEdge Manuals > **Product Support** page of your system > **Documentation.**

Table 54. Interfaces to set up iDRAC IP address (continued)

Interface	Documentation links
	NOTE: To determine the most recent iDRAC release for your platform and for the latest documentation version, see KB article KB78115.
OpenManage Deployment Toolkit	Dell OpenManage Deployment Toolkit User's Guide available at OpenManage Manuals > OpenManage Deployment Toolkit.
iDRAC Direct	Integrated Dell Remote Access Controller User's Guide at iDRAC Manuals or for system-specific Integrated Dell Remote Access Controller User's Guide, go to PowerEdge Manuals > **Product Support** page of your system > **Documentation**. **NOTE:** To determine the most recent iDRAC release for your platform and for the latest documentation version, see KB article KB78115 .
Lifecycle Controller	Dell Lifecycle Controller User's Guide at iDRAC Manuals or for system-specific Dell Lifecycle Controller User's Guide, go to PowerEdge Manuals > **Product Support** page of your system > **Documentation**. **NOTE:** To determine the most recent iDRAC release for your platform and for the latest documentation version, see KB article KB78115.
Server LCD panel	LCD panel section.
iDRAC Direct and Quick Sync 2 (optional)	Integrated Dell Remote Access Controller User's Guide at iDRAC Manuals or for system-specific Integrated Dell Remote Access Controller User's Guide, go to PowerEdge Manuals > **Product Support** page of your system > **Documentation**. **NOTE:** To determine the most recent iDRAC release for your platform and for the latest documentation version, see KB article KB78115.

NOTE: To access iDRAC, ensure that you connect the ethernet cable to the iDRAC dedicated network port or use the iDRAC Direct port by using the micro USB (type AB) cable. You can also access iDRAC through the shared LOM mode, if you have opted for a system that has the shared LOM mode enabled.

Options to log in to iDRAC

To log in to the iDRAC Web User Interface, open a browser and enter the IP address.

You can log in to iDRAC as:

- iDRAC user
- Microsoft Active Directory user
- Lightweight Directory Access Protocol (LDAP) user

In the login screen displayed, if you have opted for secure default access to iDRAC, the default username is `root` and enter the iDRAC secure default password available on back of the Information Tag. If you opted for legacy password, use the iDRAC legacy username and password - `root` and `calvin`, the iDRAC default password will be blank on the information tag. Then you will be prompted and required to create a password of your choice before proceeding. You can also log in by using your Single Sign-On or Smart Card.

NOTE: Ensure that you change the default username and password after setting up the iDRAC IP address.

For more information about logging in to the iDRAC and iDRAC licenses, see the latest Integrated Dell Remote Access Controller User's Guide

NOTE: To determine the most recent iDRAC release for your platform and for latest documentation version, see KB article KB78115.

You can also access iDRAC using command-line protocol - RACADM. For more information, see the Integrated Dell Remote Access Controller RACADM CLI Guide.

You can also access iDRAC using automation tool - Redfish API. For more information, see the Integrated Dell Remote Access Controller User's Guide Redfish API Guide.

Resources to install operating system

If the system is shipped without an operating system, you can install a supported operating system by using one of the resources provided in the table below. For information about how to install the operating system, see the documentation links provided in the table below.

Table 55. Resources to install the operating system

Resource	Documentation links
iDRAC	Integrated Dell Remote Access Controller User's Guideor for system specific Integrated Dell Remote Access Controller User's Guide, go to PowerEdge Manuals > **Product Support** page of your system > **Documentation**. **NOTE:** To determine the most recent iDRAC release for your platform and for latest documentation version, see KB article at KB78115.
Lifecycle Controller	Dell Lifecycle Controller User's Guide at iDRAC Manualsor for system specific Dell Lifecycle Controller User's Guide , go to PowerEdge Manuals > **Product Support** page of your system > **Documentation**. Dell recommends using Lifecycle Controller to install the OS, since all required drivers are installed on the system. **NOTE:** To determine the most recent iDRAC release for your platform and for latest documentation version, see KB article at KB78115.
OpenManage Deployment Toolkit	OpenManage Manuals > OpenManage Deployment Toolkit
Dell certified VMware ESXi	Virtualization solutions

NOTE: For more information about installation and how-to videos for operating systems supported on PowerEdge systems, see Supported Operating Systems for Dell PowerEdge systems.

Options to download drivers and firmware

You can download the firmware from the Dell support site. For information about downloading firmware, see the Downloading drivers and firmware section.

You can also choose any one of the following options to download the firmware. For information about how to download the firmware, see the documentation links provided in the table below.

Table 56. Options to download firmware

Option	Documentation link
Using Integrated Dell Remote Access Controller Lifecycle Controller (iDRAC with LC)	iDRAC Manuals
Using Dell Repository Manager (DRM)	OpenManage Manuals
Using Dell Server Update Utility (SUU)	OpenManage Manuals
Using Dell OpenManage Deployment Toolkit (DTK)	OpenManage Manuals
Using iDRAC virtual media	iDRAC Manuals

Options to download and install OS drivers

You can choose any one of the following options to download and install OS drivers. For information about how to download or install OS drivers, see the documentation links provided in the table below.

Table 57. Options to download and install OS drivers

Option	Documentation
Dell support site	Downloading drivers and firmware section.
iDRAC virtual media	Integrated Dell Remote Access Controller User's Guide or for system specific, go to Integrated Dell Remote Access Controller User's Guide > **Product Support** page of your system > **Documentation** . **NOTE:** To determine the most recent iDRAC release for your platform and for latest documentation version, see Integrated Dell Remote Access Controller Release Notes.

Downloading drivers and firmware

It is recommended that you download and install the latest BIOS, drivers, and systems management firmware on the system.

Prerequisites

Ensure that you clear the web browser cache before downloading the drivers and firmware.

Steps

1. Go to Drivers.
2. Enter the Service Tag of the system in the **Enter a Dell Service Tag, Dell Product ID or Model** field, and then press Enter.

   NOTE: If you do not have the Service Tag, click **Browse all products**, and navigate to your product.

3. On the displayed product page, click **Drivers & Downloads**.
   On the **Drivers & Downloads** page, all drivers that are applicable to the system are displayed.
4. Download the drivers to a USB drive, CD, or DVD.

5

Pre-operating system management applications

You can manage basic settings and features of a system without booting to the operating system by using the system firmware.

Options to manage the pre-operating system applications

You can use any one of the following options to manage the pre-operating system applications:

- System Setup
- Dell Lifecycle Controller
- Boot Manager
- Preboot Execution Environment (PXE)

Topics:

System Setup

Using the **System Setup** option, you can configure the BIOS settings, iDRAC settings, and device settings of the system.

You can access system setup by using any one of the following interfaces:

- Graphical User interface — To access go to iDRAC Dashboard, click **Configurations** > **BIOS Settings**.
- Text browser — To enable the text browser, use the Console Redirection.

To view **System Setup**, power on the system, press F2, and click **System Setup Main Menu**.

NOTE: If the operating system begins to load before you press F2, wait for the system to finish booting, and then restart the system and try again.

The options on the **System Setup Main Menu** screen are described in the following table:

Table 58. System Setup Main Menu

Option	Description
System BIOS	Enables you to configure the BIOS settings.
iDRAC Settings	Enables you to configure the iDRAC settings. The iDRAC settings utility is an interface to set up and configure the iDRAC parameters by using UEFI (Unified Extensible Firmware Interface). You can enable or disable various iDRAC parameters by using the iDRAC settings utility. For more information about this utility, see Integrated Dell Remote Access Controller User's Guide

Table 58. System Setup Main Menu (continued)

Option	Description
Device Settings	Enables you to configure device settings for devices such as storage controllers or network cards.
Service Tag Settings	Enables you to configure the System Service Tag.

System BIOS

To view the **System BIOS** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS**.

Table 59. System BIOS details

Option	Description
System Information	Provides information about the system such as the system model name, BIOS version, and Service Tag.
Memory Settings	Specifies information and options related to the installed memory.
Processor Settings	Specifies information and options related to the processor such as speed and cache size.
SATA Settings	Specifies options to enable or disable the embedded SATA controller and ports.
NVMe Settings	Specifies options to change the NVMe settings. If the system contains the NVMe drives that you want to configure in a RAID array, you must set both this field and the **Embedded SATA** field on the **SATA Settings** menu to **RAID** mode. You might also need to change the **Boot Mode** setting to **UEFI**. Otherwise, you should set this field to **Non-RAID** mode.
Boot Settings	Specifies options to specify the Boot mode (BIOS or UEFI). Enables you to modify UEFI and BIOS boot settings.
Network Settings	Specifies options to manage the UEFI network settings and boot protocols. Legacy network settings are managed from the **Device Settings** menu. **NOTE:** Network Settings are not supported in BIOS boot mode.
Integrated Devices	Specifies options to manage integrated device controllers and ports, specifies related features, and options.
Serial Communication	Specifies options to manage the serial ports, its related features, and options.
System Profile Settings	Specifies options to change the processor power management settings, memory frequency.
System Security	Specifies options to configure the system security settings, such as system password, setup password, Trusted Platform Module (TPM) security, and UEFI secure boot. It also manages the power button on the system.
Redundant OS Control	Sets the redundant OS information for redundant OS control.
Miscellaneous Settings	Specifies options to change the system date and time.

System Information

To view the **System Information** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **System Information**.

Table 60. System Information details

Option	Description
System Model Name	Specifies the system model name.

Table 60. System Information details (continued)

Option	Description
System BIOS Version	Specifies the BIOS version installed on the system.
System Management Engine Version	Specifies the current version of the Management Engine firmware.
System Service Tag	Specifies the system Service Tag.
System Manufacturer	Specifies the name of the system manufacturer.
System Manufacturer Contact Information	Specifies the contact information of the system manufacturer.
System CPLD Version	Specifies the current version of the system Complex Programmable Logic Device (CPLD) firmware.
UEFI Compliance Version	Specifies the UEFI compliance level of the system firmware.

Memory Settings

To view the **Memory Settings** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **Memory Settings**.

Table 61. Memory Settings details

Option	Description
System Memory Size	Specifies the size of the system memory.
System Memory Type	Specifies the type of memory installed in the system.
System Memory Speed	Specifies the speed of the system memory.
Video Memory	Specifies the size video memory.
System Memory Testing	Specifies whether the system memory tests are run during system boot. The two options available are **Enabled** and **Disabled**. This option is set to **Disabled** by default.
Memory Operating Mode	This field selects the memory operating mode. This feature is active only if a valid memory configuration is detected. When **Optimizer Mode** is enabled, the DRAM controllers operate independently in 64-bit mode and provide optimized memory performance. When **Dell Fault Resilient Mode (FRM)** is enabled, a percentage of the total installed memory is configured to create a fault resilient zone starting from lowest system memory address for use by select hypervisors for host virtualization resilience. Specify the FRM percentage by using the Fault Resilient Mode Memory Size[%] feature. When **Dell NUMA Fault Resilient Mode (FRM)** is enabled, a percentage of the installed memory in every NUMA node is configured to create a fault resilient zone for use by select hypervisors for host virtualization resilience. Specify the FRM percentage by using the Fault Resilient Mode Memory Size[%] feature.
Current State of Memory Operating Mode	Specifies the current state of the memory operating mode.
Fault Resilient Mode Memory Size[%]	Select to define the percent of total memory size that must be used by the fault resilient mode, when selected in the Memory Operating mode. When Fault Resilient Mode is not selected, this option is grayed out and not used by Fault Resilient Mode.
Node Interleaving	Enables or disables the Node interleaving option. Specifies if the Non-Uniform Memory Architecture (NUMA) is supported. If this field is set to **Enabled**, memory interleaving is supported if a symmetric memory configuration is installed. If the field is set to **Disabled**, the system supports NUMA (asymmetric) memory configurations. This option is set to **Disabled** by default.
ADDDC Settings	Enables or disables ADDDC Setting feature. When Adaptive Double DRAM Device Correction (ADDDC) is enabled, failing DRAMs are dynamically

Table 61. Memory Settings details (continued)

Option	Description
	mapped out. When set to **Enabled** it can impact the system performance under certain workloads. This feature is applicable for x4 DIMMs only. This option is set to **Enabled** by default.
Memory training	When option is set to **Fast** and memory configuration is not changed, the system uses previously saved memory training parameters to train the memory subsystems and system boot time is also reduced. If memory configuration is changed, the system automatically enables **Retrain at Next boot** to force one-time full memory training steps, and then go back to **Fast** afterward. When option is set to **Retrain at Next boot**, the system performs the force one-time full memory training steps at next power on and boot time is slowed on next boot. When option is set to **Enable**, the system performs the force full memory training steps on every power on and boot time is slowed on every boot.
DIMM Self Healing (Post Package Repair) on Uncorrectable Memory Error	Enables or disables Post Packing Repair (PPR) on uncorrectable memory error. This option is set to **Enabled** by default.
Correctable Error Logging	Enables or disables correctable error logging. This option is set to **Disabled** by default.
Memory Map Out	This option controls DIMMs slots on the system. This option is set to **Enabled** by default. It allows to disable system installed DIMMs.

Processor Settings

To view the **Processor Settings** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **Processor Settings**.

Table 62. Processor Settings details

Option	Description
Logical Processor	Each processor core supports up to two logical processors. If this option is set to **Enabled**, the BIOS displays all the logical processors. If this option is set to **Disabled**, the BIOS displays only one logical processor per core. This option is set to **Enabled** by default.
CPU Interconnect Speed	Enables you to govern the frequency of the communication links among the processors in the system. **NOTE:** The standard and basic bin processors support lower link frequencies. The options available are **Maximum data rate**, **16 GT/s**, **14.4 GT/s**, and **12.8 GT/s**. This option is set to **Maximum data rate** by default. Maximum data rate indicates that the BIOS runs the communication links at the maximum frequency supported by the processors. You can also select specific frequencies that the processors support, which can vary. For best performance, you should select **Maximum data rate**. Any reduction in the communication link frequency affects the performance of non-local memory access and cache coherency traffic. In addition, it can slow access to non-local I/O devices from a particular processor.

Table 62. Processor Settings details (continued)

Option	Description
	However, if power saving considerations outweigh performance, reduce the frequency of the processor communication links. Before reducing the frequency, you must localize the memory and I/O access to the nearest NUMA node to minimize the impact to system performance.
Virtualization Technology	Enables or disables the virtualization technology for the processor. This option is set to **Enabled** by default.
Kernel DMA Protection	This option is set to **Disabled** by default. When option is set to **Enabled**, BIOS and Operating System will enable direct memory access protection for DMA capable peripheral devices using virtualization technology.
Directory Mode	Enables or disables the directory mode. This option is set to **Enabled** by default.
Adjacent Cache Line Prefetch	Optimizes the system for applications that need high utilization of sequential memory access. This option is set to **Enabled** by default. You can disable this option for applications that need high utilization of random memory access.
Hardware Prefetcher	Enables or disables the hardware prefetcher. This option is set to **Enabled** by default.
DCU Streamer Prefetcher	Enables or disables the Data Cache Unit (DCU) streamer prefetcher. This option is set to **Enabled** by default.
DCU IP Prefetcher	Enables or disables the Data Cache Unit (DCU) IP prefetcher. This option is set to **Enabled** by default.
Sub NUMA Cluster	Enables or disables the Sub NUMA Cluster. This option is set to **Disabled** by default.
MADT Core Enumeration	Specifies the MADT Core Enumeration. This option is set to default in **Round Robin**. Linear option supports industry core enumeration whereas, Round Robin option supports Dell optimized core enumeration.
UMA Based Clustering	It is a read-only field and displays as **Quadrant** , when Sub NUMA Cluster is disabled or displays as **Disabled**, when Sub NUMA Cluster is either 2-way or 4-way.
UPI Prefetch	Enables you to get the memory read started early on DDR bus. The Ultra Path Interconnect (UPI) Rx path spawns the speculative memory that is read to Integrated Memory Controller (iMC) directly. This option is set to **Enabled** by default.
XPT Prefetch	This option is set to **Enabled** by default.
LLC Prefetch	Enables or disables the LLC Prefetch on all threads. This option is set to **Enabled** by default.
Dead Line LLC Alloc	Enables or disables the Dead Line LLC Alloc. This option is set to **Enabled** by default. You can enable this option to enter the dead lines in LLC or disable the option to not enter the dead lines in LLC.
Directory AtoS	Enables or disables the Directory AtoS. AtoS optimization reduces remote read latencies for repeat read accesses without intervening writes. This option is set to **Disabled** by default.
AVX P1	Enables you to reconfigure the processor Thermal Design Power (TDP) levels during POST based on the power and thermal delivery capabilities of the system. TDP verifies the maximum

Table 62. Processor Settings details (continued)

Option	Description
	heat the cooling system is must dissipate. This option is set to **Normal** by default. **NOTE:** This option is only available on certain stock keeping units (SKUs) of the processors.
Intel SST-BF	Enables Intel SST-BF. This option is displayed if Performance Per Watt (operating system) or Custom (when OSPM is enabled) system profiles are selected. This option is set to **Disabled** by default.
Intel SST-CP	Enables Intel SST-CP. This option is displayed if Performance Per Watt (operating system) or Custom (when OSPM is enabled) system profiles are selected. This option is displayed and selectable for each system profile mode. This option is set to **Disabled** by default.
x2APIC Mode	Enables or disables x2APIC mode. This option is set to **Enabled** by default. **NOTE:** For two processors 64 cores configuration, x2APIC mode is not switchable if 256 threads are enabled (BIOS settings: All CCD, cores, and logical processors enabled).
AVX ICCP Pre-Grant License	Enables or disables AVX ICCP Pre-Grant License. This option is set to **Disabled** by default.
Dell Controlled Turbo	
Dell Controlled Turbo Settings	Controls the turbo engagement. Enable this option only when System Profile is set to **Performance** or **Custom**, and CPU Power Management is set to **Performance**. This item can be selected for each system profile mode. This option is set to **Disabled** by default. **NOTE:** Depending on the number of installed processors, there might be up to two processor listings.
Dell AVX Scaling Technology	Enables you to configure the Dell AVX scaling technology. This option is set to **0** by default. Enter the value from 0 to 12 bins. The value that is entered decreases the Dell AVX Scaling Technology frequency when the Dell-controlled Turbo feature is enabled.
Optimizer Mode	Enables or disables the CPU performance. When this option is set to **Auto**, set the CPU Power Management to Max Performance. When set to **Enabled**, enables the CPU Power Management settings. When set to **Disabled**, the CPU Power Management option is disabled. This option is set to **Auto** by default.
Number of Cores per Processor	Controls the number of enabled cores in each processor. This option is set to **All** by default.
CPU Physical Address Limit	Limit CPU physical address to 46 bits to support older Hyper-V. If enabled, automatically disables TME-MT. This option is set to **Enabled** by default.
AMP Prefetch	This option enables one of the Mid-Level Cache (MLC) AMP hardware Prefetcher. This option is set to **Disabled** by default.
Homeless Prefetch	This option allows L1 Data Cache Unit (DCU) to prefetech, when the Fill Buffers (FB) is full. Auto maps to hardware default setting. This option is set to **Auto** by default.
Uncore Frequency RAPL	This setting controls whether the Running Average Power Limit (RAPL) balancer is enabled or not. If enabled, it activates the

Table 62. Processor Settings details (continued)

Option	Description
	uncore power budgeting. This option is set to **Enabled** by default.
Processor Core Speed	Specifies the maximum core frequency of the processor.
Processor Bus Speed	Specifies the bus speed of the processor. **NOTE:** The processor bus speed option displays only when both processors are installed.
Local Machine Check Exception	Enables or disables the local machine check exception. This is an extension of the MCA Recovery mechanism providing the capability to deliver Uncorrected Recoverable (UCR) Software Recoverable Action Required (SRAR) errors to one or more specific logical processors threads receiving previously poisoned or corrupted data. When enabled, the UCR SRAR Machine Check Exception is delivered only to the affected thread rather than broadcast to all threads in the system. The feature supports operating system recovery for cases of multiple recoverable faults that are detected close, which would otherwise result in a fatal machine check event. The feature is available only on Advanced RAS processors. This option is set to **Enabled** by default.
CPU Crash Log Support	This field controls Intel CPU Crash Log feature for collection of previous crash data from shared SRAM of Out-of -Band Management Service Module at post reset. This option is set to **Disabled** by default.
Processor n	**NOTE:** Depending on the number of processors, there might be up to n processors listed. The following settings are displayed for each processor:

Table 63. Processor n details

Option	Description
Family-Model-Stepping	Specifies the family, model, and stepping of the processor as defined by Intel.
Brand	Specifies the brand name.
Level 2 Cache	Specifies the total L2 cache.
Level 3 Cache	Specifies the total L3 cache.
Number of Cores	Specifies the number of cores per processor.
Microcode	Specifies the processor microcode version.

SATA Settings

To view the **SATA Settings** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **SATA Settings**.

Table 64. SATA Settings details

Option	Description
Embedded SATA	Enables the embedded SATA option to be set to **Off**, **AHCI mode** , or **RAID modes**. This option is set to **AHCI Mode** by default. **NOTE:** 1. You might also need to change the Boot Mode setting to UEFI. Otherwise, you should set the field to Non-RAID mode.

Table 64. SATA Settings details (continued)

Option	Description
	2. No ESXi and Ubuntu OS support under RAID mode.
Security Freeze Lock	Sends **Security Freeze Lock** command to the embedded SATA drives during POST. This option is applicable only for AHCI Mode. This option is set to **Enabled** by default.
Write Cache	Enables or disables the command for the embedded SATA drives during POST. This option is applicable only for AHCI Mode. This option is set to **Disabled** by default.
Port n	Sets the drive type of the selected device. For **AHCI Mode**, BIOS support is always enabled.

Table 65. Port n

Options	Descriptions
Model	Specifies the drive model of the selected device.
Drive Type	Specifies the type of drive attached to the SATA port.
Capacity	Specifies the total capacity of the drive. This field is undefined for removable media devices such as optical drives.

NVMe Settings

This option sets the NVMe drive mode. If the system contains NVMe drives that you want to configure in a RAID array, you must set both this field and the Embedded SATA field on the SATA settings menu to RAID Mode. You may also need to change the Boot Mode setting to UEFI.

To view the **NVMe Settings** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **NVMe Settings**.

Table 66. NVMe Settings details

Option	Description
NVMe mode	Enables or disables the boot mode. The option is set to **Non-RAID** mode by default.
BIOS NVMe Driver	Sets the drive type to boot the NVMe driver. The available options are **Dell Qualified Drives** and **All Drives**. This option is set to **Dell Qualified Drives** by default.

Boot Settings

You can use the **Boot Settings** screen to set the boot mode to either **BIOS** or **UEFI**. It also enables you to specify the boot order.

- **UEFI**: The Unified Extensible Firmware Interface (UEFI) is a new interface between operating systems and platform firmware. The interface consists of data tables with platform related information, boot and runtime service calls that are available to the operating system and its loader. The following benefits are available when the **Boot Mode** is set to **UEFI**:
  - Support for drive partitions larger than 2 TB.
  - Enhanced security (e.g., UEFI Secure Boot).
  - Faster boot time.

  NOTE: You must use only the UEFI boot mode in order to boot from NVMe drives.

- **BIOS**: The **BIOS Boot Mode** is the legacy boot mode. It is maintained for backward compatibility.

To view the **Boot Settings** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **Boot Settings**.

Table 67. Boot Settings details

Option	Description
Boot Mode	Enables you to set the boot mode of the system. If the operating system supports UEFI, you can set this option to UEFI. Setting this field to BIOS allows compatibility with non-UEFI operating systems. This option is set to **UEFI** by default. **CAUTION: Switching the boot mode may prevent the system from booting if the operating system is not installed in the same boot mode.** **NOTE:** Setting this field to UEFI disables the **BIOS Boot Settings** menu.
Boot Sequence Retry	Enables or disables the Boot sequence retry feature or resets the system. When this option is set to **Enabled** and the system fails to boot, the system re-attempts the boot sequence after 30 seconds. When this option is set to **Reset** and the system fails to boot, the system reboots immediately. This option is set to **Enabled** by default.
Hard-disk Failover	Enables or disables the Hard-disk failover. This option is set to **Disabled** by default.
Generic USB Boot	Enables or disables the generic USB boot placeholder. This option is set to **Disabled** by default.
Hard-disk Drive Placeholder	Enables or disables the Hard-disk drive placeholder. This option is set to **Disabled** by default.
Clean all Sysprep variables and order	When this option is set to **None**, BIOS will do nothing. When set to **Yes**, BIOS will delete variables of SysPrep #### and SysPrepOrder this option is a onetime option, will reset to none when deleting variables. This setting is only available in **UEFI Boot Mode**. This option is set to **None** by default.
UEFI Boot Settings	Specifies the UEFI boot sequence. Enables or disables UEFI Boot options. **NOTE:** This option controls the UEFI boot order. The first option in the list will be attempted first.

Table 68. UEFI Boot Settings

Option	Description
UEFI Boot Sequence	Enables you to change the boot device order.
Boot Options Enable/Disable	Enables you to select the enabled or disabled boot devices

Choosing system boot mode

System Setup enables you to specify one of the following boot modes for installing your operating system:

- UEFI boot mode (the default), is an enhanced 64-bit boot interface. If you have configured your system to boot to UEFI mode, it replaces the system BIOS.

1. From the **System Setup Main Menu**, click **Boot Settings**, and select **Boot Mode**.
2. Select the UEFI boot mode you want the system to boot into.

   CAUTION: Switching the boot mode may prevent the system from booting if the operating system is not installed in the same boot mode.

3. After the system boots in the specified boot mode, proceed to install your operating system from that mode.

NOTE: Operating systems must be UEFI-compatible to be installed from the UEFI boot mode. DOS and 32-bit operating systems do not support UEFI and can only be installed from the BIOS boot mode.

NOTE: For the latest information about supported operating systems, go to OS support.

Changing boot order

About this task

You may have to change the boot order if you want to boot from a USB key or an optical drive. The following instructions may vary if you have selected **BIOS** for **Boot Mode**.

NOTE: Changing the drive boot sequence is only supported in BIOS boot mode.

Steps

1. On the **System Setup Main Menu** screen, click **System BIOS** > **Boot Settings** > **UEFI Boot Settings** > **UEFI Boot Sequence**.
2. Use the arrow keys to select a boot device, and use the plus (+) and minus (-) sign keys to move the device down or up in the order.
3. Click **Exit**, and then click **Yes** to save the settings on exit.

   NOTE: You can also enable or disable boot order devices as needed.

Network Settings

To view the **Network Settings** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **Network Settings**.

NOTE: Network Settings are not supported in BIOS boot mode.

Table 69. Network Settings details

Option	Description
UEFI PXE Settings	Enables you to control the configuration of the UEFI PXE device.
Number of PXE Devices	This field specifies the number of PXE devices. This option is set to **4** by default.
PXE Device n (n = 1 to 4)	Enables or disables the device. When enabled, a UEFI PXE boot option is created for the device.
PXE Device n Settings(n = 1 to 4)	Enables you to control the configuration of the PXE device.
UEFI HTTP Settings	Enables you to control the configuration of the UEFI HTTP device.
HTTP Device n (n = 1 to 4)	Enables or disables the device. When enabled, a UEFI HTTP boot option is created for the device.
HTTP Device n Settings (n = 1 to 4)	Enables you to control the configuration of the HTTP device.
UEFI iSCSI Settings	Enables you to control the configuration of the iSCSI device.
iSCSI Initiator Name	Specifies the name of the iSCSI initiator in IQN format.
iSCSI Device1	Enables or disables the iSCSI device. When disabled, a UEFI boot option is created for the iSCSI device automatically. This is set to **Disabled** by default.
iSCSI Device1 Settings	Enables you to control the configuration of the iSCSI device.
UEFI NVMe-oF Settings	Enables you to control the configuration of the NVMe-oF devices.
NVMe-oF	Enables or disables the NVMe-oF feature. When enabled, it allows to configure the host and target parameters needed for fabric connection. This is set to **Disabled** by default.
NVMe-oF Host NQN	This field specifies the name of the NVMe-oF host NQN. Allowed input is in the following format: nqn.yyyy-mm.<Reserved Domain Name>:<Unique String>. Leave it empty to use system generated value with following format: nqn.1988-11.com.dell:<Model name>.<Model number>.<Service Tag>.

Table 69. Network Settings details (continued)

Option	Description
NVMe-oF Host Id	This field specifies a 16 bytes value of the NVMe-oF host identifier that uniquely identifies this host with the controller in the NVM subsystem. Allowed input is a hexadecimal-encoded string in this format: 00112233-4455-6677-8899-aabbccddeeff. Leave it empty to use system generated value. A value of all FF is not allowed.
Host Security Key Path	This field specifies the Host security key path.
NVMe-oF SubSystem Settings	This field controls the parameters for the NVMe-oF subsystem n connections.

Table 70. PXE Device n Settings details

Option	Description
Interface	Specifies NIC interface used for the PXE device.
Protocol	Specifies Protocol used for PXE device. This option is set to **IPv4** or **IPv6**. This option is set to **IPv4** by default.
Vlan	Enables Vlan for PXE device. This option is set to **Enabled** or **Disabled**. This option is set to **Disabled** by default.
Vlan ID	Shows the Vlan ID for the PXE device
Vlan Priority	Shows the Vlan Priority for the PXE device.

Table 71. HTTP Device n Settings details

Option	Description
Interface	Specifies NIC interface used for the HTTP device.
Protocol	Specifies Protocol used for HTTP device. This option is set to **IPv4** or **IPv6**. This option is set to **IPv4** by default.
Vlan	Enables Vlan for HTTP device. This option is set to **Enable** or **Disable**. This option is set to **Disable** by default.
Vlan ID	Shows the Vlan ID for the HTTP device
Vlan Priority	Shows the Vlan Priority for the HTTP device.
DHCP	Enables or disables DHCP for this HTTP device. This option is set to **Enabled** by default.
IP Address	Specifies IP address for the HTTP device.
Subnet Mask	Specifies subnet mask for the HTTP device.
Autoconfiguration	Enables or disables the **IPv6Autoconfiguration** for the HTTP Device. When set to Enabled, IPv6 Address and Gateway are retrieved from Autoconfiguration mechanism.
Prefix Length	IPv6 Prefix Length (0~127) for this HTTP Device.
IPv6 Address	IPv6 Unicast address for this HTTP Device.
Gateway	Specifies gateway for the HTTP device.
DNS info via DHCP	Enables or disables DNS Information from DHCP. This option is set to **Enabled** by default.
Primary DNS	Specifies the primary DNS server IP address for the HTTP Device.
Secondary DNS	Specifies the secondary DNS server IP address for the HTTP Device.
URI (will obtain from DHCP server if not specified)	Obtain URI from the DHCP server if not specified
TLS Authentication Configuration	Specifies the option for TLS authentication configuration.

NOTE: Autoconfiguration, Prefix Length and IPv6 Address options are visible only when **Protocol** is set to **IPv6**

Table 72. ISCSI Device1 Settings screen details

Option	Description
Connection 1	Enables or disables the iSCSI connection. This option is set to **Disabled** by default.
Connection 2	Enables or disables the iSCSI connection. This option is set to **Disabled** by default.
Connection 1 Settings	Enables you to control the configuration for the iSCSI connection.
Connection 2 Settings	Enables you to control the configuration for the iSCSI connection.
Connection Order	Enables you to control the order for which the iSCSI connections will be attempted.
ISCSI F1/F2 Prompt on Error	This field determines whether the BIOS stops and displays a prompt when iSCSI connection errors occur during POST. The BIOS will display the prompt when this setting is **Enabled**, otherwise, the BIOS will continue through POST and attempt to boot an operating system. **NOTE:** This setting will be grayed out if F1/F2 Prompt on Error in the Miscellaneous Settings menu is **Disabled**.

Table 73. TLS Authentication Configuration screen details

Option	Description
TLS Authentication Mode	View or modify the device's boot TLS Authentication Mode. This option is set to **One Way** by default. **None** means the HTTP server and the client will not authenticate each other for this boot.
Root Certificate Configuration	Import, delete, or export the root certificate.

Table 74. NVMe-oF SubSystem Settings screen details

Option	Description
NVMe-oF SubSystem n (n = 1 to 4)	Enables or disables NVMe-oF SubSystem. This option is set to **Disabled** by default.
NVMe-oF SubSystem n Settings (n = 1 to 4)	Enables you to control the configuration of the NVMe-oF SubSystem, if **Enabled**.

Table 75. NVMe-oF SubSystem n Settings

Option	Description
Interface	NIC interface used for NVMe-oF connections. This option is set to **Embedded NIC 1 Port 1 Partition 1** by default.
Transport Type	This field sets the value of transport type for NVMe-oF connection. This option is set to **TCP** by default.
Protocol	This field sets the value of protocol type for NVMe-oF connection. This option is set to **IPv4** by default. When **IPv6** is selected, IPv6 Autoconfiguration is used to get the IPv6 address.
VLAN	Enables or disables VLAN for this NVMe-oF connections. This option is set to **Disabled** by default.
VLAN Id	Specifies the VLAN Id for this NVMe-oF connection. This option is set to **1** by default.
VLAN Priority	Specifies the VLAN priority for this NVMe-oF connection. This option is set to **0** by default.
Retry Count	Specifies the retry count for this NVMe-oF connection. This option is set to **3** by default.

Table 75. NVMe-oF SubSystem n Settings (continued)

Option	Description
Timeout	Specifies the time out for this NVMe-oF connection. This option is set to **10000** by default.
DHCP	NVMe-oF connection gets subsystem's information from the DHCP server. This option is set to **Disabled** by default.
Host IP Address	Specifies the Host IP Address for this NVMe-oF connection.
Host Subnet Mask	Specifies the Host Subnet Mask for this NVMe-oF connection.
Host Gateway	Specifies the Host Gateway for this NVMe-oF connection.
NVMe-oF subsystem info via DHCP	Enables and disables the NVMe-oF subsystem's DHCP for this connection. This option is set to **Disabled** by default.
NVMe-oF subsystem NQN	Specifies the NVMe-oF subsystem's NQN for this connection.
NVMe-oF subsystem Address	Specifies the NVMe-oF subsystem's IP address for this connection.
NVMe-oF subsystem Port	Specifies the NVMe-oF subsystem's port for this connection. If subsystem NQN is empty, this field will be forced to the default Discovery Service port **8009**.This option is set to **4420** by default.
NVMe-oF subsystem NID	Specifies the NamespaceID (NID) for this NVMe-oF connection.
NVMe-oF subsystem Controller ID	Specifies the NVMe-oF subsystem's Controller ID for this connection. This option is set to **0** by default.
Security	Enables or disables the security option for this NVMe-oF connection. This option is set to **Disabled** by default.
Authentication Type	Specifies the authentication type for this NVMe-oF connection. This option is set to **None** by default.
Securitykeypath	Specifies the Securitykeypath for this NVMe-oF connection.

Integrated Devices

To view the **Integrated Devices** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **Integrated Devices**.

Table 76. Integrated Devices details

Option	Description
User Accessible USB Ports	Configures the user accessible USB ports. Selecting **Only Back Ports On** disables the front USB ports; selecting **All Ports Off** disables all front and back USB ports.; selecting **All Ports Off (Dynamic)** disables all front and back USB ports during POST. and front ports can be enabled or disabled dynamically by authorized user without resetting the system. This option is set to **All Ports On** by default.
	The USB keyboard and mouse still function in certain USB ports during the boot process, depending on the selection. After the boot process is complete, the USB ports will be enabled or disabled as per the setting.
iDRAC Direct USB Port	The iDRAC Direct USB port is managed by iDRAC exclusively with no host visibility. This option is set to **ON** or **OFF**. When set to **OFF**, iDRAC does not detect any USB devices installed in this managed port. This option is set to **On** by default.
Embedded NIC1 and NIC2	Enables or disables the OS interface of the Embedded NIC1 and NIC2 controller. If set to **Disabled (OS)**, the NIC may still be available for shared network access by the embedded management controller. Configure the **Embedded NIC1 and NIC2** option by using the NIC management utilities of the system. This option is set to **Enabled** by default.

Table 76. Integrated Devices details (continued)

Option	Description
I/OAT DMA Engine	Enables or disables the I/O Acceleration Technology (I/OAT) option. I/OAT is a set of DMA features designed to accelerate network traffic and lower CPU utilization. Enable only if the hardware and software support the feature. This option is set to **Disabled** by default.
Embedded Video Controller	Enables or disables the use of Embedded Video Controller as the primary display. When set to **Enabled**, the Embedded Video Controller will be the primary display even if add-in graphic cards are installed. When set to **Disabled**, an add-in graphics card is used as the primary display. BIOS will output displays to both the primary add-in video and the embedded video during POST and preboot environment. The embedded video will then be disabled right before the operating system boots. This option is set to **Enabled** by default. **NOTE:** When there are multiple add-in graphic cards installed in the system, the first card discovered during PCI enumeration is selected as the primary video. You might have to rearrange the cards in the slots in order to control which card is the primary video.
I/O Snoop HoldOff Response	Selects the number of cycles PCI I/O can withhold snoop requests, from the CPU, to allow time to complete its own write to LLC. This setting can help improve performance on workloads where throughput and latency are critical. The options available are **256 Cycles**, **512 Cycles**, **1K Cycles**, **2K Cycles**, **4K Cycles**, **8K Cycles**, **16K Cycles**, **32K Cycles**, **64K Cycles** and **128K Cycles**.This option is set to **2K Cycles** by default.
Current State of Embedded Video Controller	Displays the current state of the embedded video controller. The **Current State of Embedded Video Controller** option is a read-only field. If the Embedded Video Controller is the only display capability in the system (that is, no add-in graphics card is installed), then the Embedded Video Controller is automatically used as the primary display even if the **Embedded Video Controller** setting is set to **Disabled**.
SR-IOV Global Enable	Enables or disables the BIOS configuration of Single Root I/O Virtualization (SR-IOV) devices. This option is set to **Disabled** by default.
OS Watchdog Timer	If your system stops responding, this watchdog timer aids in the recovery of your operating system. When this option is set to **Enabled**, the operating system initializes the timer. When this option is set to **Disabled** (the default), the timer does not have any effect on the system.
Empty Slot Unhide	Enables or disables the root ports of all the empty slots that are accessible to the BIOS and operating system. This option is set to **Disabled** by default.
Slot Disablement	Enables or disables or boot driver disables the available PCIe slots on your system. The slot disablement feature controls the configuration of the PCIe cards installed in the specified slot. Slots must be disabled only when the installed peripheral card prevents booting into the operating system or causes delays in system startup. If the slot is disabled, both the Option ROM and UEFI drivers are disabled. Only slots that are present on the system will be available for control. When this option is set to boot driver disabled, both the Option ROM and UEFI driver from the slot will not run during POST. The system will not boot from the card and its pre-boot services will not be available. However, the card is available to the operating system.
	Slot n: Enables or disables or only the boot driver is disabled for the PCIe slot n. This option is set to **Enabled** by default.
Slot Bifurcation	**Auto Discovery Bifurcation Settings** allows **Platform Default Bifurcation**, **Auto Discovery of Bifurcation**, and **Manual bifurcation Control**.
	This option is set to **Platform Default Bifurcation** by default. The slot bifurcation field is accessible when set to **Manual bifurcation Control** and is grayed out when set to **Platform Default Bifurcation** and **Auto Discovery of Bifurcation**.

Table 76. Integrated Devices details (continued)

Option	Description
	NOTE: The slot bifurcation supports on PCIe slot only, does not support slot type from Paddle card to Riser and Slimline connector to Riser.

Serial Communication

To view the **Serial Communication** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **Serial Communication**.

NOTE: The serial port is optional for the PowerEdge R760 system. The Serial Communication option is applicable only if the serial COM port is installed in the system.

Table 77. Serial Communication details

Option	Description
Serial Communication	Enables the serial communication options. Selects serial communication devices (Serial Device 1 and Serial Device 2) in BIOS. BIOS console redirection can also be enabled, and the port address can be specified. The options available for System without serial COM port (DB9) are **On without Console Redirection**, **On with Console Redirection**, **Off**, **Auto**. This option is set to **Auto** if the external serial connector is available (connected to the rear I/O board). Else the default will be **Off**.
Serial Port Address	Enables you to set the port address for serial devices. This option is set to either **COM1** or **COM2** for the serial device **(COM1=0x3F8,COM2=0x2F8)**and set to **COM1** by default. **NOTE:** You can use only Serial Device 2 for the Serial Over LAN (SOL) feature. To use console redirection by SOL, configure the same port address for console redirection and the serial device. **NOTE:** Every time the system boots, the BIOS syncs the serial MUX setting that is saved in iDRAC. The serial MUX setting can independently be changed in iDRAC. Loading the BIOS default settings from within the BIOS setup utility may not always revert the serial MUX setting to the default setting of Serial Device 1.
External Serial Connector	Enables you to associate the External Serial Connector to **Serial Device 1**, **Serial Device 2**, or the **Remote Access Device** by using this option. This option is set to **Serial Device 1** by default. **NOTE:** Only Serial Device 2 can be used for Serial Over LAN (SOL). To use console redirection by SOL, configure the same port address for console redirection and the serial device. **NOTE:** Every time the system boots, the BIOS syncs the serial MUX setting saved in iDRAC. The serial MUX setting can independently be changed in iDRAC. Loading the BIOS default settings from within the BIOS setup utility may not always revert this setting to the default setting of Serial Device 1.
Failsafe Baud Rate	Specifies the failsafe baud rate for console redirection. The BIOS attempts to determine the baud rate automatically. This failsafe baud rate is used only if the attempt fails, and the value must not be changed. This option is set to **115200** by default.
Remote Terminal Type	Sets the remote console terminal type. This option is set to **VT100/VT220** by default.

Table 77. Serial Communication details (continued)

Option	Description
Redirection After Boot	Enables or disables the BIOS console redirection when the operating system is loaded. This option is set to **Enabled** by default.

System Profile Settings

To view the **System Profile Settings** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **System Profile Settings**.

Table 78. System Profile Settings details

Option	Description
System Profile	Sets the system profile. If you set the System Profile option to a mode other than **Performance Per Watt (DAPC)**, the BIOS automatically sets the rest of the options. You can only change the rest of the options if the mode is set to **Custom**. This option is set to **Performance Per Watt (DAPC)** by default. Other options include **Custom**, **Performance**, **Performance Per Watt (OS)** and **Workstation Performnce**. **NOTE:** All the parameters on the system profile setting screen are available only when the **System Profile** option is set to **Custom**.
CPU Power Management	Sets the CPU power management. This option is set to **System DBPM (DAPC)** by default. Other option includes **Maximum Performance**, **OS DBPM**.
Memory Frequency	Sets the speed of the system memory. You can select **Maximum Performance**, **Maximum Reliability** or a specific speed. This option is set to **Maximum Performance** by default.
Turbo Boost	Enables or disables the processor to operate in the turbo boost mode. This option is set to **Enabled** by default.
Enery Efficient Turbo	Energy Efficient Turbo (EET) is a mode of operation where a processor's core frequency is adjusted within the turbo range based on workload. This option is set to **Enabled** by default.
C1E	Enables or disables the processor to switch to a minimum performance state when it is idle. This option is set to **Enabled** by default.
C States	Enables or disables the processor to operate in all available power states. C States allow the processor to enter lower power states when idle. When set to **Enabled** (OS controlled) or when set to **Autonomous** (if hardware controlled is supported), the processor can operate in all available Power States to save power, but may increase memory latency and frequency jitter. This option is set to **Enabled** by default.
Memory Patrol Scrub	Sets the memory patrol scrub mode. This option is set to **Standard** by default.
Memory Refresh Rate	Sets the memory refresh rate to either 1x or 2x. This option is set to **1x** by default.
Uncore Frequency	Enables you to select the **Uncore Frequency** option. **Dynamic mode** enables the processor to optimize power resources across cores and uncores during runtime. The optimization of the uncore frequency to either save power or optimize performance is influenced by the setting of the **Energy Efficiency Policy** option.
Energy Efficient Policy	Enables you to select the **Energy Efficient Policy** option. The CPU uses the setting to manipulate the internal behavior of the processor and determines whether to target higher performance or better power savings. This option is set to **Balanced Performance** by default.
Monitor/Mwait	Enables the Monitor/Mwait instructions in the processor. This option is set to **Enabled** for all system profiles, except **Custom** by default. **NOTE:** This option can be disabled when System Profile is set to **Custom**. **NOTE:** When C States is set to Enabled in the Custom mode, changing the Monitor/Mwait setting does not impact the system power or performance.

Table 78. System Profile Settings details (continued)

Option	Description
Workload Profile	This option allows the user to specify the targeted workload of a server. It allows optimization of performance based on the workload type. This option is set to **Not Configured** by default.
Dynamic Load Line Switch	Dynamic Load Line Switch control. Dynamic Load Line (DLL) is a Power Management feature, which dynamically switches to the performance mode during high CPU utilization. This setting is read-only and is set to **Enabled** when Optimized Power Mode is Enabled. Read-only unless System Profile is set to **Custom**.
CPU Interconnect Bus Link Power Management	Enables or disables the CPU Interconnect Bus Link Power Management. This option is set to **Enabled** by default.
PCI ASPM L1 Link Power Management	Enables or disables the PCI **ASPM L1 Link Power Management**. This option is set to **Enabled** by default.

System Security

To view the **System Security** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **System Security**.

Table 79. System Security details

Option	Description
CPU AES-NI	Improves the speed of applications by performing encryption and decryption by using the Advanced Encryption Standard Instruction Set (AES-NI). This option is set to **Enabled** by default.
System Password	Sets the system password. This option is read-only if the password jumper is not installed in the system.
Setup Password	Sets the setup password. This option is read-only if the password jumper is not installed in the system.
Password Status	Locks the system password. This option is set to **Unlocked** by default.
TPM Information	Indicates the type of Trusted Platform Module, if present.
EMR CPU TDX/ IFS features	This option is set to **Disabled** by default.

Table 80. TPM 2.0 security information

Option	Description
TPM Information	
TPM Security	**NOTE:** The TPM menu is available only when the TPM module is installed. Enables you to control the reporting mode of the TPM. When set to Off, the presence of the TPM is not reported to the OS. When set to On, the presence of the TPM is reported to the OS. The **TPM Security** option is set to **Off** by default. When TPM 2.0 is installed, the **TPM Security** option is set to **On** or **Off**. This option is set to **Off** by default.
TPM Information	Indicates the type of Trusted Platform Module, if present.
TPM Firmware	Indicates the firmware version of the TPM.
TPM Hierarcy	Enables, disables, or clears the storage and endorsement hierarchies. When set to **Enabled**, the storage and endorsement hierarchies can be used.

Table 80. TPM 2.0 security information (continued)

Option		Description
		When set to **Disabled**, the storage and endorsement hierarchies cannot be used.
		When set to **Clear**, the storage and endorsement hierarchies are cleared of any values, and then reset to **Enabled**.
TPM Advanced Settings	**TPM PPI Bypass Provision**	When set to **Enabled**, allows the Operating System to bypass Physical Presence Interface (PPI) prompts when issuing PPI Advanced Configuration and Power interface (ACPI) provisioning operations.
	TPM PPI Bypass Clear	When set to **Enabled** allows the Operating System to bypass Physical Presence Interface (PPI) prompts when issuing PPI Advanced Configuration and Power Interface (ACPI) clear operations.
	TPM2 Algorithm Selection	Allows the user to change the cryptographic algorithms used in the Trusted Platform Module (TPM). The available options are dependent on the TPM firmware. To enable TPM2 Algorithm Selection, Intel(R) TXT technology must be disabled. The TPM2 Algorithm Selection option supports SHA1, SHA128, SHA256, SHA512 and SM3 by detecting the TPM module. This option is set to **SHA1** by default.

Table 81. System Security details

Option	Description
Intel(R) TXT	Enables you to set the Intel Trusted Execution Technology (TXT) option. To enable the **Intel TXT** option, virtualization technology and TPM Security must be enabled with Pre-boot measurements. This option is set to **Off** by default. It is set **On** for Secure Launch (Firmware Protection) support on Windows 2022.
Memory Encryption	Enables or disables the Intel Total Memory Encryption (TME) and Multi-Tenant (Intel® TME-MT). When option is set to **Disabled**, BIOS disables both TME and MK-TME technology. When option is set to **Single Key** BIOS enables the TME technology. When option is set to **Multiple Keys**, BIOS enables the TME-MT technology. This option is set to **Disabled** by default.
TME Encryption Bypass	Allows the option to bypass the Intel Total Memory Encryption. This option is set to **Disabled** by default.
Intel(R) SGX	Enables you to set the Intel Software Guard Extension (SGX) option. To enable the **Intel SGX** option, processor must be SGX capable, memory population must be compatible (minimum x8 identical DIMM1 to DIMM8 per CPU socket, not support on persistent memory configuration), memory operating mode must be set at optimizer mode, memory encryption must be enabled and node interleaving must be disabled. This option is set to **Off** by default. When this option is to **Off**, BIOS disables the SGX technology. When this option is to **On**, BIOS enables the SGX technology.
Power Button	Enables or disables the power button on the front of the system. This option is set to **Enabled** by default.
AC Power Recovery	Sets how the system behaves after AC power is restored to the system. This option is set to **Last** by default. **NOTE:** The host system will not power on until iDRAC Root of Trust (RoT) is completed, host power on will be delayed by minimum 90 seconds after the AC applied.
AC Power Recovery Delay	Sets the time delay for the system to power up after AC power is restored to the system. This option is set to **Immediate** by default. When this option is set to **Immediate**, there is no delay for power up. When this option is set to **Random**, the

Table 81. System Security details (continued)

Option	Description
	system creates a random delay for power up. When this option is set to **User Defined**, the system delay time is manually to power up.
User Defined Delay (120 s to 600 s)	Sets the **User Defined Delay** option when the **User Defined** option for **AC Power Recovery Delay** is selected. The actual AC recovery time needs to add iDRAC root of trust time (around 50 seconds).
UEFI Variable Access	Provides varying degrees of securing UEFI variables. When set to **Standard** (the default), UEFI variables are accessible in the operating system per the UEFI specification. When set to **Controlled**, selected UEFI variables are protected in the environment and new UEFI boot entries are forced to be at the end of the current boot order.
In-Band Manageability Interface	When set to **Disabled** , this setting hides the Management Engine's (ME), HECI devices, and the system's IPMI devices from the operating system. This prevents the operating system from changing the ME power capping settings, and blocks access to all in-band management tools. All management should be managed through out-of-band. This option is set to **Enabled** by default. **NOTE:** BIOS update requires HECI devices to be operational and DUP updates require IPMI interface to be operational. This setting needs to be set to Enabled to avoid updating errors.
SMM Security Mitigation	Enables or disables the UEFI SMM security mitigation protections. It is set to **Disabled** by default.
Secure Boot	Enables Secure Boot, where the BIOS authenticates each pre-boot image by using the certificates in the Secure Boot Policy. Secure Boot is set to **Disabled** by default.
Secure Boot Policy	When Secure Boot policy is set to **Standard**, the BIOS uses the system manufacturer's key and certificates to authenticate pre-boot images. When Secure Boot policy is set to **Custom**, the BIOS uses the user-defined key and certificates. Secure Boot policy is set to **Standard** by default.
Secure Boot Mode	Configures how the BIOS uses the Secure Boot Policy Objects (PK, KEK, db, dbx).
	If the current mode is set to **Deployed Mode**, the available options are **User Mode** and **Deployed Mode**. If the current mode is set to **User Mode**, the available options are **User Mode**, **Audit Mode**, and **Deployed Mode**.
	Below are the details of different boot modes available in the **Secure Boot Mode** option. **User Mode** — In **User Mode**, PK must be installed, and BIOS performs signature verification on programmatic attempts to update policy objects. The BIOS allows unauthenticated programmatic transitions between modes. **Audit mode** — In **Audit Mode**, PK is not present. BIOS does not authenticate programmatic update to the policy objects and transitions between modes. The BIOS performs a signature verification on pre-boot images and logs the results in the image Execution Information Table, but executes the images whether they pass or fail verification. **Audit Mode** is useful for programmatic determination of a working set of policy objects. **Deployed Mode** — **Deployed Mode** is the most secure mode. In **Deployed Mode**, PK must be installed and the BIOS performs signature verification on programmatic attempts to update policy objects. **Deployed Mode** restricts the programmatic mode transitions.
Secure Boot Policy Summary	Specifies the list of certificates and hashes that secure boot uses to authenticate images.

Table 81. System Security details (continued)

Option	Description
Secure Boot Custom Policy Settings	Configures the Secure Boot Custom Policy. To enable this option, set the Secure Boot Policy to **Custom** option.
Intel Trust Domain Extension(TDX)	**Intel Trust Domain Extension (TDX)** is a hardware-based trusted execution environment. It is designed to protect sensitive data and applications in Trust Domain(TD) or Virtual Machine(VM) from unauthorized access. **Memory Encryption** must be set to **Multiple Keys** for TDX to be enabled. TDX is set to **Disabled** by default. **NOTE:** To enable the TDX option, processor must be TDX capable, memory population must be compatible as SGX setting (minimum x8 identical DIMM1 to DIMM8 per CPU socket, not support on persistent memory configuration)
TME-MT/TDX Key Spilt to non-zero value	When the TME-MT/TDX Key Spilt to non-zero value is set to **1**, **2**, **3**, **4**, **5**, or **6**, it designates the number of bits for TDX usage, while the rest will be used by TME-MT. It is set to **1** by default.
TDX Secure Arbitration Mode Loader(SEAM)	This SW module runs in a new CPU Secure Arbitration Mode (SEAM) as peer virtual machine manager (VMM). This SEAM module supports TD entry and exit using the existing virtualization infrastructure. It is set to **Disabled** by default.
Intel(R) In-Field Scan	The Intel(R) In-field Scan feature allows software to scan processor cores for latent faults. The scan can be performed in the field after the server is deployed. When **Enabled**, the BIOS configures all processors to respond to software scan requests. When this setting is **Disabled**, the processors will not respond to software scan requests. It is set to **Disabled** by default.

Creating a system and setup password

Prerequisites

Ensure that the password jumper is enabled. The password jumper enables or disables the system password and setup password features. For more information, see the System board jumper settings section.

NOTE: If the password jumper setting is disabled, the existing system password and setup password are deleted and you need not provide the system password to boot the system.

Steps

1. To enter System Setup, press F2 immediately after turning on or rebooting your system.
2. On the **System Setup Main Menu** screen, click **System BIOS** > **System Security**.
3. On the **System Security** screen, verify that **Password Status** is set to **Unlocked**.
4. In the **System Password** field, type your system password, and press Enter or Tab.

   Use the following guidelines to assign the system password:
   - A password can have up to 32 characters.

   A message prompts you to reenter the system password.
5. Reenter the system password, and click **OK**.
6. In the **Setup Password** field, type your setup password and press Enter or Tab.
   A message prompts you to reenter the setup password.
7. Reenter the setup password, and click **OK**.
8. Press Esc to return to the System BIOS screen. Press Esc again.

   A message prompts you to save the changes.

   NOTE: Password protection does not take effect until the system reboots.

Using your system password to secure your system

About this task

If you have assigned a setup password, the system accepts your setup password as an alternate system password.

Steps

1. Turn on or reboot your system.
2. Type the system password and press Enter.

Next steps

When **Password Status** is set to **Locked**, type the system password and press Enter when prompted at reboot.

NOTE: If an incorrect system password is typed, the system displays a message and prompts you to reenter your password. You have three attempts to type the correct password. After the third unsuccessful attempt, the system displays an error message that the system has stopped functioning and must be turned off. Even after you turn off and restart the system, the error message is displayed until the correct password is entered.

Deleting or changing system and setup password

Prerequisites

NOTE: You cannot delete or change an existing system or setup password if the **Password Status** is set to **Locked**.

Steps

1. To enter System Setup, press F2 immediately after turning on or restarting your system.
2. On the **System Setup Main Menu** screen, click **System BIOS** > **System Security**.
3. On the **System Security** screen, ensure that **Password Status** is set to **Unlocked**.
4. In the **System Password** field, alter or delete the existing system password, and then press Enter or Tab.
5. In the **Setup Password** field, alter or delete the existing setup password, and then press Enter or Tab.

   If you change the system and setup password, a message prompts you to reenter the new password. If you delete the system and setup password, a message prompts you to confirm the deletion.
6. Press Esc to return to the **System BIOS** screen. Press Esc again, and a message prompts you to save the changes.
7. Select **Setup Password**, change, or delete the existing setup password and press Enter or Tab.

   NOTE: If you change the system password or setup password, a message prompts you to reenter the new password. If you delete the system password or setup password, a message prompts you to confirm the deletion.

Operating with setup password enabled

If **Setup Password** is set to **Enabled**, type the correct setup password before modifying the system setup options.

If you do not type the correct password in three attempts, the system displays the following message:

```
Invalid Password! Number of unsuccessful password attempts: <x> System Halted! Must
power down.
```

Even after you power off and restart the system, the error message is displayed until the correct password is typed. The following options are exceptions:

- If **System Password** is not set to **Enabled** and is not locked through the **Password Status** option, you can assign a system password. For more information, see the System Security Settings screen section.
- You cannot disable or change an existing system password.

NOTE: You can use the password status option with the setup password option to protect the system password from unauthorized changes.

Redundant OS Control

To view the **Redundant OS Control** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **Redundant OS Control**.

Table 82. Redundant OS Control details

Option	Description
Redundant OS Location	Enables you to select a backup disk from the following devices: • **None** • **SATA Ports in AHCI mode** • **BOSS PCIe Cards (Internal M.2 Drives)** • **Internal USB** **NOTE:** RAID configurations and NVMe cards are not included, as BIOS does not have the ability to distinguish between individual drives in those configurations. • **Internal SD card**
Redundant OS State	**NOTE:** This option is disabled if **Redundant OS Location** is set to **None**. When set to **Visible**, the backup disk is visible to the boot list and OS. When set to **Hidden**, the backup disk is disabled and is not visible to the boot list and OS. This option is set to **Visible** by default. **NOTE:** BIOS disables the device in hardware, so it is not accessed by the OS.
Redundant OS Boot	**NOTE:** This option is disabled if **Redundant OS Location** is set to **None** or if **Redundant OS State** is set to **Hidden**. When set to **Enabled**, BIOS boots to the device specified in **Redundant OS Location**. When set to **Disabled**, BIOS preserves the current boot list settings. This option is set to **Disabled** by default.

Miscellaneous Settings

To view the **Miscellaneous Settings** screen, power on the system, press F2, and click **System Setup Main Menu** > **System BIOS** > **Miscellaneous Settings**.

Table 83. Miscellaneous Settings details

Option	Description
System Time	Enables you to set the time on the system.
System Date	Enables you to set the date on the system.
Time Zone	Enables you to select required Time Zone.
Daylight Savings Time	Enables or disables Daylight Savings Time. This option is set to **Disabled** by default.
Asset Tag	Specifies the asset tag and enables you to modify it for security and tracking purposes.
Keyboard NumLock	Enables you to set whether the system boots with the NumLock enabled or disabled. This option is set to **On** by default. **NOTE:** This option does not apply to 84-key keyboards.
F1/F2 Prompt on Error	Enables or disables the F1/F2 prompt on error. This option is set to **Enabled** by default. The F1/F2 prompt also includes keyboard errors.
Load Legacy Video Option ROM	This option determines whether th system BIOS will load legacy video (INT 10h) option ROM from the video controller. This option is set to **Disabled** by default. **NOTE:** This option cannot be set to Enabled, when the Boot mode is UEFI and Secure Boot is enabled.
Dell Wyse P25/P45 BIOS Access	Enables or disables the Dell Wyse P25/P45 BIOS Access. This option is set to **Enabled** by default.

Table 83. Miscellaneous Settings details (continued)

Option	Description
Power Cycle Request	Enables or disables the Power Cycle Request. This option is set to **None** by default.

iDRAC Settings

The iDRAC settings is an interface to set up and configure the iDRAC parameters by using UEFI. You can enable or disable various iDRAC parameters by using the iDRAC settings.

NOTE: Accessing some of the features on the iDRAC settings needs the iDRAC Enterprise License upgrade.

For more information about using iDRAC, see *Dell Integrated Dell Remote Access Controller User's Guide* at iDRAC Manuals.

Device Settings

Device Settings enables you to configure device parameters such as storage controllers or network cards.

Service Tag Settings

Service Tag Settings enables you to configure the System Service Tag.

Dell Lifecycle Controller

Dell Lifecycle Controller (LC) provides advanced embedded systems management capabilities including system deployment, configuration, update, maintenance, and diagnosis. LC is delivered as part of the iDRAC out-of-band solution and Dell system embedded Unified Extensible Firmware Interface (UEFI) applications.

Embedded system management

The Dell Lifecycle Controller provides advanced embedded system management throughout the lifecycle of the system. The Dell Lifecycle Controller is started during the boot sequence and functions independently of the operating system.

NOTE: Certain platform configurations may not support the full set of features provided by the Dell Lifecycle Controller.

For more information about setting up the Dell Lifecycle Controller, configuring hardware and firmware, and deploying the operating system, see the Dell Lifecycle Controller documentation at iDRAC Manuals.

Boot Manager

The **Boot Manager** option enables you to select boot options and diagnostic utilities.

To enter **Boot Manager**, power on the system and press F11.

Table 84. Boot Manager details

Option	Description
Continue Normal Boot	The system attempts to boot to devices starting with the first item in the boot order. If the boot attempt fails, the system continues with the next item in the boot order until the boot is successful or no more boot options are found.
One-shot UEFI Boot Menu	Enables you to access boot menu, where you can select a one-time boot device to boot from.
Launch System Setup	Enables you to access System Setup.

Table 84. Boot Manager details (continued)

Option	Description
Launch Lifecycle Controller	Exits the Boot Manager and invokes the Dell Lifecycle Controller program.
System Utilities	Enables you to launch System Utilities menu such as Launch Diagnostics, BIOS update File Explorer, Reboot System.

PXE boot

You can use the Preboot Execution Environment (PXE) option to boot and configure the networked systems remotely.

To access the **PXE boot** option, boot the system and then press F12 during POST instead of using standard Boot Sequence from BIOS Setup. It does not pull any menu or allows managing of network devices.

6

Minimum to POST and system management configuration validation

This section describes the minimum to POST system requirement and system management configuration validation of the Dell system.

Topics:

Minimum configuration to POST

The components listed below are the minimum configuration to POST:

- One processor in processor socket 1
- One memory modules (DIMM) in slot A1
- One power supply unit
- System board + RIO card

Configuration validation

The new generation of Dell systems have added interconnect flexibility and advanced iDRAC management features to collect precise system configuration information and report configuration errors.

When the system is powered on, information about installed cables, risers, backplanes, power supplies, floating card (fPERC, adapter PERC , BOSS), and processor is obtained from the CPLD and backplane memory maps are analyzed. This information forms a unique configuration, which is compared with one of the qualified configurations that are stored in a table that is maintained by iDRAC.

One or more sensors are assigned to each of the configuration elements. During POST, any configuration validation error is logged in the System Event Log (SEL)/LifeCycle (LC) log. The reported events are categorized in the configuration validation error table.

Table 85. Configuration validation error

Error	Description	Possible cause and recommendations	Example
Config Error	A configuration element within the closest match contains something that is unexpected and does not match any Dell qualified configuration.	Wrong configuration	Config Error: Backplane cable CTRS_SRC_SA1 and BP-DST_SA1
		The element reported in HWC8010 errors are assembled incorrectly. Verify element (cable, risers, etc) placement in the system.	Config Error : SL Cable PLANAR_SL7 and CTRL_DST_PA1
Config Missing	iDRAC found a configuration element missing within the closest match detected.	Missing or damaged cable, device, or part	Config Missing: Float card front PERC/HBAadapter PERC/HBA
		Missing element or cable is reported in HWC8010 error logs. Install the	Config Missing : SL cable PLANAR_SL8 and CTRL_DST_PA1

Table 85. Configuration validation error (continued)

Error	Description	Possible cause and recommendations	Example
		missing element (cable, risers, etc).	
Comm Error	A configuration element is not responding to iDRAC using the management interface while running an inventory check.	System management sideband communication	Comm Error: Backplane 2
		Unplug AC Power, reseat the element and replace the element if the problem persists.	

Error messages

This section describes the error messages that are displayed on the screen during POST or captured in the system event log (SEL)/LifeCycle (LC) log.

Table 86. Error message HWC8010

Error code	HWC8010
Message	The System Configuration Check operation that is resulted in the following issue involving the indicated component type
Arguments	Riser, floating card (fPERC, adapter PERC, BOSS), backplane, processor, cable, or other components
Detailed Description	The issue that is identified in the message is observed in the System Configuration Check operation.
Recommended Response Action	Do the following and retry the operation: 1. Disconnect the input power. 2. Check for proper cable connection and component placement. If the issue persists, contact the service provider.
Category	System Health (HWC = Hardware Config)
Severity	Critical
Trap/EventID	2329

Table 87. Error message HWC8011

Error code	HWC8011
Message	The System Configuration Check operation that is resulted in multiple issues involving the indicated component type
Arguments	Riser, floating card (fPERC, adapter PERC, BOSS), backplane, processor, cable, or other components
Detailed Description	Multiple issues are observed in the System Configuration Check operation.
Recommended Response Action	Do the following and retry the operation: 1. Disconnect the input power. 2. Check for proper cable connection and component placement. If the issue persists, contact the service provider.
Category	System Health (HWC = Hardware Config)
Severity	Critical

7

Disassembly and reassembly

Topics:

Safety instructions

NOTE: Whenever you need to lift the system, get others to assist you. To avoid injury, do not attempt to lift the system by yourself.

CAUTION: Ensure that two or more people lift the system horizontally from the box and place it on a flat surface, rack lift, or into the rails.

WARNING: Opening or removing the system cover while the system is powered on may expose you to a risk of electric shock.

WARNING: Do not operate the system without the cover for a duration exceeding five minutes. Operating the system without the system cover can result in component damage.

CAUTION: Many repairs may only be done by a certified service technician. You should only perform troubleshooting and simple repairs as authorized in your product documentation, or as directed by the online or telephone service and support team. Damage due to servicing that is not authorized by Dell is not covered by your warranty. Read and follow the safety instructions that are shipped with your product.

NOTE: It is recommended that you always use an antistatic mat and antistatic strap while working on components inside the system.

CAUTION: To ensure proper operation and cooling, all system bays and fans must always be populated with a component or a blank.

NOTE: While replacing the hot swappable PSU, after next server boot, the new PSU automatically updates to the same firmware and configuration of the replaced one. For updating to the latest firmware and changing the configuration, see the *Lifecycle Controller User's Guide* at iDRAC Manuals.

NOTE: While replacing faulty storage controller, FC, or NIC card with the same type of card, after you power on the system, the new card automatically updates to the same firmware and configuration of the faulty one. For updating to the latest firmware and changing the configuration, see the *Lifecycle Controller User's Guide* at iDRAC Manuals.

CAUTION: Do not install GPUs, network cards, or other PCIe devices on your system that are not validated and tested by Dell. Damage caused by unauthorized and invalidated hardware installation will null and void the system warranty.

NOTE: Only use certified Optical Fiber Transceiver Class I Laser Products.

Before working inside your system

Prerequisites

Follow the safety guidelines listed in the Safety instructions.

Steps

1. Power off the system and all attached peripherals.
2. Disconnect the system from the electrical outlet and disconnect the peripherals.
3. If applicable, remove the system from the rack.
   For more information, see the *Rail Installation Guide* relevant to your rail solutions at PowerEdge Manuals.
4. Remove the system cover.

   NOTE:

   While removing the hot-swappable components from the front or rear of the system, do not remove the system cover.

After working inside your system

Prerequisites

Follow the safety guidelines listed in Safety instructions.

Steps

1. Replace the system cover.
2. If applicable, install the system into the rack.
   For more information, see the *Rail Installation Guide* relevant to your system at PowerEdge Manuals.
3. Reconnect the peripherals and connect the system to the electrical outlet, and then power on the system.

Recommended tools

You may need some or all the following tools to perform the removal and installation procedures:

- Key to the bezel lock. The key is required only if your system includes a bezel.
- Phillips 1 screwdriver
- Phillips 2 screwdriver
- Torx T30 screwdriver
- 5 mm hexadecimal nut screwdriver
- Plastic scribe
- 1/4-inch flat blade screwdriver
- Wrist grounding strap that is connected to the ground
- ESD mat
- Needle-nose pliers

You need the following tools to assemble the cables for a DC power supply unit:

- AMP 90871-1 hand-crimping tool or equivalent
- Tyco Electronics 58433-3 or equivalent
- Wire-stripper pliers to remove insulation from size 10 AWG solid or stranded, insulated copper wire.

NOTE: Use alpha wire part number 3080 or equivalent (65/30 stranding).

NOTE: For information about DC PSU cabling instructions, go to PowerEdge Manuals > **Rack Servers** > PowerEdge R760 > **Select This Product** > **Documentation** > **Manuals and Documents** > *Cabling instructions for – 48 – 60 V DC power supply*.

Optional front bezel

NOTE: LCD panel is optional on the front bezel. If the front bezel has an LCD panel, see LCD panel section.

Removing the front bezel

The procedure to remove the front bezel with and without the LCD panel is the same.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Keep the bezel key handy.

NOTE: The bezel key is part of the LCD bezel package.

Steps

1. Unlock the bezel.
2. Press the release button, and disengage the left end of the bezel.
3. Unhook the right end, and remove the bezel.

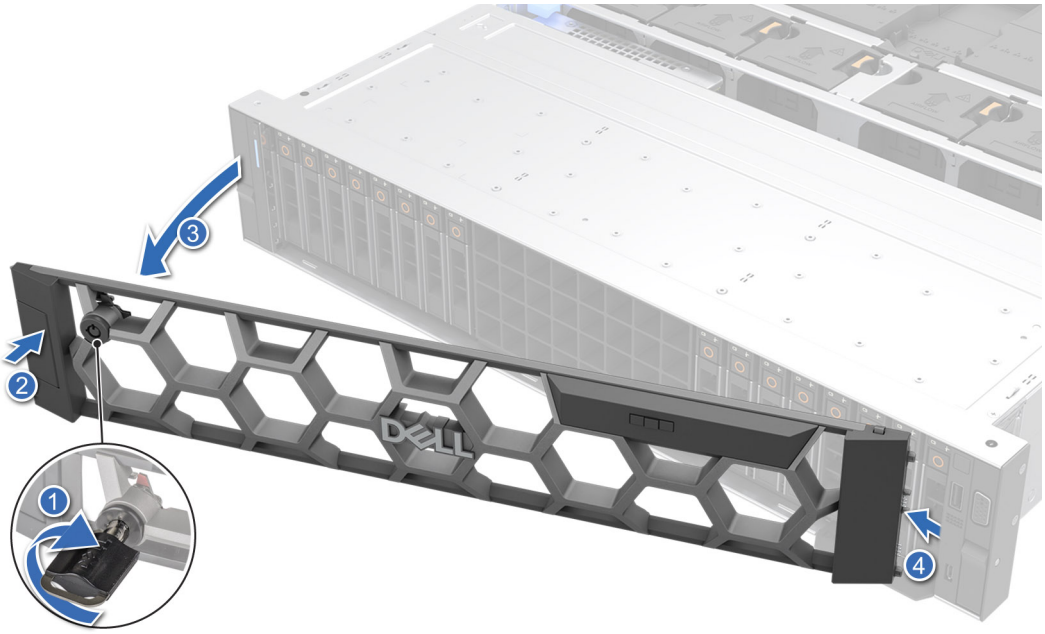


Figure 37. Removing the front bezel with the LCD panel

Next steps

Replace front bezel.

Installing the front bezel

The procedure to install the front bezel with and without the LCD panel is the same.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Locate and remove the bezel key.

NOTE: The bezel key is part of the LCD bezel package.

Steps

1. Align and insert the tabs on the bezel into the slots on the system.
2. Press the bezel until the release button clicks in place.
3. Lock the bezel.

Figure 38. Installing the front bezel with the LCD panel

System cover

Removing the system cover

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Power off the system, and any attached peripherals.
3. Disconnect the system from the electrical outlet and peripherals.

Steps

1. Using a 1/4-inch flat head or a Phillips #2 screwdriver, rotate the lock counterclockwise to the unlock position.
2. Lift the release latch until the system cover slides back.
3. Lift the cover from the system.

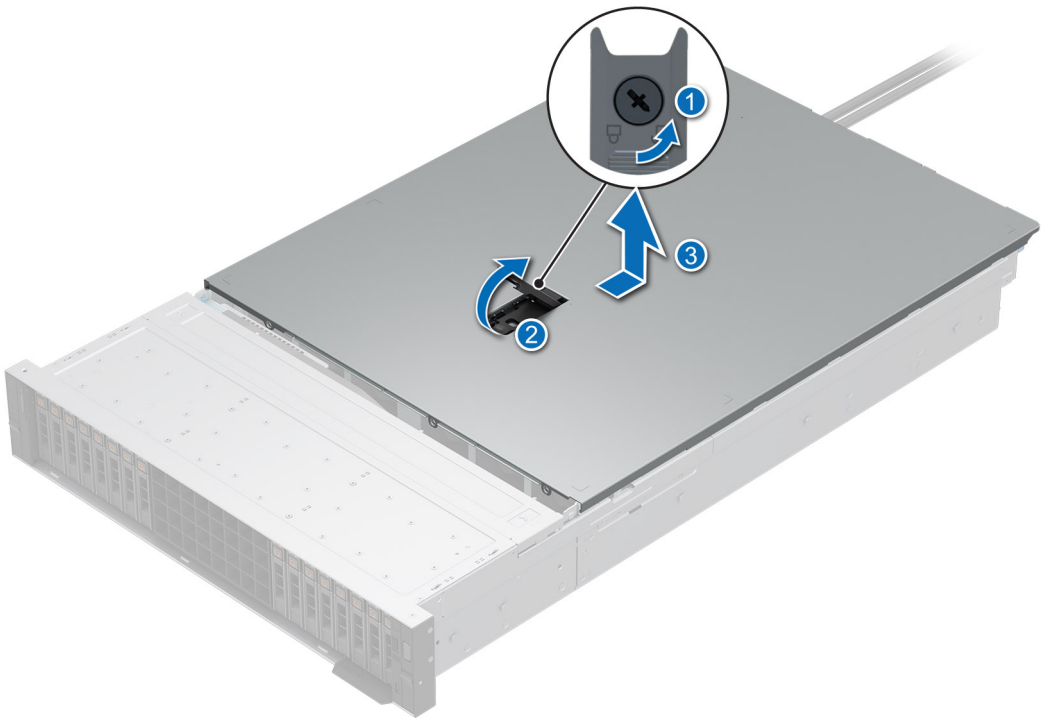


Figure 39. Removing the system cover

Next steps

1. Replace the system cover.

Installing the system cover

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Ensure that all internal cables are connected and routed properly, and no tools or extra parts are left inside the system.

Steps

1. Align the tabs on the system cover with the guide slots on the system and slide the system cover.
2. Close the system cover release latch.
3. Using a 1/4-inch flat head or Phillips #2 screwdriver, rotate the lock clockwise to the lock position.

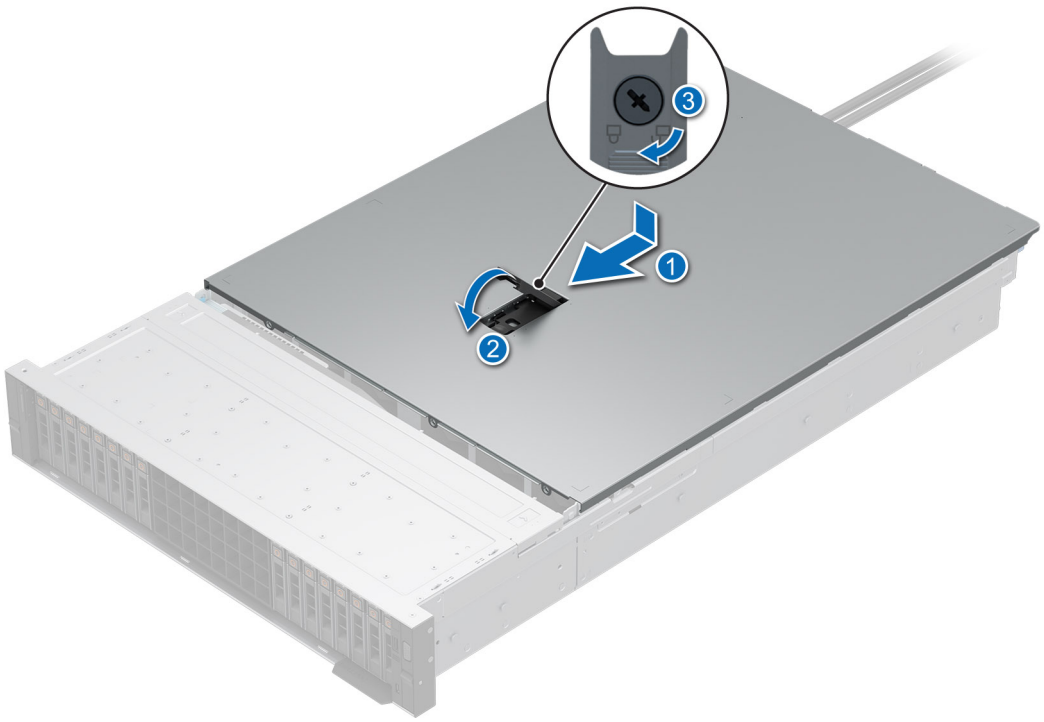


Figure 40. Installing the system cover

Next steps

1. Follow the procedure listed in After working inside your system.

Drive backplane cover

Removing the drive backplane cover

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

1. Slide the drive backplane cover in the direction of the arrows marked on the drive backplane cover.
2. Lift the drive backplane cover from the system.

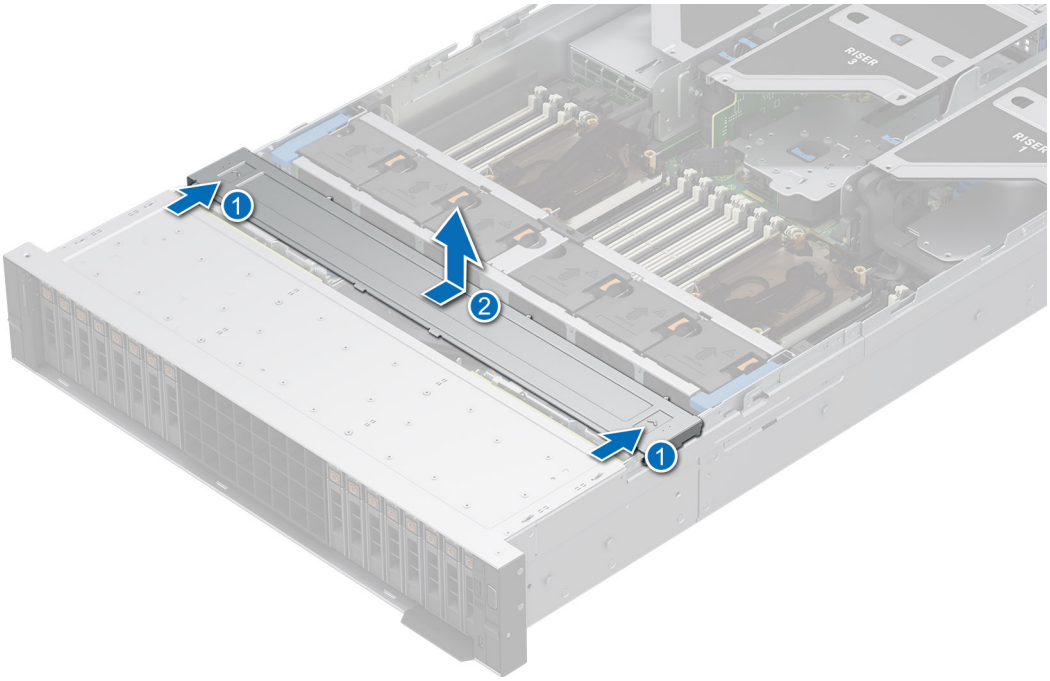


Figure 41. Removing the drive backplane cover

Next steps

1. Replace the drive backplane cover.

Installing the drive backplane cover

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

1. Align the drive backplane cover with the guide slots on the system.
2. Slide the drive backplane cover to the front of the system until the drive backplane cover fits into place.

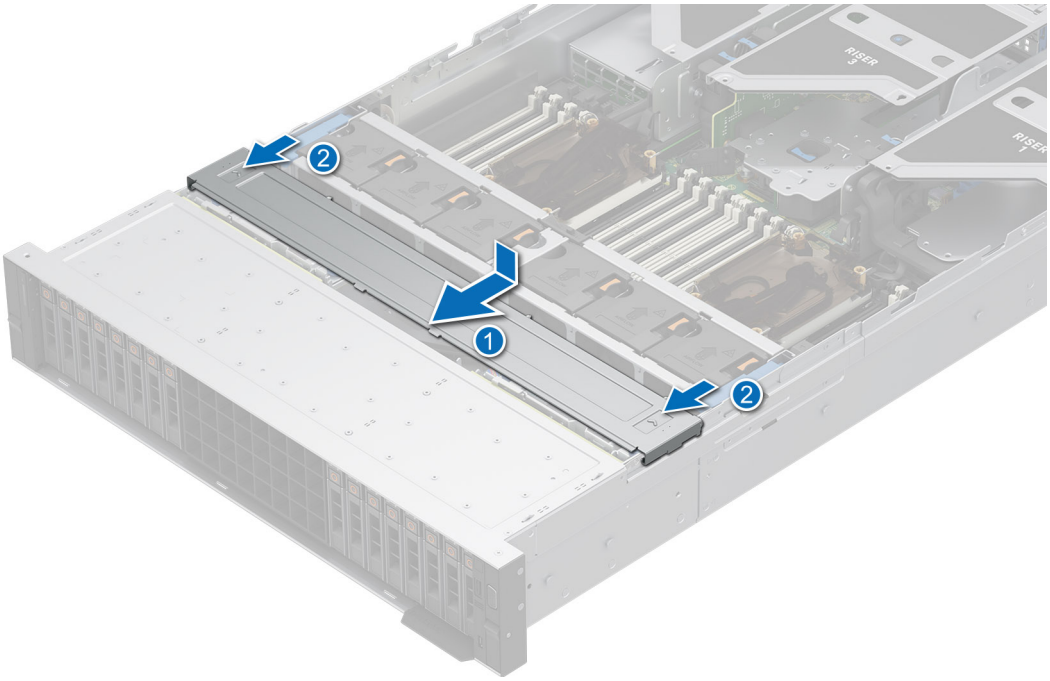


Figure 42. Installing the drive backplane cover

Next steps

1. Follow the procedure listed in After working inside your system.

Air shrouds

Removing the air shroud

Prerequisites

CAUTION: Never operate your system with the air shroud removed. The system may get overheated quickly, resulting in shutdown of the system and loss of data.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

Hold the edges of the air shroud, and lift the air shroud out of the system.

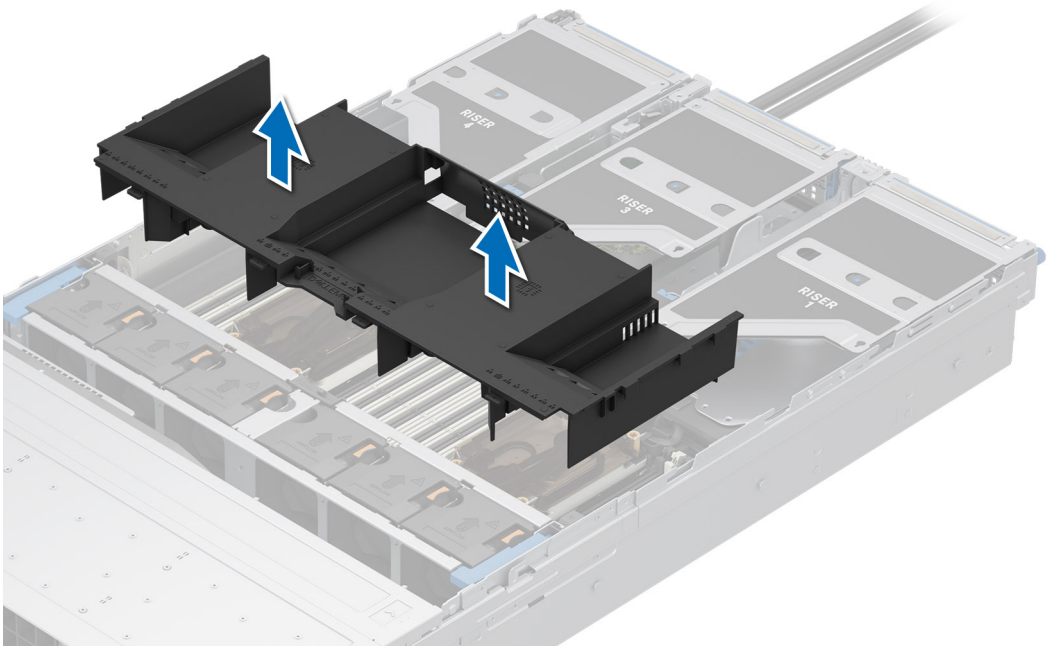


Figure 43. Removing the air shroud

Next steps

1. Replace the air shroud.

Installing the air shroud

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

1. Tilt the air shroud at an angle and align the air shroud tabs with the system slots.

   NOTE: Ensure that the air shroud tabs are below the surface of the cooling cage fan assembly.

2. Lower the air shroud into the system until it is firmly seated.

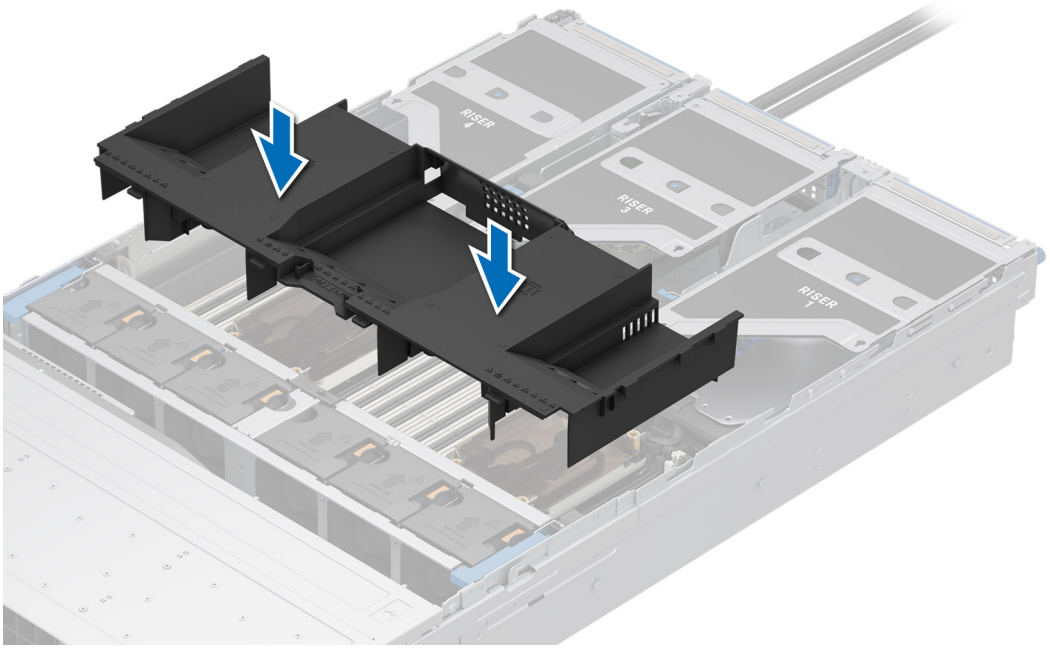


Figure 44. Installing the air shroud

Next steps

1. Follow the procedure listed in After working inside your system.

Removing the GPU air shroud top cover

Prerequisites

CAUTION: Never operate your system with the air shroud removed. The system may get overheated quickly, resulting in shutdown of the system and loss of data.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

Press the tabs on either sides of the top cover, and lift the top cover out of the GPU air shroud.

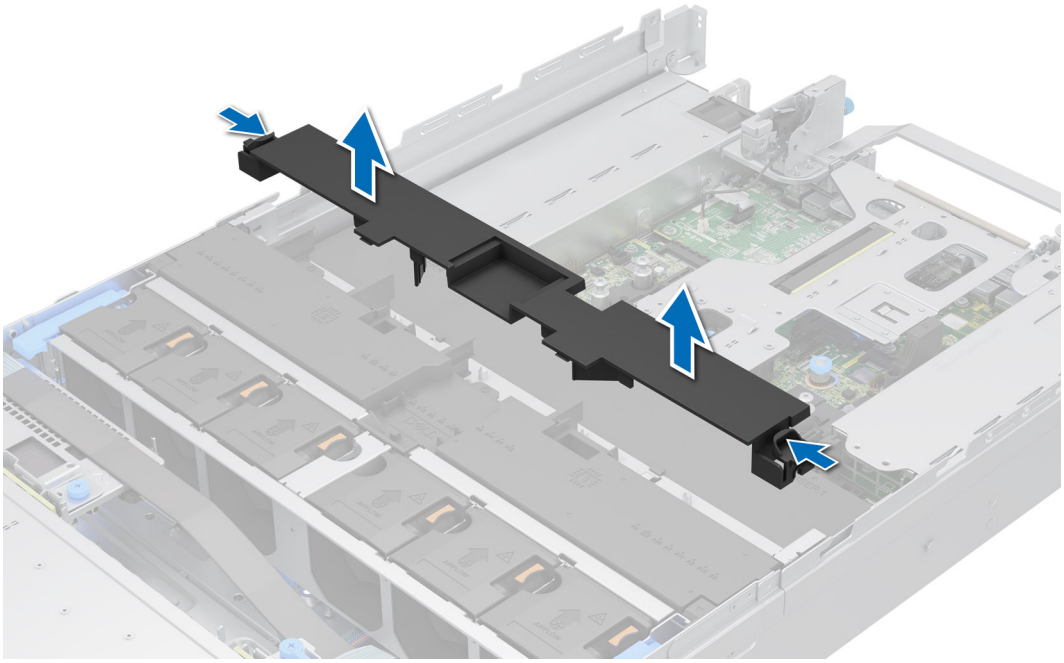


Figure 45. Removing the GPU air shroud top cover

Next steps

1. Replace the GPU air shroud top cover.

Installing the GPU air shroud top cover

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

1. Align the tabs on the top cover with the slots on the GPU air shroud.
2. Press the top cover into the GPU air shroud until it is firmly seated.

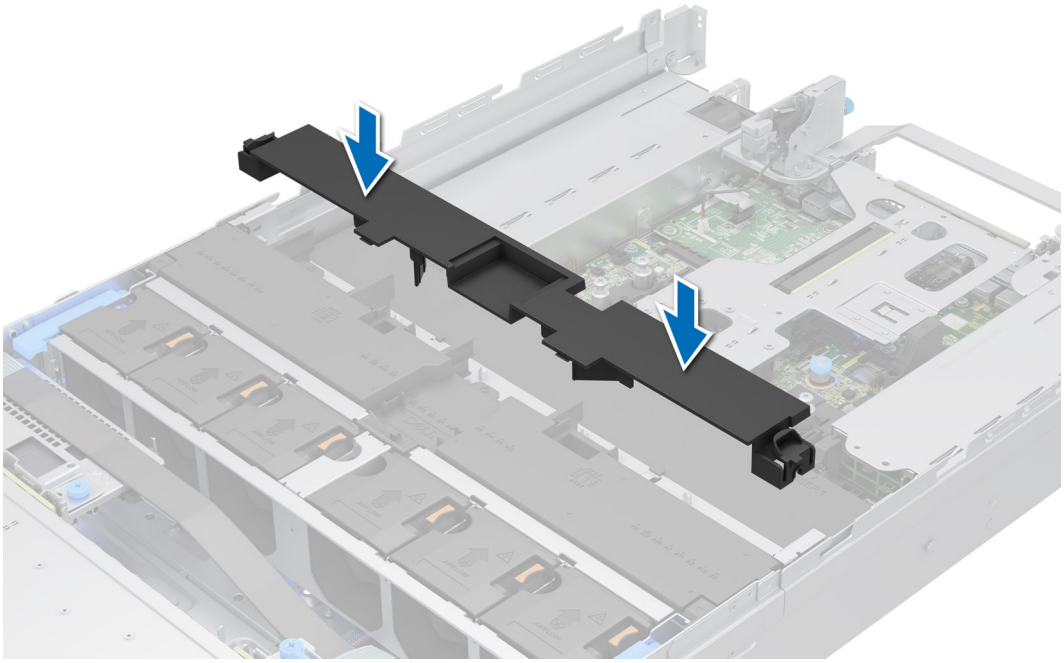


Figure 46. Installing the GPU air shroud top cover

Next steps

1. Follow the procedure listed in After working inside your system.

Removing the GPU air shroud filler

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

CAUTION: Never operate your system with the air shroud removed. The system may get overheated quickly, resulting in shutdown of the system and loss of data.

3. Remove the GPU air shroud top cover.

NOTE: The GPU air shroud filler must be removed to avoid interference with full length double-width GPU card installation.

Steps

Hold and lift the filler from the GPU air shroud.

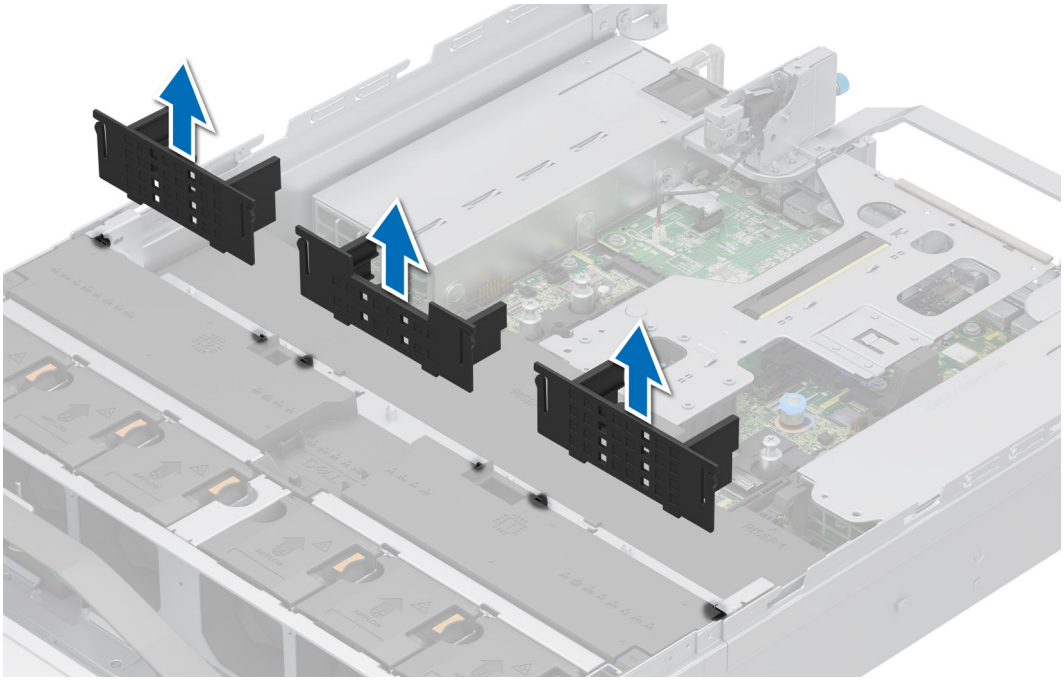


Figure 47. Removing the GPU air shroud filler

Next steps

1. Replace the GPU air shroud filler.

Installing the GPU air shroud filler

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the GPU air shroud top cover.
4. If required, remove the full length expansion card risers.

NOTE: The GPU air shroud filler must be installed, if single-width GPU card or empty riser is used.

Steps

Align and install the filler into the slots on the GPU air shroud.

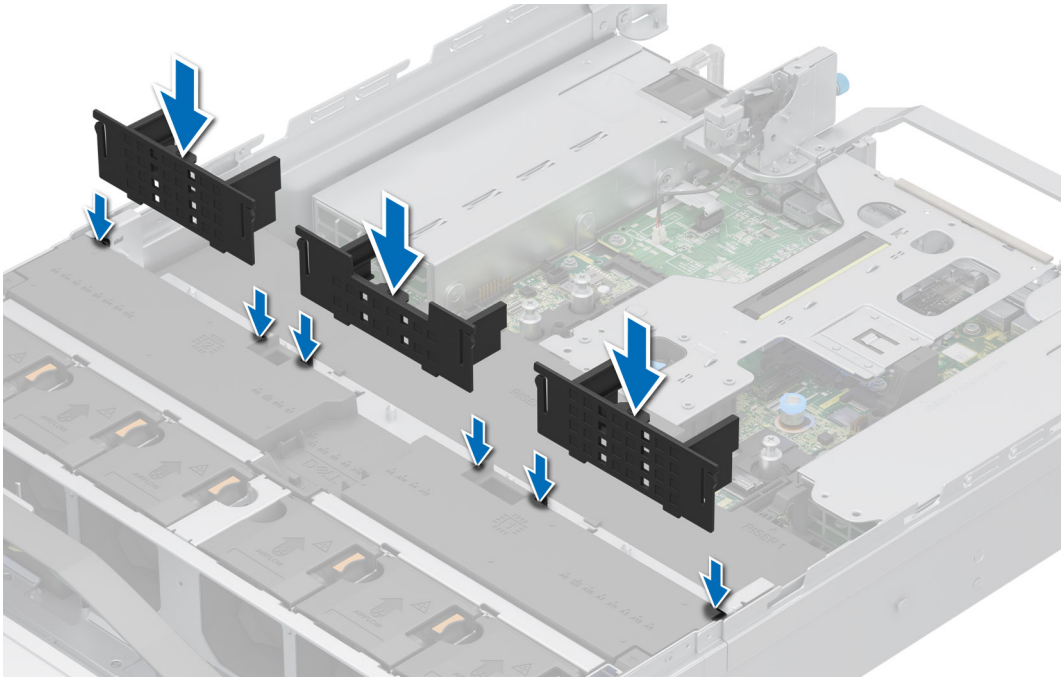


Figure 48. Installing the GPU air shroud filler

Next steps

1. Install the GPU air shroud top cover.
2. Follow the procedure listed in After working inside your system.

Removing the GPU air shroud

Prerequisites

CAUTION: Never operate your system with the air shroud removed. The system may get overheated quickly, resulting in shutdown of the system and loss of data.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the GPU air shroud top cover.
4. Remove the full length expansion card risers.

Steps

Hold the edges of the GPU air shroud, and lift the air shroud out of the system.

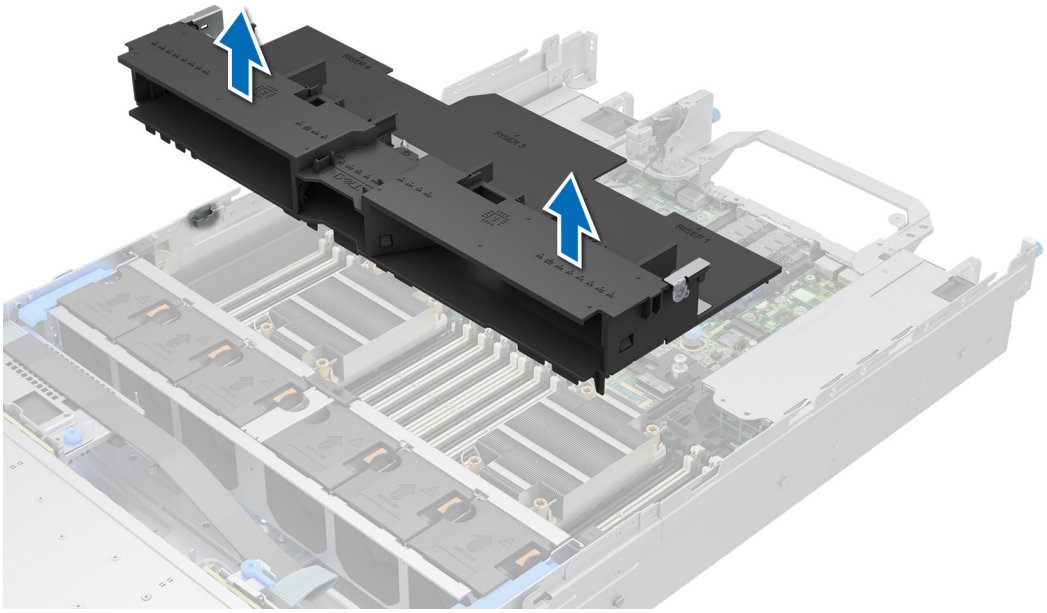


Figure 49. Removing the GPU air shroud

Next steps

1. Replace the GPU air shroud.

Installing the GPU air shroud

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the GPU air shroud top cover.
4. Remove the full length expansion card risers.

Steps

1. Align the tabs on the GPU air shroud with the slots on the system.
2. Lower the GPU air shroud into the system until it is firmly seated.

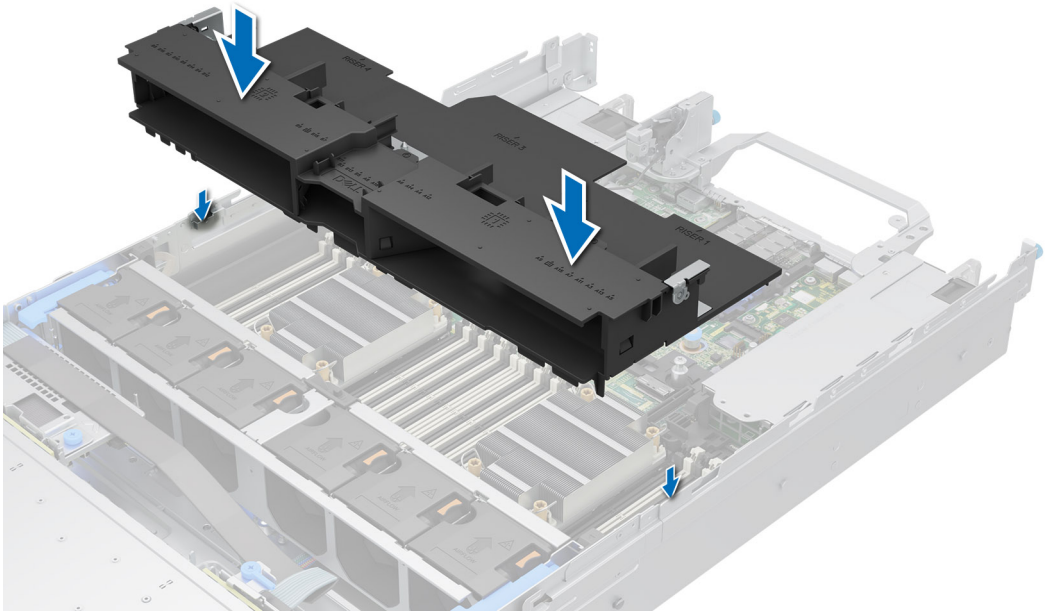


Figure 50. Installing the GPU air shroud

Next steps

1. Install the full length expansion risers.
2. Install the GPU air shroud top cover.
3. Follow the procedure listed in After working inside your system.

Removing the 2 x 2.5-inch rear drive module air shroud

Prerequisites

CAUTION: Never operate your system with the air shroud removed. The system may get overheated quickly, resulting in shutdown of the system and loss of data.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

Press the orange release tabs and lift the air shroud out of the rear drive module.

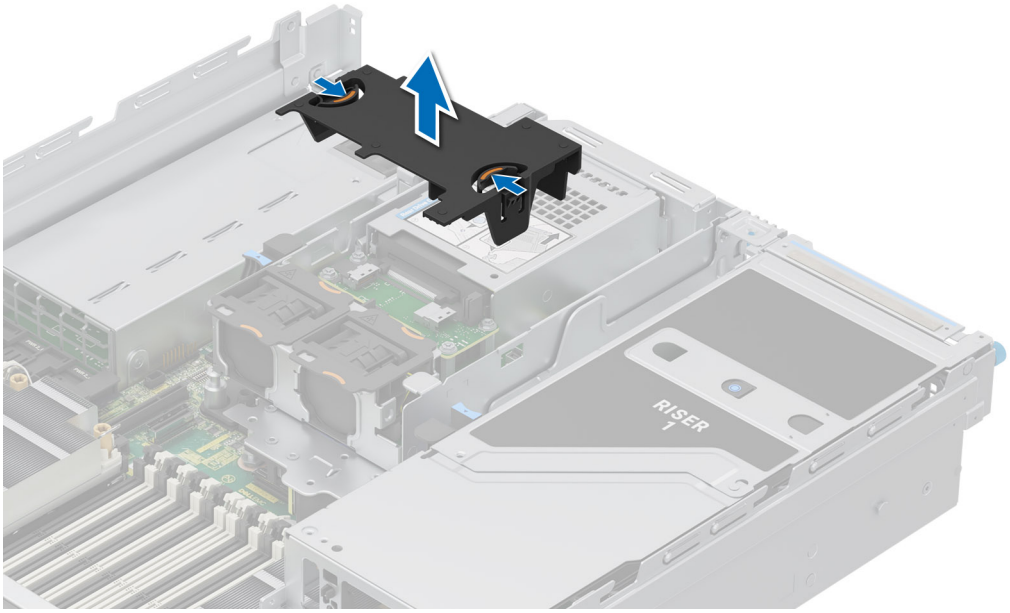


Figure 51. Removing the 2 x 2.5-inch rear drive module air shroud

Next steps

1. Replace the 2 x 2.5-inch rear drive module air shroud.

Installing the 2 x 2.5-inch rear drive module air shroud

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

1. Align the tabs on the air shroud with the slots on the rear drive module.
2. Lower the air shroud into the rear drive module until it is firmly seated.

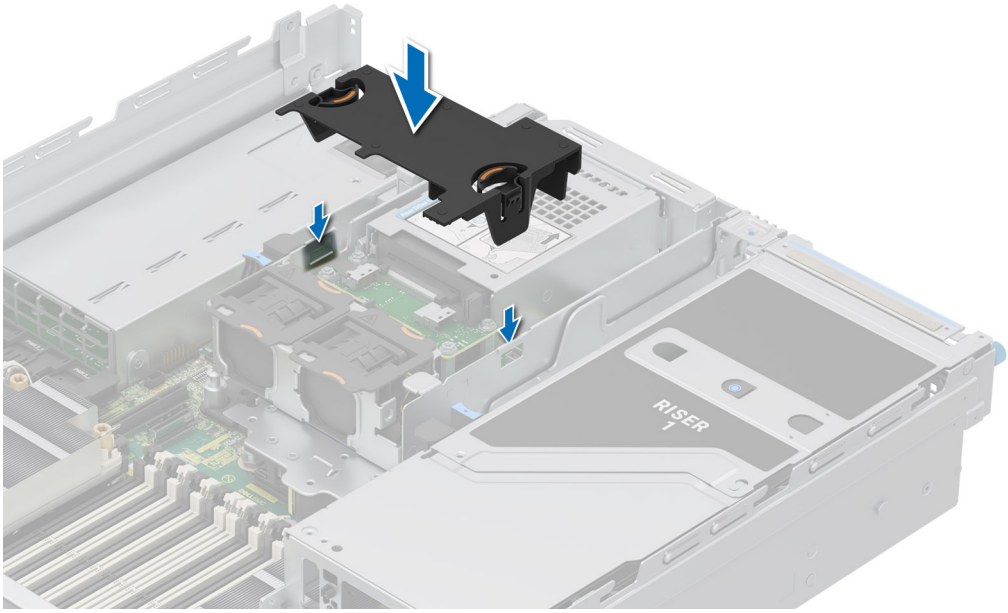


Figure 52. Installing the 2 x 2.5-inch rear drive module air shroud

Next steps

1. Follow the procedure listed in After working inside your system.

Removing the 4 x 2.5-inch rear drive module air shroud

Prerequisites

CAUTION: Never operate your system with the air shroud removed. The system may get overheated quickly, resulting in shutdown of the system and loss of data.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

Press the orange release tabs and lift the air shroud out of the rear drive module.

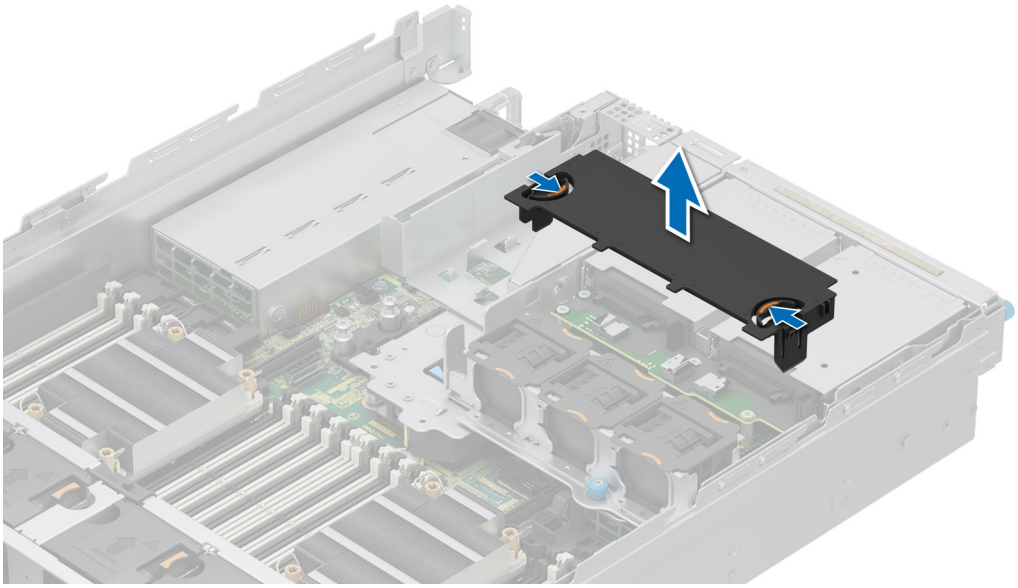


Figure 53. Removing the 4 x 2.5-inch rear drive module air shroud

Next steps

1. Replace the 4 x 2.5-inch rear drive module air shroud.

Installing the 4 x 2.5-inch rear drive module air shroud

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

1. Align the tabs on the air shroud with the slots on the rear drive module.
2. Lower the air shroud into the rear drive module until it is firmly seated.

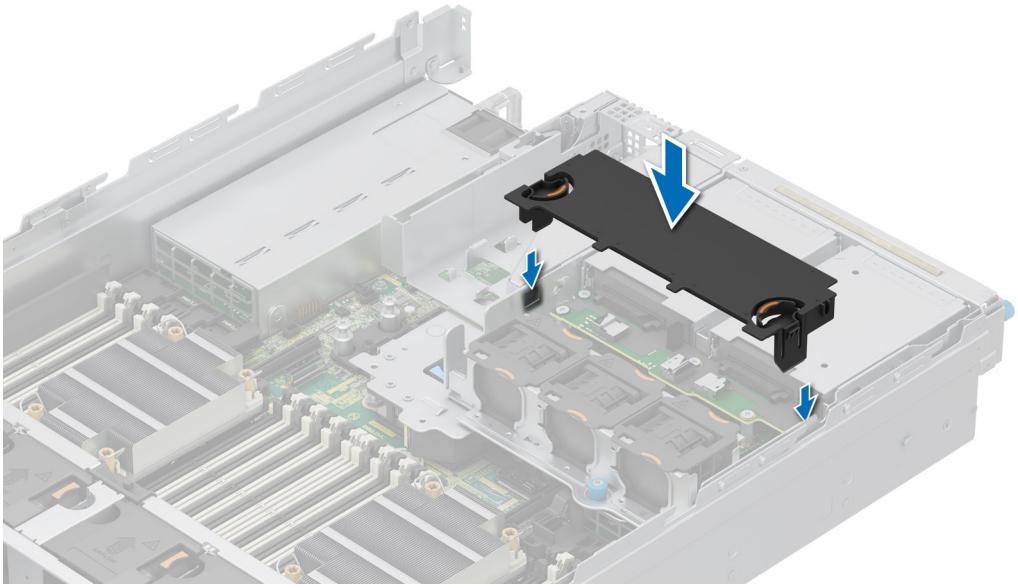


Figure 54. Installing the 4 x 2.5-inch rear drive module air shroud

Next steps

1. Follow the procedure listed in After working inside your system.

Removing the EDSFF E3.S rear drive module air shroud

Prerequisites

CAUTION: Never operate your system with the air shroud removed. The system may get overheated quickly, resulting in shutdown of the system and loss of data.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

Press the release tabs and lift the air shroud out of the rear drive module.

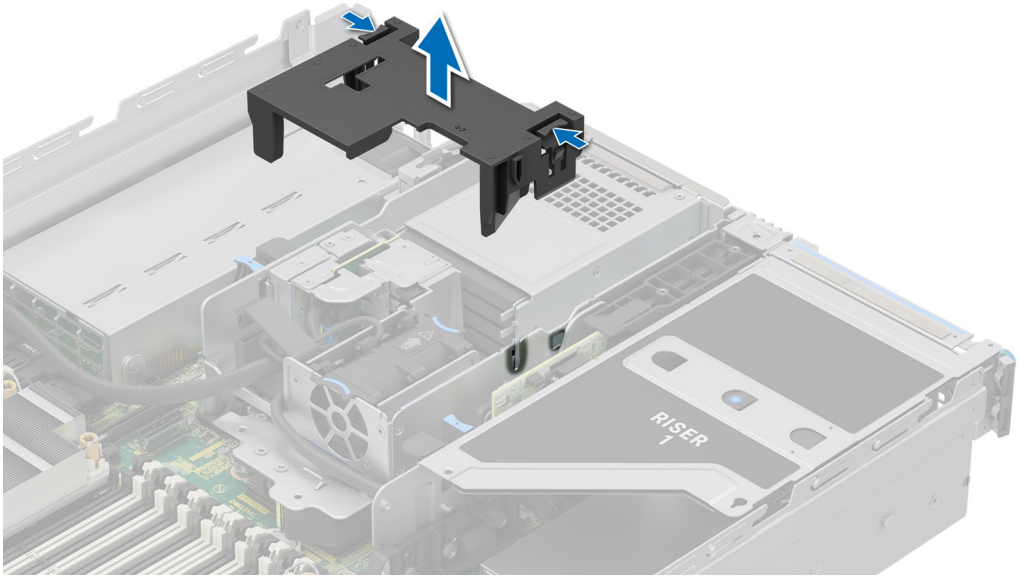


Figure 55. Removing the EDSFF E3.S rear drive module air shroud

Next steps

1. Replace the EDSFF E3.S rear drive module air shroud.

Installing the EDSFF E3.S rear drive module air shroud

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

1. Align the tabs on the air shroud with the slots on the rear drive module.
2. Lower the air shroud into the rear drive module until it is firmly seated.

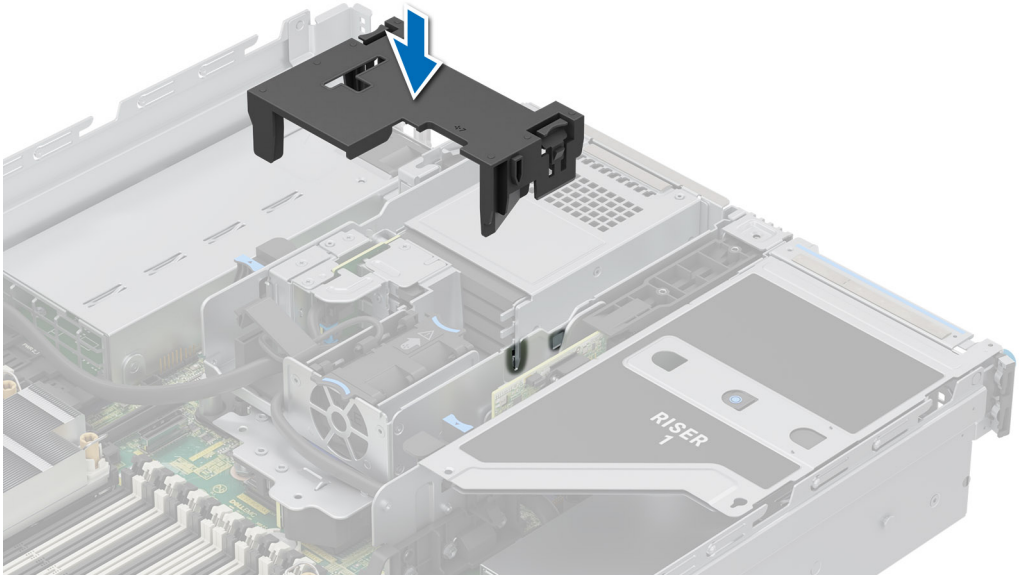


Figure 56. Installing the EDSFF E3.S rear drive module air shroud

Next steps

1. Follow the procedure listed in After working inside your system.

Cooling fans

Removing the cooling fan cage assembly

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. If required, remove the air shroud or remove the GPU air shroud.

Steps

1. Lift the blue release levers to unlock the cooling fan cage assembly from the system.
2. Hold the release levers, and lift the cooling fan cage assembly away from the system.

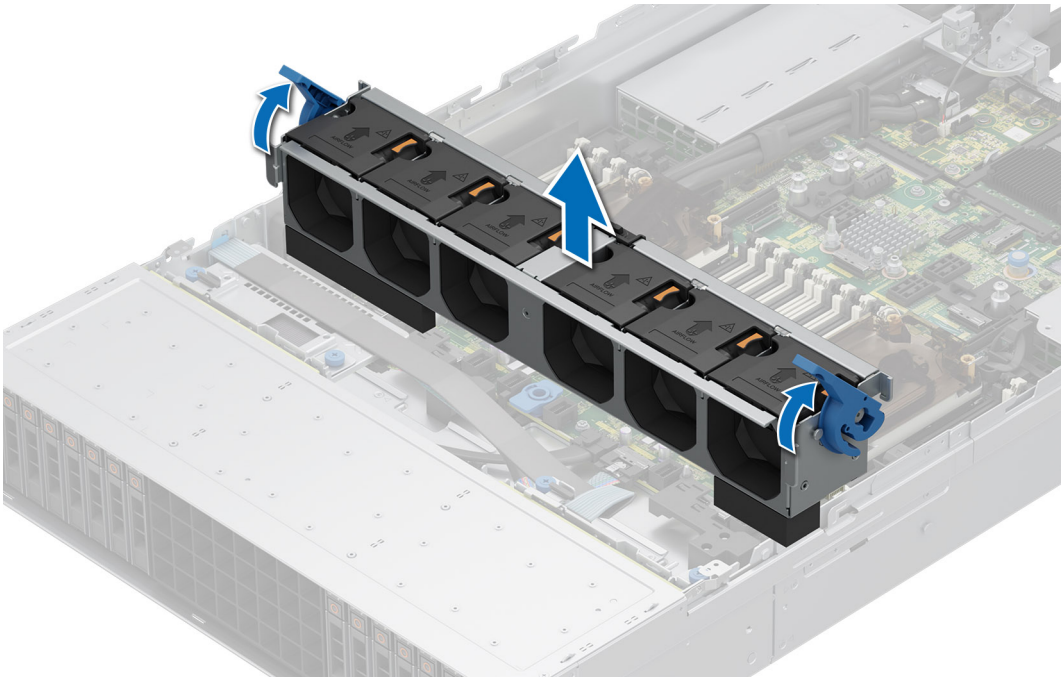


Figure 57. Removing the cooling fan cage assembly

Next steps

1. Replace the cooling fan cage assembly.

Installing the cooling fan cage assembly

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.

> **CAUTION: Ensure that the cables inside the system are correctly installed and retained by the cable retention bracket before installing the cooling fan cage assembly. Incorrectly installed cables may get damaged.**

2. Follow the procedure listed in Before working inside your system.
3. If installed, remove the air shroud or remove the GPU air shroud.

Steps

1. Holding the blue release lever of the cooling fan cage, align the guide rails with the guides on the system.
2. Lower the cooling fan cage assembly into the system until seated firmly.
3. Lower the blue release lever and press to lock the cooling fan cage assembly into the system.

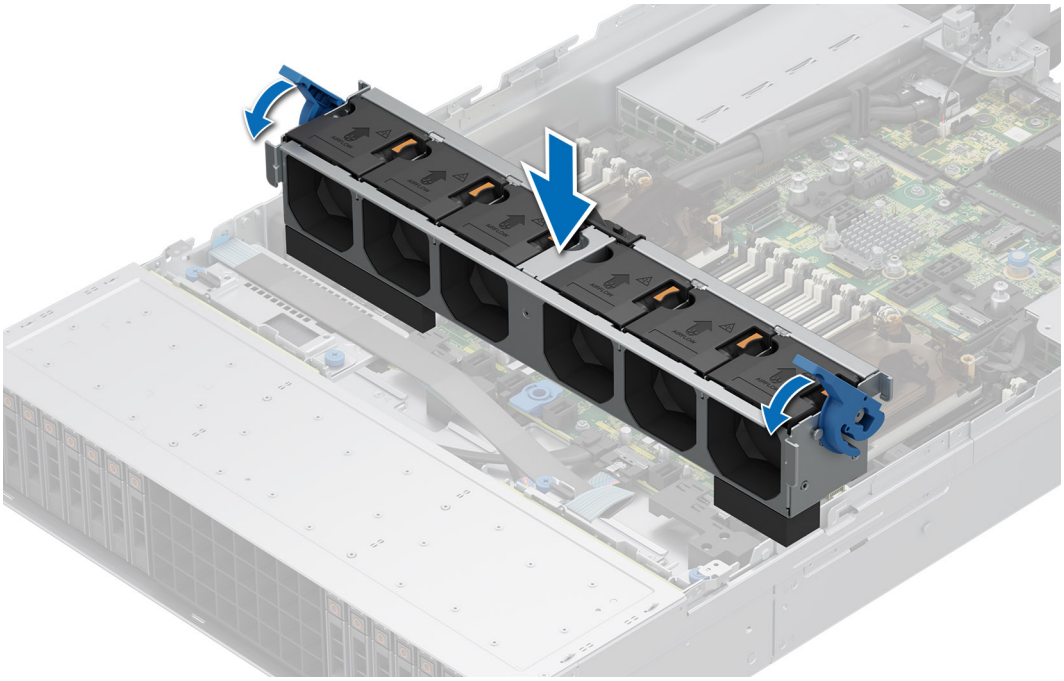


Figure 58. Installing the cooling fan cage assembly

Next steps

1. If removed, install the air shroud or install the GPU air shroud.
2. Follow the procedure listed in After working inside your system.

Removing a cooling fan

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

NOTE: The procedure for removing a standard (STD), high-performance silver grade (HPR SLVR), or high-performance gold grade (HPR GOLD) fan is the same.

Steps

Press the orange release tab and lift the cooling fan to disconnect the fan from the connector on the system board.

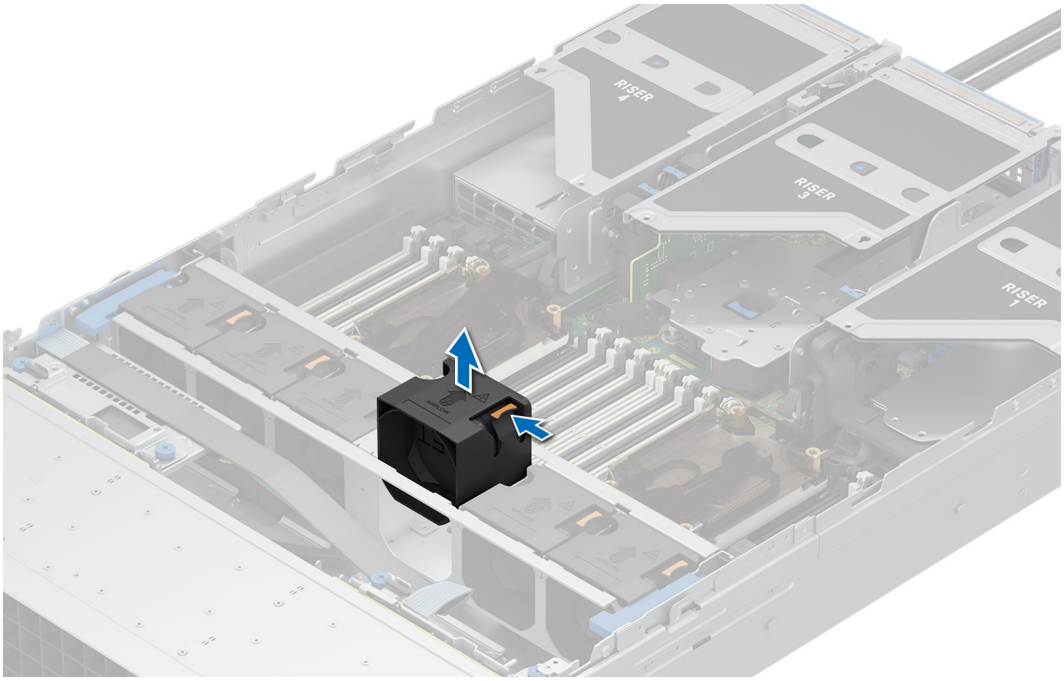


Figure 59. Removing a cooling fan

Next steps

1. Replace a cooling fan.

Installing a cooling fan

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

NOTE: The procedure to installing a standard (STD), high-performance silver grade (HPR SLVR), or high-performance gold grade (HPR GOLD) fan is the same.

Steps

Align and lower the cooling fan into the cooling fan assembly until the fan clicks into place.

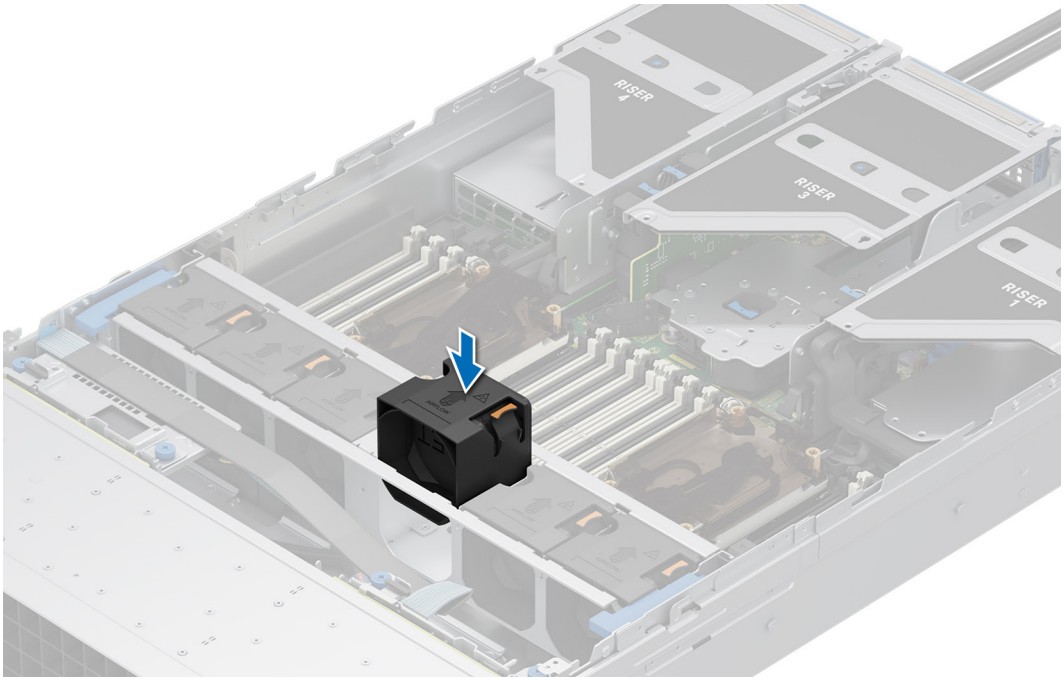


Figure 60. Installing a cooling fan

Next steps

1. Follow the procedure listed in After working inside your system.

Removing a 2 x 2.5-inch rear drive module cooling fan

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the 2 x 2.5-inch rear drive module air shroud.

Steps

Press the orange release tab and lift the rear drive module cooling fan to disconnect from the connector on the rear drive module.

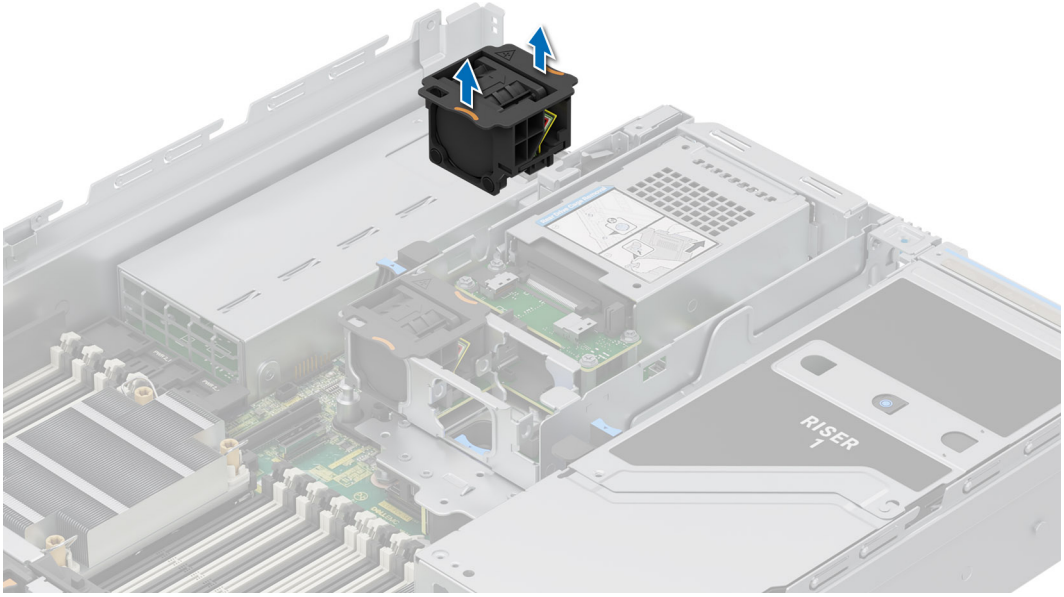


Figure 61. Removing a 2 x 2.5-inch rear drive module cooling fan

Next steps

1. Replace 2 x 2.5-inch rear drive module cooling fan.

Installing a 2 x 2.5-inch rear drive module cooling fan

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the 2 x 2.5-inch rear drive module air shroud.

Steps

Align and lower the rear drive module cooling fan into the rear drive module until the fan clicks into place.

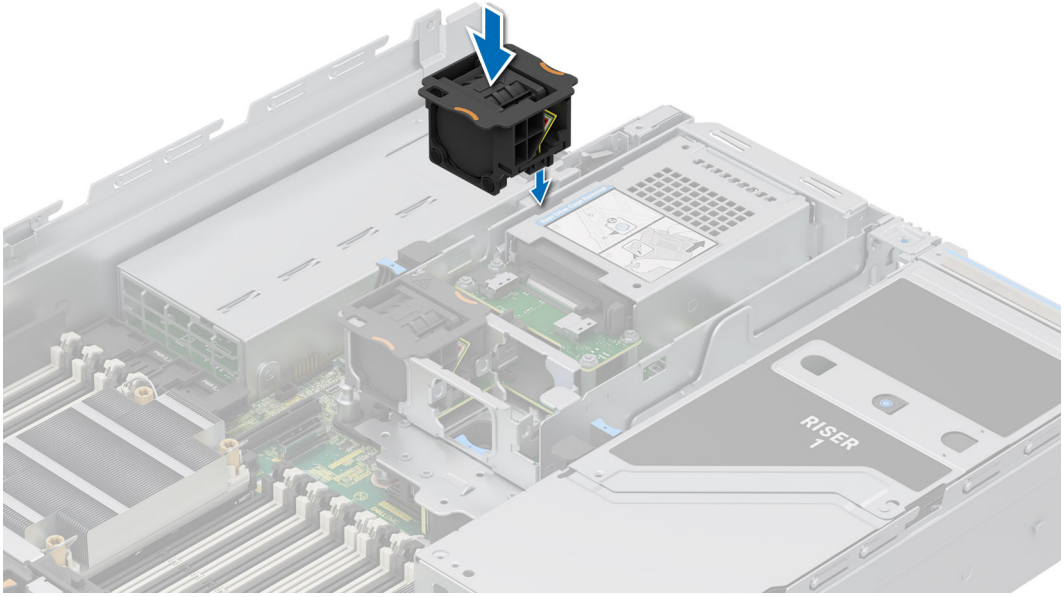


Figure 62. Installing a 2 x 2.5-inch rear drive module cooling fan

Next steps

1. Install the 2 x 2.5-inch rear drive module air shroud.
2. Follow the procedure listed in After working inside your system.

Removing a 4 x 2.5-inch rear drive module cooling fan

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the 4 x 2.5-inch rear drive module air shroud.

Steps

Press the orange release tab and lift the rear drive module cooling fan to disconnect from the connector on the rear drive module.

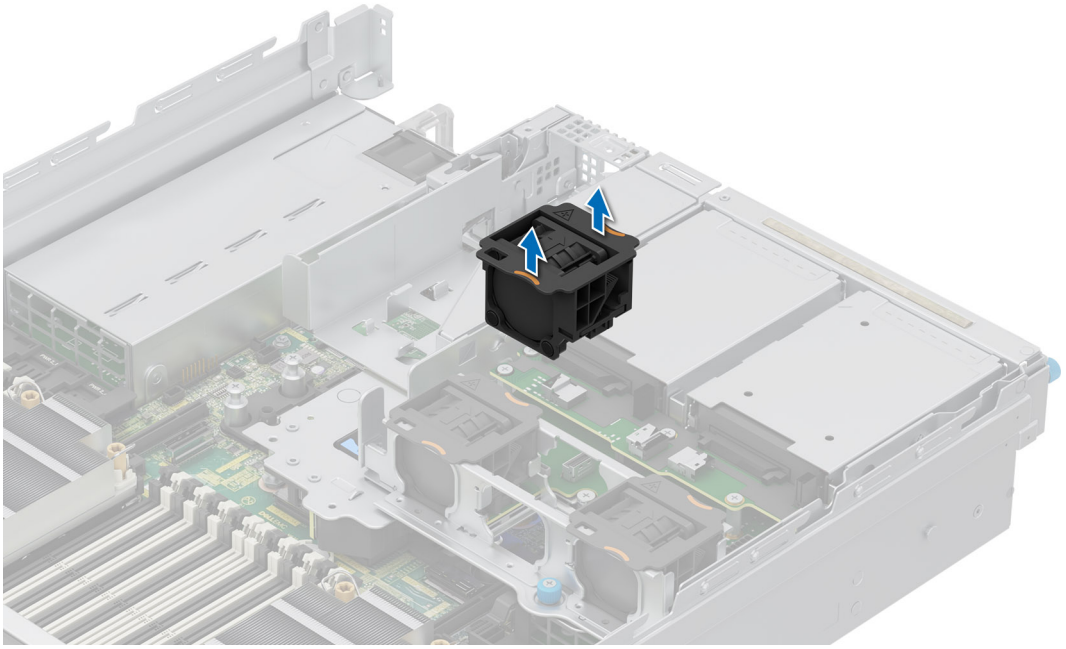


Figure 63. Removing a 4 x 2.5-inch rear drive module cooling fan

Next steps

1. Replace 4 x 2.5-inch rear drive module cooling fan.

Installing a 4 x 2.5-inch rear drive module cooling fan

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the 4 x 2.5-inch rear drive module air shroud.

Steps

Align and lower the rear drive module cooling fan into the rear drive module until the fan clicks into place.

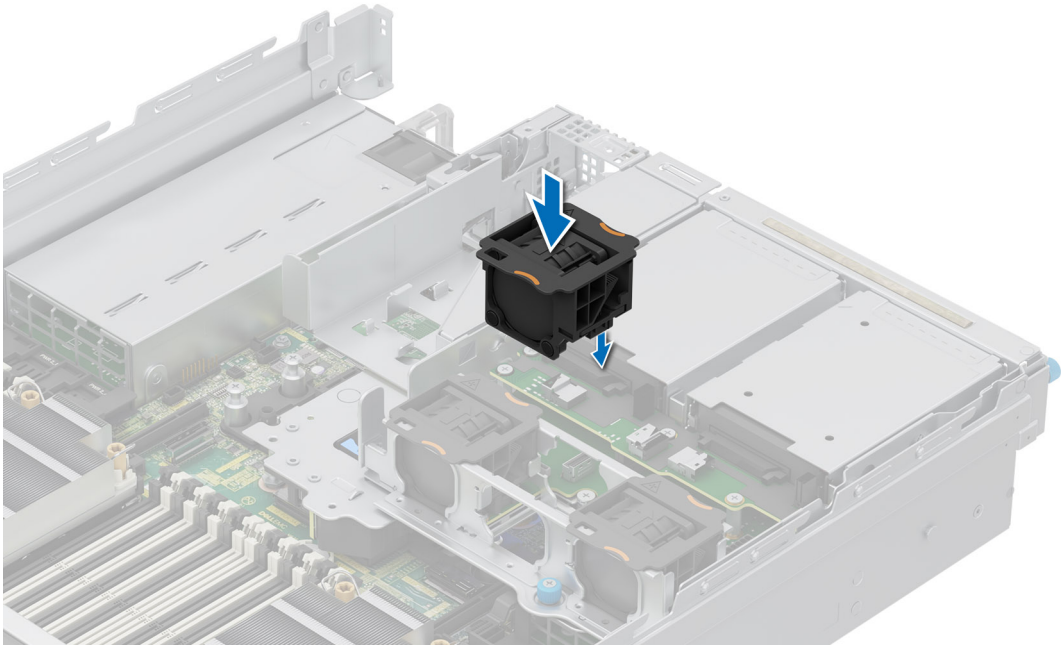


Figure 64. Installing a 4 x 2.5-inch rear drive module cooling fan

Next steps

1. Install the 4 x 2.5-inch rear drive module air shroud.
2. Follow the procedure listed in After working inside your system.

Removing the EDSFF E3.S rear drive module cooling fan

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the EDSFF E3.S rear drive module air shroud.

NOTE: EDSFF E3.S rear drive cooling fan is a cold swap.

Steps

1. Disconnect the cooling fan cable.
2. Press the blue release tab and lift the rear drive module cooling fan from the rear drive module.

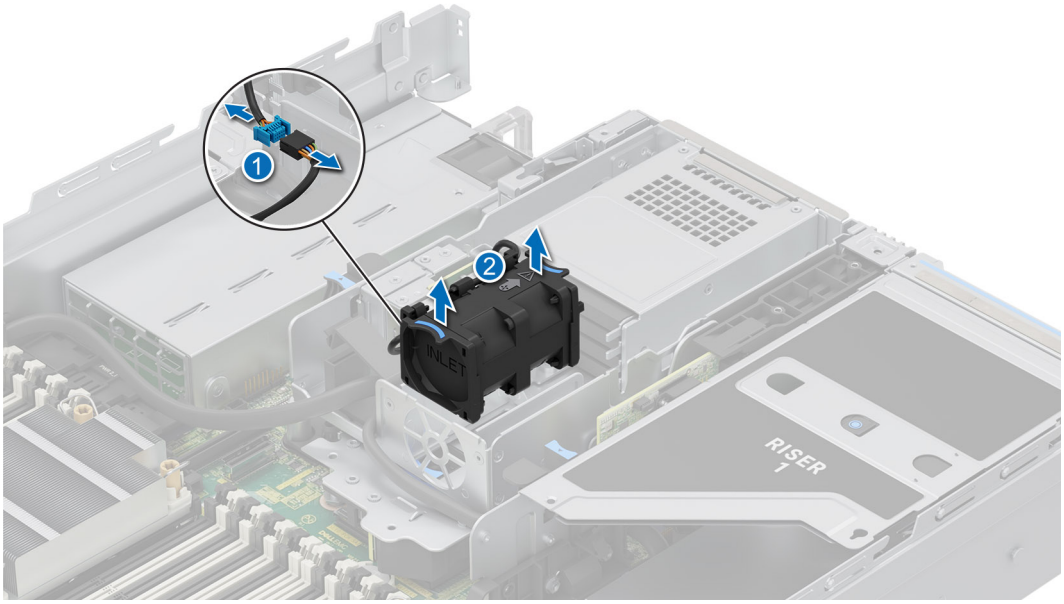


Figure 65. Removing the EDSFF E3.S rear drive module cooling fan

Next steps

1. Replace EDSFF E3.S rear drive module cooling fan.

Installing the EDSFF E3.S rear drive module cooling fan

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the EDSFF E3.S rear drive module air shroud

NOTE: EDSFF E3.S rear drive cooling fan is a cold swap.

.

Steps

1. Align and lower the rear drive module cooling fan into the rear drive module until the fan clicks into place.

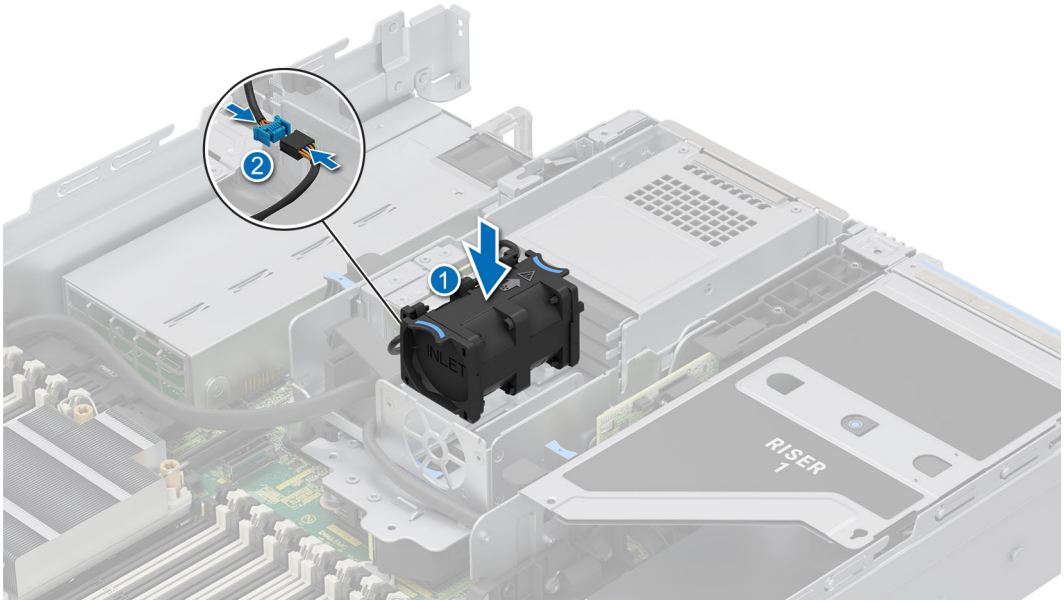


Figure 66. Installing the EDSFF E3.S rear drive module cooling fan

2. Connect the cooling fan cable.

Next steps

1. Install the EDSFF E3.S rear drive module air shroud.
2. Follow the procedure listed in After working inside your system.

Drives

Removing a drive blank

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. If installed, remove the front bezel.

CAUTION: To maintain proper system cooling, drive blanks must be installed in all empty drive slots.

Steps

Press the release button, and slide the drive blank out of the drive slot.

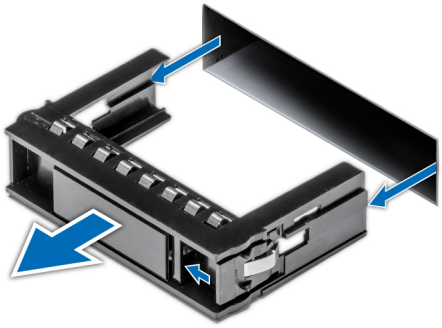


Figure 67. Removing a drive blank

Next steps

1. Replace the drive blank.

Installing a drive blank

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. If installed, remove the front bezel.

Steps

Slide the drive blank into the drive slot until the release button clicks into place.

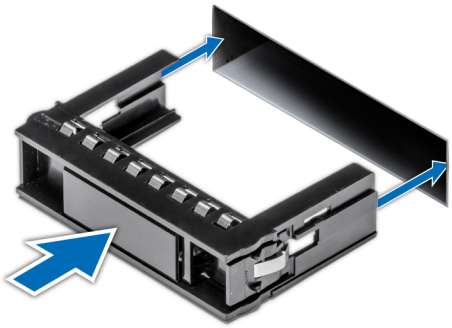


Figure 68. Installing a drive blank

Next steps

1. If removed, install the front bezel.

Removing a drive carrier

Prerequisites

1. Follow the safety guidelines listed in Safety instructions.
2. Remove the front bezel.
3. Using the management software, prepare the drive for removal. If the drive is online, the green activity or fault indicator flashes while the drive is turning off. When the drive indicators are off, the drive is ready for removal. For more information, see the storage controller documentation.

CAUTION: Before attempting to remove or install a drive while the system is running, see the documentation for the storage controller card to ensure that the host adapter is configured correctly to support drive removal and insertion.

CAUTION: To prevent data loss, ensure that your operating system supports drive installation. See the documentation supplied with your operating system.

Steps

1. Press the release button to open the drive carrier release handle.
2. Holding the drive carrier release handle, slide the drive carrier out of the drive slot.

NOTE: If you are not replacing the drive immediately, install a drive blank in the empty drive slot to maintain proper system cooling.

Figure 69. Removing a drive carrier

Next steps

Replace the drive or a drive blank.

Installing the drive carrier

Prerequisites

CAUTION: Before removing or installing a drive while the system is running, see the Storage Controller Manuals documentation for the storage controller card to ensure that the host adapter is configured correctly to support drive removal and insertion.

CAUTION: Combining SAS and SATA drives in the same RAID volume is not supported.

CAUTION: When installing a drive, ensure that the adjacent drives are fully installed. Inserting a drive carrier and attempting to lock its handle next to a partially installed carrier can damage the partially installed carrier's shield spring and make it unusable.

NOTE: Ensure that the drive carrier's release handle is in the open position before inserting the carrier into the slot.

CAUTION: To prevent data loss, ensure that your operating system supports hot-swap drive installation. See the documentation supplied with your operating system.

CAUTION: When a replacement hot swappable drive is installed and the system is powered on, the drive automatically begins to rebuild. Ensure that the replacement drive is blank or contains data that you wish to overwrite. Any data on the replacement drive is immediately lost after the drive is installed.

1. Follow the safety guidelines listed in Safety instructions.
2. Remove the front bezel.
3. Remove the drive carrier or remove the drive blank when you want to assemble the drive into the system.

Steps

1. Slide the drive carrier into the drive slot and push until the drive connects with the backplane.
2. Close the drive carrier release handle to lock the drive in place.

Figure 70. Installing a drive carrier

Next steps

Install the front bezel.

Removing the drive from the drive carrier

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Remove the drive carrier.

Steps

1. Using a Phillips #1 screwdriver, remove the screws from the slide rails on the drive carrier.

   NOTE: If the drive carrier has Torx screw, use Torx 6 (for 2.5-inch drive) or Torx 8 (for 3.5-inch drive) screwdriver to remove the drive.

2. Lift the drive out of the drive carrier.

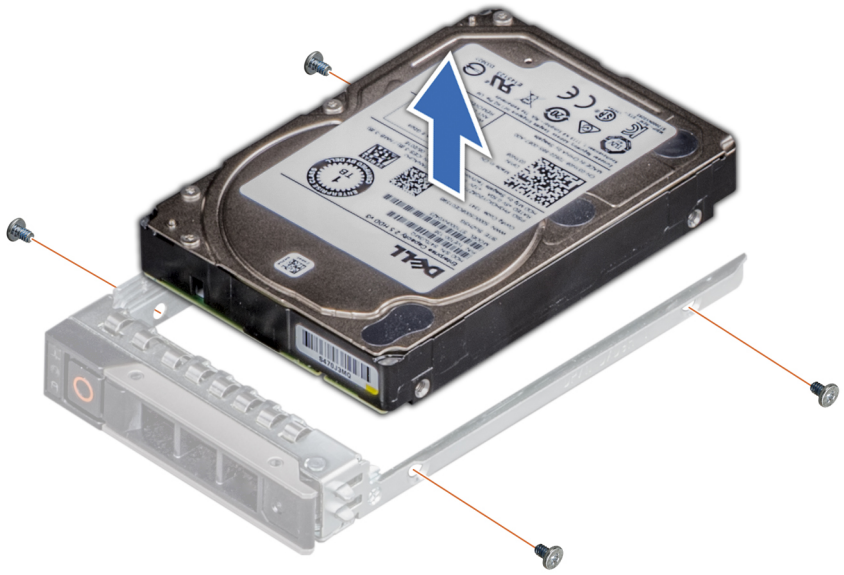


Figure 71. Removing the drive from the drive carrier

Next steps

Install the drive into the drive carrier.

Installing the drive into the drive carrier

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Remove the drive blank or Remove the drive carrier.

Steps

1. Insert the drive into the drive carrier with the drive connector facing towards the rear of the carrier.
2. Align the screw holes on the drive with the screws holes on the drive carrier.
3. Using a Phillips #1 screwdriver, secure the drive to the drive carrier with the screws.

   NOTE: When installing a drive into the drive carrier, ensure that the screws are torqued to 4 in-lbs.

   NOTE: If the drive carrier has Torx screw, use Torx 6 (for 2.5-inch drive) or Torx 8 (for 3.5-inch drive) screwdriver to install the drive.

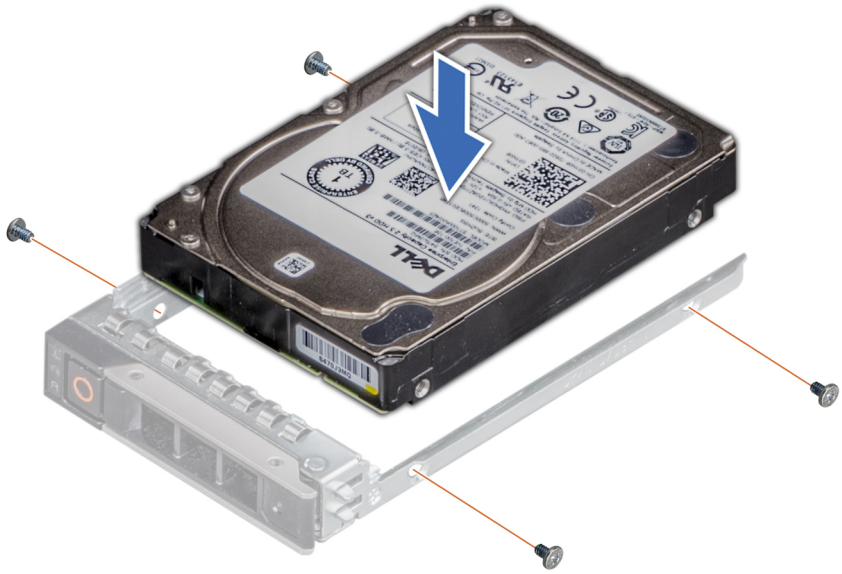


Figure 72. Installing a drive into the drive carrier

Next steps

1. Install the drive carrier.

Removing an EDSFF E3.S drive blank

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. If installed, remove the front bezel.

CAUTION: To maintain proper system cooling, drive blanks must be installed in all empty drive slots.

Steps

Lift the release button, and slide the drive blank out of the drive slot.

Figure 73. Removing an EDSFF E3.S drive blank

Next steps

1. Replace the EDSFF E3.S drive blank.

Installing an EDSFF E3.S drive blank

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. If installed, remove the front bezel.

Steps

Slide the drive blank into the drive slot until the release button clicks into place.

Figure 74. Installing an EDSFF E3.S drive blank

Next steps

1. If removed, install the front bezel.

Removing an EDSFF E3.S drive carrier

Prerequisites

1. Follow the safety guidelines listed in Safety instructions.
2. Remove the front bezel.
3. Using the management software, prepare the drive for removal. If the drive is online, the green activity or fault indicator flashes while the drive is turning off. When the drive indicators are off, the drive is ready for removal. For more information, see the storage controller documentation.

CAUTION: Before attempting to remove or install a drive while the system is running, see the documentation for the storage controller card to ensure that the host adapter is configured correctly to support drive removal and insertion.

CAUTION: To prevent data loss, ensure that your operating system supports drive installation. See the documentation supplied with your operating system.

Steps

1. Lift the release button to open the drive carrier release handle.
2. Holding the drive carrier release handle, slide the drive carrier out of the drive slot.

NOTE: If you are not replacing the drive immediately, install an EDSFF E3.S drive blank in the empty drive slot to maintain proper system cooling.

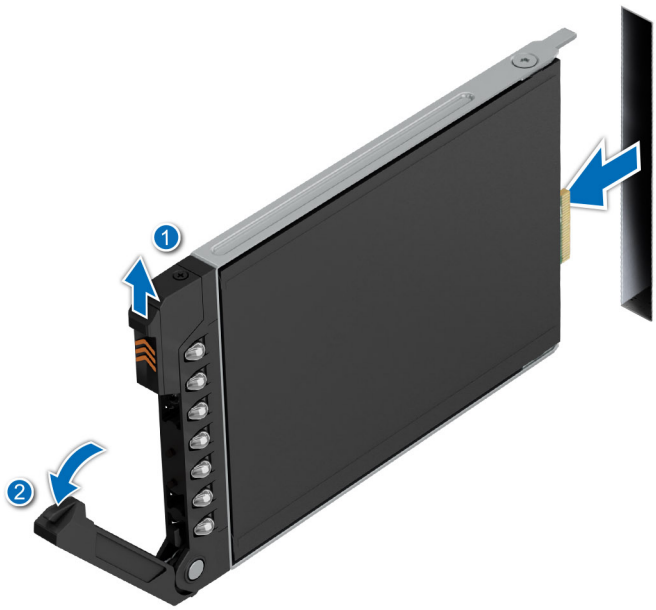


Figure 75. Removing an EDSFF E3.S drive carrier

Next steps

Replace the EDSFF E3.S drive or an EDSFF E3.S drive blank.

Installing an EDSFF E3.S drive carrier

Prerequisites

CAUTION: Before removing or installing a drive while the system is running, see the Storage Controller Manuals documentation for the storage controller card to ensure that the host adapter is configured correctly to support drive removal and insertion.

CAUTION: Combining SAS and SATA drives in the same RAID volume is not supported.

CAUTION: When installing a drive, ensure that the adjacent drives are fully installed. Inserting a drive carrier and attempting to lock its handle next to a partially installed carrier can damage the partially installed carrier's shield spring and make it unusable.

NOTE: Ensure that the drive carrier's release handle is in the open position before inserting the carrier into the slot.

CAUTION: To prevent data loss, ensure that your operating system supports hot-swap drive installation. See the documentation supplied with your operating system.

CAUTION: When a replacement hot swappable drive is installed and the system is powered on, the drive automatically begins to rebuild. Ensure that the replacement drive is blank or contains data that you wish to overwrite. Any data on the replacement drive is immediately lost after the drive is installed.

1. Follow the safety guidelines listed in Safety instructions.
2. Remove the front bezel.
3. Remove the drive carrier or remove the drive blank when you want to assemble the drive into the system.

Steps

1. Slide the drive carrier into the drive slot and push until the drive connects with the backplane.
2. Close the drive carrier release handle to lock the drive in place.

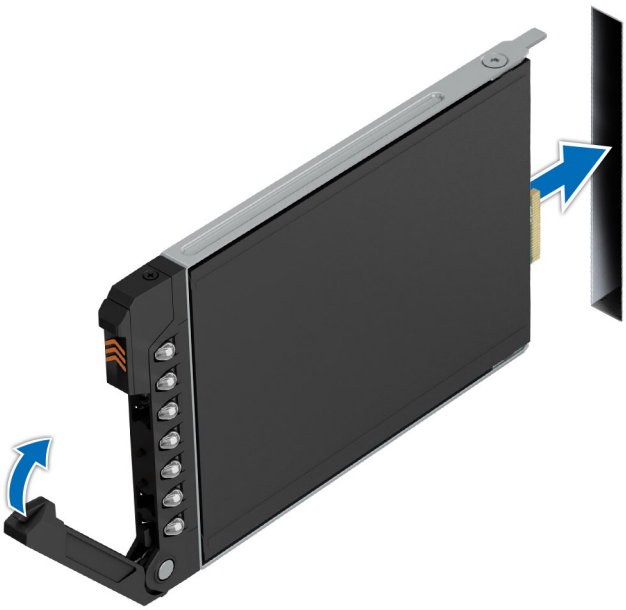


Figure 76. Installing an EDSFF E3.S drive carrier

Next steps

Install the front bezel.

Removing an EDSFF E3.S drive from the drive carrier

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Remove the drive carrier.

Steps

1. Using a Torx 6 screwdriver, remove the screws from the slide rails on the drive carrier.

2. Lift the drive out of the drive carrier.

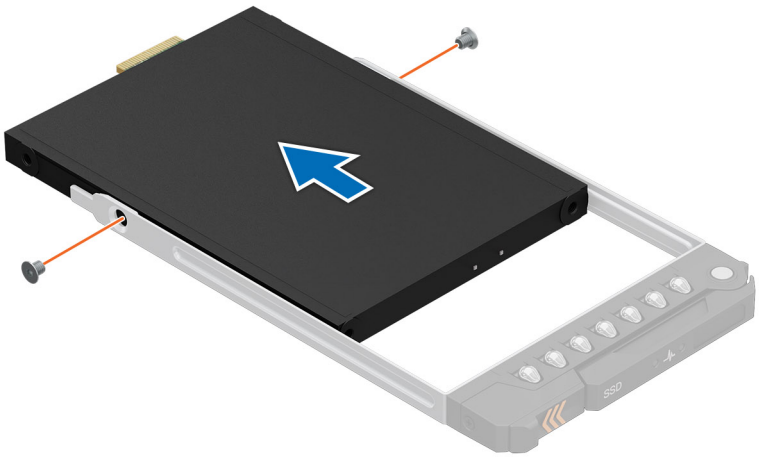


Figure 77. Removing an EDSFF E3.S drive from the drive carrier

Next steps

Install an EDSFF E3.S drive into the drive carrier.

Installing an EDSFF E3.S drive into the drive carrier

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Remove an EDSFF E3.S drive blank or Remove an EDSFF E3.S drive carrier.

Steps

1. Insert the drive into the drive carrier with the drive connector facing towards the rear of the carrier.
2. Align the screw holes on the drive with the screws holes on the drive carrier.
3. Using a Torx 6 screwdriver, secure the drive to the drive carrier with the screws.

NOTE: When installing a drive into the drive carrier, ensure that the screws are torqued to 4 in-lbs.

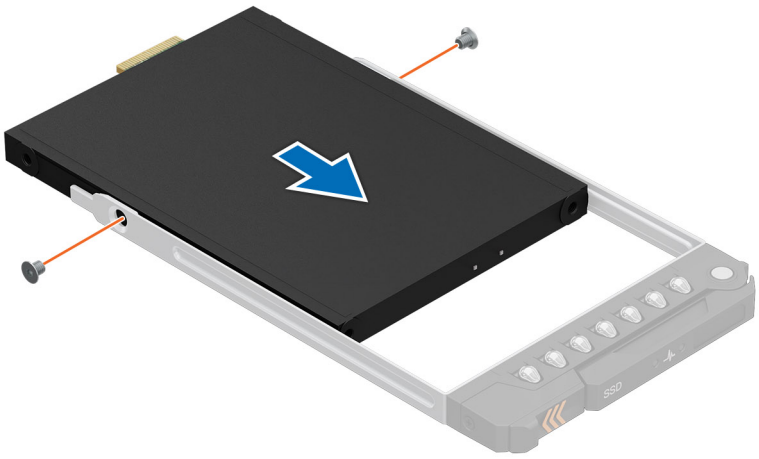


Figure 78. Installing an EDSFF E3.S drive into the drive carrier

Next steps

1. Install the drive carrier.

Rear drive module

Removing the 2 x 2.5-inch rear drive module

Prerequisites

1. Follow the safety guidelines listed in Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. If required, remove the air shroud.
4. Remove the drives.
5. Disconnect the cables from the rear drive module.

NOTE: Refer to cable routing section for more information.

Table 88. Rear drive bay slot numbers

Configurations with two rear drives	Bay0 slot numbers	Bay1 slot numbers
12 x 3.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA	Slot 0 and 1	N/A
12 x 3.5-inch SAS/SATA + 2 x 2.5-inch NVMe	Slot 0 and 1	N/A
24 x 2.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA	N/A	Slot 24 and 25
24 x 2.5-inch SAS/SATA + 2 x 2.5-inch NVMe	Slot 0 and 1	N/A

Steps

1. Using a Phillips #2 screwdriver, loosen the captive screws that secure the rear drive module to the system.
2. Press the blue release tab and holding the edges lift the rear drive module away from the system.

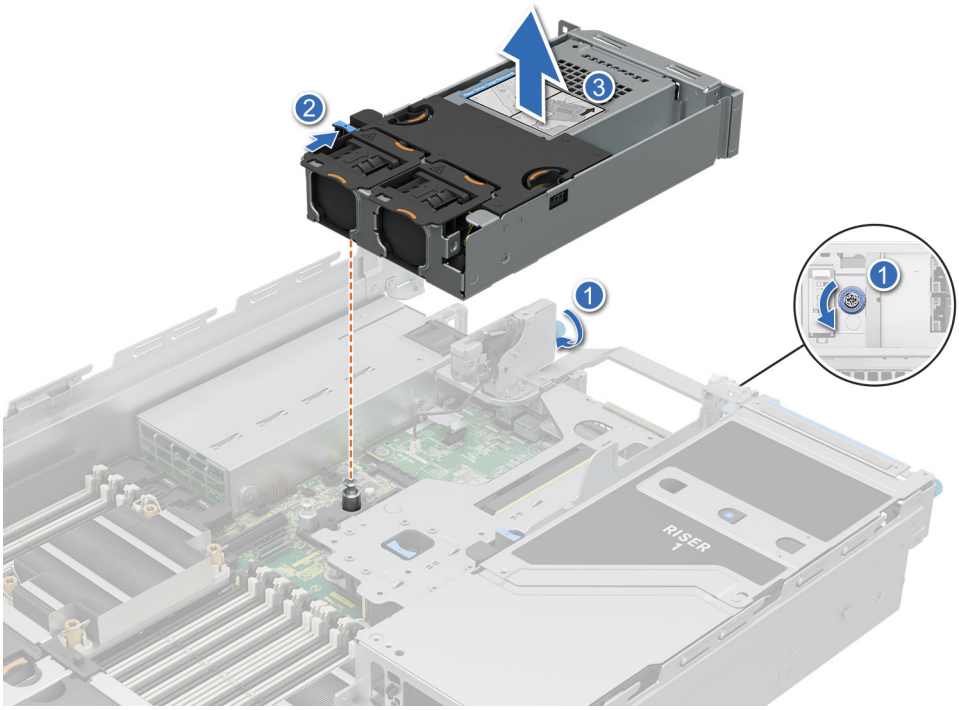


Figure 79. Removing the 2 x 2.5-inch rear drive module

Next steps

1. Replace the 2 x 2.5-inch rear drive module.

Installing the 2 x 2.5-inch rear drive module

Prerequisites

1. Follow the safety guidelines listed in Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. If required, remove the air shroud.
4. Remove the drives.
5. Disconnect the cables from the rear drive module.

NOTE: Refer to cable routing section for more information.

Steps

1. Align the slot on the rear drive module with the guide on the system.
2. Lower and press the rear drive module on top of the riser until firmly seated.
3. Using a Phillips #2 screwdriver, tighten the captive screws that secure the rear drive module into the system.

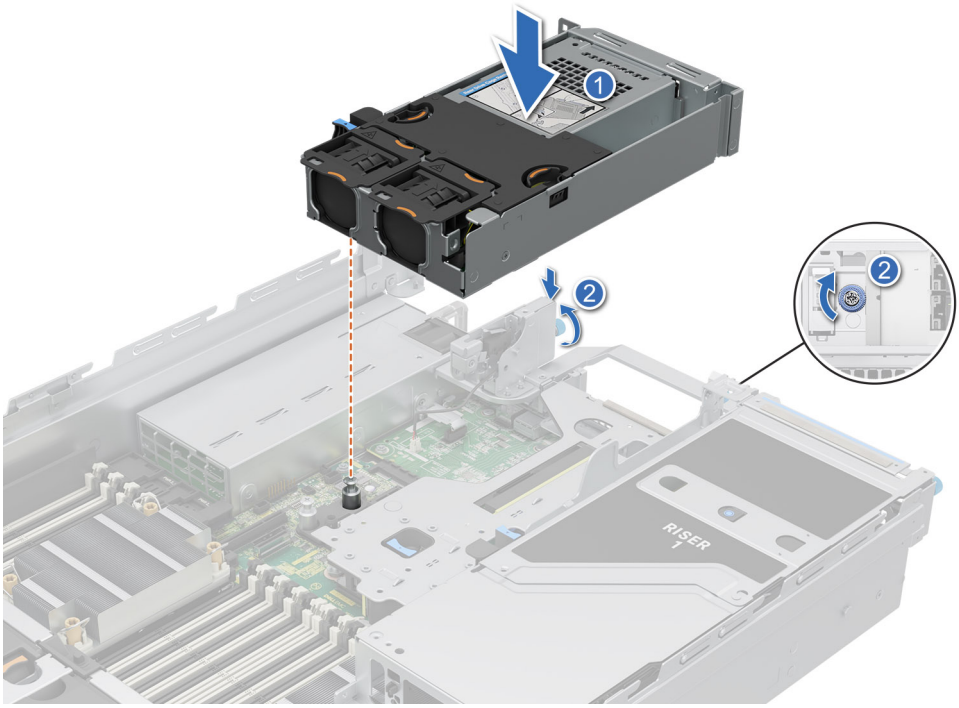


Figure 80. Installing the 2 x 2.5-inch rear drive module

Next steps

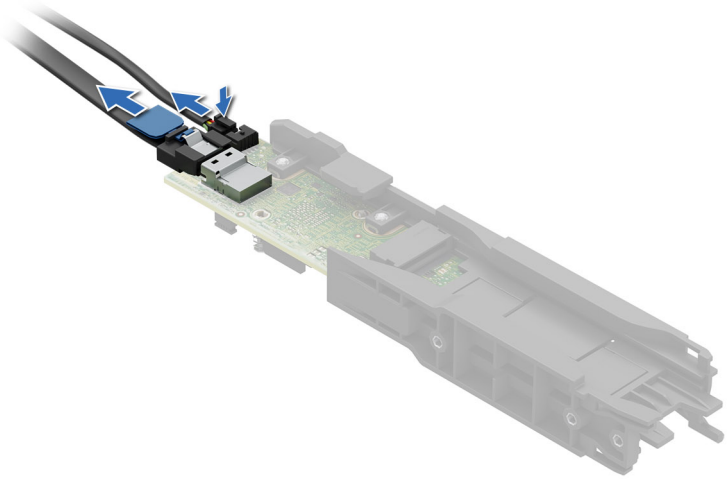
1. Connect and route all the cables to the rear drive module.
2. Install the drives.
3. If removed, install the air shroud.
4. Follow the procedure listed in After working inside your system.

Removing the 4 x 2.5-inch rear drive module

Prerequisites

1. Follow the safety guidelines listed in Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. If required, remove the air shroud.
4. Remove the drives.
5.

NOTE: If BOSS-N1 module is installed, make sure to disconnect the BOSS-N1 power cable and Signal cable before removing the 4 x 2.5-inch rear drive module.



6. Disconnect the cables from the rear drive module.

NOTE: See cable routing section for more information.

Table 89. Rear drive bay slot numbers

Configurations with four rear drives	Bay0 slot numbers	Bay1 slot numbers
12 x 3.5-inch SAS/SATA + 4 x 2.5-inch SAS/SATA	Slot 0, 1, 2 and 3	N/A
12 x 3.5-inch SAS/SATA + 4 x 2.5-inch NVMe	Slot 0, 1, 2 and 3	N/A
24 x 2.5-inch SAS/SATA + 4 x 2.5-inch SAS/SATA	N/A	Slot 24, 25, 26 and 27
24 x 2.5-inch SAS/SATA + 4 x 2.5-inch NVMe	Slot 0, 1, 2 and 3	N/A

Steps

1. Using a Phillips #2 screwdriver, loosen the captive screws that secure the rear drive module to the system.
2. Lift the rear drive module from the system.

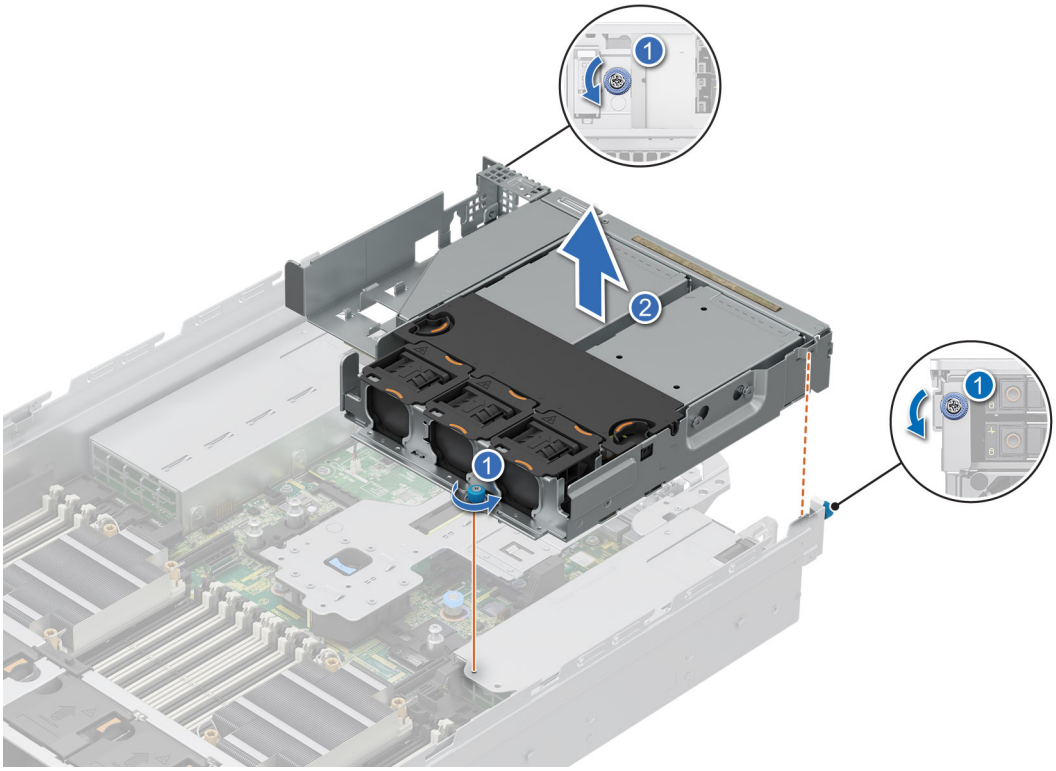


Figure 81. Removing the 4 x 2.5-inch rear drive module

Next steps

1. Replace the 4 x 2.5-inch rear drive module.

Installing the 4 x 2.5-inch rear drive module

Prerequisites

1. Follow the safety guidelines listed in Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. If required, remove the air shroud.
4. Remove the drives.
5. If installed, remove the BOSS-N1 module.
6. Disconnect the cables from the rear drive module.

NOTE: Refer to cable routing section for more information.

Steps

1. Align and lower the rear drive module with the guide on the system.
2. Using a Phillips #2 screwdriver, tighten the captive screws that secure the rear drive module into the system.

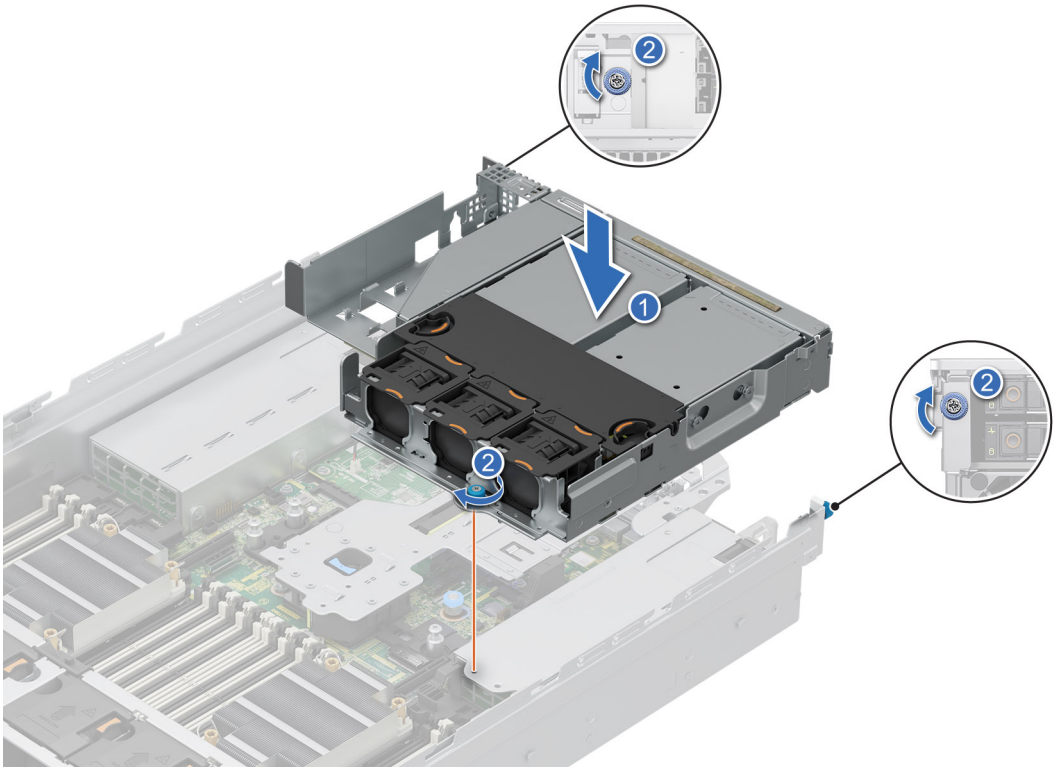


Figure 82. Installing the 4 x 2.5-inch rear drive module

Next steps

1. Connect and route all the cables to the rear drive module.
2. Install the drives.
3. If removed, install the BOSS-N1 module.
4. If removed, install the air shroud.
5. Follow the procedure listed in After working inside your system.

Removing the EDSFF E3.S rear drive module

Prerequisites

1. Follow the safety guidelines listed in Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the cooling fan cage assembly.
4. Remove the air shroud.
5. Remove the expansion card riser 1.
6. Remove an EDSFF E3. S drive carrier.
7. Disconnect the rear drive cables from the system board.

NOTE: See cable routing section for more information.

Table 90. Rear drive bay slot numbers

Configurations with four rear drives	Bay0 slot numbers
12 x 3.5-inch SAS/SATA + 4 x EDSFF E3.S NVMe	Slot 0, 1, 2 and 3
24 x 2.5-inch SAS/SATA + 4 x EDSFF E3.S NVMe	Slot 0, 1, 2 and 3

Steps

1. Using a Phillips #2 screwdriver, loosen the captive screw that secures the rear drive module to the system.
2. Press the blue release tab and holding the edges lift the rear drive module away from the system.

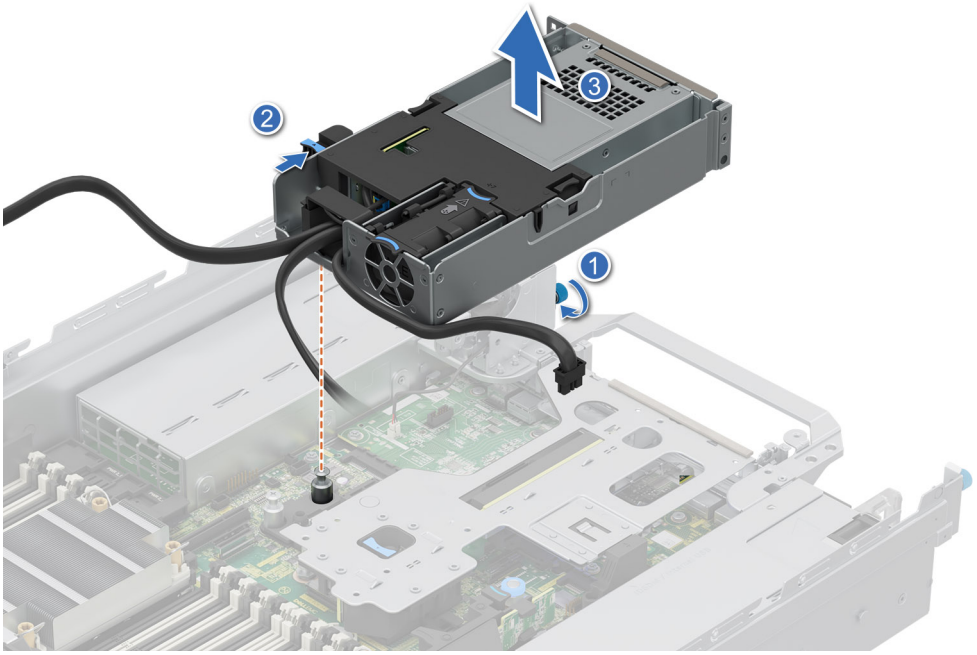


Figure 83. Removing the EDSFF E3.S rear drive module

Next steps

1. Replace the EDSFF E3.S rear drive module.

Installing the EDSFF E3.S rear drive module

Prerequisites

1. Follow the safety guidelines listed in Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the cooling fan cage assembly.
4. Remove the air shroud.
5. Remove the expansion card riser 1.
6. Remove an EDSFF E3. S drive carrier.
7. Disconnect the rear drive cables from the system board.

NOTE: See cable routing section for more information.

Steps

1. Align the slot on the rear drive module with the guide on the system.
2. Lower and press the rear drive module on top of the riser until firmly seated.
3. Using a Phillips #2 screwdriver, tighten the captive screw that secures the rear drive module into the system.

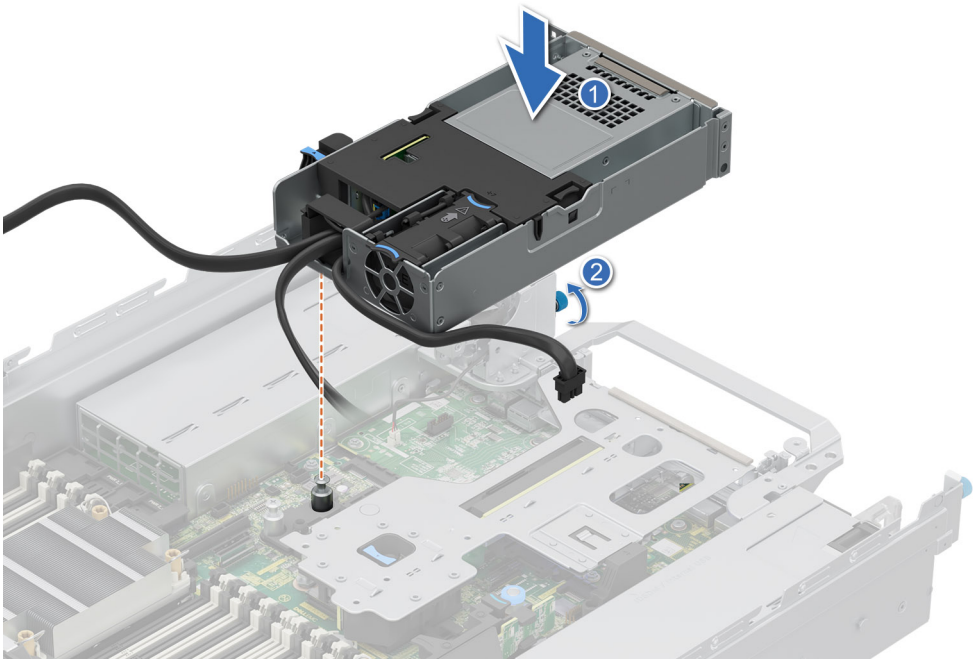


Figure 84. Installing the EDSFF E3.S rear drive module

Next steps

1. Connect and route all the cables from the rear drive module.
2. Install an EDSFF E3.S drive carrier.
3. Install the expansion card riser 1.
4. Install the air shroud.
5. Install the cooling fan cage assembly.
6. Follow the procedure listed in After working inside your system.

Drive backplane

This is a service technician replaceable part only.

Drive backplane

Depending on your system configuration, the drive backplanes that are supported are listed here:

Table 91. Supported backplane options

System	Supported hard drives options
PowerEdge R760	2.5-inch (x 8) NVMe backplane
	2.5-inch (x 8) SAS, or SATA backplane
	3.5-inch (x 12) SAS or SATA backplane
	2.5-inch (x 24) SAS, SATA, or NVMe backplane
	2.5-inch (x 24) NVMe Gen5 Switched backplane
	EDSFF E3.S (x8) NVMe backplane

Table 91. Supported backplane options (continued)

System	Supported hard drives options
	2.5-inch (x8) Universal backplane

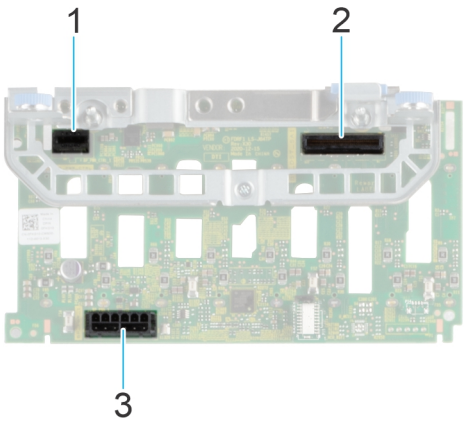


Figure 85. 8 x 2.5-inch NVMe drive backplane

1. BP_PWR_CTRL
2. BP_DST_SA1 (PERC to backplane)
3. BP_PWR_1 (backplane power cable to system board)

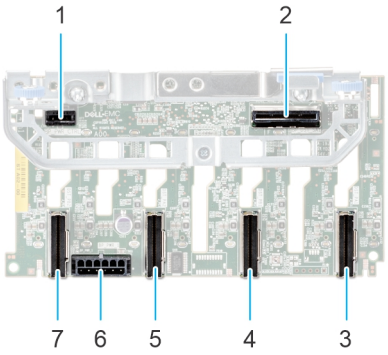


Figure 86. 8 x 2.5-inch SAS/SATA drive backplane

1. BP_PWR_CTRL
2. BP_DST_SA1 (PERC to backplane)
3. BP_DST_PA1 (PCIe/NVMe connector)
4. BP_ DST_PB1 (PCIe/NVMe connector)
5. BP_ DST_PA2 (PCIe/NVMe connector)
6. BP_PWR_1 (backplane power cable to system board)
7. BP_DST_PB2 (PCIe/NVMe connector)

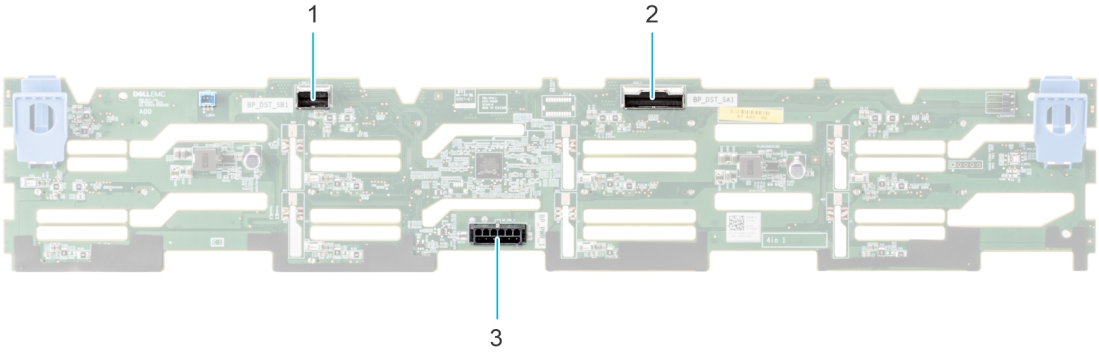


Figure 87. 12 x 3.5-inch drive backplane

1. BP_DST_SB1
2. BP_DST_SA1
3. BP_PWR_1 (backplane power cable to system board)

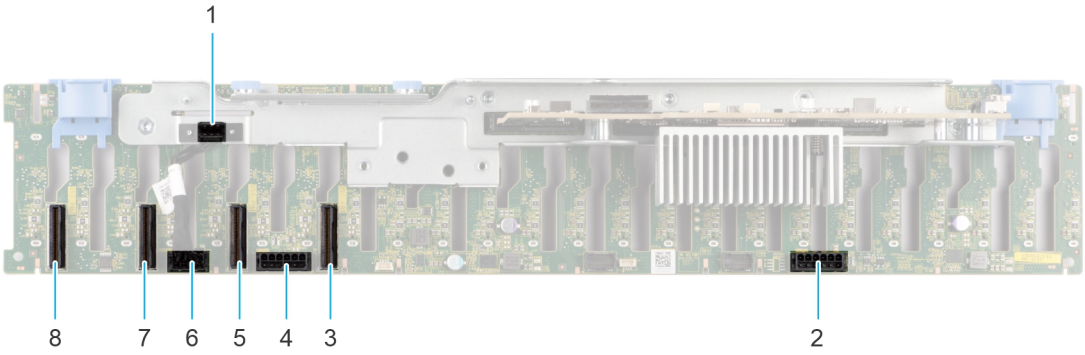


Figure 88. 24 x 2.5-inch drive backplane (front view)

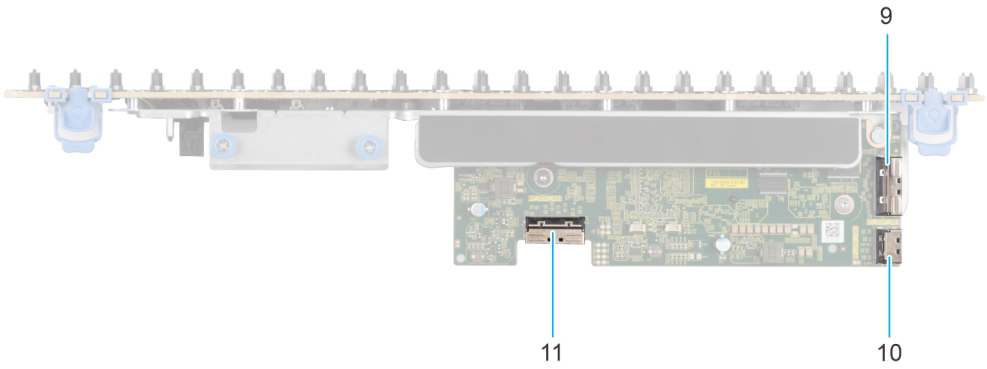


Figure 89. 24 x 2.5-inch drive backplane (top view)

1. BP_CTRL
2. BP_PWR_1 (backplane power cable to system board)
3. BP_DST_PA1 (PCIe/NVMe connector)
4. BP_PWR_2 (backplane power cable to system board)
5. BP_ DST_PB1 (PCIe/NVMe connector)
6. BP_PWR_CTRL
7. BP_ DST_PA2 (PCIe/NVMe connector)
8. BP_ DST_PB2 (PCIe/NVMe connector)
9. BP_DST_SB1
10. BP_SRC_SA2
11. BP_DST_SA1

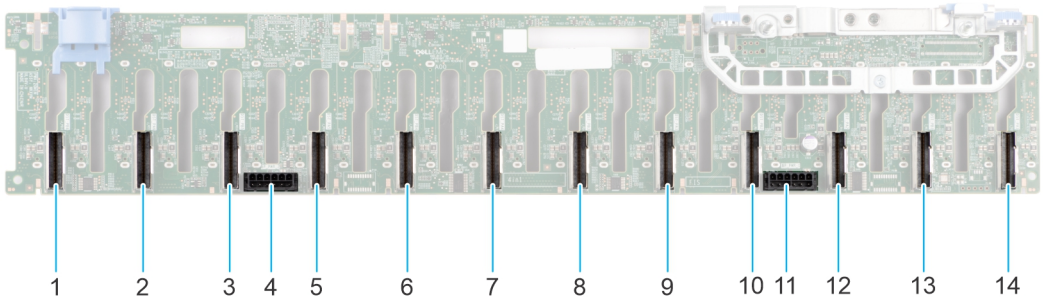


Figure 90. 24 x 2.5-inch NVMe passive backplane

1. BP_DST_PB6 (PCIe/NVMe connector)
2. BP_DST_PA6 (PCIe/NVMe connector)
3. BP_DST_PB5 (PCIe/NVMe connector)
4. BP_PWR_2
5. BP_DST_PA5 (PCIe/NVMe connector)
6. BP_DST_PB4 (PCIe/NVMe connector)
7. BP_DST_PA4 (PCIe/NVMe connector)
8. BP_DST_PB3 (PCIe/NVMe connector)
9. BP_DST_PA3 (PCIe/NVMe connector)
10. BP_DST_PB2 (PCIe/NVMe connector)
11. BP_PWR_1
12. BP_DST_PA2 (PCIe/NVMe connector)

13. BP_DST_PB1 (PCIe/NVMe connector)
14. BP_DST_PA1 (PCIe/NVMe connector)

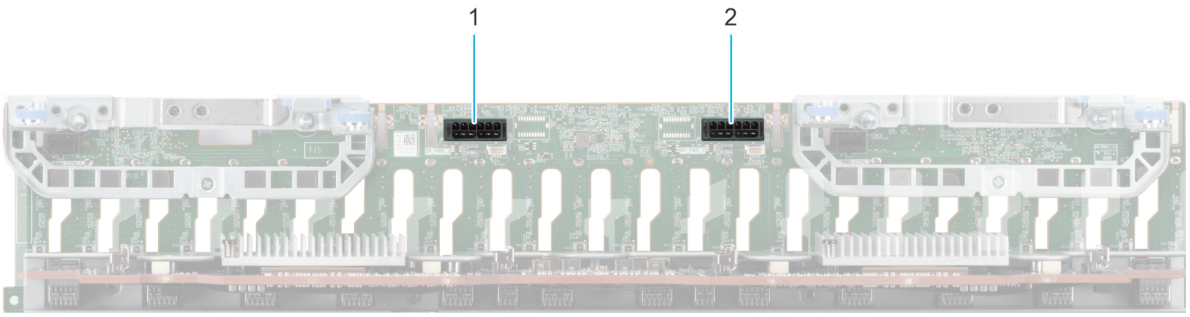


Figure 91. 24 x 2.5-inch NVMe Gen5 Switched drive backplane (front view)

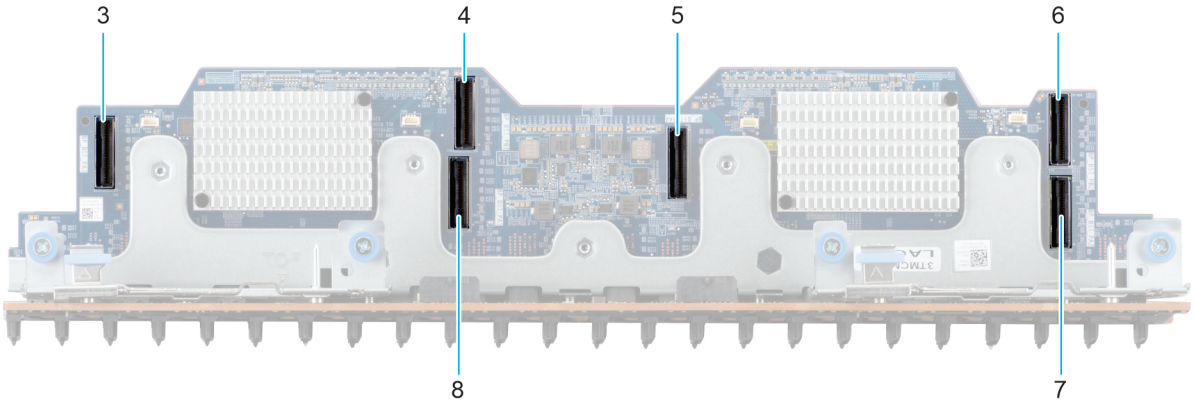


Figure 92. 24 x 2.5-inch NVMe Gen5 Switched drive backplane (top view)

1. BP_PWR_2 (backplane power cable to system board)
2. BP_PWR_1 (backplane power cable to system board)
3. BP_ DST_ PA3 (PCIe/NVMe connector)
4. BP_ DST_PB1 (PCIe/NVMe connector)
5. BP_ DST_PA4 (PCIe/NVMe connector)
6. BP_ DST_PB2 (PCIe/NVMe connector)
7. BP_ DST_PA2 (PCIe/NVMe connector)
8. BP_DST_PA1 (PCIe/NVMe connector)

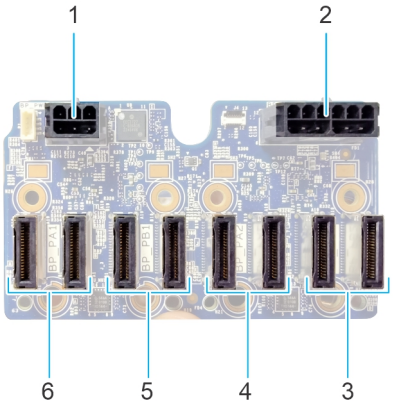


Figure 93. EDSFF E3.S NVMe drive backplane

1. BP_PWR_CTRL
2. BP_PWR_1 (backplane power cable to system board)
3. BP_PB2 (PCIe/NVMe connector)
4. BP_ PA2 (PCIe/NVMe connector)
5. BP_ PB1 (PCIe/NVMe connector)
6. BP_PA1 (PCIe/NVMe connector)

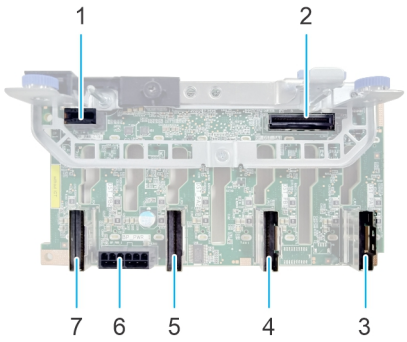


Figure 94. 8 x 2.5-inch Universal drive backplane

1. BP_PWR_CTRL
2. BP_DST_SA1 (PERC to backplane)
3. BP_DST_PA1 (PCIe/NVMe connector)
4. BP_ DST_PB1 (PCIe/NVMe connector)
5. BP_ DST_PA2 (PCIe/NVMe connector)
6. BP_PWR_1 (backplane power cable to system board)
7. BP_DST_PB2 (PCIe/NVMe connector)

Removing the drive backplane

Prerequisites

CAUTION: To prevent damage to the drives and backplane, remove the drives from the system before removing the backplane.

CAUTION: Note the number of each drive and temporarily label them before you remove the drive so that you can reinstall them in the same location.

NOTE: The procedure to remove the backplane is similar for all backplane configurations.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the drive backplane cover.
4. If installed, remove the air shroud or remove the GPU air shroud.
5. Remove the cooling fan cage assembly.
6. Remove the drives.
7. If required, remove the rear mounting front PERC module.
8. Observe and disconnect the drive backplane cables from the connector on the system board and backplane.

NOTE: See cable routing section for more information.

Steps

1. Press one or more release tabs to disengage the drive backplane from the hooks on the system.
2. Lift and pull the drive backplane out of the system.

NOTE: To avoid damaging the backplane, remove the disconnected backplane cables from the cable routing clips before removing the backplane.

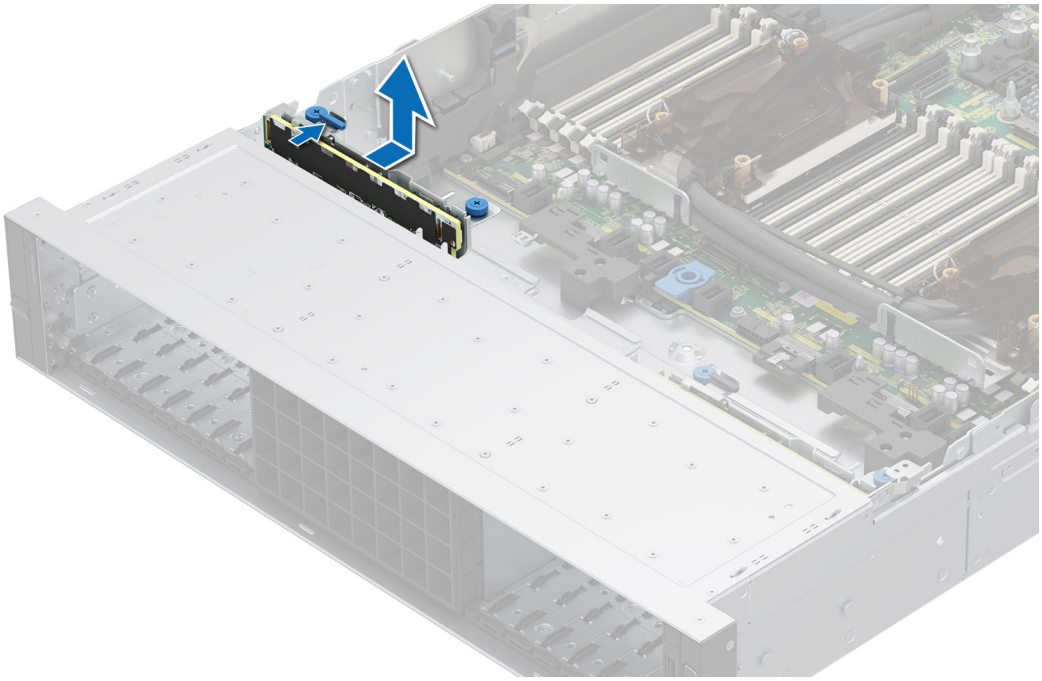


Figure 95. Removing the drive backplane

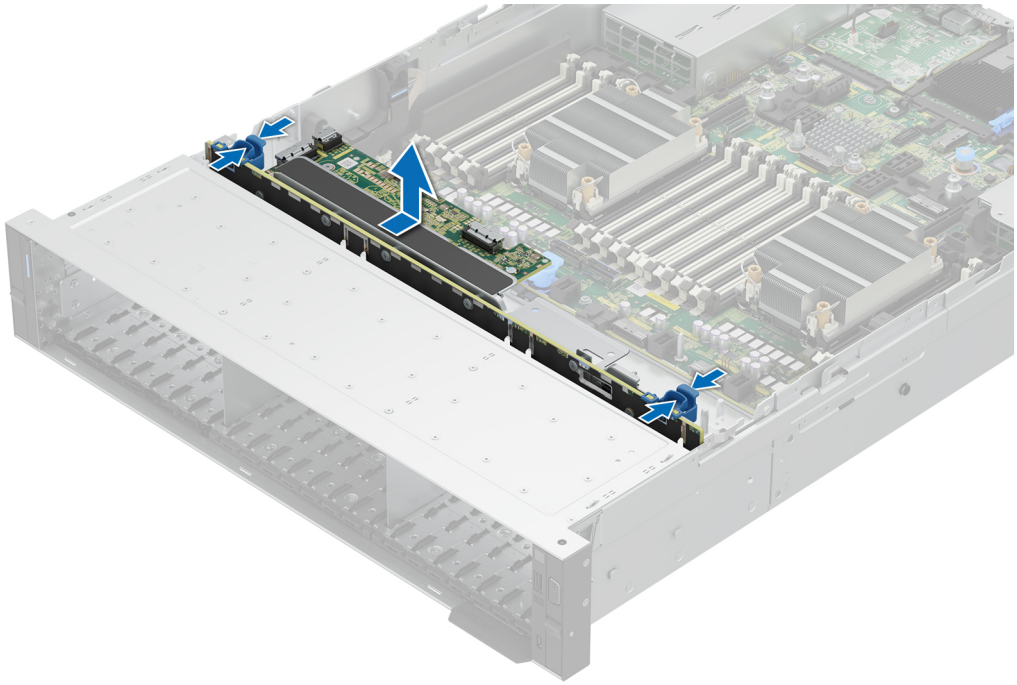


Figure 96. Removing the drive backplane

Next steps

1. Replace the drive backplane.

Installing the drive backplane

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the drive backplane cover.
4. If installed, remove the air shroud or remove the GPU air shroud.
5. Remove the cooling fan cage assembly.
6. Remove the drives.
7. If required, remove the rear mounting front PERC module.
8. Observe and disconnect the drive backplane cables from the connector on the system board and backplane.

NOTE: See cable routing section for more information.

NOTE: To avoid damaging the backplane, remove the disconnected backplane cables from the cable routing clips.

NOTE: Route the cable properly when you replace it to prevent the cable from being pinched or crimped.

Steps

1. Align the slots on the drive backplane with the guides on the system.
2. Slide the drive backplane into the guides on the system and lower the backplane until one or more blue release tabs clicks into place.

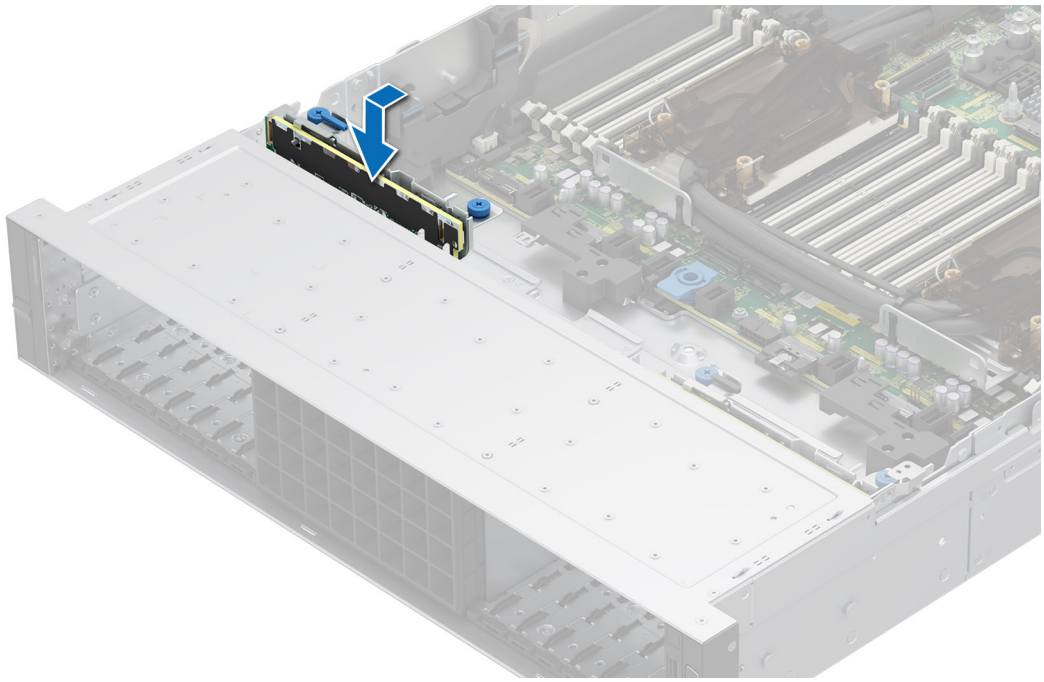


Figure 97. Installing the drive backplane

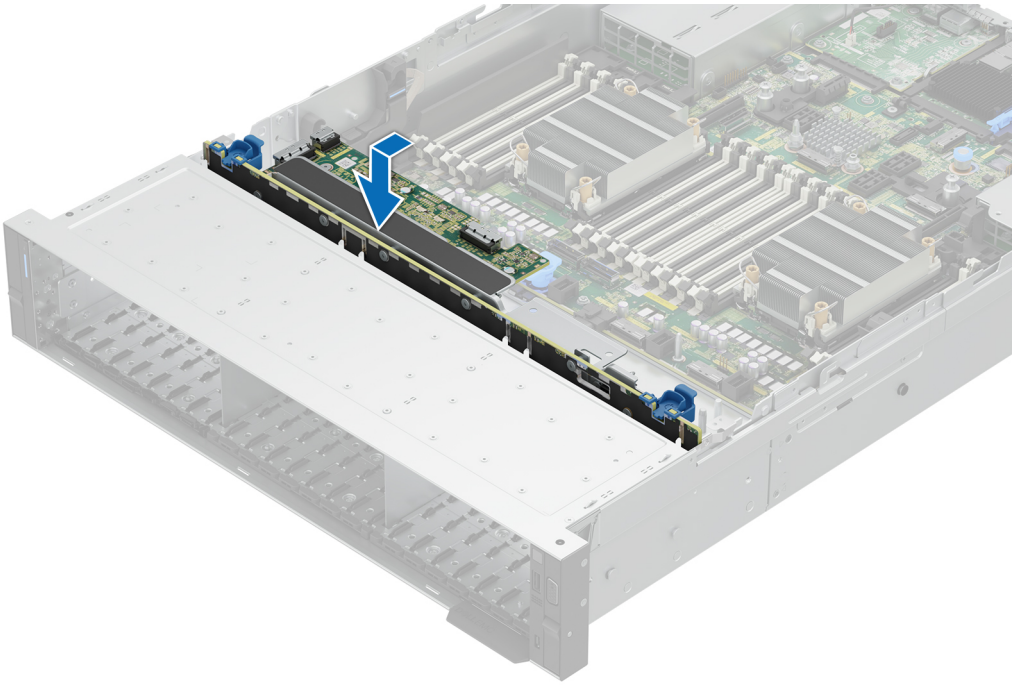


Figure 98. Installing the drive backplane

Next steps

1. Connect the drive backplane cables to the connectors on the system board and backplane.
2. Install the drives.
3. If required, install the rear mounting front PERC module.
4. Install the cooling fan cage assembly.
5. If removed, install the air shroud or install the GPU air shroud
6. Install the drive backplane cover.
7. Follow the procedure listed in After working inside your system.

Side wall brackets

Removing the side wall bracket

There are two side wall brackets on either side of the system. The procedure to remove is similar.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. If required, remove the drive backplane cover.
4. If installed, remove the air shroud or remove the GPU air shroud.
5. Remove the cooling fan cage assembly.

NOTE: Ensure that you note the routing of the cables as you remove them from the system board. Route the cables properly when you replace them to prevent the cables from being pinched or crimped.

Steps

1. Press the blue side tabs to release the side wall cable holder.

   NOTE: Move the cables out of the side wall cable holder.

2. Press the center tab to release the bracket from the chassis, and lift it away from the system.

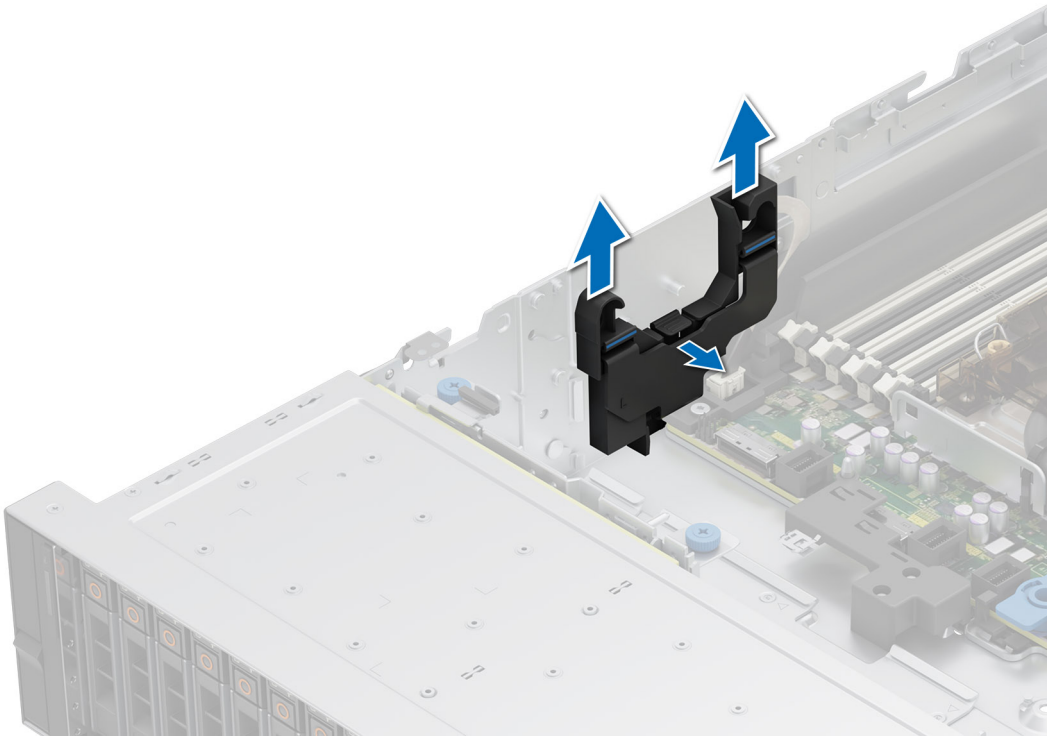


Figure 99. Removing the side wall bracket

Next steps

1. Replace the side wall bracket.

Installing the side wall bracket

There are two side wall brackets on either side of the system. The procedure to install is similar.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. If required, remove the drive backplane cover.
4. If installed, remove the air shroud or remove the GPU air shroud.
5. Remove the cooling fan cage assembly.

NOTE: Ensure that you note the routing of the cables as you remove them from the system board. Route the cables properly when you replace them to prevent the cables from being pinched or crimped.

Steps

1. Align the guide slots on the side wall bracket with the guides on the system and slide until the cover is seated firmly.

   NOTE: Route the cables through the side wall cable holder.

2. Close the side wall cable holder until the holder clicks into place.

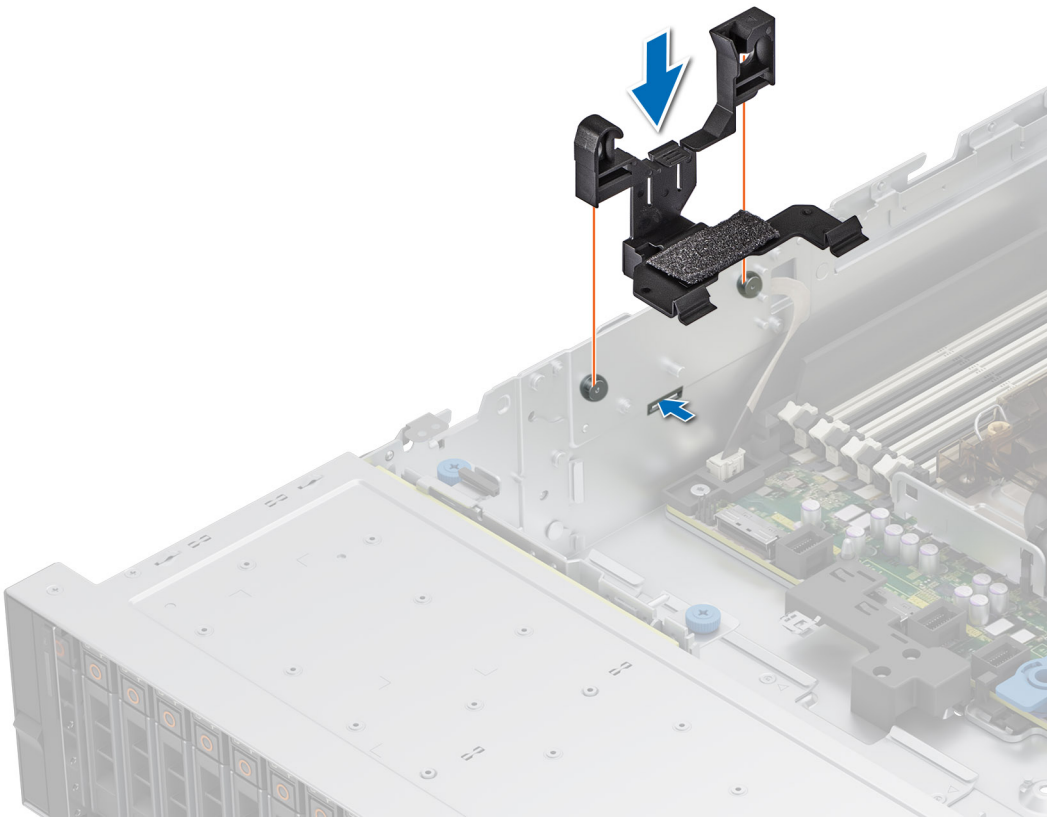


Figure 100. Installing the side wall bracket

Next steps

1. Replace the cooling fan cage assembly.
2. If removed, install the air shroud or install the GPU air shroud.
3. If removed, install the drive backplane cover.
4. Follow the procedure listed in the After working inside your system.

Cable routings

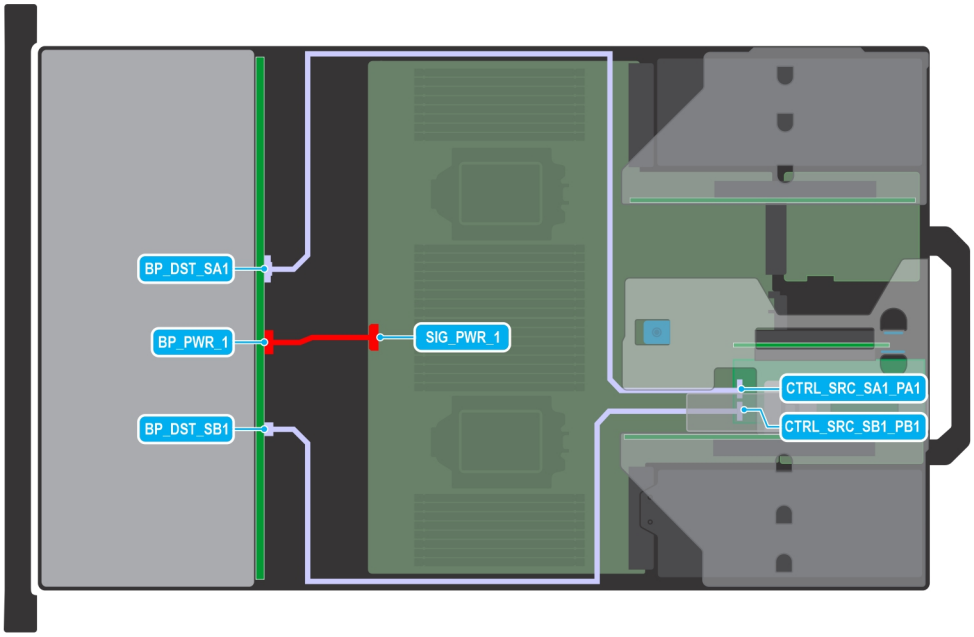


Figure 101. Configuration 0: 12 x 3.5-inch SAS/SATA with APERC11/12 in Riser 2

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 92. 12 x 3.5-inch SAS/SATA with APERC11/12 in Riser 2

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	CTRL_SRC_SA1_PA1 (adapter PERC controller connector)	BP_DST_SA1 (backplane signal connector)
3	CTRL_SRC_SB1_PB1 (adapter PERC controller connector)	BP_DST_SB1 (backplane signal connector)

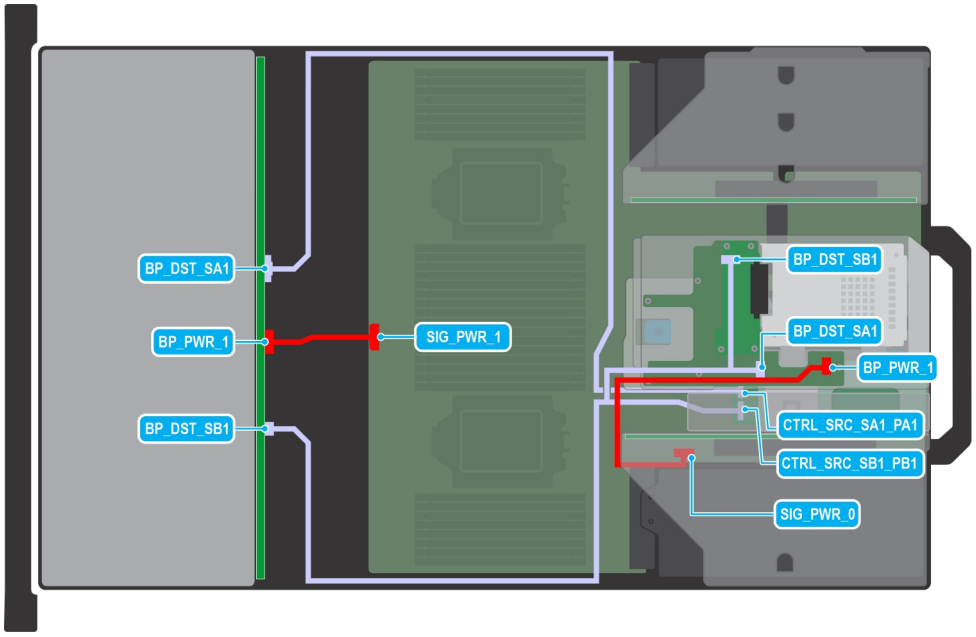


Figure 102. Configuration 1: 12 x 3.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA with APERC11/12 in Riser 2

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 93. 12 x 3.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA with APERC11/12 in Riser 2

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	CTRL_SRC_SB1_PB1 (adapter PERC controller connector) and BP_DST_SB1 (backplane signal connector)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)
3	CTRL_SRC_SA1_PA1 (adapter PERC controller connector)	BP_DST_SA1 (backplane signal connector)
4	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)

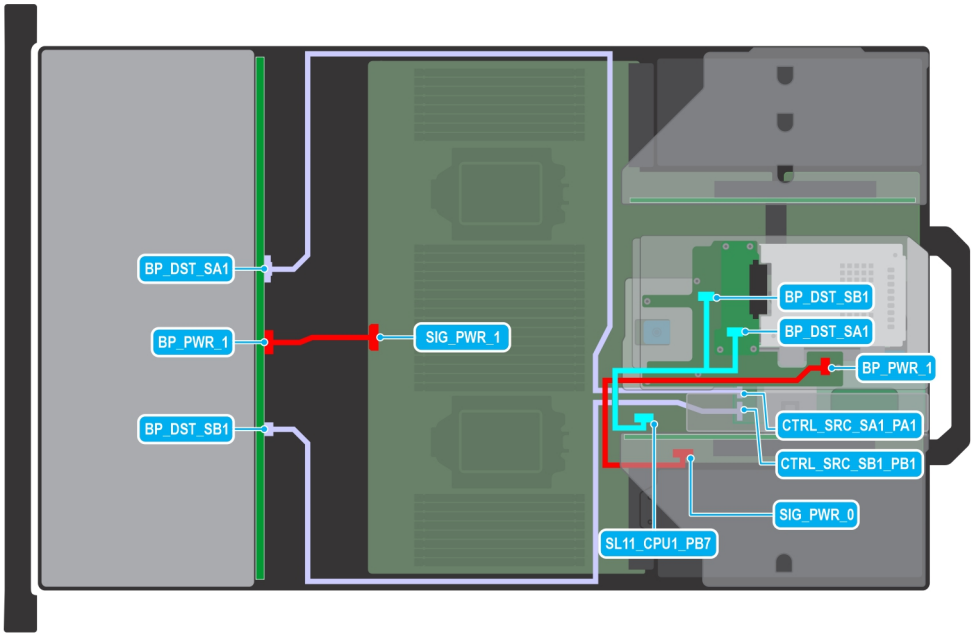


Figure 103. Configuration 2: 12 x 3.5-inch SAS/SATA + 2 x 2.5-inch NVMe with APERC11/12 in Riser 2

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 94. 12 x 3.5-inch SAS/SATA + 2 x 2.5-inch NVMe with APERC11/12 in Riser 2

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	CTRL_SRC_SB1_PB1 (adapter PERC controller connector)	BP_DST_SB1 (backplane signal connector)
3	CTRL_SRC_SA1_PA1 (adapter PERC controller connector)	BP_DST_SA1 (backplane signal connector)
4	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)
5	SL11_CPU1_PB7 (signal connector on system board)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)

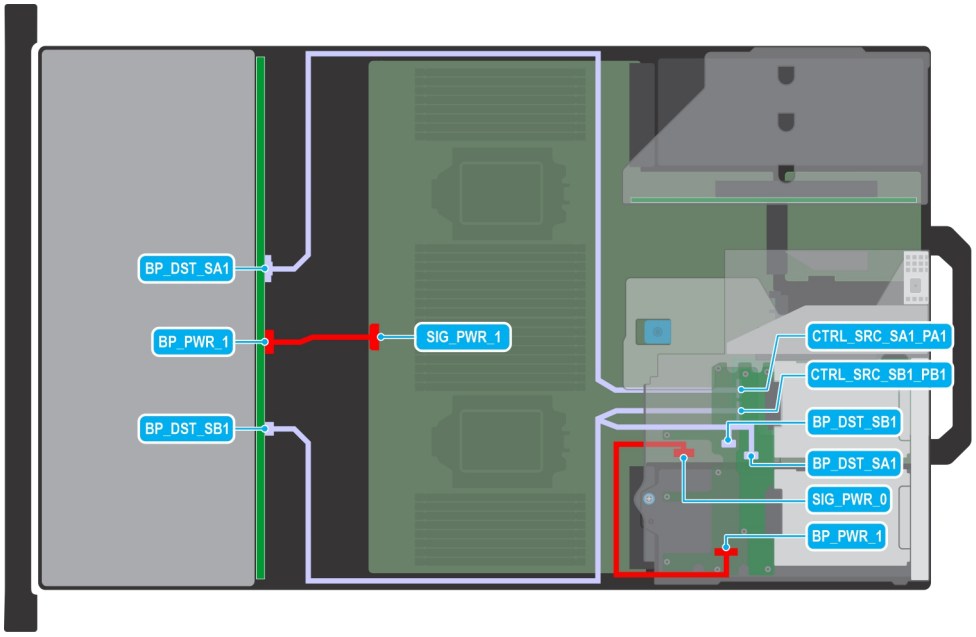


Figure 104. Configuration 3: 12 x 3.5-inch SAS/SATA + 4 x 2.5-inch SAS/SATA with APERC11/12 in Riser 2

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 95. 12 x 3.5-inch SAS/SATA + 4 x 2.5-inch SAS/SATA with APERC11/12 in Riser 2

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	CTRL_SRC_SB1_PB1 (adapter PERC controller connector) and BP_DST_SB1 (backplane signal connector)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)
3	CTRL_SRC_SA1_PA1 (adapter PERC controller connector)	BP_DST_SA1 (backplane signal connector)
4	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)

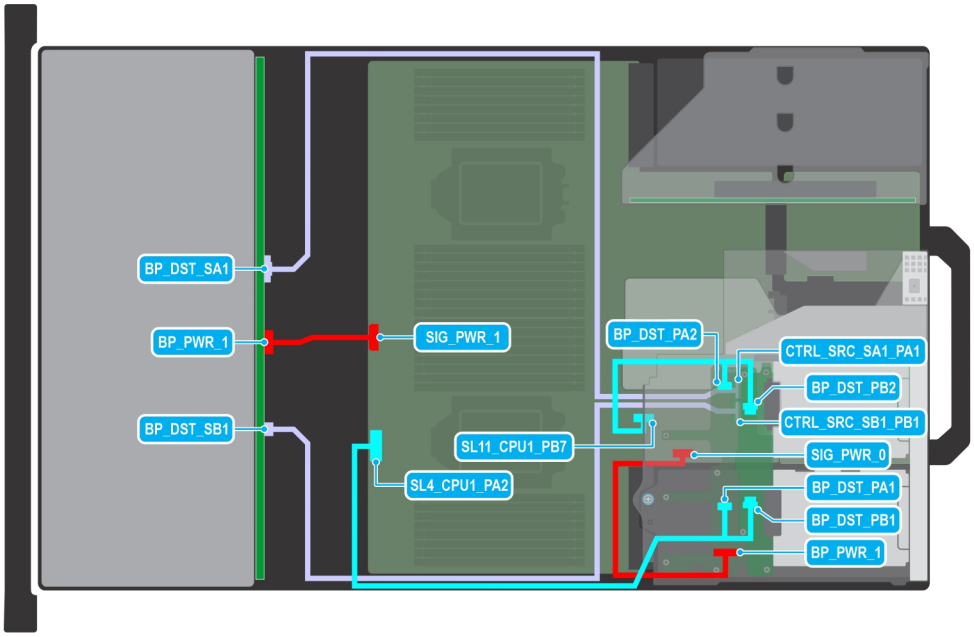


Figure 105. Configuration 4: 12 x 3.5-inch SAS/SATA + 4 x 2.5-inch NVMe with APERC11/12 in Riser 2

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 96. 12 x 3.5-inch SAS/SATA + 4 x 2.5-inch NVMe with APERC11/12 in Riser 2

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)
3	SL4_CPU1_PA2 (signal connector on system board)	BP_DST_PA1 (rear backplane signal connector) and BP_DST_PB1 (rear backplane signal connector)
4	SL11_CPU1_PB7 (signal connector on system board)	BP_DST_PA2 (rear backplane signal connector) and BP_DST_PB2 (rear backplane signal connector)
5	CTRL_SRC_SB1_PB1 (adapter PERC controller connector)	BP_DST_SB1 (backplane signal connector)
6	CTRL_SRC_SA1_PA1 (adapter PERC controller connector)	BP_DST_SA1 (backplane signal connector)

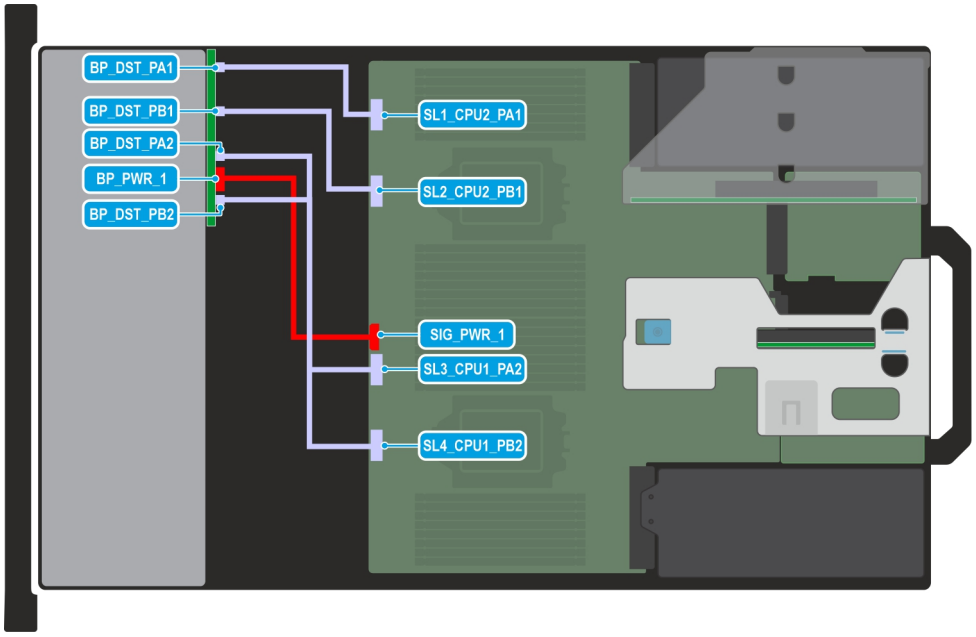


Figure 106. Configuration 5: 8 x 2.5-inch NVMe

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 97. 8 x 2.5-inch NVMe

Order	From	To
1	SL1_CPU2_PA1 (signal connector on system board)	BP_DST_PA1 (backplane signal connector)
2	SL2_CPU2_PB1 (signal connector on system board)	BP_DST_PB1 (backplane signal connector)
3	SL3_CPU1_PA2 (signal connector on system board) and SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
4	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)

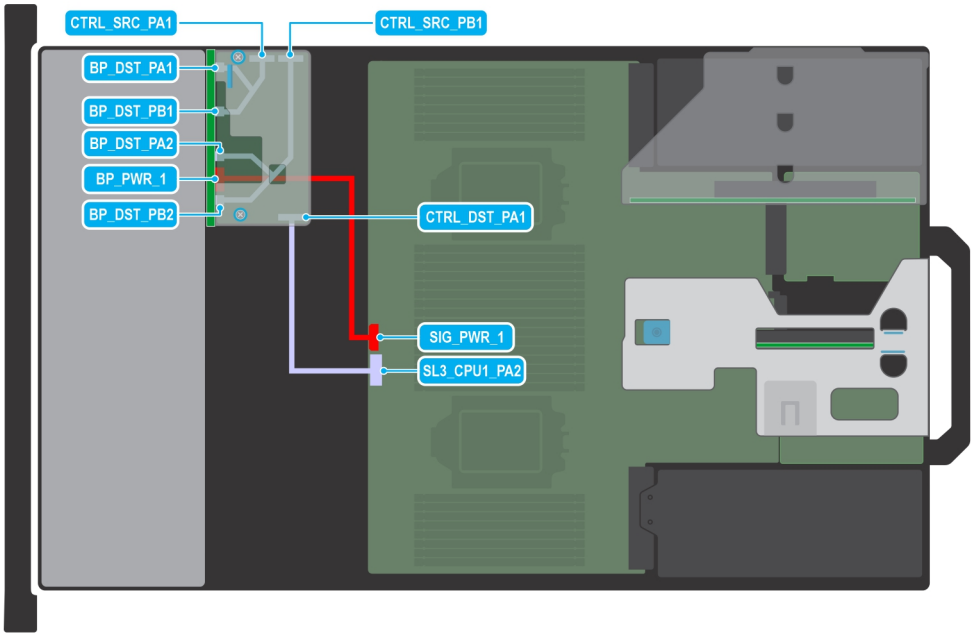


Figure 107. Configuration 6: 8 x 2.5-inch NVMe RAID with fPERC (H755N)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 98. 8 x 2.5-inch NVMe RAID with fPERC (H755N)

Order	From	To
1	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
2	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
3	CTRL_SRC_PB1 (fPERC controller connector)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
4	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)

NOTE: An 8 x 2.5-inch NVMe backplane with fPERC H755 should be assembled outside and inserted into the system, along with all necessary cables.

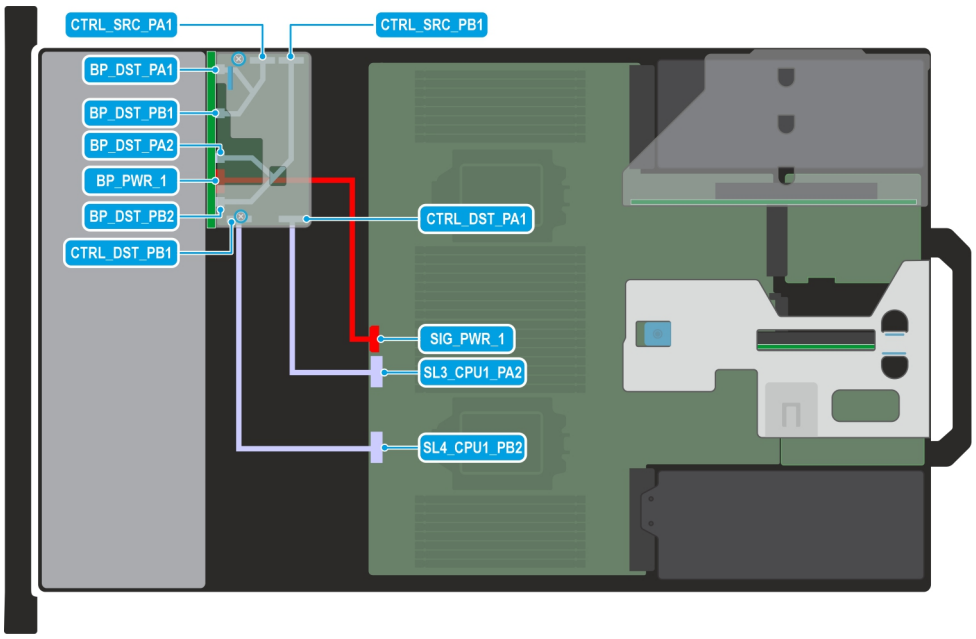


Figure 108. Configuration 7: 8 x 2.5-inch NVMe RAID with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 99. 8 x 2.5-inch NVMe RAID with fPERC (H965i)

Order	From	To
1	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
4	CTRL_SRC_PB1 (fPERC controller connector)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
5	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)

NOTE: An 8 x 2.5-inch NVMe backplane with fPERC H965i should be assembled outside and inserted into the system, along with all necessary cables.

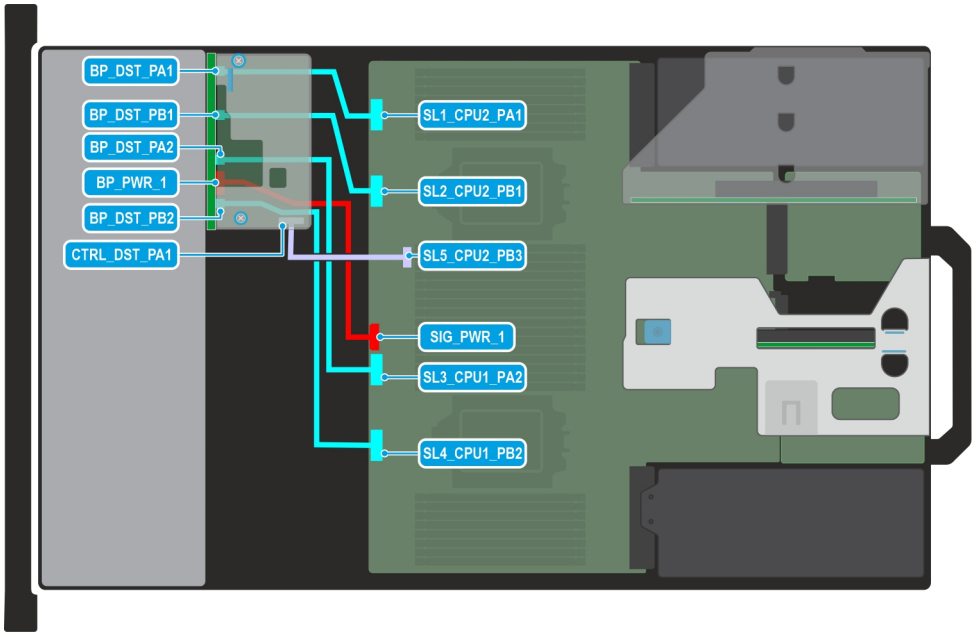


Figure 109. Configuration 8: 8 x 2.5-inch Universal (SAS/SATA/NVMe) with fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 100. 8 x 2.5-inch Universal (SAS/SATA/NVMe) with fPERC (HBA355i, H355, H755)

Order	From	To
1	SL5_CPU2_PB3 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
2	SL3_CPU1_PA2 (signal connector on system board) and SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
3	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
4	SL2_CPU2_PB1 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
5	SL1_CPU2_PA1 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)

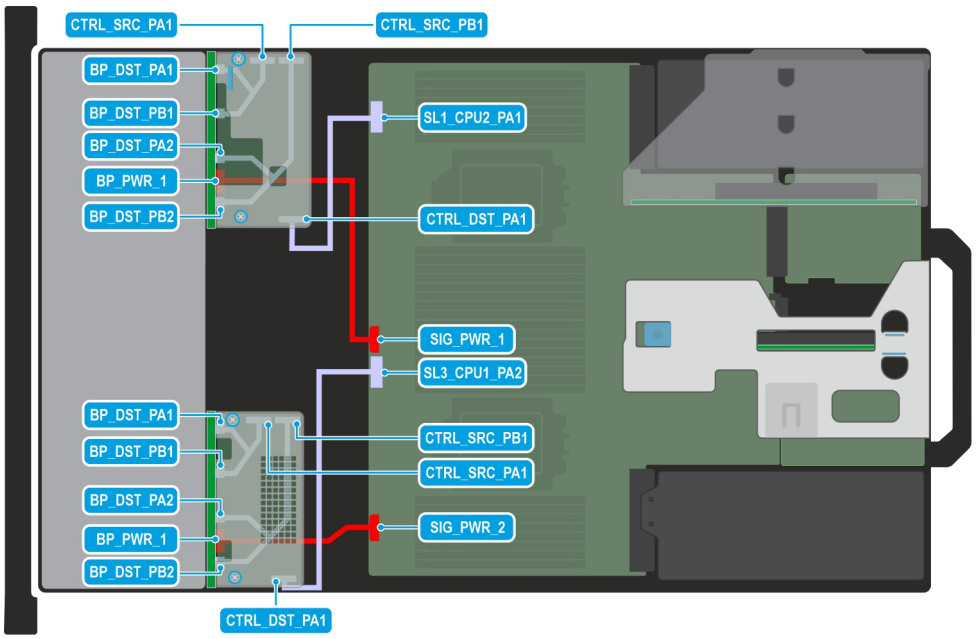


Figure 110. Configuration 9: 16 x 2.5-inch NVMe RAID with fPERC (H755N)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 101. 16 x 2.5-inch NVMe RAID with fPERC (H755N)

Order	From	To
1	SL1_CPU2_PA1 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
2	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
3	CTRL_SRC_PB1 (fPERC controller connector)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
4	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
5	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
6	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)
7	CTRL_SRC_PB1 (fPERC controller connector)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
8	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)

NOTE: An 8 x 2.5-inch NVMe backplanes with fPERC H755 should be assembled outside and inserted into the system, along with all necessary cables.

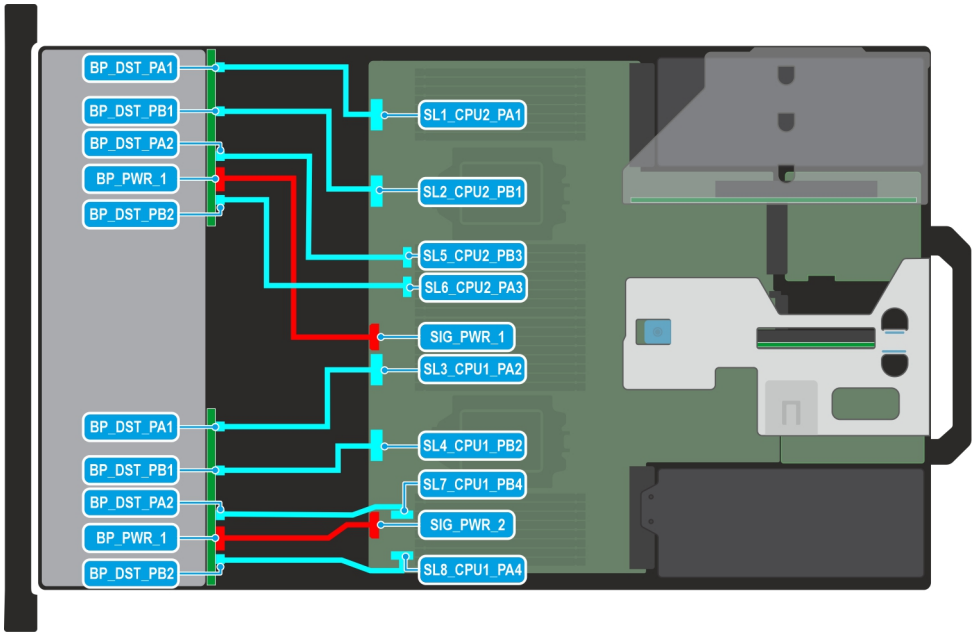


Figure 111. Configuration 10: 16 x 2.5-inch NVMe

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 102. 16 x 2.5-inch NVMe

Order	From	To
1	SL2_CPU2_PA1 (signal connector on system board)	BP_DST_PA1 (backplane signal connector)
2	SL1_CPU2_PB1 (signal connector on system board)	BP_DST_PB1 (backplane signal connector)
3	SL5_CPU2_PB3 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
4	SL6_CPU2_PA3 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)
5	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
6	SL3_CPU1_PA2 (signal connector on system board)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
7	SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PB1 (backplane signal connector)
8	SL7_CPU1_PB4 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
9	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)
10	SL8_CPU1_PA4 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)

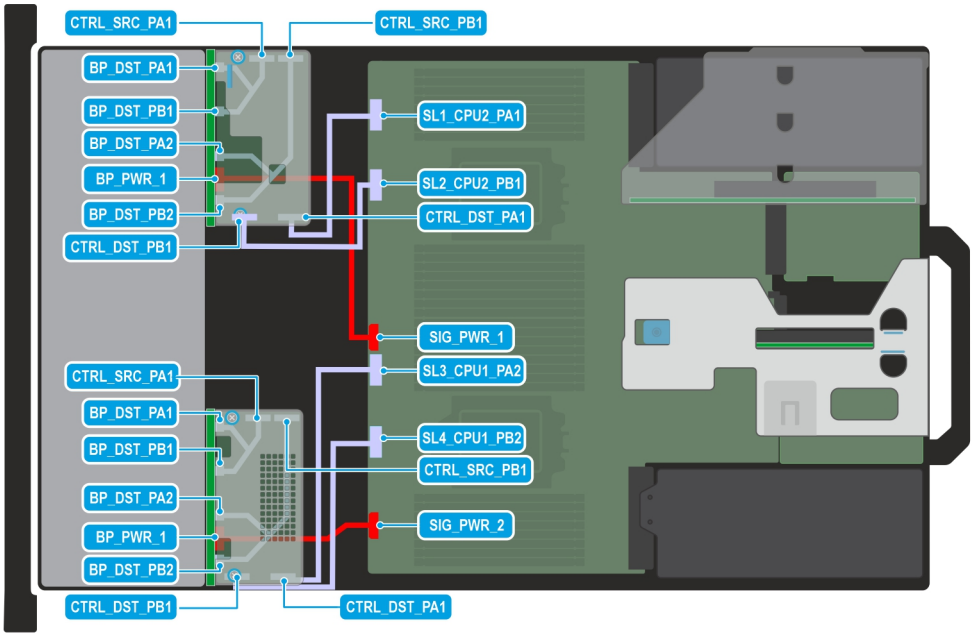


Figure 112. Configuration 11: 16 x 2.5-inch NVMe RAID with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 103. 16 x 2.5-inch NVMe RAID with fPERC (H965i)

Order	From	To
1	SL1_CPU2_PB1 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
2	SL2_CPU2_PA1 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
3	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
4	CTRL_SRC_PB1 (fPERC controller connector)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
5	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
6	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
7	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
8	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)
9	CTRL_SRC_PB1 (fPERC controller connector)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
10	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)

NOTE: An 8 x 2.5-inch NVMe backplanes with fPERC H965i should be assembled outside and inserted into the system, along with all necessary cables.

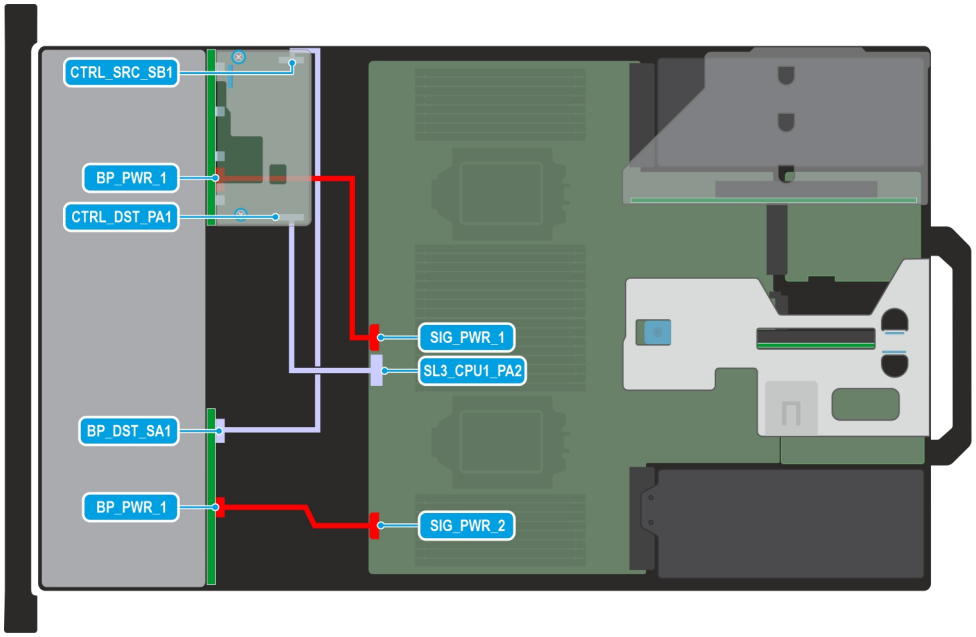


Figure 113. Configuration 12: 16 x 2.5-inch SAS/SATA with fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 104. 16 x 2.5-inch SAS/SATA with fPERC (HBA355i, H355, H755)

Order	From	To
1	SL3_CPU1_PA2 (signal connector on system board)	CTRL_SRC_PA1 (fPERC controller connector)
2	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
3	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
4	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)

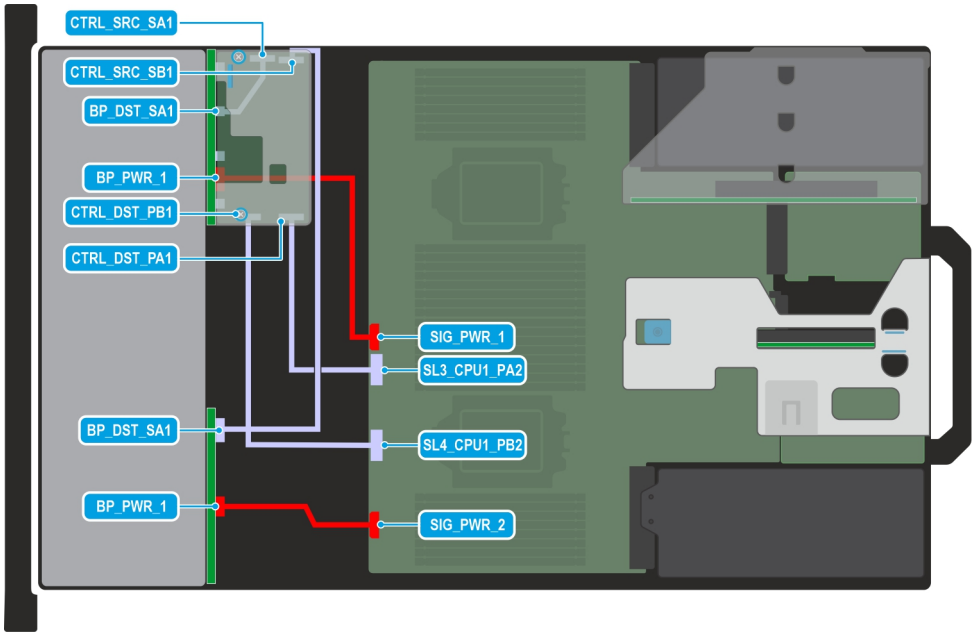


Figure 114. Configuration 13: 16 x 2.5-inch SAS/SATA with fPERC (H965i)

Table 105. 16 x 2.5-inch SAS/SATA with fPERC (H965i)

Order	From	To
1	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
2	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
3	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
4	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
5	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
6	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)

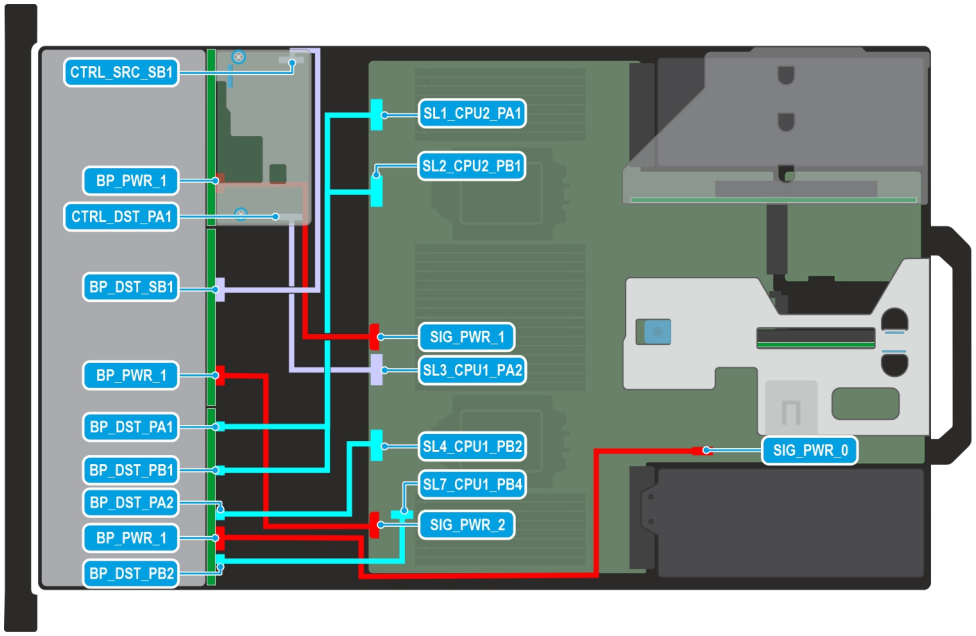


Figure 115. Configuration 14: 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe with fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 106. 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe with fPERC (HBA355i, H355, H755)

Order	From	To
1	SL1_CPU2_PB1 (signal connector on system board) and SL2_CPU2_PA1 (signal connector on system board)	BP_DST_PB1 (backplane signal connector) and BP_DST_PA1 (backplane signal connector)
2	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
3	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
4	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
5	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)
6	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PA2 (fPERC input connector)
7	SL7_CPU1_PB4 (signal connector on system board)	CTRL_DST_PB2 (fPERC input connector)
8	SIG_PWR_0 (system board power connector)	BP_PWR_1 (backplane power connector)

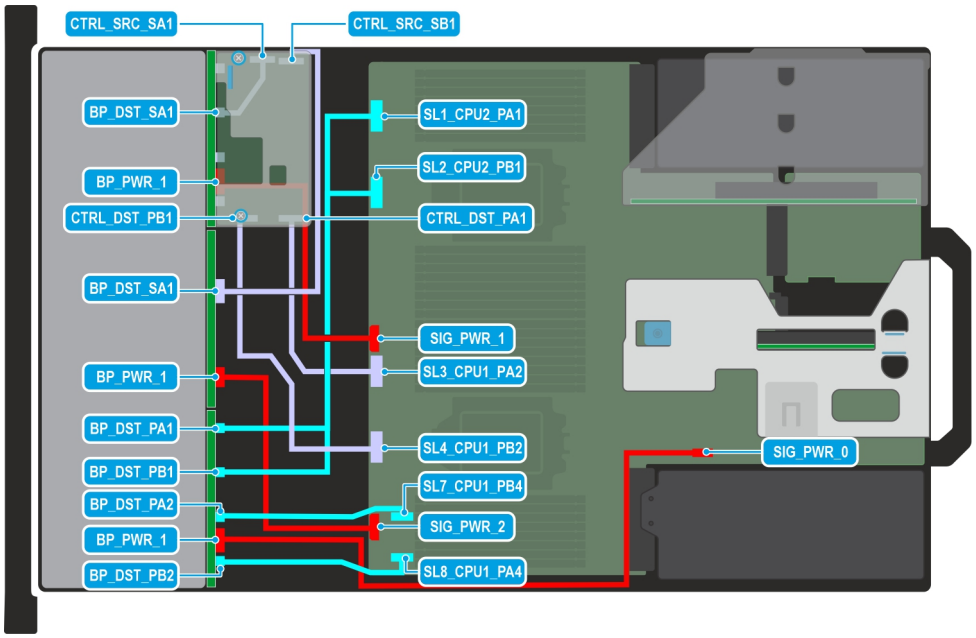


Figure 116. Configuration 15: 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 107. 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe with fPERC (H965i)

Order	From	To
1	SL1_CPU2_PB1 (signal connector on system board) and SL2_CPU2_PA1 (signal connector on system board)	BP_DST_PB1 (backplane signal connector) and BP_DST_PA1 (backplane signal connector)
2	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
3	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)

Table 107. 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe with fPERC (H965i) (continued)

Order	From	To
4	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
5	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
6	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
7	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)
8	SL7_CPU1_PB4 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
9	SIG_PWR_0 (system board power connector)	BP_PWR_1 (backplane power connector)
10	SL8_CPU1_PA4 (signal connector on system board)	BP_DST_BA2 (backplane signal connector)

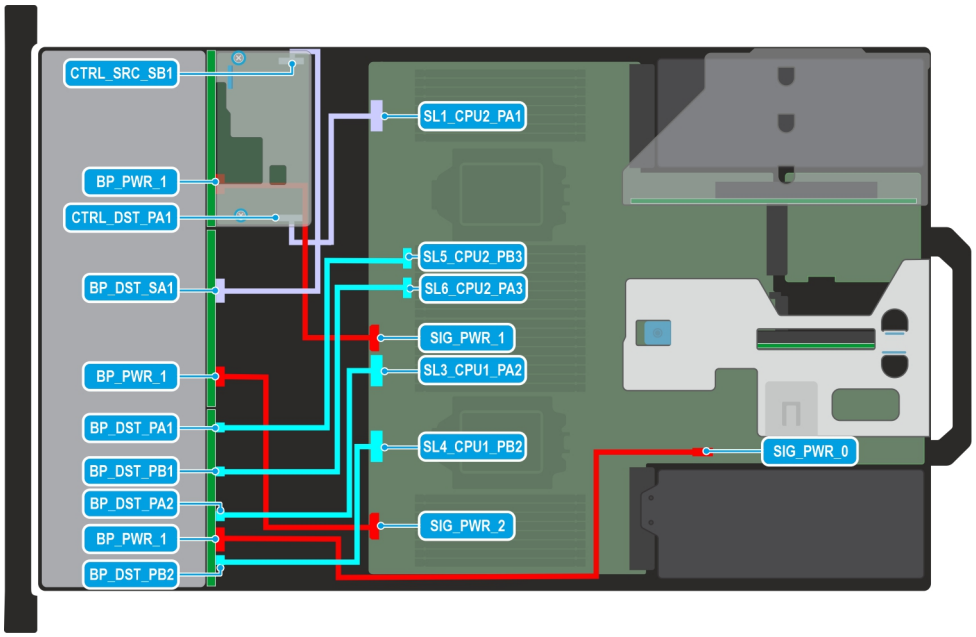


Figure 117. Configuration 16: 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe with fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 108. 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe with fPERC (HBA355i, H355, H755)

Order	From	To
1	SL1_CPU2_PA1 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
2	SL5_CPU2_PB3 (signal connector on system board)	BP_DST_PA1 (backplane signal connector)
3	SL6_CPU2_PA3 (signal connector on system board)	BP_DST_PB1 (backplane signal connector)
4	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
5	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
6	SL3_CPU1_PA2 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)

Table 108. 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe with fPERC (HBA355i, H355, H755) (continued)

Order	From	To
7	SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)
8	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)
9	SIG_PWR_0 (system board power connector)	BP_PWR_1 (backplane power connector)

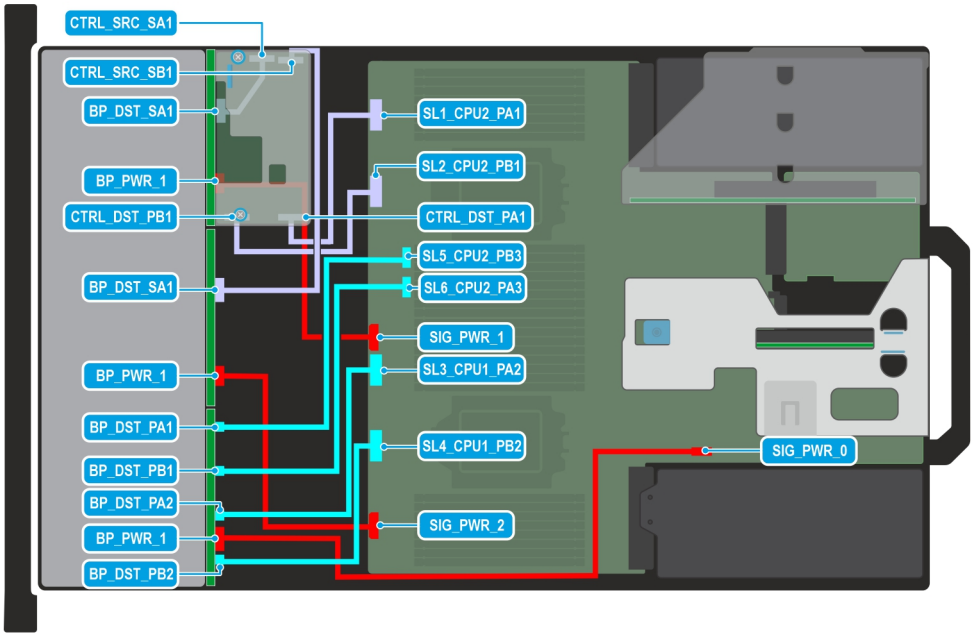


Figure 118. Configuration 17: 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 109. 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe with fPERC (H965i)

Order	From	To
1	SL1_CPU2_PA1 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
2	SL2_CPU2_PB1 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
3	SL5_CPU2_PB3 (signal connector on system board)	BP_DST_PA1 (backplane signal connector)
4	SL6_CPU2_PA3 (signal connector on system board)	BP_DST_PB1 (backplane signal connector)
5	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
6	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
7	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
8	SL3_CPU1_PA2 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
9	SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)

Table 109. 16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe with fPERC (H965i) (continued)

Order	From	To
10	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)
11	SIG_PWR_0 (system board power connector)	BP_PWR_1 (backplane power connector)

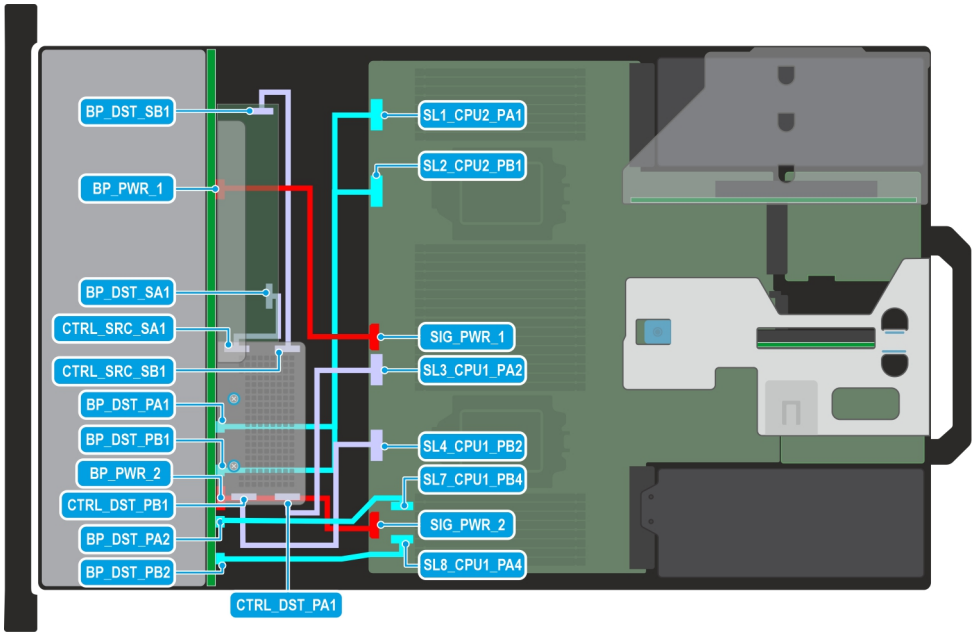


Figure 119. Configuration 18: 24 x 2.5-inch SAS/SATA with 8 universal (SAS/SATA/NVMe) slots and fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 110. 24 x 2.5-inch SAS/SATA with 8 universal (SAS/SATA/NVMe) slots and fPERC (H965i)

Order	From	To
1	SL1_CPU2_PA1 (signal connector on system board) and SL2_CPU2_PB1 (signal connector on system board)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
2	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
3	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
4	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
5	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
6	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
7	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
8	SL7_CPU1_PB4 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
9	SL8_CPU1_PA4 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)

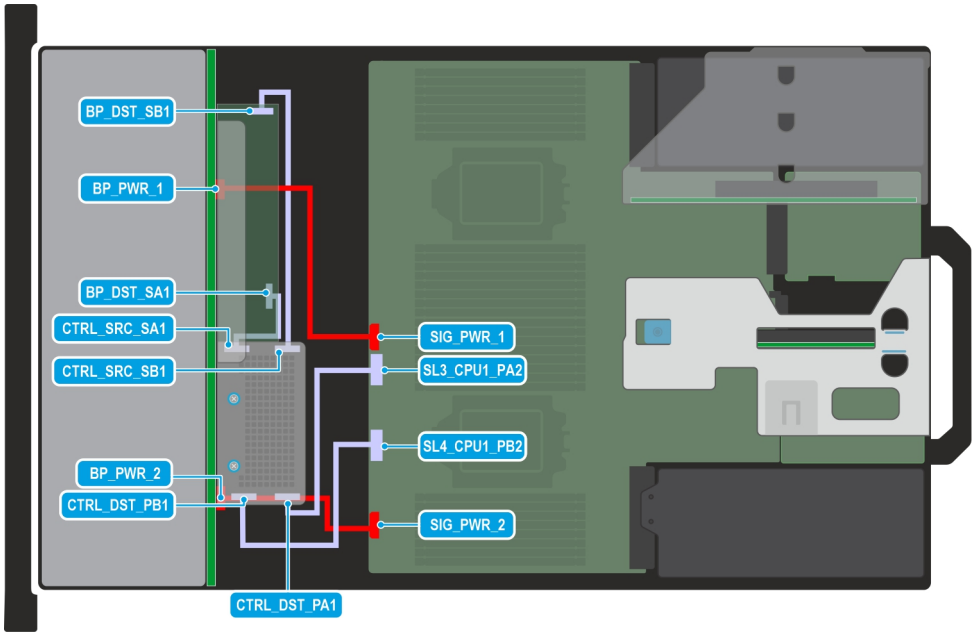


Figure 120. Configuration 19: 24 x 2.5-inch SAS/SATA with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 111. 24 x 2.5-inch SAS/SATA with fPERC (H965i)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
4	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
5	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
6	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)

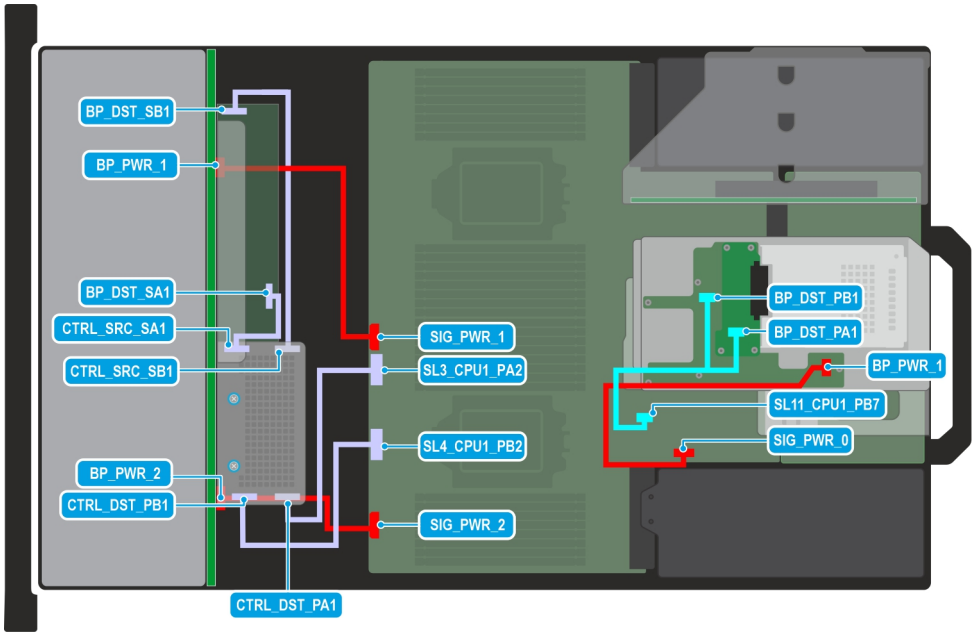


Figure 121. Configuration 20: 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch NVMe with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 112. 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch NVMe with fPERC (H965i)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
4	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
5	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
6	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
7	SL11_CPU1_PB7 (signal connector on system board)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)
8	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)

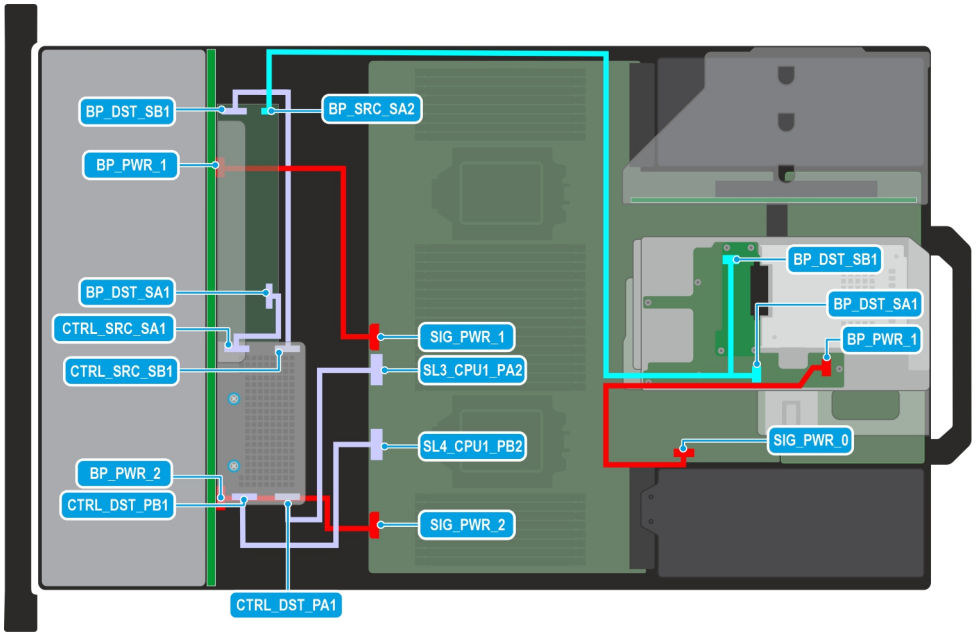


Figure 122. Configuration 21: 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 113. 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA with fPERC (H965i)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
4	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
5	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
6	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
7	BP_SRC_SA2 (backplane expander signal connector)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)
8	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)

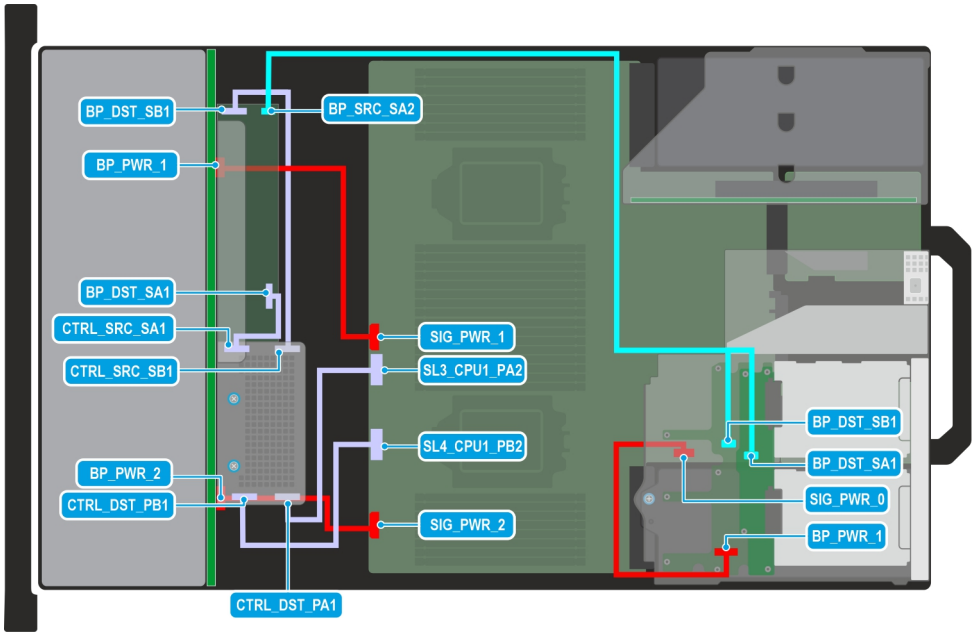


Figure 123. Configuration 22: 24 x 2.5-inch SAS/SATA + 4 x 2.5-inch SAS/SATA with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 114. 24 x 2.5-inch SAS/SATA + 4 x 2.5-inch SAS/SATA with fPERC (H965i)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
4	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
5	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
6	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
7	BP_SRC_SA2 (backplane expander signal connector)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)
8	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)

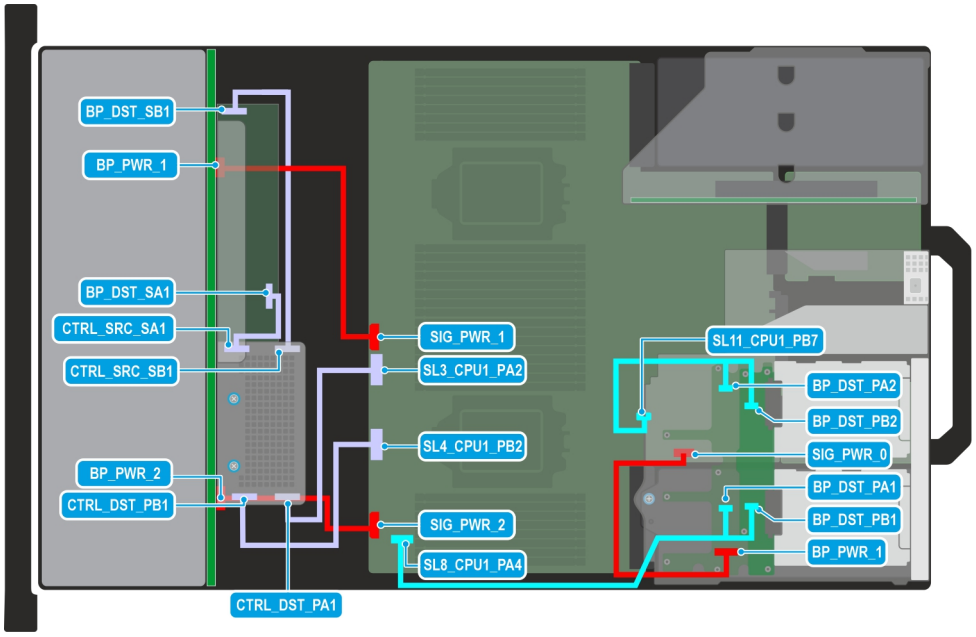


Figure 124. Configuration 23: 24 x 2.5-inch SAS/SATA + 4 x 2.5-inch NVMe with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 115. 24 x 2.5-inch SAS/SATA + 4 x 2.5-inch NVMe with fPERC (H965i)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
4	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
5	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
6	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
7	SL11_CPU1_PB7 (signal connector on system board)	BP_DST_PA2 (rear backplane signal connector) and BP_DST_PB2 (rear backplane signal connector)
8	SL8_CPU1_PA4 (signal connector on system board)	BP_DST_PA1 (rear backplane signal connector) and BP_DST_PB1 (rear backplane signal connector)
9	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)

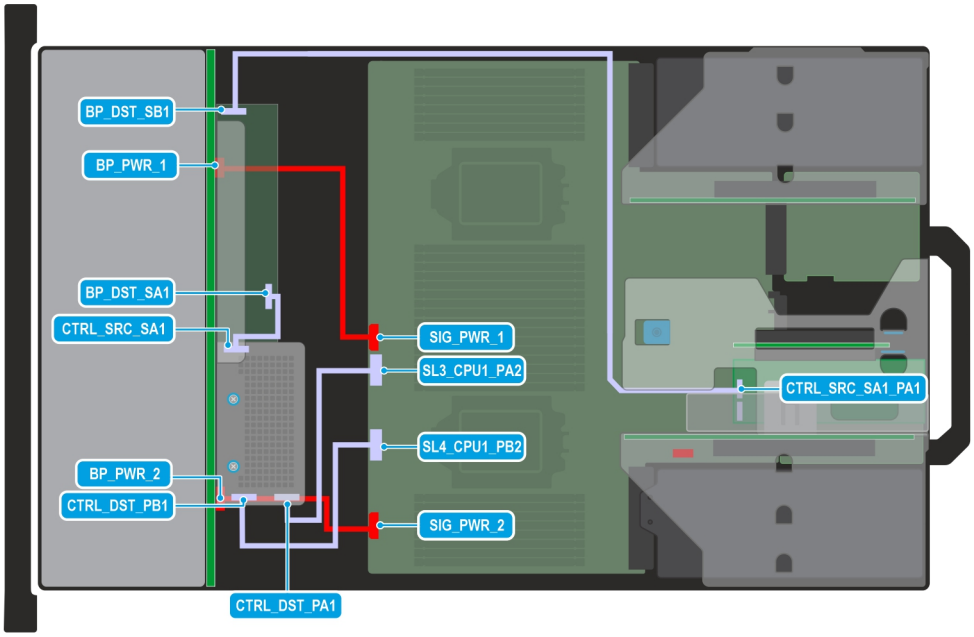


Figure 125. Configuration 24: 24 x 2.5-inch SAS/SATA dual controller with fPERC (H965i) and APERC in Riser 2

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 116. 24 x 2.5-inch SAS/SATA dual controller with fPERC (H965i) and APERC in Riser 2

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
4	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
5	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
6	CTRL_SRC_SA1_PA1 (adapter PERC controller connector)	BP_DST_SB1 (backplane expander signal connector)

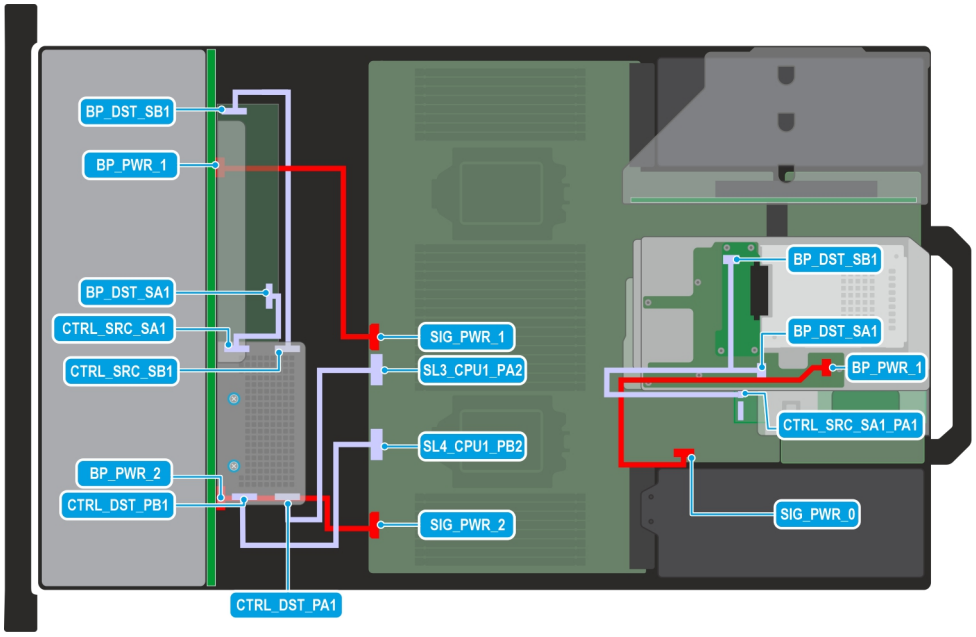


Figure 126. Configuration 25: 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA dual controller with fPERC (H965i) and APERC in Riser 2

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 117. 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA dual controller with fPERC (H965i) and APERC in Riser 2

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
4	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
5	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
6	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
7	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)
8	CTRL_SRC_SA1_PA1 (adapter PERC controller connector)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)

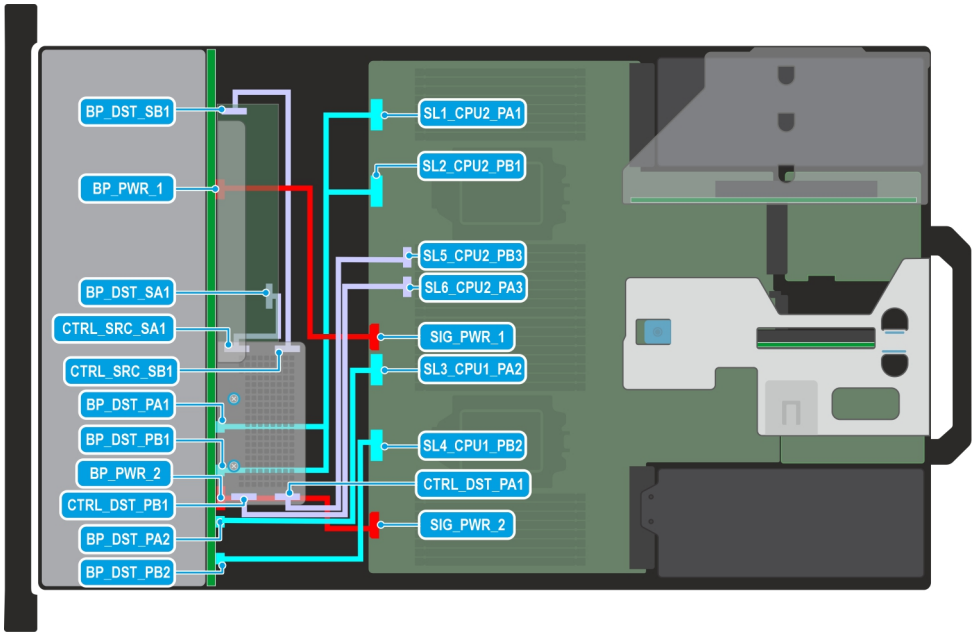


Figure 127. Configuration 26: 24 x 2.5-inch SAS/SATA with 8 universal (SAS/SATA/NVMe) slot and fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 118. 24 x 2.5-inch SAS/SATA with 8 universal (SAS/SATA/NVMe) slot and fPERC (H965i)

Order	From	To
1	SL1_CPU2_PA1 (signal connector on system board) and SL2_CPU2_PB1 (signal connector on system board)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
2	SL5_CPU2_PB3 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SL6_CPU2_PA3 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
4	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
5	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
6	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
7	SL3_CPU1_PA2 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
8	SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)
9	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)

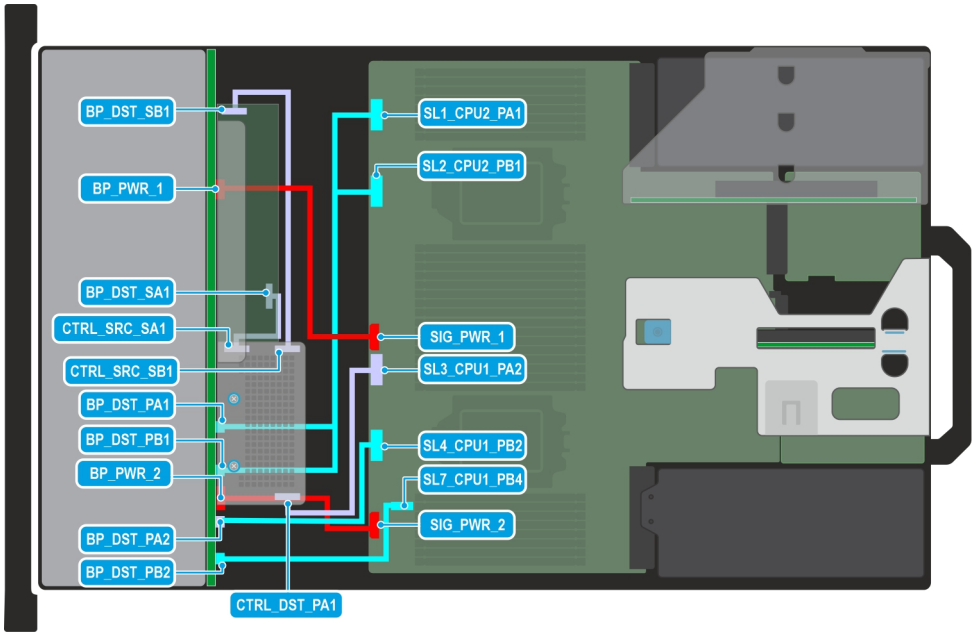


Figure 128. Configuration 27: 24 x 2.5-inch SAS/SATA with 8 universal (SAS/SATA/NVMe) slot and fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 119. 24 x 2.5-inch SAS/SATA with eight universal slots (SAS/SATA/NVMe) and fPERC (HBA355i, H355, H755)

Order	From	To
1	SL1_CPU2_PA1 (signal connector on system board) and SL2_CPU2_PB1 (signal connector on system board)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
2	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
3	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
4	SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
5	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
6	CTRL_SRC_SA1 (fPERC controller connector) **NOTE:** Tightening the connector screws secures the connector end.	BP_DST_SA1 (backplane expander signal connector)
7	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
8	SL7_CPU1_PB4 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)

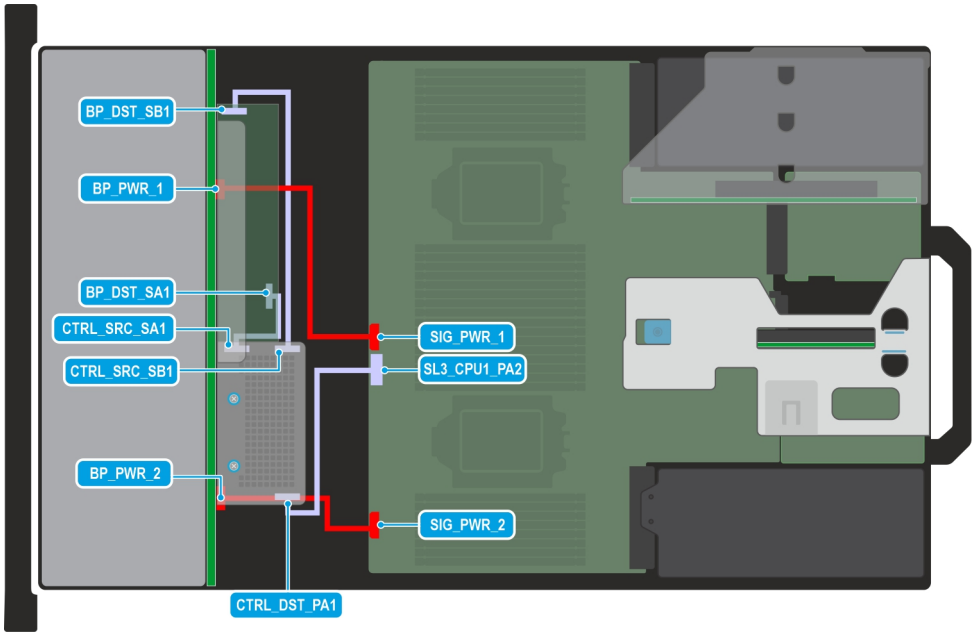


Figure 129. Configuration 28: 24 x 2.5-inch SAS/SATA with fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 120. 24 x 2.5-inch SAS/SATA with fPERC (HBA355i, H355, H755)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
4	CTRL_SRC_SA1 (fPERC controller connector) **NOTE:** Tightening the connector screws secures the connector end.	BP_DST_SA1 (backplane expander signal connector)
5	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)

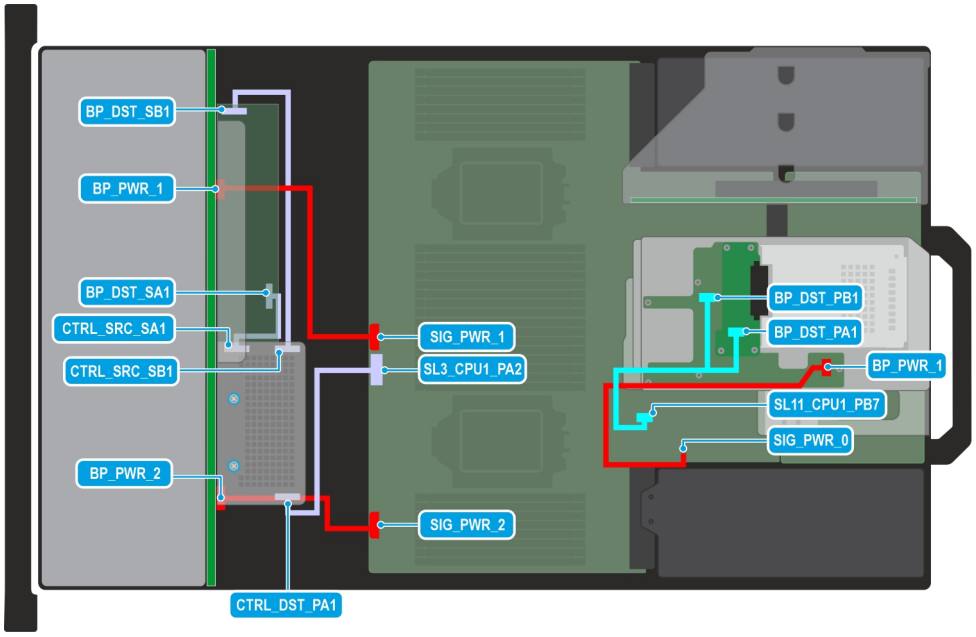


Figure 130. Configuration 29: 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch NVMe with fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 121. 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch NVMe with fPERC (HBA355i, H355, H755)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
4	CTRL_SRC_SA1 (fPERC controller connector) **NOTE:** Tightening the connector screws secures the connector end.	BP_DST_SA1 (backplane expander signal connector)
5	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
6	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)
7	SL11_CPU1_PB7 (signal connector on system board)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)

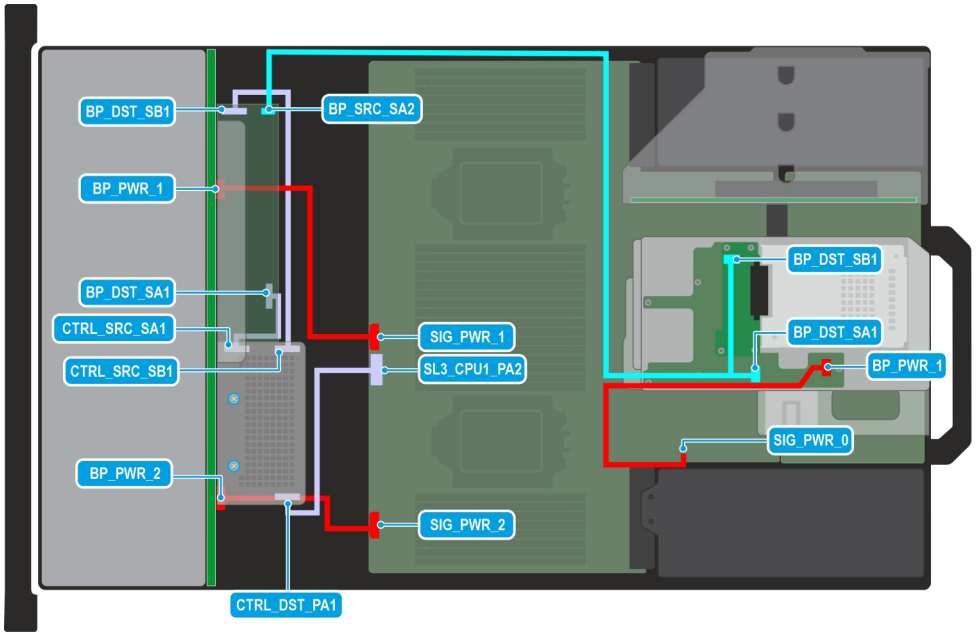


Figure 131. Configuration 30: 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA with fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 122. 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA with fPERC (HBA355i, H355, H755)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
4	CTRL_SRC_SA1 (fPERC controller connector) **NOTE:** Tightening the connector screws secures the connector end.	BP_DST_SA1 (backplane expander signal connector)
5	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
6	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)
7	BP_SRC_SA2 (backplane expander signal connector)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)

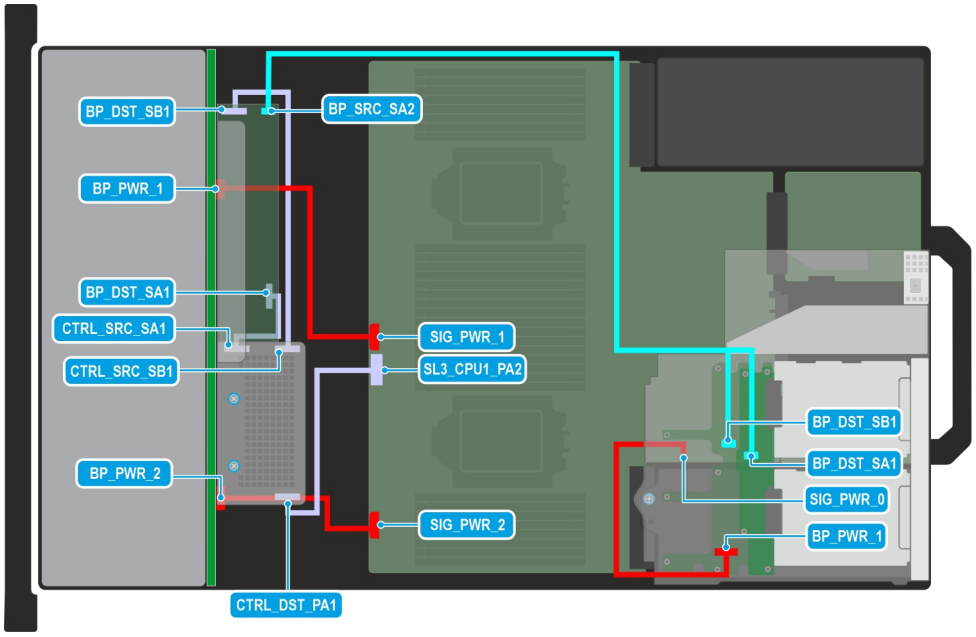


Figure 132. Configuration 31: 24 x 2.5-inch SAS/SATA + 4 x 2.5-inch SAS/SATA with fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 123. 24 x 2.5-inch SAS/SATA + 4 x 2.5-inch SAS/SATA with fPERC (HBA355i, H355, H755)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
4	CTRL_SRC_SA1 (fPERC controller connector) **NOTE:** Tightening the connector screws secures the connector end.	BP_DST_SA1 (backplane expander signal connector)
5	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
6	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)
7	BP_SRC_SA2 (backplane expander signal connector)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)

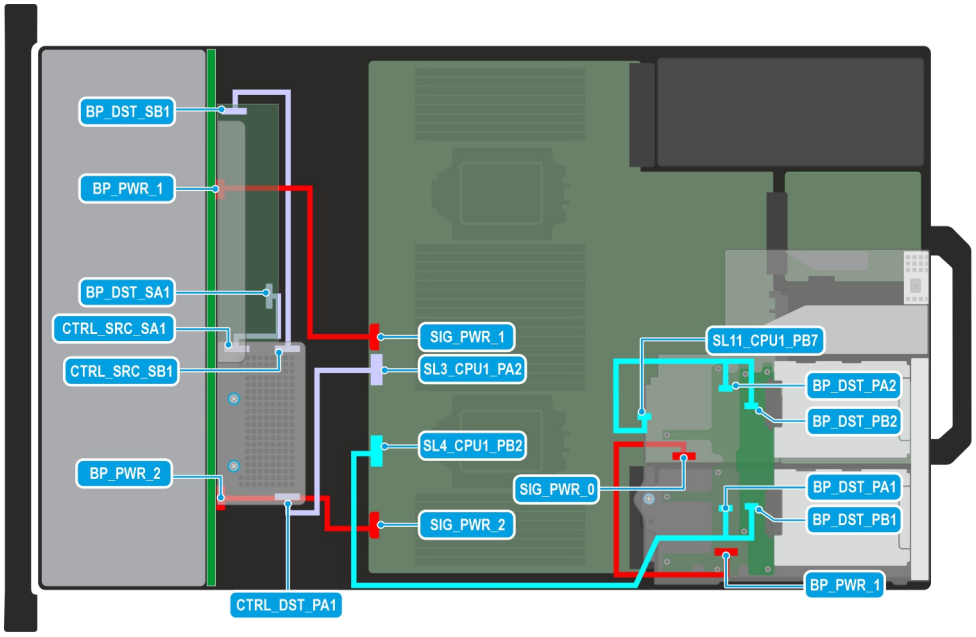


Figure 133. Configuration 32: 24 x 2.5-inch SAS/SATA + 4 x 2.5-inch NVMe with fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 124. 24 x 2.5-inch SAS/SATA + 4 x 2.5-inch NVMe with fPERC (HBA355i, H355, H755)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
4	CTRL_SRC_SA1 (fPERC controller connector) **NOTE:** Tightening the connector screws secures the connector end.	BP_DST_SA1 (backplane expander signal connector)
5	SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PA1 (rear backplane signal connector) and BP_DST_PB1 (rear backplane signal connector)
6	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
7	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)
8	SL11_CPU1_PB7 (signal connector on system board)	BP_DST_PA2 (rear backplane signal connector) and BP_DST_PB2 (rear backplane signal connector)

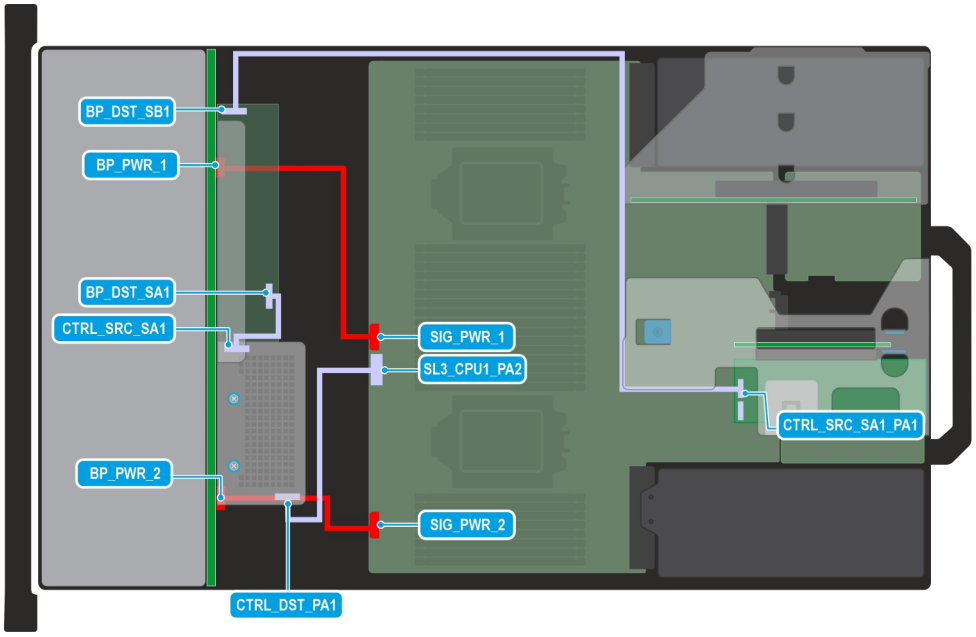


Figure 134. Configuration 33: 24 x 2.5-inch SAS/SATA dual controller with fPERC (HBA355i, H355, H755) and APERC in Riser 2

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 125. 24 x 2.5-inch SAS/SATA dual controller with fPERC (HBA355i, H355, H755) and APERC in Riser 2

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	CTRL_SRC_SA1 (fPERC controller connector) **NOTE:** Tightening the connector screws secures the connector end.	BP_DST_SA1 (backplane expander signal connector)
4	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
5	CTRL_SRC_SA1_PA1 (adapter PERC controller connector)	BP_DST_SB1 (backplane expander signal connector)

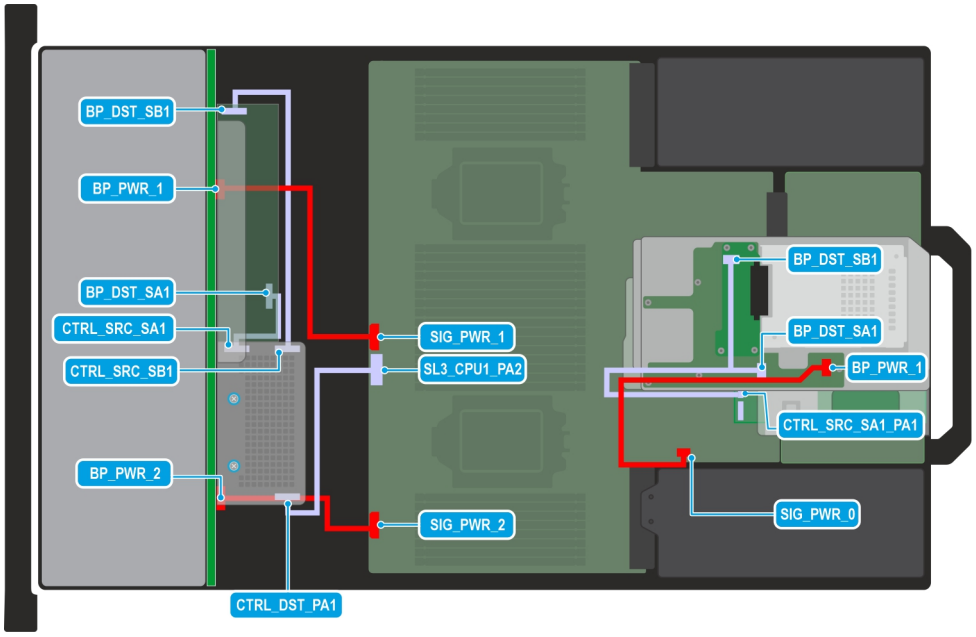


Figure 135. Configuration 34: 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA dual controller with fPERC (HBA355i, H355, H755) and APERC in Riser 2

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 126. 24 x 2.5-inch SAS/SATA + 2 x 2.5-inch SAS/SATA dual controller with fPERC (HBA355i, H355, H755) and APERC in Riser 2

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
4	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
5	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
6	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)
7	CTRL_SRC_SA1_PA1 (adapter PERC controller connector)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)

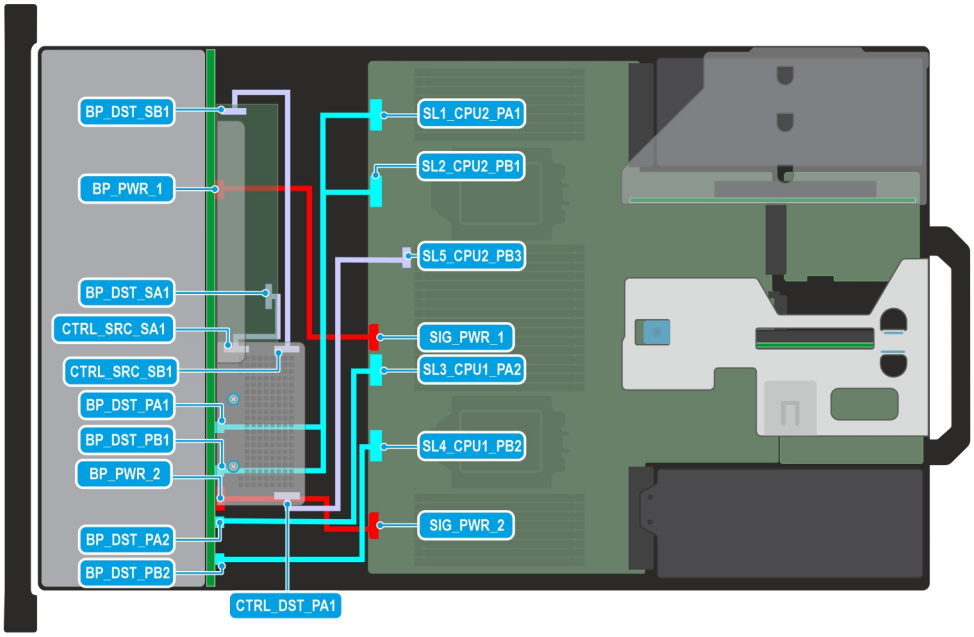


Figure 136. Configuration 35: 24 x 2.5-inch SAS/SATA with 8 universal (SAS/SATA/NVMe) slots and fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 127. 24 x 2.5-inch SAS/SATA with 8 universal (SAS/SATA/NVMe) slots and fPERC (HBA355i, H355, H755)

Order	From	To
1	SL1_CPU2_PA1 (signal connector on system board) and SL2_CPU2_PB1 (signal connector on system board)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
2	SL5_CPU2_PB3 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
4	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
5	CTRL_SRC_SA1 (fPERC controller connector) **NOTE:** Tightening the connector screws secures the connector end.	BP_DST_SA1 (backplane expander signal connector)
6	SL3_CPU1_PA2 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
7	SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)
8	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)

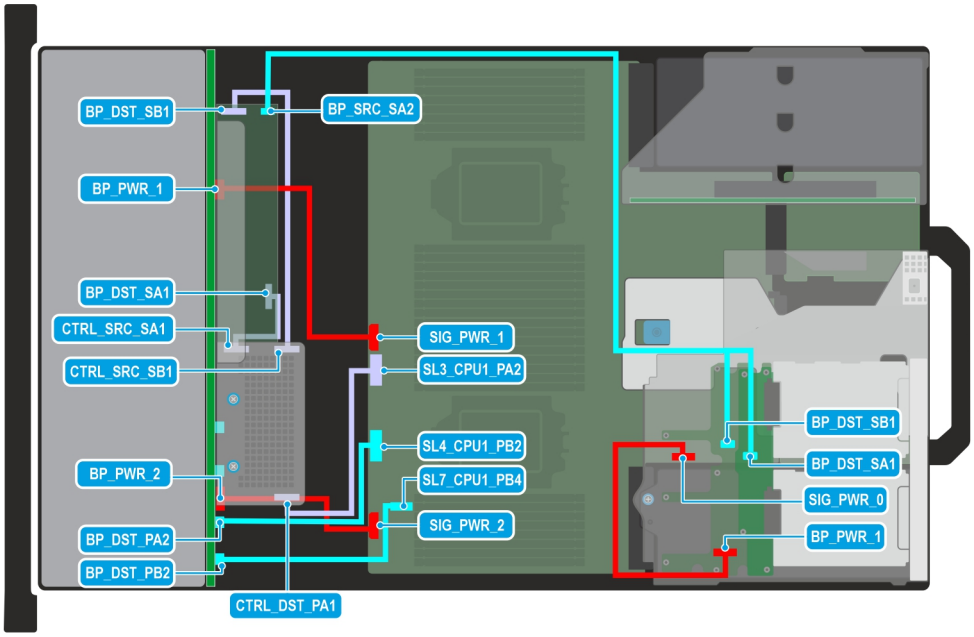


Figure 137. Configuration 36: 24 x 2.5-inch SAS/SATA with 4 universal (SAS/SATA/NVMe) slots + 4 x 2.5-inch SAS/SATA with fPERC (HBA355i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 128. 24 x 2.5-inch SAS/SATA with 4 universal (SAS/SATA/NVMe) slots+ 4 x 2.5-inch SAS/SATA with fPERC (HBA355i)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
4	CTRL_SRC_SA1 (fPERC controller connector) **NOTE:** Tightening the connector screws secures the connector end.	BP_DST_SA1 (backplane expander signal connector)
5	SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
6	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
7	SL7_CPU1_PB4 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)
8	SIG_PWR_0 (system board power connector)	BP_PWR_1 (rear backplane power connector)
9	BP_SRC_SA2 (backplane expander signal connector)	BP_DST_SA1 (rear backplane signal connector) and BP_DST_SB1 (rear backplane signal connector)

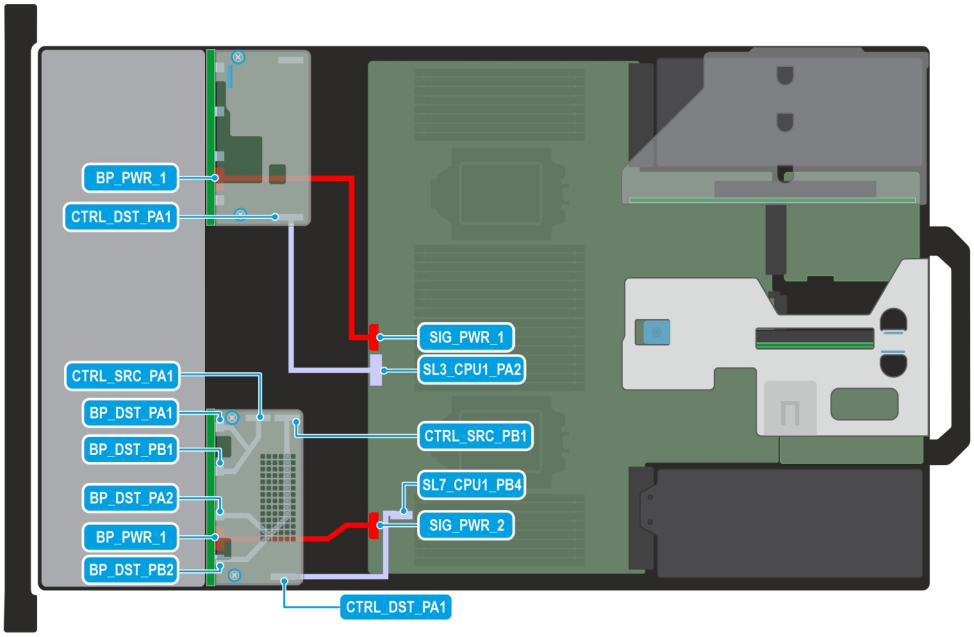


Figure 138. Configuration 37: 16 x 2.5-inch (8 x SAS/SATA with fPERC (HBA355i, H355, H755) + 8 x NVMe RAID with fPERC (H755N))

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 129. 16 x 2.5-inch (8 x SAS/SATA with fPERC (HBA355i, H355, H755) + 8 x NVMe RAID with fPERC (H755N))

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
4	CTRL_SRC_PB1 (fPERC controller connector)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
5	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
6	SL7_CPU1_PB4 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)

NOTE: An 8 x 2.5-inch NVMe backplane with fPERC H755N should be assembled outside and inserted into the system, along with all necessary cables.

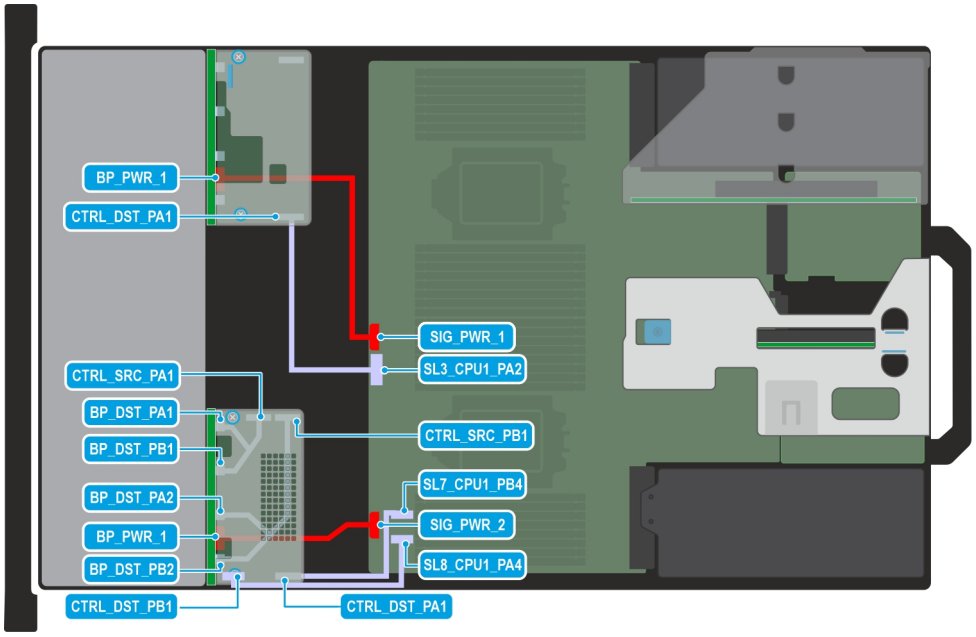


Figure 139. Configuration 38: 16 x 2.5-inch (8 x SAS/SATA with fPERC (HBA355i, H355, H755) + 8 x NVMe RAID with fPERC (H965i))

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 130. 16 x 2.5-inch (8 x SAS/SATA with fPERC (HBA355i, H355, H755) + 8 x NVMe RAID with fPERC (H965i))

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
4	CTRL_SRC_PB1 (fPERC controller connector)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
5	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
6	SL7_CPU1_PB4 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
7	SL8_CPU1_PA4 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)

NOTE: An 8 x 2.5-inch NVMe backplane with fPERC H965i should be assembled outside and inserted into the system, along with all necessary cables.

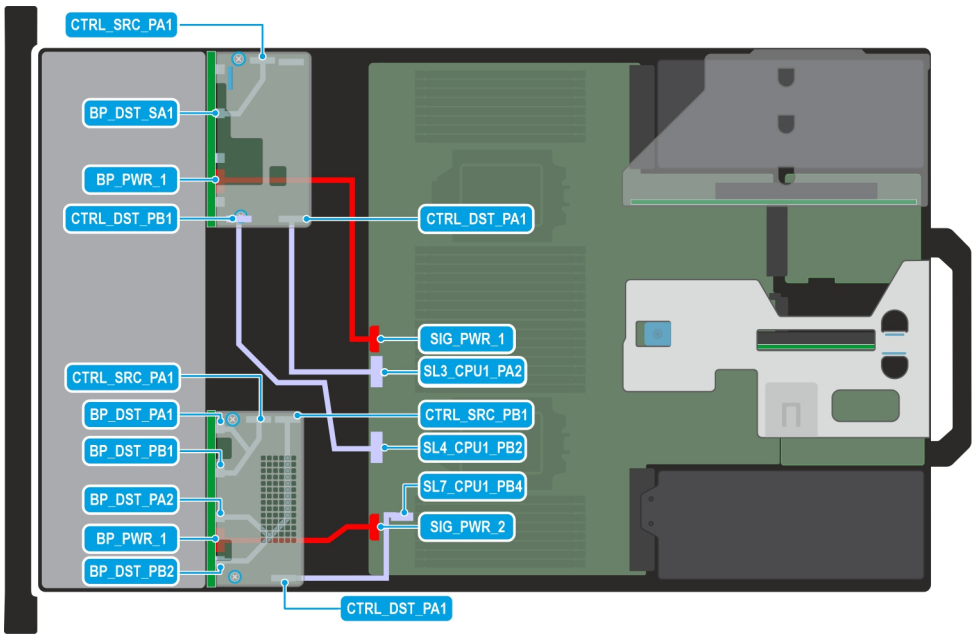


Figure 140. Configuration 39: 16 x 2.5-inch (8 x SAS/SATA with fPERC (H965i) + 8 x NVMe RAID with fPERC (H755N))

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 131. 16 x 2.5-inch (8 x SAS/SATA with fPERC (H965i) + 8 x NVMe RAID with fPERC (H755N))

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
4	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
5	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
6	CTRL_SRC_PB1 (fPERC controller connector)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
7	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
8	SL7_CPU1_PB4 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)

NOTE: An 8 x 2.5-inch NVMe backplane with fPERC H755N should be assembled outside and inserted into the system, along with all necessary cables.

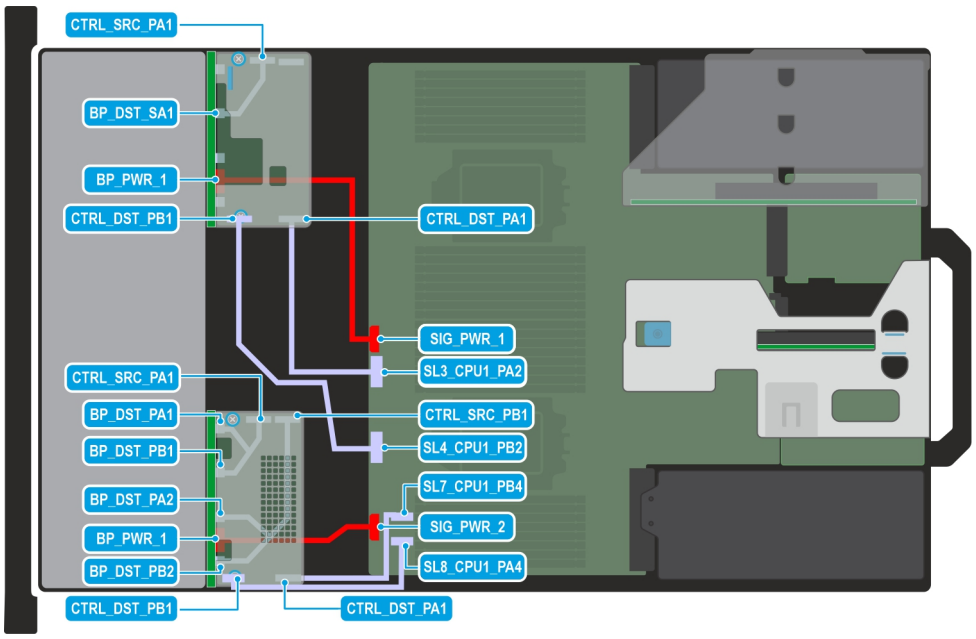


Figure 141. Configuration 40: 16 x 2.5-inch (8 x SAS/SATA with fPERC (H965i) + 8 x NVMe RAID with fPERC (H965i))

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 132. 16 x 2.5-inch (8 x SAS/SATA with fPERC (H965i) + 8 x NVMe RAID with fPERC (H965i))

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
4	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
5	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
6	CTRL_SRC_PB1 (fPERC controller connector)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
7	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
8	SL7_CPU1_PB4 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
9	SL8_CPU1_PA4 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)

NOTE: An 8 x 2.5-inch NVMe backplane with fPERC H965i should be assembled outside and inserted into the system, along with all necessary cables.

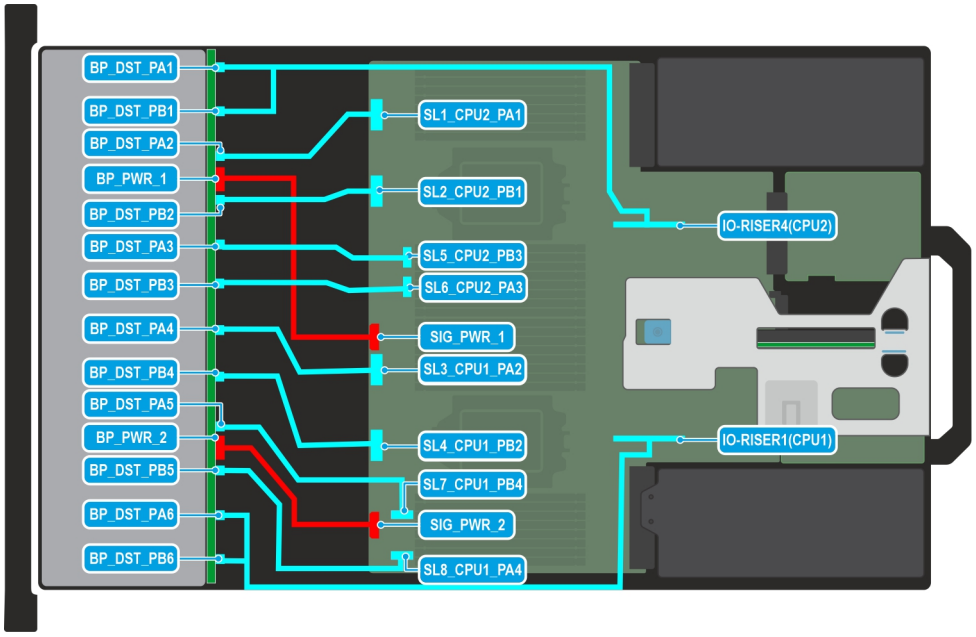


Figure 142. Configuration 41: 24 x 2.5-inch (NVMe Gen4) Passive

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 133. 24 x 2.5-inch (NVMe Gen4) Passive

Order	From	To
1	IO_RISER4(CPU2) (Riser 4 connector on system board)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
2	SL1_CPU2_PA1 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
3	SL2_CPU2_PB1 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)
4	SL5_CPU2_PB3 (signal connector on system board)	BP_DST_PA3 (backplane signal connector)
5	SL6_CPU2_PA3 (signal connector on system board)	BP_DST_PB3 (backplane signal connector)
6	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
7	SL3_CPU1_PA2 (signal connector on system board)	BP_DST_PA4 (backplane signal connector)
8	SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PB4 (backplane signal connector)
9	SL7_CPU1_PB4 (signal connector on system board)	BP_DST_PA5 (backplane signal connector)
10	SL8_CPU1_PA4 (signal connector on system board)	BP_DST_PB5 (backplane signal connector)
11	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
12	IO_RISER1(CPU1) (Riser 1 connector on system board)	BP_DST_PA6 (backplane signal connector) and BP_DST_PB6 (backplane signal connector)

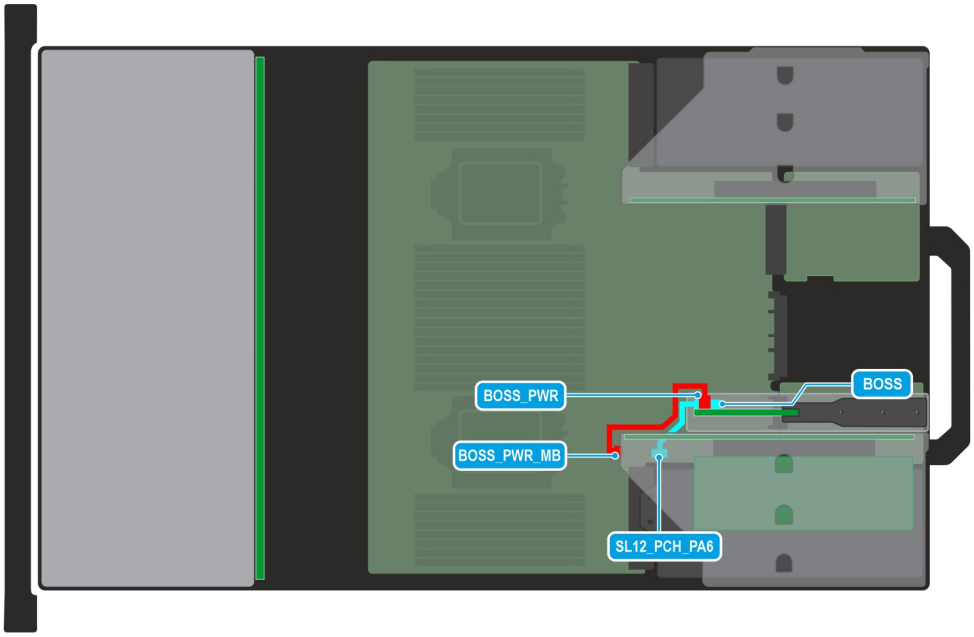


Figure 143. Configuration 42: BOSS-N1 module in Riser 1

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 134. BOSS-N1 module in Riser 1

Order	From	To
1	BOSS_PWR_MB (BOSS power connector on system board)	BOSS_PWR (BOSS module power connector)
2	SL12_PCH_PA6 (signal connector on system board)	BOSS (BOSS module signal connector)

NOTE: The BOSS-N1 power and signal cables are routed beneath Riser 1 and ensure not to damage the cables.

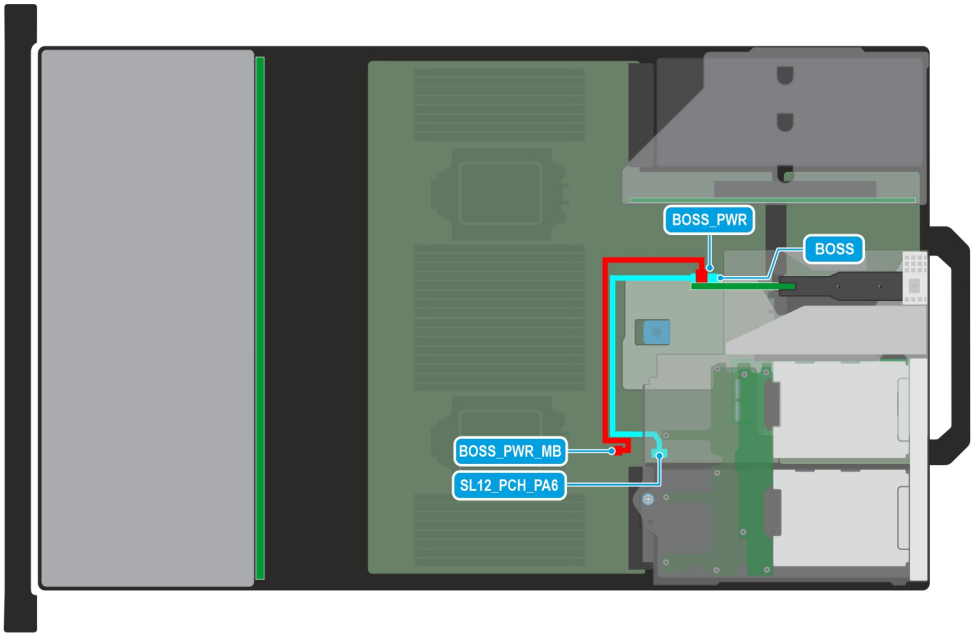


Figure 144. Configuration 43: BOSS-N1 module in 4 x 2.5-inch rear drive module

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 135. BOSS-N1 module in 4 x 2.5-inch rear drive module

Order	From	To
1	BOSS_PWR_MB (BOSS power connector on system board)	BOSS_PWR (BOSS module power connector)
2	SL12_PCH_PA6 (signal connector on system board)	BOSS (BOSS module signal connector)

NOTE: The BOSS-N1 signal cable is routed beneath the rear drive module and ensures not to damage the cable.

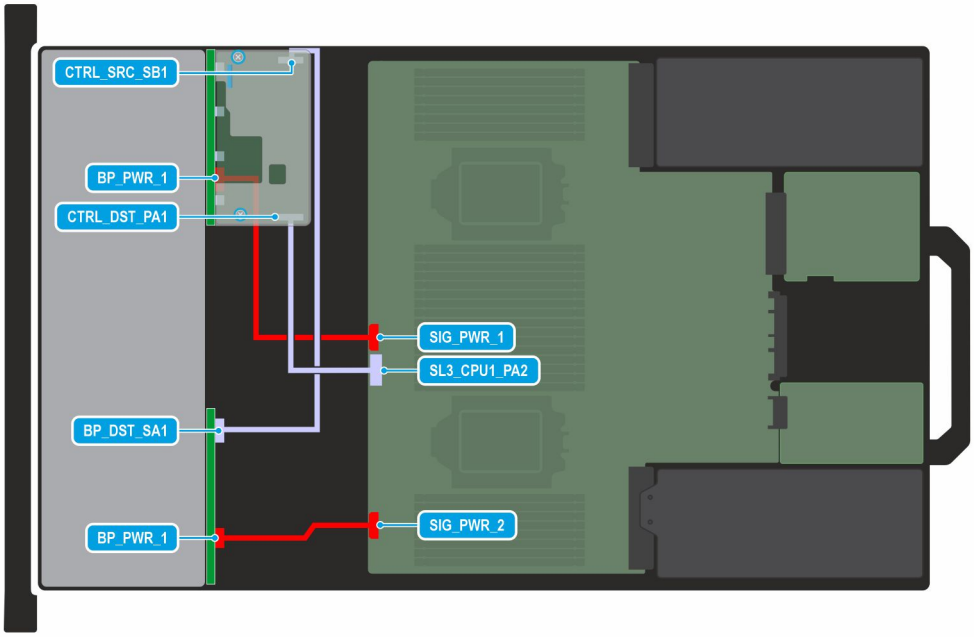


Figure 145. Configuration 44: 16 x 2.5-inch (SAS/SATA) with one CPU and fPERC (H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 136. 16 x 2.5-inch (SAS/SATA) with one CPU and fPERC (H755)

Order	From	To
1	BP_DST_SA1 (backplane signal connector)	CTRL_SRC_SB1 (fPERC controller connector)
2	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC controller connector)
3	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
4	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)

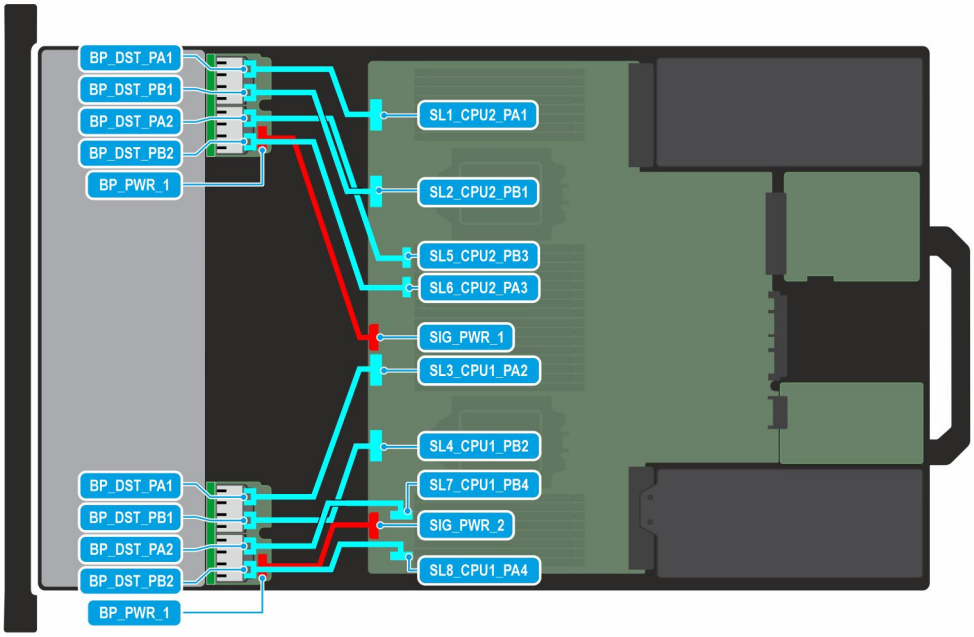


Figure 146. Configuration 45: 16 x EDSFF E3.S NVMe without fPERC

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 137. 16 x EDSFF E3.S NVMe without fPERC

Order	From	To
1	SL1_CPU2_PA1 (signal connector on system board)	BP_DST_PA1 (backplane signal connector)
2	SL2_CPU2_PB1 (signal connector on system board)	BP_DST_PB1 (backplane signal connector)
3	SL5_CPU2_PB3 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
4	SL6_CPU2_PA3 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)
5	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
6	SL3_CPU1_PA2 (signal connector on system board)	BP_DST_PA1 (backplane signal connector)
7	SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PB1 (backplane signal connector)
8	SL7_CPU1_PB4 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
9	SL8_CPU1_PA4 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)
10	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)

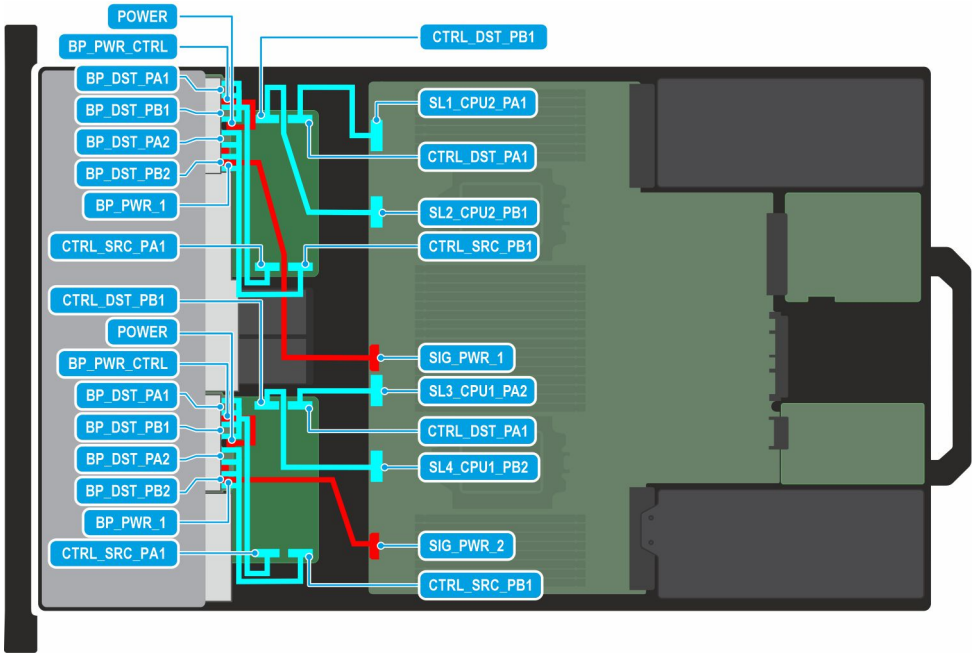


Figure 147. Configuration 46: 16 x EDSFF E3.S NVMe with dual fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 138. 16 x EDSFF E3.S NVMe with dual fPERC (H965i)

Order	From	To
1	SL1_CPU2_PA1 (signal connector on system board)	CTRL_DST_PA1 (fPERC controller connector)
2	SL2_CPU2_PB1 (signal connector on system board)	CTRL_DST_PB1 (fPERC controller connector)
3	BP_PWR_CTRL (power controller connector on backplane)	POWER (fPERC power controller connector)
4	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)	CTRL_SRC_PA1 (fPERC controller connector)
5	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)	CTRL_SRC_PB1 (fPERC controller connector)
6	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
7	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC controller connector)
8	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC controller connector)
9	BP_PWR_CTRL (power controller connector on backplane)	POWER (fPERC power controller connector)
10	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)	CTRL_SRC_PA1 (fPERC controller connector)
11	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)	CTRL_SRC_PB1 (fPERC controller connector)
12	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)

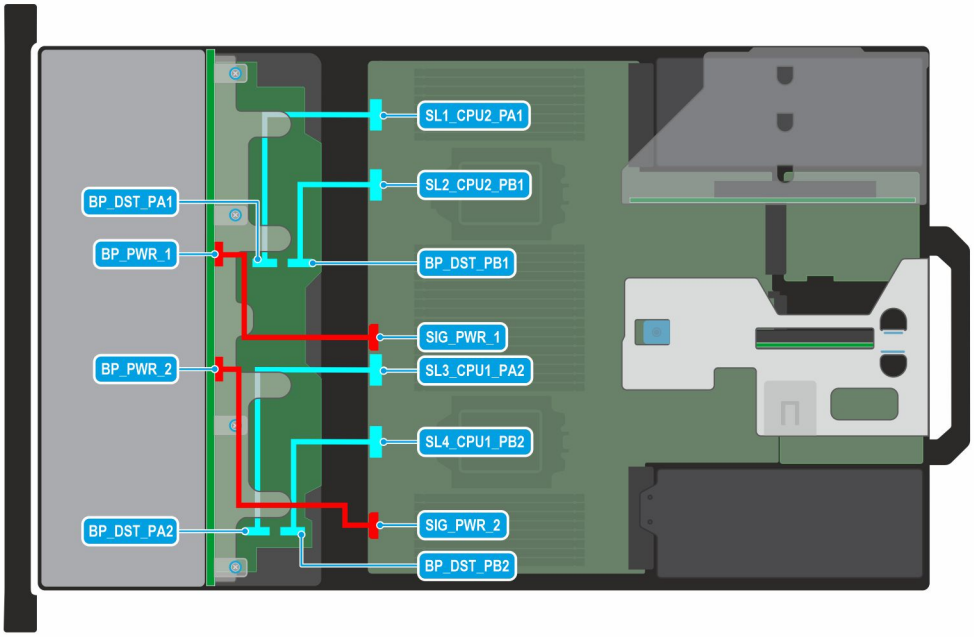


Figure 148. Configuration 47: 24 x 2.5-inch (NVMe Gen5) switched

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 139. 24 x 2.5-inch (NVMe Gen5) switched

Order	From	To
1	SL1_CPU2_PA1 (signal connector on system board)	BP_DST_PA1 (backplane signal connector)
2	SL2_CPU2_PB1 (signal connector on system board)	BP_DST_PB1 (backplane signal connector)
3	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
4	SL3_CPU1_PA2 (signal connector on system board)	BP_DST_PA2 (backplane signal connector)
5	SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PB2 (backplane signal connector)
6	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)

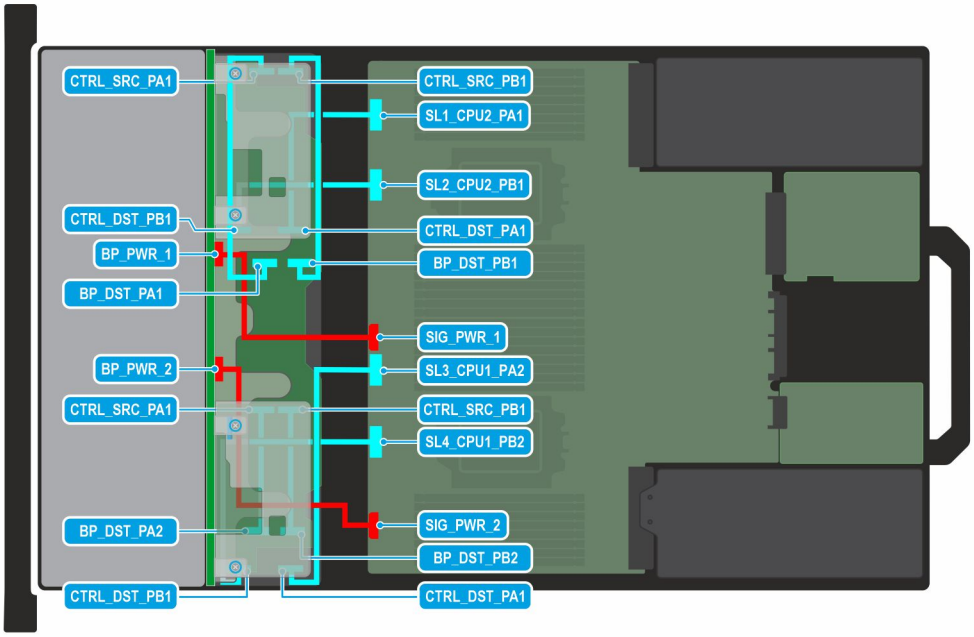


Figure 149. Configuration 48: 24 x 2.5-inch (NVMe Gen5) switched with dual fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 140. 24 x 2.5-inch (NVMe Gen5) switched with dual fPERC (H965i)

Order	From	To
1	BP_DST_PB1 (backplane signal connector)	CTRL_SRC_PB1 (fPERC controller connector)
2	BP_DST_PA1 (backplane signal connector)	CTRL_SRC_PA1 (fPERC controller connector)
3	SL1_CPU2_PA1 (signal connector on system board)	CTRL_DST_PA1 (fPERC controller connector)
4	SL2_CPU2_PB1 (signal connector on system board)	CTRL_DST_PB1 (fPERC controller connector)
5	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
6	BP_DST_PB2 (backplane signal connector)	CTRL_SRC_PB1 (fPERC controller connector)
7	BP_DST_PA2 (backplane signal connector)	CTRL_SRC_PA1 (fPERC controller connector)
8	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC controller connector)
9	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC controller connector)
10	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)

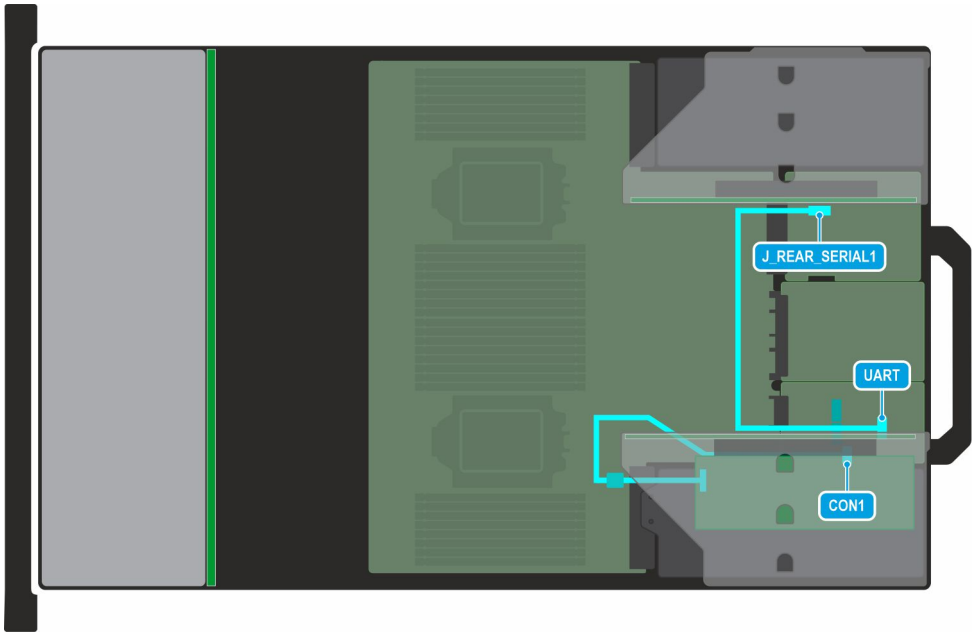


Figure 150. Configuration 49: Dell DPU (Mellanox: 25 Gb, Pensando: 100 Gb or 25 Gb) without power cable

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 141. Dell DPU (Mellanox: 25 Gb, Pensando: 100 Gb or 25 Gb) without power cable

Order	From	To
1	J_REAR_SERIAL1 (UART connector on rear I/O card)	UART (UART connector on MIC card)
2	CON1 (Connector 1 on MIC card)	Connector on DPU card in riser 1

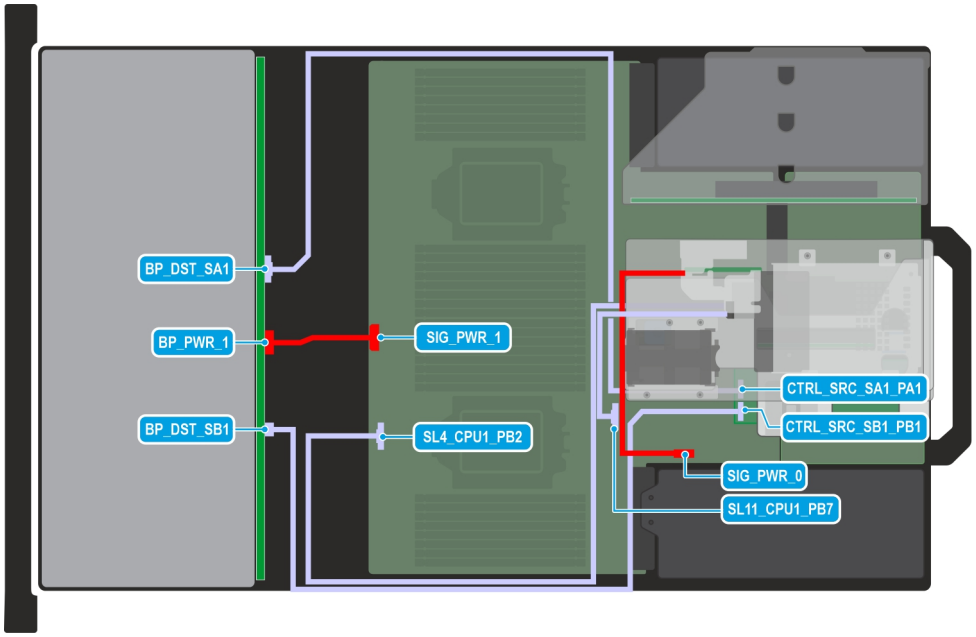


Figure 151. Configuration 50: 12 x 3.5-inch SAS/SATA + 4 x EDSFF E3.S with APERC11 in Riser 2

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 142. 12 x 3.5-inch SAS/SATA + 4 x EDSFF E3.S with APERC11 in Riser 2

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	CTRL_SRC_SB1_PB1 (adapter PERC controller connector)	BP_DST_SB1 (backplane signal connector)
3	CTRL_SRC_SA1_PA1 (adapter PERC controller connector)	BP_DST_SA1 (backplane signal connector)
4	SIG_PWR_0 (system board power connector)	Power connector on E3 rear module*
5	SL4_CPU1_PA2 (signal connector on system board)	Rear backplane signal connector on E3 rear module*
6	SL11_CPU1_PB7 (signal connector on system board)	Rear backplane signal connector on E3 rear module*

NOTE: *Disconnect cables from the system board side since the cables in the rear E3 module are preassembled.

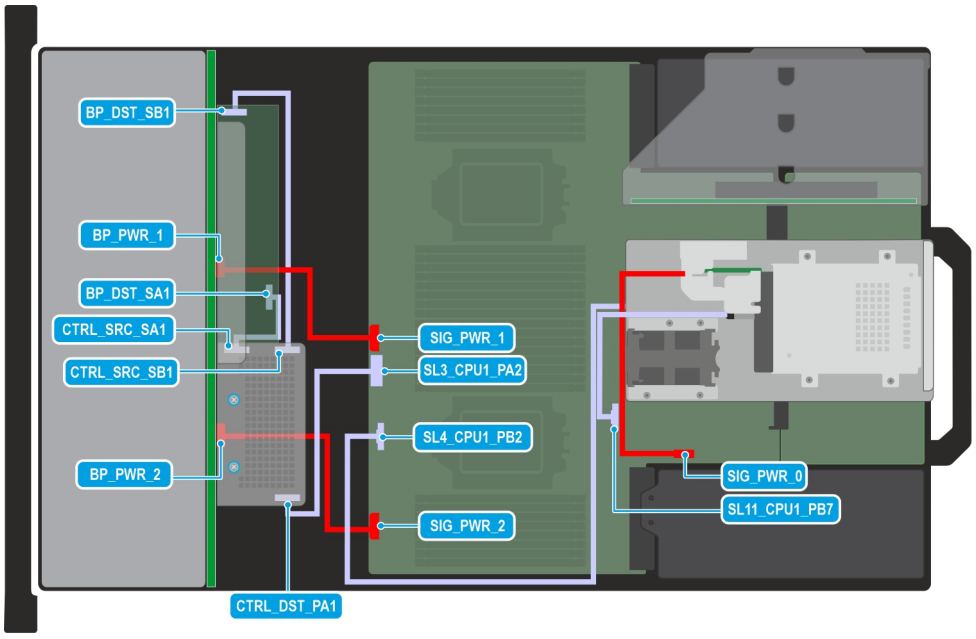


Figure 152. Configuration 51: 24 x 2.5-inch SAS/SATA + 4 x EDSFF E3.S with fPERC (HBA355i, H355, H755)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 143. 24 x 2.5-inch SAS/SATA + 4 x EDSFF E3.S with fPERC (HBA355i, H355, H755)

Order	From	To
1	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
2	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
3	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
4	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
5	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
6	SIG_PWR_0 (system board power connector)	Power connector on E3 rear module*
7	SL4_CPU1_PA2 (signal connector on system board)	Rear backplane signal connector on E3 rear module*

Table 143. 24 x 2.5-inch SAS/SATA + 4 x EDSFF E3.S with fPERC (HBA355i, H355, H755) (continued)

Order	From	To
8	SL11_CPU1_PB7 (signal connector on system board)	Rear backplane signal connector on E3 rear module*

NOTE: *Disconnect cables from the system board side since the cables in the rear E3 module are preassembled.

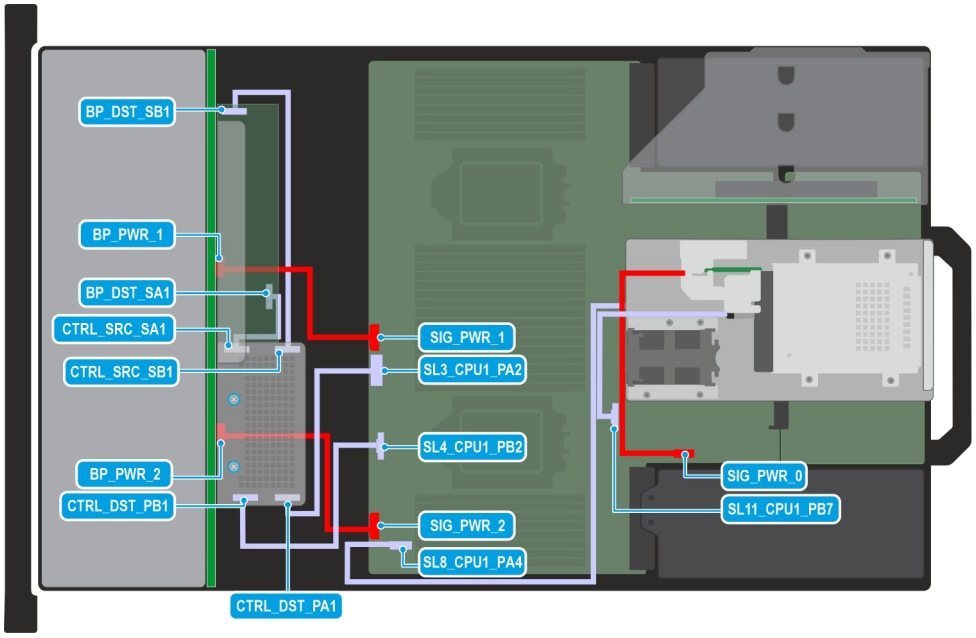


Figure 153. Configuration 52: 24 x 2.5-inch SAS/SATA + 4 x EDSFF E3.S with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 144. 24 x 2.5-inch SAS/SATA + 4 x EDSFF E3.S with fPERC (H965i)

Order	From	To
1	CTRL_SRC_SB1 (fPERC controller connector)	BP_DST_SB1 (backplane expander signal connector)
2	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
3	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
4	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
5	SIG_PWR_2 (system board power connector)	BP_PWR_2 (backplane power connector)
6	SL4_CPU1_PA2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
7	SIG_PWR_0 (system board power connector)	Power connector on E3 rear module*
8	SL8_CPU1_PA4 (signal connector on system board)	Rear backplane signal connector on E3 rear module*
9	SL11_CPU1_PB7 (signal connector on system board)	Rear backplane signal connector on E3 rear module*

NOTE: *Disconnect cables from the system board side since the cables in the rear E3 module are preassembled.

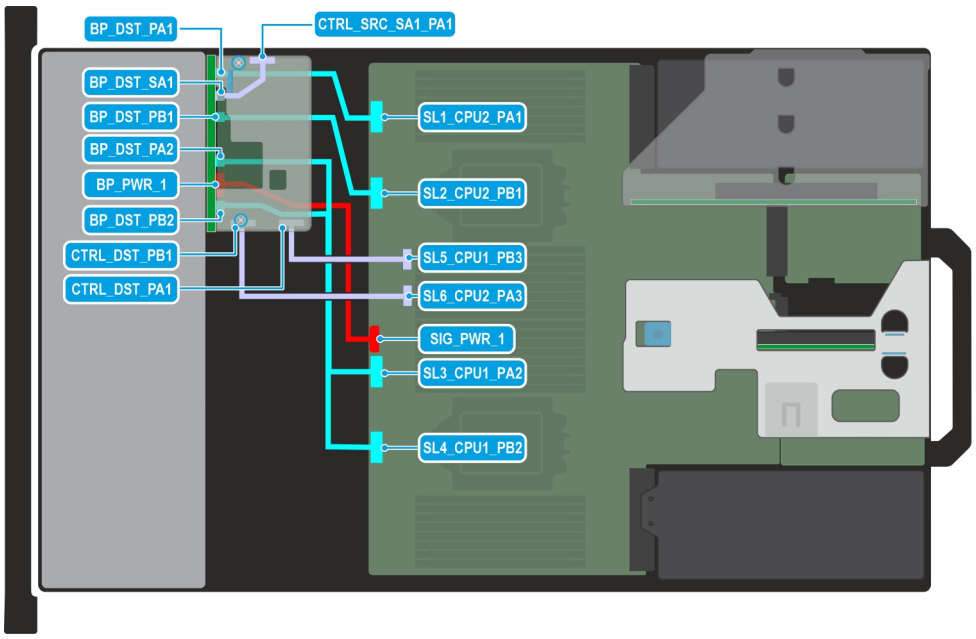


Figure 154. Configuration 53: 8 x 2.5-inch Universal (SAS/SATA/NVMe) with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 145. 8 x 2.5-inch Universal (SAS/SATA/NVMe) with fPERC (H965i)

Order	From	To
1	SL5_CPU2_PB3 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
2	SL6_CPU2_PA3 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
3	CTRL_SRC_SA1 (fPERC controller connector)	BP_DST_SA1 (backplane expander signal connector)
4	SL3_CPU1_PA2 (signal connector on system board) and SL4_CPU1_PB2 (signal connector on system board)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
5	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
6	SL2_CPU2_PB1 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
7	SL1_CPU2_PA1 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)

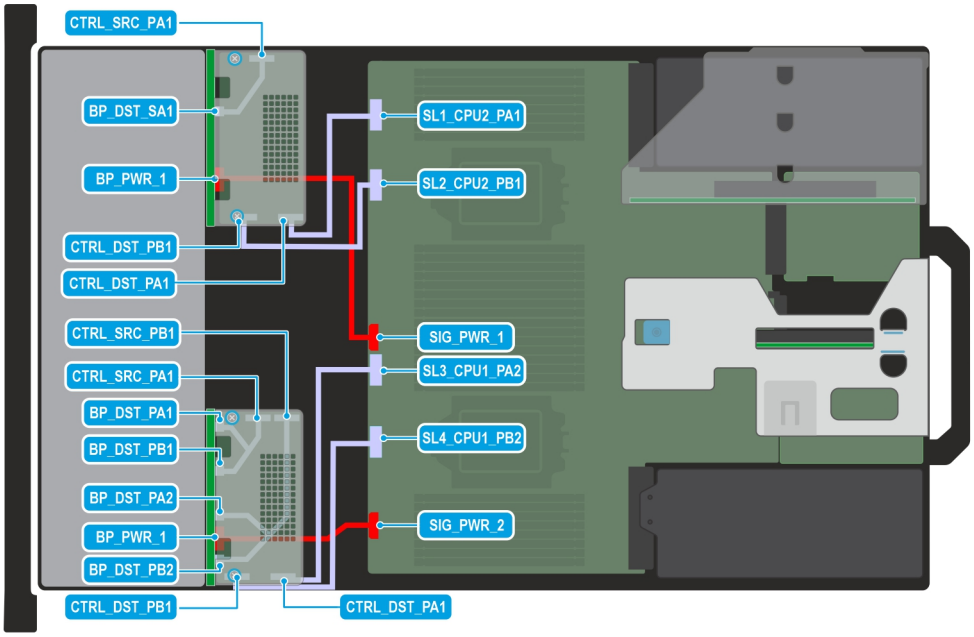


Figure 155. Configuration 54: 16 x 2.5-inch (8 x SAS/SATA + 8 x NVMe RAID) dual controller with fPERC (H965i)

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 146. 16 x 2.5-inch (8 x SAS/SATA + 8 x NVMe RAID) dual controller with fPERC (H965i)

Order	From	To
1	SIG_PWR_1 (system board power connector)	BP_PWR_1 (backplane power connector)
2	SL1_CPU2_PA1 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
3	SL2_CPU2_PB1 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
4	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_SA1 (backplane signal connector)
5	SL3_CPU1_PA2 (signal connector on system board)	CTRL_DST_PA1 (fPERC input connector)
6	SL4_CPU1_PB2 (signal connector on system board)	CTRL_DST_PB1 (fPERC input connector)
7	CTRL_SRC_PB1 (fPERC controller connector)	BP_DST_PA2 (backplane signal connector) and BP_DST_PB2 (backplane signal connector)
8	CTRL_SRC_PA1 (fPERC controller connector)	BP_DST_PA1 (backplane signal connector) and BP_DST_PB1 (backplane signal connector)
9	SIG_PWR_2 (system board power connector)	BP_PWR_1 (backplane power connector)

NOTE: An 8 x 2.5-inch NVMe backplane with fPERC H965i should be assembled outside and inserted into the system, along with all necessary cables.

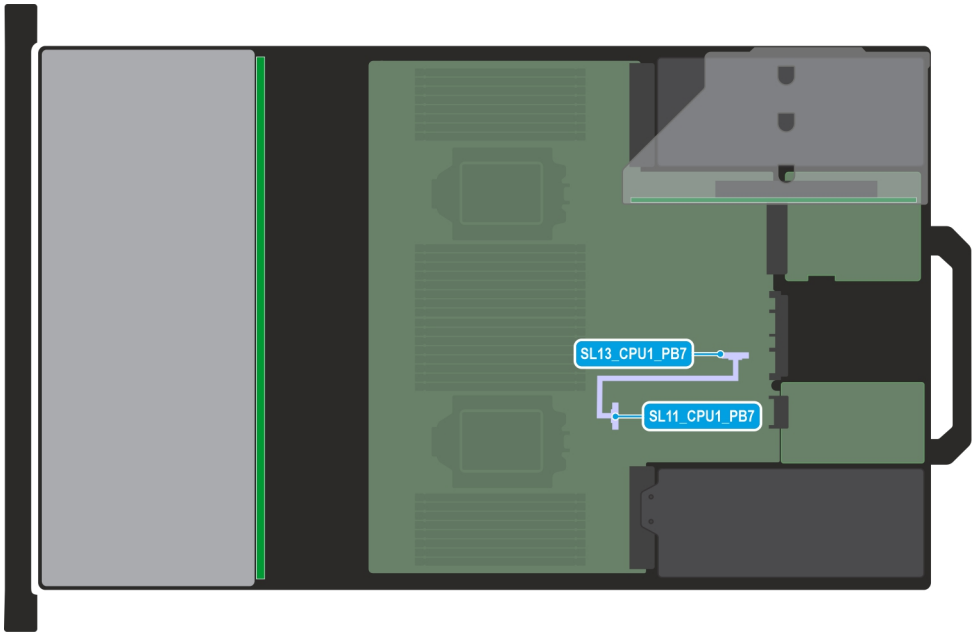


Figure 156. Configuration 55: OCP cable

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 147. OCP cable

Order	From	To
1	SL11_CPU1_PB7 (signal connector on system board)	SL13_CPU1_PB7 (signal connector on system board)

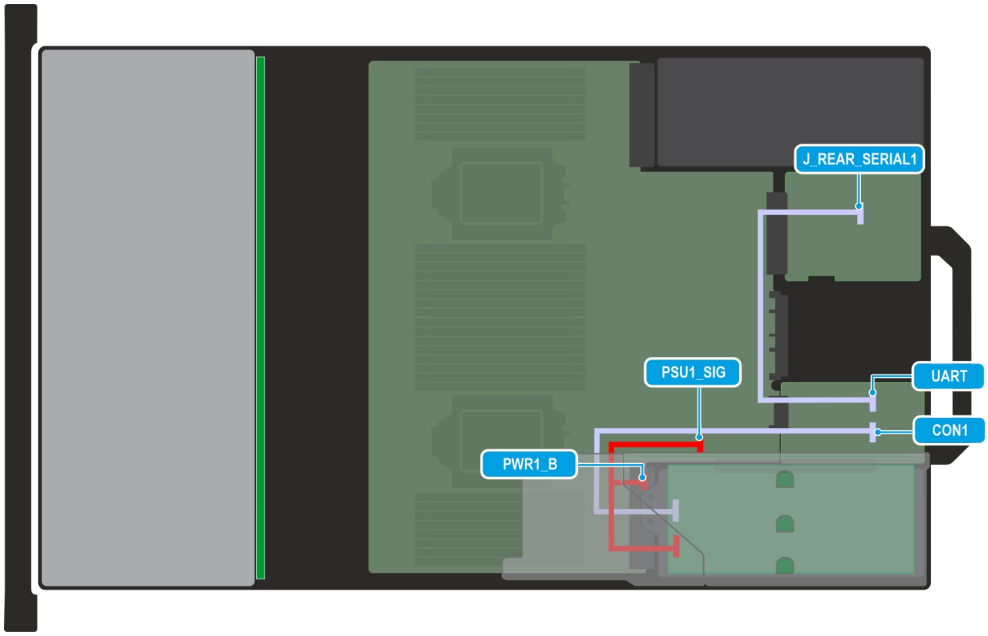


Figure 157. Configuration 56: Dell Data Processing Unit (DPU) (Intel: 200 Gb) with power cable

NOTE: Follow the sequential order as shown in the table to remove the cables, to install the cables follow the reverse sequential order.

Table 148. Dell DPU (Intel: 200 Gb) with power cable

Order	From	To
1	J_REAR_SERIAL1 (UART connector on rear I/O card)	UART (UART connector on MIC card)
2	CON1 (Connector 1 on MIC card)	Connector on DPU card in riser 1
3	PWR1_B (system board power connector) and PSU1_SIG (power signal connector)	Aux power connector on DPU card in riser 1

NOTE: Dell DPUs only support vSphere 8.0+ and Partner or Channel DPU only supports Linux-based OS.

PERC module

This is a service technician replaceable part only.

Removing the rear mounting front PERC module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the cooling fan cage assembly.
4. Remove the drive backplane cover.
5. If required, remove the air shroud or remove the GPU air shroud..
6. Disconnect all the cables, observe the cable routing.

NOTE: See cable routing section for more information.

Steps

1. Using a Phillips #2 screwdriver, loosen the captive screws on the rear mounting front PERC module.
2. Slide the rear mounting front PERC module to disengage from the connector on the drive backplane.

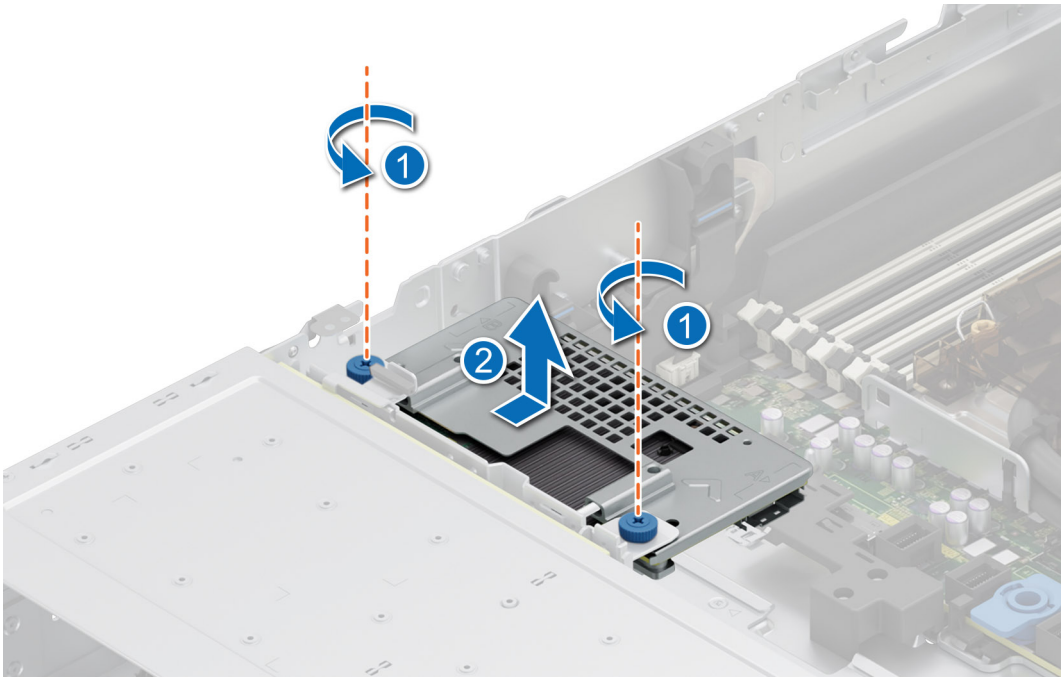


Figure 158. Removing the rear mounting front PERC module

3. Disconnect the battery power cable from the front PERC card.
4. Tilt and lift the battery holder assembly from the front PERC shroud.

NOTE: Remove the battery cable from the front PERC shroud cable holder.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

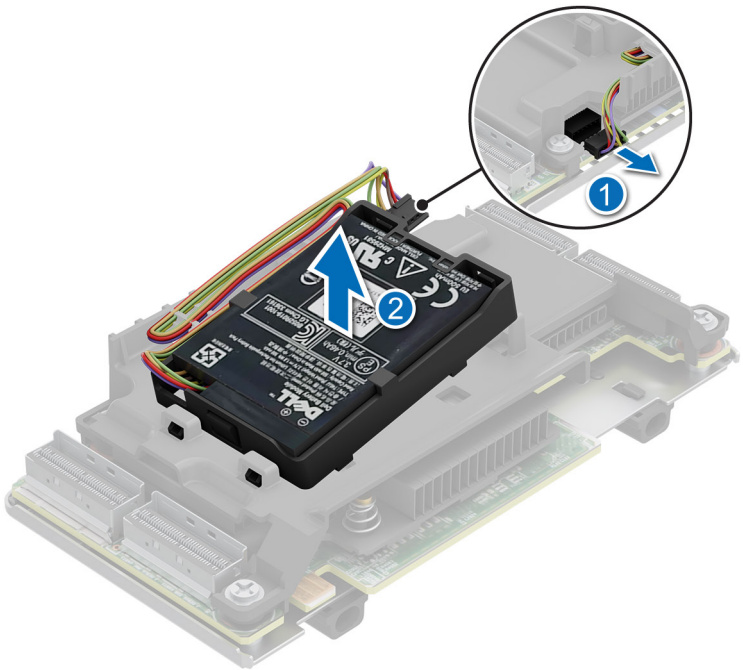


Figure 159. Removing the battery holder assembly from the PERC shroud

5. Press and remove the battery from the battery holder.

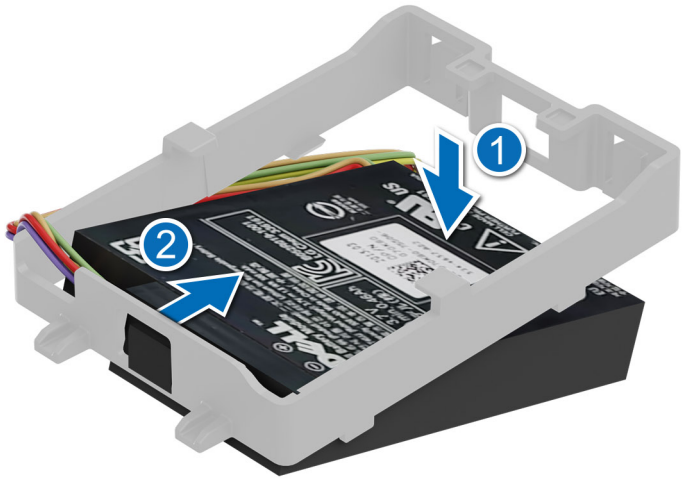


Figure 160. Removing the battery from the battery holder

6. Using a Phillips #2 screwdriver, remove the four screws on the front PERC shroud.
7. Remove the front PERC shroud from the PERC.card.
8. Remove the front PERC card from the PERC tray.

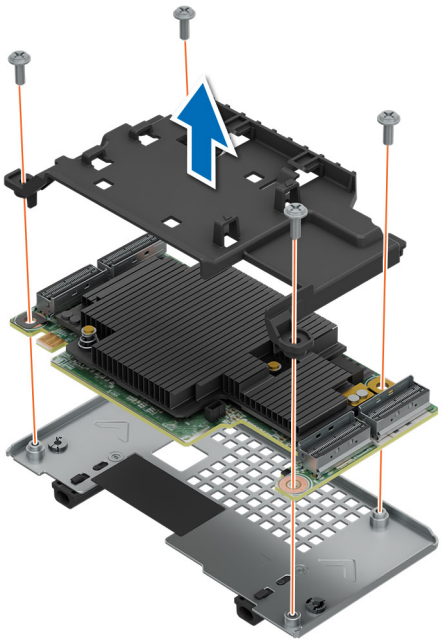


Figure 161. Removing the front PERC card

Next steps

1. Replace the rear mounting front PERC module.

Installing the rear mounting front PERC module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the cooling fan cage assembly.
4. Remove the drive backplane cover.
5. If required, remove the air shroud or remove the GPU air shroud.
6. Route the cable properly to prevent the cable from being pinched or crimped.

NOTE: See cable routing section for more information.

Steps

1. Align and install front PERC card to the guides on the front PERC tray.
2. Align and Install the front PERC shroud on the front PERC card.
3. Using a Phillips #2 screwdriver, tighten the four screws to secure the front PERC shroud to the front PERC card.

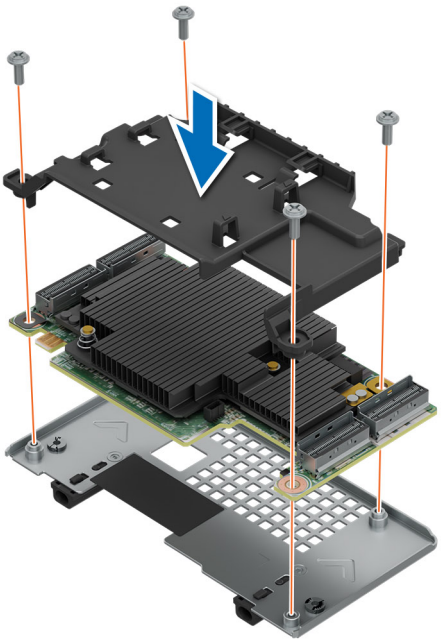


Figure 162. Installing the front PERC card

4. Insert the battery tab into the battery holder and ensure the battery that it is firmly seated.

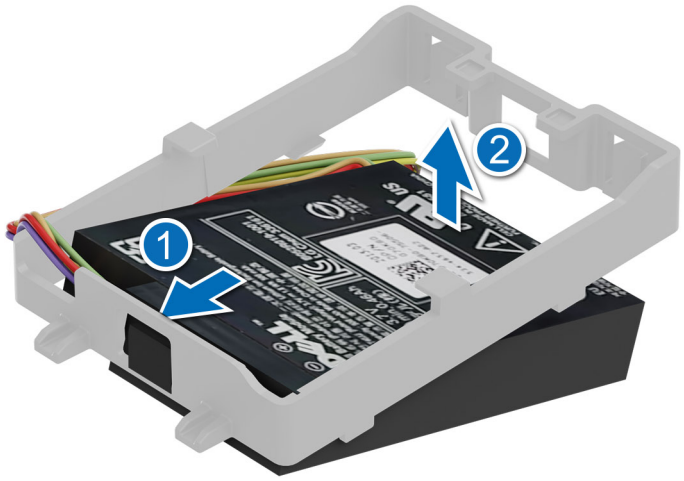


Figure 163. Installing the battery into the battery holder

5. Tilt the battery holder assembly to align the tabs with the front PERC shroud.
6. Press the battery holder assembly on to the front PERC shroud.
7. Connect the battery power cable to the front PERC card.

NOTE: Route the battery cable into the front PERC shroud cable holder.

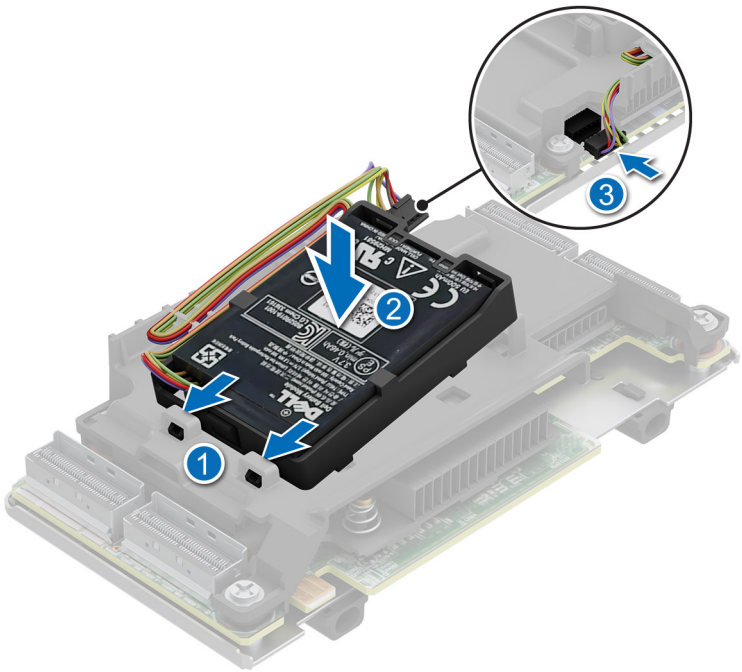


Figure 164. Installing the battery holder assembly into the PERC shroud

8. Align the connectors and guide slots on the rear mounting front PERC module with the connectors and guide pins on the drive backplane.
9. Slide the rear mounting front PERC module until the module is connected to the drive backplane.
10. Using a Phillips #2 screwdriver, tighten the captive screws on the rear mounting front PERC module.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

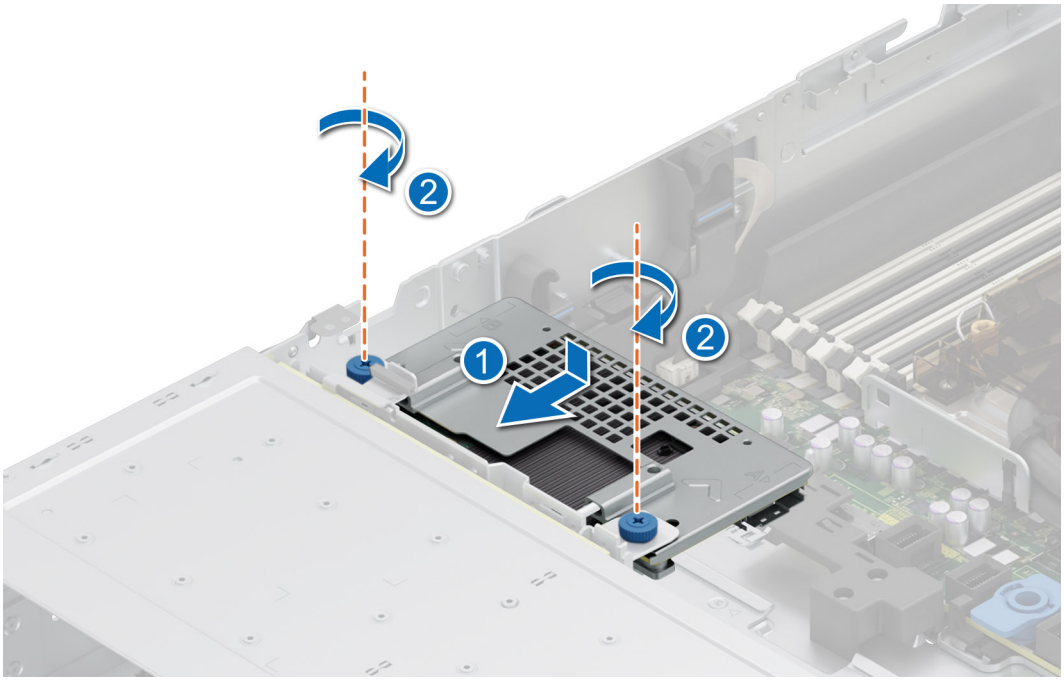


Figure 165. Installing the rear mounting front PERC module

Next steps

1. Connect all the cables, observe the cable routing.
2. Install the cooling fan cage assembly.
3. If removed, install the air shroud or install the GPU air shroud.
4. Install the drive backplane cover.
5. Follow the procedure listed in After working inside your system.

Removing the adapter PERC module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. If required, remove the air shroud or remove the GPU air shroud.
4. If required, remove the drive backplane cover.
5. Remove the cooling fan cage assembly.
6. Remove the expansion card riser.
7. Disconnect all the cables from the adapter PERC (APERC) card, observe the cable routing.

NOTE: Refer to cable routing section for more information.

NOTE: APERC module must be installed only in expansion card riser 1 or riser 2.

Steps

1. Tilt the expansion card retention latch lock to open.
2. Pull the card holder before removing the card from the riser.
3. Hold the APERC module by the edges. and pull the module from the expansion card connector on the riser.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

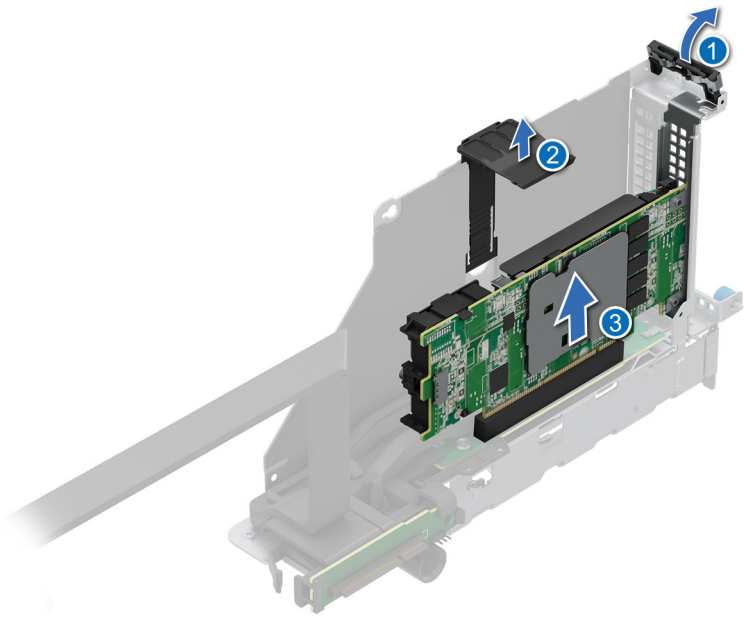


Figure 166. Removing the APERC module

4. If the APERC module is not going to be replaced, install a filler bracket and close the card retention latch.

NOTE: You must install a filler bracket over an empty expansion card slot to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

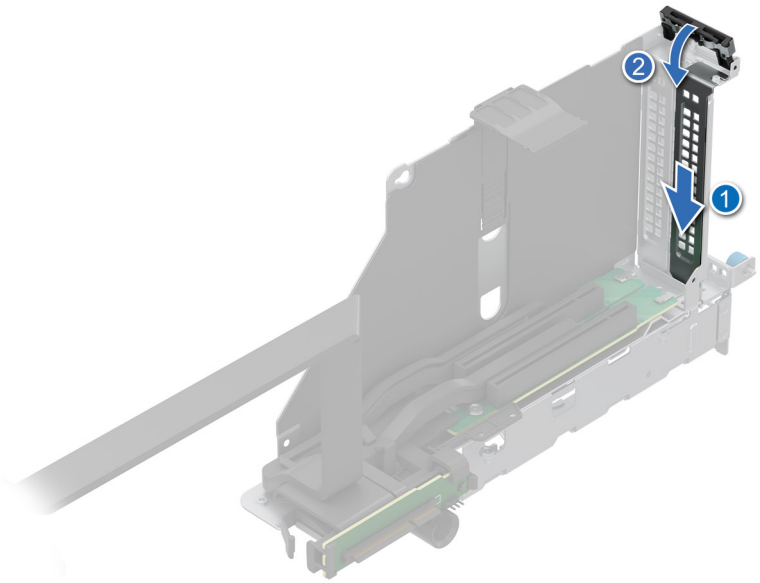


Figure 167. Installing the filler bracket

Next steps

1. Replace the APERC module.

Installing the adapter PERC module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. If required, remove the air shroud or remove the GPU air shroud.
4. If required, remove the drive backplane cover.
5. Remove the cooling fan cage assembly.
6. Remove the expansion card riser.
7. Disconnect all the cables from the adapter PERC (APERC) card, observe the cable routing.

   NOTE: Refer to cable routing section for more information.

8. If installing a new APERC module, unpack it and prepare the module for installation.

   NOTE: For instructions, see the documentation accompanying the card.

   NOTE: APERC module must be installed only in expansion card riser 1 or riser 2.

Steps

1. Pull and lift up the expansion card retention latch lock to open.
2. If installed, remove the filler bracket.

   NOTE: Store the filler bracket for future use. Filler brackets must be installed in empty expansion card slots to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

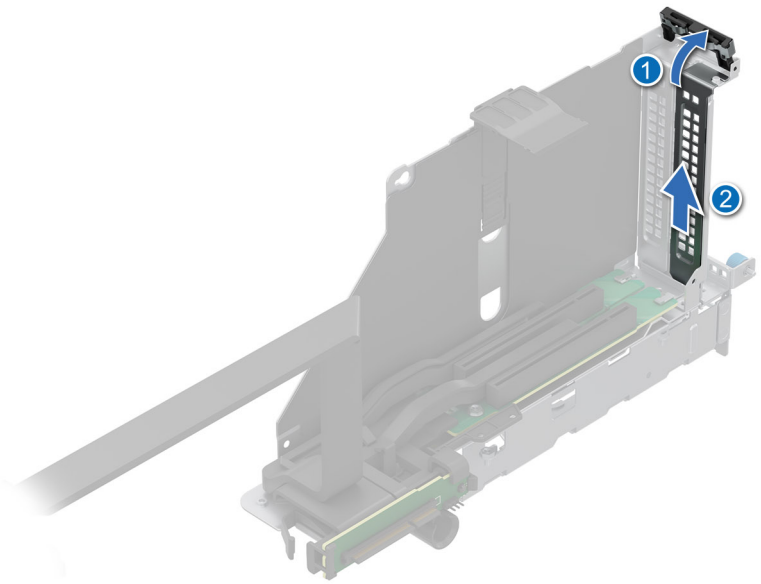


Figure 168. Removing the filler bracket

3. Hold the adapter PERC (APERC) module by the edges, and align the module edge connector with the expansion card connector on the riser.
4. Insert the module into the expansion card connector until firmly seated.
5. Close the expansion card retention latch.
6. Push the card holder to hold the module in the riser.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

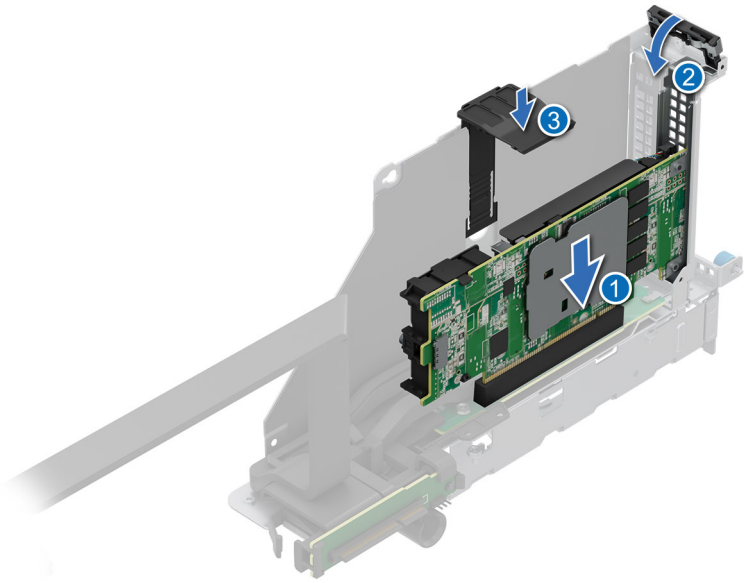


Figure 169. Installing the APERC module

Next steps

1. Connect the cables to the APERC module and route the cables properly.

NOTE: Refer to cable routing section for more information.

2. Install the cooling fan cage assembly.
3. If removed, install the air shroud or install the GPU air shroud.
4. Install the drive backplane cover.
5. Install the expansion card riser.
6. Follow the procedure listed in After working inside your system.

Removing the EDSFF E3.S PERC module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the cooling fan cage assembly.
4. Remove the drive backplane cover.
5. If required, remove the air shroud or remove the GPU air shroud..
6. Disconnect all the cables from the PERC, observe the cable routing.

NOTE: See cable routing section; configuration 46 for more information.

Steps

1. Press the release tabs on both the sides of the PERC tray, and lift the PERC tray out of the system.
2. Disconnect the PERC power cable from the EDSFF E3.S backplane module.

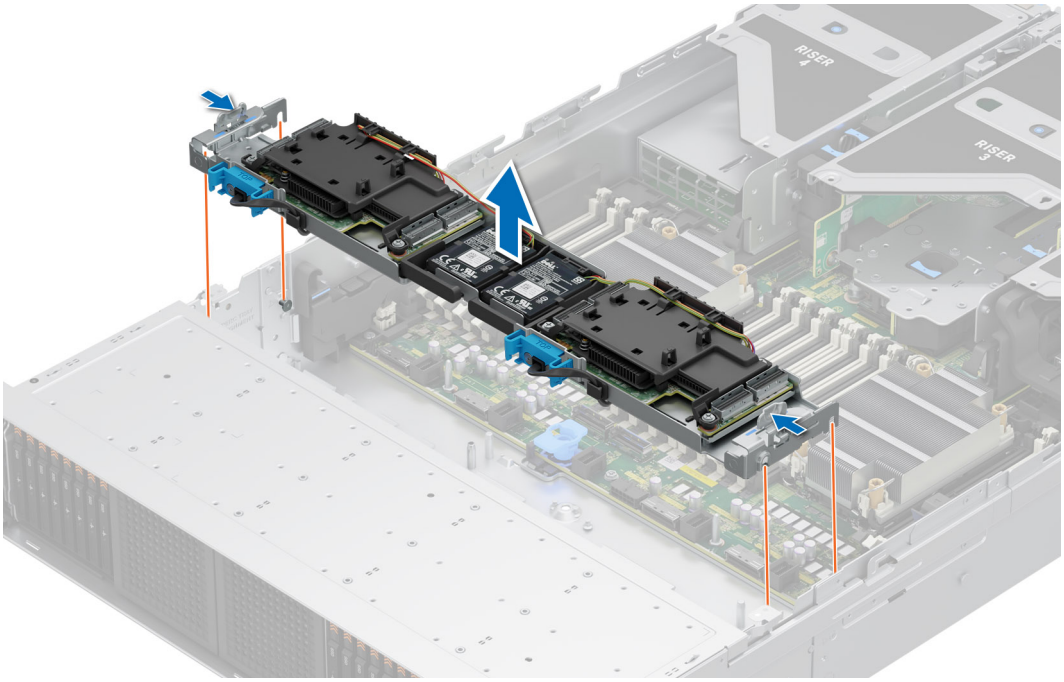


Figure 170. Removing the PERC tray

3. Press the blue tabs and remove the PERC power cable from the PERC card.
4. Disconnect the battery power cable from the PERC card.
5. Tilt and lift the battery holder assembly from the front PERC tray.

NOTE: Remove the battery cable from the front PERC shroud cable holder.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

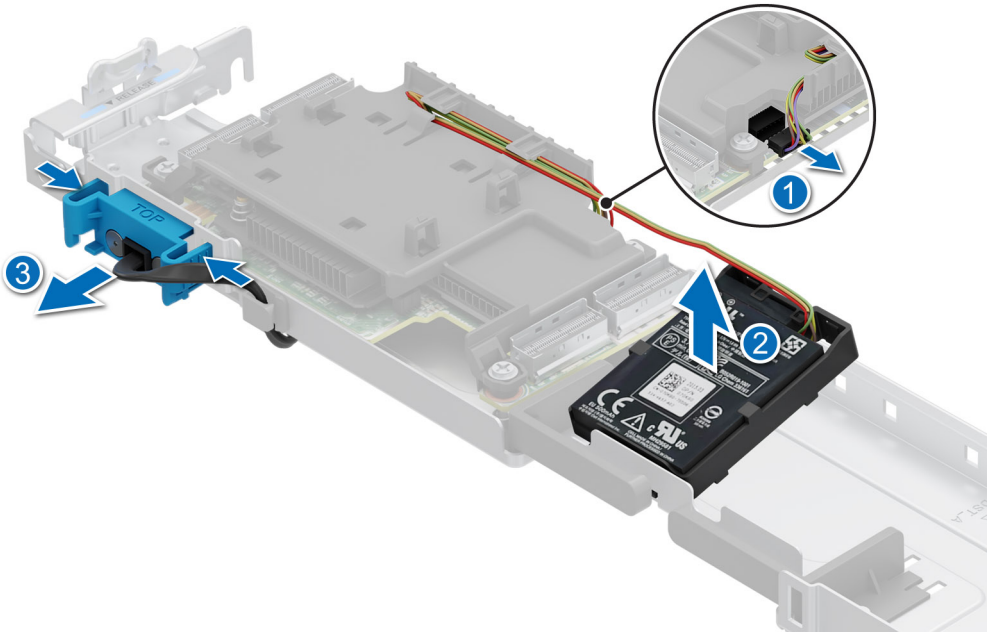


Figure 171. Removing the battery holder assembly from the PERC shroud

6. Press and remove the battery from the battery holder.

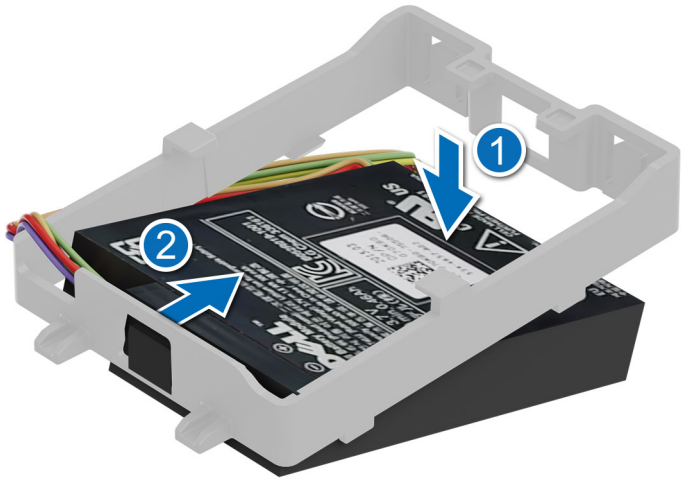


Figure 172. Removing the battery from the battery holder

7. Using a Phillips #2 screwdriver, remove the four screws on the front PERC shroud.
8. Remove the PERC shroud from the PERC.card.
9. Remove the PERC card from the PERC tray.

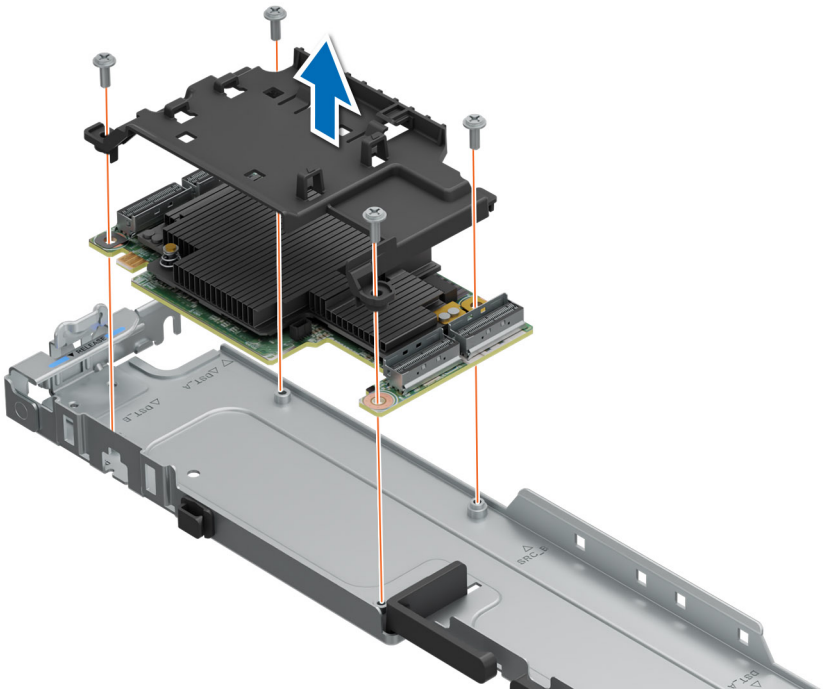


Figure 173. Removing the PERC card from PERC tray

NOTE: The procedure to remove the other PERC card is similar.

Next steps

1. Replace the EDSFF E3.S PERC module.

Installing the EDSFF E3.S PERC module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the cooling fan cage assembly.
4. Remove the drive backplane cover.
5. If required, remove the air shroud or remove the GPU air shroud.
6. Route the cable properly to prevent the cable from being pinched or crimped.

NOTE: See cable routing section; configuration 46 for more information.

Steps

1. Align and install PERC card to the guides on the front PERC tray.
2. Align and Install the PERC shroud on the PERC card.
3. Using a Phillips #2 screwdriver, tighten the four screws to secure the PERC shroud to the PERC tray.

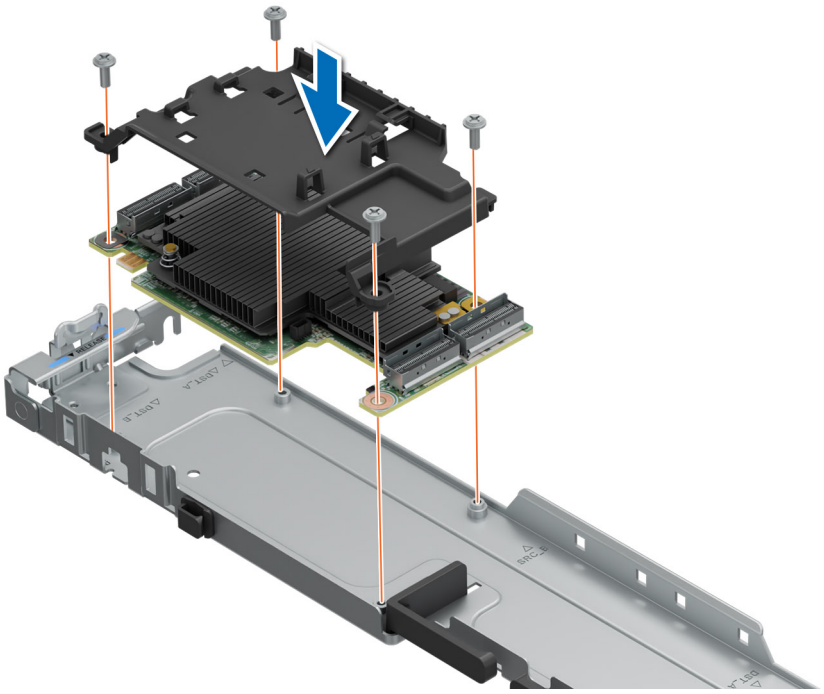


Figure 174. Installing the PERC card into PERC tray

4. Insert the battery tab into the battery holder and ensure the battery that it is firmly seated.

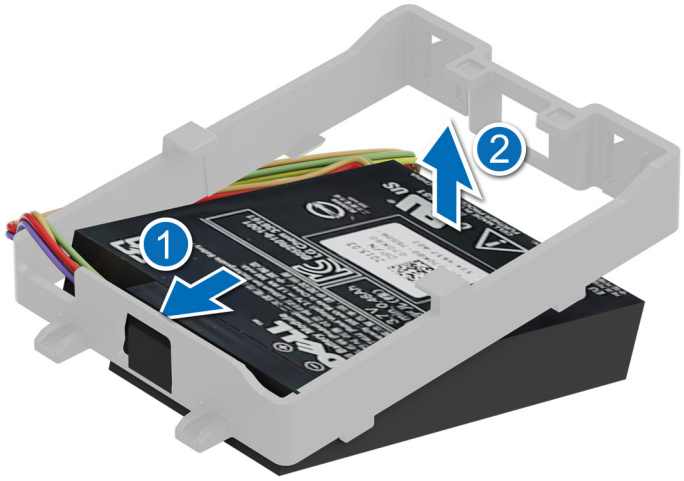


Figure 175. Installing the battery into the battery holder

5. Align and connect the PERC power cable to the PERC card.
6. **NOTE:** Route the PERC cable into the PERC tray cable holder.

   Tilt the battery holder assembly to align the tabs with the PERC tray.
7. Press the battery holder assembly on to the PERC tray.
8. Connect the battery power cable to the front PERC card.

   NOTE: Route the battery cable into the front PERC shroud cable holder.

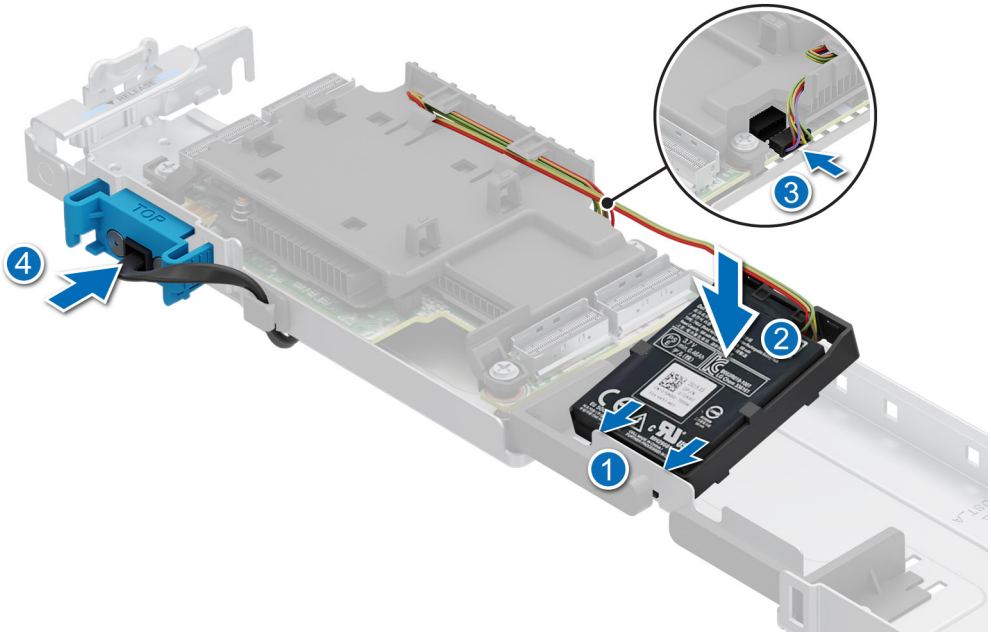


Figure 176. Installing the battery holder assembly into the PERC shroud

NOTE: Procedure to install the other PERC card is similar.

9. Align the guide slots on the PERC tray with the guide pins on the system.

   NOTE: Connect all the cables to the PERC card before lowering the tray. See cable routing section for more information.

10. Lower the PERC tray, until it is firmly seated and secured.

    NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

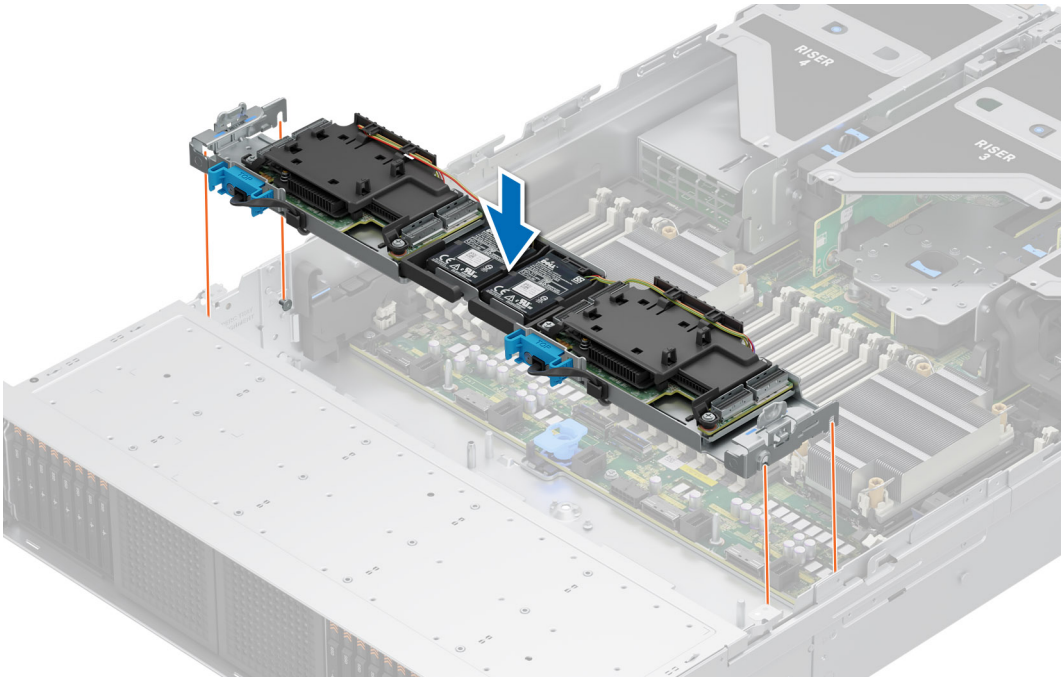


Figure 177. Installing the PERC tray

Next steps

1. Connect all the cables, observe the cable routing.

   NOTE: See cable routing section; configuration 46 for more information.

2. Install the cooling fan cage assembly.
3. If removed, install the air shroud or install the GPU air shroud.
4. Install the drive backplane cover.
5. Follow the procedure listed in After working inside your system.

EDSFF E3.S backplane module

This is a service technician replaceable part only.

Removing the EDSFF E3.S backplane module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the front bezel.
4. Remove the cooling fan cage assembly.
5. Remove the drive backplane cover.
6. If required, remove the air shroud or remove the GPU air shroud.
7. Remove the EDSFF E3.S PERC module.
8. Remove the EDSFF E3.S drives.
9. Disconnect the cables, observe the cable routing.

   NOTE: See cable routing section; configuration 45 or 46 for more information.

Steps

1. Using a Phillips #2 screwdriver, loosen the captive screws on the EDSFF E3.S backplane module.
2. Slide and remove the EDSFF E3.S backplane module from the system.

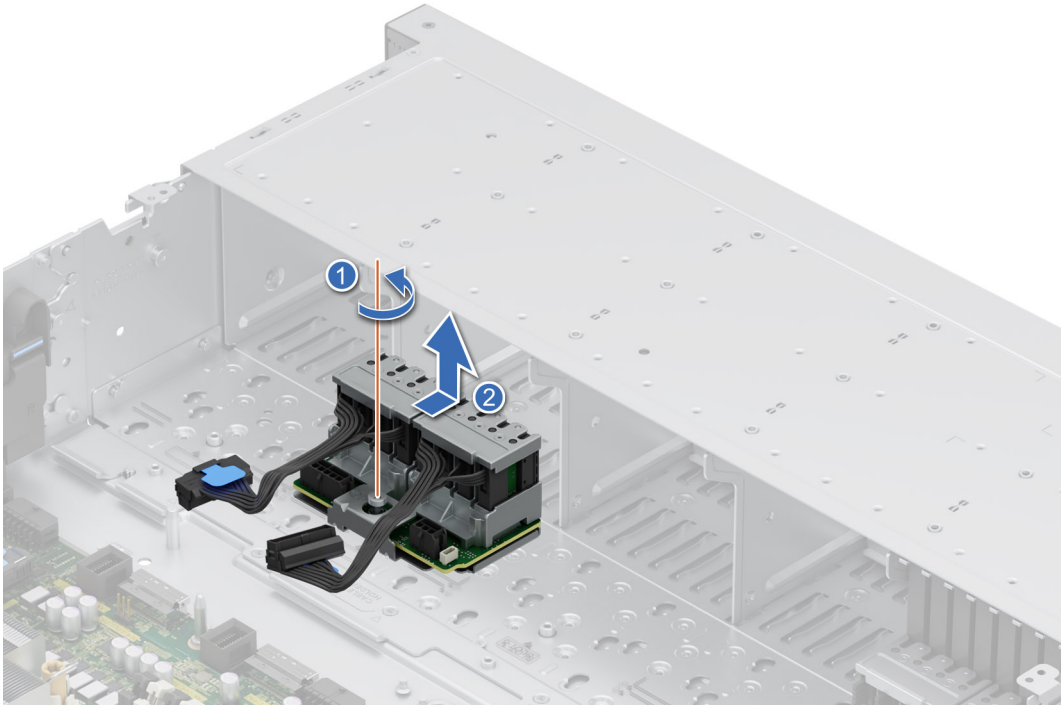


Figure 178. Removing the EDSFF E3.S backplane module

Next steps

1. Replace the EDSFF E3.S backplane module.

Installing the EDSFF E3.S backplane module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the front bezel.
4. Remove the cooling fan cage assembly.
5. Remove the drive backplane cover.
6. If required, remove the air shroud or remove the GPU air shroud.
7. Remove the EDSFF E3.S PERC module.
8. Remove the EDSFF E3.S drives.
9. Disconnect the cables, observe the cable routing.

NOTE: See cable routing section; configuration 45 or 46 for more information.

Steps

1. Align the guides on the EDSFF E3.S backplane module with the slots on the system.
2. Slide the EDSFF E3.S backplane module towards the rear of the system, until it is firmly secured.
3. Using a Phillips #2 screwdriver, tighten the captive screw on the EDSFF E3.S backplane module.

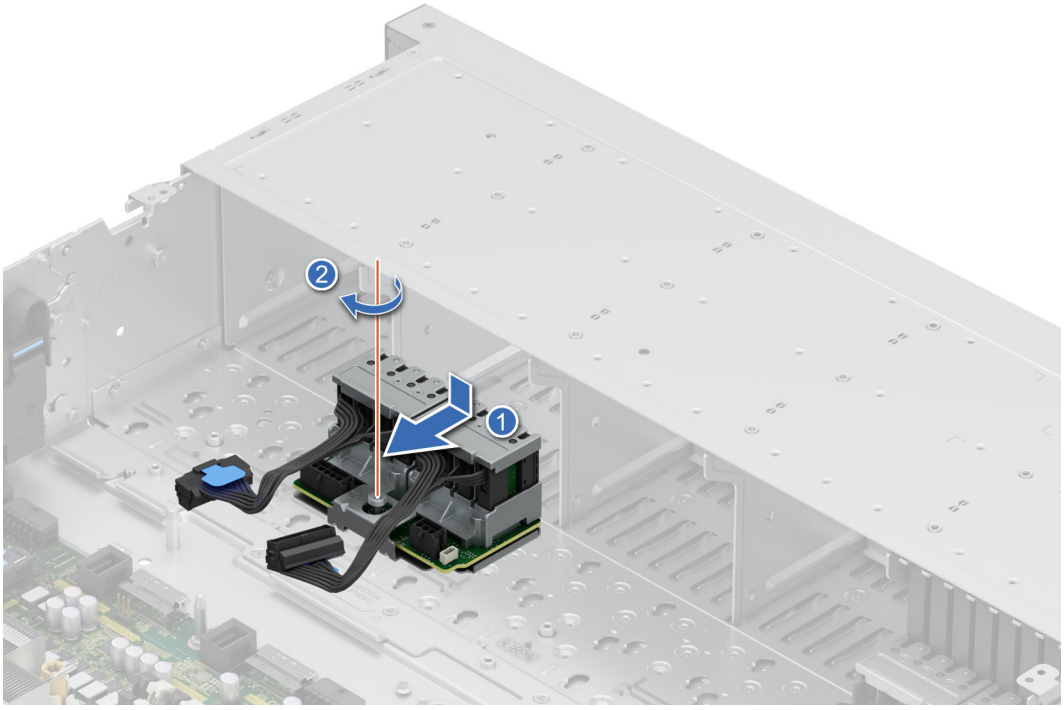


Figure 179. Installing the EDSFF E3.S backplane module

Next steps

1. Connect all the cables, observe the cable routing.

   NOTE: See cable routing section; configuration 45 or 46 for more information.

2. Install the EDSFF E3.S PERC module.
3. Install the cooling fan cage assembly.
4. If removed, install the air shroud or install the GPU air shroud.
5. Install the drive backplane cover.
6. Install the EDSFF E3.S drives .
7. Install the front bezel.
8. Follow the procedure listed in After working inside your system.

System memory

System memory guidelines

The PowerEdge R760 system supports DDR5 registered DIMMs (RDIMMs).

Your system memory is organized into eight channels per processor (two memory sockets per channel), 16 memory sockets per processor and 32 memory sockets per system.

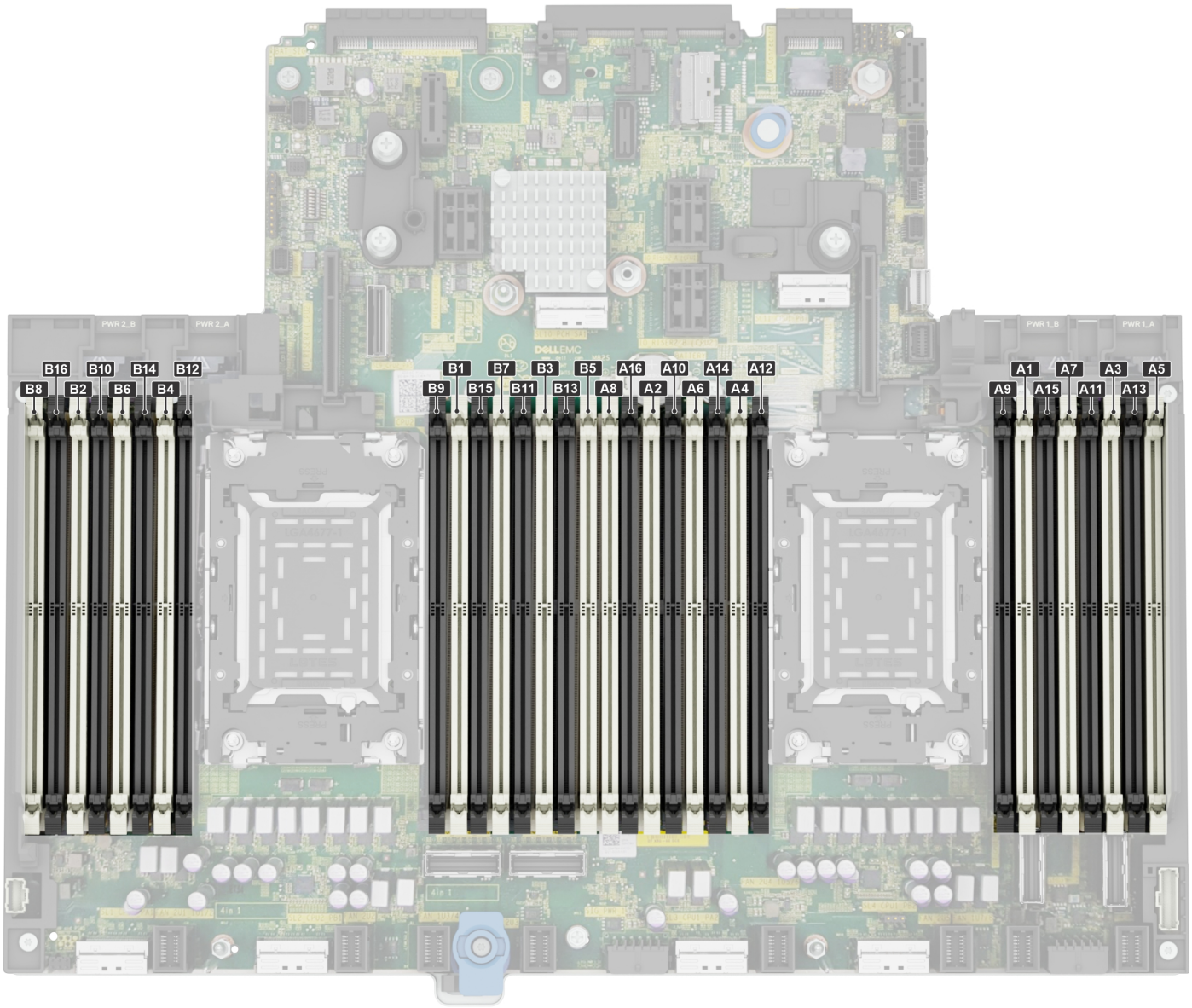


Figure 180. Memory channels

Memory channels are organized as follows:

Table 149. Memory channels

Processor	Channel A	Channel B	Channel C	Channel D	Channel E	Channel F	Channel G	Channel H
Processor 1	Slots A1 and A9	Slots A7 and A15	Slots A3 and A11	Slots A5 and A13	Slots A4 and A12	Slots A6 and A14	Slots A2 and A10	Slots A8 and A16
Processor 2	Slots B1 and B9	Slots B7 and B15	Slots B3 and B11	Slots B5 and B13	Slots B4 and B12	Slots B6 and B14	Slots B2 and B10	Slots B8 and B16

Table 150. Supported memory matrix

DIMM type	Rank	Capacity	DIMM rated voltage and speed	Operating Speed	
				1 DIMM per channel (DPC)	2 DIMMs per channel (DPC)
RDIMM	1 R	16 GB	DDR5 (1.1 V), 4800 MT/s	4800 MT/s	4400 MT/s

Table 150. Supported memory matrix (continued)

DIMM type	Rank	Capacity	DIMM rated voltage and speed	Operating Speed	
				1 DIMM per channel (DPC)	2 DIMMs per channel (DPC)
	2 R	32 GB, 64 GB	DDR5 (1.1 V), 4800 MT/s	4800 MT/s	4400 MT/s
	4 R	128 GB	DDR5 (1.1 V), 4800 MT/s	4800 MT/s	4400 MT/s
	8 R	256 GB	DDR5 (1.1 V), 4800 MT/s	4800 MT/s	4400 MT/s
	1 R	16 GB	DDR5 (1.1 V), 5600 MT/s	5600 MT/s	4400 MT/s
	2 R	32 GB, 64 GB, 96 GB	DDR5 (1.1 V), 5600 MT/s	5600 MT/s	4400 MT/s
	4 R	128 GB	DDR5 (1.1 V), 5600 MT/s	5600 MT/s	4400 MT/s
	8 R	256 GB	DDR5 (1.1 V), 5600 MT/s	5600 MT/s	4400 MT/s

NOTE: 5600 MT/s RDIMMs are applicable for 5th Gen Intel® Xeon® Scalable Processors.

NOTE: The processor may reduce the performance of the rated DIMM speed.

NOTE: No support for 96 GB memory when configured with either 2 DIMMs per CPU RDIMM or 4 DIMMs per CPU RDIMM.

General memory module installation guidelines

To ensure optimal performance of your system, observe the following general guidelines when configuring your system memory. If your system's memory configuration fails to observe these guidelines, your system might not boot, stop responding during memory configuration, or operate with reduced memory.

The memory bus may operate at speeds of 5600 MT/s, 4800 MT/s, 4400 MT/s, or 4000 MT/s depending on the following factors:

- System profile selected (for example, Performance, Performance Per Watt Optimized (OS), or Custom [can be run at high speed or lower])
- Maximum supported DIMM speed of the processors
- Maximum supported speed of the DIMMs

NOTE: MT/s indicates DIMM speed in MegaTransfers per second.

NOTE: Fault Resilient Memory supports only eight and sixteen DIMMs per processor.

- All DIMMs must be DDR5.
- Memory mixing is not supported for:
  - Different DIMM capacities
  - X4 and X8 DRAM memory modules
  - 3DS and non-3DS RDIMMs

    NOTE: 3DS is a DRAM technology that is used to manufacture the highest capacity DIMMs. See your DIMM documentation for additional details.

- Modes supported in Xeon Max processor:
  - Xeon Max only without DIMMs
  - Cache with DIMMs
  - Flat with DIMMs

- Supported RDIMM configurations per Xeon Max processor:
  - 0 DIMM (Xeon Max only mode)
  - 1 DIMM (Flat mode)
  - 2 DIMM (Flat mode)
  - 4 DIMMs (Cache or Flat mode)
  - 8 DIMMs (Cache or Flat mode)
  - 16 DIMMs (Cache or Flat mode)
- DDR5/Xeon Max memory ratio must be in the range of 2:1 ~ 64:1 for cache mode.

  NOTE: Each Xeon Max processor has 64 GB integrated memory.

- The combination of Flat and Cache modes is not supported.
- **NOTE:** Fault Resilient Memory is only available in Flat mode, with eight or sixteen DIMMs per processor.
- If memory modules with different speeds are installed, they operate at the speed of the slowest installed memory module(s).
- Populate memory module sockets only if a processor is installed.
  - For single-processor systems, sockets A1 to A16 are available.
  - For dual-processor systems, sockets A1 to A16 and sockets B1 to B16 are available.
  - A minimum of one DIMM must be populated for each installed processor.
- In **Optimizer Mode**, the DRAM controllers operate independently in the 64-bit mode and provide optimized memory performance.

Table 151. Memory population rules

Processor	Memory population	Memory population information
Single processor	A{1}, A{2}, A{3}, A{4}, A{5}, A{6}, A{7}, A{8}, A{9}, A{10}, A{11}, A{12}, A{13}, A{14}, A{15}, A{16}	1, 2, 4, 6, 8, 12 or 16 DIMMs are allowed.
Dual processor (Start with processor1. Processor 1 and processor 2 population should match)	A{1}, B{1}, A{2}, B{2}, A{3}, B{3}, A{4}, B{4}, A{5}, B{5}, A{6}, B{6}, A{7}, B{7} A{8}, B{8}, A{9}, B{9}, A{10}, B{10}, A{11}, B{11}, A{12}, B{12}, A{13}, B{13}, A{14}, B{14}, A{15}, B{15}, A{16}, B{16}	2, 4, 8, 12, 16, 24 or 32 DIMMs are supported per system.

Table 152. Memory population rules for Xeon Max processor

Processor	Memory population	Memory population information
Single processor	A{1}, A{2}, A{3}, A{4}, A{5}, A{6}, A{7}, A{8}, A{9}, A{10}, A{11}, A{12}, A{13}, A{14}, A{15}, A{16}	0, 1, 2, 4, 8, or 16 DIMMs are allowed.
Dual processor (Start with processor1. Processor 1 and processor 2 population should match)	A{1}, B{1}, A{2}, B{2}, A{3}, B{3}, A{4}, B{4}, A{5}, B{5}, A{6}, B{6}, A{7}, B{7} A{8}, B{8}, A{9}, B{9}, A{10}, B{10}, A{11}, B{11}, A{12}, B{12}, A{13}, B{13}, A{14}, B{14}, A{15}, B{15}, A{16}, B{16}	0, 2, 4, 8, 16, or 32 DIMMs are supported per system.

- Populate all the sockets with white release tabs first, followed by the sockets with black release tabs.
- Unbalanced or odd memory configurations result in a performance loss, and the system may not identify the memory modules being installed. Always populate memory channels identically with equal DIMMs for the best performance.
- Supported RDIMM configurations are 1, 2, 4, 6, 8, 12, or 16 DIMMs per processor.

Removing a memory module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

3. Remove the air shroud or remove the GPU air shroud.

WARNING: The memory modules are hot to touch for some time after the system has been powered off. Allow the memory modules to cool before handling them.

NOTE: To ensure proper system cooling, memory module blanks must be installed in any memory socket that is not populated. The memory module blanks compatible with the R760 are DDR5 gray color blanks. Remove the memory module blanks only if you intend to install memory module in these sockets.

Steps

1. Locate the appropriate memory module socket.
2. To release the memory module from the socket, simultaneously press the ejectors on both ends of the memory module socket to fully open.

   CAUTION: Handle each memory module only by the card edges, ensuring not to touch the middle of the memory module or metallic contacts.

3. Lift the memory module away from the system.

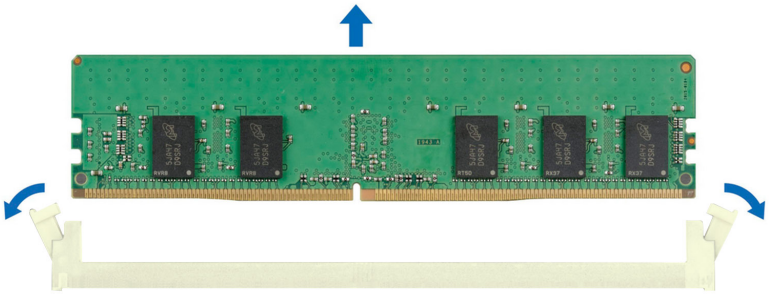


Figure 181. Removing a memory module

Next steps

Replace the memory module.

Installing a memory module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.

Steps

1. Locate the appropriate memory module socket.

   CAUTION: Handle each memory module only by the card edges, ensuring not to touch the middle of the memory module or metallic contacts.

   NOTE: Ensure that the socket ejector latches are fully open before installing the memory module.

2. Align the edge connector of the memory module with the alignment key of the memory module socket, and insert the memory module in the socket.

   CAUTION: To prevent damage to the memory module or the memory module socket during installation, do not bend or flex the memory module. Insert both ends of the memory module simultaneously.

   NOTE: The memory module socket has an alignment key that enables you to install the memory module in the socket in only one orientation.

   CAUTION: Do not apply pressure at the center of the memory module; apply pressure at both ends of the memory module evenly.

3. Press the memory module with your thumbs until the ejectors firmly click into place. When the memory module is properly seated in the socket, the memory module socket levers align with the levers on the other sockets that have memory modules that are installed.

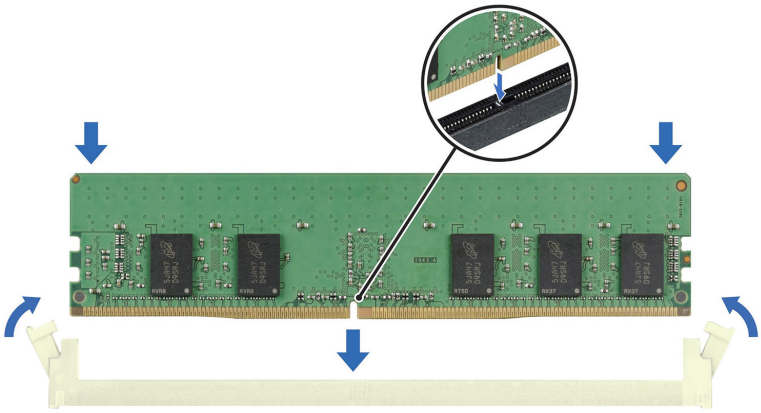


Figure 182. Installing a memory module

Next steps

1. Install the air shroud or install the GPU air shroud.
2. Follow the procedure listed in After working inside your system.
3. To verify that the memory module has been installed properly, press **F2** during reboot and click **System Setup Main Menu > System BIOS > Memory Settings**. In the **Memory Settings** screen, the **System Memory Size** must reflect the updated capacity of the installed memory.
4. If the **System Memory Size** is incorrect, one or more of the memory modules may not be installed properly. Shut down the system and ensure that the memory modules are firmly seated in the correct sockets.
5. Run the system memory test in system diagnostics.

Processor and heat sink module

This is a service technician replaceable part only.

Removing the processor and heat sink module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.

NOTE: The heat sink and processor are hot to touch for some time after the system has been powered off. Allow the heat sink and processor to cool down before handling them.

Steps

1. Ensure all four anti-tilt wires are in the locked position (outward position), and then using a Torx T30 screwdriver, loosen the captive nuts on the processor heat sink module (PHM) in the order that is mentioned below:
   a. Loosen the first nut three turns.
   b. Loosen the nut diagonally opposite to the nut you loosened first.
   c. Repeat the procedure for the remaining two nuts.
   d. Return to the first nut and loosen it completely.

   NOTE: Ensure that the anti-tilt wires on the PHM are in locked position when loosening the captive nuts.

2. Set all the anti-tilt wires to unlocked position (inward position).

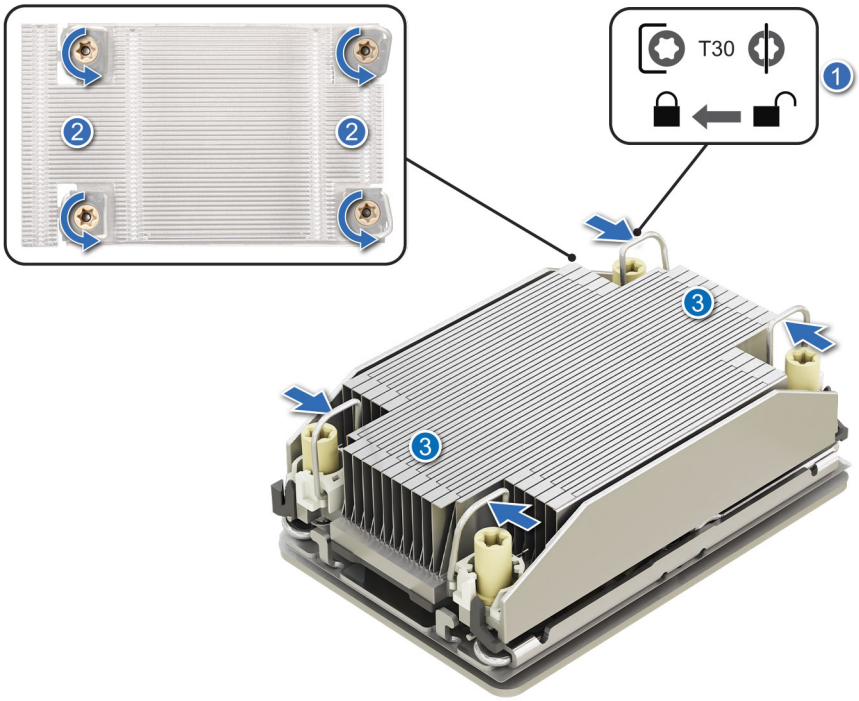


Figure 183. Removing the processor heat sink module

3. Lift the PHM from the system and set the PHM aside with the processor side facing up.

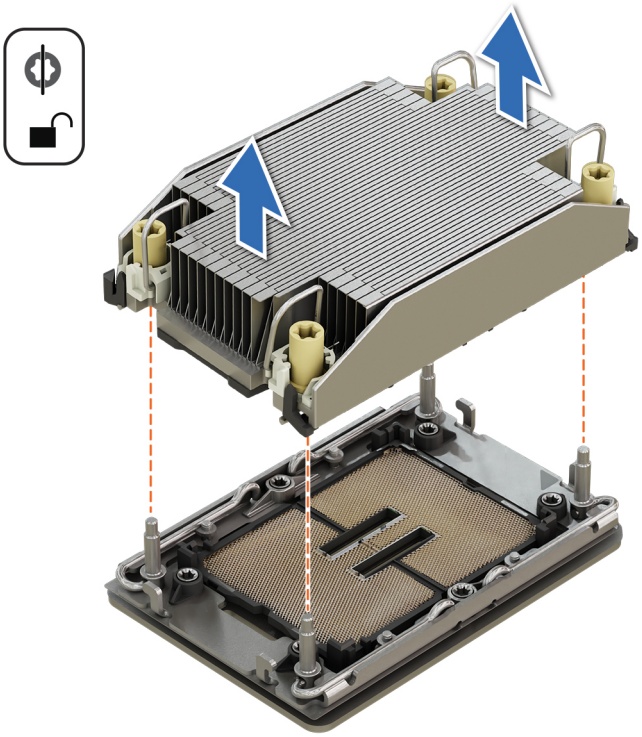


Figure 184. Removing a heat sink

Next steps

If you are removing a faulty heat sink, replace the heat sink, if not, remove the processor.

Removing the processor

Prerequisites

WARNING: Remove the processor from processor and heat sink module (PHM) only if you are replacing the processor or heat sink.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. Remove the processor heat sink module.

CAUTION: You may find the CMOS battery loss or CMOS checksum error that is displayed during the first instance of powering on the system after the processor or system board replacement which is expected. To fix this, simply go to setup option to configure the system settings.

Steps

1. Place the heat sink with the processor side facing up.
2. Using your thumb, lift the thermal interface material (TIM) break lever to release the processor from the TIM and retaining clip.

   NOTE: For Xeon Max processor, turn the side lever (up to 60 degrees) with the flat blade screwdriver to release the Xeon Max processor from the TIM and retaining clip.

3. Holding the processor by the edges, lift the processor away from the retaining clip.

   NOTE: Ensure to hold the retaining clip to the heat sink as you lift the TIM break lever.

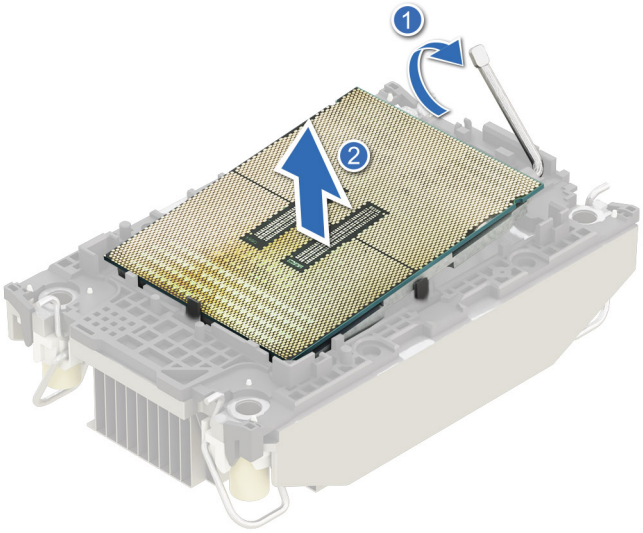


Figure 185. Removing the processor

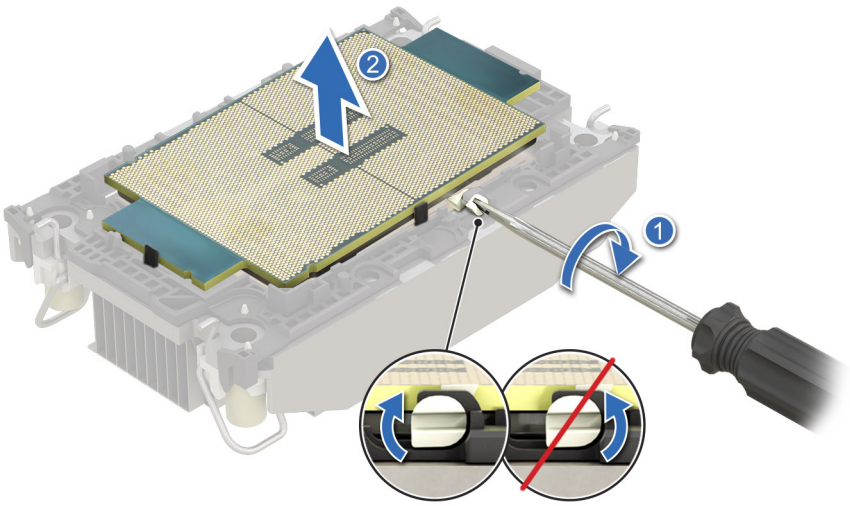


Figure 186. Removing the Xeon Max processor

NOTE: Ensure to return the TIM break lever or side lever on the retaining clip back to original position.

4. Using your thumb and index finger, first hold the retaining clip release tab at the pin 1 connector, pull out the tip of the retaining clip release tab, and then lift the retaining clip partially from the heat sink.
5. Repeat the procedure at the remaining three corners of the retaining clip.
6. After all the corners are released from the heat sink, lift the retaining clip from the pin 1 corner of the heat sink.

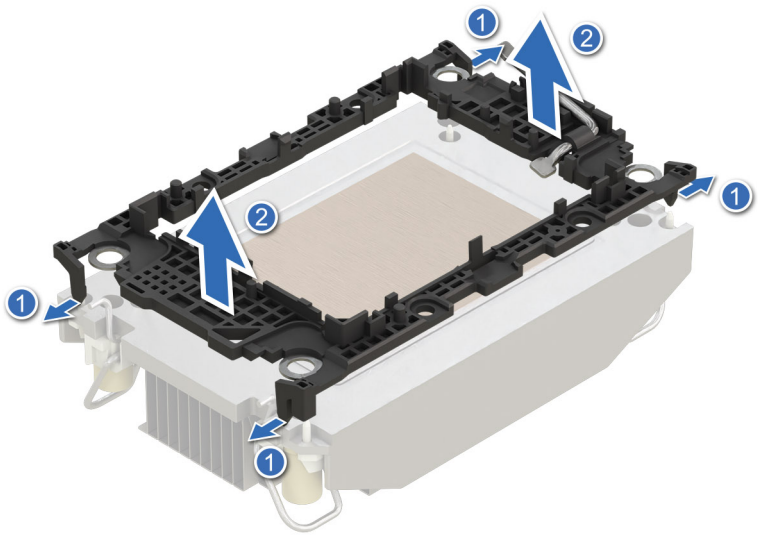


Figure 187. Removing the retaining clip

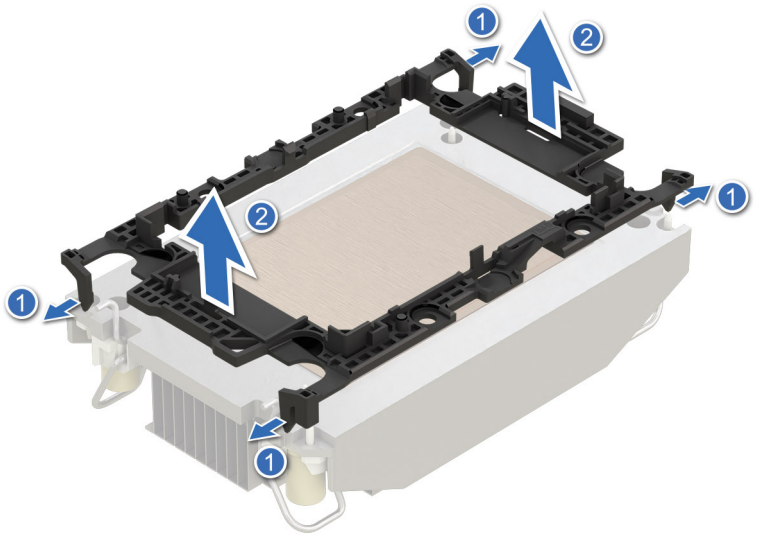


Figure 188. Removing the Xeon Max retaining clip

Next steps

Replace the processor.

Installing the processor

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. Remove the processor heat sink module.

Steps

1. Place the processor in the processor tray.

   NOTE: Ensure the pin 1 indicator on the processor tray is aligned with the pin 1 indicator on the processor.

2. Place the retaining clip on top of the processor in the processor tray aligning pin 1 indicator on the processor.

   NOTE: Ensure the pin 1 indicator on the retaining clip is aligned with the pin 1 indicator on the processor before placing the retaining clip on the processor.

   NOTE: Before you install the heat sink, ensure to place the processor and retaining clip in the tray.

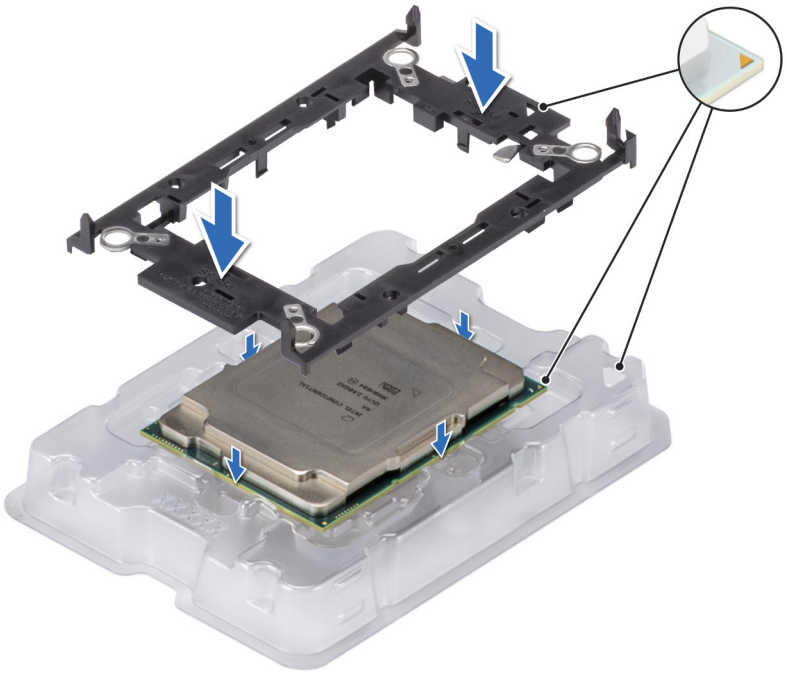


Figure 189. Installing the retaining clip

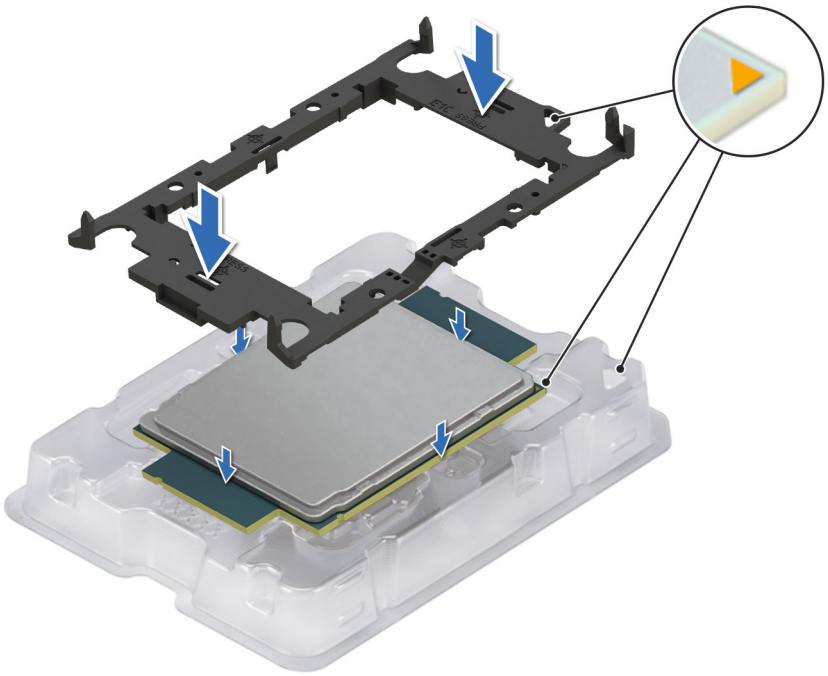


Figure 190. Installing the Xeon Max retaining clip

3. Align the processor with retaining clip, by using your fingers press the retaining clip on all the four sides until it clicks into place.

   NOTE: Ensure that the processor is securely latched to the retaining clip.

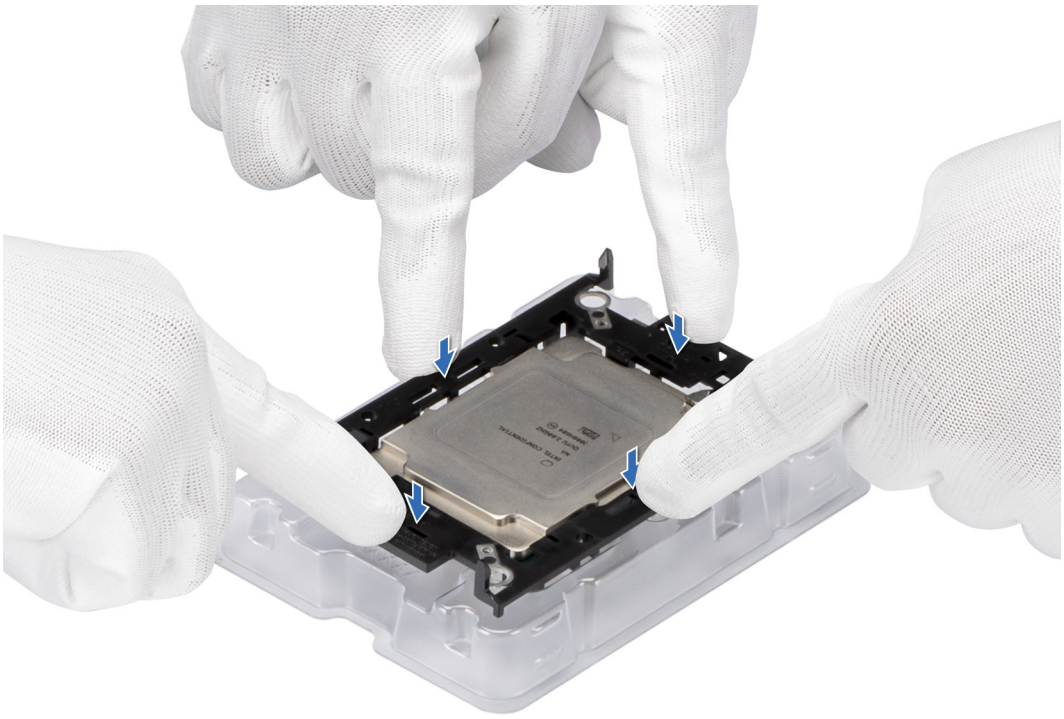


Figure 191. Press the retaining clip on the four sides

4. If you are using an existing heat sink, remove the thermal grease from the heat sink by using a clean lint-free cloth.
5. Apply the thermal grease in a thin spiral design on the bottom of the heat sink.

   CAUTION: Applying too much thermal grease can result in excess grease coming in contact with and contaminating the processor socket.

NOTE: The thermal grease syringe is intended for single use only. Dispose the syringe after you use it.

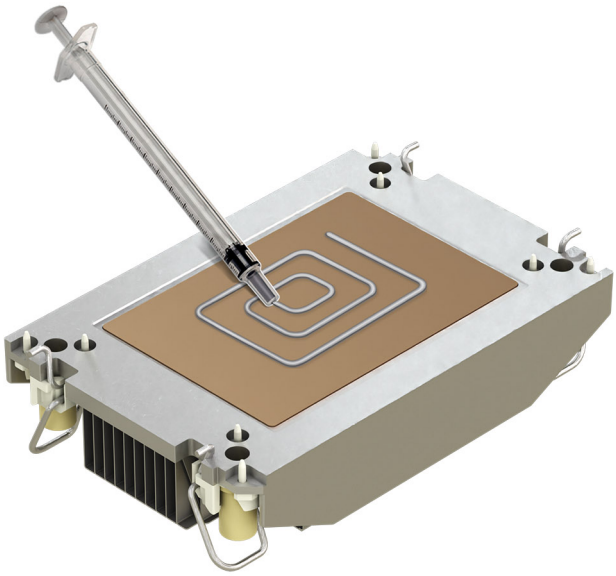


Figure 192. Applying thermal grease

6. For new heat sink, pull and remove the plastic cover from the base of heat sink.

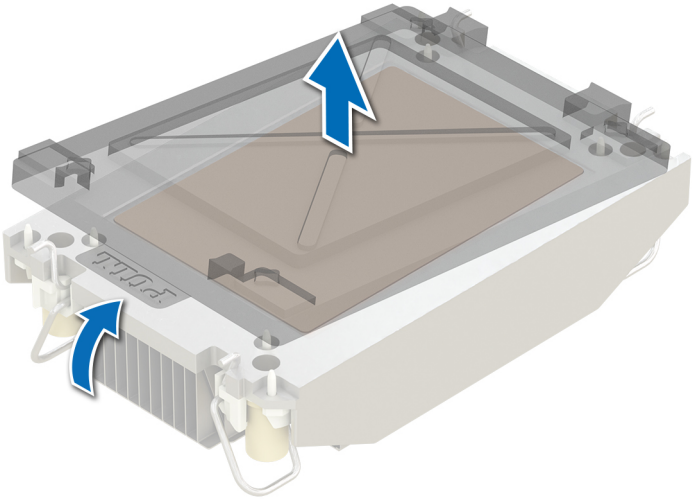


Figure 193. Removing the cover

7. Place the heat sink on the processor and press the base of the heat sink until the retaining clip locks onto the heat sink at all the four corners.

CAUTION: To avoid damaging the fins on the heat sink, do not press down on the heat sink fins.

NOTE:

- Ensure latching features on retaining clip, and heat sink are aligned during assembly.
- Ensure that the pin 1 indicator on the heat sink is aligned with the pin 1 indicator on the retaining clip before placing the heat sink onto the retaining clip.

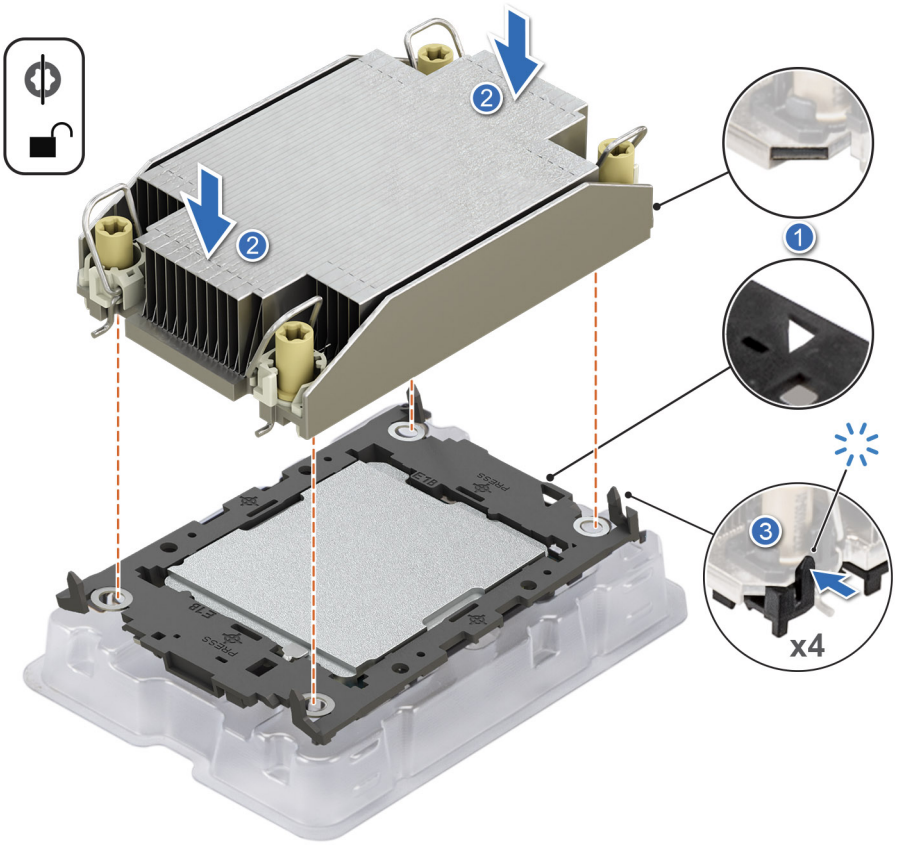


Figure 194. Installing the heat sink onto the processor

Next steps

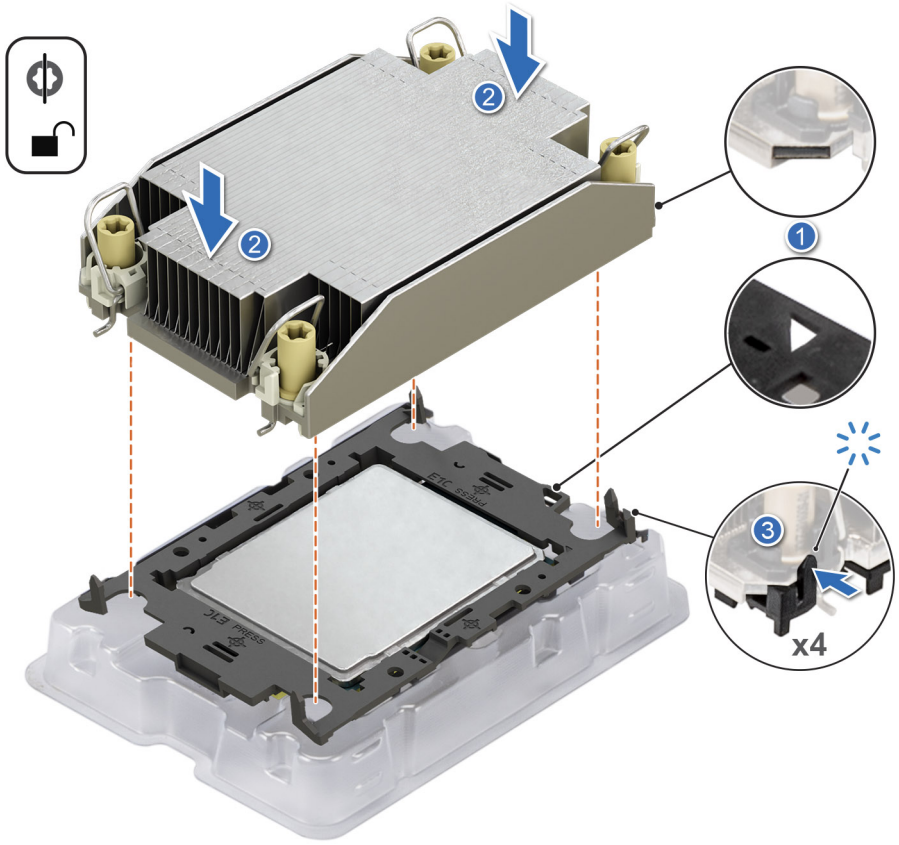


Figure 195. Installing the heat sink onto the Xeon Max processor

1. Install the processor heat sink module.
2. Install the air shroud or install the GPU air shroud.
3. Follow the procedure listed in After working inside your system.

Installing the processor and heat sink module

Prerequisites

Never remove the heat sink from a processor unless you intend to replace the processor or heat sink. The heat sink is necessary to maintain proper thermal conditions.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. If installed, remove the processor dust cover.

Steps

1. Set the anti-tilt wires to the unlocked position on the heat sink (inward position).
2. Align the pin 1 indicator of the heat sink to the system board, and then place the processor heat sink module (PHM) on the processor socket.

CAUTION: To avoid damaging the fins on the heat sink, do not press down on the heat sink fins.

NOTE: Ensure that the PHM is held parallel to the system board to prevent damaging the components.

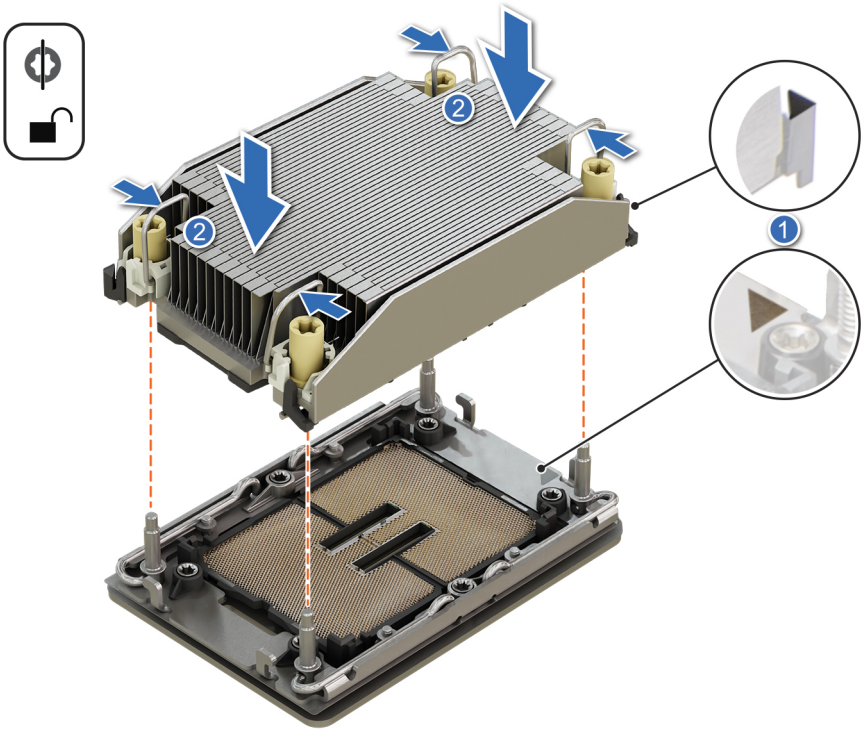


Figure 196. Installing the processor heat sink

3. Set the anti-tilt wires to the locked position (outward position), and then using the Torx T30 screwdriver, tighten the captive nuts (8 in-lbf) on the heat sink in the order below:
   a. In a random order, tighten the first nut three turns.
   b. Tighten the nut diagonally opposite to the nut that you tighten first.
   c. Repeat the procedure for the remaining two nuts.
   d. Return to the first nut to tighten it completely.
   e. Check all the nuts to ensure they are firmly secured.

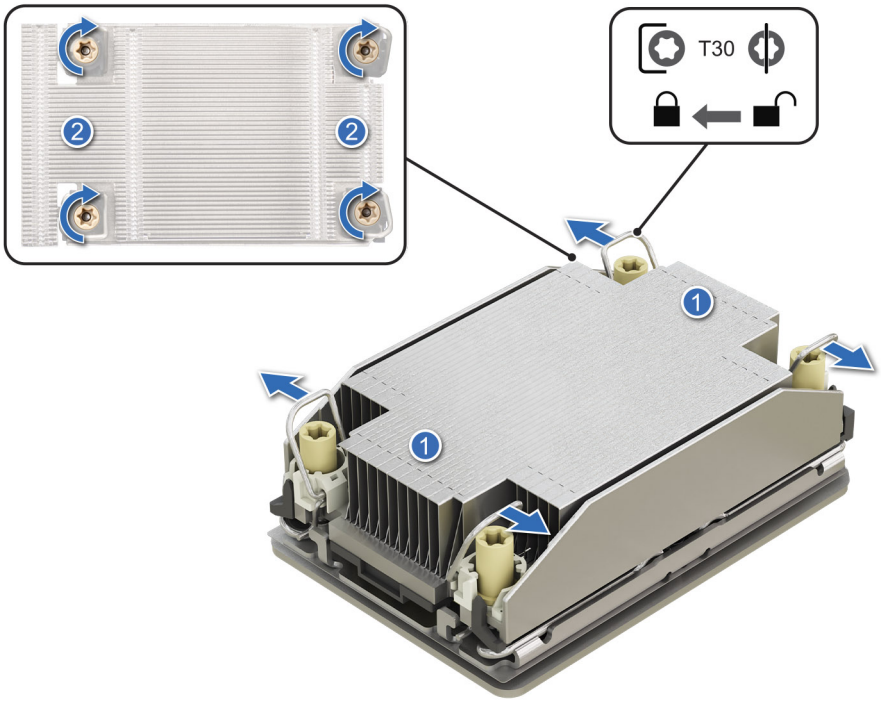


Figure 197. Set the anti-tilt wires to the locked position and tightening the nuts

Next steps

1. Install the air shroud or install the GPU air shroud.
2. Follow the procedure listed in the After working inside your system.

Removing the Direct Liquid Cooling module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. Remove the expansion card riser.

WARNING: The Direct liquid cooling (DLC) module and processor are too hot to touch for some time after the system has been powered off. Allow the liquid cooling module and processor to cool down before handling them.

NOTE: Rear I/O (RIO) board is different for the system with DLC module.

Steps

1. Using a Phillips #2 screw driver, loosen the captive screw on the DLC ring holder.
2. Tilt the DLC ring holder to loosen the DLC tubes.
3. Disconnect the DLC leak detection cable from the LC RIO board.
4. Remove the DLC tubes from the clip and LC RIO board.
5. Slightly lift the DLC tubes surrounding the DIMM slots.
6. Ensure all four anti-tilt wires are in the locked position (outward position), and then using a Torx T30 screwdriver, loosen the captive nuts on the DLC module in the order that is mentioned below:
   a. Loosen the first nut three turns.
   b. Loosen the nut diagonally opposite to the nut you loosened first.
   c. Repeat the procedure for the remaining two nuts.
   d. Return to the first nut and loosen it completely.

NOTE: Ensure that the anti-tilt wires on the DLC module are in locked position when loosening the captive nuts.

7. Set the anti-tilt wires on the DLC module to the unlock position and lift the DLC module from the system.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

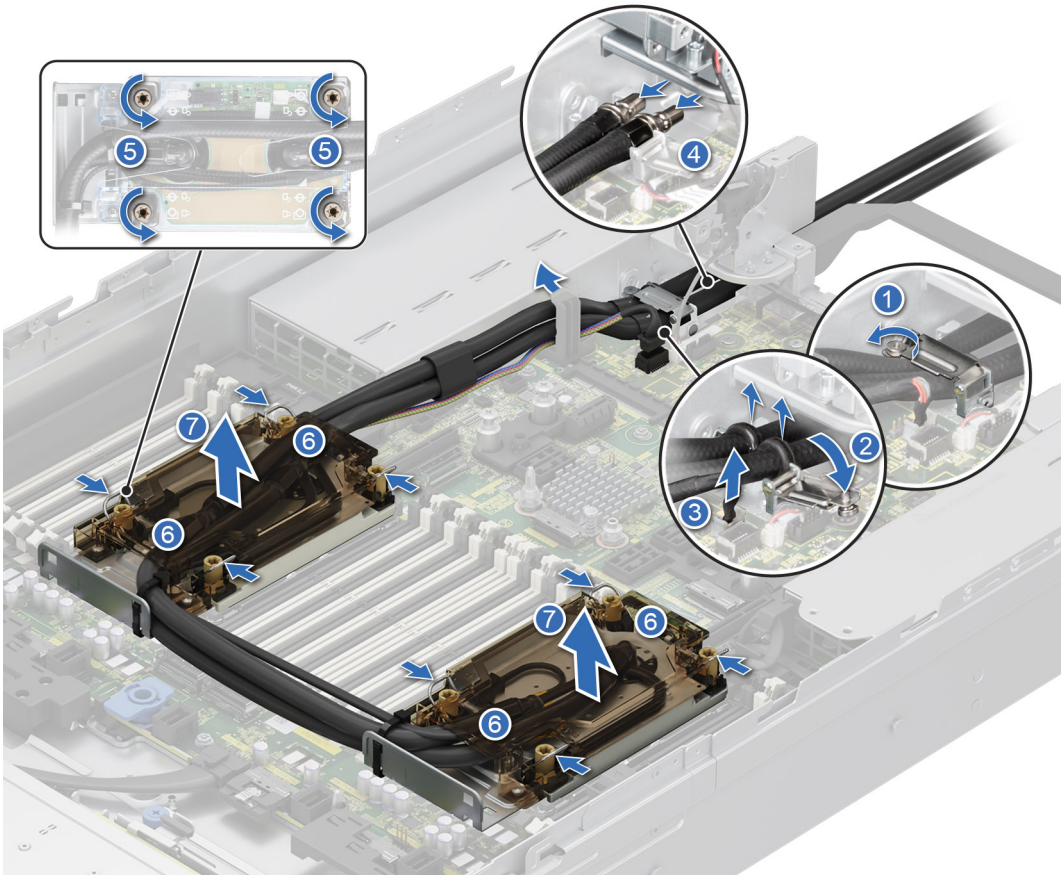


Figure 198. Removing the DLC module

Next steps

1. If you are removing a faulty liquid cooling module, replace the Direct Liquid Cooling module, else remove the processor.

Removing the processor

Prerequisites

WARNING: Remove the processor from Direct Liquid Cooling (DLC) module only if you are replacing the processor or DLC module.

NOTE: Removing the Xeon Max processor from DLC module is the same as processor and heat sink module (PHM).

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. Remove the Direct Liquid Cooling module.

CAUTION: You may find the CMOS battery loss or CMOS checksum error that is displayed during the first instance of powering on the system after the processor or system board replacement which is expected. To fix this, go to setup option to configure the system settings.

Steps

1. Place the DLC module with the processor side facing up.
2. Using your thumb, lift the thermal interface material (TIM) break lever to release the processor from the TIM and retaining clip.
3. Holding the processor by the edges, lift the processor away from the retaining clip.

   NOTE: Ensure to hold the retaining clip to the heat sink as you lift the TIM break lever.

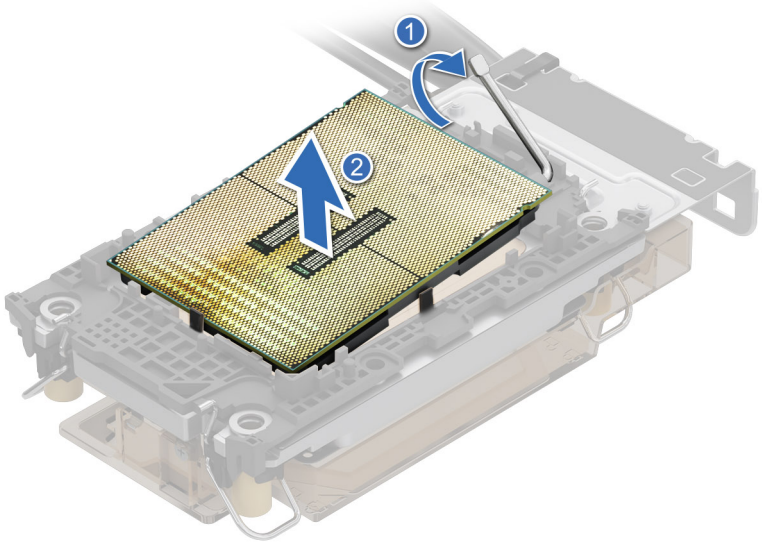


Figure 199. Lift up the TIM break lever

NOTE: Ensure to return the TIM break lever back to original position.

4. Using your thumb and index finger, first hold the retaining clip release tab at the pin 1 connector, pull out the tip of the retaining clip release tab, and then lift the retaining clip partially from the DLC module.
5. Repeat the procedure at the remaining three corners of the retaining clip.
6. After all the corners are released from the DLC module, lift the retaining clip from the pin 1 corner of the DLC module.

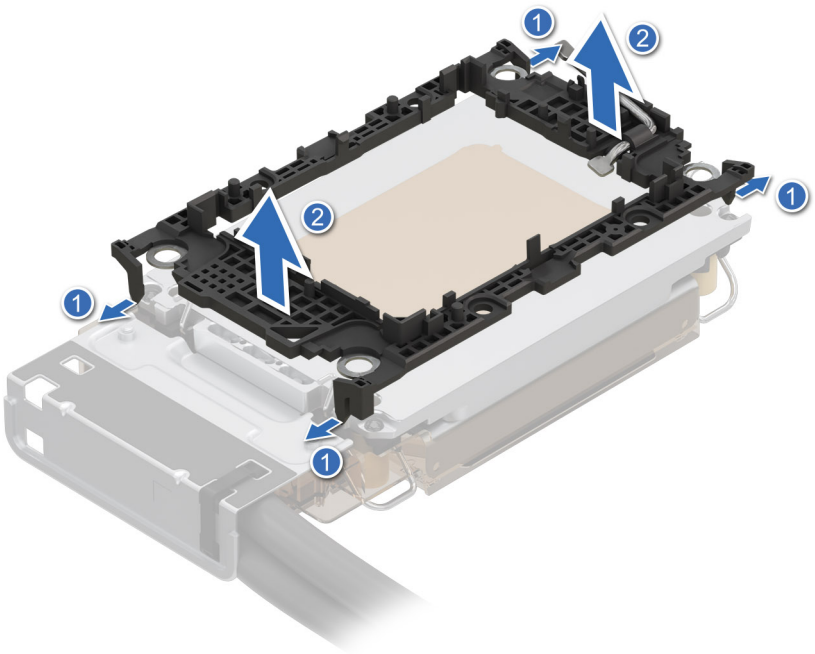


Figure 200. Removing the retaining clip

Next steps

Replace the processor.

Installing the processor

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. Remove the liquid cooling module.
5. **NOTE:** Installing the Xeon Max processor to Direct Liquid Cooling (DLC) module is the same as processor and heat sink module (PHM).

Steps

1. Place the processor in the processor tray.

   NOTE: Ensure the pin 1 indicator on the processor tray is aligned with the pin 1 indicator on the processor.

2. Place the retaining clip on top of the processor in the processor tray aligning pin 1 indicator on the processor.

   NOTE: Ensure the pin 1 indicator on the retaining clip is aligned with the pin 1 indicator on the processor before placing the retaining clip on the processor.

   NOTE: Before you install the DLC module, ensure to place the processor and retaining clip in the tray.

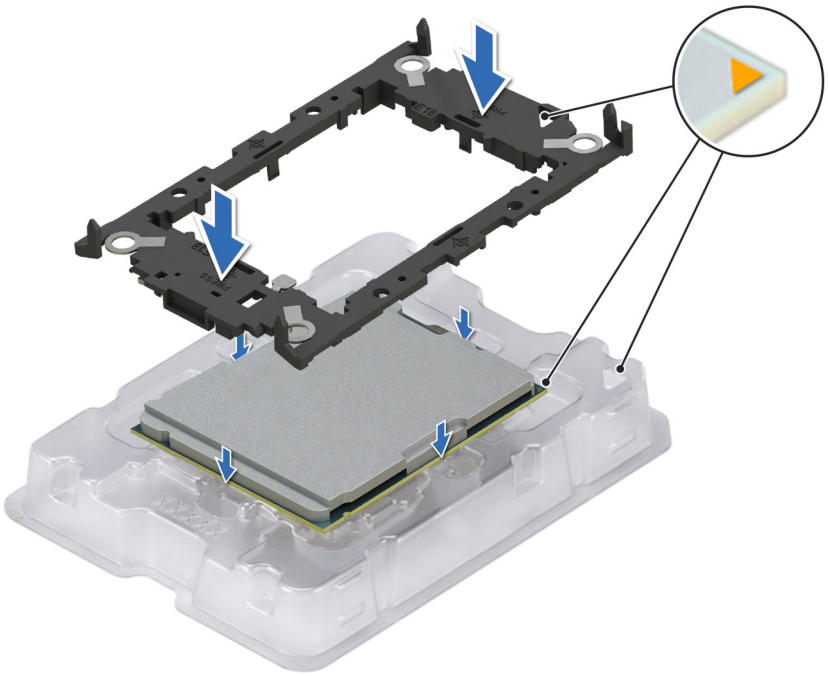


Figure 201. Installing the retaining clip

3. Align the processor with retaining clip, by using your fingers press the retaining clip on all the four sides until it clicks into place.

   NOTE: Ensure that the processor is securely latched to the retaining clip.

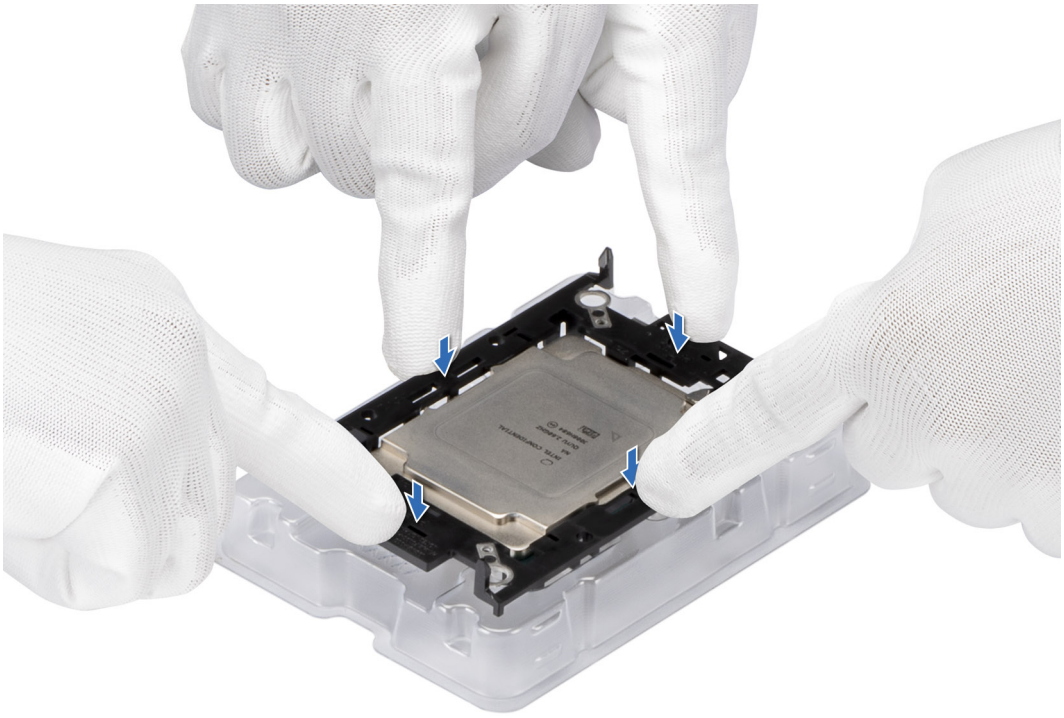


Figure 202. Press the retaining clip on the four sides

4. If you are using an existing DLC module, remove the thermal grease from the DLC module by using a clean lint-free cloth.
5. Apply the thermal grease syringe in a quadrilateral design on the top of the processor.
6. Use the thermal grease syringe included with your processor kit to apply the grease in a thin spiral design on the bottom of the DLC module.

CAUTION: Applying too much thermal grease can result in excess grease coming in contact with and contaminating the processor socket.

NOTE: The thermal grease syringe is intended for single use only. Dispose the syringe after you use it.

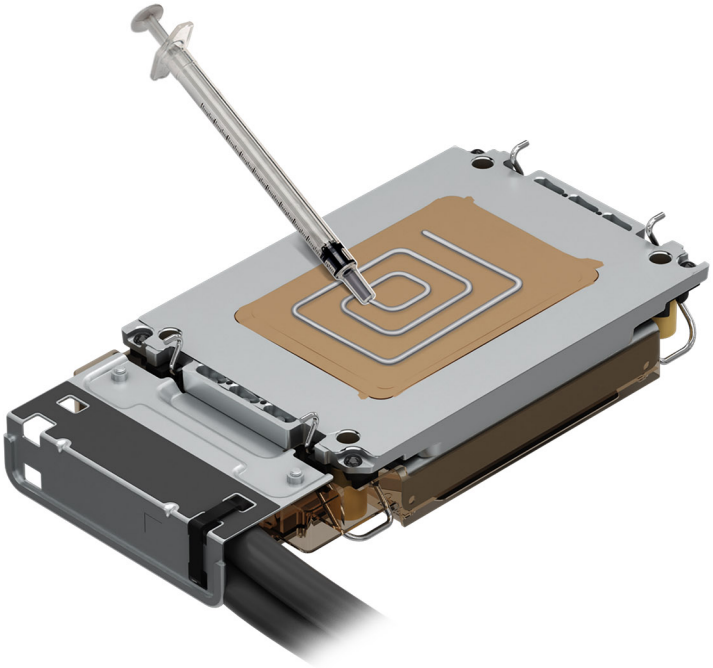


Figure 203. Applying thermal grease

7. For new DLC module, pull and remove the plastic cover from the base of DLC module.

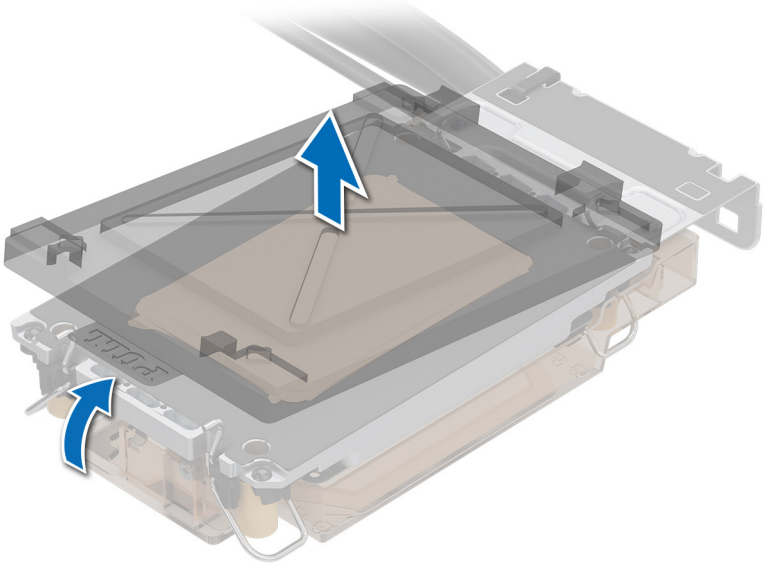


Figure 204. Removing the cover

8. Place the DLC module on the processor and press the base of the DLC module until the retaining clip locks onto the DLC module at all the four corners.

NOTE:

- Ensure latching features on retaining clip, and DLC module are aligned during assembly.
- Ensure that the pin 1 indicator on the DLC module is aligned with the pin 1 indicator on the retaining clip before placing the DLC module onto the retaining clip.

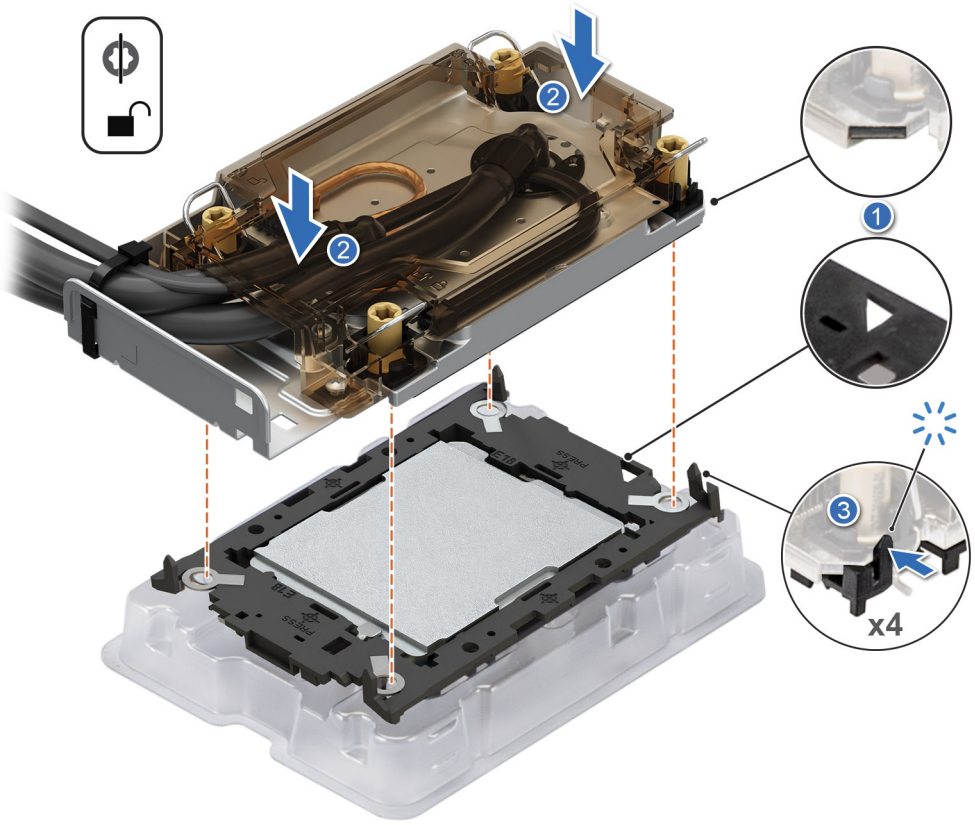


Figure 205. Installing the DLC module onto the processor

Next steps

1. Install the Direct Liquid Cooling module.
2. Install the air shroud or install the GPU air shroud.
3. Follow the procedure listed in After working inside your system.

Installing the Direct Liquid Cooling module

Prerequisites

Never uninstall the Direct Liquid Cooling (DLC) module from a processor unless you intend to replace the processor or system board. The DLC module is necessary to maintain proper thermal conditions.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. Remove the expansion card riser.
5. If installed, remove the processor dust cover.

NOTE: Ensure anti-tilt wires on the DLC module are in the unlocked position.

Steps

1. Align the DLC module with the standoff screws on the system board.

NOTE: Ensure that the DLC tubes and liquid cooling leak detection cable are placed towards the rear of the system.

2. Place the module on the processor slot and set all the anti-tilt wires to locked position (outward position).
3. Route the DLC tubes to the front of the system and along the DIMM latches.
4. Using the Torx T30 screwdriver, tighten the captive nuts (8 in-lbf) on the DLC module in the order below:
   a. In a random order, tighten the first nut three turns.
   b. Tighten the nut diagonally opposite to the nut that you tighten first.
   c. Repeat the procedure for the remaining two nuts.
   d. Return to the first nut to tighten it completely.
   e. Check all the nuts to ensure they are firmly secured.
5. The tubes leading towards the rear of the chassis and the DLC leak detection cable are placed in between the PSU 2 and the clip of rear I/O board (RIO).

   NOTE: Leak detection cable must be placed first into the clip (underneath the cooling tubes), and then place tube 2 and tube 1 into the clip to ensure that cable does not interfere with the PCIe risers.

6. Route the rear end of the DLC tubes through the RIO board.

   NOTE: Follow the number labels on the DLC tubes and ring holders (1,2).

7. Connect the DLC leak detection cable to the connector on RIO.
8. Align the rubber ring on the tubes with the ring holder.
9. Tilt the DLC ring holder and using a Phillips #2 screwdriver, tighten the captive screw on the DLC ring holder to secure it in place.

   NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

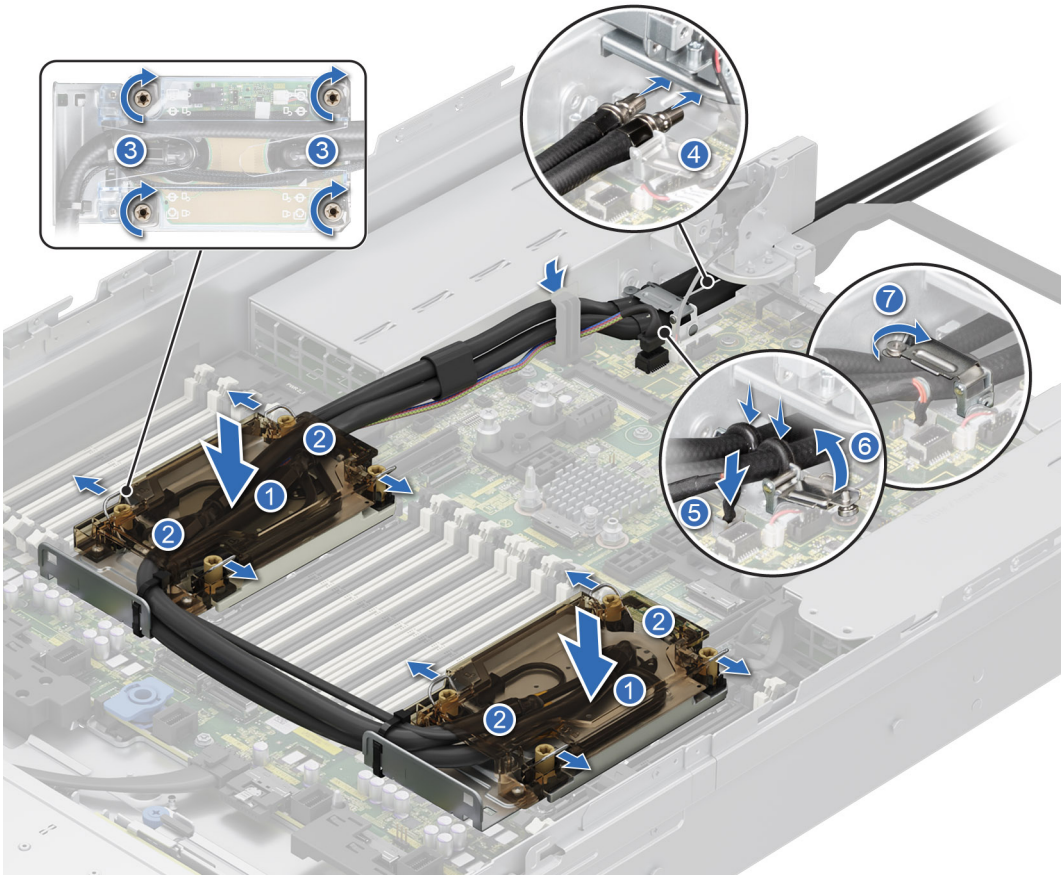


Figure 206. Installing the DLC module

Next steps

1. Install the expansion card riser.
2. Install the air shroud or install the GPU air shroud.
3. Follow the procedure listed in the After working inside your system.

Expansion cards and expansion card risers

NOTE: When an expansion card is not supported or missing, the iDRAC and Lifecycle Controller logs an event. This does not prevent your system from booting. However, if a F1/F2 pause occurs with an error message, see Troubleshooting expansion cards section in the PowerEdge Servers Troubleshooting Guide at PowerEdge Manuals.

Expansion card installation guidelines

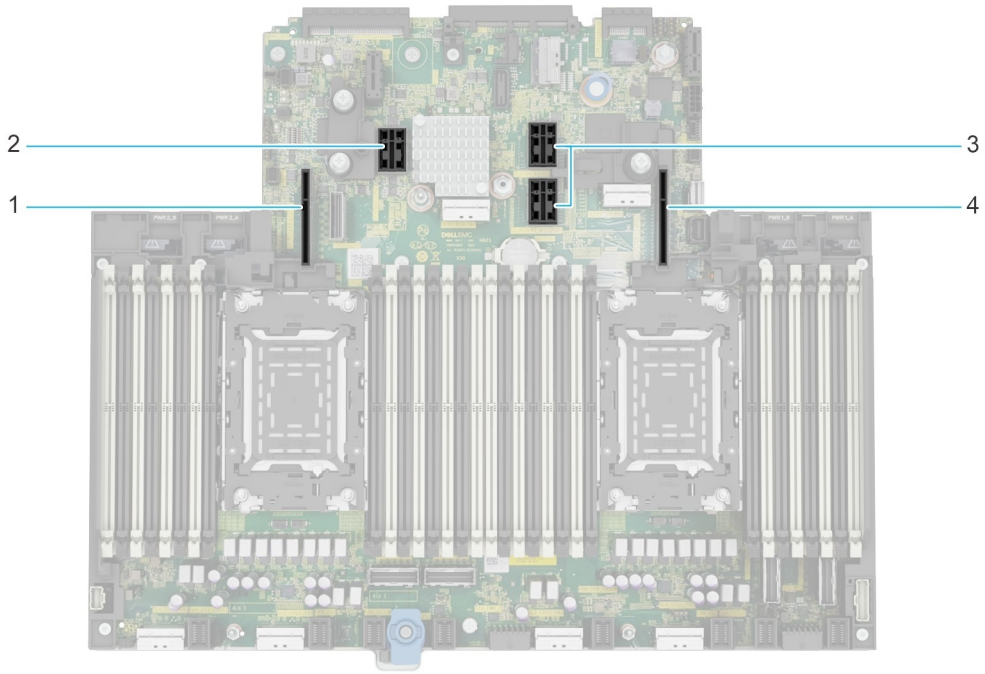


Figure 207. Expansion card riser slot connectors

1. Riser 4
2. Riser 3
3. Riser 2
4. Riser 1

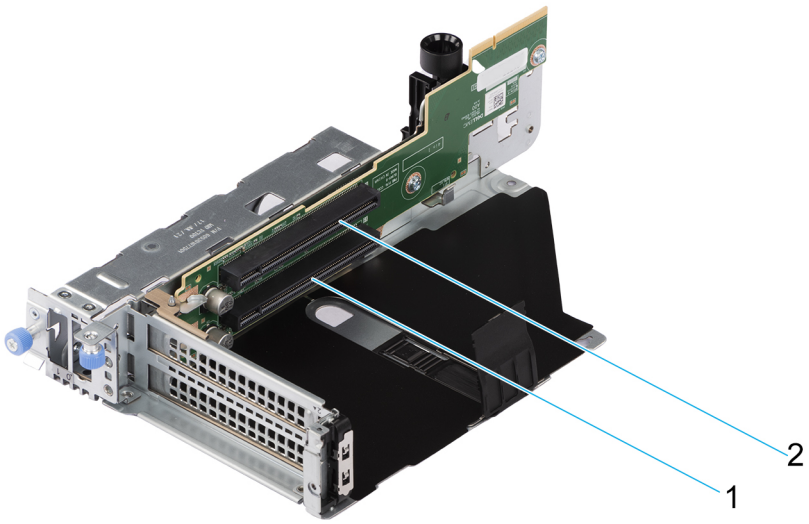


Figure 208. Riser 1B

1. Slot 1
2. Slot 2

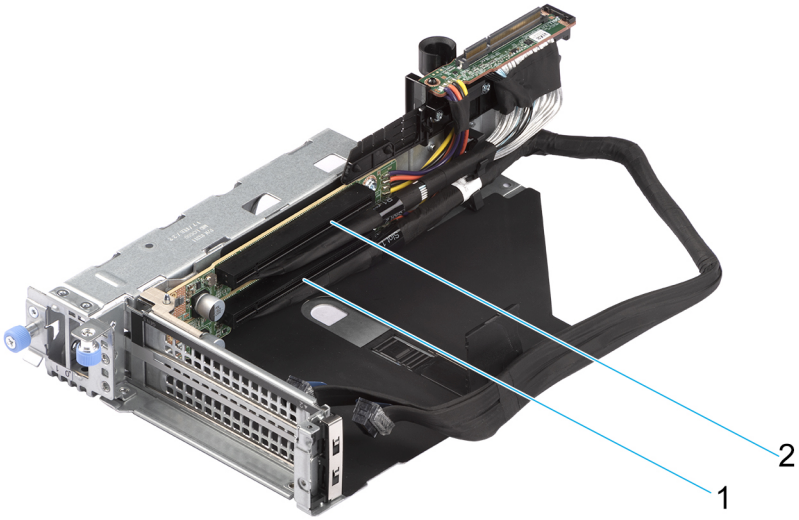


Figure 209. Riser 1R

1. Slot 1
2. Slot 2

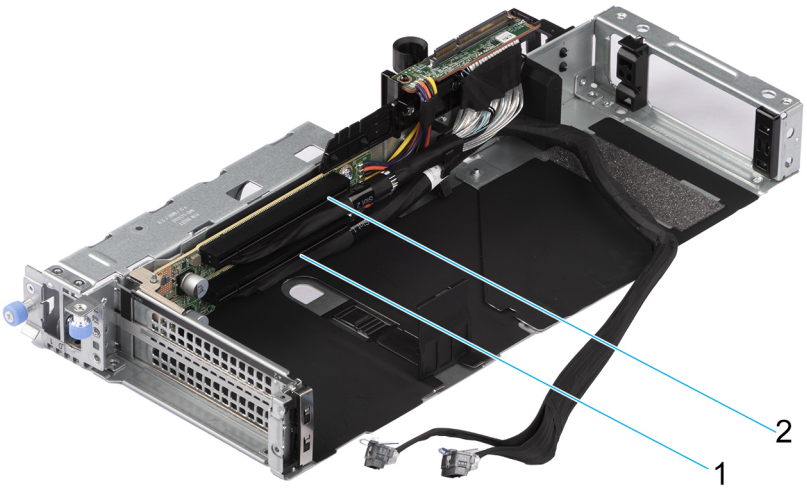


Figure 210. Riser 1R FL

1. Slot 1
2. Slot 2

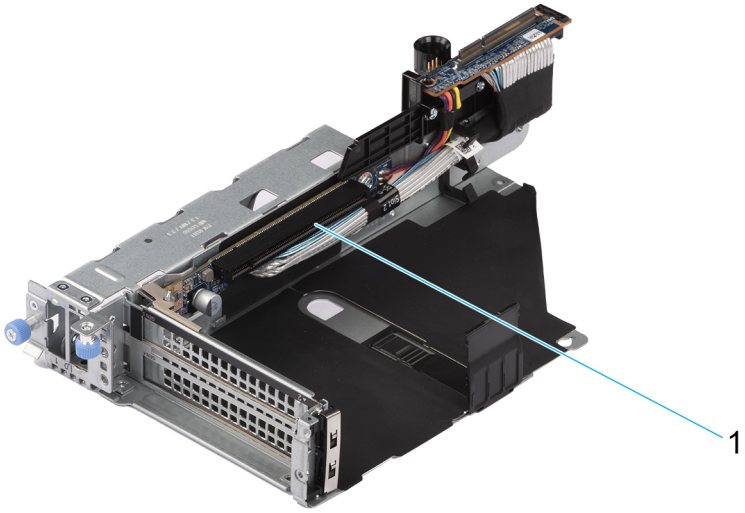


Figure 211. Riser 1P

1. Slot 2

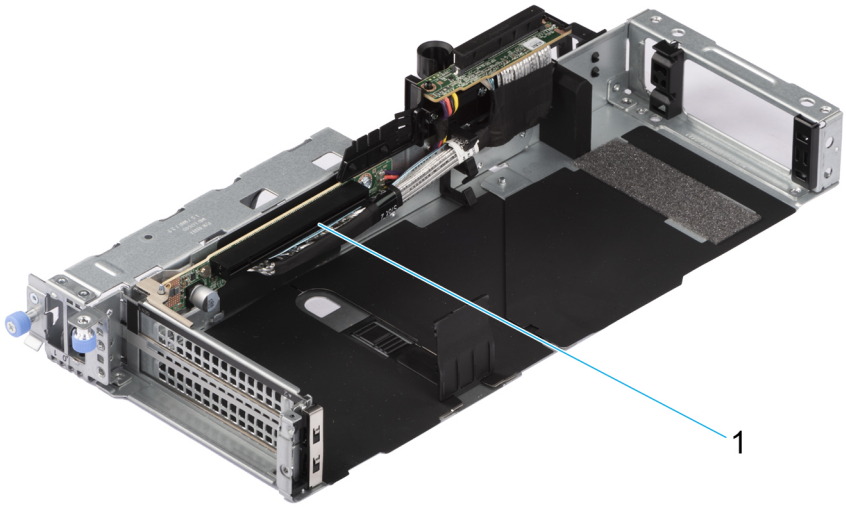


Figure 212. Riser 1P FL

1. Slot 2

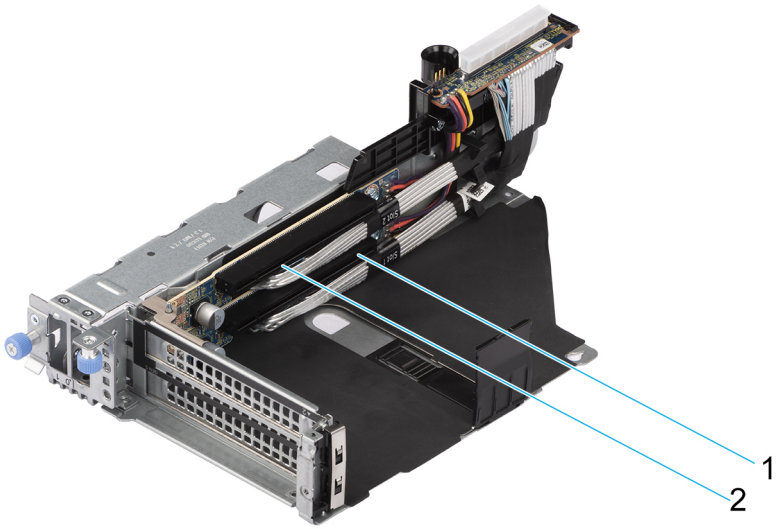


Figure 213. Riser 1Q

1. Slot 1
2. Slot 2

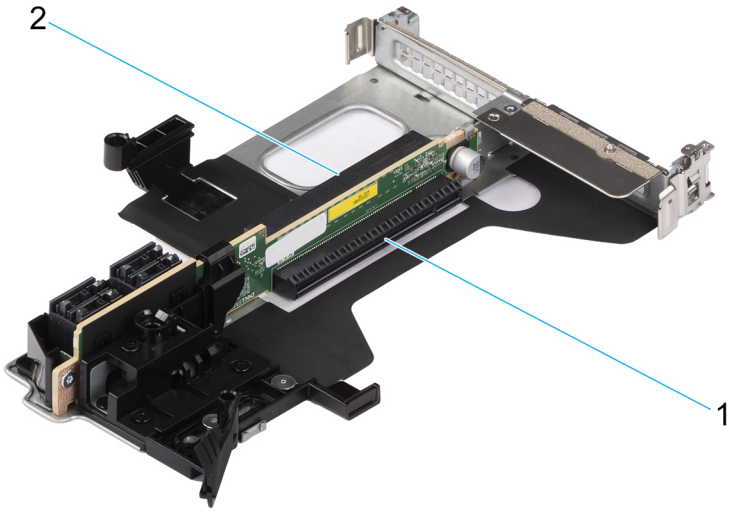


Figure 214. Riser 2A

1. Slot 6
2. Slot 3

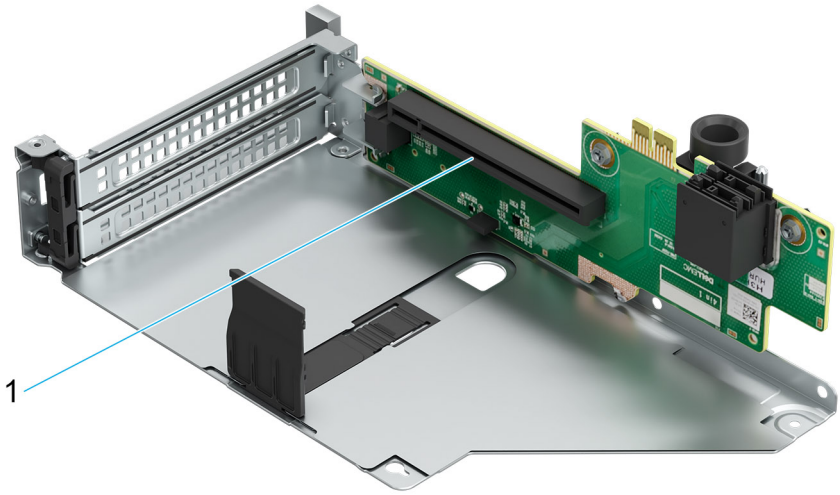


Figure 215. Riser 3A

1. Slot 5

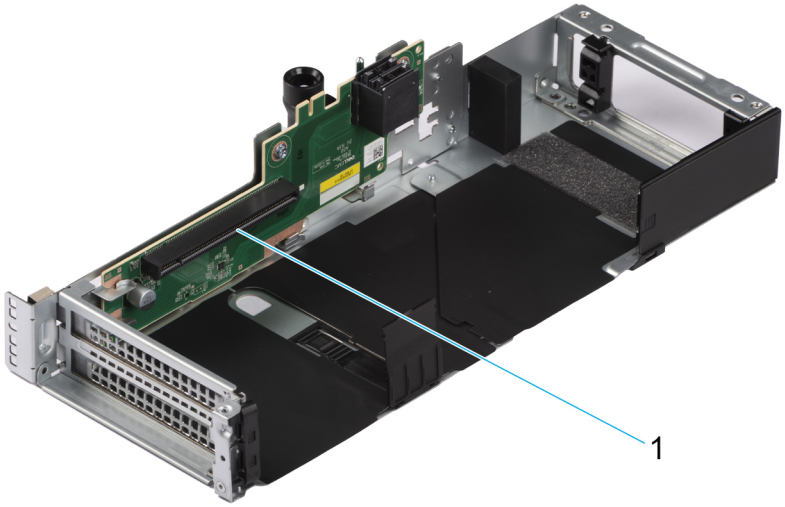


Figure 216. Riser 3A FL

1. Slot 5

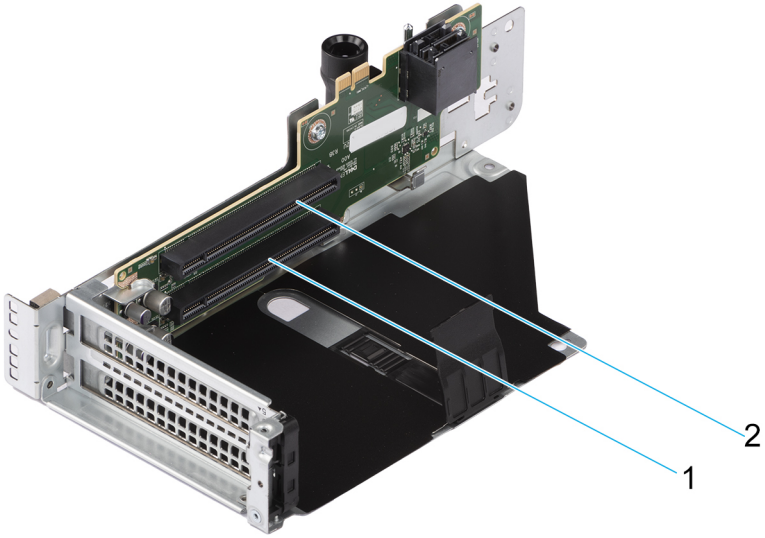


Figure 217. Riser 3B

1. Slot 4
2. Slot 5

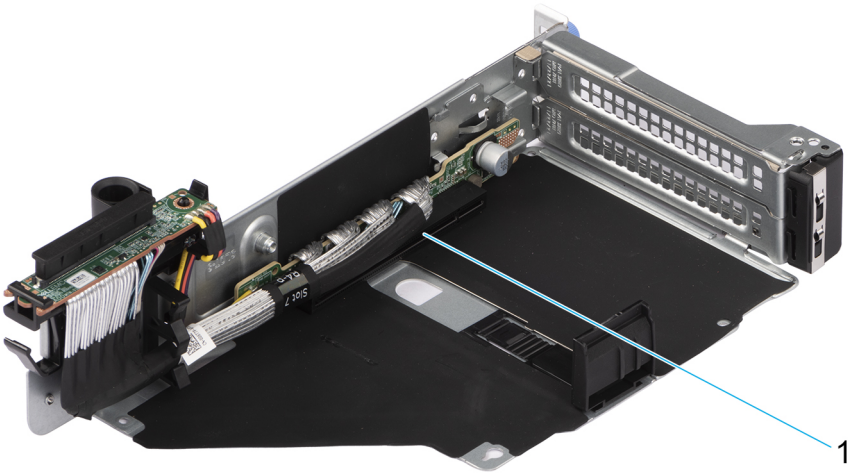


Figure 218. Riser 4P

1. Slot 7

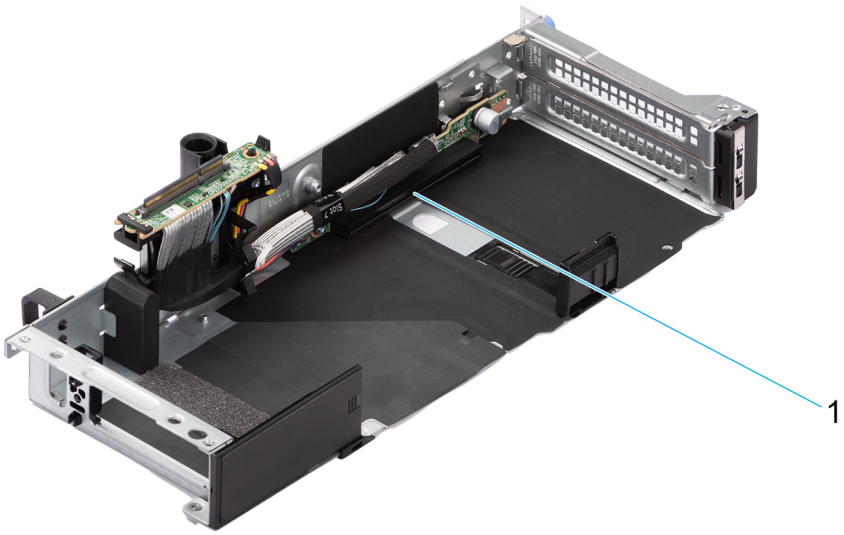


Figure 219. Riser 4P - FL

1. Slot 7

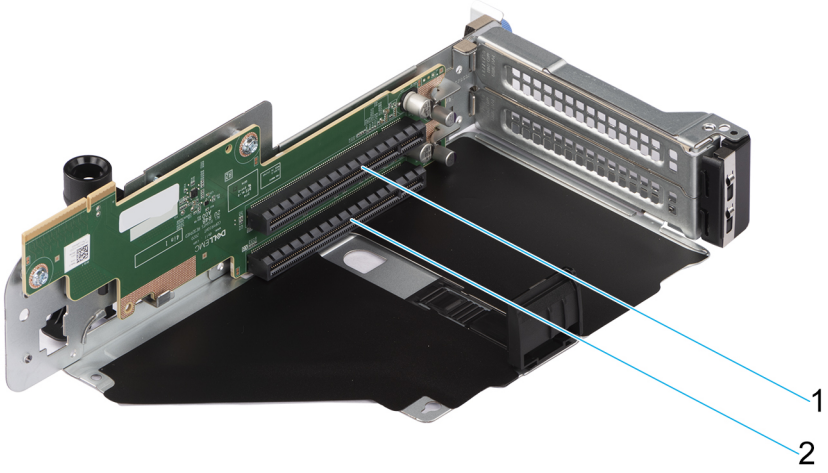


Figure 220. Riser 4B

1. Slot 8
2. Slot 7

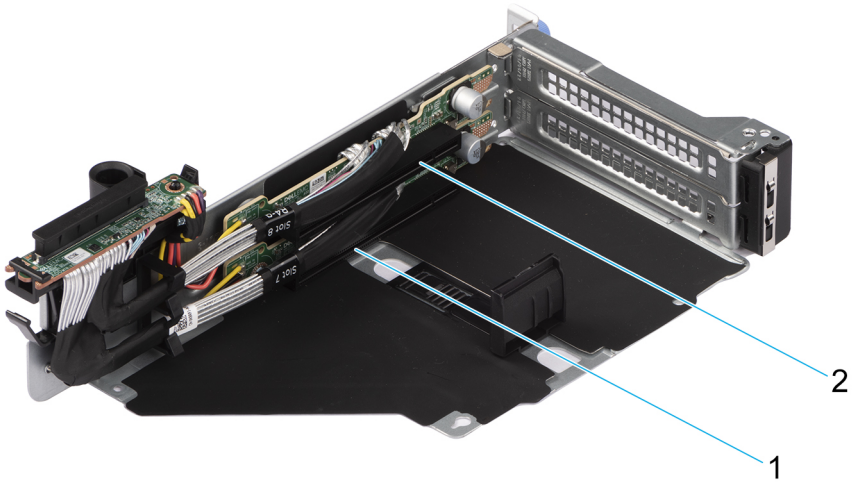


Figure 221. Riser 4Q

1. Slot 7
2. Slot 8

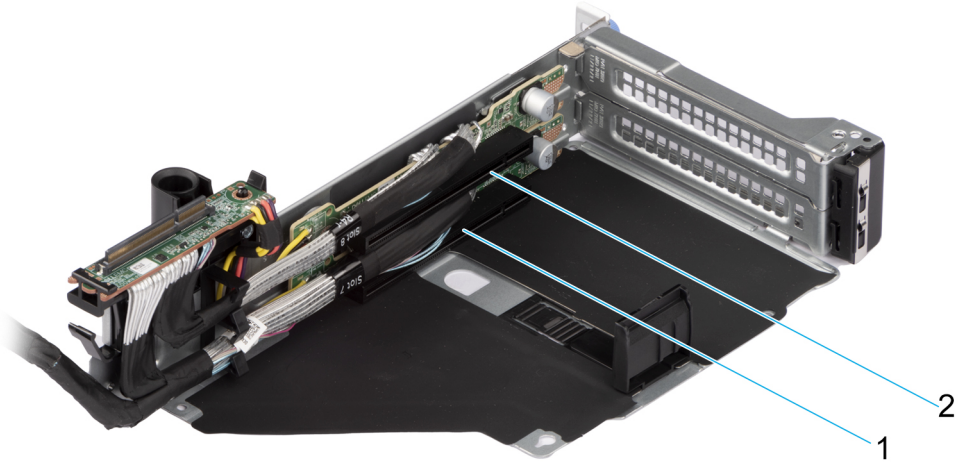


Figure 222. Riser 4R

1. Slot 7
2. Slot 8

NOTE: The expansion-card slots are not hot-swappable.

The following table provides guidelines for installing expansion cards to ensure proper cooling and mechanical fit. The expansion cards with the highest priority should be installed first using the slot priority indicated. All the other expansion cards should be installed in the card priority and slot priority order.

Table 153. Expansion card riser configurations

Configurations	Expansion card risers	PCIe Slots	Form factor	Controlling processor	Slot's electrical bandwidth/ physical connector
Config1. 6 x8 FH + 2 x16 LP	R1B	1	Full height	Processor 1	PCIe Gen4 x8 (x16 connector)
		2	Full height	Processor 1	PCIe Gen4 x8 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
		6	Low profile	Processor 2	PCIe Gen4 x16 (x16 connector)
	R3B	4	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
		5	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
	R4B	7	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
		8	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
Config2. 4 x8 FH (Gen5) + 2x 8FH + 2 x16 LP	R1Q	1	Full height	Processor 1	PCIe Gen5 x8 (x16 connector)
		2	Full height	Processor 1	PCIe Gen5 x8 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)

Table 153. Expansion card riser configurations (continued)

Configurations	Expansion card risers	PCIe Slots	Form factor	Controlling processor	Slot's electrical bandwidth/ physical connector
		6	Low profile	Processor 2	PCIe Gen4 x16 (x16 connector)
	R3B	4	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
		5	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
	R4Q	7	Full height	Processor 2	PCIe Gen5 x8 (x16 connector)
		8	Full height	Processor 2	PCIe Gen5 x8 (x16 connector)
Config3-1. 2 x16 LP + 2 x8 FH + 2 x16 FH (Gen5)	R1P	2	Full height	Processor 1	PCIe Gen5 x16 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
		6	Low profile	Processor 2	PCIe Gen4 x16 (x16 connector)
	R3B	4	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
		5	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
	R4P	7	Full height	Processor 2	PCIe Gen5 x16 (x16 connector)
Config3-2. 2 x16 LP + 2 x8 FH + 2 x16 DW (Gen5)	R1P	2	Full height (DW)	Processor 1	PCIe Gen5 x16 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
		6	Low profile	Processor 2	PCIe Gen4 x16 (x16 connector)
	R3B	4	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
		5	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
	R4P	7	Full height (DW)	Processor 2	PCIe Gen5 x16 (x16 connector)
Config4-1. 2x16LP + 3x8FH +1x16 FH (Gen5) +1x16 Gen5 SNAPI	R1P	2	Full height	Processor 1	PCIe Gen5 x16 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
		6	Low profile	Processor 2	PCIe Gen4 x16 (x16 connector)
	R3B	4	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
		5	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)

Table 153. Expansion card riser configurations (continued)

Configurations	Expansion card risers	PCIe Slots	Form factor	Controlling processor	Slot's electrical bandwidth/ physical connector
	R4R	7	Full height	Processor 1 and 2	PCIe Gen5 x16 (x16 connector)
Config5-1. 2 x16 LP + 2 x16 FH + 2x16 FH (Gen5)	R1R	1	Full height	Processor 1	PCIe Gen4 x16 (x16 connector)
		2	Full height	Processor 1	PCIe Gen5 x16 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
		6	Low profile	Processor 2	PCIe Gen4 x16 (x16 connector)
	R3A	5	Full height	Processor 2	PCIe Gen4 x16 (x16 connector)
	R4P	7	Full height	Processor 2	PCIe Gen5 x16 (x16 connector)
Config5-2. 2 x16 LP + 2 x16 FH + 2x16 FH (Gen5)	R1R	1	Full height	Processor 1	PCIe Gen4 x16 (x16 connector)
		2	Full height	Processor 1	PCIe Gen5 x16 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
		6	Low profile	Processor 2	PCIe Gen4 x16 (x16 connector)
	R3A	5	Full height	Processor 2	PCIe Gen4 x16 (x16 connector)
	R4P	7	Full height (DW)	Processor 2	PCIe Gen5 x16 (x16 connector)
Config6. 2 x16 LP + 2 x8 FH (Gen5)	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
		6	Low profile	Processor 2	PCIe Gen4 x16 (x16 connector)
	R4Q	7	Full height	Processor 2	PCIe Gen5 x8 (x16 connector)
		8	Full height	Processor 2	PCIe Gen5 x8 (x16 connector)
Config7. 2 x16 LP + 4 x8 FH (Gen5)	R1Q	1	Full height	Processor 1	PCIe Gen5 x8 (x16 connector)
		2	Full height	Processor 1	PCIe Gen5 x8 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
		6	Low profile	Processor 2	PCIe Gen4 x16 (x16 connector)
	R4Q	7	Full height	Processor 2	PCIe Gen5 x8 (x16 connector)

Table 153. Expansion card riser configurations (continued)

Configurations	Expansion card risers	PCIe Slots	Form factor	Controlling processor	Slot's electrical bandwidth/ physical connector
		8	Full height	Processor 2	PCIe Gen5 x8 (x16 connector)
Config8. 2 x8 FH + 1 x16 LP (Gen4)	R1B	1	Full height	Processor 1	PCIe Gen4 x8 (x16 connector)
		2	Full height	Processor 1	PCIe Gen4 x8 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
Config9. 3 x8 FH (Gen5) + 1 x16 LP	R1Q	1	Full height	Processor 1	PCIe Gen5 x8 (x16 connector)
		2	Full height	Processor 1	PCIe Gen5 x8 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
	R4R	7	Full height	Processor 1	PCIe Gen5 x8 (x16 connector)
Config10-1. 1 x16 LP + 1 x8 FH (Gen5) +1 x16 FH (Gen5)	R1P	2	Full height	Processor 1	PCIe Gen5 x16 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
	R4R	7	Full height	Processor 1	PCIe Gen5 x8 (x16 connector)
Config11. 2 x16 LP + 2 x8 FH	R1-paddle	N/A	N/A	N/A	N/A
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
		6	Low profile	Processor 2	PCIe Gen4 x16 (x16 connector)
	R3B	4	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
		5	Full height	Processor 2	PCIe Gen4 x8 (x16 connector)
	R4-paddle	N/A	N/A	N/A	N/A
Config12. 2 x16 LP + 4 x8 FH (Gen5)	R1Q	1	Full height	Processor 1	PCIe Gen5 x8 (x16 connector)
		2	Full height	Processor 1	PCIe Gen5 x8 (x16 connector)
	R2A	3	Low profile	Processor 1	PCIe Gen4 x16 (x16 connector)
		6	Low profile	Processor 2	PCIe Gen4 x16 (x16 connector)
	R4Q	7	Full height	Processor 2	PCIe Gen5 x8 (x16 connector)
		8	Full height	Processor 2	PCIe Gen5 x8 (x16 connector)

NOTE: In Config11, R1 and R4 paddle cards do not have a physical PCIe slot. See R1 and R4 paddle card installation.

Table 154. Configuration 0: No risers

Card type	Slot priority	Maximum number of cards
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 HBA465i)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755N)	Integrated slot	2
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1

Table 155. Configuration 1: R1B+R2A+R3B+R4B

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	8, 4	1
Inventec (Serial)	8, 4	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	5, 4, 7, 1, 2	5
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1

Table 155. Configuration 1: R1B+R2A+R3B+R4B (continued)

Card type	Slot priority	Maximum number of cards
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 HBA465i)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755N)	Integrated slot	2
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Foxconn (PERC Adapter12 HBA465i)	3	1
Foxconn (PERC Adapter12 H965i)	3	1
Foxconn (PERC Adapter11 H755)	3	1
Foxconn (PERC Adapter11 HBA355i)	3	1
Foxconn (PERC Adapter11 H355)	3	1
Intel (GPU ATS-M)	7, 8, 4, 5, 1, 2	6
NVIDIA (GPU A2)	7, 8, 4, 5, 1, 2	6
Mellanox (LP NIC: NDR200)	6, 3	2
Mellanox (NIC: HDR100 VPI)	6, 3	2
Mellanox (LP NIC: HDR VPI), 2P	6, 3	2
Mellanox (LP NIC: HDR VPI), 1P	6, 3	2
Mellanox (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 100Gb)	6, 3	2
Intel (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 25Gb)	5, 4, 7, 1, 2	5
Mellanox (NIC: 25Gb)	5, 4, 7, 1, 2	5
Mellanox (NIC: 25Gb)	6, 3	2
Intel (NIC: 25Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 25Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 25Gb)	6, 3	2
Broadcom (Emulex) (HBA: FC64)	5, 4, 7, 1, 2	5
Broadcom (Emulex) (HBA: FC64)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	5, 4, 7, 1, 2	5
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	5, 4, 7, 1, 2	5

Table 155. Configuration 1: R1B+R2A+R3B+R4B (continued)

Card type	Slot priority	Maximum number of cards
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 4, 7, 1, 2	5
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 4, 7, 1, 2	5
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Intel (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 25Gb)	5, 4, 7, 1, 2	5
Broadcom (NIC: 25Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4, 7, 1, 2	5
Broadcom (NIC: 10Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4, 7, 1, 6, 3, 2	7
Broadcom (NIC: 10Gb)	5, 4, 7, 1, 2	5
Broadcom (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 1Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 1Gb)	6, 3	2
Broadcom (NIC: 1Gb)	5, 4, 7, 1, 2	5
Broadcom (NIC: 1Gb)	6, 3	2
Foxconn (HBA355e DIB External Adapter)	5, 4, 7, 1, 6, 3, 2	7
Foxconn (H965e DIB External Adapter)	6, 3	1

Table 156. Configuration 2: R1Q+R2A+R3B+R4Q

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	8, 4	1
Inventec (Serial)	8, 4	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	5, 4, 7, 1, 2	5
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1

Table 156. Configuration 2: R1Q+R2A+R3B+R4Q (continued)

Card type	Slot priority	Maximum number of cards
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 HBA465i)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755N)	Integrated slot	2
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Foxconn (PERC Adapter12 HBA465i)	3	1
Foxconn (PERC Adapter12 H965i)	3	1
Foxconn (PERC Adapter11 H755)	3	1
Foxconn (PERC Adapter11 HBA355i)	3	1
Foxconn (PERC Adapter11 H355)	3	1
Intel (GPU ATS-M)	7, 8, 4, 5, 1, 2	6
NVIDIA (GPU A2)	7, 8, 4, 5, 1, 2	6
Mellanox (LP NIC: NDR200)	6, 3	2
Mellanox (NIC: HDR100 VPI)	6, 3	2
Mellanox (LP NIC: HDR VPI), 2P	6, 3	2
Mellanox (LP NIC: HDR VPI), 1P	6, 3	2
Mellanox (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 100Gb)	6, 3	2
Intel (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 25Gb)	5, 4, 7, 1, 2	5
Mellanox (NIC: 25Gb)	5, 4, 7, 1, 2	5
Mellanox (NIC: 25Gb)	6, 3	2
Intel (NIC: 25Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 25Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 25Gb)	6, 3	2
Broadcom (Emulex) (HBA: FC64)	5, 4, 7, 1, 2	5
Broadcom (Emulex) (HBA: FC64)	6, 3	2

Table 156. Configuration 2: R1Q+R2A+R3B+R4Q (continued)

Card type	Slot priority	Maximum number of cards
Broadcom (Emulex) (HBA: FC32)	5, 4, 7, 1, 2	5
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	5, 4, 7, 1, 2	5
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 4, 7, 1, 2	5
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 4, 7, 1, 2	5
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Intel (NIC: ACC100)	6, 3	2
Broadcom (NIC: 25Gb)	5, 4, 7, 1, 2	5
Broadcom (NIC: 25Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4, 7, 1, 2	5
Broadcom (NIC: 10Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4, 7, 1, 6, 3, 2	7
Broadcom (NIC: 10Gb)	5, 4, 7, 1, 2	5
Broadcom (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 1Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4, 7, 1, 2	5
Intel (NIC: 1Gb)	6, 3	2
Broadcom (NIC: 1Gb)	5, 4, 7, 1, 2	5
Broadcom (NIC: 1Gb)	6, 3	2
Foxconn (HBA355e DIB External Adapter)	5, 4, 7, 1, 6, 3, 2	7
Foxconn (H965e DIB External Adapter)	6, 3	1

Table 157. Configuration 3-1: R1P+R2A+R3B+R4P (HL)

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	4	1
Inventec (Serial)	4	1
Mellanox (NVIDIA) (Dell DPU: 100Gb)	2	1
Pensando (Dell DPU: 100Gb)	2	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	5, 4, 7, 2	4
Pensando (Dell DPU: 25Gb)	2	1

Table 157. Configuration 3-1: R1P+R2A+R3B+R4P (HL) (continued)

Card type	Slot priority	Maximum number of cards
Mellanox (NVIDIA) (Dell DPU: 25Gb)	2	1
Inventec (MIC Card)	Integrated slot	1
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 HBA465i)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755N)	Integrated slot	2
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Foxconn (PERC Adapter12 HBA465i)	3	1
Foxconn (PERC Adapter12 H965i)	3	1
Foxconn (PERC Adapter11 H755)	3	1
Foxconn (PERC Adapter11 HBA355i)	3	1
Foxconn (PERC Adapter11 H355)	3	1
NVIDIA (GPU L4)	7, 2	2
Intel (GPU ATS-M)	7, 4, 5, 2	4
NVIDIA (GPU A2)	7, 4, 5, 2	4
Mellanox (FH NIC: NDR200)	7, 2	2
Mellanox (LP NIC: NDR200)	6, 3	2
Mellanox (NIC: NDR400)	7, 2	2
Mellanox (NIC: HDR100 VPI)	7, 2	2
Mellanox (NIC: HDR100 VPI)	6, 3	2
Mellanox (FH NIC: HDR VPI), 2P	7, 2	2

Table 157. Configuration 3-1: R1P+R2A+R3B+R4P (HL) (continued)

Card type	Slot priority	Maximum number of cards
Mellanox (LP NIC: HDR VPI), 2P	6, 3	2
Mellanox (FH NIC: HDR VPI), 1P	7, 2	2
Mellanox (LP NIC: HDR VPI), 1P	6, 3	2
Mellanox (NIC: 100Gb)	7, 2	2
Mellanox (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 100Gb)	6, 3	2
Intel (NIC: 100Gb)	2	2
Intel (NIC: 100Gb)	6, 3	2
Intel (NIC: 100Gb)	7, 2	2
Intel (NIC: 25Gb)	7, 2	2
Intel (NIC: 25Gb)	7, 2	2
Broadcom (NIC: 25Gb)	5, 4, 7, 2	4
Intel (NIC: 10Gb)	7, 2	2
Mellanox (NIC: 25Gb)	5, 4, 7, 2	4
Mellanox (NIC: 25Gb)	6, 3	2
Intel (NIC: 25Gb)	5, 4, 7, 2	4
Intel (NIC: 25Gb)	5, 4, 7, 2	4
Intel (NIC: 25Gb)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	7, 2	2
Broadcom (Emulex) (HBA: FC64)	5, 4, 7, 2	4
Broadcom (Emulex) (HBA: FC64)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	5, 4, 7, 2	4
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	5, 4, 7, 2	4
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 4, 7, 2	4
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 4, 7, 2	4
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Intel (NIC: ACC100)	6, 3	2
Broadcom (NIC: 25Gb)	5, 4, 7, 2	4
Broadcom (NIC: 25Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4, 7, 2	4
Broadcom (NIC: 10Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4, 7, 6, 3, 2	6
Broadcom (NIC: 10Gb)	5, 4, 7, 2	4
Broadcom (NIC: 10Gb)	6, 3	2

Table 157. Configuration 3-1: R1P+R2A+R3B+R4P (HL) (continued)

Card type	Slot priority	Maximum number of cards
Intel (NIC: 10Gb)	5, 4, 7, 2	4
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 4, 7, 2	4
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4, 7, 2	4
Intel (NIC: 1Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4, 7, 2	4
Intel (NIC: 1Gb)	6, 3	2
Broadcom (NIC: 1Gb)	5, 4, 7, 2	4
Broadcom (NIC: 1Gb)	6, 3	2
Foxconn (HBA355e DIB External Adapter)	5, 4, 7, 6, 3, 2	6
Foxconn (H965e DIB External Adapter)	7, 6, 3, 2	1

Table 158. Configuration 3-2: R1P+R2A+R3B+R4P (FL)

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	4	1
Inventec (Serial)	4	1
Intel (Dell DPU: 200Gb)	2	1
Mellanox (NVIDIA) (Dell DPU: 100Gb)	2	1
Pensando (Dell DPU: 100Gb)	2	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	5, 4, 7, 2	4
Pensando (Dell DPU: 25Gb)	2	1
Mellanox (NVIDIA) (Dell DPU: 25Gb)	2	1
Inventec (MIC Card)	Integrated slot	1
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1

Table 158. Configuration 3-2: R1P+R2A+R3B+R4P (FL) (continued)

Card type	Slot priority	Maximum number of cards
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 HBA465i)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755N)	Integrated slot	2
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Foxconn (PERC Adapter12 HBA465i)	3	1
Foxconn (PERC Adapter12 H965i)	3	1
Foxconn (PERC Adapter11 H755)	3	1
Foxconn (PERC Adapter11 HBA355i)	3	1
Foxconn (PERC Adapter11 H355)	3	1
Intel (GPU PVC)	7, 2	2
NVIDIA (GPU H100)	7, 2	2
NVIDIA (GPU L40S)	7, 2	2
NVIDIA (GPU L40)	7, 2	2
NVIDIA (GPU A40)	7, 2	2
NVIDIA (GPU A800)	7, 2	2
NVIDIA (GPU A100)	7, 2	2
NVIDIA (GPU A30)	7, 2	2
NVIDIA (GPU A16)	7, 2	2
NVIDIA (GPU L4)	7, 2	2
Intel (GPU ATS-M)	7, 4, 5, 2	4
NVIDIA (GPU A2)	7, 4, 5, 2	4
Mellanox (FH NIC: NDR200)	7, 2	2
Mellanox (LP NIC: NDR200)	6, 3	2
Mellanox (NIC: NDR400)	7, 2	2
Mellanox (NIC: HDR100 VPI)	7, 2	2
Mellanox (NIC: HDR100 VPI)	6, 3	2
Mellanox (FH NIC: HDR VPI), 2P	7, 2	2
Mellanox (LP NIC: HDR VPI), 2P	6, 3	2
Mellanox (FH NIC: HDR VPI), 1P	7, 2	2
Mellanox (LP NIC: HDR VPI), 1P	6, 3	2
Mellanox (NIC: 100Gb)	7, 2	2
Mellanox (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 100Gb)	6, 3	2

Table 158. Configuration 3-2: R1P+R2A+R3B+R4P (FL) (continued)

Card type	Slot priority	Maximum number of cards
Intel (NIC: 100Gb)	2	2
Intel (NIC: 100Gb)	6, 3	2
Intel (NIC: 100Gb)	7, 2	2
Intel (NIC: 25Gb)	7, 2	2
Intel (NIC: 25Gb)	7, 2	2
Broadcom (NIC: 25Gb)	5, 4, 7, 2	4
Mellanox (NIC: 25Gb)	5, 4, 7, 2	4
Mellanox (NIC: 25Gb)	6, 3	2
Intel (NIC: 25Gb)	5, 4, 7, 2	4
Intel (NIC: 25Gb)	5, 4, 7, 2	4
Intel (NIC: 25Gb)	6, 3	2
Broadcom (Emulex) (HBA: FC64)	5, 4, 7, 2	4
Broadcom (Emulex) (HBA: FC64)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	7, 2	2
Broadcom (Emulex) (HBA: FC32)	5, 4, 7, 2	4
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	5, 4, 7, 2	4
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 4, 7, 2	4
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 4, 7, 2	4
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Intel (NIC: ACC100)	6, 3	2
Broadcom (NIC: 25Gb)	5, 4, 7, 2	4
Broadcom (NIC: 25Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4, 7, 2	4
Broadcom (NIC: 10Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4, 7, 6, 3, 2	6
Broadcom (NIC: 10Gb)	5, 4, 7, 2	4
Broadcom (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 4, 7, 2	4
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 4, 7, 2	4
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4, 7, 2	4
Intel (NIC: 1Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4, 7, 2	4

Table 158. Configuration 3-2: R1P+R2A+R3B+R4P (FL) (continued)

Card type	Slot priority	Maximum number of cards
Intel (NIC: 1Gb)	6, 3	2
Broadcom (NIC: 1Gb)	5, 4, 7, 2	4
Broadcom (NIC: 1Gb)	6, 3	2
Foxconn (HBA355e DIB External Adapter)	5, 4, 7, 6, 3, 2	6
Foxconn (H965e DIB External Adapter)	7, 6, 3, 2	1

Table 159. Configuration 4-1: R1P+R2A+R3B+R4R (HL)

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	8, 4	1
Inventec (Serial)	8, 4	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	5, 4, 2	3
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 HBA465i)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755N)	Integrated slot	2
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Foxconn (PERC Adapter12 HBA465i)	3	1
Foxconn (PERC Adapter12 H965i)	3	1
Foxconn (PERC Adapter11 H755)	3	1
Foxconn (PERC Adapter11 HBA355i)	3	1
Foxconn (PERC Adapter11 H355)	3	1

Table 159. Configuration 4-1: R1P+R2A+R3B+R4R (HL) (continued)

Card type	Slot priority	Maximum number of cards
NVIDIA (GPU L4)	2	1
Intel (GPU ATS-M)	8, 4, 5, 2	4
NVIDIA (GPU A2)	8, 4, 5, 2	4
Mellanox (FH NIC: NDR200)	7	1
Mellanox (LP NIC: NDR200)	6, 3	2
Mellanox (NIC: NDR400)	7	1
Mellanox (NIC: HDR100 VPI)	7	1
Mellanox (NIC: HDR100 VPI)	6, 3	2
Mellanox (FH NIC: HDR VPI), 2P	2	1
Mellanox (LP NIC: HDR VPI), 2P	6, 3	2
Mellanox (FH NIC: HDR VPI), 1P	7	1
Mellanox (LP NIC: HDR VPI), 1P	6, 3	2
Mellanox (NIC: 100Gb)	2	1
Mellanox (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 100Gb)	6, 3	2
Intel (NIC: 100Gb)	2	1
Intel (NIC: 100Gb)	6, 3	2
Intel (NIC: 100Gb)	2	1
Intel (NIC: 25Gb)	2	1
Intel (NIC: 25Gb)	2	1
Broadcom (NIC: 25Gb)	5, 4, 2	1
Mellanox (NIC: 25Gb)	5, 4, 2	3
Mellanox (NIC: 25Gb)	6, 3	2
Intel (NIC: 25Gb)	5, 4, 2	3
Intel (NIC: 25Gb)	5, 4, 2	3
Intel (NIC: 25Gb)	6, 3	2
Broadcom (Emulex) (HBA: FC64)	5, 4, 2	3
Broadcom (Emulex) (HBA: FC64)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	2	1
Broadcom (Emulex) (HBA: FC32)	5, 4, 2	3
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	5, 4, 2	3
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 4, 2	3
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 4, 2	3
Qlogic (Marvell) (HBA: FC32)	6, 3	2

Table 159. Configuration 4-1: R1P+R2A+R3B+R4R (HL) (continued)

Card type	Slot priority	Maximum number of cards
Intel (NIC: ACC100)	6, 3	2
Broadcom (NIC: 25Gb)	5, 4, 2	3
Broadcom (NIC: 25Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4, 2	3
Broadcom (NIC: 10Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4, 6, 3, 2	5
Broadcom (NIC: 10Gb)	5, 4, 2	3
Broadcom (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 4, 2	3
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 4, 2	3
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4, 2	3
Intel (NIC: 1Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4, 2	3
Intel (NIC: 1Gb)	6, 3	2
Broadcom (NIC: 1Gb)	5, 4, 2	3
Broadcom (NIC: 1Gb)	6, 3	2
Foxconn (HBA355e DIB External Adapter)	5, 4, 6, 3, 2	5
Foxconn (H965e DIB External Adapter)	6, 3, 2	1

Table 160. Configuration 5-1: R1R+R2A+R3A+R4P (HL)

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	4, 8	1
Inventec (Serial)	4, 8	1
Intel (Dell DPU: 200Gb)	2	1
Mellanox (NVIDIA) (Dell DPU: 100Gb)	2	1
Pensando (Dell DPU: 100Gb)	2	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	5, 7, 1, 2	4
Pensando (Dell DPU: 25Gb)	2	1
Mellanox (NVIDIA) (Dell DPU: 25Gb)	2	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1

Table 160. Configuration 5-1: R1R+R2A+R3A+R4P (HL) (continued)

Card type	Slot priority	Maximum number of cards
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 HBA465i)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755N)	Integrated slot	2
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Foxconn (PERC Adapter12 HBA465i)	3	1
Foxconn (PERC Adapter12 H965i)	3	1
Foxconn (PERC Adapter11 H755)	3	1
Foxconn (PERC Adapter11 HBA355i)	3	1
Foxconn (PERC Adapter11 H355)	3	1
NVIDIA (GPU L4)	7, 5, 1, 2	4
Intel (GPU ATS-M)	7, 5, 1, 2	4
NVIDIA (GPU A2)	7, 5, 1, 2	4
Mellanox (FH NIC: NDR200)	5, 7, 1, 2	4
Mellanox (LP NIC: NDR200)	6, 3	2
Mellanox (NIC: NDR400)	7, 2	2
Mellanox (NIC: HDR100 VPI)	5, 7, 1, 2	4
Mellanox (NIC: HDR100 VPI)	6, 3	2
Mellanox (FH NIC: HDR VPI), 2P	5, 7, 1, 2	4
Mellanox (LP NIC: HDR VPI), 2P	6, 3	2
Mellanox (FH NIC: HDR VPI), 1P	5, 7, 1, 2	4
Mellanox (LP NIC: HDR VPI), 1P	6, 3	2
Mellanox (NIC: 100Gb)	5, 7, 1, 2	4
Mellanox (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 100Gb)	5, 1	2
Broadcom (NIC: 100Gb)	6, 3	2

Table 160. Configuration 5-1: R1R+R2A+R3A+R4P (HL) (continued)

Card type	Slot priority	Maximum number of cards
Intel (NIC: 100Gb)	5, 7, 1, 2	4
Intel (NIC: 100Gb)	6, 3	2
Intel (NIC: 100Gb)	5, 7, 1, 2	4
Intel (NIC: 25Gb)	5, 7, 1, 2	4
Intel (NIC: 25Gb)	5, 7, 1, 2	4
Broadcom (NIC: 25Gb)	5, 7, 1, 2	4
Intel (NIC: 10Gb)	5, 7, 1, 2	4
Mellanox (NIC: 25Gb)	5, 7, 1, 2	4
Mellanox (NIC: 25Gb)	6, 3	2
Intel (NIC: 25Gb)	5, 7, 1, 2	4
Intel (NIC: 25Gb)	5, 7, 1, 2	4
Intel (NIC: 25Gb)	6, 3	2
Broadcom (Emulex) (HBA: FC64)	5, 7, 1, 2	4
Broadcom (Emulex) (HBA: FC64)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 7, 2	3
Broadcom (Emulex) (HBA: FC32)	5, 7, 1, 2	4
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	5, 7, 1, 2	4
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 7, 2	4
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 7, 1, 2	4
Qlogic (Marvell) (HBA: FC32)	6, 3	2
CORNELIS (NIC: 100Gb)	6, 3	2
Intel (NIC: ACC100)	6, 3	2
Broadcom (NIC: 25Gb)	5, 7, 1, 2	4
Broadcom (NIC: 25Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 7, 1, 2	4
Broadcom (NIC: 10Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 7, 1, 6, 3, 2	6
Broadcom (NIC: 10Gb)	5, 7, 1, 2	4
Broadcom (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 7, 1, 2	4
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 7, 1, 2	4
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 7, 1, 2	4

Table 160. Configuration 5-1: R1R+R2A+R3A+R4P (HL) (continued)

Card type	Slot priority	Maximum number of cards
Intel (NIC: 1Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 7, 1, 2	4
Intel (NIC: 1Gb)	6, 3	2
Broadcom (NIC: 1Gb)	5, 7, 1, 2	4
Broadcom (NIC: 1Gb)	6, 3	2
Foxconn (HBA355e DIB External Adapter)	5, 7, 1, 6, 3, 2	6
Foxconn (H965e DIB External Adapter)	5, 7, 1, 6, 3, 2	1

Table 161. Configuration 5-2: R1R+R2A+R3A+R4P (FL)

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	4	1
Inventec (Serial)	4	1
Intel (Dell DPU: 200Gb)	2	1
Mellanox (NVIDIA) (Dell DPU: 100Gb)	2	1
Pensando (Dell DPU: 100Gb)	2	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	5, 7, 1, 2	4
Pensando (Dell DPU: 25Gb)	2	1
Mellanox (NVIDIA) (Dell DPU: 25Gb)	2	1
Inventec (MIC Card)	Integrated slot	1
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 HBA465i)	Integrated slot	1

Table 161. Configuration 5-2: R1R+R2A+R3A+R4P (FL) (continued)

Card type	Slot priority	Maximum number of cards
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755N)	Integrated slot	2
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Foxconn (PERC Adapter12 HBA465i)	3	1
Foxconn (PERC Adapter12 H965i)	3	1
Foxconn (PERC Adapter11 H755)	3	1
Foxconn (PERC Adapter11 HBA355i)	3	1
Foxconn (PERC Adapter11 H355)	3	1
Intel (GPU PVC)	7	1
NVIDIA (GPU H100)	7	1
NVIDIA (GPU L40S)	7	1
NVIDIA (GPU L40)	7	1
NVIDIA (GPU A40)	7	1
NVIDIA (GPU A800)	7	1
NVIDIA (GPU A100)	7	1
NVIDIA (GPU A30)	7	1
NVIDIA (GPU A16)	7	1
NVIDIA (GPU L4)	7, 5, 1, 2	4
Intel (GPU ATS-M)	7, 5, 1, 2	4
NVIDIA (GPU A2)	7, 5, 1, 2	4
Mellanox (FH NIC: NDR200)	5, 7, 1, 2	4
Mellanox (LP NIC: NDR200)	6, 3	2
Mellanox (NIC: NDR400)	7, 2	2
Mellanox (NIC: HDR100 VPI)	5, 7, 1, 2	4
Mellanox (NIC: HDR100 VPI)	6, 3	2
Mellanox (FH NIC: HDR VPI), 2P	5, 7, 1, 2	4
Mellanox (LP NIC: HDR VPI), 2P	6, 3	2
Mellanox (FH NIC: HDR VPI), 1P	5, 7, 1, 2	4
Mellanox (LP NIC: HDR VPI), 1P	6, 3	2
Mellanox (NIC: 100Gb)	5, 7, 1, 2	4
Mellanox (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 100Gb)	5, 1	2
Broadcom (NIC: 100Gb)	6, 3	2
Intel (NIC: 100Gb)	5, 7, 1, 2	4
Intel (NIC: 100Gb)	6, 3	2

Table 161. Configuration 5-2: R1R+R2A+R3A+R4P (FL) (continued)

Card type	Slot priority	Maximum number of cards
Intel (NIC: 100Gb)	5, 7, 1, 2	4
Intel (NIC: 25Gb)	5, 7, 1, 2	4
Intel (NIC: 25Gb)	5, 7, 1, 2	4
Broadcom (NIC: 25Gb)	5, 7, 1, 2	4
Intel (NIC: 10Gb)	5, 7, 1, 2	4
Mellanox (NIC: 25Gb)	5, 7, 1, 2	4
Mellanox (NIC: 25Gb)	6, 3	2
Intel (NIC: 25Gb)	5, 7, 1, 2	4
Intel (NIC: 25Gb)	5, 7, 1, 2	4
Intel (NIC: 25Gb)	6, 3	2
Broadcom (Emulex) (HBA: FC64)	5, 7, 1, 2	4
Broadcom (Emulex) (HBA: FC64)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 7, 2	3
Broadcom (Emulex) (HBA: FC32)	5, 7, 1, 2	4
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	5, 7, 1, 2	4
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 7, 2	4
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 7, 1, 2	4
Qlogic (Marvell) (HBA: FC32)	6, 3	2
CORNELIS (NIC: 100Gb)	6, 3	2
Intel (NIC: (ACC100)	6, 3	2
Broadcom (NIC: 25Gb)	5, 7, 1, 2	4
Broadcom (NIC: 25Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 7, 1, 2	4
Broadcom (NIC: 10Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 7, 1, 6, 3, 2	6
Broadcom (NIC: 10Gb)	5, 7, 1, 2	4
Broadcom (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 7, 1, 2	4
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 7, 1, 2	4
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 7, 1, 2	4
Intel (NIC: 1Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 7, 1, 2	4

Table 161. Configuration 5-2: R1R+R2A+R3A+R4P (FL) (continued)

Card type	Slot priority	Maximum number of cards
Intel (NIC: 1Gb)	6, 3	2
Broadcom (NIC: 1Gb)	5, 7, 1, 2	4
Broadcom (NIC: 1Gb)	6, 3	2
Foxconn (HBA355e DIB External Adapter)	5, 7, 1, 6, 3, 2	6
Foxconn (H965e DIB External Adapter)	5, 7, 1, 6, 3, 2	1

Table 162. Configuration 6: R2A+R4Q

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	8	1
Inventec (Serial)	8	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	7	1
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 HBA465i)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Foxconn (PERC Adapter12 HBA465i)	3	1
Foxconn (PERC Adapter12 H965i)	3	1
Foxconn (PERC Adapter11 H755)	3	1
Foxconn (PERC Adapter11 HBA355i)	3	1

Table 162. Configuration 6: R2A+R4Q (continued)

Card type	Slot priority	Maximum number of cards
Foxconn (PERC Adapter11 H355)	3	1
Mellanox (LP NIC: NDR200)	6, 3	2
Mellanox (NIC: HDR100 VPI)	3, 6	2
Mellanox (LP NIC: HDR VPI), 2P	3, 6	2
Mellanox (LP NIC: HDR VPI), 1P	3, 6	2
Mellanox (NIC: 100Gb)	3, 6	2
Broadcom (NIC: 100Gb)	3, 6	2
Intel (NIC: 100Gb)	3, 6	2
Broadcom (NIC: 25Gb)	7	1
Mellanox (NIC: 25Gb)	7	1
Mellanox (NIC: 25Gb)	3, 6	2
Intel (NIC: 25Gb)	7	1
Intel (NIC: 25Gb)	7	1
Intel (NIC: 25Gb)	3, 6	2
Broadcom (Emulex) (HBA: FC64)	7	1
Broadcom (Emulex) (HBA: FC64)	3, 6	2
Broadcom (Emulex) (HBA: FC32)	7	1
Broadcom (Emulex) (HBA: FC32)	3, 6	2
Broadcom (Emulex) (HBA: FC32)	7	1
Broadcom (Emulex) (HBA: FC32)	3, 6	2
Qlogic (Marvell) (HBA: FC32)	7	1
Qlogic (Marvell) (HBA: FC32)	3, 6	2
Qlogic (Marvell) (HBA: FC32)	7	1
Qlogic (Marvell) (HBA: FC32)	3, 6	2
Intel (NIC: (ACC100)	3, 6	2
Broadcom (NIC: 25Gb)	7	1
Broadcom (NIC: 25Gb)	3, 6	2
Broadcom (NIC: 10Gb)	7	1
Broadcom (NIC: 10Gb)	3, 6	2
Broadcom (NIC: 10Gb)	7, 3, 6	3
Broadcom (NIC: 10Gb)	7	1
Broadcom (NIC: 10Gb)	3, 6	2
Intel (NIC: 10Gb)	7	1
Intel (NIC: 10Gb)	3, 6	2
Intel (NIC: 10Gb)	7	1
Intel (NIC: 10Gb)	3, 6	2
Intel (NIC: 1Gb)	7	1

Table 162. Configuration 6: R2A+R4Q (continued)

Card type	Slot priority	Maximum number of cards
Intel (NIC: 1Gb)	3, 6	2
Intel (NIC: 1Gb)	7	1
Intel (NIC: 1Gb)	3, 6	2
Broadcom (NIC: 1Gb)	7	1
Broadcom (NIC: 1Gb)	3, 6	2
Foxconn (HBA355e DIB External Adapter)	7, 3, 6	3
Foxconn (H965e DIB External Adapter)	3, 6	1

Table 163. Configuration 7: R1Q+R2A+R4Q

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	8	1
Inventec (Serial)	8	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	7, 1, 2	3
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 HBA465i)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Foxconn (PERC Adapter12 HBA465i)	3	1
Foxconn (PERC Adapter12 H965i)	3	1

Table 163. Configuration 7: R1Q+R2A+R4Q (continued)

Card type	Slot priority	Maximum number of cards
Foxconn (PERC Adapter11 H755)	3	1
Foxconn (PERC Adapter11 HBA355i)	3	1
Foxconn (PERC Adapter11 H355)	3	1
Mellanox (LP NIC: NDR200)	6, 3	2
Mellanox (NIC: HDR100 VPI)	6, 3	2
Mellanox (LP NIC: HDR VPI), 2P	6, 3	2
Mellanox (LP NIC: HDR VPI), 1P	6, 3	2
Mellanox (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 100Gb)	6, 3	2
Intel (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 25Gb)	7, 1, 2	3
Mellanox (NIC: 25Gb)	7, 1, 2	3
Mellanox (NIC: 25Gb)	6, 3	2
Intel (NIC: 25Gb)	7, 1, 2	3
Intel (NIC: 25Gb)	7, 1, 2	3
Intel (NIC: 25Gb)	6, 3	2
Broadcom (Emulex) (HBA: FC64)	7, 1, 2	3
Broadcom (Emulex) (HBA: FC64)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	7, 1, 2	3
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	7, 1, 2	3
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	7, 1, 2	3
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	7, 1, 2	3
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Intel (NIC: ACC100)	6, 3	2
Broadcom (NIC: 25Gb)	7, 1, 2	3
Broadcom (NIC: 25Gb)	6, 3	2
Broadcom (NIC: 10Gb)	7, 1, 2	3
Broadcom (NIC: 10Gb)	6, 3	2
Broadcom (NIC: 10Gb)	7, 1, 2, 6, 3	5
Broadcom (NIC: 10Gb)	7, 1, 2	3
Broadcom (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	7, 1, 2	3
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	7, 1, 2	3

Table 163. Configuration 7: R1Q+R2A+R4Q (continued)

Card type	Slot priority	Maximum number of cards
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 1Gb)	7, 1, 2	3
Intel (NIC: 1Gb)	6, 3	2
Intel (NIC: 1Gb)	7, 1, 2	3
Intel (NIC: 1Gb)	6, 3	2
Broadcom (NIC: 1Gb)	7, 1, 2	3
Broadcom (NIC: 1Gb)	6, 3	2
Foxconn (HBA355e DIB External Adapter)	7, 1, 2, 6, 3	5
Foxconn (H965e DIB External Adapter)	6, 3	1

Table 164. Configuration 8: R1B+R2A

Card type	Slot priority	Maximum number of cards
Mellanox (NVIDIA) (Channel DPU: 25Gb)	1, 2	2
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (PERC Adapter11 H755)	3	1
Foxconn (PERC Adapter11 HBA355i)	3	1
Foxconn (PERC Adapter11 H355)	3	1
Intel (GPU ATS-M)	1, 2	2
NVIDIA (GPU A2)	1, 2	2
Mellanox (LP NIC: NDR200)	3	1
Mellanox (NIC: HDR100 VPI)	3	1

Table 164. Configuration 8: R1B+R2A (continued)

Card type	Slot priority	Maximum number of cards
Mellanox (LP NIC: HDR VPI), 2P	3	1
Mellanox (LP NIC: HDR VPI), 1P	3	1
Mellanox (NIC: 100Gb)	3	1
Broadcom (NIC: 100Gb)	3	1
Intel (NIC: 100Gb)	3	1
Broadcom (NIC: 25Gb)	1, 2	2
Mellanox (NIC: 25Gb)	1, 2	2
Mellanox (NIC: 25Gb)	3	1
Intel (NIC: 25Gb)	1, 2	2
Intel (NIC: 25Gb)	1, 2	2
Intel (NIC: 25Gb)	3	1
Broadcom (Emulex) (HBA: FC64)	1, 2	2
Broadcom (Emulex) (HBA: FC64)	3	1
Broadcom (Emulex) (HBA: FC32)	1, 2	2
Broadcom (Emulex) (HBA: FC32)	3	1
Broadcom (Emulex) (HBA: FC32)	1, 2	2
Broadcom (Emulex) (HBA: FC32)	3	1
Qlogic (Marvell) (HBA: FC32)	1, 2	2
Qlogic (Marvell) (HBA: FC32)	3	1
Qlogic (Marvell) (HBA: FC32)	1, 2	2
Qlogic (Marvell) (HBA: FC32)	3	1
Intel (NIC: ACC100)	3	1
Broadcom (NIC: 25Gb)	1, 2	2
Broadcom (NIC: 25Gb)	3	1
Broadcom (NIC: 10Gb)	1, 2	2
Broadcom (NIC: 10Gb)	3	1
Broadcom (NIC: 10Gb)	1, 3, 2	3
Broadcom (NIC: 10Gb)	1, 2	2
Broadcom (NIC: 10Gb)	3	1
Intel (NIC: 10Gb)	1, 2	2
Intel (NIC: 10Gb)	3	1
Intel (NIC: 10Gb)	1, 2	2
Intel (NIC: 10Gb)	3	1
Intel (NIC: 1Gb)	1, 2	2
Intel (NIC: 1Gb)	3	1
Intel (NIC: 1Gb)	1, 2	2
Intel (NIC: 1Gb)	3	1

Table 164. Configuration 8: R1B+R2A (continued)

Card type	Slot priority	Maximum number of cards
Broadcom (NIC: 1Gb)	1, 2	2
Broadcom (NIC: 1Gb)	3	1
Foxconn (HBA355e DIB External Adapter)	1, 3, 2	3
Foxconn (H965e DIB External Adapter)	3	1

Table 165. Configuration 9: R1Q+R2A+R4R

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	8	1
Inventec (Serial)	8	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	7, 1, 2	3
Inventec (LOM Card)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755N)	Integrated slot	1
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Intel (GPU ATS-M)	7, 1, 2	3
NVIDIA (GPU A2)	7, 1, 2	3
Mellanox (LP NIC: NDR200)	3	1
Mellanox (NIC: HDR100 VPI)	3	1
Mellanox (LP NIC: HDR VPI), 2P	3	1
Mellanox (LP NIC: HDR VPI), 1P	3	1
Mellanox (NIC: 100Gb)	3	1

Table 165. Configuration 9: R1Q+R2A+R4R (continued)

Card type	Slot priority	Maximum number of cards
Broadcom (NIC: 100Gb)	3	1
Intel (NIC: 100Gb)	3	1
Broadcom (NIC: 25Gb)	7, 1, 2	3
Mellanox (NIC: 25Gb)	7, 1, 2	3
Mellanox (NIC: 25Gb)	3	1
Intel (NIC: 25Gb)	7, 1, 2	3
Intel (NIC: 25Gb)	7, 1, 2	3
Intel (NIC: 25Gb)	3	1
Broadcom (Emulex) (HBA: FC64)	7, 1, 2	3
Broadcom (Emulex) (HBA: FC64)	3	1
Broadcom (Emulex) (HBA: FC32)	7, 1, 2	3
Broadcom (Emulex) (HBA: FC32)	3	1
Broadcom (Emulex) (HBA: FC32)	7, 1, 2	3
Broadcom (Emulex) (HBA: FC32)	3	1
Qlogic (Marvell) (HBA: FC32)	7, 1, 2	3
Qlogic (Marvell) (HBA: FC32)	3	1
Qlogic (Marvell) (HBA: FC32)	7, 1, 2	3
Qlogic (Marvell) (HBA: FC32)	3	1
Intel (NIC: ACC100)	3	1
Broadcom (NIC: 25Gb)	7, 1, 2	3
Broadcom (NIC: 25Gb)	3	1
Broadcom (NIC: 10Gb)	7, 1, 2	3
Broadcom (NIC: 10Gb)	3	1
Broadcom (NIC: 10Gb)	7, 1, 3, 2	4
Broadcom (NIC: 10Gb)	7, 1, 2	3
Broadcom (NIC: 10Gb)	3	1
Intel (NIC: 10Gb)	7, 1, 2	3
Intel (NIC: 10Gb)	3	1
Intel (NIC: 10Gb)	7, 1, 2	3
Intel (NIC: 10Gb)	3	1
Intel (NIC: 1Gb)	7, 1, 2	3
Intel (NIC: 1Gb)	3	1
Intel (NIC: 1Gb)	7, 1, 2	3
Intel (NIC: 1Gb)	3	1
Broadcom (NIC: 1Gb)	7, 1, 2	3
Broadcom (NIC: 1Gb)	3	1
Foxconn (HBA355e DIB External Adapter)	7, 1, 3, 2	4

Table 165. Configuration 9: R1Q+R2A+R4R (continued)

Card type	Slot priority	Maximum number of cards
Foxconn (H965e DIB External Adapter)	3	1

Table 166. Configuration 10-1: R1P+R2A+R4R (HL)

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	8	1
Inventec (Serial)	8	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	7, 2	2
Inventec (LOM Card)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755N)	Integrated slot	1
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
NVIDIA (GPU L4)	2	1
Intel (GPU ATS-M)	7, 2	2
NVIDIA (GPU A2)	7, 2	2
Mellanox (FH NIC: NDR200)	2	1
Mellanox (LP NIC: NDR200)	3	1
Mellanox (NIC: NDR400)	2	1
Mellanox (NIC: HDR100 VPI)	2	1
Mellanox (NIC: HDR100 VPI)	3	1
Mellanox (FH NIC: HDR VPI), 2P	2	1
Mellanox (LP NIC: HDR VPI), 2P	3	1
Mellanox (FH NIC: HDR VPI), 1P	2	1

Table 166. Configuration 10-1: R1P+R2A+R4R (HL) (continued)

Card type	Slot priority	Maximum number of cards
Mellanox (LP NIC: HDR VPI), 1P	3	1
Mellanox (NIC: 100Gb)	2	1
Mellanox (NIC: 100Gb)	3	1
Broadcom (NIC: 100Gb)	3	1
Intel (NIC: 100Gb)	2	1
Intel (NIC: 100Gb)	3	1
Intel (NIC: 100Gb)	2	1
Intel (NIC: 25Gb)	2	1
Intel (NIC: 25Gb)	2	1
Broadcom (NIC: 25Gb)	7, 2	2
Intel (NIC: 10Gb)	2	1
Mellanox (NIC: 25Gb)	7, 2	2
Mellanox (NIC: 25Gb)	3	1
Intel (NIC: 25Gb)	7, 2	2
Intel (NIC: 25Gb)	7, 2	2
Intel (NIC: 25Gb)	3	1
Broadcom (Emulex) (HBA: FC64)	7, 2	2
Broadcom (Emulex) (HBA: FC64)	3	1
Qlogic (Marvell) (HBA: FC32)	2	1
Broadcom (Emulex) (HBA: FC32)	7, 2	2
Broadcom (Emulex) (HBA: FC32)	3	1
Broadcom (Emulex) (HBA: FC32)	7, 2	2
Broadcom (Emulex) (HBA: FC32)	3	1
Qlogic (Marvell) (HBA: FC32)	7, 2	2
Qlogic (Marvell) (HBA: FC32)	3	1
Qlogic (Marvell) (HBA: FC32)	7, 2	2
Qlogic (Marvell) (HBA: FC32)	3	1
Intel (NIC: ACC100)	3	1
Broadcom (NIC: 25Gb)	7, 2	2
Broadcom (NIC: 25Gb)	3	1
Broadcom (NIC: 10Gb)	7, 2	2
Broadcom (NIC: 10Gb)	3	1
Broadcom (NIC: 10Gb)	7, 3, 2	3
Broadcom (NIC: 10Gb)	7, 2	2
Broadcom (NIC: 10Gb)	3	1
Intel (NIC: 10Gb)	7, 2	2
Intel (NIC: 10Gb)	3	1

Table 166. Configuration 10-1: R1P+R2A+R4R (HL) (continued)

Card type	Slot priority	Maximum number of cards
Intel (NIC: 10Gb)	7, 2	2
Intel (NIC: 10Gb)	3	1
Intel (NIC: 1Gb)	7, 2	2
Intel (NIC: 1Gb)	3	1
Intel (NIC: 1Gb)	7, 2	2
Intel (NIC: 1Gb)	3	1
Broadcom (NIC: 1Gb)	7, 2	2
Broadcom (NIC: 1Gb)	3	1
Foxconn (HBA355e DIB External Adapter)	7, 3, 2	3
Foxconn (H965e DIB External Adapter)	3, 2	1

Table 167. Configuration 10-2: R1P+R2A+R4R (FL)

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	8	1
Inventec (Serial)	8	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	7, 2	2
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	2
Foxconn (Front PERC11 H755N)	Integrated slot	1
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Intel (GPU PVC)	2	1
NVIDIA (GPU H100)	2	1

Table 167. Configuration 10-2: R1P+R2A+R4R (FL) (continued)

Card type	Slot priority	Maximum number of cards
NVIDIA (GPU L40S)	2	1
NVIDIA (GPU L40)	2	1
NVIDIA (GPU A40)	2	1
NVIDIA (GPU A800)	2	1
NVIDIA (GPU A100)	2	1
NVIDIA (GPU A30)	2	1
NVIDIA (GPU A16)	2	1
NVIDIA (GPU L4)	2	1
Intel (GPU ATS-M)	7, 2	2
NVIDIA (GPU A2)	7, 2	2
Mellanox (FH NIC: NDR200)	2	1
Mellanox (LP NIC: NDR200)	3	1
Mellanox (NIC: NDR400)	2	1
Mellanox (NIC: HDR100 VPI)	2	1
Mellanox (NIC: HDR100 VPI)	3	1
Mellanox (FH NIC: HDR VPI), 2P	2	1
Mellanox (LP NIC: HDR VPI), 2P	3	1
Mellanox (FH NIC: HDR VPI), 1P	2	1
Mellanox (LP NIC: HDR VPI), 1P	3	1
Mellanox (NIC: 100Gb)	2	1
Mellanox (NIC: 100Gb)	3	1
Broadcom (NIC: 100Gb)	3	1
Intel (NIC: 100Gb)	2	1
Intel (NIC: 100Gb)	3	1
Intel (NIC: 100Gb)	2	1
Intel (NIC: 25Gb)	2	1
Intel (NIC: 25Gb)	2	1
Broadcom (NIC: 25Gb)	7, 2	2
Intel (NIC: 10Gb)	2	1
Mellanox (NIC: 25Gb)	7, 2	2
Mellanox (NIC: 25Gb)	3	1
Intel (NIC: 25Gb)	7, 2	2
Intel (NIC: 25Gb)	7, 2	2
Intel (NIC: 25Gb)	3	1
Broadcom (Emulex) (HBA: FC64)	7, 2	2
Broadcom (Emulex) (HBA: FC64)	3	1
Qlogic (Marvell) (HBA: FC32)	2	1

Table 167. Configuration 10-2: R1P+R2A+R4R (FL) (continued)

Card type	Slot priority	Maximum number of cards
Broadcom (Emulex) (HBA: FC32)	7, 2	2
Broadcom (Emulex) (HBA: FC32)	3	1
Broadcom (Emulex) (HBA: FC32)	7, 2	2
Broadcom (Emulex) (HBA: FC32)	3	1
Qlogic (Marvell) (HBA: FC32)	7, 2	2
Qlogic (Marvell) (HBA: FC32)	3	1
Qlogic (Marvell) (HBA: FC32)	7, 2	2
Qlogic (Marvell) (HBA: FC32)	3	1
Intel (NIC: ACC100)	3	1
Broadcom (NIC: 25Gb)	7, 2	2
Broadcom (NIC: 25Gb)	3	1
Broadcom (NIC: 10Gb)	7, 2	2
Broadcom (NIC: 10Gb)	3	1
Broadcom (NIC: 10Gb)	7, 3, 2	3
Broadcom (NIC: 10Gb)	7, 2	2
Broadcom (NIC: 10Gb)	3	1
Intel (NIC: 10Gb)	7, 2	2
Intel (NIC: 10Gb)	3	1
Intel (NIC: 10Gb)	7, 2	2
Intel (NIC: 10Gb)	3	1
Intel (NIC: 1Gb)	7, 2	2
Intel (NIC: 1Gb)	3	1
Intel (NIC: 1Gb)	7, 2	2
Intel (NIC: 1Gb)	3	1
Broadcom (NIC: 1Gb)	7, 2	2
Broadcom (NIC: 1Gb)	3	1
Foxconn (HBA355e DIB External Adapter)	7, 3, 2	3
Foxconn (H965e DIB External Adapter)	3, 2	1

Table 168. Configuration 11: R1 paddle+R2A+R3B+R4 paddle

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	8, 4	1
Inventec (Serial)	8, 4	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	5, 4	2
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1

Table 168. Configuration 11: R1 paddle+R2A+R3B+R4 paddle (continued)

Card type	Slot priority	Maximum number of cards
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Intel (GPU ATS-M)	4, 5	2
NVIDIA (GPU A2)	4, 5	2
Mellanox (LP NIC: NDR200)	6, 3	2
Mellanox (NIC: HDR100 VPI)	6, 3	2
Mellanox (LP NIC: HDR VPI), 2P	6, 3	2
Mellanox (LP NIC: HDR VPI), 1P	6, 3	2
Mellanox (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 100Gb)	6, 3	2
Intel (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 25Gb)	5, 4	2
Mellanox (NIC: 25Gb)	5, 4	2
Mellanox (NIC: 25Gb)	6, 3	2
Intel (NIC: 25Gb)	5, 4	2
Intel (NIC: 25Gb)	5, 4	2
Intel (NIC: 25Gb)	6, 3	2
Broadcom (Emulex) (HBA: FC64)	5, 4	2
Broadcom (Emulex) (HBA: FC64)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	5, 4	2
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	5, 4	2
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	5, 4	2
Qlogic (Marvell) (HBA: FC32)	6, 3	2

Table 168. Configuration 11: R1 paddle+R2A+R3B+R4 paddle (continued)

Card type	Slot priority	Maximum number of cards
Qlogic (Marvell) (HBA: FC32)	5, 4	2
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Intel (NIC: ACC100)	6, 3	2
Broadcom (NIC: 25Gb)	5, 4	2
Broadcom (NIC: 25Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4	2
Broadcom (NIC: 10Gb)	6, 3	2
Broadcom (NIC: 10Gb)	5, 4, 6, 3	4
Broadcom (NIC: 10Gb)	5, 4	2
Broadcom (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 4	2
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	5, 4	2
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4	2
Intel (NIC: 1Gb)	6, 3	2
Intel (NIC: 1Gb)	5, 4	2
Intel (NIC: 1Gb)	6, 3	2
Broadcom (NIC: 1Gb)	5, 4	2
Broadcom (NIC: 1Gb)	6, 3	2
Foxconn (HBA355e DIB External Adapter)	5, 4, 6, 3	4
Foxconn (H965e DIB External Adapter)	6, 3	1

Table 169. Configuration 12: R1Q+R2A+R4Q

Card type	Slot priority	Maximum number of cards
Inventec (VGA)	8	1
Inventec (Serial)	8	1
Mellanox (NVIDIA) (Channel DPU: 25Gb)	7, 1, 2	3
Inventec (LOM Card)	Integrated slot	1
Broadcom (OCP: 100Gb)	Integrated slot	1
Mellanox (OCP: 100Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Mellanox (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 25Gb)	Integrated slot	1
Broadcom (OCP: 25Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1

Table 169. Configuration 12: R1Q+R2A+R4Q (continued)

Card type	Slot priority	Maximum number of cards
Broadcom (OCP: 10Gb)	Integrated slot	1
Intel (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 10Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Broadcom (OCP: 1Gb)	Integrated slot	1
Intel (OCP: 1Gb)	Integrated slot	1
Foxconn (BOSS)	Integrated slot	1
Foxconn (Front PERC12 HBA465i)	Integrated slot	1
Foxconn (Front PERC12 H965i)	Integrated slot	1
Foxconn (Front PERC11 H755)	Integrated slot	1
Foxconn (Front PERC11 H355)	Integrated slot	1
Foxconn (Front PERC11 HBA355i)	Integrated slot	1
Foxconn (PERC Adapter11 H755)	3	1
Foxconn (PERC Adapter11 HBA355i)	3	1
Foxconn (PERC Adapter11 H355)	3	1
Mellanox (LP NIC: NDR200)	6, 3	2
Mellanox (NIC: HDR100 VPI)	6, 3	2
Mellanox (LP NIC: HDR VPI), 2P	6, 3	2
Mellanox (LP NIC: HDR VPI), 1P	6, 3	2
Mellanox (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 100Gb)	6, 3	2
Broadcom (NIC: 25Gb)	7, 1, 2	3
Intel (NIC: 100Gb)	6, 3	2
Mellanox (NIC: 25Gb)	7, 1, 2	3
Mellanox (NIC: 25Gb)	6, 3	2
Intel (NIC: 25Gb)	7, 1, 2	3
Intel (NIC: 25Gb)	7, 1, 2	3
Intel (NIC: 25Gb)	6, 3	2
Broadcom (Emulex) (HBA: FC64)	7, 1, 2	3
Broadcom (Emulex) (HBA: FC64)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	7, 1, 2	3
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Broadcom (Emulex) (HBA: FC32)	7, 1, 2	3
Broadcom (Emulex) (HBA: FC32)	6, 3	2
Qlogic (Marvell) (HBA: FC32)	7, 1, 2	3
Qlogic (Marvell) (HBA: FC32)	6, 3	2

Table 169. Configuration 12: R1Q+R2A+R4Q (continued)

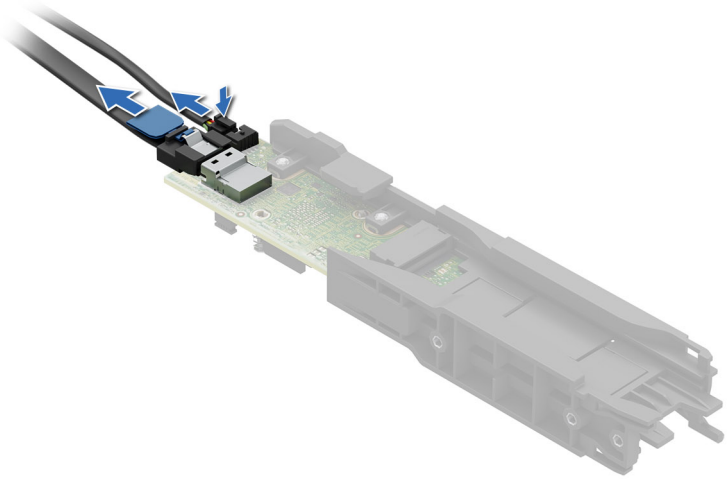
Card type	Slot priority	Maximum number of cards
Qlogic (Marvell) (HBA: FC32)	7, 1, 2	3
Qlogic (Marvell) (HBA: FC32)	6, 3	2
Intel (NIC: ACC100)	6, 3	2
Broadcom (NIC: 25Gb)	7, 1, 2	3
Broadcom (NIC: 25Gb)	6, 3	2
Broadcom (NIC: 10Gb)	7, 1, 2	3
Broadcom (NIC: 10Gb)	6, 3	2
Broadcom (NIC: 10Gb)	7, 1, 2, 6, 3	5
Broadcom (NIC: 10Gb)	7, 1, 2	3
Broadcom (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	7, 1, 2	3
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 10Gb)	7, 1, 2	3
Intel (NIC: 10Gb)	6, 3	2
Intel (NIC: 1Gb)	7, 1, 2	3
Intel (NIC: 1Gb)	6, 3	2
Intel (NIC: 1Gb)	7, 1, 2	3
Intel (NIC: 1Gb)	6, 3	2
Broadcom (NIC: 1Gb)	7, 1, 2	3
Broadcom (NIC: 1Gb)	6, 3	2
Foxconn (HBA355e DIB External Adapter)	7, 1, 2, 6, 3	5
Foxconn (H965e DIB External Adapter)	6, 3	1

Removing the expansion card risers

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4.

NOTE: If BOSS-N1 module is installed, be sure to disconnect the BOSS-N1 power cable and Signal cable before removing the Riser 1 cage.



5. If applicable, disconnect the cables from the expansion card or system board.

Steps

1. Loosen the captive screws on the riser and system.
2. Press the blue release tab or blue button on the riser and holding the edges lift the expansion card riser from the riser connector on the system board.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

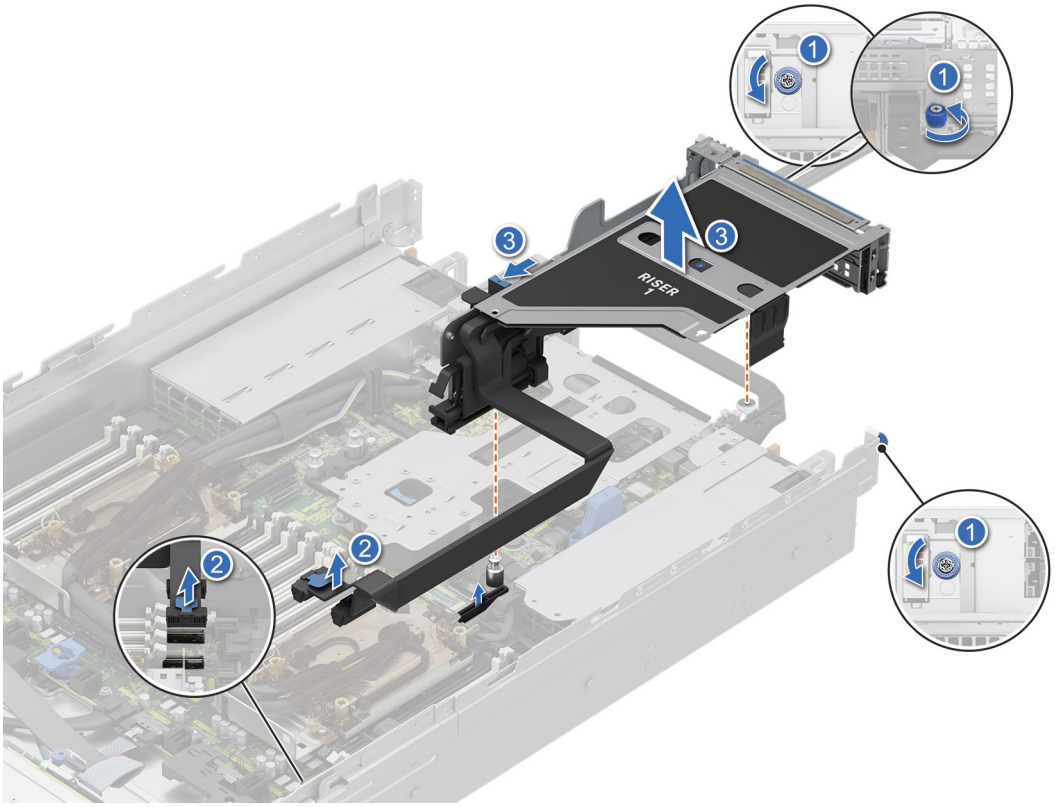


Figure 223. Removing the expansion card riser 1

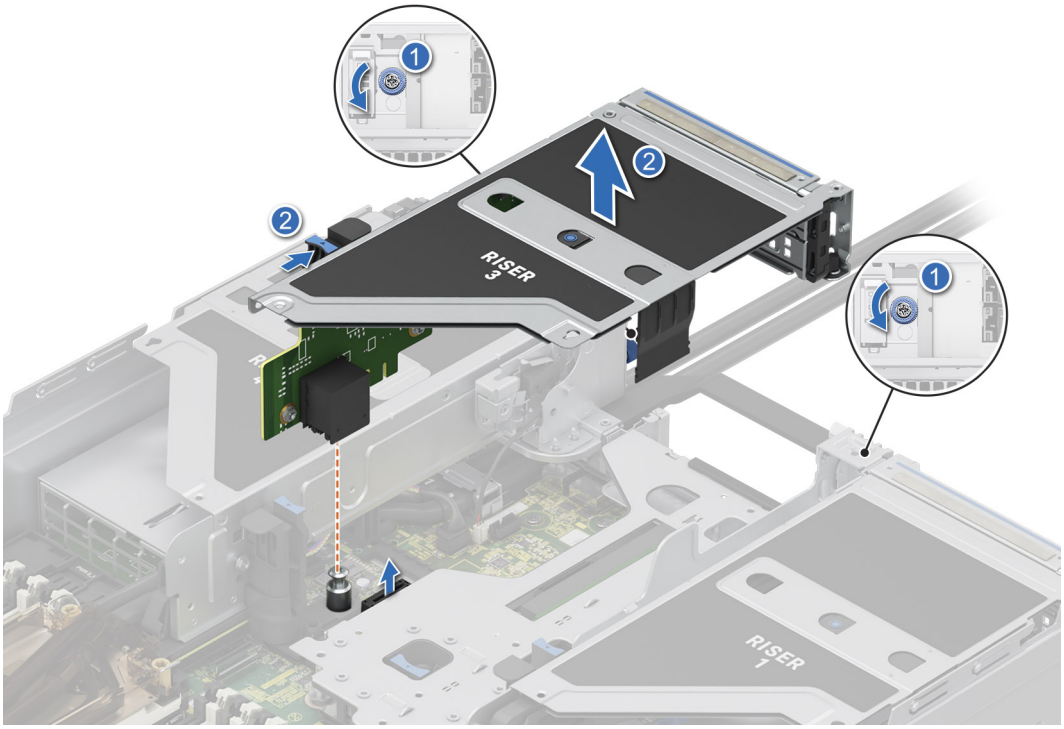


Figure 224. Removing the expansion card riser 3

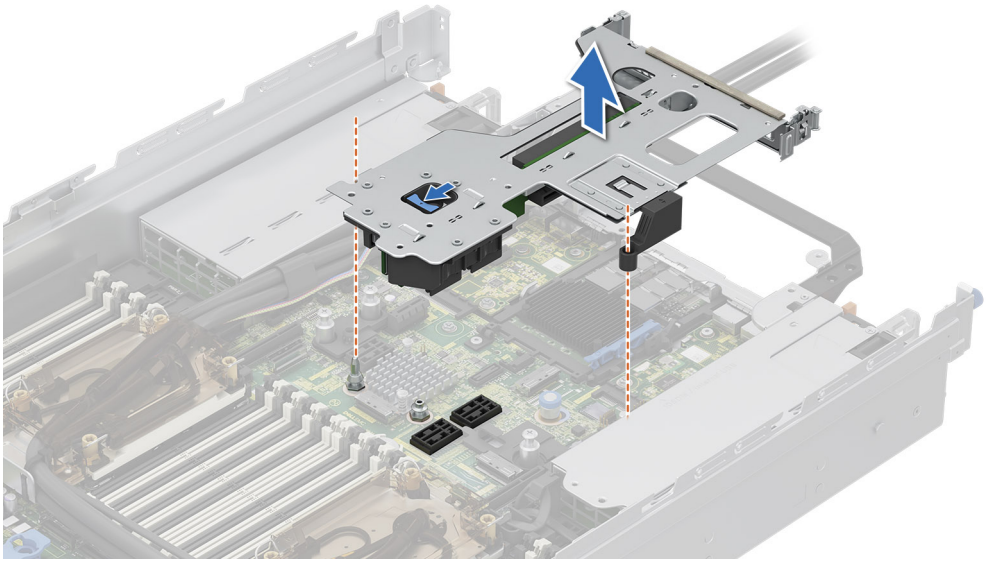


Figure 225. Removing the expansion card riser 2

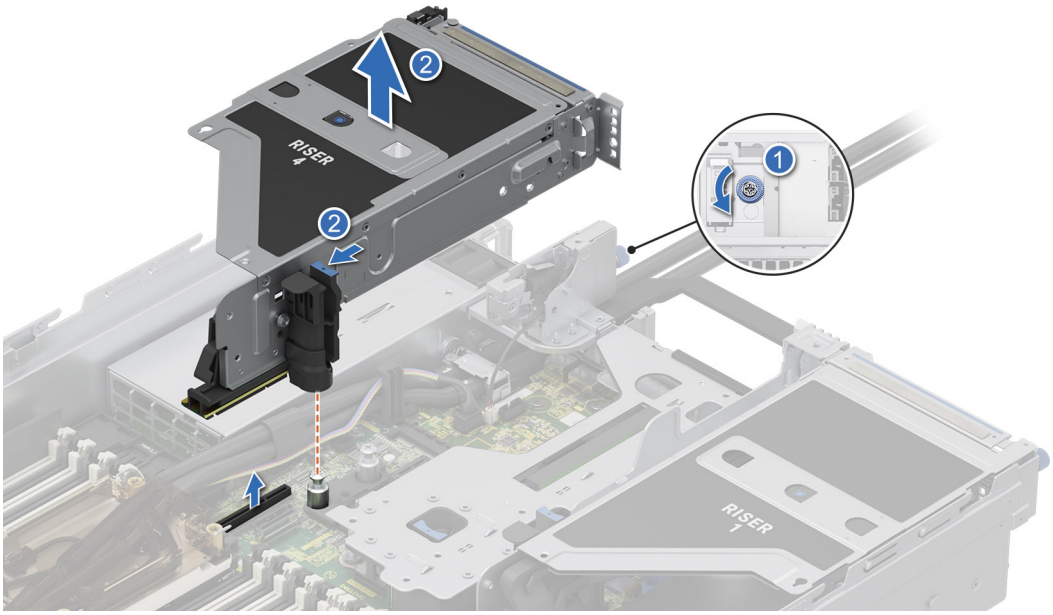


Figure 226. Removing the expansion card riser 4

3. If the risers are not going to be replaced, install riser blanks, and if required tighten the captive screws.

NOTE: You must install a filler bracket over an empty expansion card slot to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

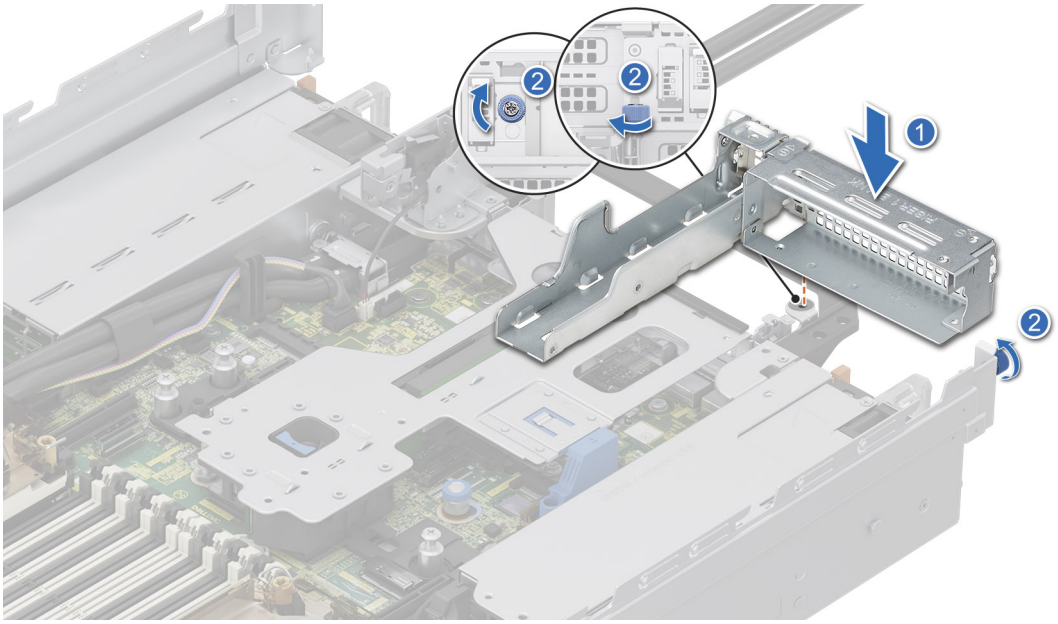


Figure 227. Installing the Riser 1 blank

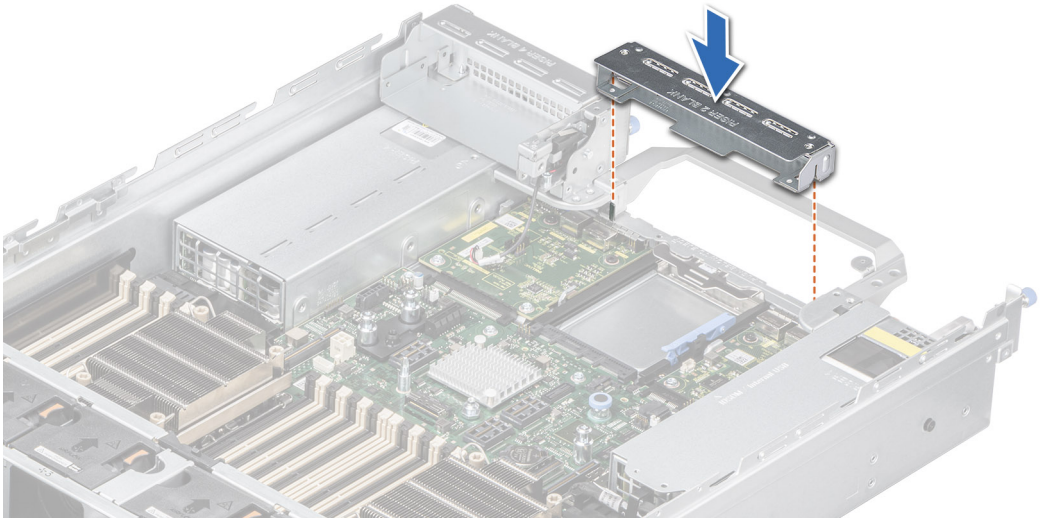


Figure 228. Installing the Riser 2 blank

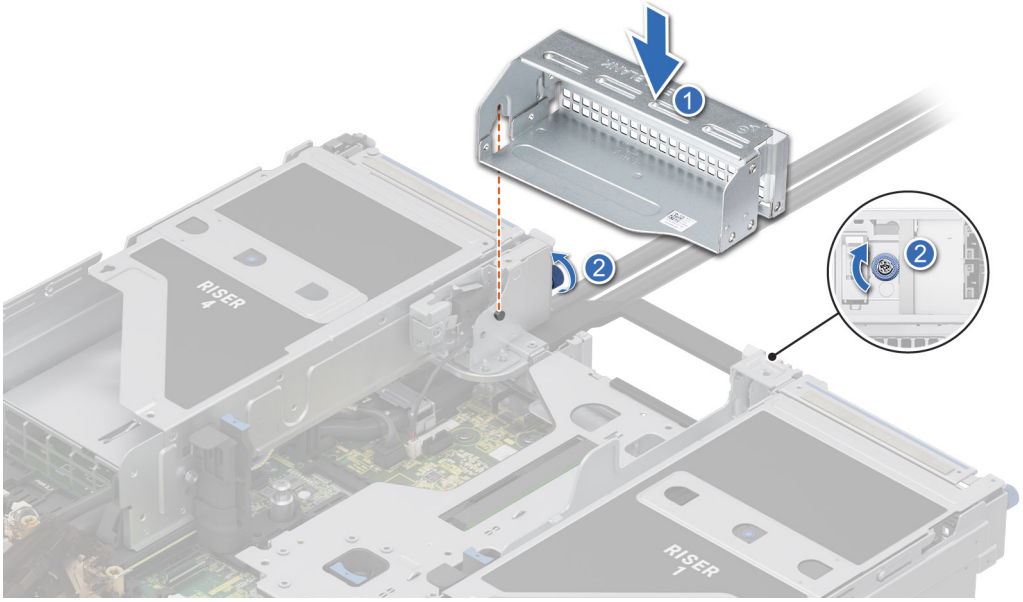


Figure 229. Installing the Riser 3 blank

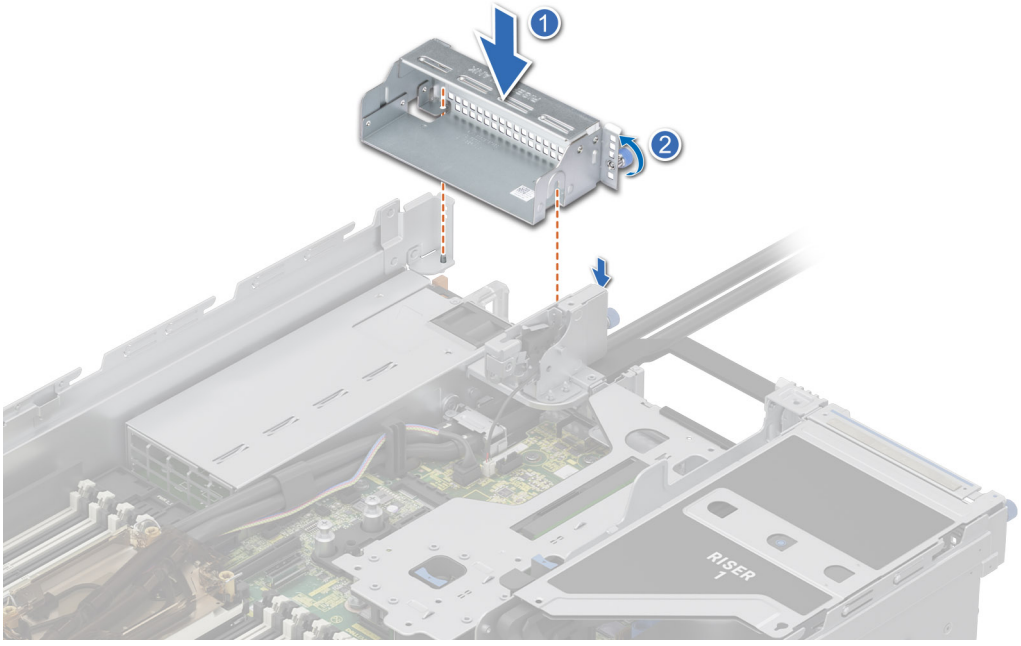


Figure 230. Installing the Riser 4 blank

Next steps

1. Replace the expansion card riser.

Installing the expansion card risers

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. If removed, install the expansion cards into the expansion card risers.

NOTE: Install Riser 2 before installing Riser 1 and Riser 3. Install Riser 4 after installing Riser 3.

CAUTION: Do not install GPUs, network cards, or other PCIe devices on your system that are not validated and tested by Dell. Damage caused by unauthorized and invalidated hardware installation will null and void the system warranty.

Steps

1. If installed, remove the riser blanks and if required loosen the captive screws.

   NOTE: Store the riser blanks for future use. Filler brackets must be installed in empty expansion card slots to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

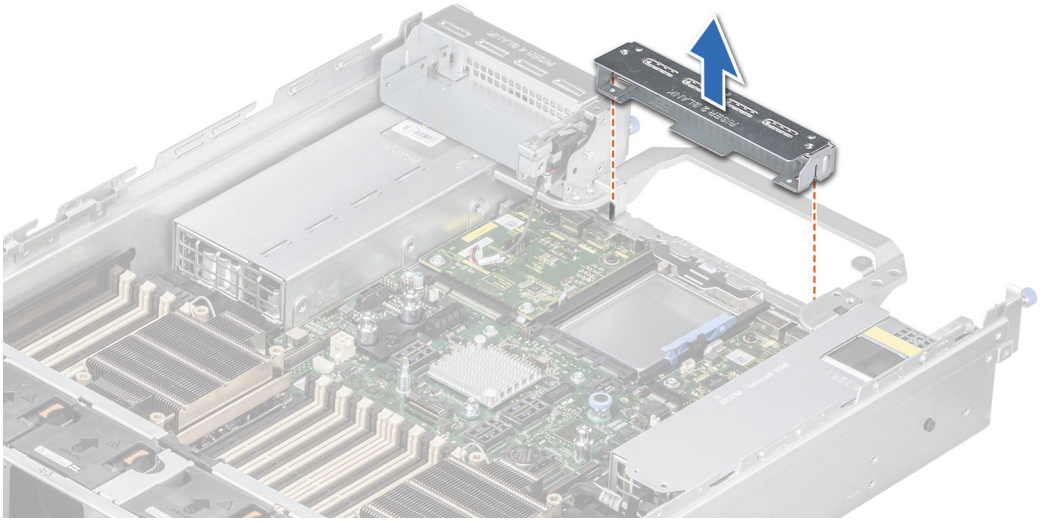


Figure 231. Removing the Riser 2 blank

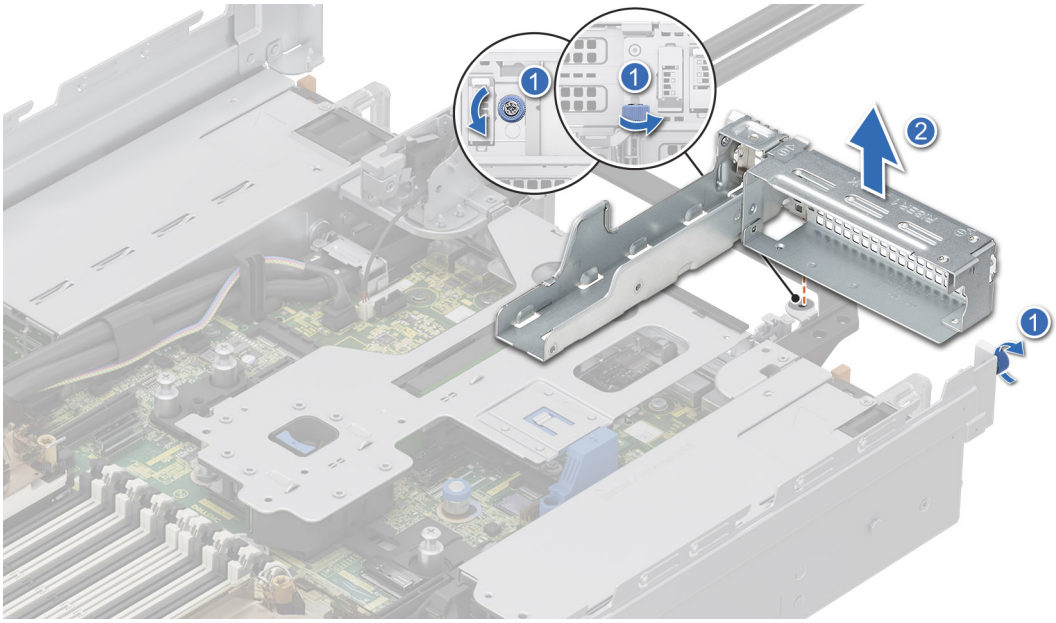


Figure 232. Removing the Riser 1 blank

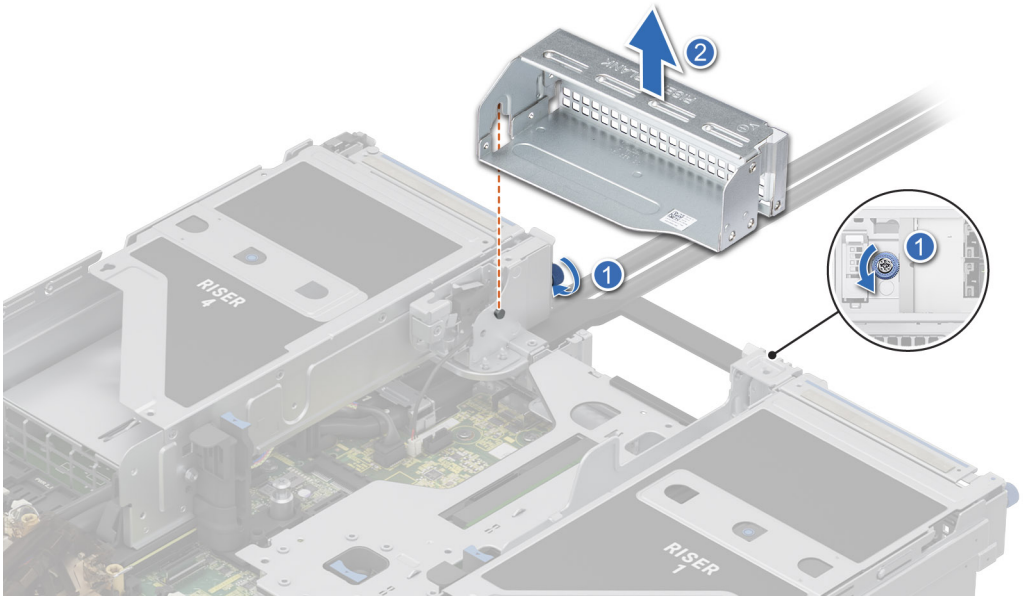


Figure 233. Removing the Riser 3 blank

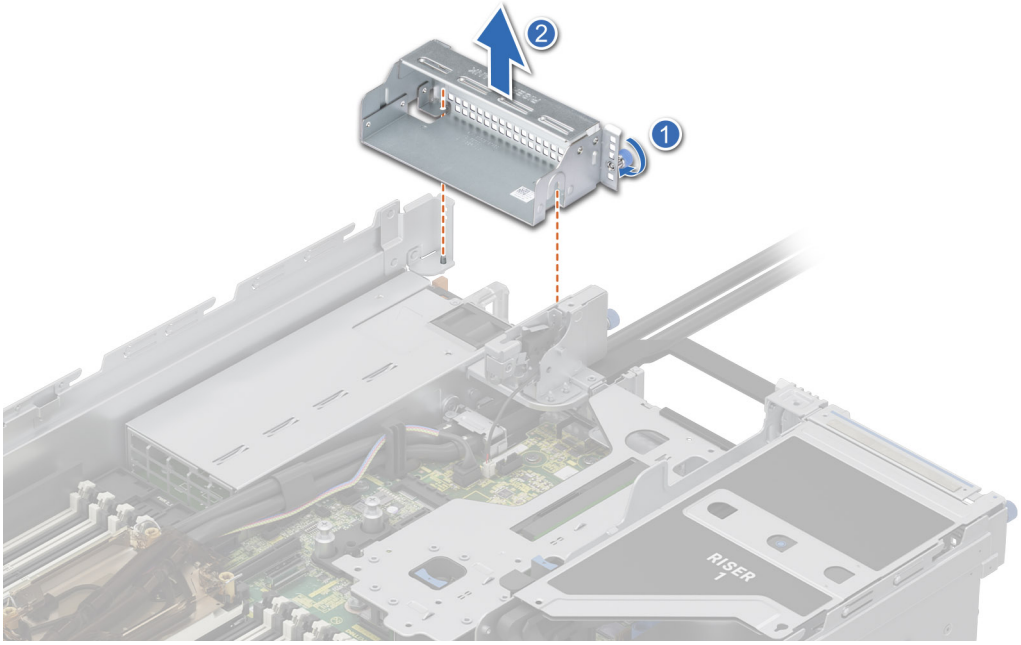


Figure 234. Removing the Riser 4 blank

2. Holding the edges or the touch points, align the holes on the expansion card riser with the guides on the system board.
3. Lower the expansion card riser into place and press the touch points until the expansion card riser connector is fully seated on the system board connector.
4. Tighten the captive screws on the risers and system if any.

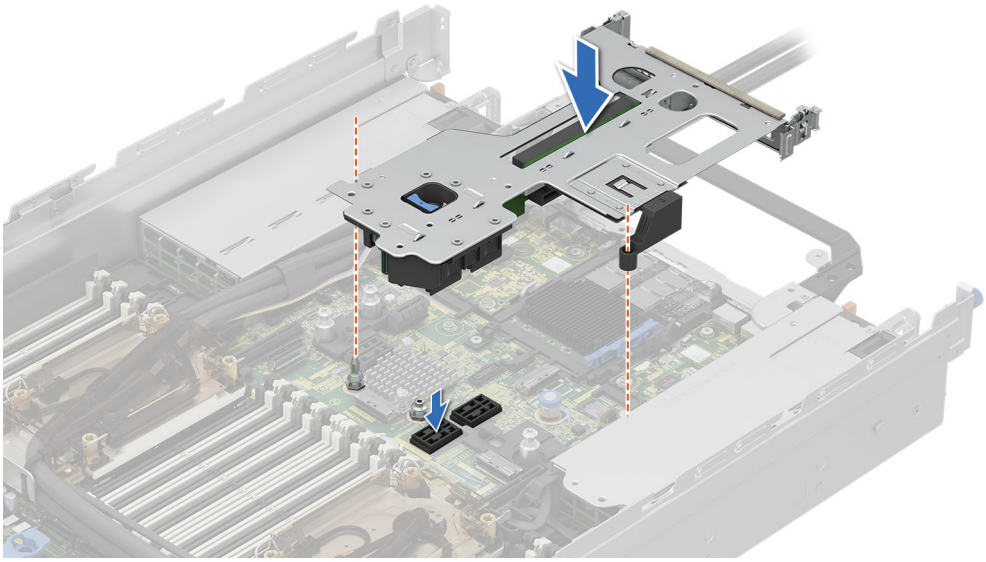


Figure 235. Installing the expansion card riser 2

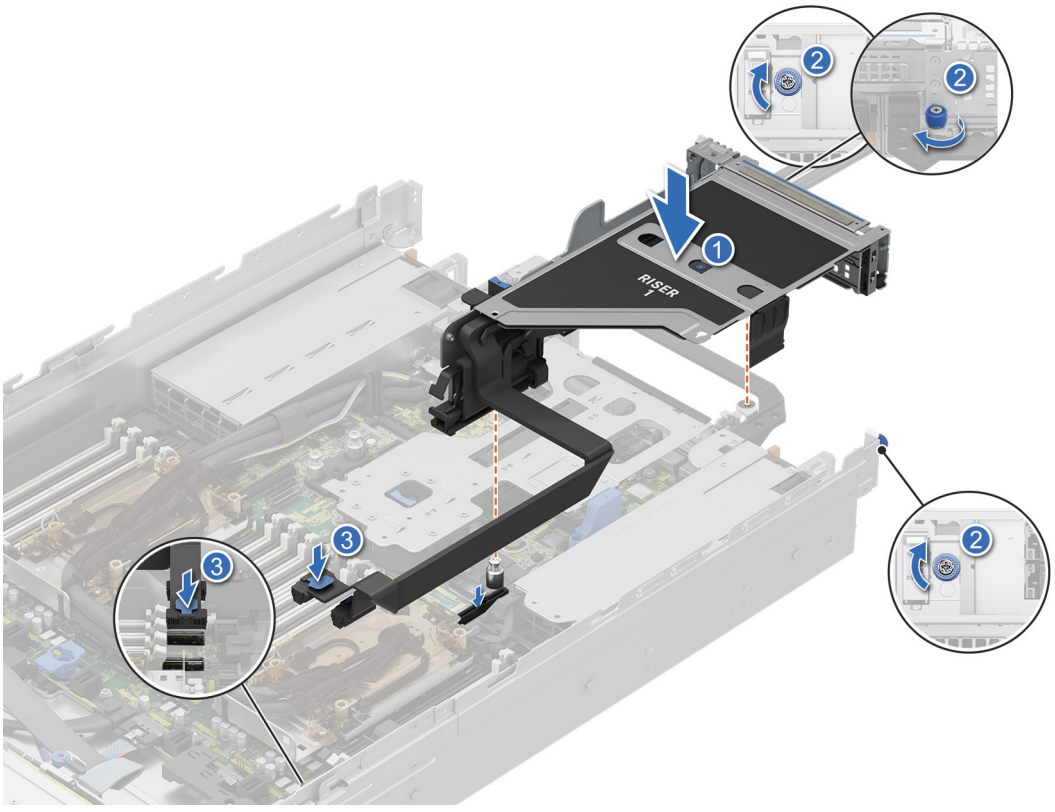


Figure 236. Installing the expansion card riser 1

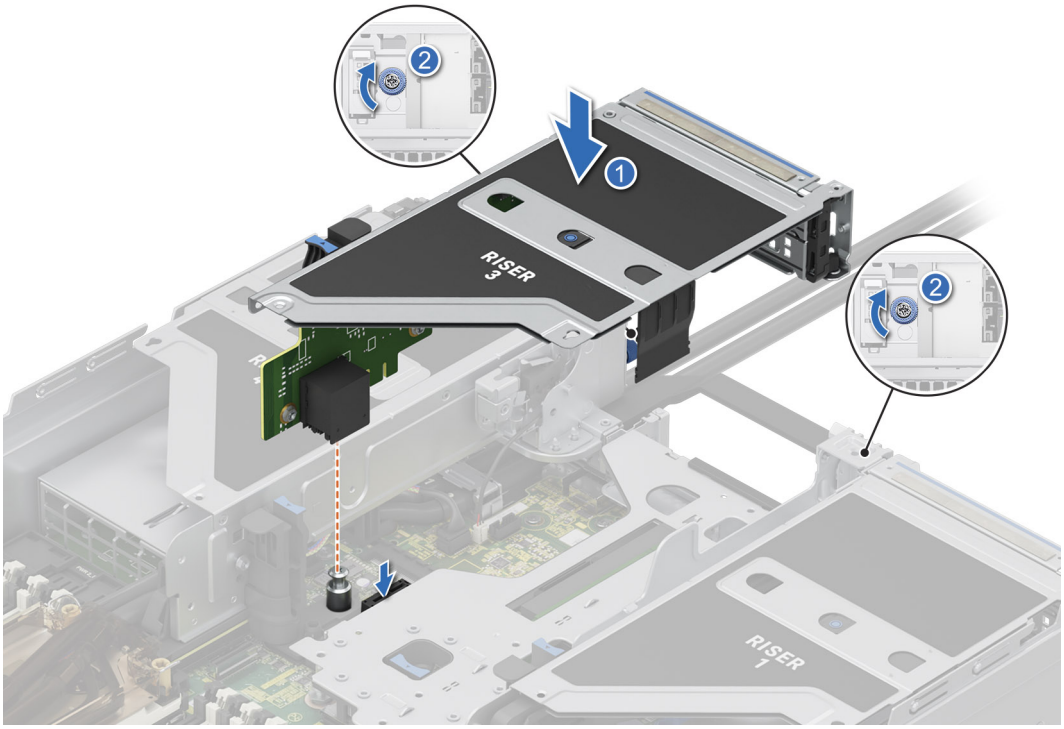


Figure 237. Installing the expansion card riser 3

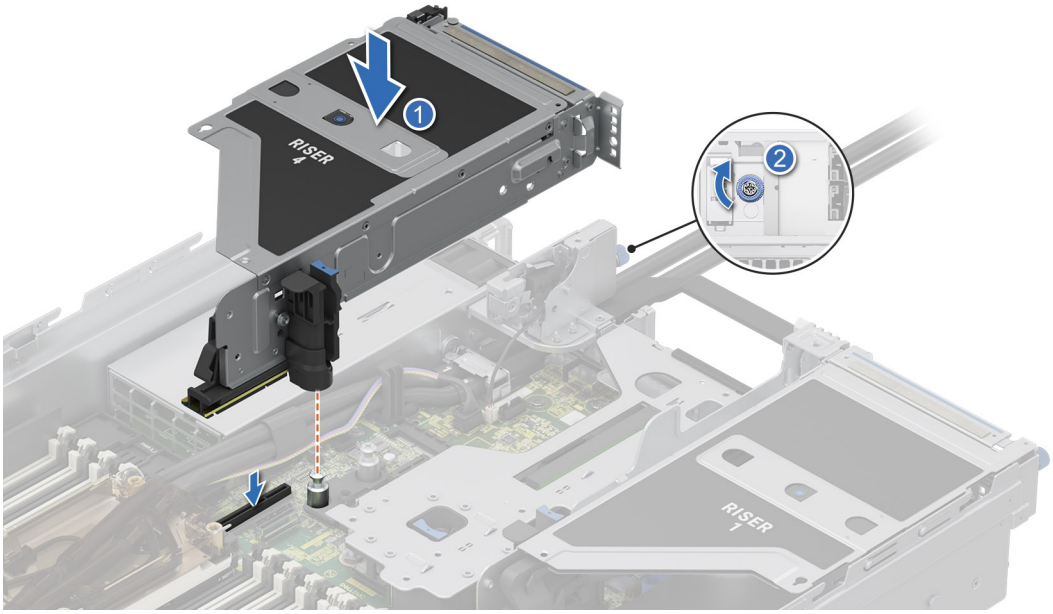


Figure 238. Installing the expansion card riser 4

Next steps

1. If required, reconnect the cables to the expansion card or system board.
2. Install the air shroud or install the GPU air shroud.
3. Follow the procedure listed in After working inside your system.
4. Install any device drivers required for the card as described in the documentation for the card.

Removing expansion card from the expansion card riser

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. If applicable, disconnect the cables from the expansion card.
4. Remove the air shroud or remove the GPU air shroud.
5. Remove the expansion card riser.

Steps

1. Tilt the expansion card retention latch lock to open.
2. Pull the card holder before removing the card from the riser.
3. Hold the expansion card by the edges and pull the card from the riser.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

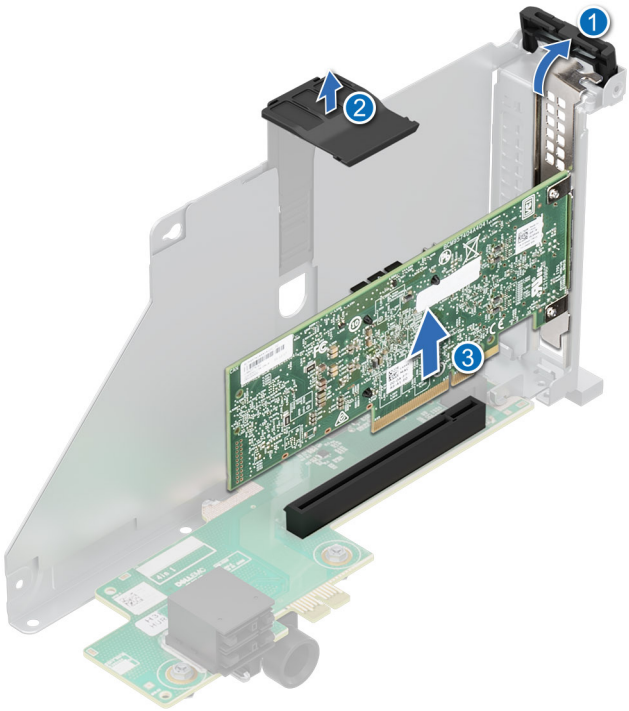


Figure 239. Removing expansion card from the expansion card riser

4. If the expansion card is not going to be replaced, install a filler bracket and close the card retention latch.

NOTE: You must install a filler bracket over an empty expansion card slot to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

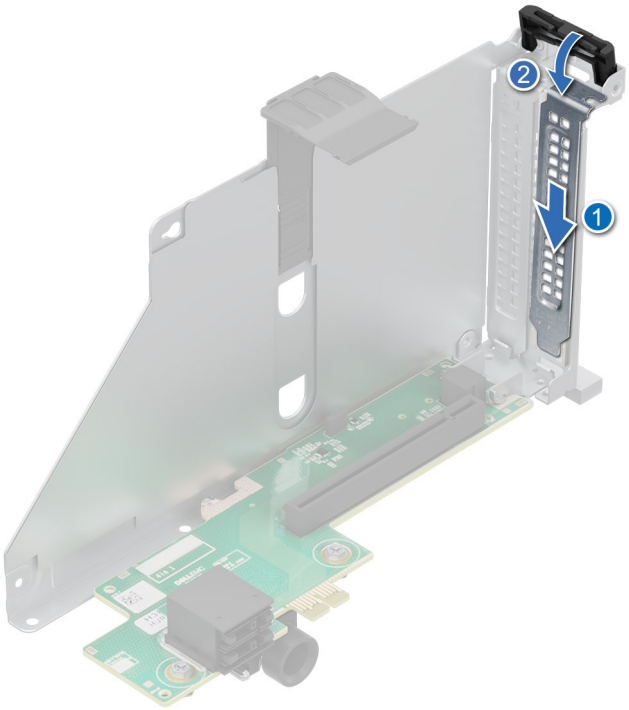


Figure 240. Installing the filler bracket

Next steps

1. If applicable, install an expansion card into the expansion card riser.

Installing an expansion card into the expansion card riser

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. Remove the expansion card riser.
5. If installing a new expansion card, unpack it and prepare the card for installation.

NOTE: For instructions, see the documentation accompanying the card.

CAUTION: Do not install GPUs, network cards, or other PCIe devices on your system that are not validated and tested by Dell. Damage caused by unauthorized and invalidated hardware installation will null and void the system warranty.

Steps

1. Tilt the expansion card retention latch lock to open.
2. If installed, remove the filler bracket.

NOTE: Store the filler bracket for future use. Filler brackets must be installed in empty expansion card slots to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

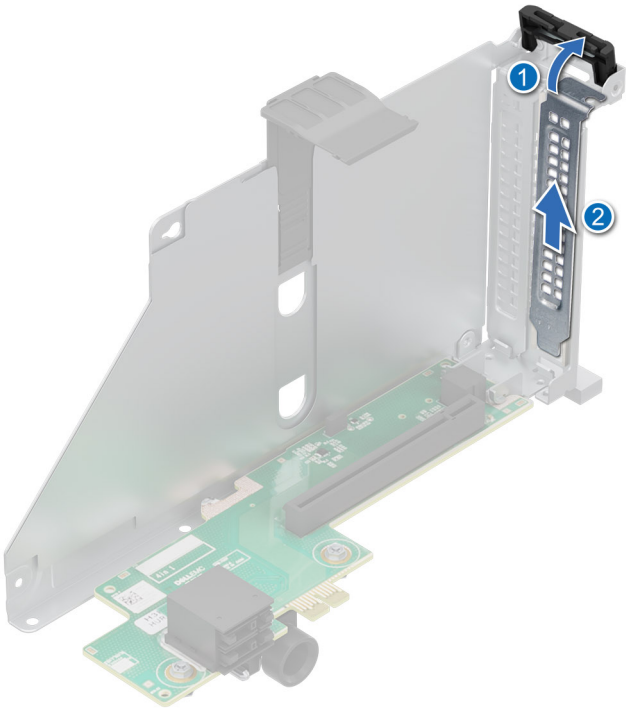


Figure 241. Removing the filler bracket

3. Hold the card by edges, and align the card with the connector on the riser.
4. Insert the card firmly into the expansion card connector until seated.
5. Close the expansion card retention latch.
6. Push the card holder to hold the card in the riser.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

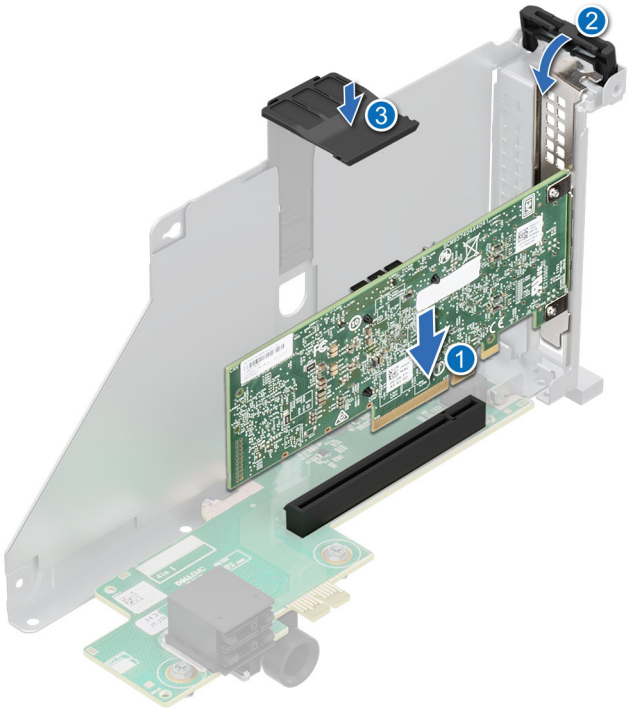


Figure 242. Installing an expansion card into the expansion card riser

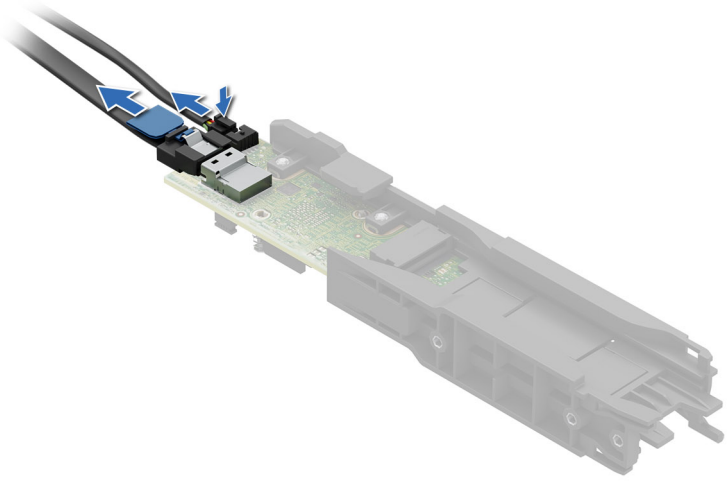
Next steps

1. If applicable, connect the cables to the expansion card.
2. Install the expansion card risers.
3. Install the air shroud or install the GPU air shroud.
4. Follow the procedure listed in After working inside your system.
5. Install any device drivers required for the card as described in the documentation for the card.

Removing the full length expansion card risers

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the GPU air shroud top cover.
4. If applicable, disconnect the cables from the expansion card or system board.
5. **NOTE:** If BOSS-N1 module is installed, be sure to disconnect the BOSS-N1 power cable and signal cable before removing the Riser 1 cage.



Steps

1. To remove full length expansion card riser:
   a. Loosen the captive screws on the riser.
   b. Press the blue release tab and holding the edges, lift the expansion card riser from the riser connector on the system board.
   c. Disconnect the GPU power cable and signal cable from the system board.

   NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

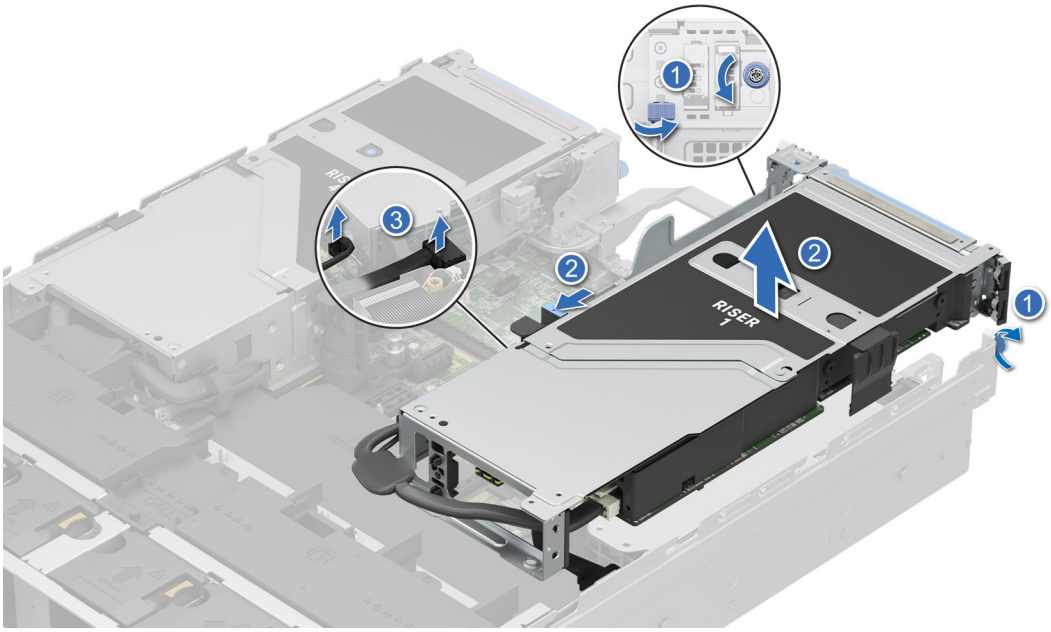


Figure 243. Removing the expansion card riser (Riser 1)

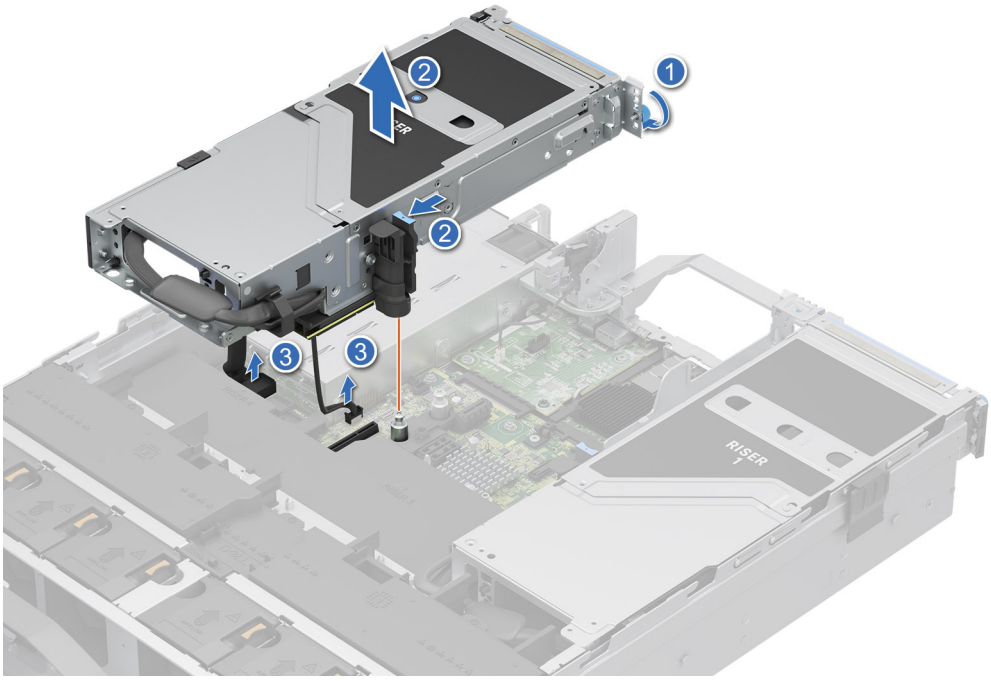


Figure 244. Removing the expansion card riser (Riser 4)

2. If the risers are not going to be replaced, install riser blanks and tighten the captive screws.

NOTE: You must install a filler bracket over an empty expansion card slot to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

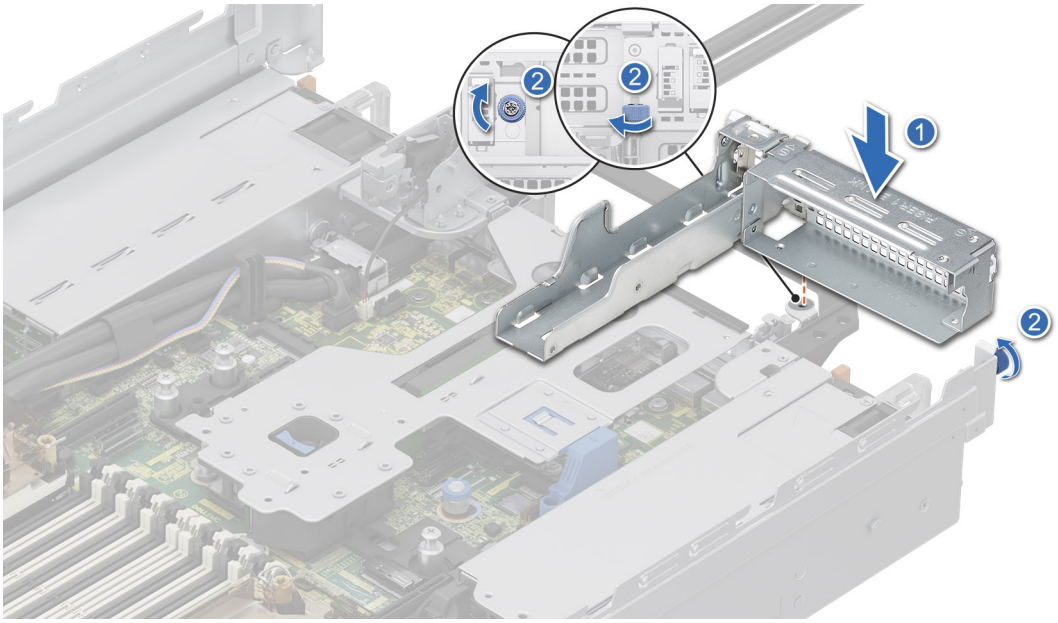


Figure 245. Installing the Riser 1 blank

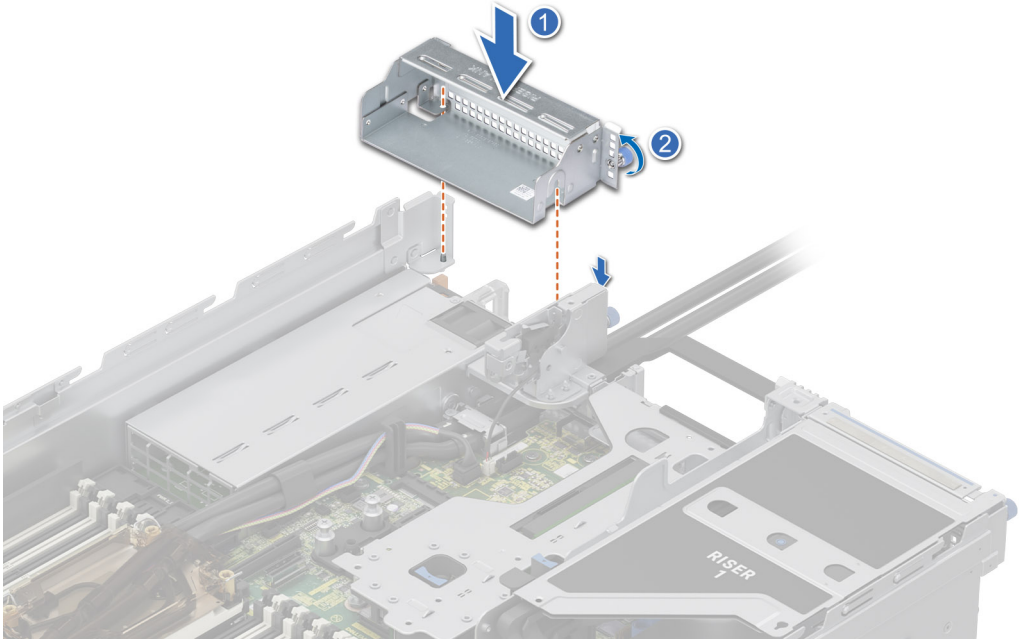


Figure 246. Installing the Riser 4 blank

Next steps

1. Replace the full length expansion card riser.

Installing the full length expansion card risers

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. If installing full length expansion card riser for the first time, remove the air shroud and replace it with the GPU air shroud.

4. Remove the GPU air shroud top cover.
5. If installed, remove the GPU air shroud filler.
6. If removed, install the GPU into the expansion card risers.

NOTE: Full length risers are supported only in Riser 1 and Riser 4 slot. Install Riser 4 first and then Riser 1.

Steps

1. If installed, remove the riser blanks by loosening the captive screws.

   NOTE: Store the Riser blanks for future use. Filler brackets must be installed in empty expansion card slots to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

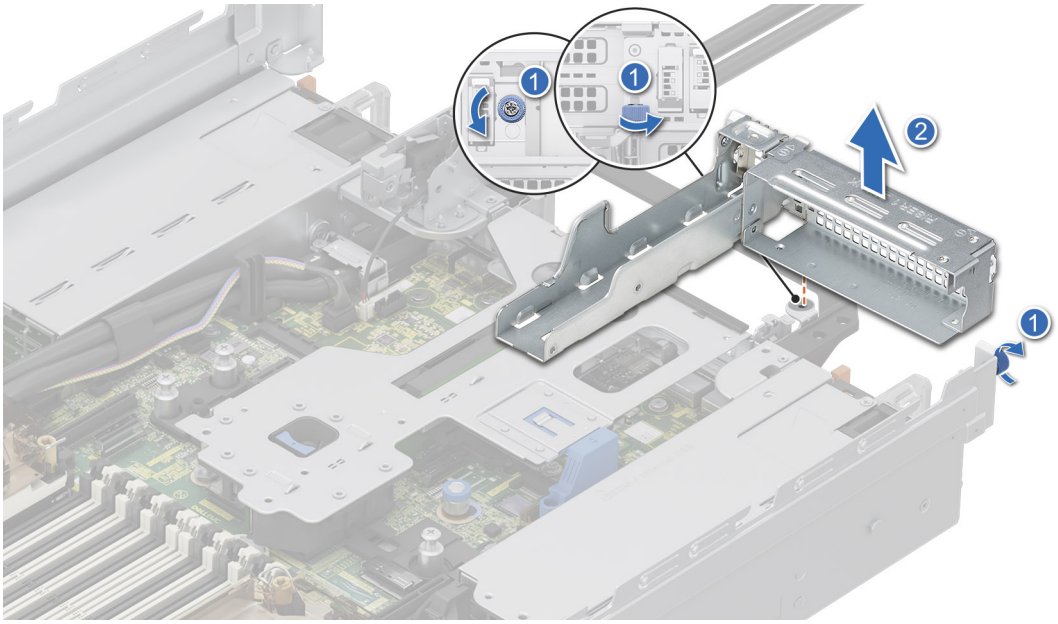


Figure 247. Removing the Riser 1 blank

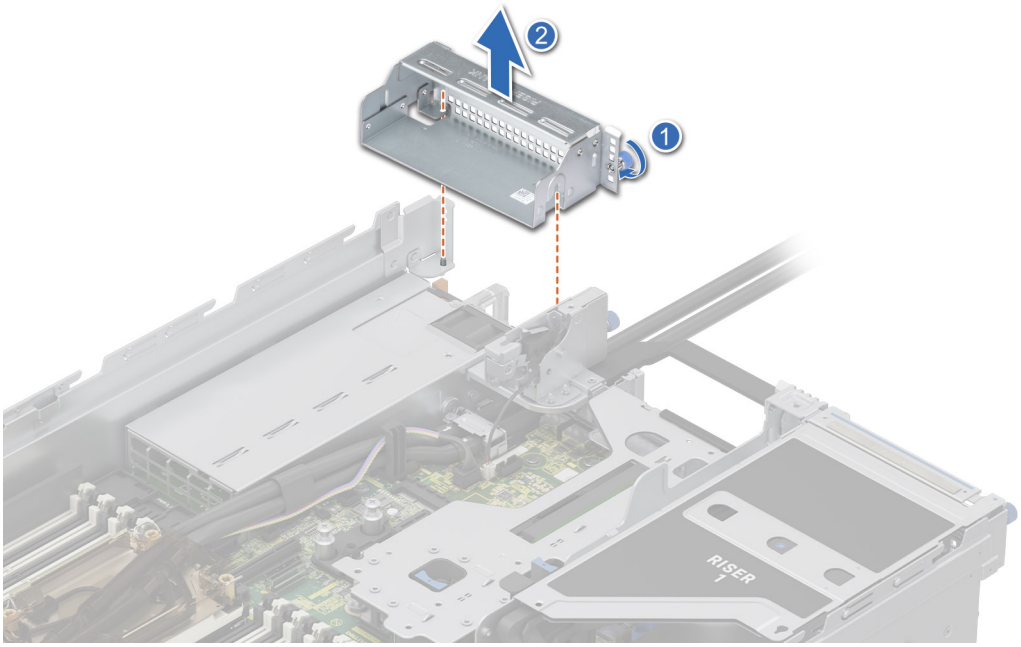


Figure 248. Removing the Riser 4 blank

2. To install the full length expansion card risers:
   a. For Riser 4 connect the GPU power cable to the connector PWR2_B and signal cable to the connector PSU2_SIG on the system board.
   b. For Riser 1 connect the GPU power cable to the connector PWR1_B and signal cable to the connector PSU1_SIG on the system board.

      NOTE: Temporarily unplug and plug the VGA cable for making space to connect Riser 1 GPU power cable to system board.

   c. Holding the edges or the touch points, align the holes on the expansion card riser with the guides on the system board and GPU air shroud.
   d. Lower the expansion card riser into place and press the touch points until the expansion card riser connector is fully seated on the system board connector.
   e. Tighten the captive screws on the risers and system if any.

      NOTE: Route the cables properly through the riser clip.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

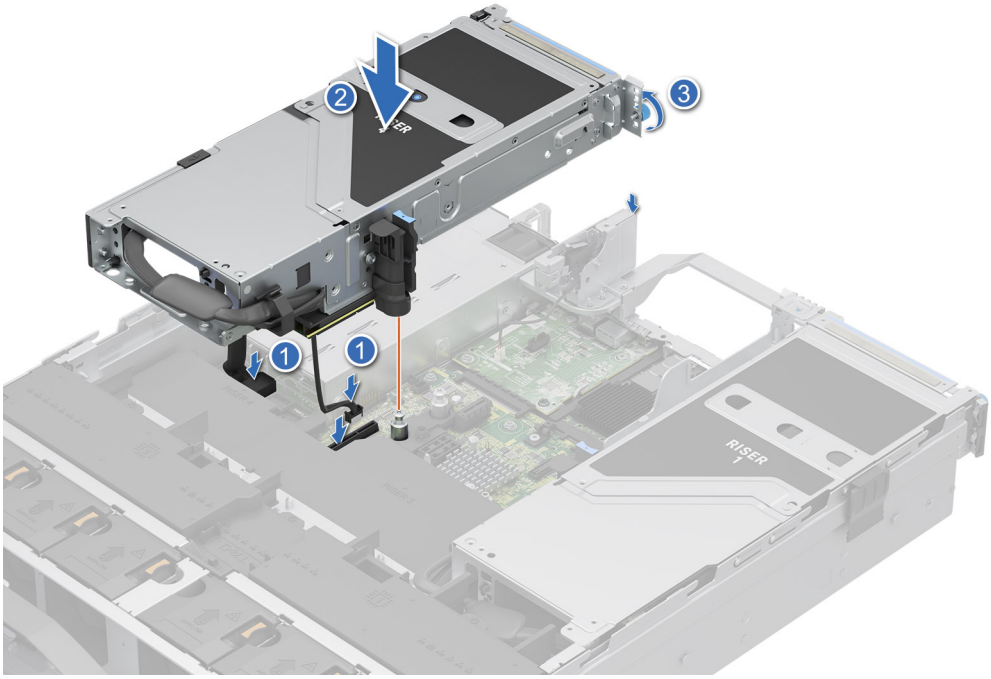


Figure 249. Installing the expansion card riser (Riser 4)

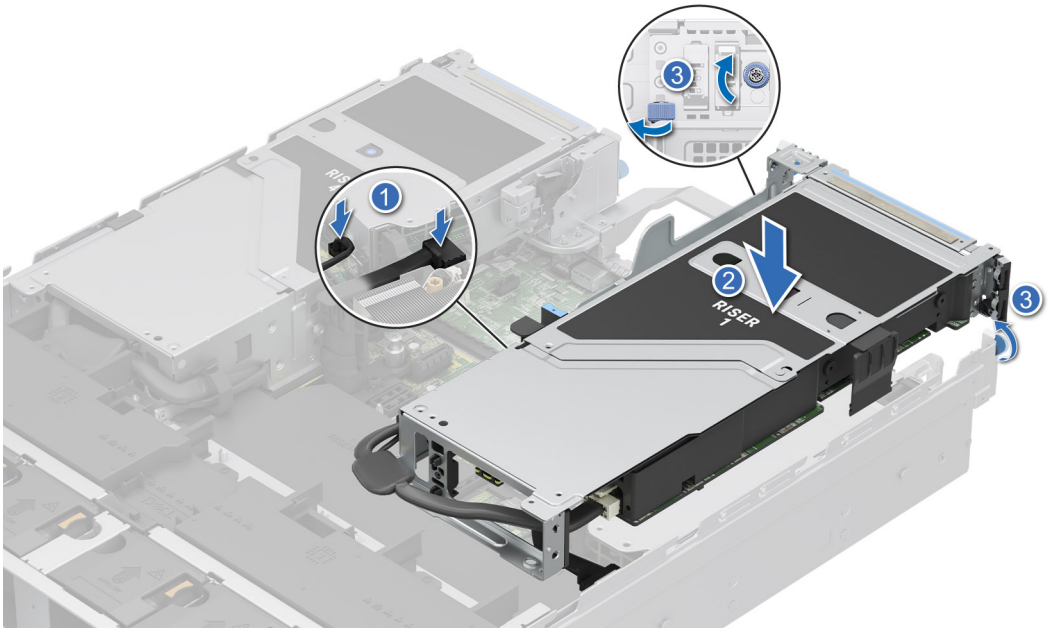


Figure 250. Installing the expansion card riser (Riser 1)

Next steps

1. If applicable, connect the cables to the expansion card or system board.
2. Install the GPU air shroud top cover.
3. Follow the procedure listed in After working inside your system.
4. Install any device drivers required for the card as described in the documentation for the card.

Removing a GPU

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. If applicable, disconnect the cables from the expansion card.
4. Remove the GPU air shroud top cover.
5. Remove the full length expansion card riser.

Steps

1. To remove the GPU from Riser 1:
   a. Tilt the expansion card holder latch on the riser.
   b. Press the tab, and pull the card holder from the riser.
   c. Hold the GPU card by the edges and pull the card from the riser.
   d. Disconnect the GPU power cable from the GPU card.

   NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

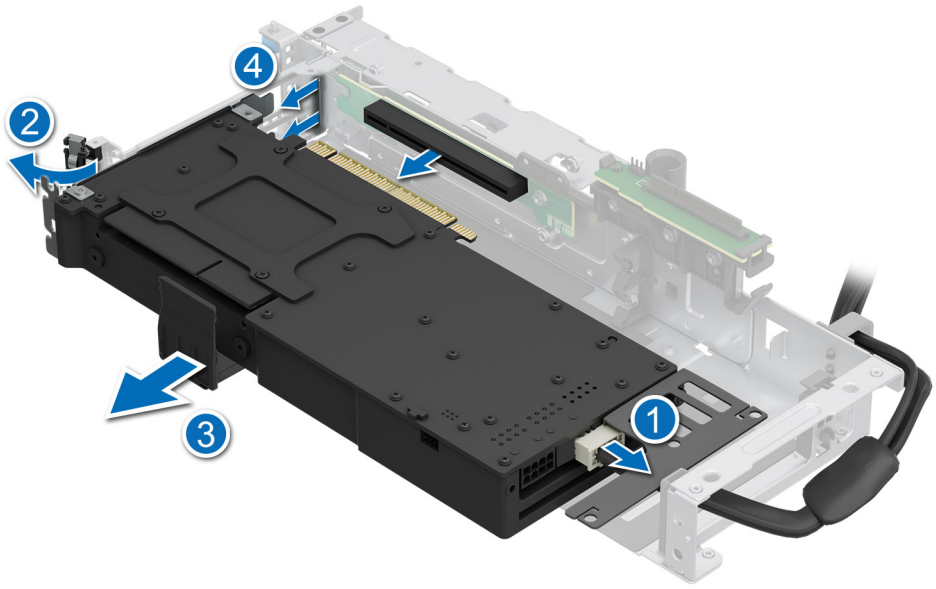


Figure 251. Removing GPU from Riser 1

2. To remove the GPU from Riser 4:
   a. Slide the expansion card latch on the riser.
   b. Press the tab, and pull the card holder from the riser.
   c. Tilt the expansion card holder latch on the riser.
   d. Hold the GPU card by the edges and pull the card from the riser.
   e. Disconnect the GPU power cable from the GPU card.

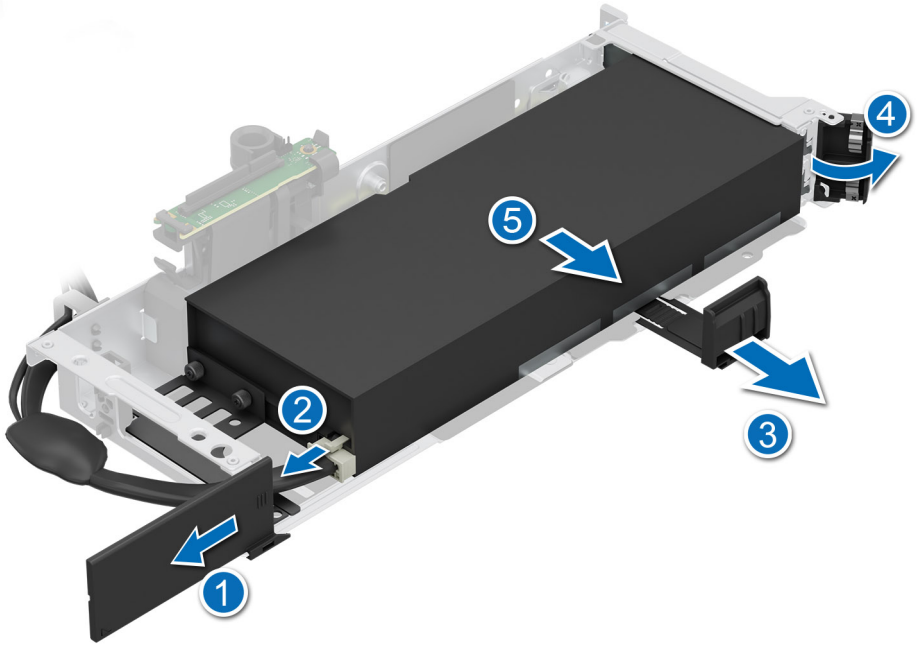


Figure 252. Removing GPU from Riser 4

3. If removing the GPU permanently, install a filler bracket.

NOTE: You must install a filler bracket over an empty expansion card slot to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system. The filler bracket is necessary to maintain proper thermal conditions.

4. Install a metal filler bracket over the empty expansion slot opening and close the expansion card latch.

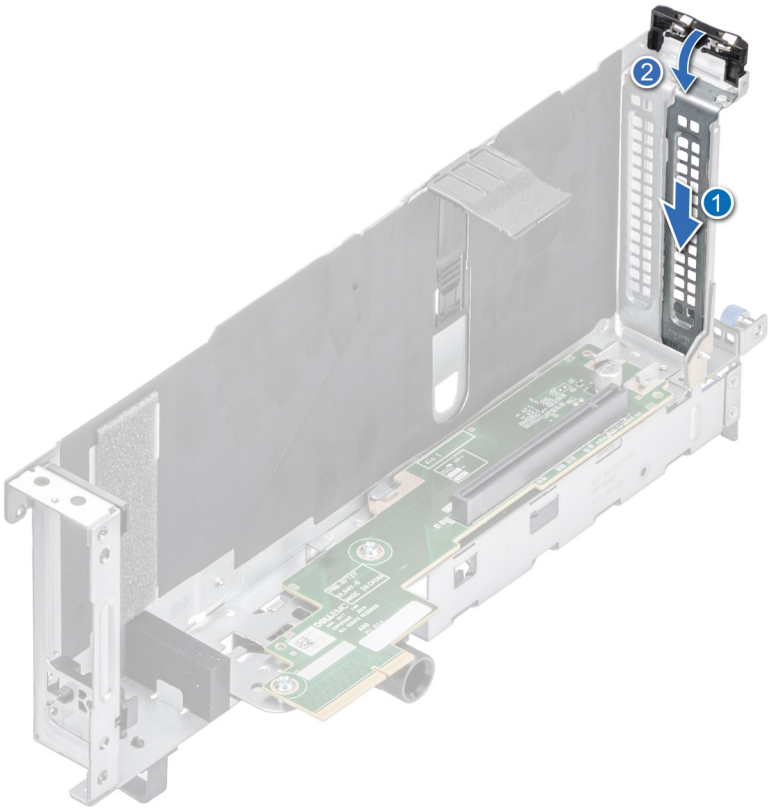


Figure 253. Installing the metal filler bracket

Next steps

1. Replace the GPU.

Installing a GPU

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. If installing a new expansion card, unpack it and prepare the card for installation.

NOTE: For instructions, see the documentation accompanying the card.

4. Remove the GPU air shroud top cover.
5. Remove the GPU air shroud filler.
6. Remove the full length expansion card riser.

CAUTION: Do not install GPUs, network cards, or other PCIe devices on your system that are not validated and tested by Dell. Damage caused by unauthorized and invalidated hardware installation will null and void the system warranty.

WARNING: Consumer-Grade GPU should not be installed or used in the Enterprise Server products.

Steps

1. If installed, remove the filler bracket.

   NOTE: Store the filler bracket for future use. Filler brackets must be installed in empty expansion card slots to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

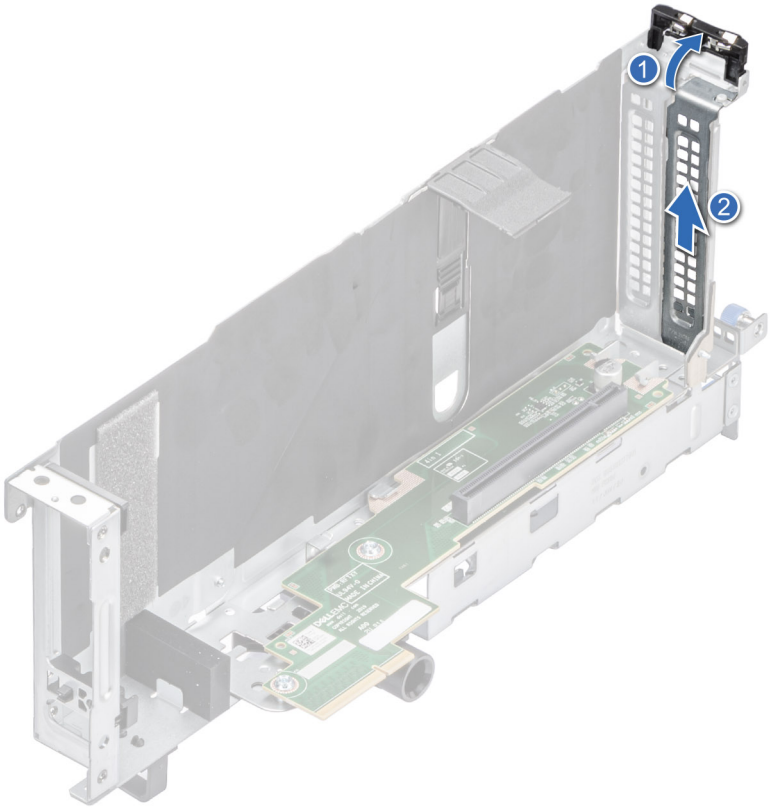


Figure 254. Removing the filler bracket

2. To install the GPU on Riser 1:
   a. Connect the GPU power cable to the GPU card.
   b. Align the connector on the GPU with the connector on the riser.
   c. Insert the GPU into the riser until firmly seated.
   d. Tilt the expansion card holder latch.
   e. Press the card holder latch to secure the GPU card to the riser.

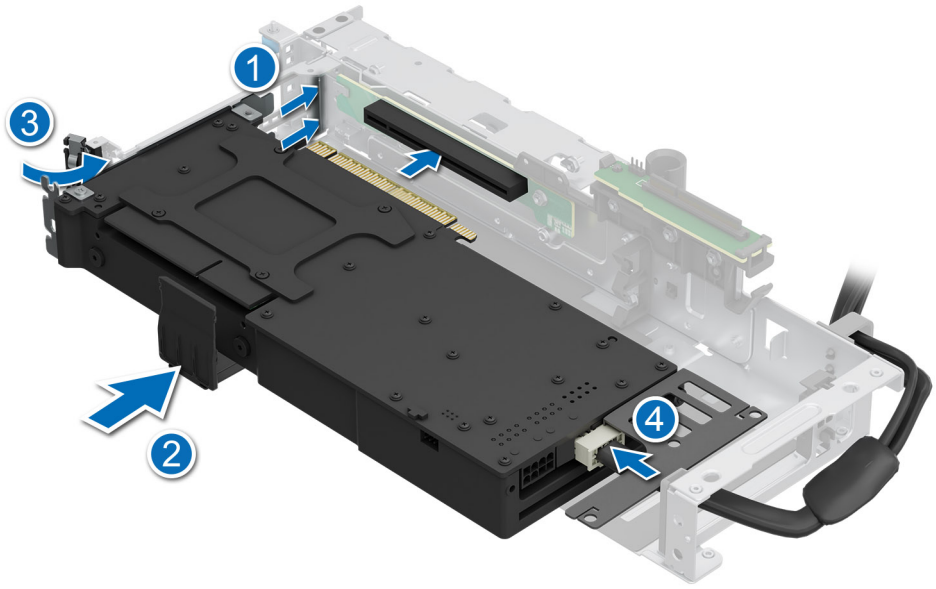


Figure 255. Installing GPU on Riser 1

3. To install the GPU on Riser 4:
   a. Connect the GPU power cable to the GPU card.
   b. Align the connector on the GPU with the connector on the riser.
   c. Insert the GPU into the riser until firmly seated.
   d. Tilt the expansion card holder latch.
   e. Press the card holder latch to secure the GPU card to the riser.
   f. Slide the expansion card latch on the riser.

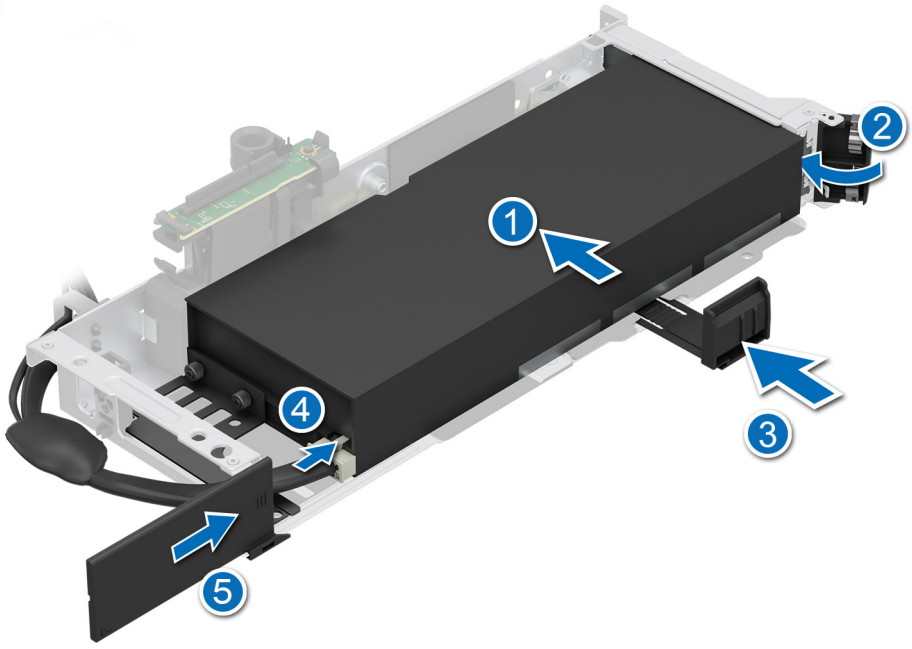


Figure 256. Installing GPU on Riser 4

Next steps

1. If removed, install the GPU air shroud.

NOTE: The GPU air shroud filler must be installed, if single-width GPU card or empty riser is used.

2. Install the full length expansion card riser.
3. Install the GPU air shroud top cover.
4. Follow the procedure listed in After working inside your system.
5. Install any device drivers required for the card as described in the documentation for the card.

Removing R1 and R4 paddle cards

R1 and R4 paddle cards are supported on 24 x 2.5-inch NVMe Gen4 (passive) configuration only.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. Remove the cooling fan cage assembly.

NOTE: Observe the cable routing before disconnecting the cables.

5. Remove the paddle card cable from side wall bracket.
6. Disconnect the paddle card cables from the drive backplane.

Steps

Press the blue release tab on the paddle cards and holding the edges lift the paddle cards from the riser connector on the system board.

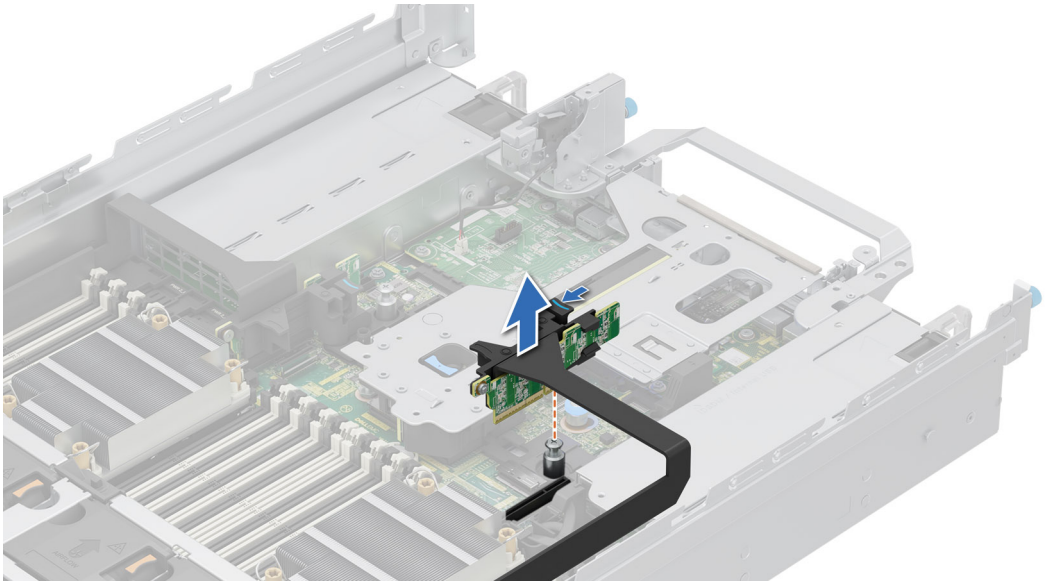


Figure 257. Removing the R1 paddle card

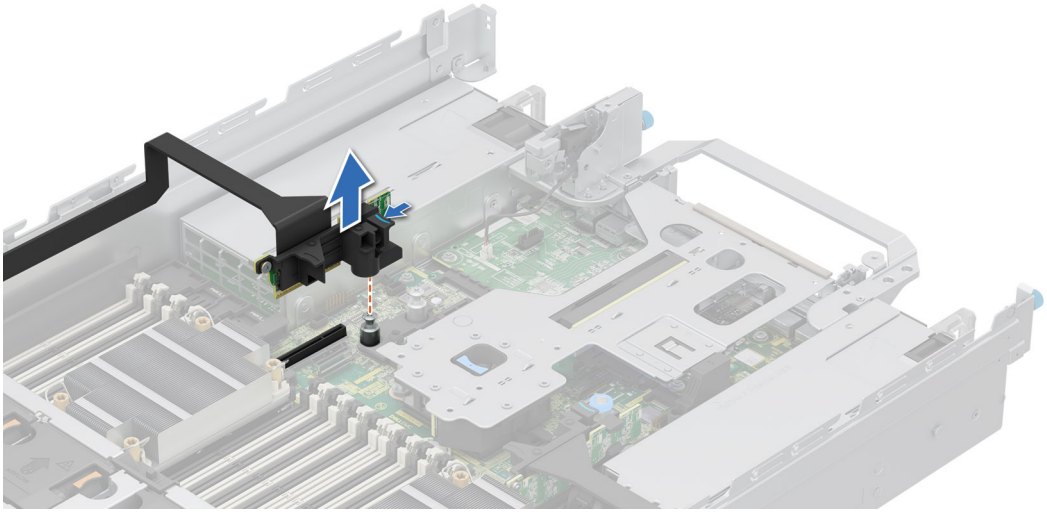


Figure 258. Removing the R4 paddle card

Next steps

1. Replace the paddle cards.

Installing R1 and R4 paddle cards

R1 and R4 paddle cards are supported on 24 x 2.5-inch NVMe Gen4 (passive) configuration only.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. Remove the cooling fan cage assembly.

NOTE: Observe the cable routing before disconnecting the cables.

5. Remove the paddle card cable from side wall bracket.
6. Disconnect the paddle card cables from the drive backplane.

Steps

1. Holding the edges, align the hole on the paddle cards with the guides on the system board.
2. Lower the paddle cards into place and press until the paddle card connector is fully seated on the system board connector.

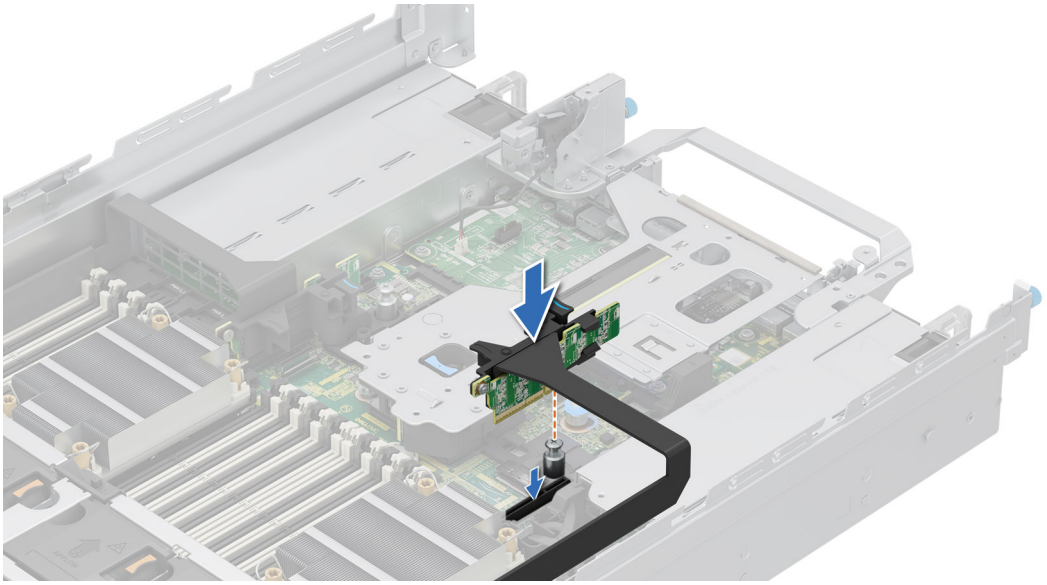


Figure 259. Installing the R1 paddle card

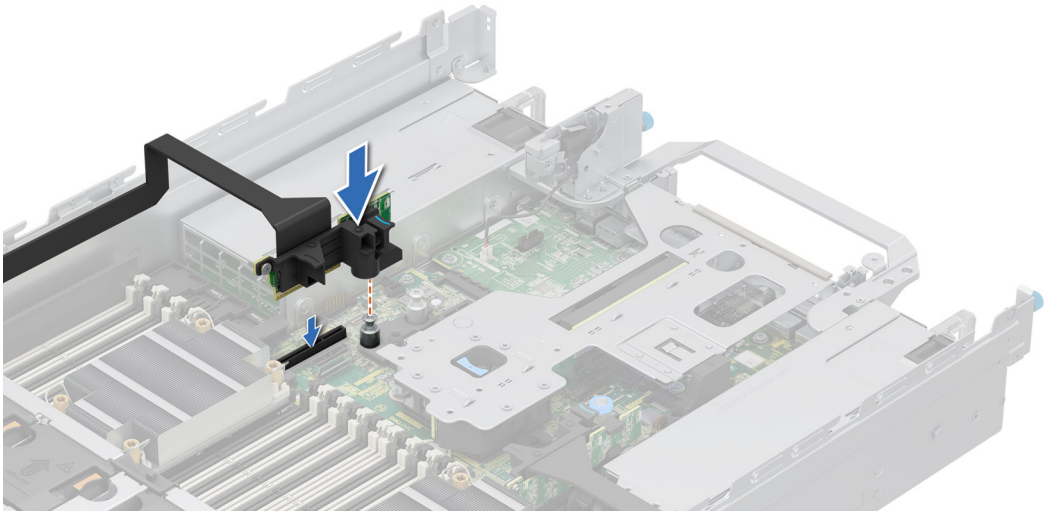


Figure 260. Installing the R4 paddle card

Next steps

1. Connect the paddle card cables to the drive backplane.
2. Insert the paddle card cable into the side wall bracket.
3. Install the cooling fan cage assembly.
4. Install the air shroud or install the GPU air shroud.
5. Follow the procedure listed in After working inside your system.

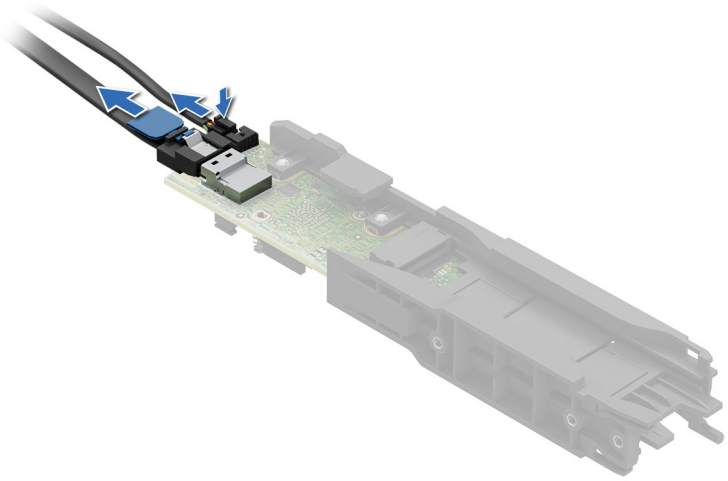
Data processing unit (DPU)

Removing a DPU card from a full length riser

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.

2. Follow the procedure listed in the Before working inside your system.
3. If applicable, disconnect the cables from the expansion card.
4. Remove the GPU air shroud top cover.
5. Remove the full length expansion card riser.
6. **NOTE:** If the BOSS-N1 module is installed, be sure to disconnect the BOSS-N1 power cable and signal cable before removing the Riser 1 cage.



7. Disconnect the cables from the DPU card and the system board. See Cable routing topic, configuration 56.

NOTE: Dell DPUs only support vSphere 8.0+ operating system and Partner or Channel DPU only supports Linux-based operating system.

Steps

1. To remove the DPU card from Riser 1:
   a. Tilt the expansion card holder latch on the riser.
   b. Press the tab, and pull the card holder from the riser.
   c. Hold the DPU card by the edges and pull the card from the riser.

   NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

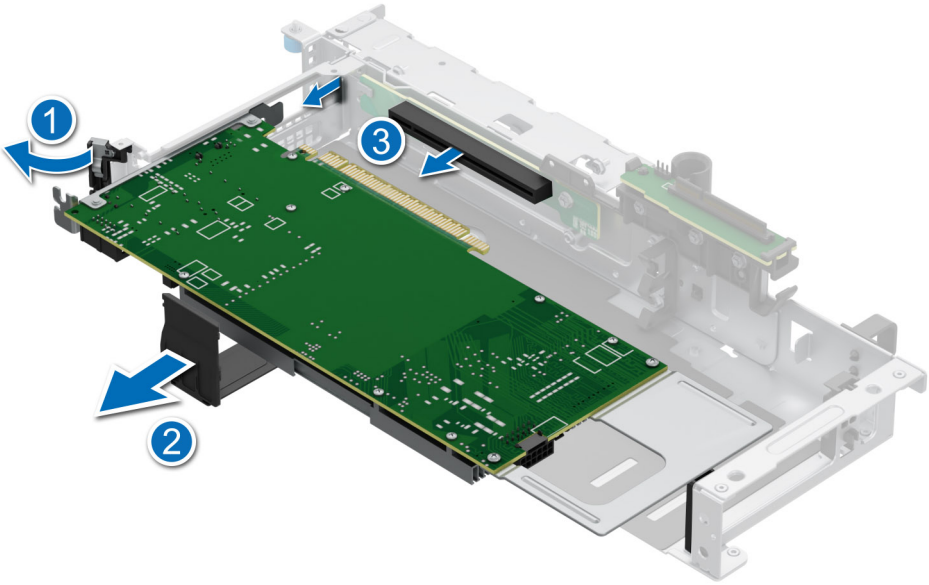


Figure 261. Removing DPU card from Riser 1

2. Using a Phillips #2 screwdriver loosen the two screws and remove the DPU bracket from the DPU card.

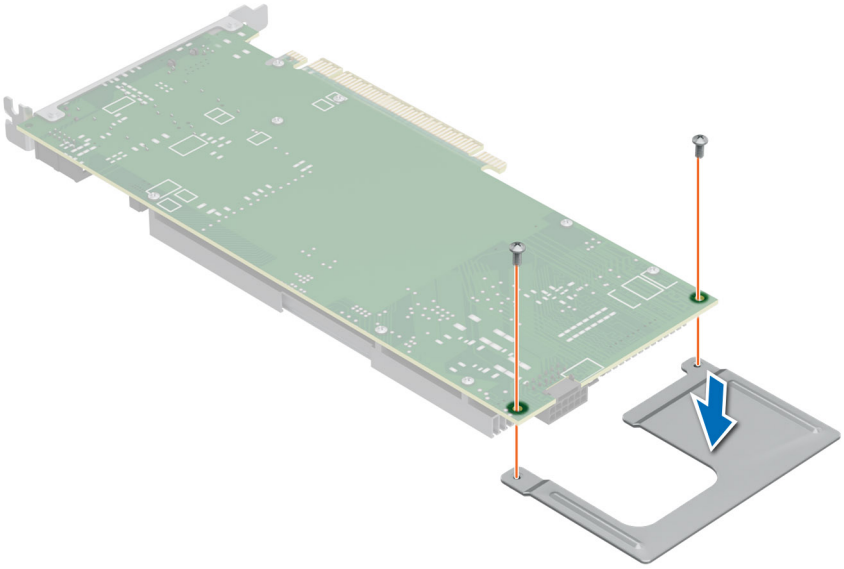


Figure 262. Removing DPU bracket

3. If removing the DPU permanently, install a filler bracket.

   NOTE: You must install a filler bracket over an empty expansion card slot to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system. The filler bracket is necessary to maintain proper thermal conditions.

4. Install a metal filler bracket over the empty expansion slot opening and close the expansion card latch.

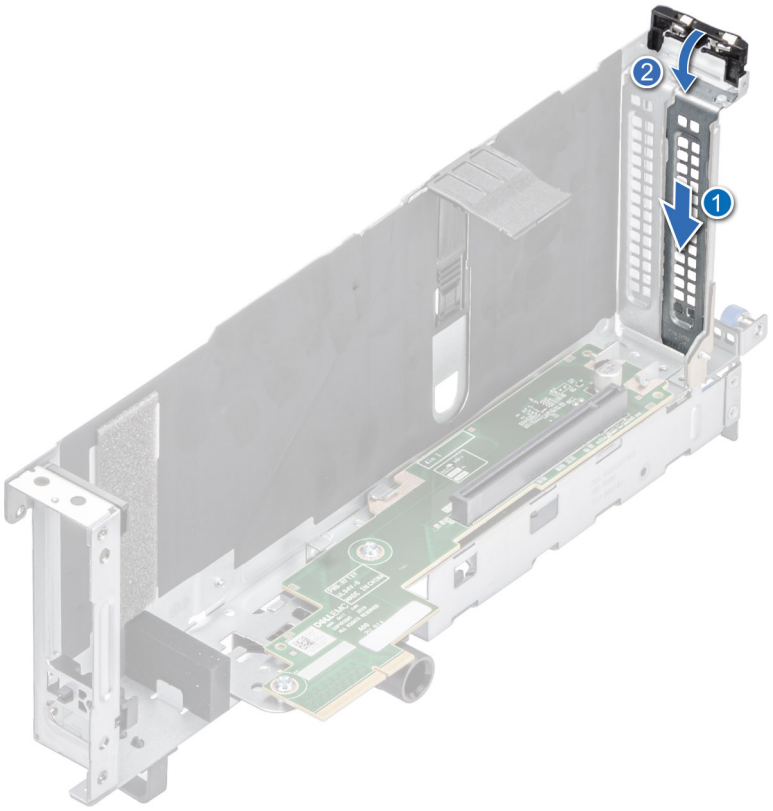


Figure 263. Installing the metal filler bracket

Next steps

1. Replace the DPU card.

Installing a DPU into a full length riser

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. If installing a new expansion card, unpack it and prepare the card for installation.

NOTE: For instructions, see the documentation accompanying the card.

4. Remove the GPU air shroud top cover.
5. If installed, remove the GPU air shroud filler.
6. Remove the full length expansion card riser.
7. Disconnect the cables from the DPU card and the system board. See Cable routing topic, configuration 56.

NOTE: Dell DPUs only support vSphere 8.0+ operating system and Partner or Channel DPU only supports Linux-based operating system.

CAUTION: Do not install GPUs, network cards, or other PCIe devices on your system that are not validated and tested by Dell. Damage caused by unauthorized and invalidated hardware installation will null and void the system warranty.

Steps

1. If installed, remove the filler bracket.

NOTE: Store the filler bracket for future use. Filler brackets must be installed in empty expansion card slots to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

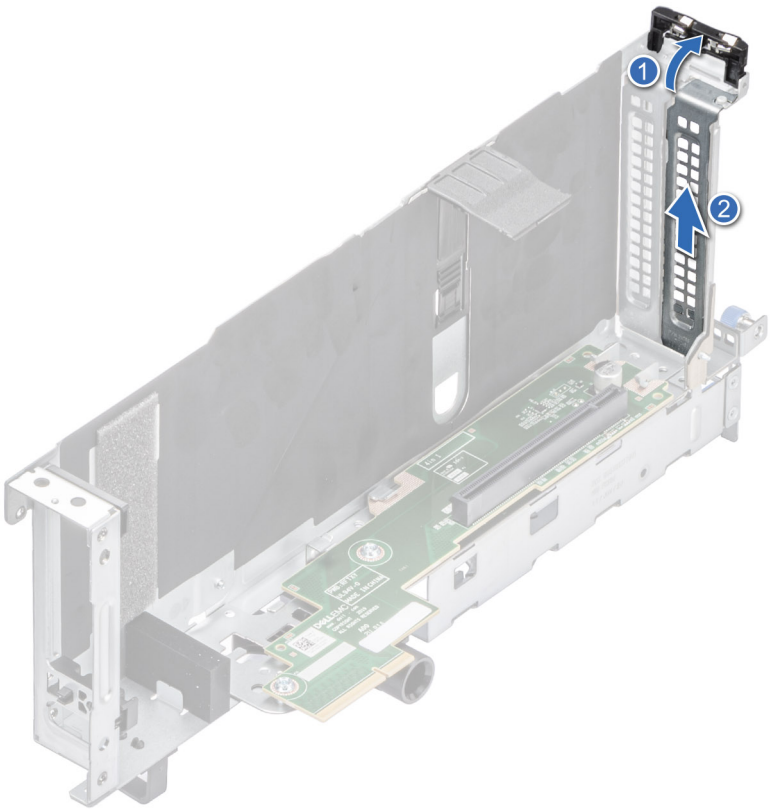


Figure 264. Removing the filler bracket

2. Using a Phillips #2 screwdriver, tighten the two screws to secure the DPU bracket with the DPU card.

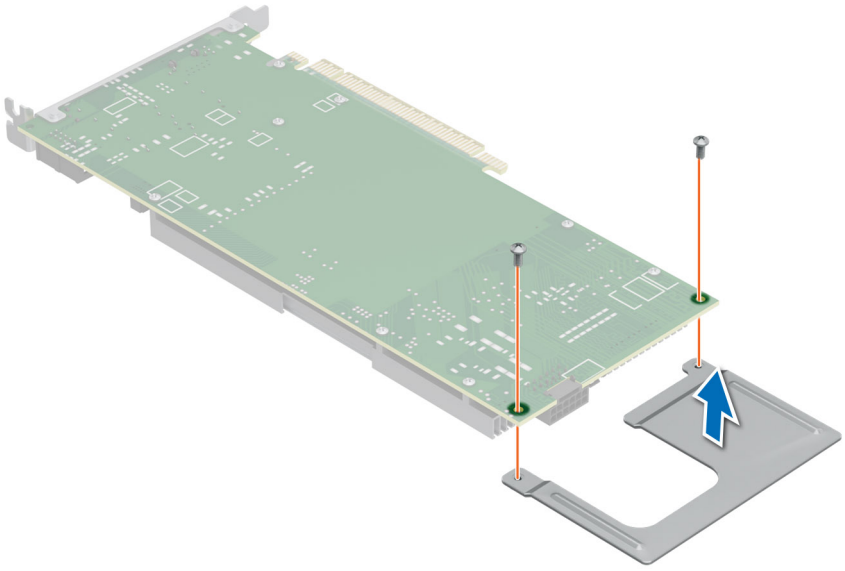


Figure 265. Installing DPU bracket

3. To install the DPU on Riser 1:
   a. Align the connector on the DPU card with the connector on the riser.
   b. Insert the DPU card into the riser until firmly seated.
   c. Tilt the expansion card holder latch.
   d. Press the card holder latch to secure the DPU card to the riser.

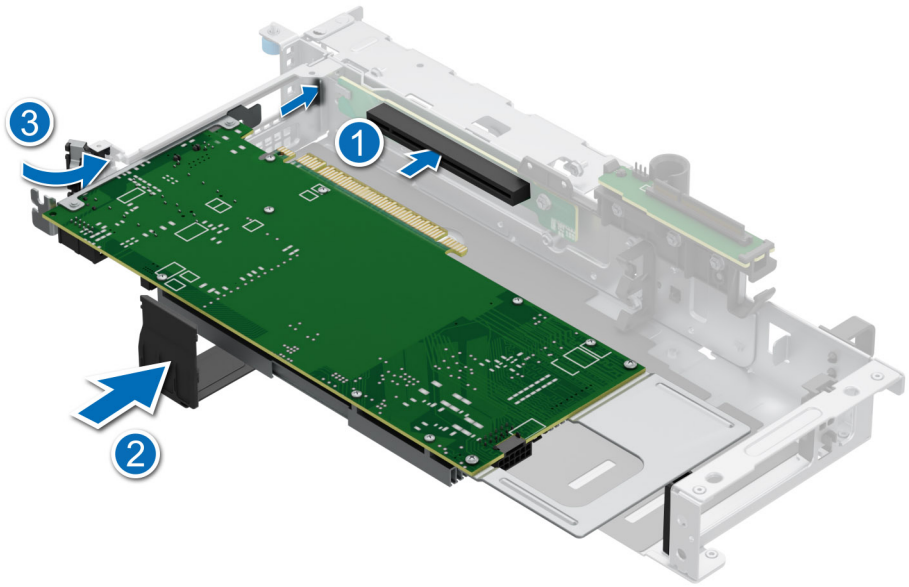


Figure 266. Installing DPU card on Riser 1

Next steps

1. Connect the cables to the DPU card and to the system board. See Cable routing topic, configuration 56.
2. If removed, install the GPU air shroud.

   NOTE: The GPU air shroud filler must be installed, if a single-width GPU card or empty riser is used.

3. Install the full length expansion card riser.
4. Install the GPU air shroud top cover.
5. Follow the procedure listed in After working inside your system.
6. Install any device drivers required for the card as described in the documentation for the card.

Optional serial COM port

This is a service technician replaceable part only.

Removing the serial COM port

The procedure to remove serial COM port from Riser 3 or 4 is same.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. If required, remove PCIe card from slot 7.

NOTE: The serial COM port is supported only in slot 4 or slot 8 of the expansion card riser.

Steps

1. Loosen the captive screws on the system.
2. Press the blue release tab or blue button on the riser and holding the edges lift the expansion card riser from the riser connector on the system board.
3. Disconnect the serial COM port cable from the rear I/O board.

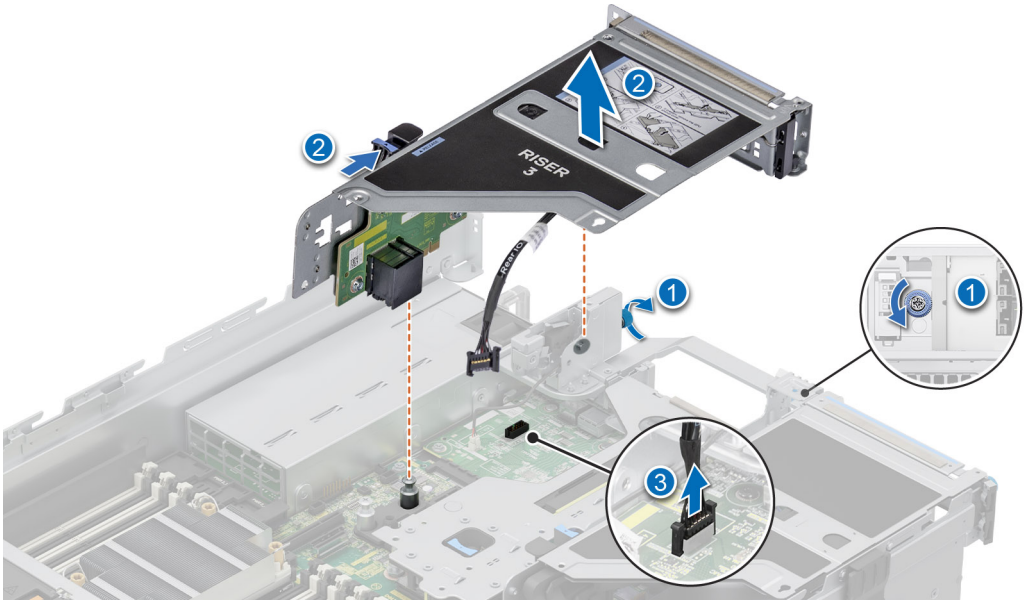


Figure 267. Disconnecting the serial COM port

4. Open the latch on the expansion card riser and slide the serial COM port out of the expansion card riser.

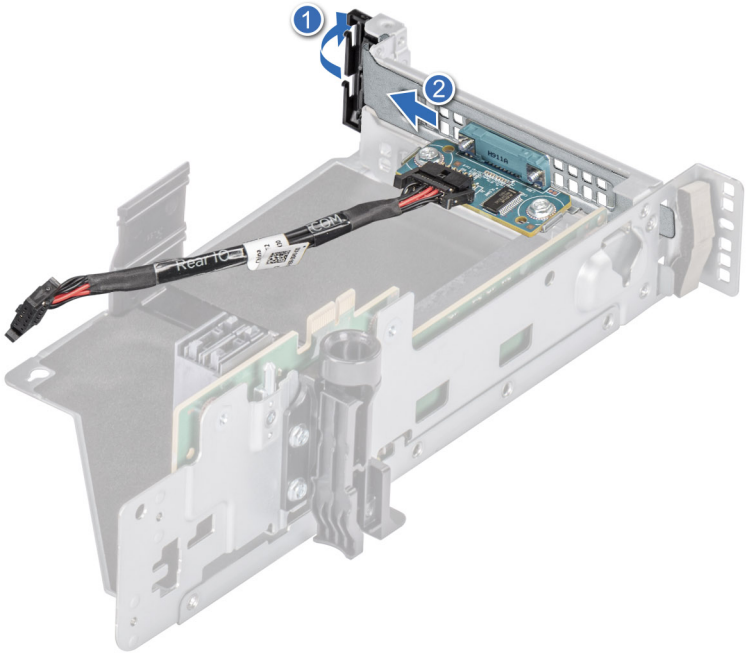


Figure 268. Removing the Serial COM port

5. Install the filler bracket if not replacing the serial COM port.

Next steps

1. Replace the serial COM port.

Installing the serial COM port

The procedure to install serial COM port to Riser 3 or 4 is same.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.

NOTE: The serial COM port is supported only in slot 4 or slot 8 of the expansion card riser.

4. Remove expansion card riser.
5. If required, remove PCIe card from slot 7.

Steps

1. Open the latch on the expansion card riser and remove the filler bracket from the expansion card riser.
2. Slide the serial COM port into the expansion card riser and close the latch.

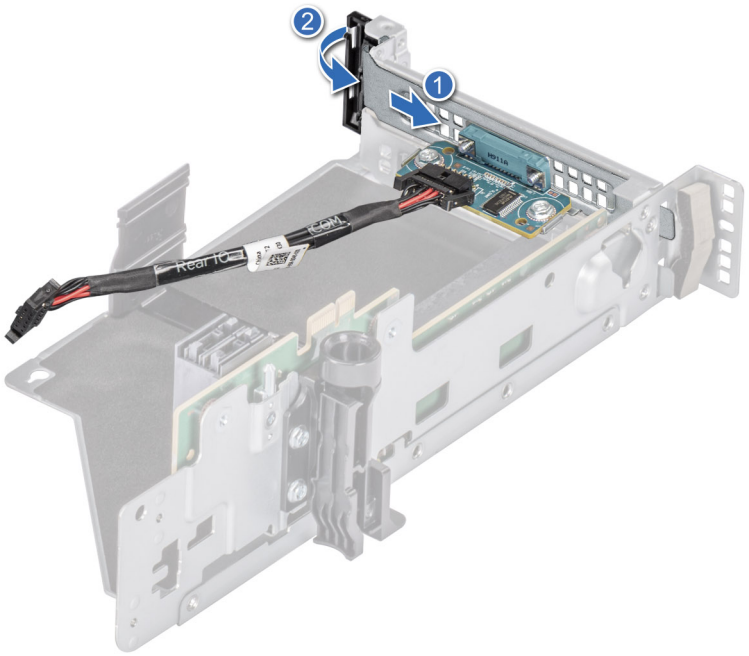


Figure 269. Installing the serial COM port

3. Connect the serial COM port cable to the rear I/O board.
4. Holding the edges or the touch points, align the holes on the expansion card riser with the guides on the system board.
5. Lower the expansion card riser into place and press the touch points until the expansion card riser connector is fully seated on the system board connector.
6. Tighten the captive screws on the system.

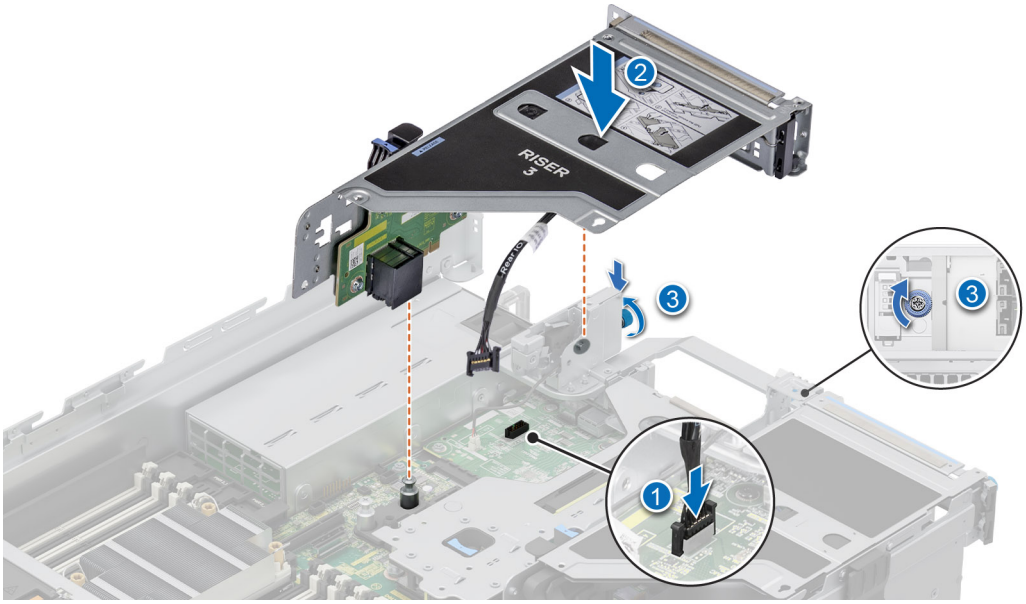


Figure 270. Connecting the serial COM port

Next steps

1. Install the air shroud or install the GPU air shroud.
2. If required, install PCIe card to slot 7.
3. Follow the procedure listed in After working inside your system.

Optional VGA port for Direct Liquid Cooling module

Removing the VGA port

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.

NOTE: VGA port is supported only in slot 4 of the expansion card riser.

Steps

1. Loosen the captive screws on the system.
2. Press the blue release tab or blue button on the riser and holding the edges lift the expansion card riser from the riser connector on the system board.
3. Disconnect the VGA port cable from the liquid cooling (LC) rear I/O board.

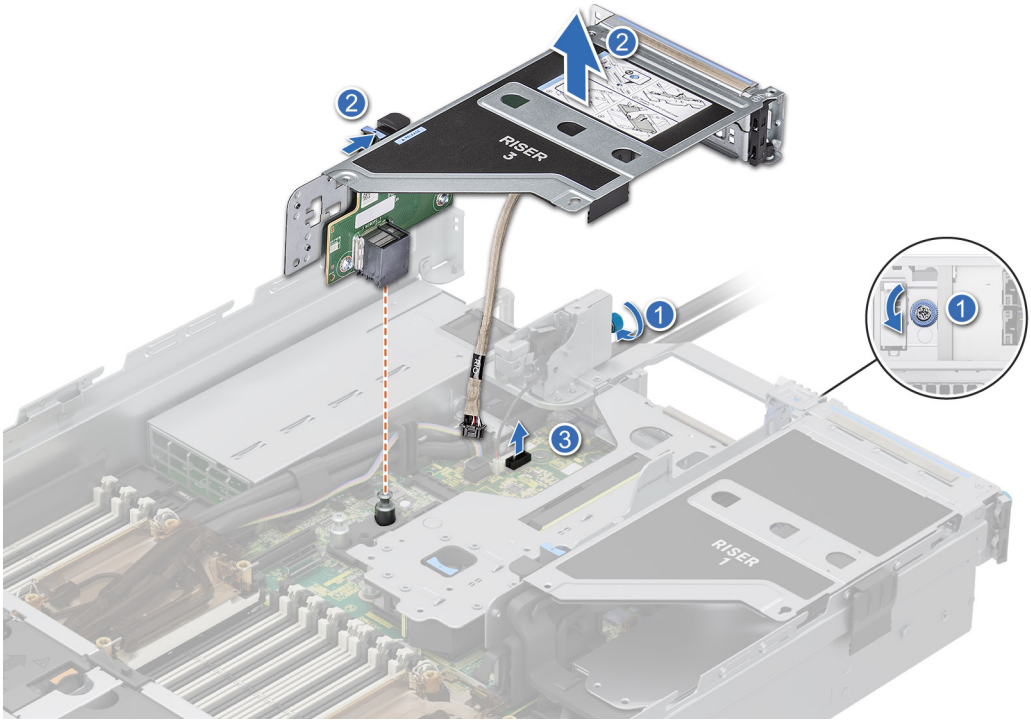


Figure 271. Disconnecting the VGA port cable

4. Open the latch on the expansion card riser and slide the VGA port out of the expansion card riser.

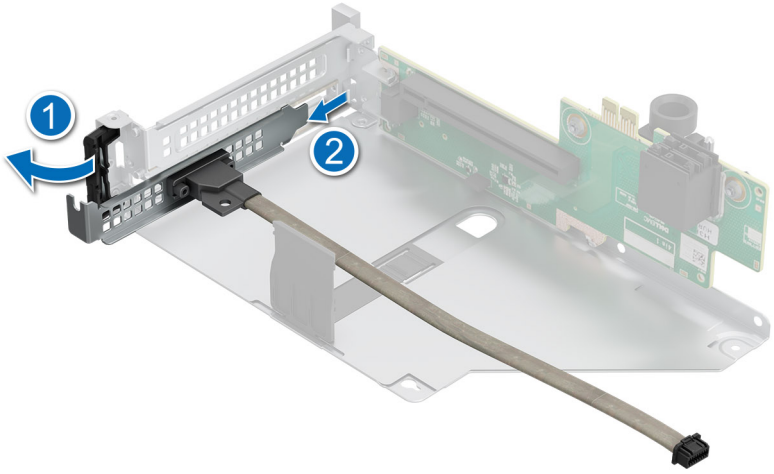


Figure 272. Removing the VGA port

5. Install the filler bracket if not replacing the VGA port.

Next steps

1. Replace the VGA port.

Installing the VGA port

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. Remove the air shroud or remove the GPU air shroud.
4. Remove expansion card riser.

NOTE: VGA port is supported only in slot 4 of the expansion card riser.

Steps

1. Open the latch on the expansion card riser and remove the filler bracket from the expansion card riser.
2. Slide the VGA port into the expansion card riser.

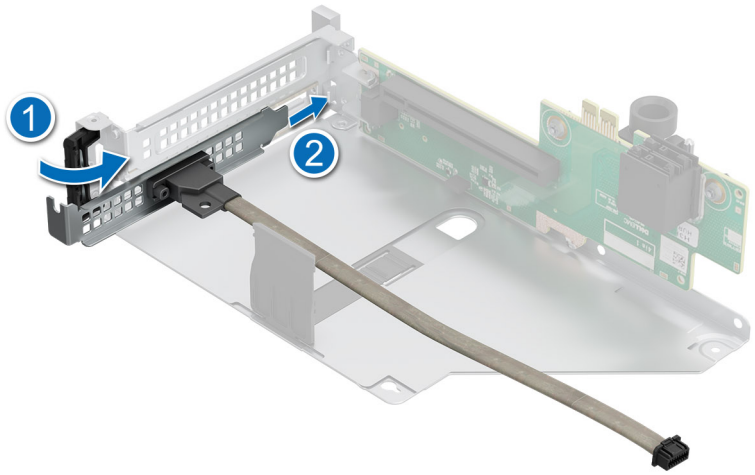


Figure 273. Installing the VGA port

3. Connect the VGA port cable to the LC rear I/O board.
4. Holding the edges or the touch points, align the holes on the expansion card riser with the guides on the system board.
5. Lower the expansion card riser into place and press the touch points until the expansion card riser connector is fully seated on the system board connector.
6. Tighten the captive screws on the system.

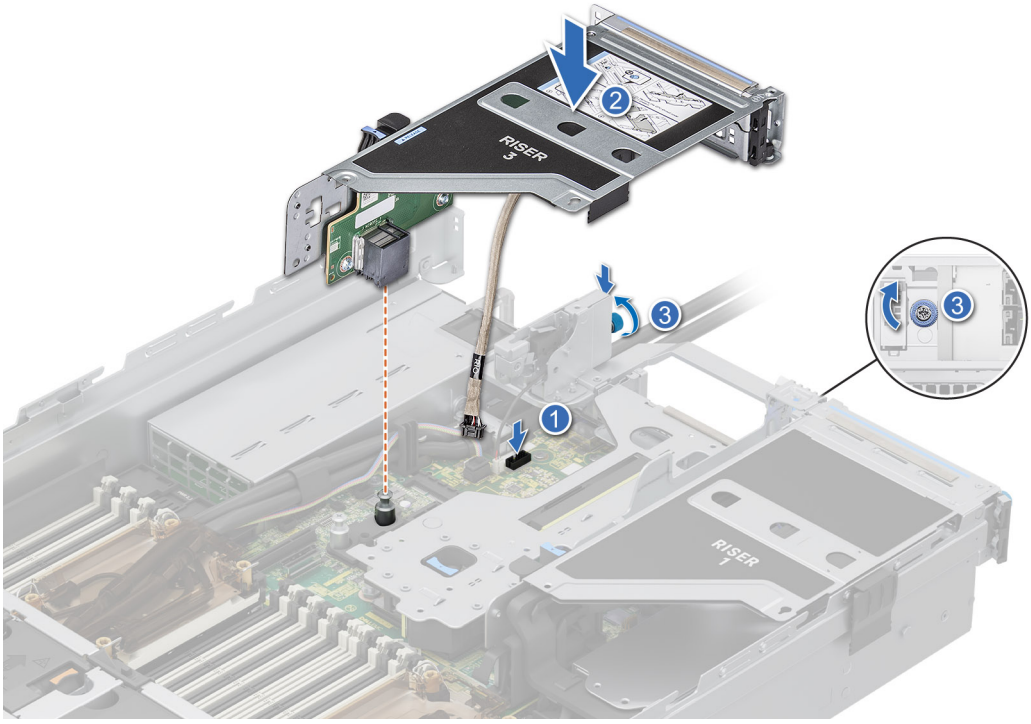


Figure 274. Connecting the VGA port cable

Next steps

1. Install the air shroud or install the GPU air shroud.
2. Follow the procedure listed in After working inside your system.

M.2 SSD module

Removing the M.2 NVMe SSD module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.

Steps

1. Pull and lift the BOSS-N1 card carrier retention latch lock to open.
2. Slide the BOSS-N1 card carrier out.

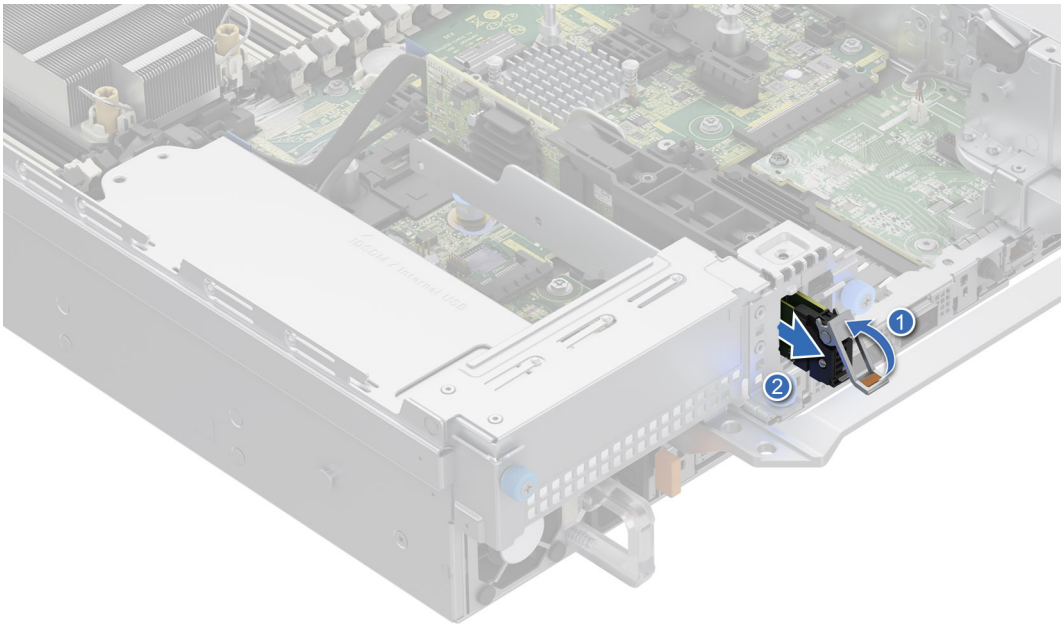


Figure 275. Removing the BOSS-N1 card carrier

3. Using the Phillips #1 screwdriver, remove the M3 x 0.5 x 4.5 mm screw securing the M.2 NVMe SSD module to the BOSS-N1 card.
4. Pull the M.2 NVMe SSD module to disconnect from the BOSS-N1 card connector.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

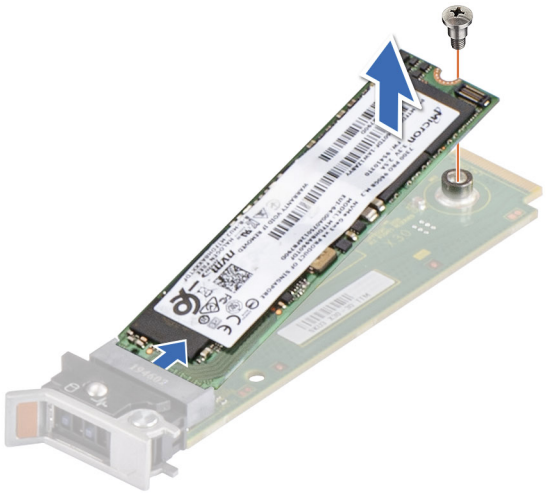


Figure 276. Removing the M.2 NVMe SSD module

Next steps

1. Replace the M.2 NVMe SSD module.

Installing the M.2 NVMe SSD module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.

Steps

1. Align the M.2 NVMe SSD module at an angle with the BOSS-N1 card connector.
2. Insert the M.2 NVMe SSD module until it is firmly seated in the BOSS-N1 card connector.
3. Using the Phillips #1 screwdriver, secure the M.2 NVMe SSD module on the BOSS-N1 card with the M3 x 0.5 x 4.5 mm screw.

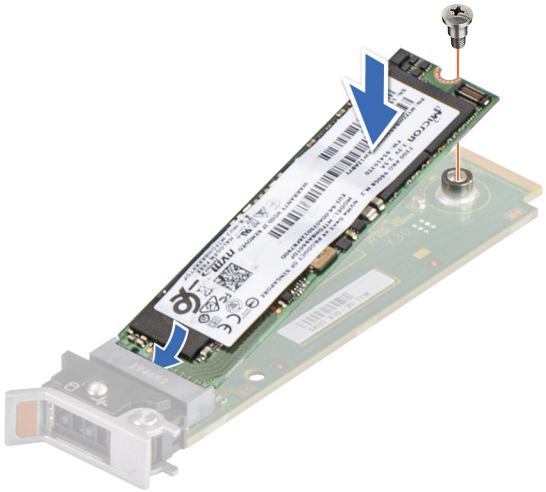


Figure 277. Installing the M.2 NVMe SSD module

4. Slide the BOSS-N1 card carrier into the BOSS-N1 module slot.
5. Close the BOSS-N1 card carrier release latch to lock the carrier in place.

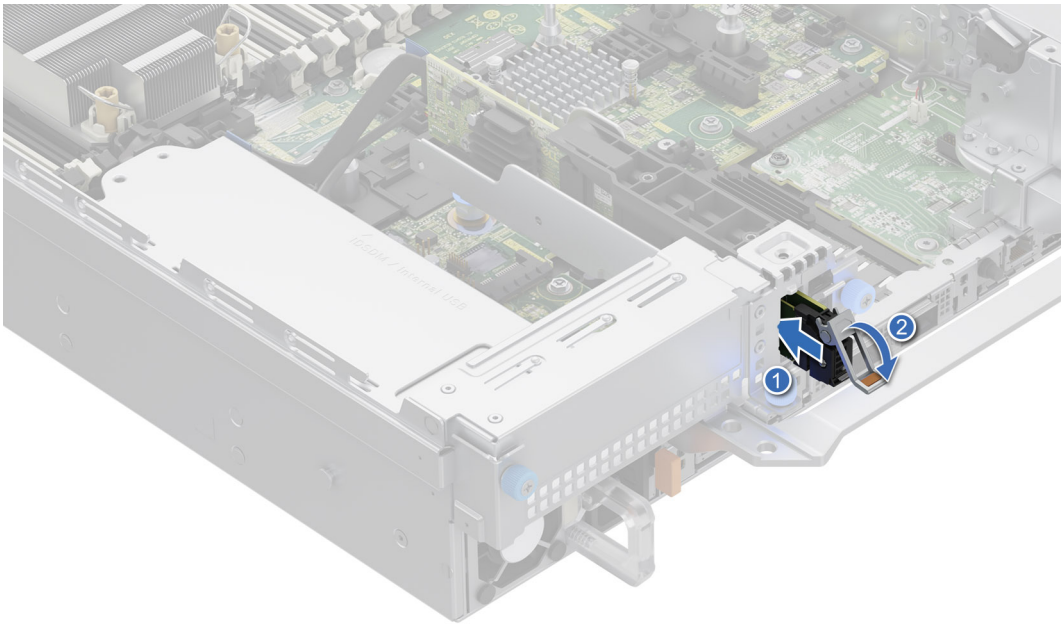


Figure 278. Installing the BOSS-N1 card carrier

Next steps

1. Follow the procedure listed in the After working inside your system.

Optional BOSS-N1 module

Removing the BOSS-N1 module blank

The removal of the BOSS-N1 module blank from the Riser 1 and 4 x 2.5-inch rear drive module is similar.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

Use a screwdriver to push out the blank from the BOSS-N1 module bay.

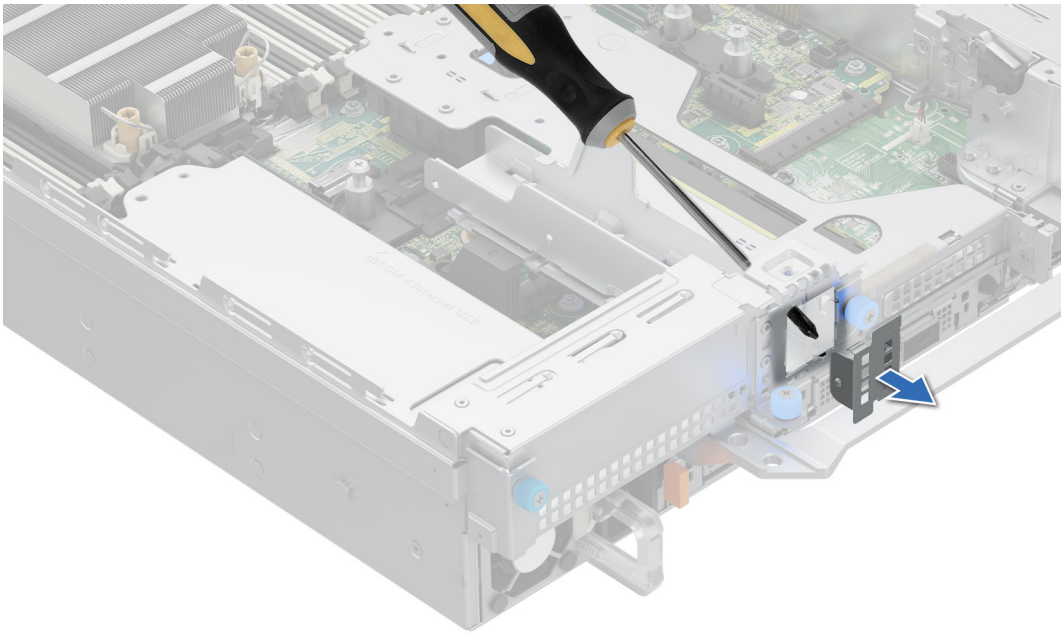


Figure 279. Removing the BOSS-N1 module blank

Next steps

1. Replace the BOSS-N1 module blank or install BOSS-N1 module.

Installing the BOSS-N1 module blank

The installation of the BOSS-N1 module blank to the Riser 1 and 4 x 2.5-inch rear drive module is similar.

Prerequisites

Follow the safety guidelines listed in the Safety instructions.

Steps

Align the blank with the BOSS-N1 module bay and push it into the bay until it clicks into place.

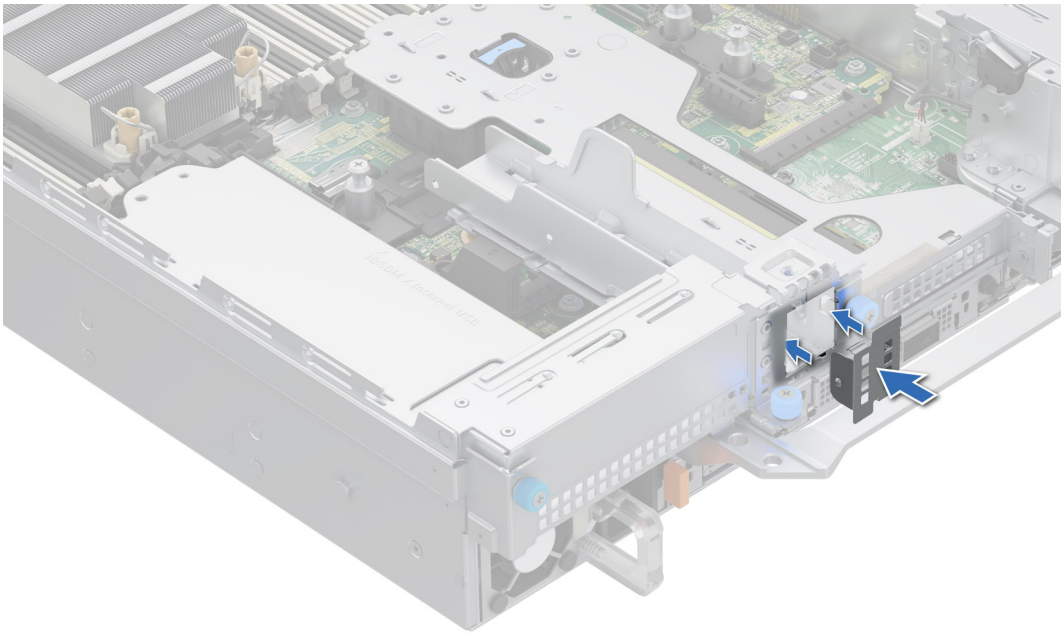


Figure 280. Installing the BOSS-N1 module blank

Removing the BOSS-N1 card carrier blank

The removal of the BOSS-N1 card carrier blank from the Riser 1 and 4 x 2.5-inch rear drive module is similar.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

Press and pull the BOSS-N1 card carrier blank out from the BOSS-N1 module.

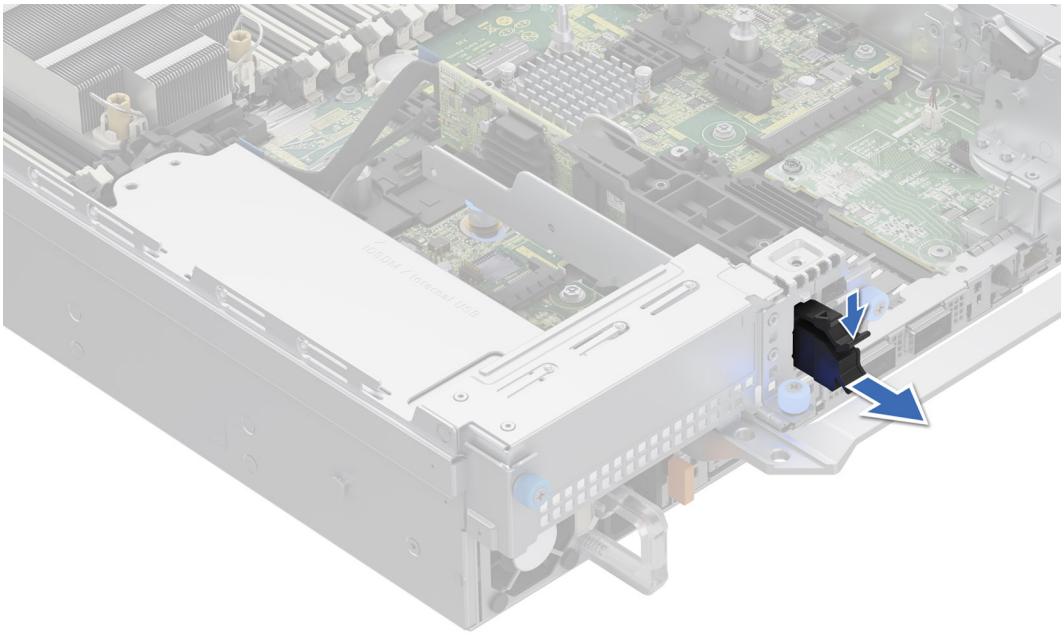


Figure 281. Removing the BOSS-N1 card carrier blank

Next steps

1. Replace the BOSS-N1 card carrier blank or install BOSS-N1 card carrier.

Installing the BOSS-N1 card carrier blank

The installation of the BOSS-N1 card carrier blank to the Riser 1 and 4 x 2.5-inch rear drive module is similar.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.

Steps

Align the blank with the BOSS-N1 module bay and push it into the bay until it clicks into place.

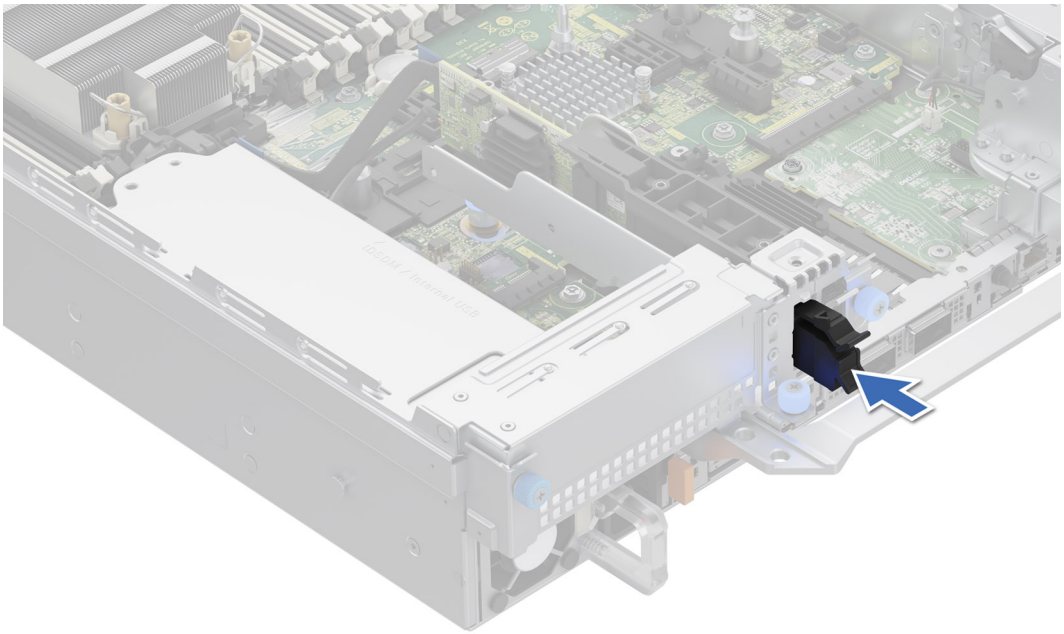


Figure 282. Installing the BOSS-N1 card carrier blank

Removing the BOSS-N1 module

The removal of the BOSS-N1 module from the Riser 1 and 4 x 2.5-inch rear drive module is similar.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the M.2 NVMe SSD module.

Steps

1. Disconnect the BOSS-N1 power and signal cable from the system board.
2. Using the Phillips #1 screwdriver remove the M3 x 0.5 x 4.5 mm screw that secures the BOSS-N1 module on Riser 1.
3. Slide the BOSS-N1 module towards the front of the chassis and lift the module.

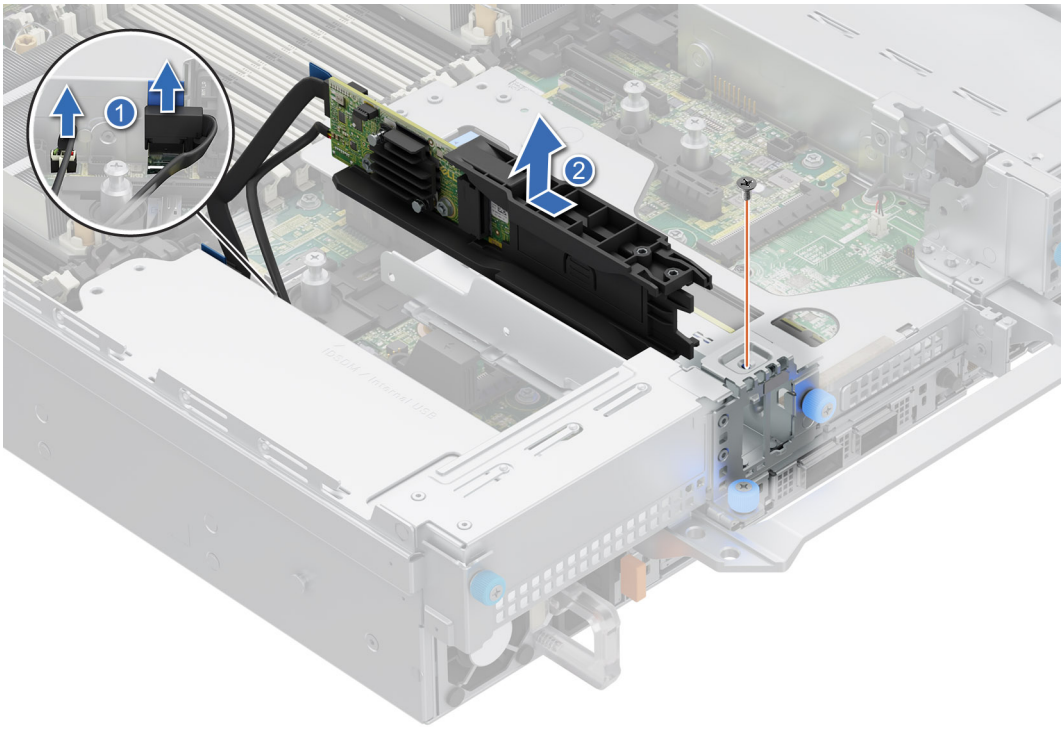


Figure 283. Removing the BOSS-N1 module

4. Pull the blue tag to remove the BOSS-N1 signal cable from the BOSS-N1 module.
5. Remove the BOSS-N1 power cable from the BOSS-N1 module.

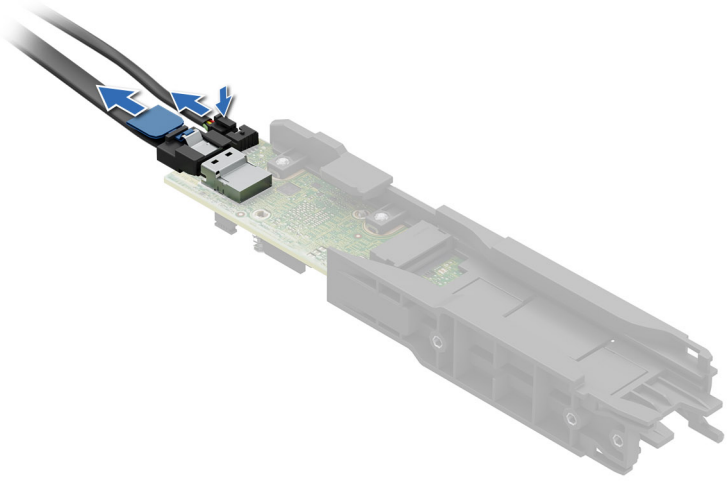


Figure 284. Removing the BOSS-N1 power and signal cable from the BOSS-N1 module

Next steps

1. Replace the BOSS-N1 module or Install the BOSS-N1 module blank.

Installing the BOSS-N1 module

The installation of the BOSS-N1 module to the Riser 1 and 4 x 2.5-inch rear drive module is similar.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. If installed, remove the BOSS module blank.
4. Remove the M.2 NVMe SSD module.

Steps

1. Connect the BOSS-N1 power and signal cables to the connectors on the BOSS-N1 module.

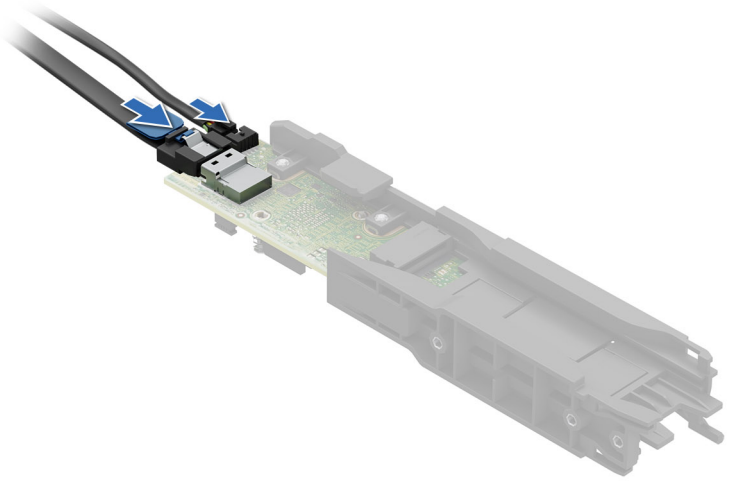


Figure 285. Connecting the BOSS-N1 power and signal cables to the BOSS-N1 module

2. Align the BOSS-N1 module at an angle with the controller card module slot.
3. Insert the BOSS-N1 module and push the module horizontally towards the rear of the system until firmly seated.
4. Using the Phillips #1 screwdriver, secure the BOSS-N1 module with the M3 x 0.5 x 4.5 mm screw.
5. Connect the BOSS-N1 power and signal cable to the connectors on the system board.

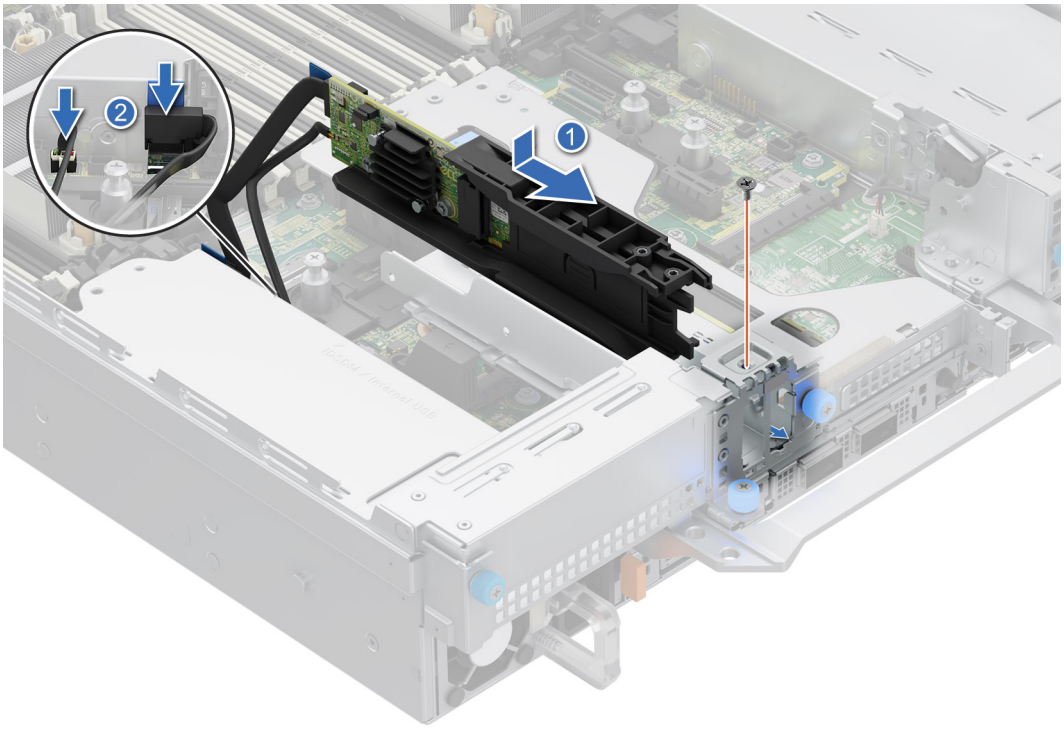


Figure 286. Installing the BOSS-N1 module

Next steps

1. Install the M.2 NVMe SSD module.

System battery

This is a service technician replaceable part only.

Replacing the system battery

Prerequisites

WARNING: There is a danger of a new battery exploding if it is incorrectly installed. Replace the battery only with the same or equivalent type that is recommended by the manufacturer. Discard used batteries according to the manufacturer's instructions. See the Safety instructions that came with your system for more information.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. If applicable, disconnect the power or data cables from the expansion cards.
4. Remove the expansion card risers.

Steps

1. Press and hold the battery socket retention latch, for the battery to pop out.

   NOTE: If the battery does not pop out, then lift it out of the socket.

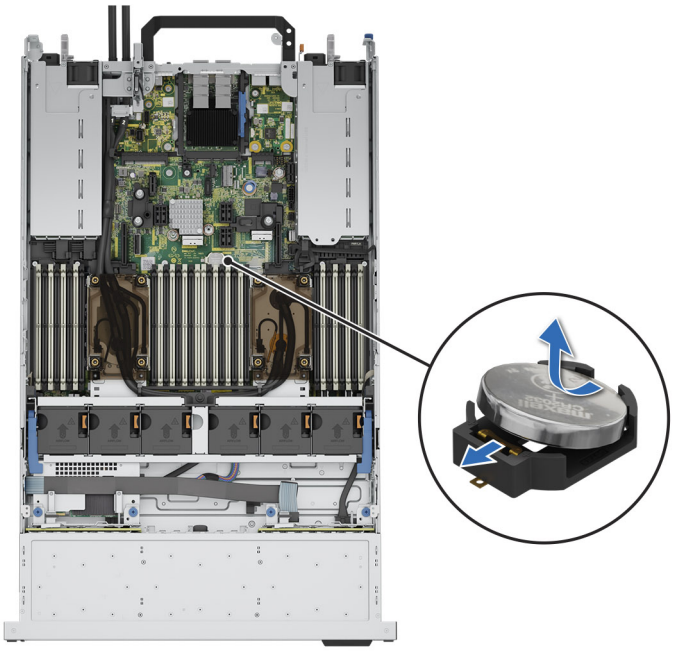


Figure 287. Removing the system battery

2. To install a new system battery, hold the battery with the positive side facing up at an angle and slide it under the battery holder socket latch.
3. Press the battery into the connector until it snaps into place.

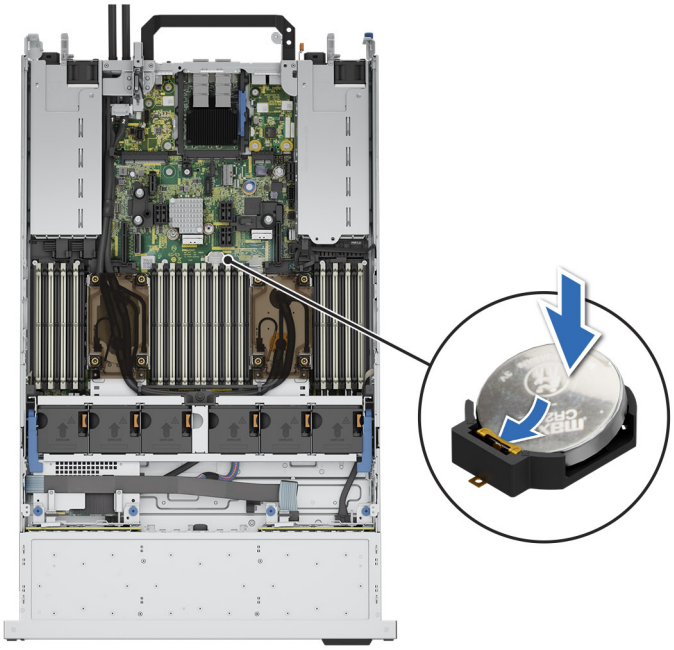


Figure 288. Installing the system battery

Next steps

1. Install the expansion card risers.
2. If applicable, connect the cables to one or more expansion cards.
3. Follow the procedure listed in After working inside your system.
4. Confirm that the battery is operating properly, by performing the following steps:
   a. Enter the System Setup, while booting, by pressing F2.

b. Enter the correct time and date in the System Setup **Time** and **Date** fields.
c. **Exit** the System Setup.
d. To test the newly installed battery, check the time and date at least an hour after installing the battery.
e. Enter the System Setup and if the time and date are still incorrect, see Getting help section.

Optional internal USB card

NOTE: To locate the internal USB port on the system board, see the System board jumpers and connectors section.

Removing the internal USB card

Prerequisites

CAUTION: To avoid interference with other components in the server, the maximum permissible dimensions of the USB memory key are 15.9 mm wide x 57.15 mm long x 7.9 mm high.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the expansion card risers.

Steps

1. Holding the blue tag, lift the internal USB card to disconnect from the connector on the system board.
2. Remove the USB memory key from the internal USB card.

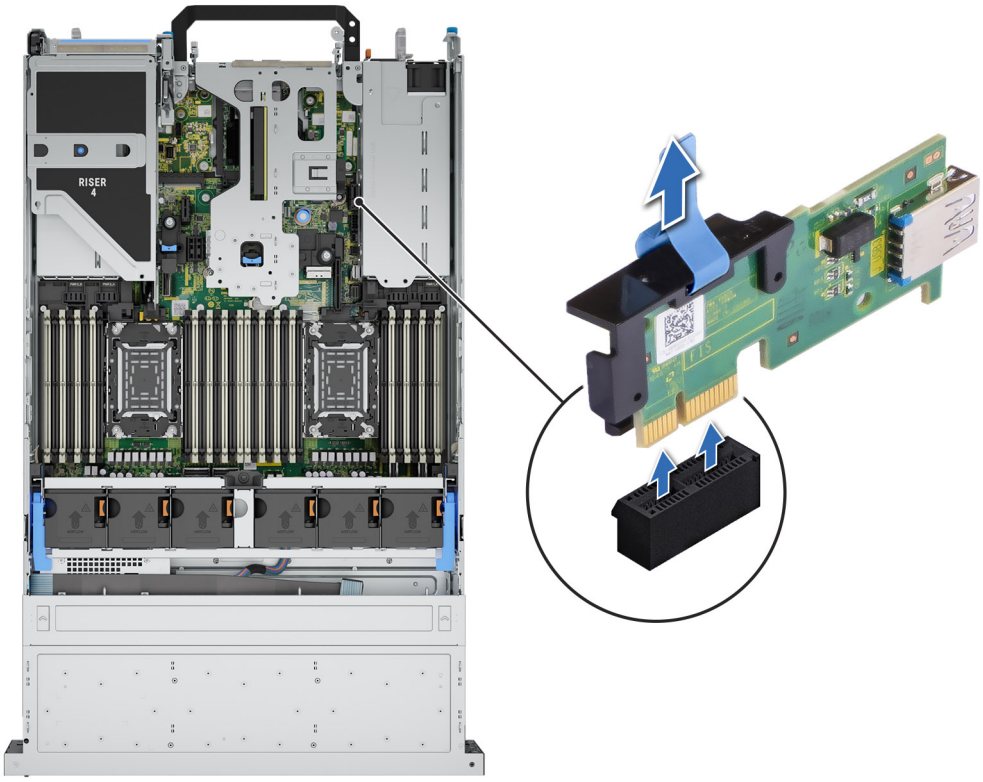


Figure 289. Removing the internal USB card

Next steps

1. Replace the internal USB card.

Installing the internal USB card

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the expansion card risers.

Steps

1. Connect the USB key to the internal USB card.

   NOTE: For information about the exact location of USB on system board, see System board jumpers and connectors section.

2. Align the internal USB card with the connector on the system board and press firmly until the internal USB card is seated.

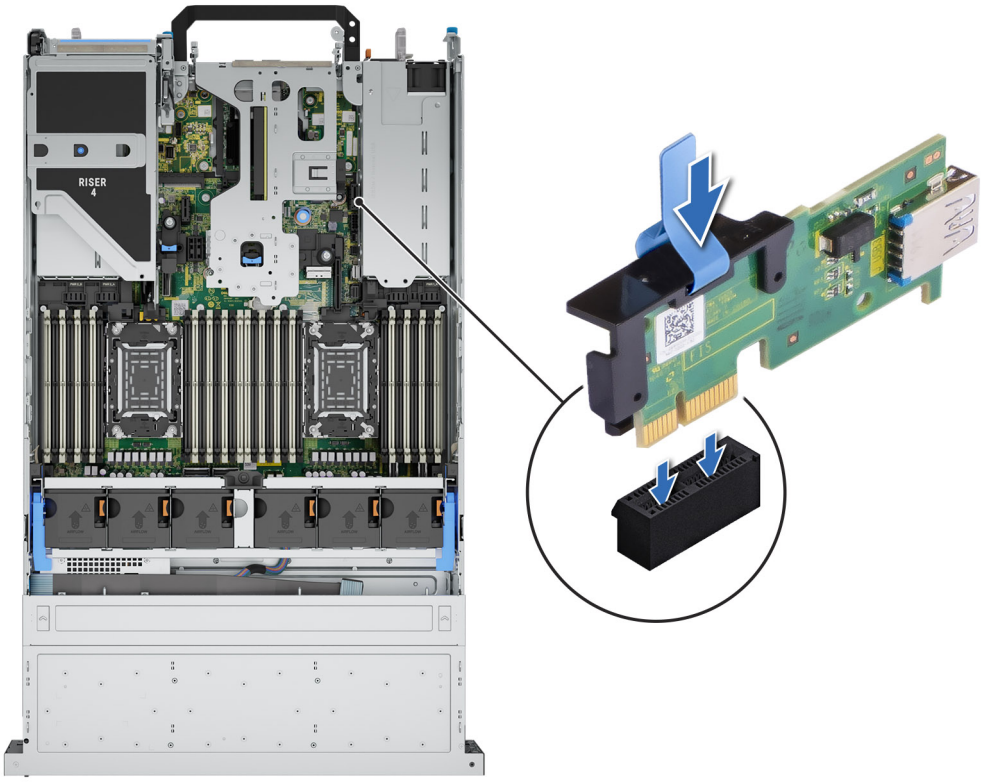


Figure 290. Installing the internal USB card

Next steps

1. Install the expansion card risers.
2. Follow the procedure listed in After working inside your system.
3. While booting, press F2 to enter **System Setup** and verify that the system detects the USB memory key.

Intrusion switch

This is a service technician replaceable part only.

Removing the intrusion switch module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the expansion card riser.

NOTE: Ensure that you note the routing of the cable as you remove it from the system board. Route the cable properly when you replace it to prevent the cable from being pinched or crimped.

Steps

1. Disconnect the intrusion switch cable from the connector on the rear I/O board.
2. Using a Phillips #1 screwdriver, loosen the screw on the intrusion switch module.
3. Slide the intrusion switch module out of the slot on the system.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

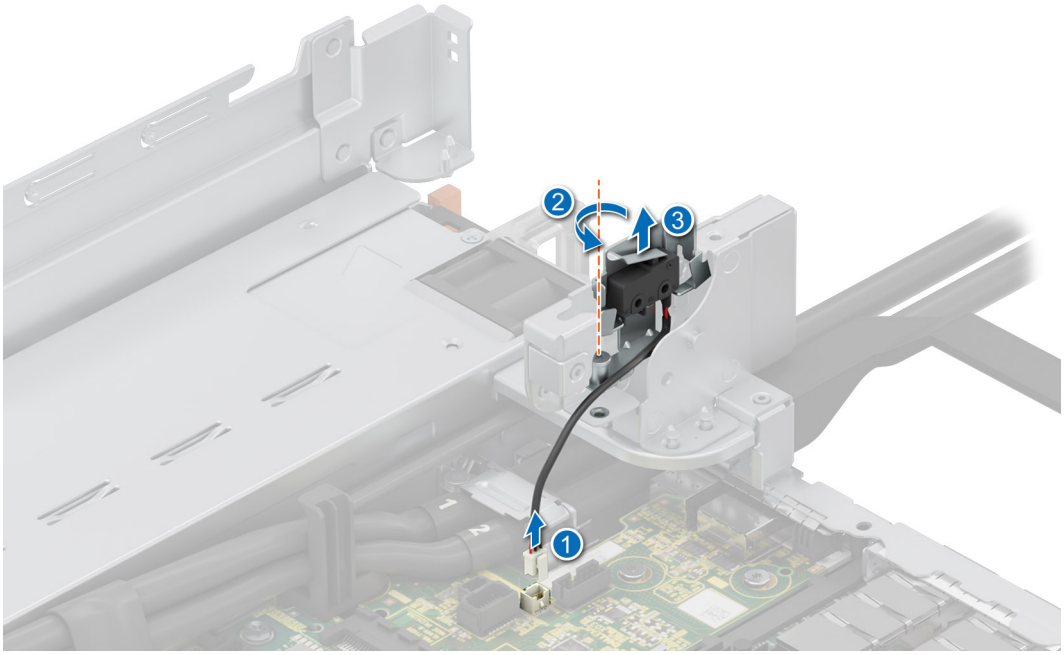


Figure 291. Removing the intrusion switch module

Next steps

1. Replace the intrusion switch module.

Installing the intrusion switch module

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

3. Remove the expansion card riser.

NOTE: Ensure that you note the routing of the cable as you remove it from the system board. Route the cable properly when you replace it to prevent the cable from being pinched or crimped.

Steps

1. Align and slide the intrusion switch module into the slot in the system until firmly seated.
2. Using a Phillips #1 screwdriver, tighten the screw on the intrusion switch module.
3. Connect the intrusion switch cable to the connector on the rear I/O board.

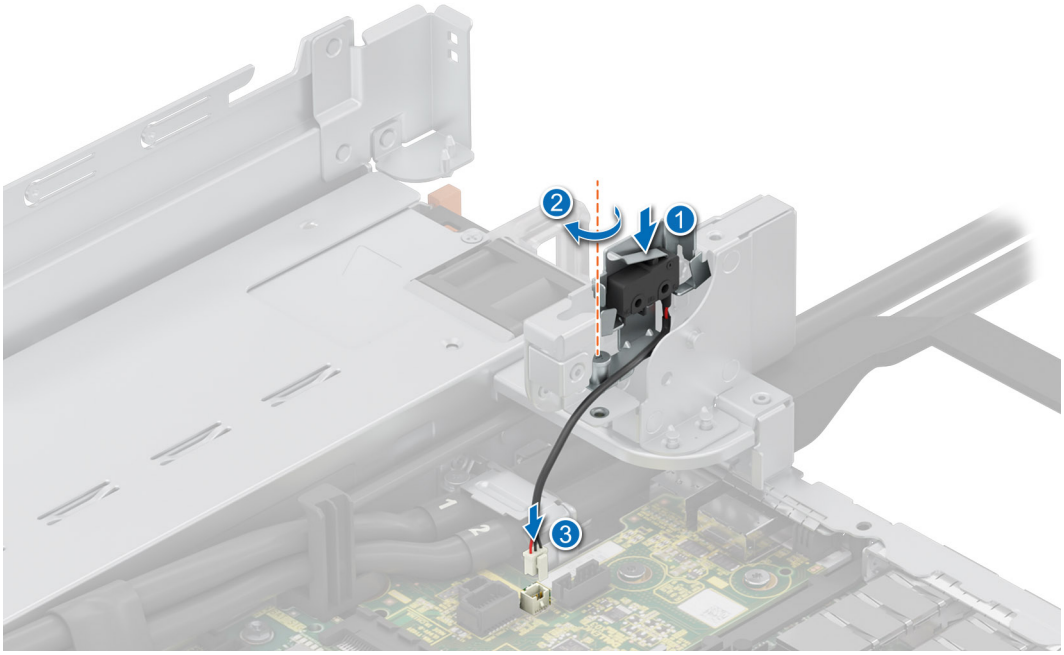


Figure 292. Installing the intrusion switch module

Next steps

1. Install the expansion card riser.
2. Follow the procedure listed in After working inside your system.

Optional OCP NIC card

Removing the OCP NIC card

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the expansion card riser.
4. Disconnect OCP cable from the SL11_CPU1_PB7 to SL13_CPU1_PB7 connectors on the MAX system board, if 100 GbE OCP card of PCIe width x16 is used.

NOTE: See cable routing section.

Steps

1. Open the blue latch to disengage the OCP NIC card.

2. Push the OCP NIC card towards the rear end of the system to disconnect from the connector on the system board.
3. Slide the OCP NIC card out of the slot on the system.

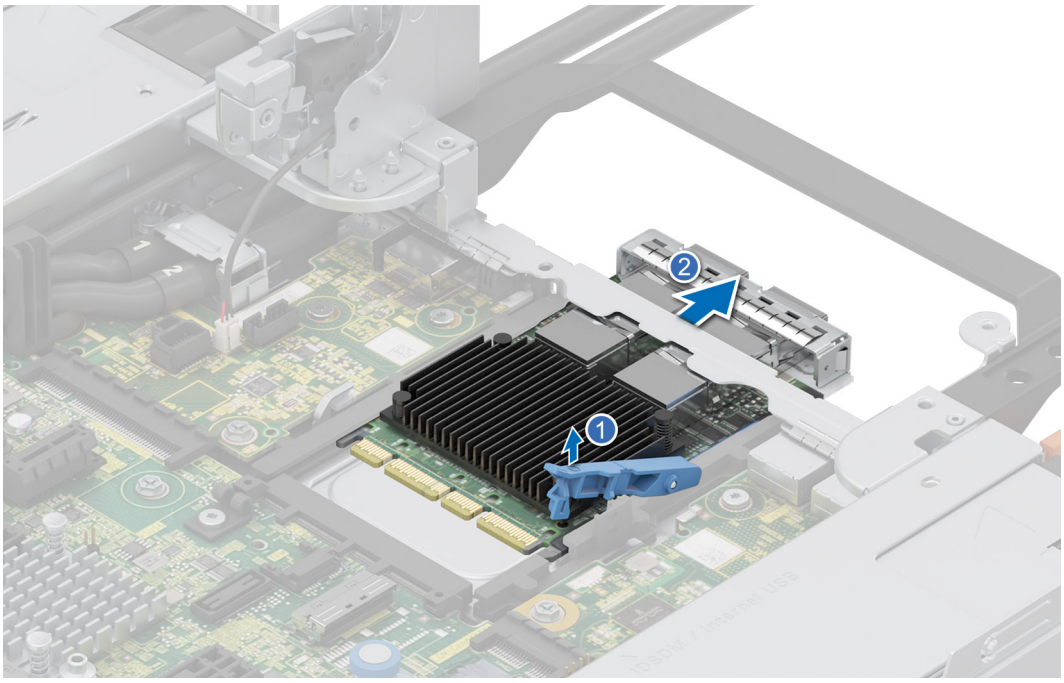


Figure 293. Removing the OCP NIC card

4. If the OCP NIC card is not going to be replaced, install a filler bracket .

NOTE: You must install a filler bracket over an empty expansion card slot to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

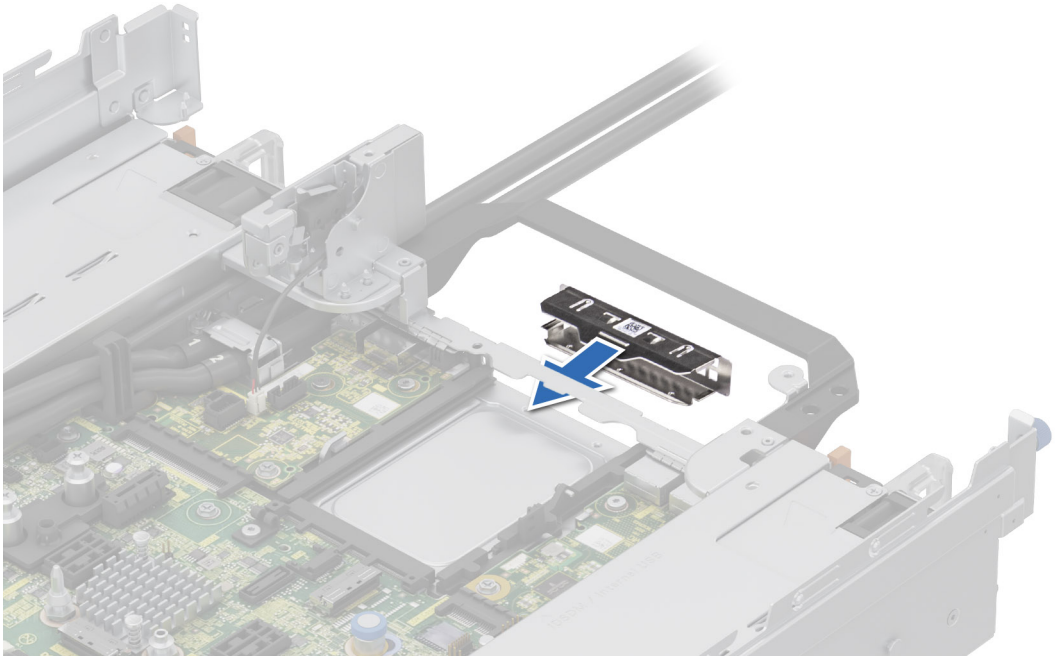


Figure 294. Installation of filler bracket

Next steps

1. Replace the OCP NIC card.

Installing the OCP NIC card

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the expansion card riser.
4. Disconnect OCP NIC cable from the SL11_CPU1_PB7 to SL13_CPU1_PB7 connectors on the MAX system board, if 100 GbE OCP NIC card of PCIe width x16 is used.

NOTE: See cable routing section.

CAUTION: Do not install GPUs, network cards, or other PCIe devices on your system that are not validated and tested by Dell. Damage caused by unauthorized and invalidated hardware installation will null and void the system warranty.

Steps

1. If installed, remove the filler bracket.

NOTE: Store the filler bracket for future use. Filler brackets must be installed in empty expansion card slots to maintain Federal Communications Commission (FCC) certification of the system. The brackets also keep dust and dirt out of the system and aid in proper cooling and airflow inside the system.

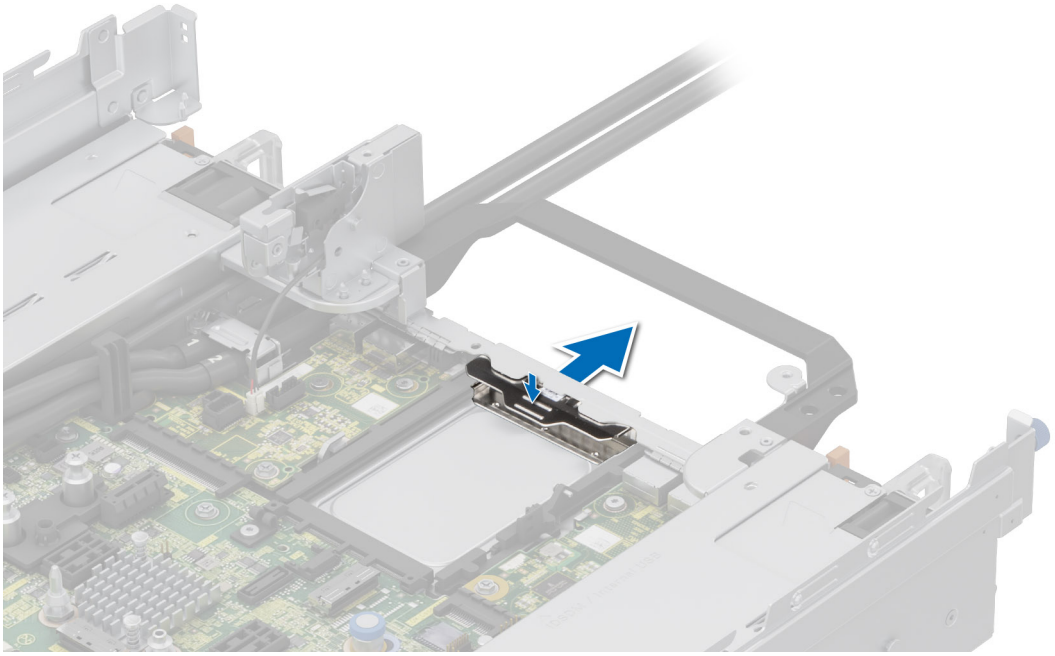


Figure 295. Removal of filler bracket

2. Open the blue latch on the system board.
3. Slide the OCP NIC card into the slot in the system.
4. Push until the OCP NIC card is connected to the connector on the system board.
5. Close the blue latch to lock the OCP NIC card to the system.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

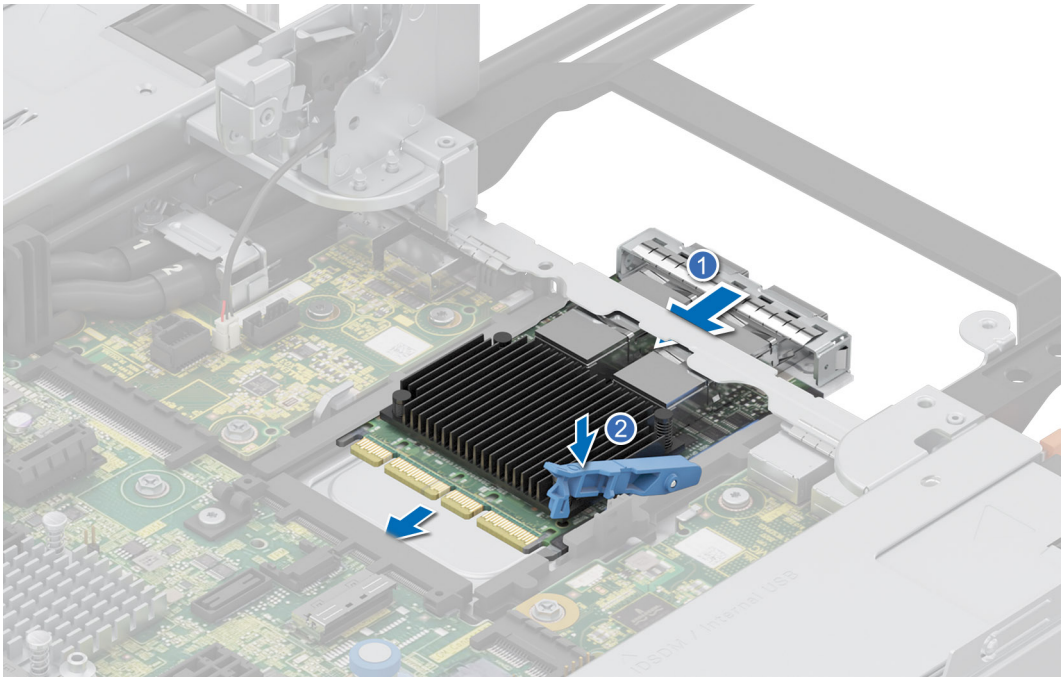


Figure 296. Installing the OCP NIC card

Next steps

1. Connect OCP NIC cable from SL11_CPU1_PB7 to SL13_CPU1_PB7 connectors on the MAX system board, if 100 GbE OCP NIC card of PCIe width x16 is used.

   NOTE: See cable routing section.

2. Install the expansion card riser.
3. Follow the procedure listed in After working inside your system.

Power supply unit

NOTE: While replacing the hot swappable PSU, after next server boot; the new PSU automatically updates to the same firmware and configuration of the replaced one. For updating to the latest firmware and changing the configuration, see the *Lifecycle Controller User's Guide* at iDRAC Manuals.

NOTE: For information about DC PSU cabling instructions, go to PowerEdge Manuals > **Rack Servers** > PowerEdge R760 > **Select This Product** > **Documentation** > **Manuals and Documents** > Cabling instructions for – 48 – 60 V DC power supply.

Hot spare feature

Your system supports the hot spare feature that significantly reduces the power overhead associated with the power supply unit (PSU) redundancy.

When the hot spare feature is enabled, one of the redundant PSUs is switched to the sleep state. The active PSU supports 100 percent of the system load, thus operating at higher efficiency. The PSU in the sleep state monitors output voltage of the active PSU. If the output voltage of the active PSU drops, the PSU in the sleep state returns to an active output state.

If having both PSUs active is more efficient than having one PSU in the sleep state, the active PSU can also activate the sleeping PSU.

The default PSU settings are as follows:

- If the load on the active PSU is more than 50 percent of PSU rated power wattage, then the redundant PSU is switched to the active state.
- If the load on the active PSU falls below 20 percent of PSU rated power wattage, then the redundant PSU is switched to the sleep state.

You can configure the hot spare feature by using the iDRAC settings. For more information, see the *iDRAC User's Guide* available at PowerEdge Manuals.

Removing a power supply unit blank

Prerequisites

Follow the safety guidelines listed in the Safety instructions.

Steps

Pull the blank out of the system.

CAUTION: To ensure proper system cooling, the PSU blank must be installed in the second PSU bay in a non-redundant configuration. Remove the PSU blank only if you are installing a second PSU.

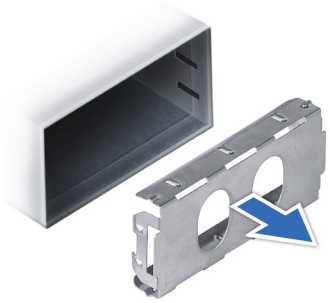


Figure 297. Removing a power supply unit blank

Next steps

1. Replace the PSU blank or install the PSU.

Installing a power supply unit blank

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.

   NOTE: Install the power supply unit (PSU) blank only in the second PSU bay.

2. If required, Remove the PSU.

Steps

Align the PSU blank with the PSU bay and push it into the PSU bay until it clicks into place.

Figure 298. Installing a power supply unit blank

Removing a power supply unit adapter

Remove the PSU adapter, when installing PSU with 86 mm wide form factor.

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

Using a Phillips #1 screwdriver, loosen the screw and remove the power supply unit adapter.

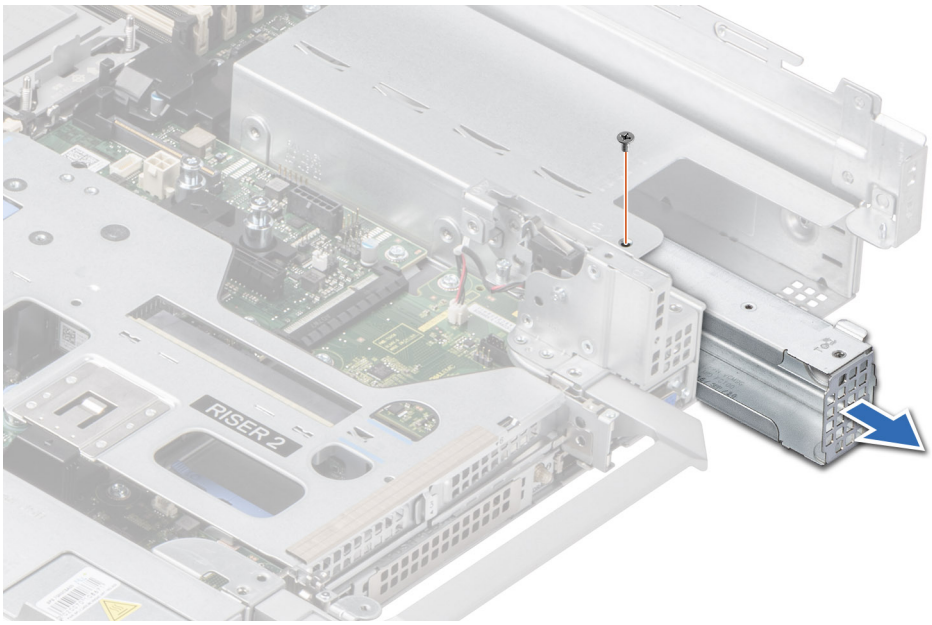


Figure 299. Removing a power supply unit adapter

Next steps

1. Replace the PSU adapter or Install the PSU.

Installing a power supply unit adapter

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. If required, Remove the PSU.

NOTE: Remove the PSU adapter, when installing PSU with 86 mm wide form factor.

Steps

1. Align and insert the power supply unit adapter.
2. Using a phillips #1 screwdriver, tighten the screw.

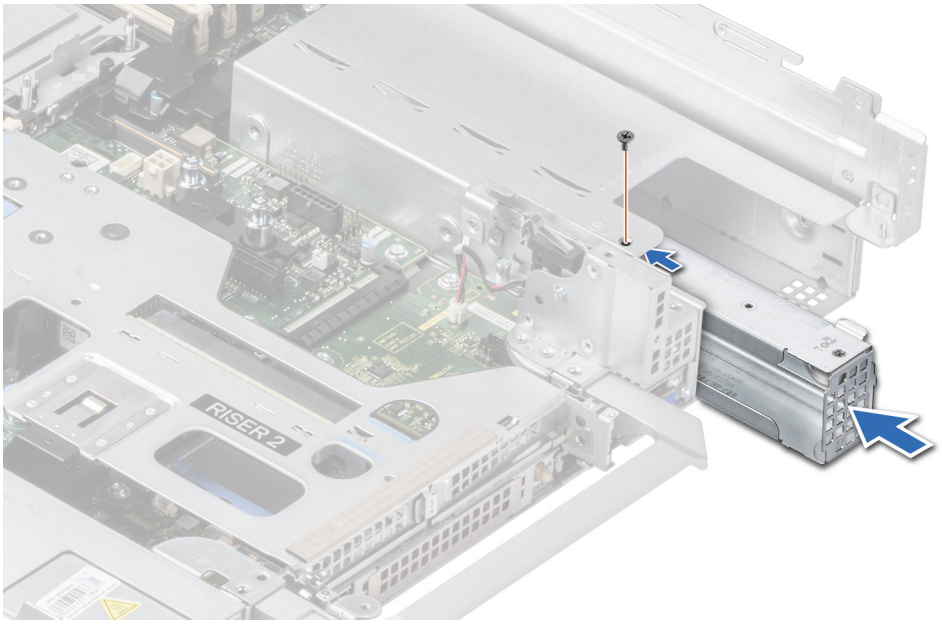


Figure 300. Installing a power supply unit adapter

Next steps

1. Follow the procedure listed in After working inside your system.

Removing a power supply unit

Prerequisites

CAUTION: The system requires one power supply unit (PSU) for normal operation. On power-redundant systems, remove and replace only one PSU at a time in a system that is powered on.

1. Follow the safety guidelines listed in the Safety instructions.
2. Disconnect the power cable from the power outlet and from the PSU that you intend to remove.
3. Remove the cable from the strap on the PSU handle.
4. Unlatch and lift or remove the optional cable management accessory if it interferes with the PSU removal.

NOTE: For information about the cable management when the PSU is removed or installed while the system is in a rack, see the system's cable management arm documentation at PowerEdge Manuals.

Steps

Press the release latch and holding the PSU handle, slide the PSU out of the bay.

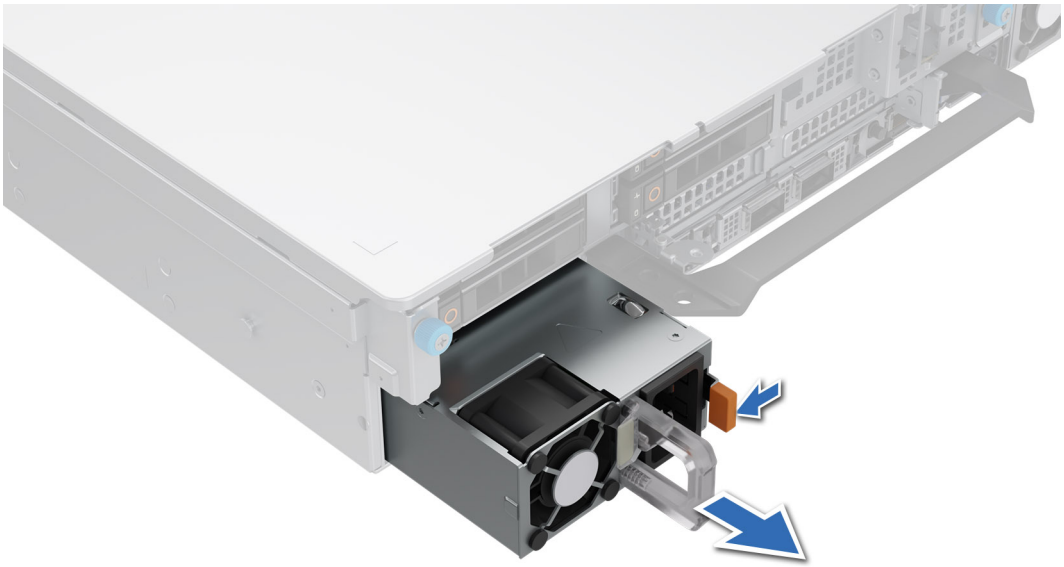


Figure 301. Removing a power supply unit

Next steps

1. Replace the PSU or install the PSU blank.

Installing a power supply unit

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. For systems that support redundant PSU, ensure that both the PSUs are of the same type and have the same maximum output power.

   NOTE: The maximum output power (shown in watts) is listed on the PSU label.

3. If required, Remove the PSU blank.

Steps

Slide the PSU into the PSU bay until the release latch snaps into place.

Figure 302. Installing a power supply unit

Next steps

1. If you have unlatched or removed the cable management accessory, reinstall or relatch it. For information about the cable management when the PSU is removed or installed while the system is in the rack, see the system's cable management accessory documentation at PowerEdge Manuals.
2. Connect the power cable to the PSU, and plug the cable into a power outlet.

CAUTION: When connecting the power cable to the PSU, secure the cable to the PSU with the strap.

NOTE: When installing hot swapping, or hot adding a new PSU, wait for 15 seconds for the system to recognize the PSU and determine its status. The PSU redundancy may not occur until discovery is complete. The PSU status indicator turns green to indicate that the PSU is functioning properly.

Trusted Platform Module

This is a service technician replaceable part only.

Upgrading the Trusted Platform Module

Removing the TPM

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

NOTE:

- Ensure that the operating system is compatible with the TPM version you are installing.
- Ensure that you download and install the latest BIOS firmware on your system.
- Ensure that the BIOS is configured to enable UEFI boot mode.

CAUTION: The TPM plug-in module is cryptographically bound to that particular system board after it is installed. When the system is powered on, any attempt to remove an installed TPM plug-in module breaks the cryptographic binding, and the removed TPM cannot be installed on another system board. Ensure any keys that you have stored on the TPM have been securely transferred.

Steps

1. Locate the TPM connector on the system board. For more information, see system board connectors .
2. Press to hold the module down and remove the screw using the security Torx 8-bit shipped with the TPM module.
3. Slide the TPM module out from its connector.
4. Push the plastic rivet away from the TPM connector and rotate it 90° counterclockwise to release it from the system board.
5. Pull the plastic rivet out of its slot on the system board.

Installing the TPM

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.

Steps

1. To install the TPM, align the edge connectors on the TPM with the slot on the TPM connector.
2. Insert the TPM into the TPM connector such that the plastic rivet aligns with the slot on the system board.
3. Press the plastic rivet until the rivet snaps into place.
4. Replace the screw that secures the TPM to the system board.

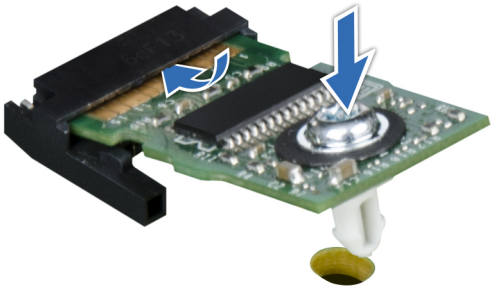


Figure 303. Installing the TPM

Initializing TPM for users

Steps

1. Initialize the TPM.
   For more information, see Initialize the TPM 2.0 for users.
2. The **TPM Status** changes to **Enabled, Activated**.

Initializing the TPM 2.0 for users

Steps

1. While booting your system, press F2 to enter System Setup.
2. On the **System Setup Main Menu** screen, click **System BIOS** > **System Security Settings**.

3. From the **TPM Security** option, select **On**.
4. Save the settings.
5. Restart your system.

System board

This is a service technician replaceable part only.

Removing the system board

Prerequisites

CAUTION: If you are using the Trusted Platform Module (TPM) with an encryption key, you may be prompted to create a recovery key during program or System Setup. Be sure to create and safely store this recovery key. If you replace this system board, you must supply the recovery key when you restart your system or program before you can access the encrypted data on your drives.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the following components:
   a. Air shroud
   b. Cooling fan cage assembly
   c. Side wall bracket
   d. Memory modules
   e. Serial COM port (if installed)
   f. VGA port (if installed)
   g. Expansion card risers
   h. Rear drive module
   i. Processor and heat sink module or Direct Liquid Cooling module
   j. R1 and R4 paddle cards (if installed)
   k. BOSS-N1 module
   l. GPU air shroud (if installed)
   m. Internal USB card (if installed)
   n. OCP card (if installed)
   o. Power supply units (PSU)
   p. Disconnect all the cables from the system board and make note of all the cable connections.

CAUTION: Take care not to damage the system identification button while removing the system board from the system.

CAUTION: Do not lift the system board by holding a memory module, processor, or other components.

Steps

1. Using the system board holder and plunger, slide the system board towards the front of the system.
2. At a tilted angle, lift the system board out of the chassis.

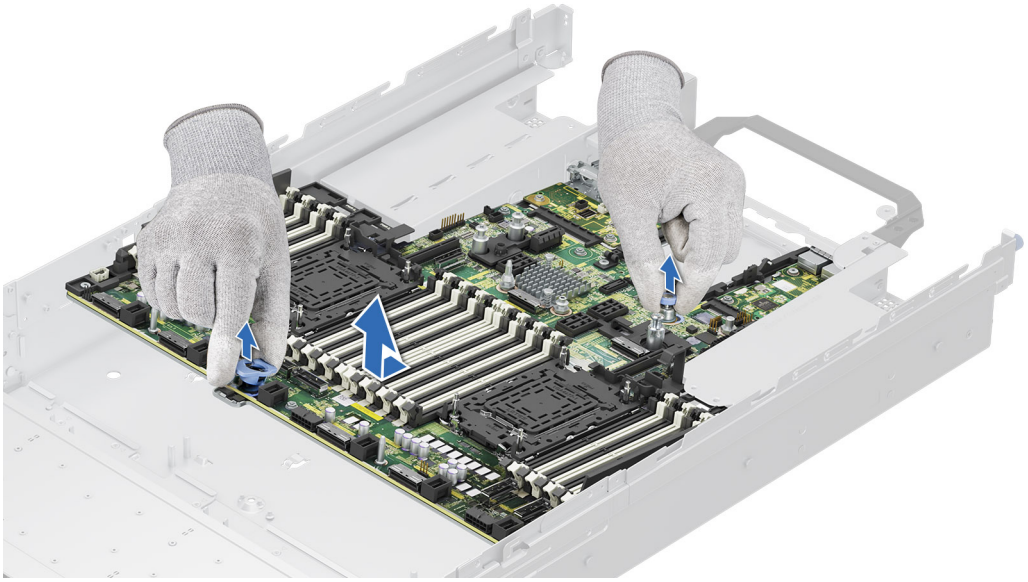


Figure 304. Removing the system board

Next steps

1. Install the system board.

Installing the system board

Prerequisites

NOTE: Before replacing the system board, replace the old iDRAC MAC address label on the Express Service Tag with the iDRAC MAC address label of the replacement system board.

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in Before working inside your system.
3. If you are replacing the system board, remove all the components that are listed in the removing the system board section.

Steps

1. Unpack the new system board assembly.

   CAUTION: Do not lift the system board by holding a memory module, processor, or other components.

   CAUTION: Take care not to damage the system identification button while placing the system board into the chassis.

2. Holding the system board holder and plunger, lower the system board at a tilted angle into the system.
3. Slide the system board towards the rear of the chassis until the connectors are firmly seated in the slots.

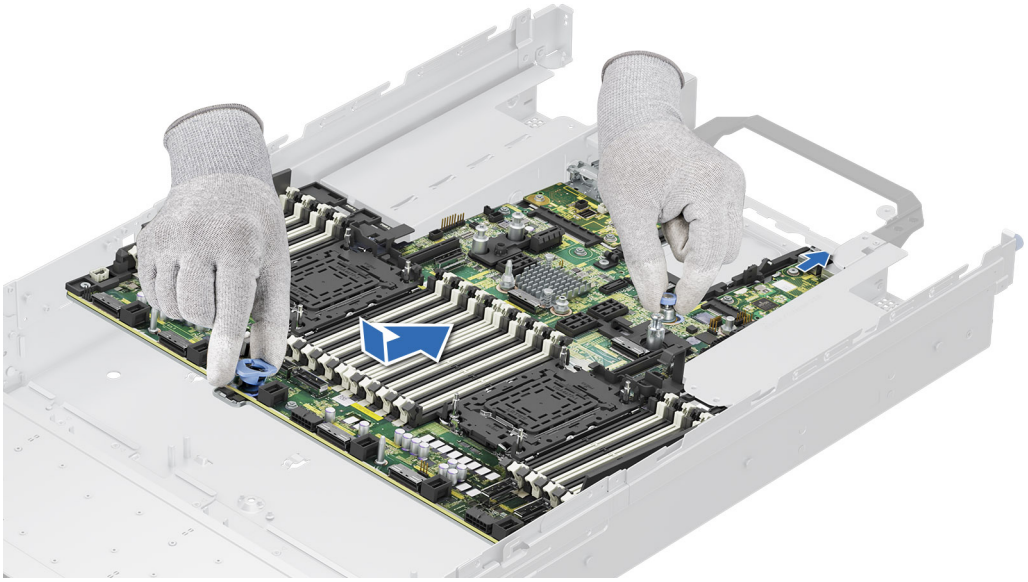


Figure 305. Installing the system board

Next steps

1. Replace the following components:
   a. Trusted Platform Module (TPM)

      NOTE: The TPM Module must be replaced only while installing a new system board.

   b. Internal USB card (if removed)
   c. OCP card (if removed)
   d. Processor and heat sink module or Direct Liquid Cooling module
   e. Memory modules
   f. R1 and R4 paddle cards (if removed)
   g. GPU air shroud (if removed)
   h. Expansion card risers
   i. Rear drive module
   j. VGA port (if removed)
   k. Serial COM port (if removed)
   l. BOSS-N1 module
   m. Side wall bracket
   n. Cooling fan cage assembly
   o. Air shroud
   p. Power supply units (PSU)
2. Reconnect all cables to the system board.

   NOTE: Ensure that the cables inside the system are routed along the chassis wall and secured using the cable securing bracket.

3. Ensure that you perform the following steps:
   a. Use the Easy Restore feature to restore the Service Tag. See the Restoring the system by using the Easy Restore feature section.
   b. If the service tag is not backed up in the backup flash device, enter the system service tag manually. See the Manually update the Service Tag by using System Setup section.
   c. Install BIOS and iDRAC version updates, Diagnostics, and OS Driver Pack and OS Collector.
   d. Re-enable the Trusted Platform Module (TPM). See the Upgrading the Trusted Platform Module section.
4. Follow the procedure listed in After working inside your system.

Restoring the system using Easy Restore

The Easy Restore feature enables you to restore your service tag, license, UEFI configuration, and the system configuration data after replacing the system board. All data is backed up in a backup flash device automatically. If BIOS detects a new system board, and the service tag in the backup flash device, BIOS prompts the user to restore the backup information.

About this task

Below is a list of options/steps available:

Steps

1. Restore the service tag, license, and diagnostics information, press **Y**
2. Navigate to the Lifecycle Controller based restore options, press **N**
3. Restore data from a previously created **Hardware Server Profile**, press **F10**

   NOTE: When the restore process is complete, BIOS prompts to restore the system configuration data.

4. Restore data from a previously created **Hardware Server Profile**, press **F10**
5. To restore the system configuration data, press **Y**
6. To use the default configuration settings, press **N**

   NOTE: After the restore process is complete, system reboots.

Manually update the Service Tag

After replacing a system board, if Easy Restore fails, follow this process to manually enter the Service Tag, using **System Setup**.

About this task

If you know the system service tag, use the **System Setup** menu to enter the service tag.

Steps

1. Power on the system.
2. To enter the **System Setup**, press **F2**.
3. Click **Service Tag Settings**.
4. Enter the service tag.

   NOTE: You can enter the service tag only when the **Service Tag** field is empty. Ensure that you enter the correct service tag. Once the service tag is entered, it cannot be updated or changed. Incorrectly entered service tag will lead to system board replacement.

5. Click **OK**.

LOM card, MIC card and rear I/O board

Removing the LOM card, MIC card and rear I/O board

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the system board.

   NOTE: The procedure to remove the liquid cooling rear I/O board and rear I/O board is the same.

Steps

1. Using a Phillips # 2 screwdriver, remove the screws that secure the LAN on Motherboard (LOM) card, Management Interface card (MIC), and rear I/O board to the system board.
2. Holding the edges, pull the LOM card, MIC card, or rear I/O board to disconnect from the connector on the system board.

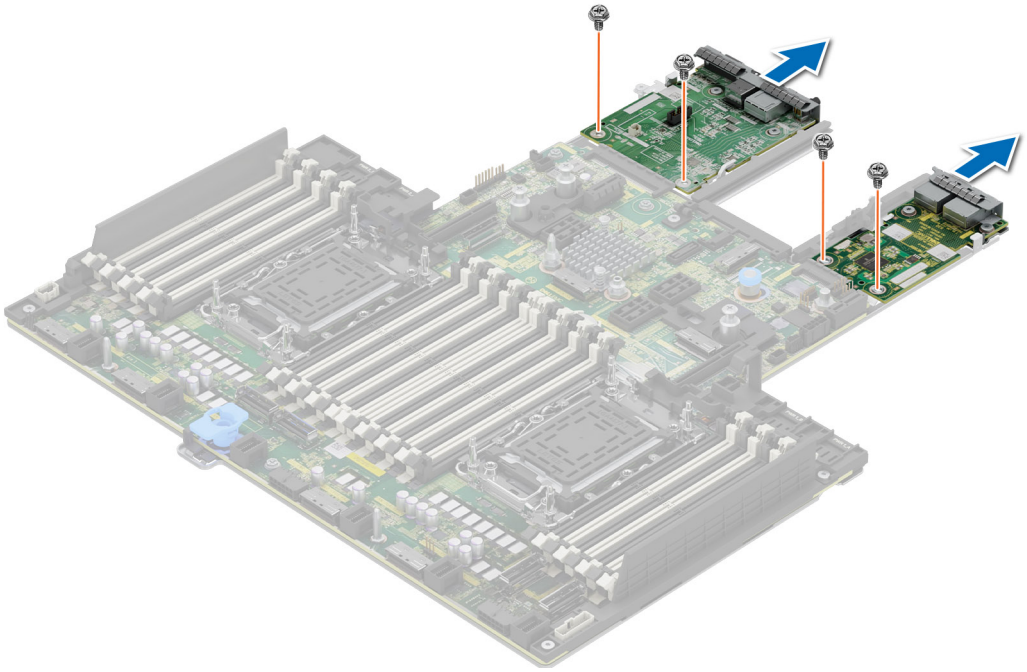


Figure 306. Removing the LOM card and rear I/O board

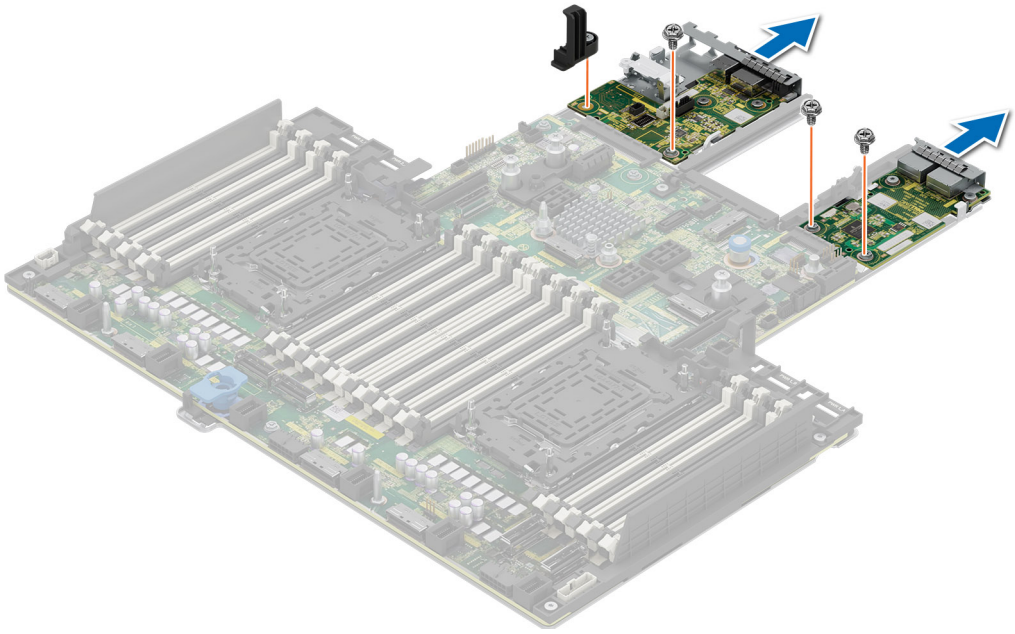


Figure 307. Removing the LOM card and liquid cooling rear I/O board

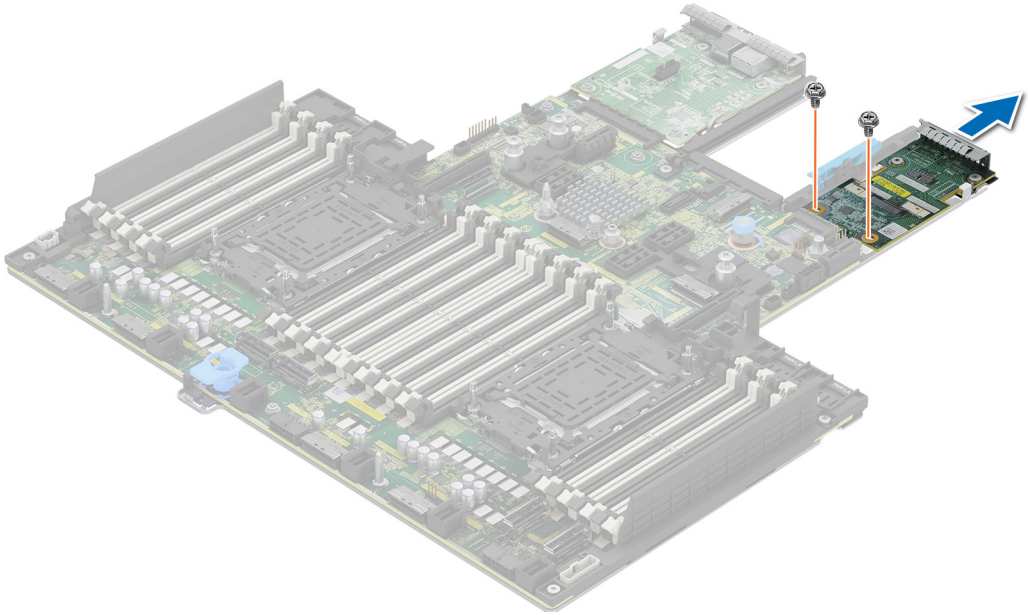


Figure 308. Removing the MIC card

NOTE: MIC is card is only available in the system that supports Dell DPU cards.

Next steps

1. Replace the LOM card, MIC card and rear I/O board.

Installing the LOM card, MIC card and rear I/O board

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the system board.

NOTE: The procedure to install the liquid cooling rear I/O board and rear I/O board is the same.

Steps

1. Align the connectors and slots on the LAN on Motherboard (LOM) card, Management Interface card (MIC), or rear I/O board with the connector and standoffs on the system board.
2. Press the LOM card, MIC card, or rear I/O board until firmly seated on the system board connector.
3. Using a Phillips #2 screwdriver, secure the LOM card, MIC card or rear I/O board to the system board with screws.

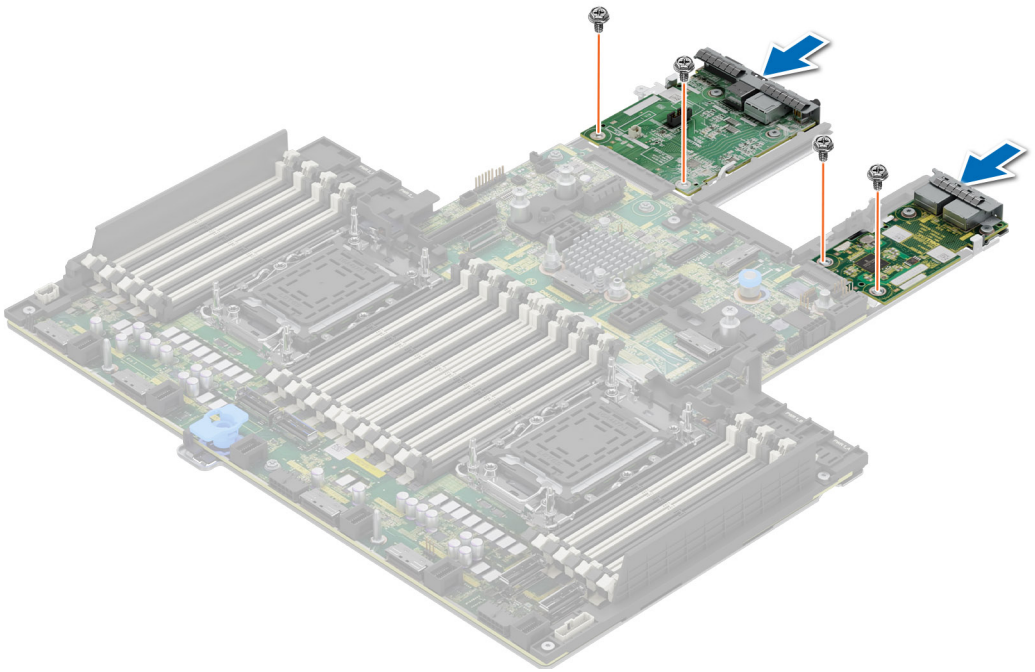


Figure 309. Installing the LOM card and rear I/O board

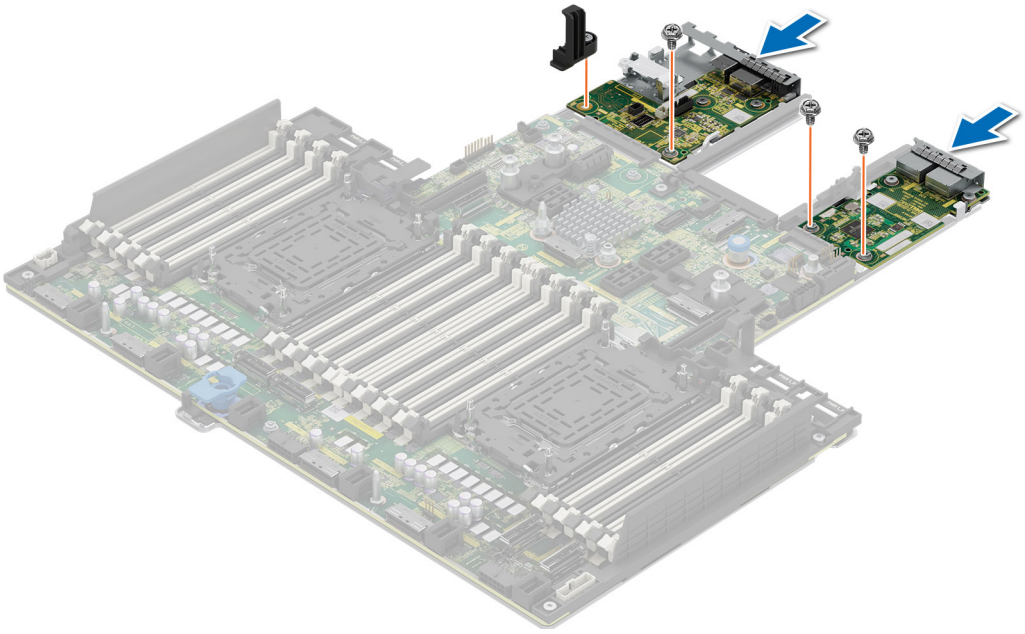


Figure 310. Installing the LOM card and Liquid cooling rear I/O board

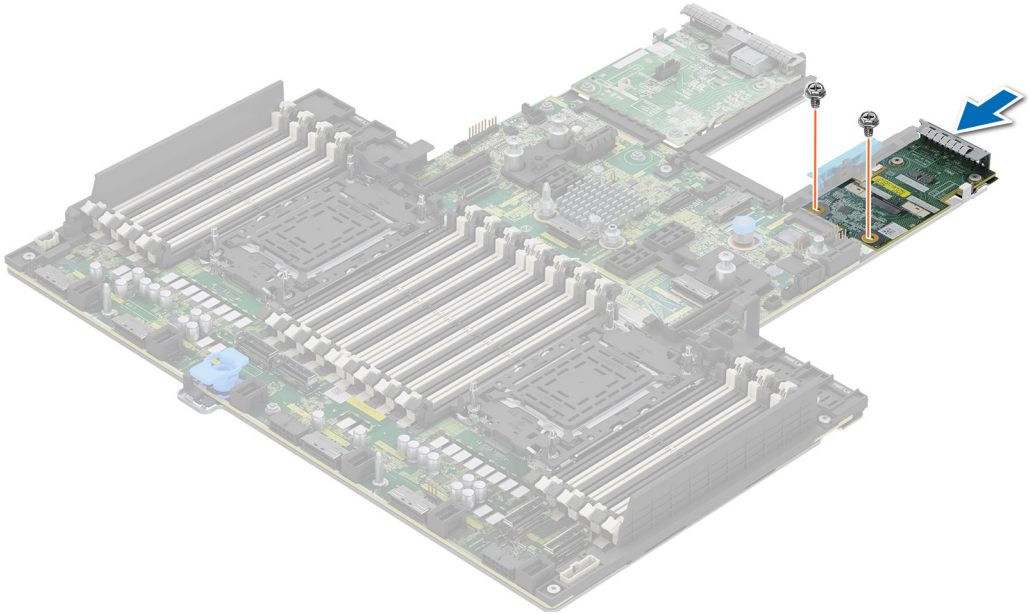


Figure 311. Installing the MIC card

NOTE: MIC is card is only available in the system that supports Dell DPU cards.

Next steps

1. Install the system board.
2. Follow the procedure listed in After working inside your system.

Control panel

This is a service technician replaceable part only.

Removing the right control panel

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the drive backplane cover.
4. If installed, remove the air shroud or remove the GPU air shroud.
5. Remove the cooling fan cage assembly.
6. Remove the side wall bracket.

Steps

1. Using the Phillips #1 screwdriver, remove the screws that secure the right control panel and cable cover to the system.
2. Remove the cable cover away from the system.
3. Disconnect the right control panel cable and the VGA cable from the connectors on the system board.
4. Holding the right control panel and VGA cable assembly, slide the right control panel out of the system.

NOTE: Observe the routing of the cable assembly as you remove the right control panel from the system.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

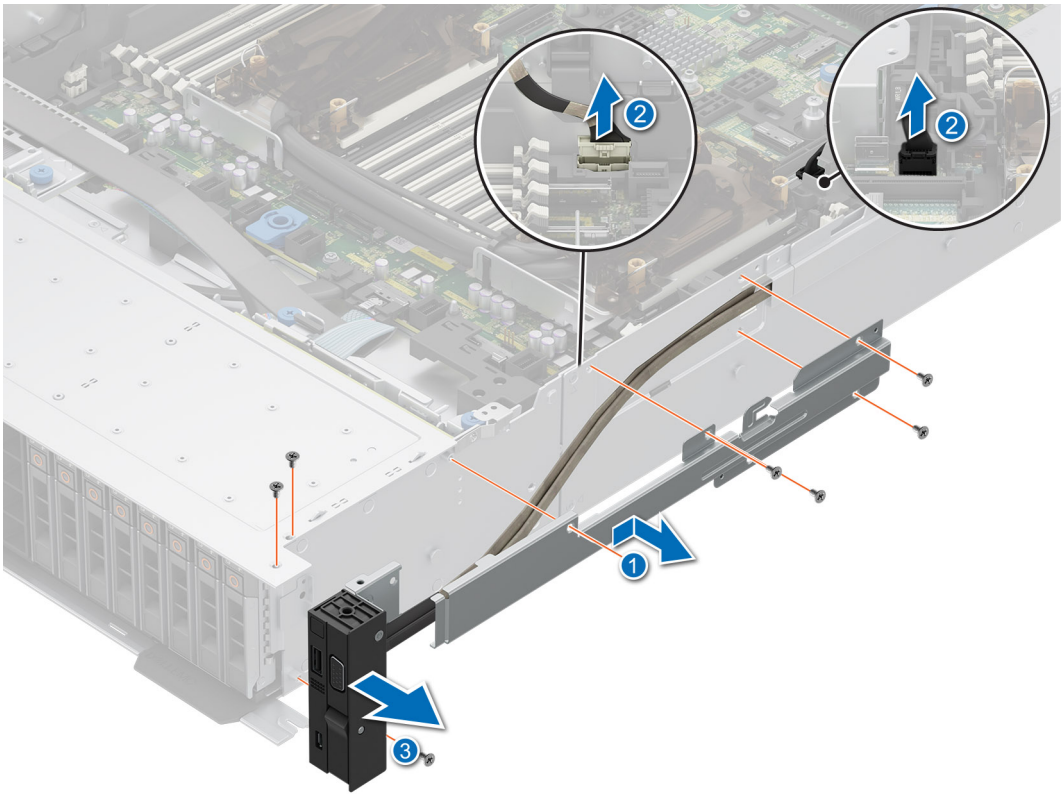


Figure 312. Removing the right control panel

Next steps

1. Replace the right control panel.

Installing the right control panel

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the drive backplane cover.
4. If installed, remove the air shroud or remove the GPU air shroud.
5. Remove the cooling fan cage assembly.
6. Remove the side wall bracket.

Steps

1. Align and slide the right control panel into the slot on the system.
2. Route the right control panel cable through the side wall of the system.
3. Align and slide the right control panel cable cover in the slot on the system.

   NOTE: Route the cable properly to prevent the cable from being pinched or crimped.

4. Connect the right control panel cable and VGA cable to the connectors on the system board.
5. Using the Phillips #1 screwdriver, tighten the screws that secure the right control panel and the cable cover to the system.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

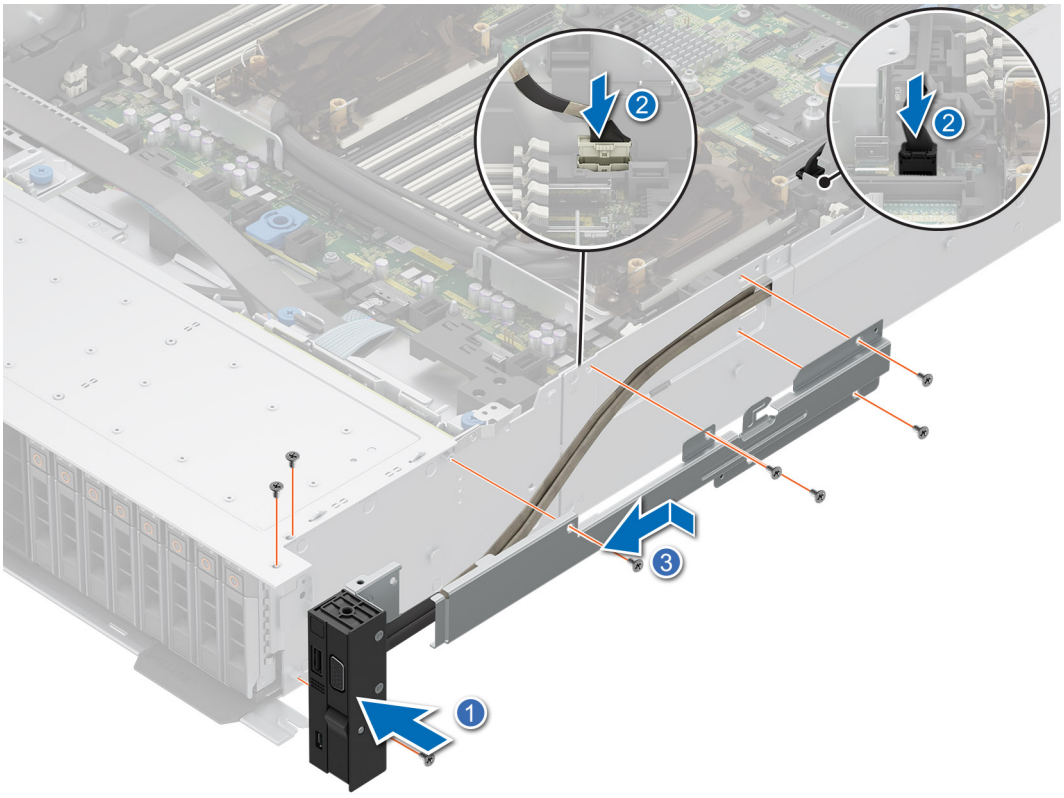


Figure 313. Installing the right control panel

Next steps

1. Install the side wall bracket.
2. Install the cooling fan cage assembly.
3. Install the drive backplane cover.
4. If removed, install the air shroud or install the GPU air shroud
5. Follow the procedure listed in After working inside your system.

Removing the left control panel

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the drive backplane cover.
4. If installed, remove the air shroud or remove the GPU air shroud.
5. Remove the cooling fan cage assembly.
6. Remove the side wall bracket.

Steps

1. Using the Phillips #1 screwdriver, remove the screws that secure the left control panel and the cable cover to the system.
2. Remove the cable cover away from the system.
3. Disconnect the control panel cable from the connector on the system board.
4. Holding the cable, slide the left control panel out of the system.

NOTE: Observe the routing of the cable as you remove the left control panel from the system.

NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

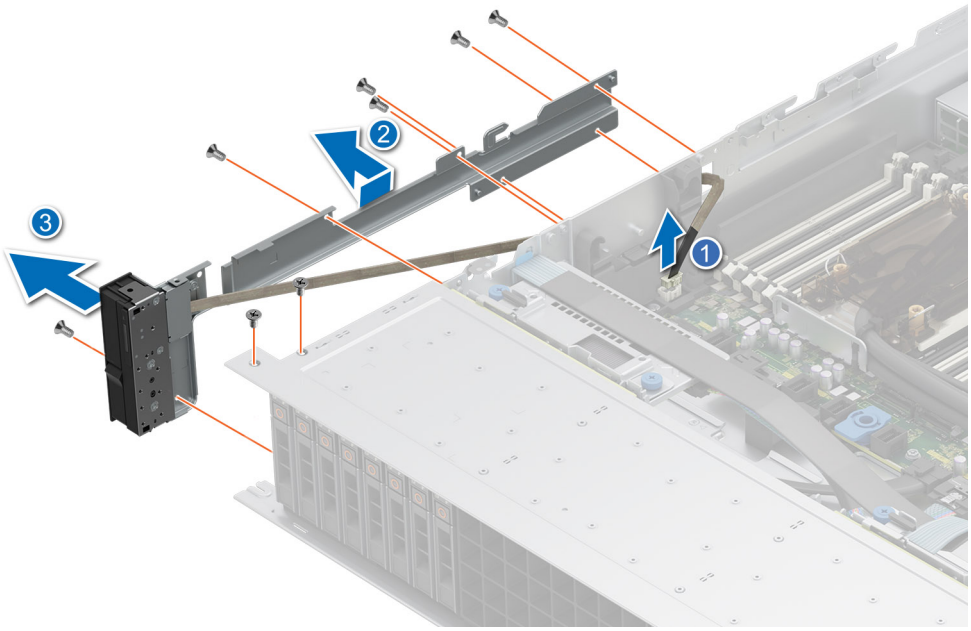


Figure 314. Removing the left control panel

Next steps

1. Replace the left control panel.

Installing the left control panel

Prerequisites

1. Follow the safety guidelines listed in the Safety instructions.
2. Follow the procedure listed in the Before working inside your system.
3. Remove the drive backplane cover.
4. If installed, remove the air shroud or remove the GPU air shroud.
5. Remove the cooling fan cage assembly.
6. Remove the side wall bracket.

Steps

1. Align and slide the left control panel in the slot on the system.
2. Route the left control panel cable through the side wall of the system.
3. Align and slide the left control panel cable cover in the slot on the system.

   NOTE: Route the cable properly to prevent the cable from being pinched or crimped.

4. Connect the left control panel cable to the connector on the system board .
5. Using the Phillips #1 screwdriver, tighten the screws to secure the left control panel and the cable cover to the system.

   NOTE: The numbers on the image do not depict the exact steps. The numbers are for representation of sequence.

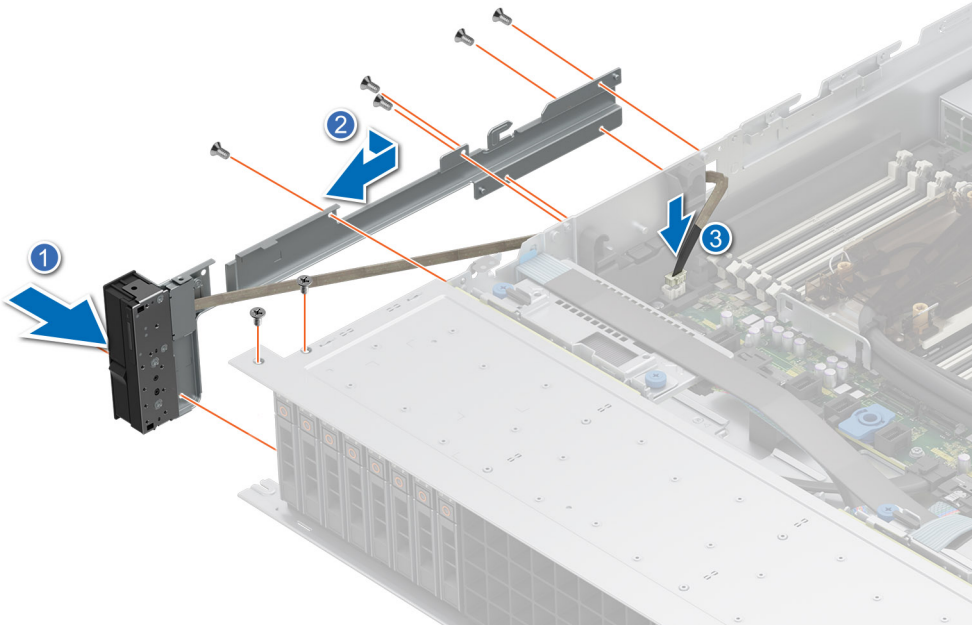


Figure 315. Installing the left control panel

Next steps

1. Install the side wall bracket.
2. Install the cooling fan cage assembly.
3. Install the drive backplane cover.
4. If removed, install the air shroud or install the GPU air shroud
5. Follow the procedure listed in After working inside your system.

8

Upgrade Kits

The table lists the available After Point Of Sale [APOS] kits.

Table 170. Upgrade kits

Kits	Related links to service instructions
Bezel	See Installing the front bezel
M.2 NVMe SSD	See Installing the M.2 NVMe SSD module
BOSS-N1	See Installing the BOSS-N1 controller card module
GPU	See GPU kit
Drives	See Installing the drive
Memory	See Installing a memory module
PERC	See Installing the rear mounting front PERC module and also see the document included with the kit.
Network cards (Standard PCIe adapter LP/FH)	See Installing the LOM card and rear I/O board
Network cards (OCP)	See Installing the OCP card
PCIe SSD card	See Installing the drive
Power cords	Offered, but without special service instructions
Power supplies	See Installing a power supply unit
Quick sync	Offered, but without special service instructions
TPM	See Upgrading the Trusted Platform Module
Processor enablement thermal kits	See Installing the processor
Internal USB 3.0 card	See Internal USB card kit
Serial COM port	See Installing the serial COM port
Cables	Offered, but without special service instructions
Fans	See Installing a fan
Heat sink	See Installing a processor heat sink module or Direct Liquid Cooling Module
Risers	Not available as APOS kits, upgrades offered only with the "Basic Deployment Upgrade of Dell Server" service
Rail	Offered, but without special service instructions
Cable Management Arm (CMA)	Offered, but without special service instructions **NOTE:** CMA is not supported in Direct Liquid Cooling configuration.

Topics:

- BOSS-N1 module kit
- GPU kit
- Internal USB card kit
- Serial COM port kit

BOSS-N1 module kit

The BOSS-N1 module supports up to two M.2 NVMe SSDs.

Before you begin the installation or removal process, follow the safety guidelines and before working inside the system instructions.

Table 171. BOSS-N1 module kit components

Components in kit	R760 (quantity)
BOSS-N1 controller card module	1
BOSS-N1 card carrier	1 or 2*
M.2 NVMe SSD	1 or 2*
M.2 NVMe SSD capacity label	1 or 2†
BOSS-N1 card carrier blank	1
M3 x 0.5 x 4.5 mm screws	1
BOSS-N1 power cable for Riser 1 (220 mm)	1
BOSS-N1 signal cable for Riser 1 (170 mm)	1
BOSS-N1 power cable for x4 rear drive module (260 mm)	1
BOSS-N1 signal cable for x4 rear drive module (240 mm)	1

NOTE: *The quantity depends on the purchase order.

NOTE: †The quantity depends on the BOSS-N1 card carrier

To remove the BOSS blank :

1. Power off the system and remove the system cover.
2. Use a screwdriver to push out the blank from the BOSS-N1 module bay.

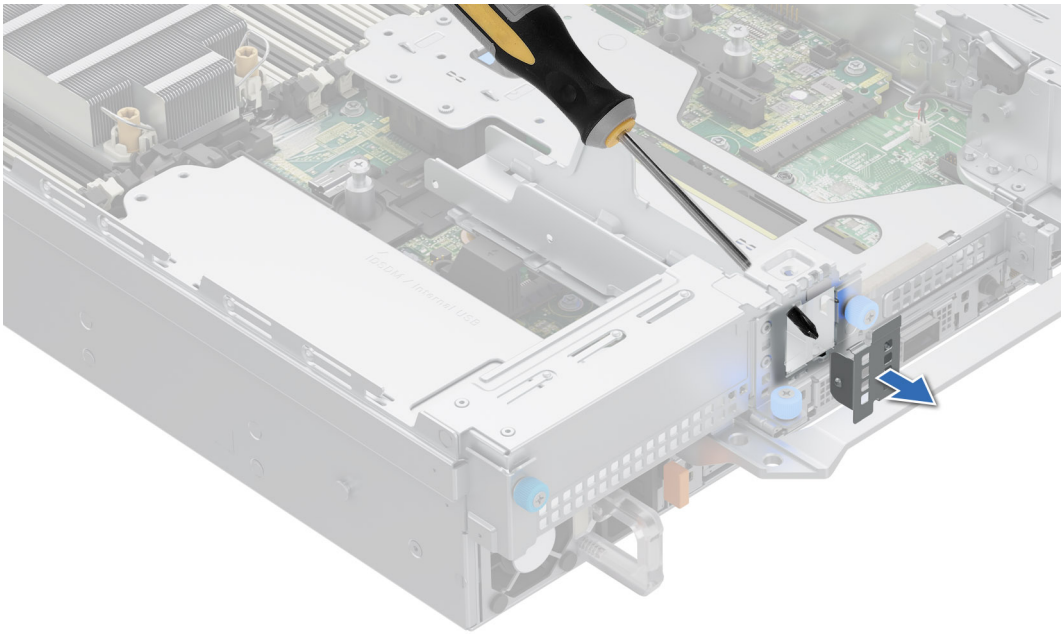


Figure 316. Removing the BOSS-N1 module blank

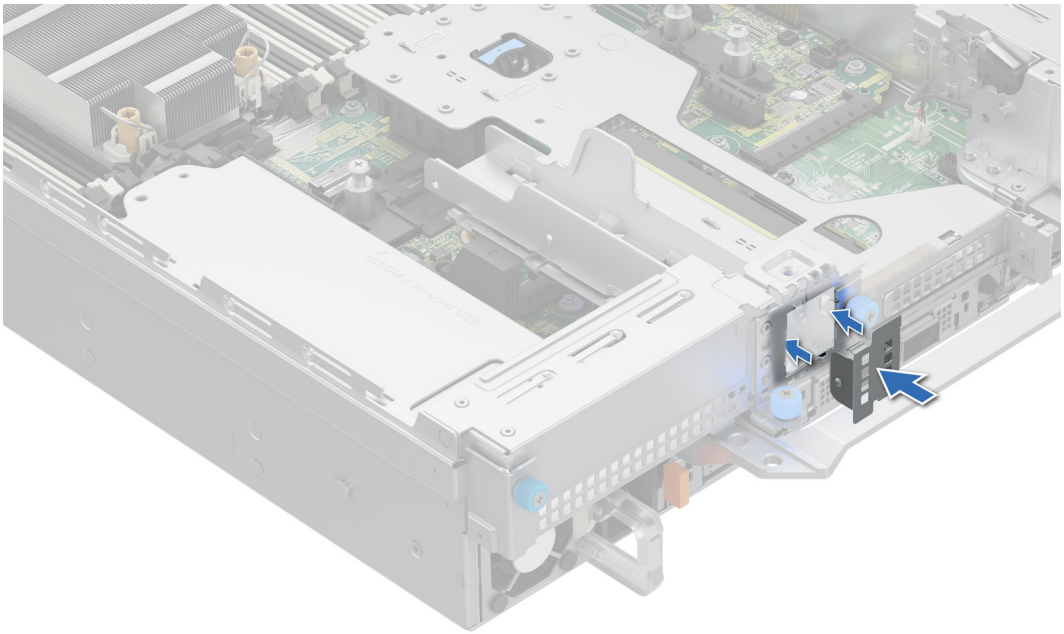


Figure 317. Installing the BOSS-N1 module blank

To install the BOSS-N1 module:

1. To install the BOSS-N1 module , see installing the BOSS-N1 module steps 1 to 5.
2. To install the M.2 NVMe SSD and BOSS-N1 card carrier, see installing the BOSS-N1 module steps 6 to 10.

NOTE: Install a BOSS-N1 card carrier blank if you are only using one BOSS-N1 card carrier.

NOTE: Refer to cable routing section, configuration 49 and 50 for more information about connecting the BOSS cables to system board connectors.

NOTE: The installation of the BOSS-N1 module to the Riser 1 and 4 x 2.5-inch rear drive module is similar.

NOTE: Installing the BOSS-N1 card carrier does not require the system to be powered off. System shutdown is only required when installing the BOSS-N1 controller card module.

GPU kit

The GPU FL kit is available for the Customer. Depending on the kit ordered, the respective components are available.

CAUTION: Do not install GPUs, network cards, or other PCIe devices on your system that are not validated and tested by Dell. Damage caused by unauthorized and invalidated hardware installation will null and void the system warranty.

CAUTION: Double Width (DW) GPU only supported on Riser Configurations 3-2, 5-2, or 10-2. APOS Riser upgrades to Riser Configurations 3, 5, and 10 are not supported.

WARNING: Consumer-Grade GPU should not be installed or used in the Enterprise Server products.

Table 172. Components in the full length (FL) GPU kit

Components	GPU FL kit	
	Details	**Quantity**
Risers	Riser configuration (RC) 3-2, 5-2*, or, 10-2*	RC 3-2: R1P^ (FL) + R2A (HL) + R3B (HL) + R4P^ (FL) RC 5-2: R1R (FL) + R2A (HL) + R3A (FL) + R4P^ (FL) RC 10-2: R1P^ (FL) + R2A (HL) + R4R (FL)
Shroud	GPU shroud	1
Fans	HPR GOLD fan	6
Heat sinks	L-type heat sink for processor 1 and processor 2	RC 3-2, 5-2: 2 RC 10-2: 1
Cables	Power cable	2 x 4 (8-position) or 2 x 6 + 1 x 4 (12-position + 4-sideband)
FL - Full Length, HL - Half Length, HPR - High Performance, RC - Riser configuration		

NOTE: Adding GPUs to a system may increase the power envelope of that configuration beyond the current power supplies rated capability. Confirm power increase and upgrade PSU as needed to avoid negative impact on performance.

NOTE: The power cable is imprinted with a silkscreen indicating which connector on the system board and to which GPU it should be connected. Refer to the GPU power cable matrix table below for the power cable required for your GPU.

NOTE: Populate only processor 1 slot in RC10-2, as it only supports a single processor configuration.

NOTE: See expansion card installation guidelines for more information about riser configuration supported for the system.

NOTE: ^ R1P and R4P supports Double Width (DW) GPU.

NOTE: *The configuration 5-2 supports DW GPU only on slot 7 and configuration 10-2 supports DW GPU only on slot 2.

NOTE: All GPU cards require an L-type heat sink and GPU shroud, irrespective of the length. However, the cooling fan and foam are dependent on different configurations which is shown in the below table.

Before you begin, follow the safety guidelines and before working inside the system instructions.

1. Remove the standard or High Performance Silver (HPR) cooling fans and install the High performance Gold (VHP) cooling fans.

   NOTE: See the cooling fan and foam requirement matrix for the cooling fan and foam requirement for different configurations.

Table 173. Cooling fan and foam requirement matrix

System configuration	Cooling fan	Foam requirement
	w/GPU	w/GPU
8 x 2.5-inch NVMe	HPR GOLD	No
8 x 2.5-inch NVMe + 8 x 2.5-inch SAS/SATA	HPR GOLD	Yes
16 x 2.5-inch SAS/SATA	HPR GOLD	Yes
16 x 2.5-inch NVMe	HPR GOLD	No
24 x 2.5-inch SAS/SATA	HPR GOLD	Yes
16 x 2.5-inch SAS/SATA + 8 x 2.5-inch NVMe	HPR GOLD	Yes
24 x 2.5-inch NVMe	HPR GOLD	No
16 X EDSFF E3.S NVMe	HPR GOLD	No
NOTE: HPR GOLD is also known as High performance Gold (HPR GOLD) fans.		

NOTE: Foam is required for all the configurations with rotational drives having:

- 3.5-inch drives with HPR Silver or HPR Gold fan
- 2.5-inch drives with HPR Gold fan

NOTE: For more information about supported cooling fans matrix, see the thermal restriction matrix section.

NOTE: 12 x 3.5-inch and rear drive configuration systems do not support a GPU card.

2. Remove the air shroud.
3. Remove the processor and heat sink module and also remove the processor.

NOTE: All GPU cards require an L-type heat sink and GPU shroud that is installed, irrespective of the length.

4. Install the processor on L-type heat sink and install the processor and heat sink module.
5. Install the GPU air shroud.
6. Remove the GPU air shroud top cover.

NOTE: The GPU air shroud top cover is part of the GPU air shroud.

7. Remove the GPU air shroud filler.
8. Install the GPU into full length risers.

NOTE: See installing full length expansion card riser into the system.

NOTE: For information about riser slot location on the system board, see the System board jumpers and connectors section.

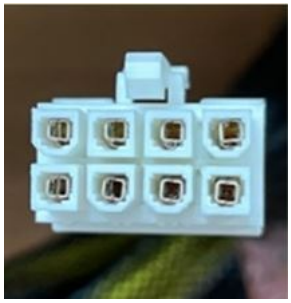
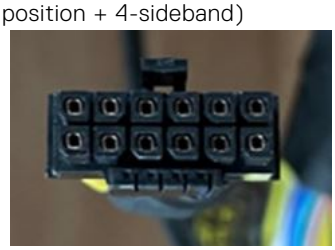
9. If applicable, connect the power cables to the GPU. To know the connectors for the GPU on the system board, see the System board jumpers and connectors section.

   See the GPU power cable matrix to know about the requirement of cables for the GPU.

Table 174. GPU power cable matrix

Category	Supported GPUs	Type	Vendor	Cable	Cable quantity
GPU	NVIDIA A2, L4	HL (FH and LP brackets)	NVIDIA	Not required	Not required

Table 174. GPU power cable matrix (continued)

Category	Supported GPUs	Type	Vendor	Cable	Cable quantity
GPU	NVIDIA A30, A40, A16, A100, and A800	FH and FL	NVIDIA	CPU type 2 x 4 (8-position) 	1 each for Riser 1 and Riser 4
GPU	NVIDIA H100, L40, and L40S	FH and FL	NVIDIA	12VH type 2 x 6 + 1 x 4 (12-position + 4-sideband) 	1 each for Riser 1 and Riser 4
HL - Half Length, FH - Full Height, FL - Full Length					

NOTE: A maximum of two DW GPUs with power cables or a maximum of six SW GPUs are supported in a system based on riser configuration.

10. Install the full length expansion card riser or half height expansion card riser. See GPU kit components table for supported GPU risers.
11. If installing SW GPU Install the GPU air shroud filler.
12. Install the GPU air shroud top cover.
13. Install the foam on the system cover. To install the foam,
    a. Place the system cover with the System Information Label (SIL) side facing up.
    b. Clean the surface of the system cover and make sure it is clean before attaching the foam.
    c. For easier handling, peel off a small section of the adhesive cover and align the foam with the system cover.
    d. Remove rest of the adhesive cover, and install foam on the system cover.
    e. Press along the length of the foam to ensure that it is firmly affixed to the system cover.

Figure 318. Installing foam on the system cover

After installing, follow the After working inside the system instructions.

Internal USB card kit

The internal USB card kit contains one internal USB card. For installation of internal USB card, see installing the internal USB card section.

NOTE: Ensure to install the internal USB card in the USB card port and not in the J_R3_PCIE_PWR connector port.

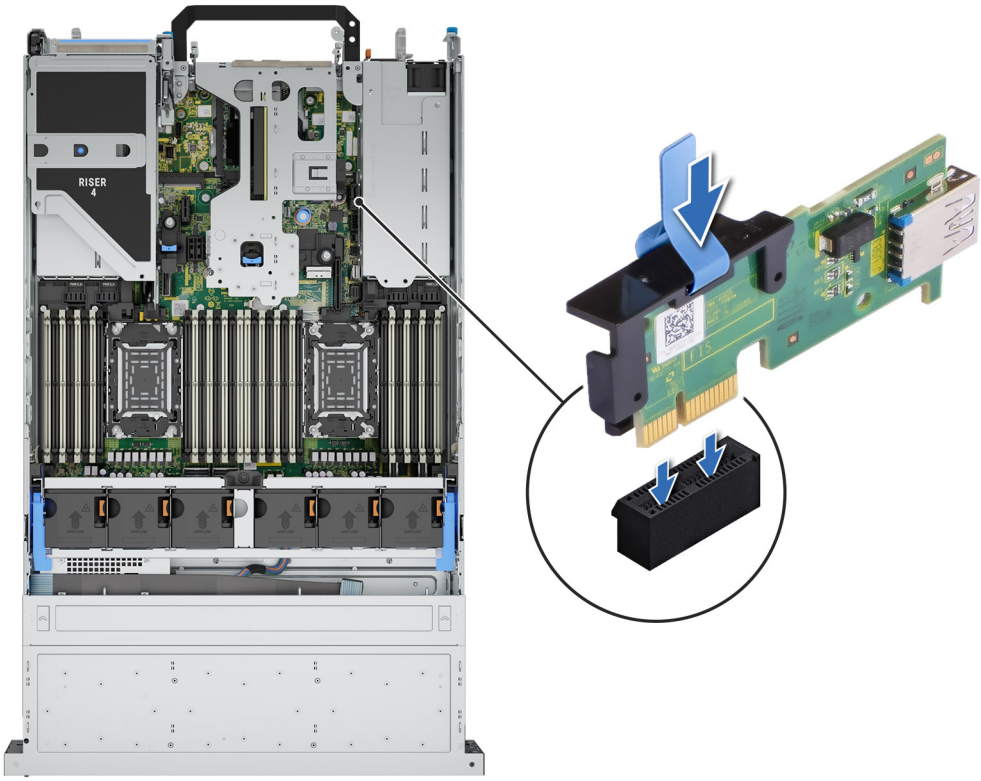


Figure 319. Internal USB card port information

Serial COM port kit

The serial COM port kit contains the components that are listed in the table.

Table 175. Serial COM port kit

Components	Quantity
Serial COM port card	1
Cable	1

For installation procedure of the serial COM port, see serial COM port section.

9

Jumpers and connectors

This topic provides some basic and specific information about jumpers and switches. It also describes the connectors on the various boards in the system. Jumpers on the system board help to disable the system and reset the passwords. To install components and cables correctly, you must know the connectors on the system board.

Topics:

System board jumpers and connectors

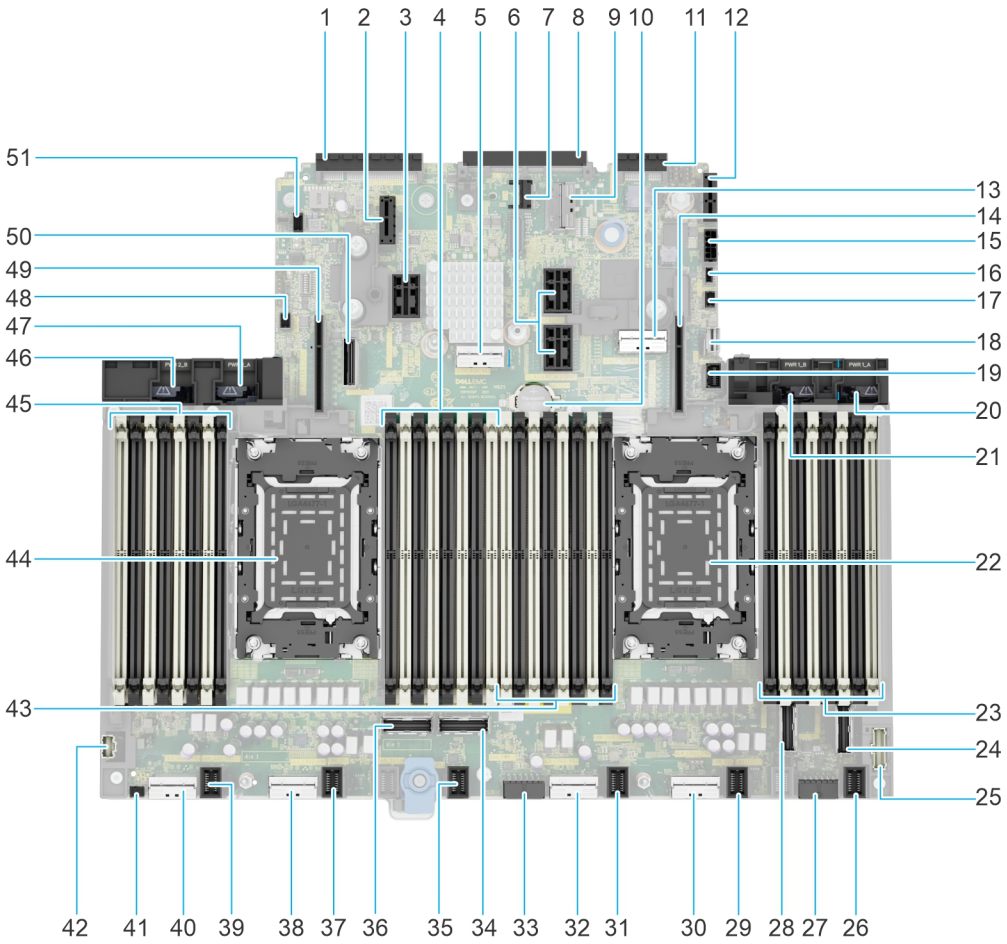


Figure 320. System board jumpers and connectors

Table 176. System board jumpers and connectors

Item	Connector	Description
1.	Rear_I/O_connector	Rear I/O connector
2.	J_R3_PCIE_PWR	Riser 3 power connector

Table 176. System board jumpers and connectors (continued)

Item	Connector	Description
3.	IO_RISER3 (CPU2)	Riser 3
4	B9, B1, B15, B7, B11, B3, B13, B5	DIMM for CPU 2 channels A, B, C, D
5.	SL10_PCH_SA1 [1]	SATA connector 10
6.	IO_RISER2_A (CPU1) and IO_RISER2_B (CPU2)	Riser 2
7.	TPM	TPM connector
8.	OCP	OCP NIC 3.0 connector
9.	SL13_CPU1_PB7	PCIe connector 13
10.	BATTERY	Coin cell battery
11.	LOM_Connector	LOM connector
12.	Internal USB	Internal USB connector
13.	SL11_CPU1_PB7	PCIe connector 11
14.	IO_RISER1 (CPU1)	Riser 1
15.	SIG_PWR_0	Power connector 0 - use for BP only
16.	BOSS_PWR	BOSS card power
17.	PSU1_SIG	PUCK sideband signal for Riser 1 GPU
18.	SL12_PCH_PA6	PCIe connector12
19.	FRONT_VIDEO	Front VGA
20.	PWR1_A	For power cable
21.	PWR1_B	For Riser 1 GPU power
22.	CPU 1	Processor 1
23.	A9, A1, A15, A7, A11, A3, A13, A5	DIMM for CPU 1 channels A, B, C, D
24.	SL8_CPU1_PA4	PCIe connector 8
25.	RGT_CP	Right control panel connector
26.	FAN_2U6	Fan 6 connector
27.	SIG_PWR_2	Power connector 2 - use for BP only
28.	SL7_CPU1_PB4	PCIe connector 7
29.	FAN_2U5	Fan 5 connector
30.	SL4_CPU1_PB2	PCIe connector 4
31.	FAN_2U4	Fan 4 connector
32.	SL3_CPU1_PA2	PCIe connector 3
33.	SIG_PWR_1	Power connector 2 - use for BP only
34.	SL6_CPU2_PA3	PCIe connector 6
35.	FAN_2U3	Fan 3 connector
36.	SL5_CPU2_PB3	PCIe connector 5
37.	FAN_2U2	Fan 2 connector
38.	SL2_CPU2_PB1	PCIe connector 2
39.	FAN_2U1	Fan 1 connector

Table 176. System board jumpers and connectors (continued)

Item	Connector	Description
40.	SL1_CPU2_PA1	PCIe connector 1
41.	PWRD_EN and NVRAM_CLR	Jumper
42.	LFT_CP	Left control panel connector
43.	A8, A16, A2, A10, A6, A14, A4, A12	DIMMs for CPU 1 channels H, G, F, E
44.	CPU 2	Processor 2
45.	B8, B16, B2, B10, B6, B14, B4, B12	DIMMs for CPU 2 channels H, G, F, E
46.	PWR2_B	For Riser 4 GPU power
47.	PWR2_A	For power cable
48.	PSU2_SIG	PUCK sideband signal for Riser 4 GPU
49.	IO_RISER4 (CPU2)	Riser 4
50.	SL9_CPU2_PA5 [1]	PCIe connector 9
51.	BAT_SIG	Battery signal connector

NOTE: The platform supports Maximum (MAX) and Mainstream (MS) system boards.

- [1] SL9_CPU2_PA5 and SL10_PCH_SA1 connectors are available only on MAX system board.
- MS system board supports CPU TDP < 250 W
- MAX system board supports CPU TDP => 250 W

System board jumper settings

For information about resetting the password jumper to disable a password, see the Disabling a forgotten password section.

Table 177. System board jumper settings

Jumper	Setting	Description
PWRD_EN		The BIOS password feature is enabled.
		The BIOS password feature is disabled. The BIOS password is now disabled and you are not allowed to set a new password.
NVRAM_CLR		The BIOS configuration settings are retained at system boot.
		The BIOS configuration settings are cleared at system boot.

CAUTION: You should be cautious when changing the BIOS settings. The BIOS interface is designed for advanced users. Any changes in the setting might prevent your system from starting correctly and may even result in data loss.

Disabling a forgotten password

The software security features of the system include a system password and a setup password. The password jumper enables or disables password features and clears any password(s) currently in use.

Prerequisites

CAUTION: Many repairs may only be done by a certified service technician. You should only perform troubleshooting and simple repairs as authorized in your product documentation, or as directed by the online or telephone service and support team. Damage due to servicing that is not authorized by Dell is not covered by your warranty. Read and follow the safety instructions that are shipped with your product.

Steps

1. Power off the system and all attached peripherals. Disconnect the system from the electrical outlet, and disconnect the peripherals.
2. Remove the system cover.
3. Move the jumper on the system board from pins 2 and 4 to pins 4 and 6.
4. Replace the system cover.

   NOTE: The existing passwords are not disabled (erased) until the system boots with the jumper on pins 4 and 6. However, before you assign a new system and/or setup password, you must move the jumper back to pins 2 and 4.

   NOTE: If you assign a new system and/or setup password with the jumper on pins 4 and 6, the system disables the new password(s) the next time it boots.

5. Reconnect the peripherals and connect the system to the electrical outlet, and then power on the system.
6. Power off the system.
7. Remove the system cover.
8. Move the jumper on the system board from pins 4 and 6 to pins 2 and 4.
9. Replace the system cover.
10. Reconnect the peripherals and connect the system to the electrical outlet, and then power on the system.
11. Assign a new system and/or setup password.

10

System diagnostics and indicator codes

The diagnostic indicators on the system front panel display system status during system startup.

Topics:

Status LED indicators

NOTE: The indicators display solid amber if any error occurs.

Figure 321. Status LED indicators

Table 178. Status LED indicators and descriptions

Icon	Description	Condition	Corrective action
	Drive indicator	The indicator turns solid amber if there is a drive error.	• Check the System Event Log to determine if the drive has an error. • Run the appropriate Online Diagnostics test. Restart the system and run embedded diagnostics (ePSA).

Table 178. Status LED indicators and descriptions (continued)

Icon	Description	Condition	Corrective action
			• If the drives are configured in a RAID array, restart the system, and enter the host adapter configuration utility program.
	Temperature indicator	The indicator turns solid amber if the system experiences a thermal error (for example, the ambient temperature is out of range or there is a fan failure).	Ensure that none of the following conditions exist: • A cooling fan has been removed or has failed. • System cover, air shrouds, or back filler bracket has been removed. • Ambient temperature is too high. • External airflow is obstructed. If the problem persists, see the Getting help section.
	Electrical indicator	The indicator turns solid amber if the system experiences an electrical error (for example, voltage out of range, or a failed power supply unit (PSU) or voltage regulator).	Check the System Event Log or system messages for the specific issue. If it is due to a problem with the PSU, check the LED on the PSU. Reseat the PSU. If the problem persists, see the Getting help section.
	Memory indicator	The indicator turns solid amber if a memory error occurs.	Check the System Event Log or system messages for the location of the failed memory. Reseat the memory module. If the problem persists, see the Getting help section.
	PCIe indicator	The indicator turns solid amber if a PCIe card experiences an error.	Restart the system. Update any required drivers for the PCIe card. Reinstall the card. If the problem persists, see the Getting help section. **NOTE:** For more information about the supported PCIe cards, see the Expansion cards and expansion card risers > Expansion card installation guidelines section.

System health and system ID indicator codes

The system health and system ID indicator is located on the left control panel of the system.

Figure 322. System health and system ID indicator

Table 179. System health and system ID indicator codes

System health and system ID indicator code	Condition
Solid blue	Indicates that the system is powered on, is healthy, and system ID mode is not active. Press the system health and system ID button to switch to system ID mode.
Blinking blue	Indicates that the system ID mode is active. Press the system health and system ID button to switch to system health mode.
Solid amber	Indicates that the system is in fail-safe mode. If the problem persists, see the Getting help section.
Blinking amber	EEMI guide.

iDRAC Quick Sync 2 indicator codes

iDRAC Quick Sync 2 module (optional) is located on the left control panel front IO panel of the system.

Table 180. iDRAC Quick Sync 2 indicators and descriptions

iDRAC Quick Sync 2 indicator code	Condition	Corrective action
Off (default state)	Indicates that the iDRAC Quick Sync 2 feature is powered off. Press the iDRAC Quick Sync 2 button to power on the iDRAC Quick Sync 2 feature.	If the LED fails to power on, reseat the left control panel flex cable and check. If the problem persists, see the Getting help section.
Solid white	Indicates that iDRAC Quick Sync 2 is ready to communicate. Press the iDRAC Quick Sync 2 button to power off.	If the LED fails to power off, restart the system. If the problem persists, see the Getting help section.
Blinks white rapidly	Indicates data transfer activity.	If the indicator continues to blink indefinitely, see the Getting help section.
Blinks white slowly	Indicates that firmware update is in progress.	If the indicator continues to blink indefinitely, see the Getting help section.
Blinks white five times rapidly and then powers off	Indicates that the iDRAC Quick Sync 2 feature is disabled.	Check if iDRAC Quick Sync 2 feature is configured to be disabled by iDRAC. If the problem persists, see the Getting help section. PowerEdge Manuals or *Dell OpenManage Server Administrator User's Guide* at OpenManage Manuals.
Solid amber	Indicates that the system is in fail-safe mode.	Restart the system. If the problem persists, see the Getting help section.
Blinking amber	Indicates that the iDRAC Quick Sync 2 hardware is not responding properly.	Restart the system. If the problem persists, see the Getting help section.

iDRAC Direct LED indicator codes

The iDRAC Direct LED indicator lights up to indicate that the port is connected and is being used as a part of the iDRAC subsystem.

You can configure iDRAC Direct by using a USB to micro USB (type AB) cable, which you can connect to your laptop or tablet. Cable length should not exceed 3 feet (0.91 meters). Performance could be affected by cable quality. The following table describes iDRAC Direct activity when the iDRAC Direct port is active:

Table 181. iDRAC Direct LED indicator codes

iDRAC Direct LED indicator code	Condition
Solid green for two seconds	Indicates that the laptop or tablet is connected.
Blinking green (on for two seconds and off for two seconds)	Indicates that the laptop or tablet that is connected is recognized.
LED Indicator off	Indicates that the laptop or tablet is unplugged.

LCD panel

The LCD panel provides system information, status, and error messages to indicate if the system is functioning correctly or requires attention. The LCD panel is used to configure or view the iDRAC IP address of the system. For more information about the event and error messages that are generated by the system firmware and agents that monitor system components , go to EEMI guide.

The LCD panel is available only on the optional front bezel. The optional front bezel is hot pluggable.

The status and conditions of the LCD panel are outlined here:

- The LCD backlight is white during normal operating conditions.

- If there is an issue, the LCD backlight turns amber and displays an error code followed by descriptive text.

  NOTE: If the system is connected to a power source and an error is detected, the LCD turns amber regardless of whether the system is powered on or off.

- When the system powers off and there are no errors, the LCD enters the standby mode after five minutes of inactivity. Press any button on the LCD to power it on.
- If the LCD panel stops responding, remove the bezel and reinstall it.

  If the problem persists, see Getting help.
- The LCD backlight remains off if LCD messaging is powered off using the iDRAC utility, the LCD panel, or other tools.

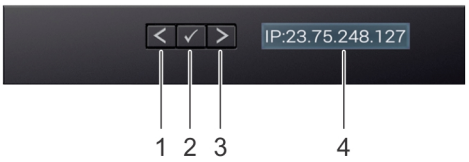


Figure 323. LCD panel features

Table 182. LCD panel features

Item	Button or display	Description
1	Left	Moves the cursor back in one-step increments.
2	Select	Selects the menu item that is highlighted by the cursor.
3	Right	Moves the cursor forward in one-step increments. During message scrolling: • Press and hold the right button to increase scrolling speed. • Release the button to stop. **NOTE:** The display stops scrolling when the button is released. After 45 seconds of inactivity, the display starts scrolling.
4	LCD display	Displays the system information, status, and error messages or iDRAC IP address.

Viewing Home screen

The **Home** screen displays user-configurable information about the system. This screen is displayed during normal system operation when there are no status messages or errors. When the system turns off and there are no errors, the LCD enters the standby mode after five minutes of inactivity. Press any button on the LCD to turn it on.

Steps

1. To view the **Home** screen, press one of the three navigation buttons (Select, Left, or Right).
2. To navigate to the **Home** screen from another menu, complete the following steps:
   a. Press and hold the navigation button till the up arrow is displayed.
   b. Navigate to the **Home** icon using the up arrow .
   c. Select the **Home** icon.
   d. On the **Home** screen, press the **Select** button to enter the main menu.

Setup menu

NOTE: When you select an option in the Setup menu, you must confirm the option before proceeding to the next action.

Table 183. Setup menu

Option	Description
iDRAC	Select **DHCP** or **Static IP** to configure the network mode. If **Static IP** is selected, the available fields are **IP**, **Subnet (Sub)**, and **Gateway (Gtw)**. Select **Setup DNS** to enable DNS and to view domain addresses. Two separate DNS entries are available.
Set error	Select **SEL** to view LCD error messages in a format that matches the IPMI description in the SEL. This enables you to match an LCD message with an SEL entry. Select **Simple** to view LCD error messages in a simplified user-friendly description. For information about the event and error messages generated by the system firmware and agents that monitor system components go to EEMI guide.
Set home	Select the default information to be displayed on the **Home** screen. See View Home menu section for the options and option items that can be set as the default on the **Home** screen.

View menu

NOTE: When you select an option in the View menu, you must confirm the option before proceeding to the next action.

Table 184. View menu

Option	Description
iDRAC IP	Displays the **IPv4** or **IPv6** addresses for iDRAC9. Addresses include **DNS** (**Primary** and **Secondary**), **Gateway**, **IP**, and **Subnet** (IPv6 does not have Subnet).
MAC	Displays the MAC addresses for **iDRAC**, **iSCSI**, or **Network** devices.
Name	Displays the name of the **Host**, **Model**, or **User String** for the system.
Number	Displays the **Asset tag** or the **Service tag** for the system.
Power	Displays the power output of the system in BTU/hr or Watts. The display format can be configured in the **Set home** submenu of the **Setup** menu.
Temperature	Displays the temperature of the system in Celsius or Fahrenheit. The display format can be configured in the **Set home** submenu of the **Setup** menu.

NIC indicator codes

Each NIC on the back of the system has indicators that provide information about the activity and link status. The activity LED indicator indicates if data is flowing through the NIC, and the link LED indicator indicates the speed of the connected network.

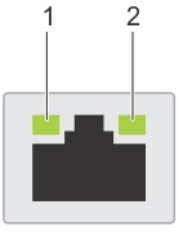


Figure 324. NIC indicator codes

1. Link LED indicator
2. Activity LED indicator

Table 185. NIC indicator codes

NIC indicator codes	Condition
Link and activity indicators are off.	Indicates that the NIC is not connected to the network.
Link indicator is green, and the activity indicator is blinking green.	Indicates that the NIC is connected to a valid network at its maximum port speed, and data is being sent or received.

Table 185. NIC indicator codes (continued)

NIC indicator codes	Condition
Link indicator is amber, and the activity indicator is blinking green.	Indicates that the NIC is connected to a valid network at less than its maximum port speed, and data is being sent or received.
Link indicator is green, and the activity indicator is off.	Indicates that the NIC is connected to a valid network at its maximum port speed, and data is not being sent or received.
The link indicator is amber, and the activity indicator is off.	Indicates that the NIC is connected to a valid network at less than its maximum port speed, and data is not being sent or received.
The link indicator is blinking green, and activity is off.	Indicates that the NIC identity is enabled through the NIC configuration utility.

Power supply unit indicator codes

AC and DC power supply units (PSUs) have an illuminated translucent handle that serves as an indicator. The indicator shows if power is present or if a power fault has occurred.

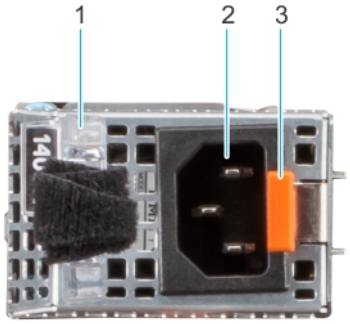


Figure 325. AC PSU status indicator

1. AC PSU handle
2. Socket
3. Release latch

Table 186. AC and DC PSU status indicator codes

Power indicator codes	Condition
Green	Indicates that a valid power source is connected to the PSU and the PSU is operational.
Blinking amber	Indicates an issue with the PSU.
Not powered on	Indicates that the power is not connected to the PSU.
Blinking green	Indicates that the firmware of the PSU is being updated. **CAUTION: Do not disconnect the power cord or unplug the PSU when updating firmware. If firmware update is interrupted, the PSUs will not function.**
Blinking greens and powers off	When hot-plugging a PSU, it blinks green five times at a rate of 4 Hz and powers off. This indicates a PSU mismatch due to efficiency, feature set, health status, or supported voltage. **CAUTION: If two PSUs are installed, both the PSUs must have the same type of label; for example, Extended Power Performance (EPP) label. Mixing PSUs from previous generations of PowerEdge servers is not supported, even if the PSUs have the**

Table 186. AC and DC PSU status indicator codes (continued)

Power indicator codes	Condition
	same power rating. This results in a PSU mismatch condition or failure to power on the system. **CAUTION: If two PSUs are used, they must be of the same type and have the same maximum output power.** **CAUTION: When correcting a PSU mismatch, replace the PSU with the blinking indicator. Swapping the PSU to make a matched pair can result in an error condition and an unexpected system shutdown. To change from a high output configuration to a low output configuration or vice versa, you must power off the system.** **CAUTION: AC PSUs support both 240 V and 120 V input voltages with the exception of Titanium PSUs, which support only 240 V. When two identical PSUs receive different input voltages, they can output different wattages, and trigger a mismatch.**

Drive indicator codes

The LEDs on the drive carrier indicate the state of each drive. Each drive carrier has two LEDs: an activity LED (green) and a status LED (bicolor, green/amber). The activity LED blinks whenever the drive is accessed.

Figure 326. Drive indicators

1. Drive activity LED indicator
2. Drive status LED indicator
3. Drive capacity label

NOTE: If the drive is in the Advanced Host Controller Interface (AHCI) mode, the status LED indicator does not power on.

NOTE: Drive status indicator behavior is managed by Storage Spaces Direct. Not all drive status indicators may be used.

Table 187. Drive indicator codes

Drive status indicator code	Condition
Blinks green twice per second	Indicates that the drive is being identified or preparing for removal.

Table 187. Drive indicator codes (continued)

Drive status indicator code	Condition
Not powered on	Indicates that the drive is ready for removal. **NOTE:** The drive status indicator remains off until all drives are initialized after the system is powered on. Drives are not ready for removal during this time.
Blinks green, amber, and then powers off	Indicates that there is an unexpected drive failure.
Blinks amber four times per second	Indicates that the drive has failed.
Blinks green slowly	Indicates that the drive is rebuilding.
Solid green	Indicates that the drive is online.
Blinks green for three seconds, amber for three seconds, and then powers off after six seconds	Indicates that the rebuild has stopped.

EDSFF E3.S drive led codes

The LEDs on the drive carrier indicate the state of each drive. The LEDs on the EDSFF E3.S drive have two LEDs: an activity LED (green) and a locate/fault LED (blue/amber). The activity LED blinks whenever the drive is accessed.

Figure 327. EDSFF E3.S drive indicators

1. Drive activity LED indicator
2. Drive status LED indicator
3. Drive capacity label

EDSFF E3.S drive led codes

E3.S hard drives have Green LED and Blue/Amber LED.

- Green LED shows : Drive power status , Activity
- Blue/Amber LED shows: Drive Fault, Locate

EDSFF indicator behavior

Table 188. EDSFF indicator behavior

Pattern Name	Description	Blue Element	Amber Element
Locate	This device is being identified.	ON (1 sec ON 1 sec OFF)	OFF
Fault	The device is in a fault condition.	OFF	ON (2 sec ON 1 sec OFF)
N/A	This device does not have fault or locate device.	OFF	OFF

NOTE: Locate behavior overrides Fault state.

Green LED

The green LED is driven and controlled by the device. The two functions for this LED are defined as follows:

- Power: This function indicates that the device has power and has no issues with its power regulation. Once the green LED is ON, it shall either remain ON or blink at the activity frequency unless the device determines power is no longer within its operating range.

- Activity: This function indicates if the device is being used.

Table 189. LED and device state per function for Green LED

Function/Device state	LED state
Power ON/Device is powered, no activity occurring.	ON
Activity/Device is powered, host initiated I/O activity occurring.	4 Hz nominal blink rate
Power OFF/Device is not powered.	OFF

Using system diagnostics

If you experience an issue with the system, run the system diagnostics before contacting Dell for technical support. The purpose of running system diagnostics is to test the system hardware without using additional equipment or risking data loss. If you are unable to fix the issue yourself, service and support personnel can use the diagnostics results to help you solve the issue.

Dell Embedded System Diagnostics

NOTE: The Dell Embedded System Diagnostics is also known as Enhanced Pre-boot System Assessment (ePSA) diagnostics.

The Embedded System Diagnostics provide a set of options for particular device groups or devices allowing you to:

- Run tests automatically or in an interactive mode
- Repeat tests
- Display or save test results
- Run thorough tests to introduce additional test options to provide extra information about the failed devices
- View status messages that inform you if tests are completed successfully
- View error messages that inform you of issues encountered during testing

Running the Embedded System Diagnostics from Boot Manager

Run the Embedded System Diagnostics (ePSA) if your system does not boot.

Steps

1. When the system is booting, press F11.
2. Use the up arrow and down arrow keys to select **System Utilities** > **Launch Diagnostics**.
3. Alternatively, when the system is booting, press F10, select **Hardware Diagnostics** > **Run Hardware Diagnostics**.
   The **ePSA Pre-boot System Assessment** window is displayed, listing all devices detected in the system. The diagnostics starts executing the tests on all the detected devices.

Running the Embedded System Diagnostics from the Dell Lifecycle Controller

Steps

1. When the system is booting, press F10.
2. Select **Hardware Diagnostics** → **Run Hardware Diagnostics**.
   The **ePSA Pre-boot System Assessment** window is displayed, listing all devices detected in the system. The diagnostics start executing the tests on all the detected devices.

System diagnostic controls

Table 190. System diagnostic controls

Menu	Description
Configuration	Displays the configuration and status information of all detected devices.
Results	Displays the results of all tests that are run.
System health	Provides the current overview of the system performance.
Event log	Displays a timestamped log of the results of all tests run on the system. This is displayed if at least one event description is recorded.

11

Getting help

Topics:

Recycling or End-of-Life service information

Take back and recycling services are offered for this product in certain countries. If you want to dispose of system components, visit How to Recycle and select the relevant country.

Contacting Dell Technologies

Dell provides online and telephone based support and service options. If you do not have an active internet connection, you can find Dell contact information on your purchase invoice, packing slip, bill or Dell product catalog. The availability of services varies depending on the country and product, and some services may not be available in your area. To contact Dell for sales, technical assistance, or customer service issues follow these steps:

Steps

1. Go to Dell Support.
2. Select your country from the drop-down menu on the lower right corner of the page.
3. For customized support:
   a. Enter the system Service Tag in the **Enter a Service Tag, Serial Number, Service Request, Model, or Keyword** field.
   b. Click **Search**.
   The support page that lists the various support categories is displayed.
4. For general support:
   a. Select your product category.
   b. Select your product segment.
   c. Select your product.
   The support page that lists the various support categories is displayed.
5. For contact details of Dell Global Technical Support:
   a. Click Contact Technical Support.
   b. The **Contact Technical Support** page is displayed with details to call, chat, or e-mail the Dell Global Technical Support team.

Accessing system information by using QR code

You can use the QR code located on the Express service tag in the front of the R760 system, to access information about PowerEdge R760. There is also another QR code for accessing product information on the back of the system cover.

Prerequisites

Ensure that your smart phone or tablet has a QR code scanner installed.

The QR code includes the following information about your system:

- How-to videos
- Reference materials, including the Installation and Service Manual, LCD diagnostics, and mechanical overview
- The system service tag to quickly access the specific hardware configuration and warranty information
- A direct link to Dell to contact technical support and sales teams

Steps

1. Go to PowerEdge Manuals, and navigate to your specific product or
2. Use your smart phone or tablet to scan the model-specific QR code on your system.

QR code for PowerEdge R760 system resources

Figure 328. QR code for PowerEdge R760 system

Receiving automated support with Secure Connect Gateway (SCG)

Dell Secure Connect Gateway (SCG) is an optional Dell Services offering that automates technical support for your Dell server, storage, and networking devices. By installing and setting up a Secure Connect Gateway (SCG) application in your IT environment, you can receive the following benefits:

- Automated issue detection — Secure Connect Gateway (SCG) monitors your Dell devices and automatically detects hardware issues, both proactively and predictively.
- Automated case creation — When an issue is detected, Secure Connect Gateway (SCG) automatically opens a support case with Dell Technical Support.
- Automated diagnostic collection — Secure Connect Gateway (SCG) automatically collects system state information from your devices and uploads it securely to Dell. This information is used by Dell Technical Support to troubleshoot the issue.
- Proactive contact — A Dell Technical Support agent contacts you about the support case and helps you resolve the issue.

The available benefits vary depending on the Dell Service entitlement purchased for your device. For more information about Secure Connect Gateway (SCG), go to secureconnectgateway.

12

Documentation resources

This section provides information about the documentation resources for your system.

To view the document that is listed in the documentation resources table:

- From the Dell support site:
  1. Click the documentation link that is provided in the Location column in the table.
  2. Click the required product or product version.

     NOTE: To locate the model number, see the front of your system.

  3. On the Product Support page, click **Documentation**.
- Using search engines:
  - Type the name and version of the document in the search box.

Table 191. Additional documentation resources for your system

Task	Document	Location
Setting up your system	For more information about installing and securing the system into a rack, see the Rail Installation Guide included with your rail solution. For information about setting up your system, see the *Getting Started Guide* document that is shipped with your system.	PowerEdge Manuals
Configuring your system	For information about the iDRAC features, configuring and logging in to iDRAC, and managing your system remotely, see the Integrated Dell Remote Access Controller User's Guide. For information about understanding Remote Access Controller Admin (RACADM) subcommands and supported RACADM interfaces, see the RACADM CLI Guide for iDRAC. For information about Redfish and its protocol, supported schema, and Redfish Eventing implemented in iDRAC, see the Redfish API Guide. For information about iDRAC property database group and object descriptions, see the Attribute Registry Guide. For information about Intel QuickAssist Technology, see the Integrated Dell Remote Access Controller User's Guide.	PowerEdge Manuals
	For information about earlier versions of, the iDRAC documents. To identify the version of iDRAC available on your system, on the iDRAC web interface, click **?** > **About**.	iDRAC Manuals

Table 191. Additional documentation resources for your system (continued)

Task	Document	Location
	For information about installing the operating system, see the operating system documentation.	Operating System Manuals
	For information about updating drivers and firmware, see the Methods to download firmware and drivers section in this document.	Drivers
Managing your system	For information about systems management software offered by Dell, see the Dell OpenManage Systems Management Overview Guide.	PowerEdge Manuals
	For information about setting up, using, and troubleshooting OpenManage, see the Dell OpenManage Server Administrator User's Guide.	OpenManage Manuals
	For information about installing and using Dell Secure Connect Gateway, see the Dell Secure Connect Gateway Enterprise User's Guide.	serviceability tools
	For information about partner programs enterprise systems management, see the OpenManage Connections Enterprise Systems Management documents.	OpenManage Manuals
Working with the Dell PowerEdge RAID controllers (if applicable)	For information about understanding the features of the Dell PowerEdge RAID controllers (PERC), Software RAID controllers, or BOSS card and deploying the cards, see the Storage controller documentation.	Storage Controller Manuals
Understanding event and error messages	For information about the event and error messages that are generated by the system firmware and agents that monitor system components, see the EEMI guide.	EEMI guide
Troubleshooting your system	For information about identifying and troubleshooting the PowerEdge server issues, see the Server Troubleshooting Guide.	PowerEdge Manuals